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User's Manual

μ PD784216A, 784218A, 784216AY, 784218AY Subseries

16-bit Single-Chip Microcontrollers

Hardware

μ PD784214A

μ PD784214AY

μ PD784215A

μ PD784215AY

μ PD784216A

μ PD784216AY

μ PD784217A

μ PD784217AY

μ PD784218A

μ PD784218AY

μ PD78F4216A

μ PD78F4216AY

μ PD78F4218A

μ PD78F4218AY

[MEMO]

① VOLTAGE APPLICATION WAVEFORM AT INPUT PIN

Waveform distortion due to input noise or a reflected wave may cause malfunction. If the input of the CMOS device stays in the area between V_{IL} (MAX) and V_{IH} (MIN) due to noise, etc., the device may malfunction. Take care to prevent chattering noise from entering the device when the input level is fixed, and also in the transition period when the input level passes through the area between V_{IL} (MAX) and V_{IH} (MIN).

② HANDLING OF UNUSED INPUT PINS

Unconnected CMOS device inputs can be cause of malfunction. If an input pin is unconnected, it is possible that an internal input level may be generated due to noise, etc., causing malfunction. CMOS devices behave differently than Bipolar or NMOS devices. Input levels of CMOS devices must be fixed high or low by using pull-up or pull-down circuitry. Each unused pin should be connected to V_{DD} or GND via a resistor if there is a possibility that it will be an output pin. All handling related to unused pins must be judged separately for each device and according to related specifications governing the device.

③ PRECAUTION AGAINST ESD

A strong electric field, when exposed to a MOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop generation of static electricity as much as possible, and quickly dissipate it when it has occurred. Environmental control must be adequate. When it is dry, a humidifier should be used. It is recommended to avoid using insulators that easily build up static electricity. Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work benches and floors should be grounded. The operator should be grounded using a wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions need to be taken for PW boards with mounted semiconductor devices.

④ STATUS BEFORE INITIALIZATION

Power-on does not necessarily define the initial status of a MOS device. Immediately after the power source is turned ON, devices with reset functions have not yet been initialized. Hence, power-on does not guarantee output pin levels, I/O settings or contents of registers. A device is not initialized until the reset signal is received. A reset operation must be executed immediately after power-on for devices with reset functions.

⑤ POWER ON/OFF SEQUENCE

In the case of a device that uses different power supplies for the internal operation and external interface, as a rule, switch on the external power supply after switching on the internal power supply. When switching the power supply off, as a rule, switch off the external power supply and then the internal power supply. Use of the reverse power on/off sequences may result in the application of an overvoltage to the internal elements of the device, causing malfunction and degradation of internal elements due to the passage of an abnormal current.

The correct power on/off sequence must be judged separately for each device and according to related specifications governing the device.

⑥ INPUT OF SIGNAL DURING POWER OFF STATE

Do not input signals or an I/O pull-up power supply while the device is not powered. The current injection that results from input of such a signal or I/O pull-up power supply may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements. Input of signals during the power off state must be judged separately for each device and according to related specifications governing the device.

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- Availability of related technical literature
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Major Revisions in This Edition

Page	Description
U13570EJ2V0UD00 → U13570EJ3V0UD00	
p.34	CHAPTER 1 GENERAL • Update of 78K/IV PRODUCT LINEUP
p.110	CHAPTER 4 CLOCK GENERATOR • Modification of Figure 4-4 Clock Status Register (PCS) Format
p.408	CHAPTER 23 INTERRUPT FUNCTIONS • Modification of TMIC00 bit name in Figure 23-1 Interrupt Control Register (××ICn)
p.517 p.535 p.541 p.548 p.551 p.556 p.557 p.558	CHAPTER 25 STANDBY FUNCTION • Modification of Figure 25-1 Standby Function State Transitions • Modification of Table 25-5 Operating States in STOP Mode • Modification of description in 25.4.2 (3) Releasing the STOP mode by $\overline{\text{RESET}}$ input • Modification of description in 25.5.2 (3) Releasing the IDLE mode by $\overline{\text{RESET}}$ input • Modification of description in 25.6 (5) A/D converter • Modification of description in 25.7.3 (1) (b) (iii) Releasing the HALT mode by $\overline{\text{RESET}}$ input • Modification of description in 25.7.3 (2) (a) Setting the IDLE mode and the operating states • Modification of description in 25.7.3 (2) (b) (iii) Releasing the IDLE mode by $\overline{\text{RESET}}$ input
p.608	Addition of CHAPTER 30 ELECTRICAL SPECIFICATIONS (μ PD784214A, 784215A, 784216A, 784217A, 784218A, 784214AY, 784215AY, 784216AY, 784217AY, 784218AY)
p.632	Addition of CHAPTER 31 ELECTRICAL SPECIFICATIONS (μ PD78F4216A, 78F4218A, 78F4216AY, 78F4218AY)
p.659	Addition of CHAPTER 32 PACKAGE DRAWINGS
p.661	Addition of CHAPTER 33 RECOMMENDED SOLDERING CONDITIONS
pp.670, 671 p.672 p.674 p.675	Modification of description in APPENDIX B DEVELOPMENT TOOLS • Addition of SP78K4 to B.1 Language Processing Software , modification of description in Remark • Addition and modification of description in B.3.1 Hardware • Modification of description in Remark in B.3.2 Software • Addition of B.4 Cautions on Designing Target System
p.681	Modification of description in APPENDIX C EMBEDDED SOFTWARE
U13570EJ3V0UD00 → U13570EJ3V1UD00	
p.36	Modification of 1.2 Ordering Information
p.661	Addition of lead-free products to CHAPTER 33 RECOMMENDED SOLDERING CONDITIONS

The mark ★ shows major revised points.

INTRODUCTION

Readers This manual is intended for user engineers who wish to understand the functions of the μ PD784216A, 784218A, 784216AY, and 784218AY Subseries and design its application systems.

Purpose This manual is intended to help users understand the hardware functions of the μ PD784216A, 784218A, 784216AY, and 784218AY Subseries.

Organization The μ PD784216A, 784218A, 784216AY, and 784218AY Subseries User's Manuals consist of two volumes, Hardware (this manual) and Instruction.

Hardware

Pin functions
Internal block functions
Interrupts
Other on-chip peripheral functions
Electrical specifications

Instruction

CPU functions
Addressing
Instruction set

**There are cautions associated with using this product.
Be sure to read the cautions in the text of each chapter and the summary at the end of each chapter.**

How to read this manual Reading this manual requires general knowledge about electronics, logic circuits, and microcontrollers.

- **If there are no particular differences in functions**

The μ PD784218A Subseries is described as the representative subseries.

The μ PD784218A of the μ PD784218A Subseries is described as the representative mask ROM product, and the μ PD78F4218A is described as the representative flash memory product.

- **If there are differences in functions**

Each product name is presented and described individually.

Since μ PD784216A, 784218A Subseries products are described as the representative products even in this case, for information on the operation of μ PD784216AY, 784218AY Subseries products, read the μ PD784214A, 784215A, 784216A, 784217A, 784218A, and 78F4218A as the μ PD784214AY, 784215AY, 784216AY, 784217AY, 784218AY, and 78F4218AY.

- **To understand the overall functions**

→ Read this manual in the order of the **CONTENTS**.

- **For unusual operations when debugging**

→ See the applicable cautions listed at the end of each chapter.

- **To check the details of a register whose name is known**
→ See **APPENDIX D REGISTER INDEX**.
- **To learn details of the instruction functions**
→ Refer to the **78K/IV Series User's Manual — Instruction (U10905E)**.
- **To find out about the electrical specifications**
→ Refer to the chapter of electrical specifications
- **For application examples of the functions**
→ Refer to the application notes (published separately).

Differences between the μ PD784216A Subseries, μ PD784218A Subseries, μ PD784216AY Subseries, and μ PD784218AY Subseries

The only functional differences between the four subseries are the clocked serial interface, ROM correction, and external access status functions. The four subseries otherwise share the same functions.

Caution

The clocked serial interface is described in the following two chapters.

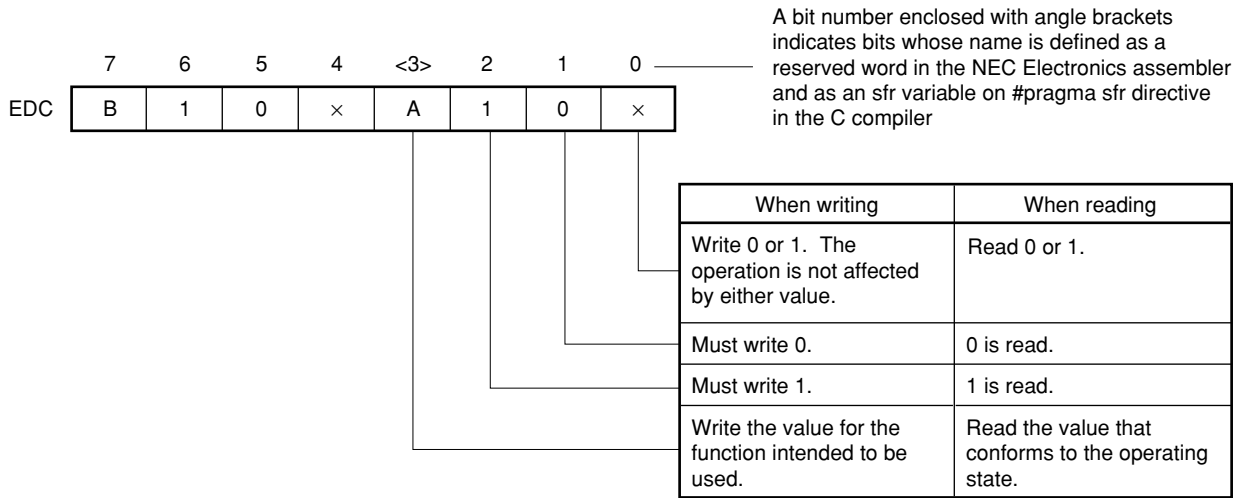
- **CHAPTER 18 3-WIRE SERIAL I/O MODE**
- **CHAPTER 19 I²C BUS MODE (μ PD784216AY, 784218AY SUBSERIES ONLY)**

For an overview of the serial interface, read CHAPTER 16 altogether.

Legend

- Data significance: The left side is the most significant digit. The right side is the least significant digit.
- Active low notation: $\overline{\text{xxx}}$ (overbar on pin or signal name)
- Note:** Description of **Note** in the text
- Caution:** Information requiring particular attention
- Remark:** Supplemental description of the text
- Numerical notations: Binary numbers xxxxB or xxxx
 Decimal numbers xxxx
 Hexadecimal numbers ... xxxxH

Register notation



Never write a combination of codes that have “Setting prohibited” written in the register description in this manual.

Characters that are easily confused: 0 (zero), O (capital o)

: 1 (one), l (letter l), I (capital i)

Related Documents The related documents in this publication may include preliminary versions. However, preliminary versions are not marked as such.

Documents Related to Devices

Document Name	Document No.
μPD784216A, 784218A, 784216AY, 784218AY Subseries Hardware User's Manual	This manual
78K/IV Series Software Fundamentals Application Note	U10095E
78K/IV Series Instructions User's Manual	U10905E

Documents Related to Development Tools (User's Manuals)

Document Name	Document No.	
RA78K4 Assembler Package	Operation	U15254E
	Language	U15255E
	Structured Assembler Preprocessor	U11743E
CC78K4 C Compiler	Operation	U15557E
	Language	U15556E
SM78K Series Ver. 2.30 or Later System Simulator	Operation (Windows™ Based)	U15373E
	External Part User Open Interface Specification	U15802E
ID78K Series Integrated Debugger Ver. 2.30 or Later	Operation (Windows Based)	U15185E
RX78K4 Real-time OS	Fundamentals	U10603E
	Installation	U10604E
Project Manager Ver 3.12 or Later (Windows Based)		U14610E

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Documents Related to Development Hardware Tools (User's Manuals)

Document Name	Document No.
IE-78K4-NS In-Circuit Emulator	U13356E
IE-784225-NS-EM1 Emulation Board	U13742E
IE-784000-R In-Circuit Emulator	U12903E
IE-784218-R-EM1 Emulation Board	U12155E

Documents Related to Flash Memory Writing

Document Name	Document No.
PG-FP3 Flash Memory Programmer User's Manual	U13502E

Other Related Documents

Document Name	Document No.
SEMICONDUCTOR SELECTION GUIDE - Products and Packages -	X13769X
Semiconductor Device Mount Manual	Note
Quality Grades on NEC Semiconductor Devices	C11531E
NEC Semiconductor Device Reliability/Quality Control System	C10983E
Guide to Prevent Damage for Semiconductor Devices by Electrostatic Discharge (ESD)	C11892E

Note See the "Semiconductor Device Mount Manual" website (<http://www.necel.com/pkg/en/mount/index.html>).

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CHAPTER 1 OVERVIEW

The μ PD784218A Subseries is a member of the 78K/IV Series and consists of 100-pin products intended for general-purpose applications. The 78K/IV Series has 16-bit single-chip microcontrollers and provides a high-performance CPU with functions such as access to a 1 MB memory space.

The μ PD784218A has a 256 KB mask ROM and a 12,800-byte RAM on chip. In addition, it incorporates a high-performance timer/counter, an 8-bit A/D converter, an 8-bit D/A converter, and an independent 2-channel serial interface.

The μ PD784217A is a product with the mask ROM capacity of the μ PD784218A changed to 192 KB.

The μ PD784216A is based on the μ PD784218A with 128 KB of mask ROM and 8,192 bytes of RAM.

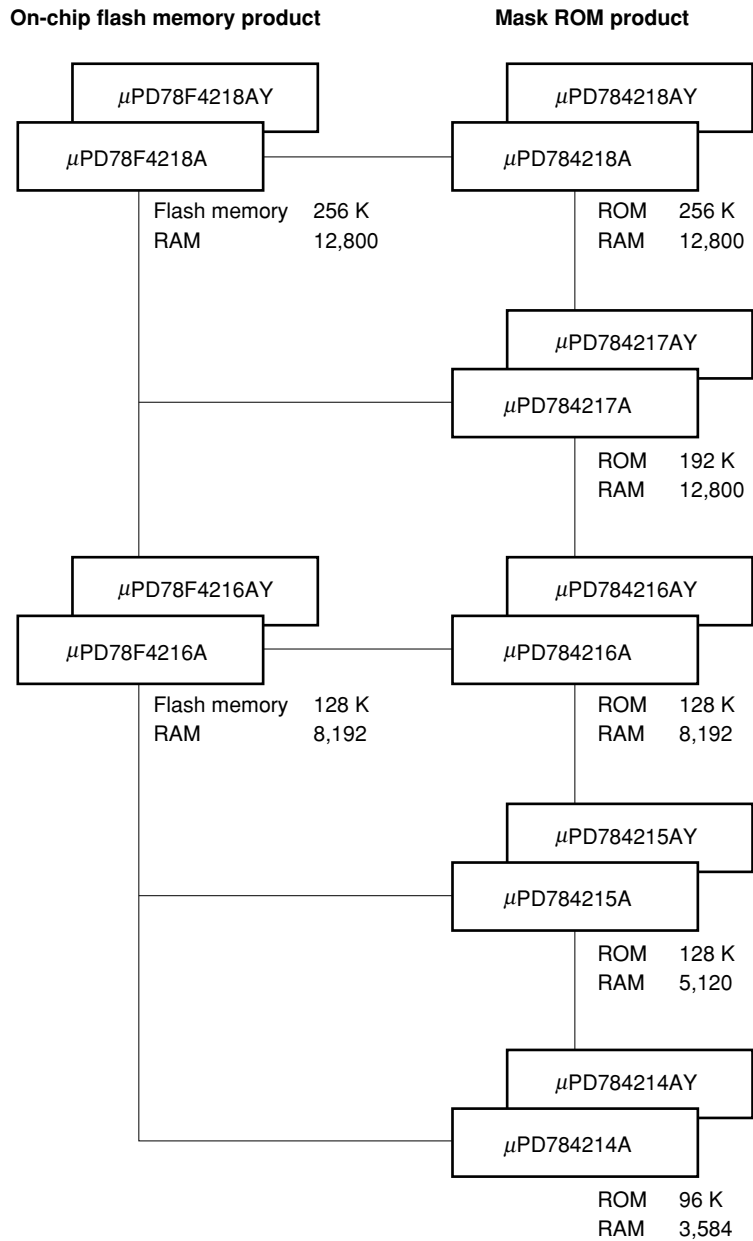
The μ PD784215A is based on the μ PD784218A with 128 KB of mask ROM and 5,120 bytes of RAM.

The μ PD784214A is based on the μ PD784218A with 128 KB of mask ROM and 3,584 bytes of RAM.

The μ PD78F4216A and 78F4218A are products with the mask ROM of the μ PD784216A and 784218A replaced by a flash memory.

The μ PD784216AY and 784218AY Subseries adds an I²C bus control function to the μ PD784216A and 784218A Subseries.

The relationships among these products are shown below.

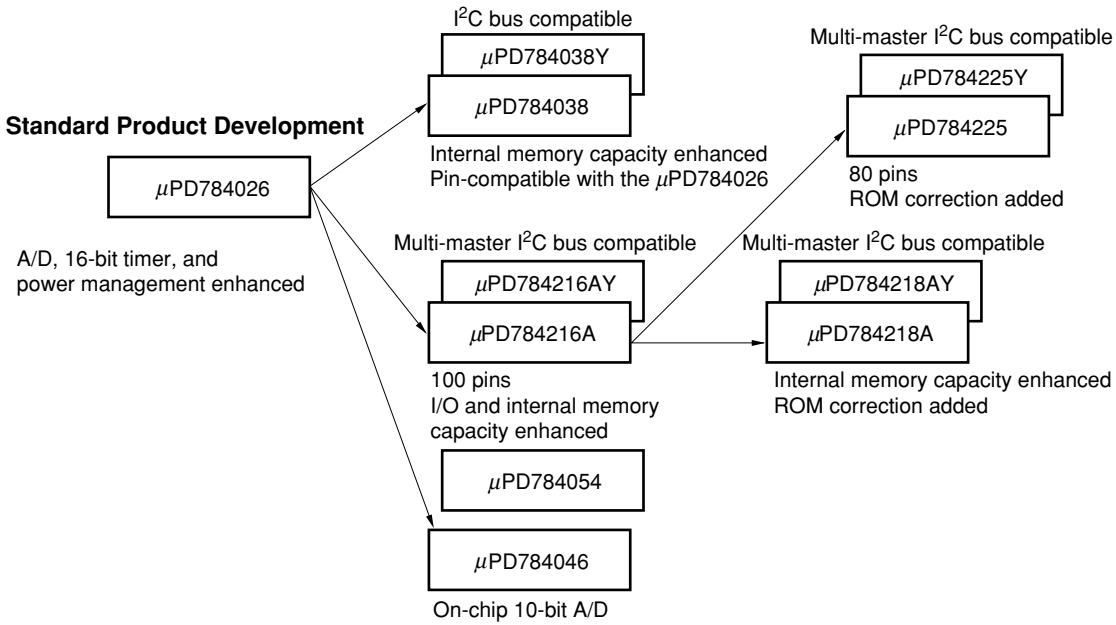


These products can be applied in the following areas.

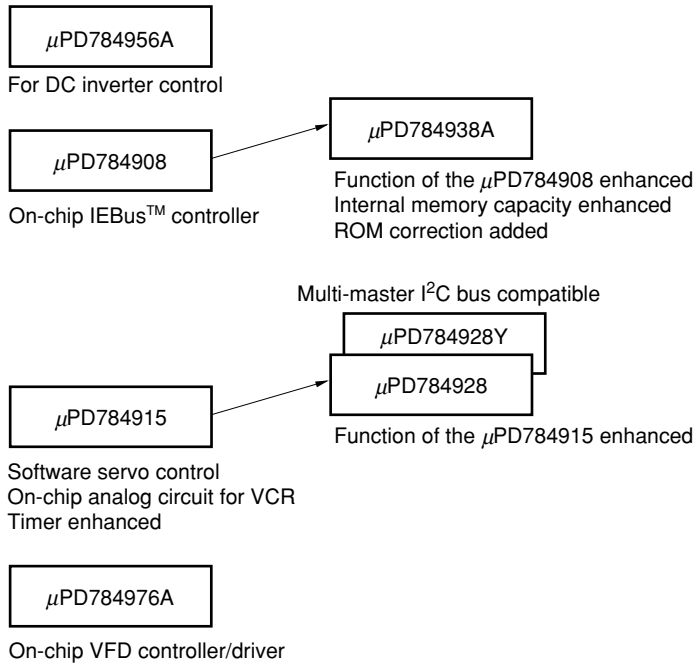
- Cellular phones, PHS, cordless phones, CD-ROMs, AV equipment, etc.

★ 78K/IV Series Product Development Diagram

: In mass production



ASSP Development



Remark VFD (Vacuum Fluorescent Display) is referred to as FIP™ (Fluorescent Indicator Panel) in some documents, but the functions of the two are the same.

1.1 Features

- On-chip ROM correction (μ PD784218A, 784218AY Subseries only)
- Inherits the peripheral functions of the μ PD78078 Subseries
- Minimum instruction execution time
 - 160 ns (main system clock: $f_{xx} = 12.5$ MHz operation)
 - 61 μ s (subsystem clock: $f_{xt} = 32.768$ kHz operation)
- Instruction set suited for control applications
- Interrupt controller (4-level priority)
 - Vectored interrupt servicing, macro service, and context switching
- Standby function
 - HALT, STOP, and IDLE modes
 - In the low power consumption mode: HALT and IDLE modes (subsystem clock operation)
- On-chip memory:

Mask ROM	256 KB (μ PD784218A, 784218AY)
	192 KB (μ PD784217A, 784217AY)
	128 KB (μ PD784215A, 784216A, 784215AY, 784216AY)
	96 KB (μ PD784214A, 784214AY)
Flash memory	256 KB (μ PD78F4218A, 78F4218AY)
	128 KB (μ PD78F4216A, 78F4216AY)
RAM	12,800 bytes (μ PD784217A, 784218A, 784217AY, 784218AY, 78F4218A, 78F4218AY)
	8,192 bytes (μ PD784216A, 784216AY, 78F4216A, 78F4216AY)
	5,120 bytes (μ PD784215A, 784215AY)
	3,584 bytes (μ PD784214A, 784214AY)
- I/O pins: 86
 - Software programmable pull-up resistors: 70 inputs
 - LED direct drive possible: 22 outputs
 - Transistor direct drive possible: 6 outputs
- Timer/counter: 16-bit timer/counter \times 1 unit
8-bit timer/counter \times 6 units
- Watch timer: 1 channel
- Watchdog timer: 1 channel
- Serial interfaces
 - UART/IOE (3-wire serial I/O): 2 channels (on-chip baud rate generator)
 - CSI (3-wire serial I/O, multimaster compatible I²C bus^{Note}): 1 channel
- A/D converter: 8-bit resolution \times 8 channels
- D/A converter: 8-bit resolution \times 2 channels
- Real-time output port (by combining with the timer/counter, two stepping motors can be independently controlled)
- Clock frequency function
- Clock output function: Select from f_{xx} , $f_{xx}/2$, $f_{xx}/2^2$, $f_{xx}/2^3$, $f_{xx}/2^4$, $f_{xx}/2^5$, $f_{xx}/2^6$, $f_{xx}/2^7$, and f_{xt}
- Buzzer output function: Select from $f_{xx}/2^{10}$, $f_{xx}/2^{11}$, $f_{xx}/2^{12}$, and $f_{xx}/2^{13}$
- Power supply voltage: $V_{DD} = 1.8$ to 5.5 V (mask ROM version)
 $V_{DD} = 1.9$ to 5.5 V (flash memory version)

Note Only in the μ PD784216AY, 784218AY Subseries

★ 1.2 Ordering Information

(1) μ PD784216A, 784218A Subseries

Part Number	Package	On-chip ROM
μ PD784214AGC-xxx-8EU	100-pin plastic LQFP (fine pitch) (14 × 14)	Mask ROM
μ PD784214AGF-xxx-3BA	100-pin plastic QFP (14 × 20)	Mask ROM
μ PD784215AGC-xxx-8EU	100-pin plastic LQFP (fine pitch) (14 × 14)	Mask ROM
μ PD784215AGF-xxx-3BA	100-pin plastic QFP (14 × 20)	Mask ROM
μ PD784216AGC-xxx-8EU	100-pin plastic LQFP (fine pitch) (14 × 14)	Mask ROM
μ PD784216AGF-xxx-3BA	100-pin plastic QFP (14 × 20)	Mask ROM
μ PD784217AGC-xxx-8EU	100-pin plastic LQFP (fine pitch) (14 × 14)	Mask ROM
μ PD784217AGF-xxx-3BA	100-pin plastic QFP (14 × 20)	Mask ROM
μ PD784218AGC-xxx-8EU	100-pin plastic LQFP (fine pitch) (14 × 14)	Mask ROM
μ PD784218AGF-xxx-3BA	100-pin plastic QFP (14 × 20)	Mask ROM
μ PD78F4216AGC-8EU	100-pin plastic LQFP (fine pitch) (14 × 14)	Flash memory
μ PD78F4216AGF-3BA	100-pin plastic QFP (14 × 20)	Flash memory
μ PD78F4218AGC-8EU	100-pin plastic LQFP (fine pitch) (14 × 14)	Flash memory
μ PD78F4218AGF-3BA	100-pin plastic QFP (14 × 20)	Flash memory
μ PD784214AGC-xxx-8EU-A	100-pin plastic LQFP (fine pitch) (14 × 14)	Mask ROM
μ PD784214AGF-xxx-3BA-A	100-pin plastic QFP (14 × 20)	Mask ROM
μ PD784215AGC-xxx-8EU-A	100-pin plastic LQFP (fine pitch) (14 × 14)	Mask ROM
μ PD784215AGF-xxx-3BA-A	100-pin plastic QFP (14 × 20)	Mask ROM
μ PD784216AGC-xxx-8EU-A	100-pin plastic LQFP (fine pitch) (14 × 14)	Mask ROM
μ PD784216AGF-xxx-3BA-A	100-pin plastic QFP (14 × 20)	Mask ROM
μ PD784217AGC-xxx-8EU-A	100-pin plastic LQFP (fine pitch) (14 × 14)	Mask ROM
μ PD784217AGF-xxx-3BA-A	100-pin plastic QFP (14 × 20)	Mask ROM
μ PD784218AGC-xxx-8EU-A	100-pin plastic LQFP (fine pitch) (14 × 14)	Mask ROM
μ PD784218AGF-xxx-3BA-A	100-pin plastic QFP (14 × 20)	Mask ROM
μ PD78F4216AGC-8EU-A	100-pin plastic LQFP (fine pitch) (14 × 14)	Flash memory
μ PD78F4216AGF-3BA-A	100-pin plastic QFP (14 × 20)	Flash memory
μ PD78F4218AGC-8EU-A	100-pin plastic LQFP (fine pitch) (14 × 14)	Flash memory
μ PD78F4218AGF-3BA-A	100-pin plastic QFP (14 × 20)	Flash memory

Remark 1. xxx indicates ROM code suffix.

2. Products that have the part numbers suffixed by “-A” are lead-free products.

(2) μ PD784216AY, 784218AY Subseries

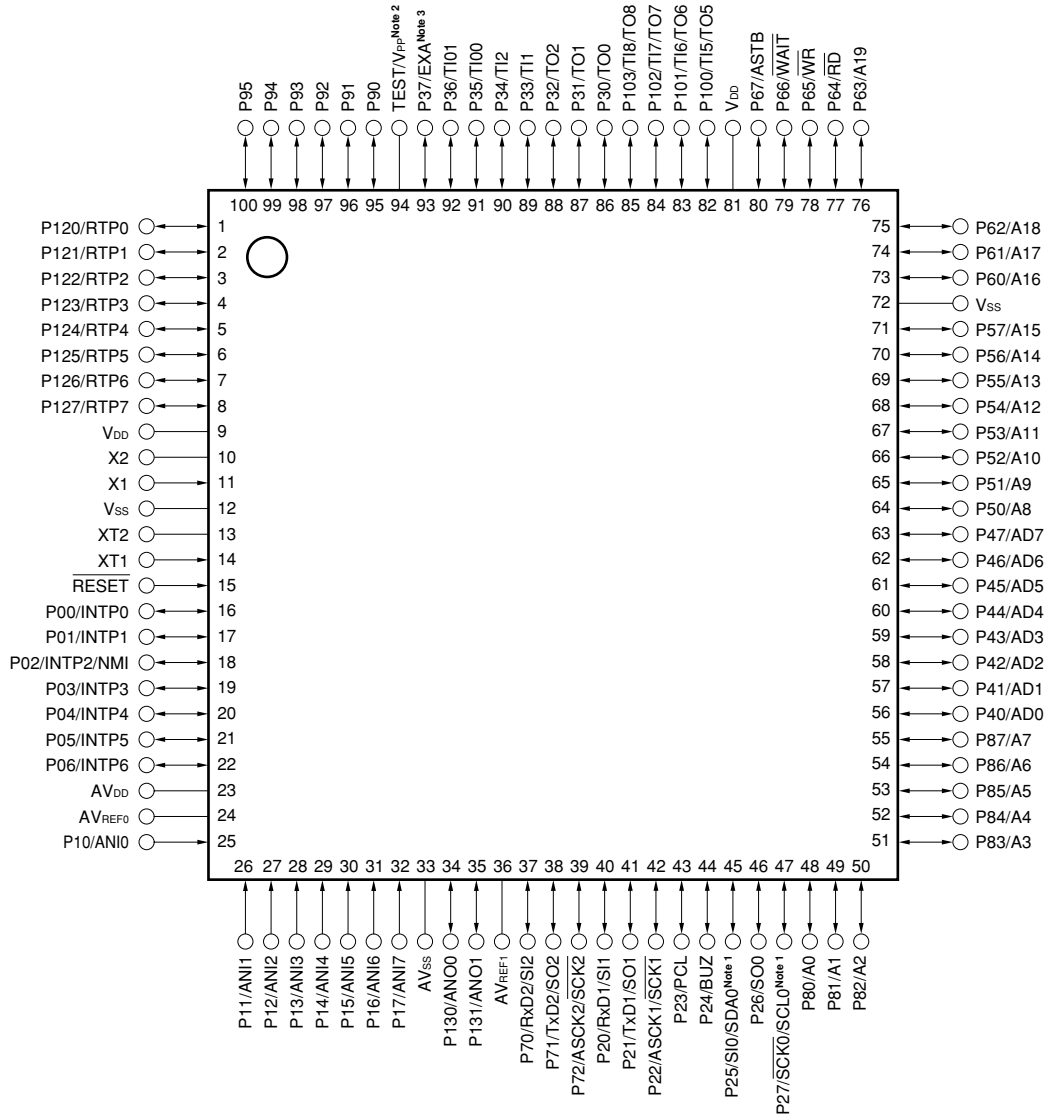
Part Number	Package	On-chip ROM
μ PD784214AYGC-xxx-8EU	100-pin plastic LQFP (fine pitch) (14 × 14)	Mask ROM
μ PD784214AYGF-xxx-3BA	100-pin plastic QFP (14 × 20)	Mask ROM
μ PD784215AYGC-xxx-8EU	100-pin plastic LQFP (fine pitch) (14 × 14)	Mask ROM
μ PD784215AYGF-xxx-3BA	100-pin plastic QFP (14 × 20)	Mask ROM
μ PD784216AYGC-xxx-8EU	100-pin plastic LQFP (fine pitch) (14 × 14)	Mask ROM
μ PD784216AYGF-xxx-3BA	100-pin plastic QFP (14 × 20)	Mask ROM
μ PD784217AYGC-xxx-8EU	100-pin plastic LQFP (fine pitch) (14 × 14)	Mask ROM
μ PD784217AYGF-xxx-3BA	100-pin plastic QFP (14 × 20)	Mask ROM
μ PD784218AYGC-xxx-8EU	100-pin plastic LQFP (fine pitch) (14 × 14)	Mask ROM
μ PD784218AYGF-xxx-3BA	100-pin plastic QFP (14 × 20)	Mask ROM
μ PD78F4216AYGC-8EU	100-pin plastic LQFP (fine pitch) (14 × 14)	Flash memory
μ PD78F4216AYGF-3BA	100-pin plastic QFP (14 × 20)	Flash memory
μ PD78F4218AYGC-8EU	100-pin plastic LQFP (fine pitch) (14 × 14)	Flash memory
μ PD78F4218AYGF-3BA	100-pin plastic QFP (14 × 20)	Flash memory
μ PD784214AYGC-xxx-8EU-A	100-pin plastic LQFP (fine pitch) (14 × 14)	Mask ROM
μ PD784214AYGF-xxx-3BA-A	100-pin plastic QFP (14 × 20)	Mask ROM
μ PD784215AYGC-xxx-8EU-A	100-pin plastic LQFP (fine pitch) (14 × 14)	Mask ROM
μ PD784215AYGF-xxx-3BA-A	100-pin plastic QFP (14 × 20)	Mask ROM
μ PD784216AYGC-xxx-8EU-A	100-pin plastic LQFP (fine pitch) (14 × 14)	Mask ROM
μ PD784216AYGF-xxx-3BA-A	100-pin plastic QFP (14 × 20)	Mask ROM
μ PD784217AYGC-xxx-8EU-A	100-pin plastic LQFP (fine pitch) (14 × 14)	Mask ROM
μ PD784217AYGF-xxx-3BA-A	100-pin plastic QFP (14 × 20)	Mask ROM
μ PD784218AYGC-xxx-8EU-A	100-pin plastic LQFP (fine pitch) (14 × 14)	Mask ROM
μ PD784218AYGF-xxx-3BA-A	100-pin plastic QFP (14 × 20)	Mask ROM
μ PD78F4216AYGC-8EU-A	100-pin plastic LQFP (fine pitch) (14 × 14)	Flash memory
μ PD78F4216AYGF-3BA-A	100-pin plastic QFP (14 × 20)	Flash memory
μ PD78F4218AYGC-8EU-A	100-pin plastic LQFP (fine pitch) (14 × 14)	Flash memory
μ PD78F4218AYGF-3BA-A	100-pin plastic QFP (14 × 20)	Flash memory

Remark 1. xxx indicates ROM code suffix.

2. Products that have the part numbers suffixed by “-A” are lead-free products.

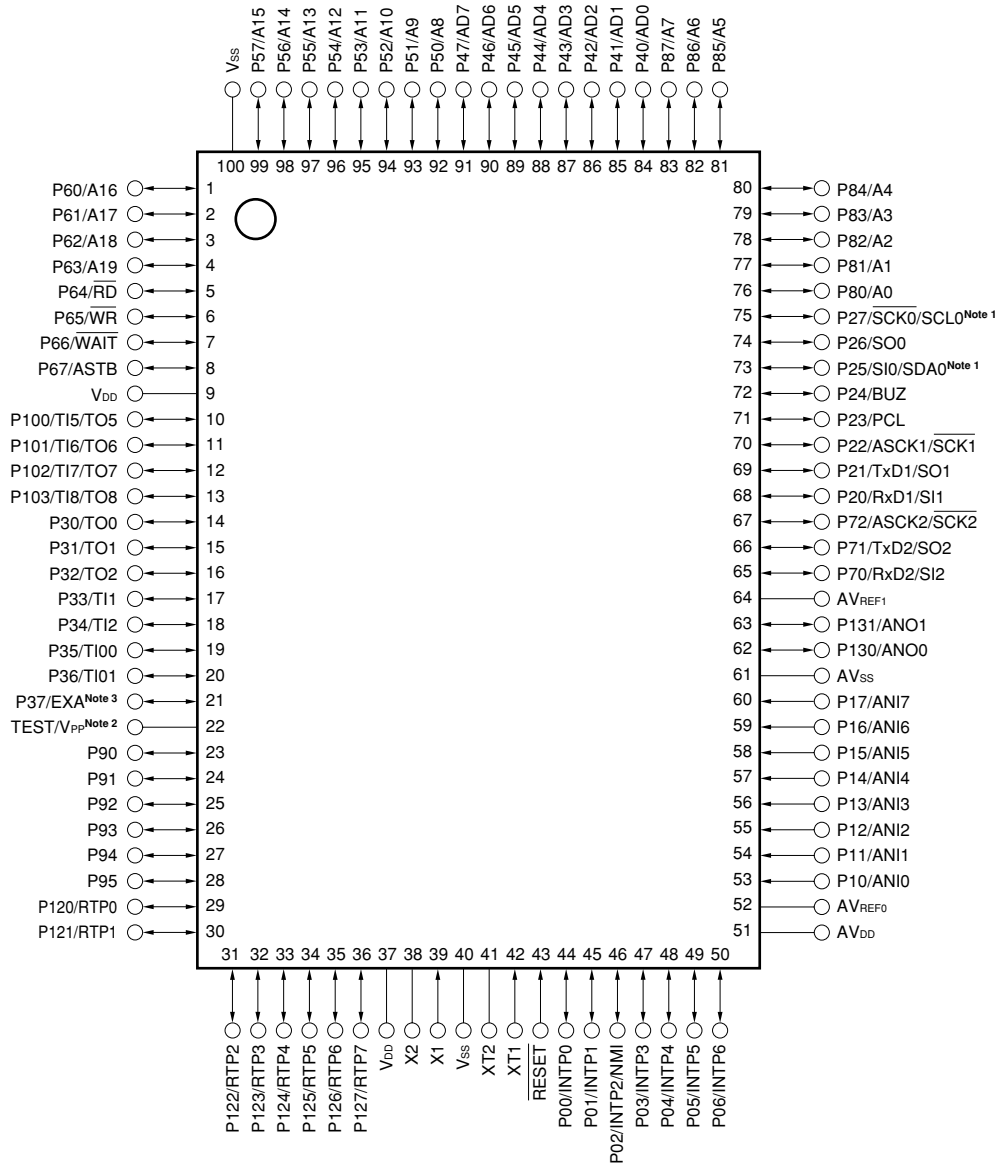
1.3 Pin Configuration (Top View)

- 100-pin plastic LQFP (fine pitch) (14 × 14)



- Notes**
1. The SDA0 and SCL0 pins are provided only for the μ PD784216AY, 784218AY Subseries.
 2. The V_{PP} pin is provided only for the μ PD78F4216A, 78F4218A, 78F4216AY, and 78F4218AY.
 3. The EXA pin is provided only for the μ PD784218A, 784218AY Subseries.

• 100-pin plastic QFP (14 × 20)



- Notes**
1. The SDA0 and SCL0 pins are provided only for the μ PD784216AY, 784218AY Subseries.
 2. The V_{PP} pin is provided only for the μ PD78F4216A, 78F4218A, 78F4216AY, and 78F4218AY.
 3. The EXA pin is provided only for the μ PD784218A, 784218AY Subseries.

- Cautions**
1. Connect the TEST pin directly to V_{SS} or pull down. For the pull-down connection, use of a resistor with a resistance between 470 Ω and 10 kΩ is recommended.
 2. Connect the V_{PP} pin directly to V_{SS} or pull down during normal operation. When using a system in which on-chip flash memory is rewritten on board, connect the V_{PP} pin via a pull-down resistor.
For the pull-down connection, use of a resistor with a resistance between 470 Ω and 10 kΩ is recommended.
 3. Connect the AV_{DD} pin to V_{DD}.
 4. Connect the AV_{SS} pin to V_{SS}.

Remark If the device is used in an application where noise generated from the microcontroller must be reduced, it is recommended to suppress noise by supplying power separately to V_{DD} positive power supply for ports and V_{DD} for pins other than ports, and by separately connecting V_{SS} (ground) for ports potential V_{SS} for pins other than ports. Make sure that V_{DD} for ports and V_{DD} for pins other than ports are the same potential. In addition, V_{SS} for ports and V_{SS} for pins other than ports must be also the same potential.

In the μPD784214AGC, 784215AGC, 784216AGC, 784217AGC, 784218AGC, 78F4216AGC, 78F4218AGC, 784214AYGC, 784215AYGC, 784216AYGC, 784217AYGC, 784218AYGC, 78F4216AYGC, and 78F4218AYGC

Positive power V _{DD} for ports:	Pin 81
Positive power V _{DD} for pins other than ports:	Pin 9
Ground potential V _{SS} for ports:	Pin 72
Ground potential V _{SS} for pins other than ports:	Pin 12

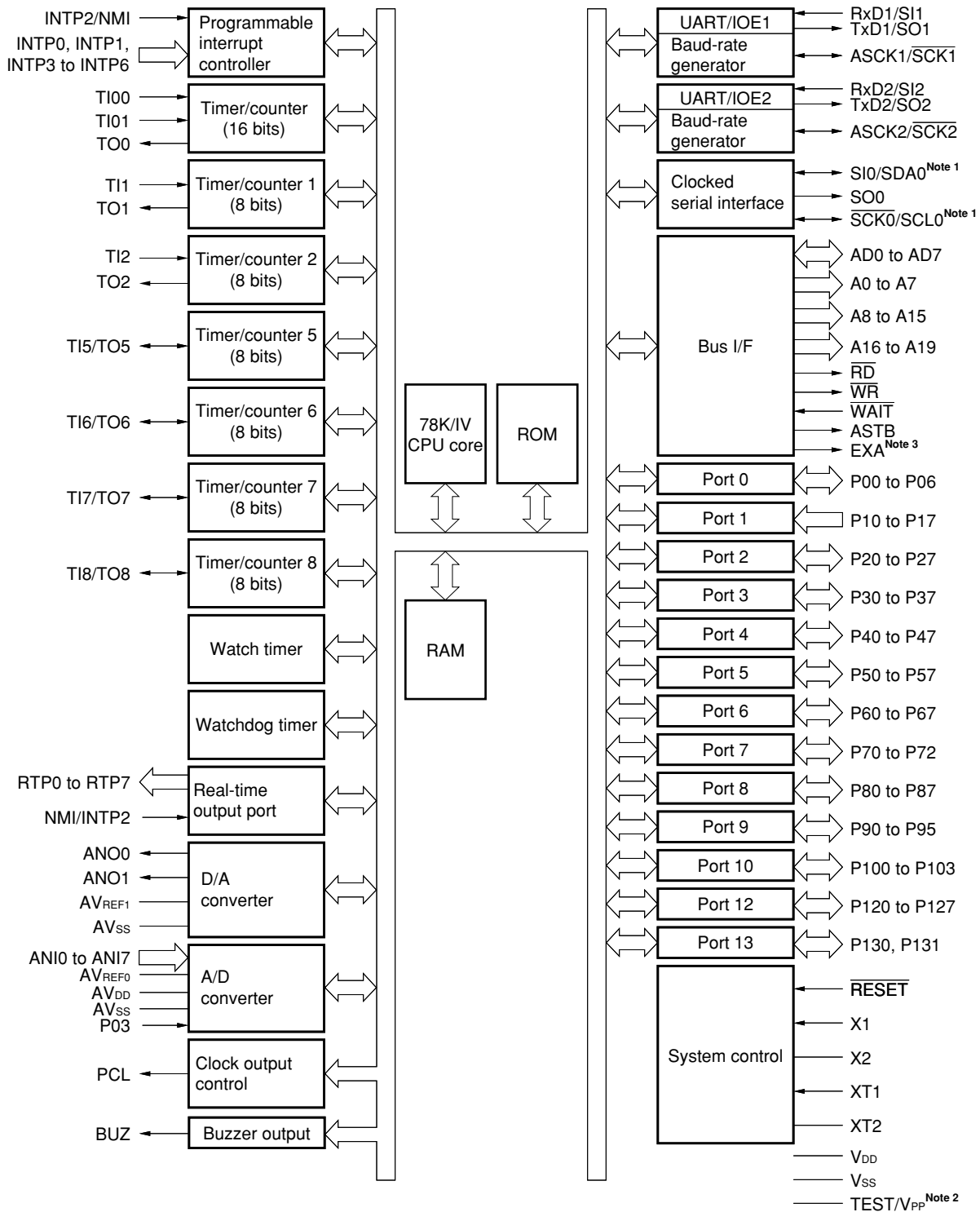
In the μPD784214AGF, 784215AGF, 784216AGF, 784217AGF, 784218AGF, 78F4216AGF, 78F4218AGF, 784214AYGF, 784215AYGF, 784216AYGF, 784217AYGF, 784218AYGF, 78F4216AYGF, and 78F4218AYGF

Positive power V _{DD} for ports:	Pin 9
Positive power V _{DD} for pins other than ports:	Pin 37
Ground potential V _{SS} for ports:	Pin 100
Ground potential V _{SS} for pins other than ports:	Pin 40

A0 to A19:	Address bus	P120 to P127:	Port 12
AD0 to AD7:	Address/data bus	P130, P131:	Port 13
ANI0 to ANI7:	Analog input	PCL:	Programmable clock
ANO0, ANO1:	Analog output	\overline{RD} :	Read strobe
ASCK1, ASCK2:	Asynchronous serial clock	\overline{RESET} :	Reset
ASTB:	Address strobe	RTP0 to RTP7:	Real-time output port
AV _{DD} :	Analog power supply	RxD1, RxD2:	Receive data
AV _{REF0} , AV _{REF1} :	Analog reference voltage	$\overline{SCK0}$ to $\overline{SCK2}$:	Serial clock
AV _{SS} :	Analog ground	SCL0 ^{Note 1} :	Serial clock
BUZ:	Buzzer clock	SDA0 ^{Note 1} :	Serial data
EXA ^{Note 3} :	External access status output	SI0 to SI2:	Serial input
INTP0 to INTP6:	Interrupt from peripherals	SO0 to SO2:	Serial output
NMI:	Non-maskable interrupt	TEST:	Test
P00 to P06:	Port 0	TI00, TI01,	
P10 to P17:	Port 1	TI1, TI2, TI5 to TI8:	Timer input
P20 to P27:	Port 2	TO0 to TO2, TO5 to TO8:	Timer output
P30 to P37:	Port 3	TxD1, TxD2:	Transmit data
P40 to P47:	Port 4	V _{DD} :	Power supply
P50 to P57:	Port 5	V _{PP} ^{Note 2} :	Programming power supply
P60 to P67:	Port 6	V _{SS} :	Ground
P70 to P72:	Port 7	\overline{WAIT} :	Wait
P80 to P87:	Port 8	\overline{WR} :	Write strobe
P90 to P95:	Port 9	X1, X2:	Crystal (Main system clock)
P100 to P103:	Port 10	XT1, XT2:	Crystal (Subsystem clock)

- Notes**
1. The SDA0 and SCL0 pins are provided only for the μ PD784216AY, 784218AY Subseries.
 2. The V_{PP} pin is provided only for the μ PD78F4216A, 78F4218A, 78F4216AY, and 78F4218AY.
 3. The EXA pin is provided only for the μ PD784218A, 784218AY Subseries.

1.4 Block Diagram



- Notes**
1. The SDA0 and SCL0 pins are provided only for the μ PD784216AY, 784218AY Subseries.
 2. The V_{PP} pin is provided only for the μ PD78F4216A, 78F4218A, 78F4216AY, and 78F4218AY.
 3. The EXA pin is provided only for the μ PD784218A, 784218AY Subseries.

Remark The on-chip ROM capacity differs depending on the product.

1.5 Function List

(1/2)

Item		Product Name								
		μ PD784214A	μ PD784215A	μ PD784216A	μ PD78F4216A	μ PD78F4217A	μ PD784218A	μ PD78F4218A		
		μ PD784214AY	μ PD784215AY	μ PD784216AY	μ PD78F4216AY	μ PD78F4217AY	μ PD784218AY	μ PD78F4218AY		
Number of basic instructions (mnemonics)		113								
General-purpose registers		8 bits \times 16 registers \times 8 banks or 16 bits \times 8 registers \times 8 banks (memory mapping)								
Minimum instruction execution time		<ul style="list-style-type: none"> 160 ns (12.5 MHz operation with main system clock) 61 μs (32.768 kHz operation with subsystem clock) 								
Internal memory	ROM	96 KB (mask ROM)	128 KB (mask ROM)	128 KB (flash memory)	192 KB (mask ROM)	256 KB (mask ROM)	256 KB (flash memory)			
	RAM	3,584 bytes	5,120 bytes	8,192 bytes	12,800 bytes					
Memory space		1 MB of combined program and data								
I/O ports	Total	86								
	CMOS inputs	8								
	CMOS I/O	72								
	N-ch open-drain I/O	6								
Pins with added functions ^{Note}	Pins with pull-up resistors	70								
	LED direct drive outputs	22								
	Medium voltage pins	6								
Real-time output ports		4 bits \times 2 or 8 bits \times 1								
Timer/event counters		Timer/event counter: Timer counter \times 1 (16 bits)				Capture/compare register \times 2				<ul style="list-style-type: none"> Pulse output available PPG output Square wave output One-shot pulse output
		Timer/event counter 1: Timer counter \times 1 (8 bits)				Compare register \times 1				<ul style="list-style-type: none"> Pulse output available PWM output Square wave output
		Timer/event counter 2: Timer counter \times 1 (8 bits)				Compare register \times 1				<ul style="list-style-type: none"> Pulse output available PWM output Square wave output
		Timer/event counter 5: Timer counter \times 1 (8 bits)				Compare register \times 1				<ul style="list-style-type: none"> Pulse output available PWM output Square wave output
		Timer/event counter 6: Timer counter \times 1 (8 bits)				Compare register \times 1				<ul style="list-style-type: none"> Pulse output available PWM output Square wave output
		Timer/event counter 7: Timer counter \times 1 (8 bits)				Compare register \times 1				<ul style="list-style-type: none"> Pulse output available PWM output Square wave output
		Timer/event counter 8: Timer counter \times 1 (8 bits)				Compare register \times 1				<ul style="list-style-type: none"> Pulse output available PWM output Square wave output

Note The pins with added functions are included in the I/O pins.

Item	Product Name		μ PD784214A	μ PD784215A	μ PD784216A	μ PD78F4216A	μ PD78F4217A	μ PD784218A	μ PD78F4218A	
			μ PD784214AY	μ PD784215AY	μ PD784216AY	μ PD78F4216AY	μ PD78F4217AY	μ PD784218AY	μ PD78F4218AY	
Serial interfaces	<ul style="list-style-type: none"> • UART/IOE (3-wire serial I/O): 2 channels (on-chip baud rate generator) • CSI (3-wire serial I/O, multimaster compatible I²C bus^{Note}): 1 channel 									
A/D converter	8-bit resolution \times 8 channels									
D/A converter	8-bit resolution \times 2 channels									
Clock output	Select from f_{xx} , $f_{xx}/2$, $f_{xx}/2^2$, $f_{xx}/2^3$, $f_{xx}/2^4$, $f_{xx}/2^5$, $f_{xx}/2^6$, $f_{xx}/2^7$, and f_{XT}									
Buzzer output	Select from $f_{xx}/2^{10}$, $f_{xx}/2^{11}$, $f_{xx}/2^{12}$, and $f_{xx}/2^{13}$									
Watch timer	1 channel									
Watchdog timer	1 channel									
Standby	<ul style="list-style-type: none"> • HALT, STOP, and IDLE modes • In the low power consumption mode (CPU operation with subsystem clock): HALT and IDLE modes 									
Interrupts	Hardware source	29 (internal: 20, external: 9)								
	Software source	BRK instruction, BRKCS instruction, and operand error								
	Non-maskable	Internal: 1, external: 1								
	Maskable	Internal: 19, external: 8								
		<ul style="list-style-type: none"> • 4-level programmable priority • Three processing formats: Vectored interrupt, macro service, and context switching 								
Power supply voltage	$V_{DD} = 1.8$ to 5.5 V		$V_{DD} = 1.9$ to 5.5 V		$V_{DD} = 1.8$ to 5.5 V		$V_{DD} = 1.9$ to 5.5 V			
Package	<ul style="list-style-type: none"> • 100-pin plastic LQFP (fine pitch) (14 \times 14) • 100-pin plastic QFP (14 \times 20) 									

Note Only in the μ PD784216AY, 784218AY Subseries

1.6 Differences Between Models in μ PD784216A, 784216AY/784218A, 784218AY Subseries

The only difference between the μ PD784214A, 784215A, 784216A, 784217A, and 784218A line is the internal memory capacity.

The μ PD784214AY, 784215AY, 784216AY, 784217AY, and 784218AY are models with the addition of an I²C bus control function.

The μ PD78F4216A, 78F4216AY, 78F4218A, and 78F4218AY are provided with a 128 KB/256 KB flash memory instead of the mask ROM of the above models. These differences are summarized in Table 1-1.

Table 1-1. Differences Between Models in μ PD784216A, 784216AY/784218A, 784218AY Subseries

Part Number Item	μ PD784214A, μ PD784214AY	μ PD784215A, μ PD784215AY	μ PD784216A, μ PD784216AY	μ PD784217A, μ PD784217AY	μ PD784218A, μ PD784218AY	μ PD78F4216A, μ PD78F4216AY	μ PD78F4218A, μ PD78F4218AY
Internal ROM	96 KB (mask ROM)	128 KB (mask ROM)		192 KB (mask ROM)	256 KB (mask ROM)	128 KB (flash memory)	256 KB (flash memory)
Internal RAM	3,584 bytes	5,120 bytes	8,192 bytes	12,800 bytes		8,192 bytes	12,800 bytes
Internal memory size switching register (IMS)	Not provided					Provided ^{Note}	
ROM correction	Not provided			Provided		Not provided	Provided
External access status function	Not provided			Provided		Not provided	Provided
Supply voltage	V _{DD} = 1.8 to 5.5 V					V _{DD} = 1.9 to 5.5 V	
Electrical specifications	Refer to the chapters of electrical specifications and recommended soldering conditions.						
Recommended soldering conditions							
EXA pin	Not provided			Provided		Not provided	Provided
TEST pin	Provided					Not provided	
V _{PP} pin	Not provided					Provided	

Note The internal flash memory capacity and internal RAM capacity can be changed using the internal memory size switching register (IMS).

Caution There are differences in noise immunity and noise radiation between the flash memory and mask ROM versions. When pre-producing an application set with the flash memory version and then mass-producing it with the mask ROM version, be sure to conduct sufficient evaluations on the commercial samples (not engineering samples) of the mask ROM version.

CHAPTER 2 PIN FUNCTIONS

2.1 Pin Function List

(1) Port pins (1/3)

Pin Symbol	I/O	Alternate Function	Function
P00	I/O	INTP0	Port 0 (P0): <ul style="list-style-type: none"> • 7-bit I/O port • Input/output can be specified in 1-bit units • Regardless of whether the input or output mode is specified, on-chip pull-up resistor connection can be specified by the setting of software in 1-bit units
P01		INTP1	
P02		INTP2/NMI	
P03		INTP3	
P04		INTP4	
P05		INTP5	
P06		INTP6	
P10 to P17	Input	ANI0 to ANI7	Port 1 (P1): <ul style="list-style-type: none"> • 8-bit dedicated input port
P20	I/O	RxD1/SI1	Port 2 (P2): <ul style="list-style-type: none"> • 8-bit I/O port • Input/output can be specified in 1-bit units • Regardless of whether the input or output mode is specified, on-chip pull-up resistor connection can be specified by the setting of software in 1-bit units
P21		TxD1/SO1	
P22		ASCK1/ $\overline{\text{SCK1}}$	
P23		PCL	
P24		BUZ	
P25		SI0/SDA0 ^{Note 1}	
P26		SO0	
P27		$\overline{\text{SCK0}}$ /SCL0 ^{Note 1}	
P30	I/O	TO0	Port 3 (P3): <ul style="list-style-type: none"> • 8-bit I/O port • Input/output can be specified in 1-bit units • Regardless of whether the input or output mode is specified, on-chip pull-up resistor connection can be specified by the setting of software in 1-bit units
P31		TO1	
P32		TO2	
P33		TI1	
P34		TI2	
P35		TI00	
P36		TI01	
P37		EXA ^{Note 2}	
P40 to P47	I/O	AD0 to AD7	Port 4 (P4): <ul style="list-style-type: none"> • 8-bit I/O port • Input/output can be specified in 1-bit units • For input mode pins, on-chip pull-up resistor connection can be specified for all bits at once by the setting of software • LED can be driven directly

Notes 1. The SDA0 and SCL0 pins are provided only for the μ PD784216AY, 784218AY Subseries.

2. The EXA pin is provided only for the μ PD784218A, 784218AY Subseries.

(1) Port Pins (2/3)

Pin Symbol	I/O	Alternate Function	Function
P50 to P57	I/O	A8 to A15	Port 5 (P5): <ul style="list-style-type: none"> • 8-bit I/O port • Input/output can be specified in 1-bit units • For input mode pins, on-chip pull-up resistor connection can be specified for all bits at once by the setting of software • LED can be driven directly
P60	I/O	A16	Port 6 (P6): <ul style="list-style-type: none"> • 8-bit I/O port • Input/output can be specified in 1-bit units • For input mode pins, on-chip pull-up resistor connection can be specified for all bits at once by the setting of software
P61		A17	
P62		A18	
P63		A19	
P64		$\overline{\text{RD}}$	
P65		$\overline{\text{WR}}$	
P66		$\overline{\text{WAIT}}$	
P67		ASTB	
P70	I/O	RxD2/SI2	Port 7 (P7): <ul style="list-style-type: none"> • 3-bit I/O port • Input/output can be specified in 1-bit units • Regardless of whether the input or output mode is specified, on-chip pull-up resistor connection can be specified by the setting of software in 1-bit units
P71		TxD2/SO2	
P72		ASCK2/ $\overline{\text{SCK2}}$	
P80 to P87	I/O	A0 to A7	Port 8 (P8): <ul style="list-style-type: none"> • 8-bit I/O port • Input/output can be specified in 1-bit units • Regardless of whether the input or output mode is specified, on-chip pull-up resistor connection can be specified by the setting of software in 1-bit units • Interrupt control flag (KRIF) is set to 1 by detecting the falling edge
P90 to P95	I/O	—	Port 9 (P9): <ul style="list-style-type: none"> • N-channel open drain medium voltage I/O port • 6-bit I/O port • Input/output can be specified in 1-bit units • LED can be driven directly
P100	I/O	TI5/TO5	Port 10 (P10): <ul style="list-style-type: none"> • 4-bit I/O port • Input/output can be specified in 1-bit units • Regardless of whether the input or output mode is specified, on-chip pull-up resistor connection can be specified by the setting of software in 1-bit units
P101		TI6/TO6	
P102		TI7/TO7	
P103		TI8/TO8	

(1) Port Pins (3/3)

Pin Symbol	I/O	Alternate Function	Function
P120 to P127	I/O	RTP0 to RTP7	Port 12 (P12): <ul style="list-style-type: none"> • 8-bit I/O port • Input/output can be specified in 1-bit units • Regardless of whether the input or output mode is specified, on-chip pull-up resistor connection can be specified by the setting of software in 1-bit units
P130, P131	I/O	ANO0, ANO1	Port 13 (P13): <ul style="list-style-type: none"> • 2-bit I/O port • Input/output can be specified in 1-bit units

(2) Non-port pins (1/2)

Pin Symbol	I/O	Alternate Function	Function
TI00	Input	P35	External count clock input to 16-bit timer counter
TI01		P36	Capture trigger signal input to capture/compare register 00
TI1		P33	External count clock input to 8-bit timer counter 1
TI2		P34	External count clock input to 8-bit timer counter 2
TI5		P100/TO5	External count clock input to 8-bit timer counter 5
TI6		P101/TO6	External count clock input to 8-bit timer counter 6
TI7		P102/TO7	External count clock input to 8-bit timer counter 7
TI8		P103/TO8	External count clock input to 8-bit timer counter 8
TO0	Output	P30	16-bit timer output (shared with 14-bit PWM output)
TO1		P31	8-bit timer output (shared with 8-bit PWM output)
TO2		P32	
TO5		P100/TI5	
TO6		P101/TI6	
TO7		P102/TI7	
TO8		P103/TI8	
RxD1	Input	P20/SI1	Serial data input (UART1)
RxD2		P70/SI2	Serial data input (UART2)
TxD1	Output	P21/SO1	Serial data output (UART1)
TxD2		P71/SO2	Serial data output (UART2)
ASCK1	Input	P22/ $\overline{\text{SCK1}}$	Baud rate clock input (UART1)
ASCK2		P72/ $\overline{\text{SCK2}}$	Baud rate clock input (UART2)
SI0	Input	P25/SDA0 ^{Note}	Serial data input (3-wire serial I/O0)
SI1		P20/RxD1	Serial data input (3-wire serial I/O1)
SI2		P70/RxD2	Serial data input (3-wire serial I/O2)
SO0	Output	P26	Serial data output (3-wire serial I/O0)
SO1		P21/TxD1	Serial data output (3-wire serial I/O1)
SO2		P71/TxD2	Serial data output (3-wire serial I/O2)
SDA0 ^{Note}	I/O	P25/SI0	Serial data I/O (I ² C bus)
$\overline{\text{SCK0}}$		P27/SCL0 ^{Note}	Serial clock I/O (3-wire serial I/O0)
$\overline{\text{SCK1}}$		P22/ASCK1	Serial clock I/O (3-wire serial I/O1)
$\overline{\text{SCK2}}$		P72/ASCK2	Serial clock I/O (3-wire serial I/O2)
SCL0 ^{Note}		P27/ $\overline{\text{SCK0}}$	Serial clock I/O (I ² C bus)

Note The SDA0 and SCL0 pins are provided only for the μ PD784216AY, 784218AY Subseries.

(2) Non-port pins (2/2)

Pin Symbol	I/O	Alternate Function	Function	
NMI	Input	P02/INTP2	Non-maskable interrupt request input	
INTP0		P00	External interrupt request input	
INTP1		P01		
INTP2		P02/NMI		
INTP3		P03		
INTP4		P04		
INTP5		P05		
INTP6		P06		
PCL	Output	P23		Clock output (for trimming main system clock and subsystem clock)
BUZ		P24	Buzzer output	
RTP0 to RTP7		P120 to P127	Real-time output port that outputs data synchronized with the trigger	
AD0 to AD7	I/O	P40 to P47	Low-order address/data bus when the memory is externally expanded	
A0 to A7	Output	P80 to P87	Low-order address bus when the memory is externally expanded	
A8 to A15		P50 to P57	Middle-order address bus when the memory is externally expanded	
A16 to A19		P60 to P63	High-order address bus when the memory is externally expanded	
\overline{RD}		P64	Strobe signal output for external memory read operation	
\overline{WR}		P65	Strobe signal output for external memory write operation	
\overline{WAIT}		Input	P66	Wait insertion during external memory access
ASTB	Output	P67	Strobe output that externally latches the address information that is output to ports 4 to 6, and port 8 in order to access external memory	
EXA ^{Note 1}		P37	Status signal output during external memory access	
\overline{RESET}	Input	—	System reset input	
X1		—	Crystal connection for main system clock oscillation	
X2		—		
XT1	Input	—	Crystal connection for subsystem clock oscillation	
XT2		—		
ANI0 to ANI7	Input	P10 to P17	Analog voltage input to A/D converter	
ANO0, ANO1	Output	P130, P131	Analog voltage output to D/A converter	
AV _{REF0}	—	—	Reference voltage applied to A/D converter	
AV _{REF1}			Reference voltage applied to D/A converter	
AV _{DD}			Positive power supply to A/D converter. Connect to V _{DD} .	
AV _{SS}			Ground for A/D converter and D/A converter. Connect to V _{SS} .	
V _{DD}			Positive power supply	
V _{SS}			GND	
TEST			V _{PP} ^{Note 2}	Connect directly to V _{SS} or via a pull-down resistor. For the pull-down connection, use of a resistor with a resistance between 470 Ω and 10 kΩ is recommended.
V _{PP} ^{Note 2}			TEST	Flash memory programming mode setting High voltage application pin during program write/verify

Notes 1. The EXA pin is provided only for the μPD784218A, 784218AY Subseries.

2. The V_{PP} pin is provided only for the μPD78F4216A, 784218A, 78F4216AY, and 78F4218AY.

2.2 Pin Function Description

(1) P00 to P06 (Port 0)

This port is a 7-bit I/O port. In addition to being an I/O port, this port has an external interrupt request input function. The following operating modes are selectable in 1-bit units.

(a) Port mode

This port functions as a 7-bit I/O port. It can be specified as input port or output port in 1-bit units using the port 0 mode register. Regardless of whether input or output mode is specified, pull-up resistors can be connected in 1-bit units using pull-up resistor option register 0.

(b) Control mode

The port functions as an external interrupt request input.

(i) INTP0 to INTP6

INTP0 to INTP6 are external interrupt request input pins that can select the valid edge (rising edge, falling edge, or both rising and falling edges). The valid edge can be specified by the external interrupt rising edge enable register and the external interrupt falling edge enable register. INTP2 also becomes the external trigger signal input pin of the real-time output port by the valid edge input.

(ii) NMI

This is the external non-maskable interrupt request input pin. The valid edge can be specified by the external interrupt rising edge enable register and the external interrupt falling edge enable register.

(2) P10 to P17 (Port 1)

This port is an 8-bit dedicated input port. In addition to being a general-purpose input port, this port functions as the analog input for the A/D converter.

It does not have on-chip pull-up resistors.

(a) Port mode

The port functions as an 8-bit dedicated input port.

(b) Control mode

The port functions as the analog input pins (ANI0 to ANI7) of the A/D converter. The values are undefined when the pins specified for analog input are read.

(3) P20 to P27 (Port 2)

This port is an 8-bit I/O port. In addition to being an I/O port, this port has the data I/O function, clock I/O function, clock output function, and output buzzer function of the serial interface.

The following operating modes are selectable in 1-bit units.

(a) Port mode

This port functions as an 8-bit I/O port. It can be specified as input port or output port in 1-bit units using the port 2 mode register. Regardless of whether input or output mode is specified, pull-up resistors can be connected in 1-bit units using pull-up resistor option register 2.

(b) Control mode

This port functions as the data I/O pins, clock I/O pins, clock output pins, and buzzer output pins of the serial interface.

Pins P25 and P27 can be specified in the N-channel open drain by the port function control register (PF2) (only in the μ PD784216AY, 784218AY Subseries).

(i) SI0, SI1, SO0, SO1, SDA0

These pins are the I/O pins for serial data in the serial interface.

The SDA0 pin is provided only for the μ PD784216AY, 784218AY Subseries.

(ii) $\overline{\text{SCK0}}$, $\overline{\text{SCK1}}$, SCL0

These pins are the I/O pins for the serial clock of the serial interface.

The SCL0 pin is provided only for the μ PD784216AY, 784218AY Subseries.

(iii) RxD1, TxD1

These pins are the I/O pins for serial data in the asynchronous serial interface.

(iv) ASCK1

This is the I/O pin for the baud rate clock of the asynchronous serial interface.

(v) PCL

This is the clock output pin.

(vi) BUZ

This is the buzzer output pin.

(4) P30 to P37 (Port 3)

This port is an 8-bit I/O port. In addition to being an I/O port, this port has the timer I/O function and the external access status output function.

The following operating modes are selectable in 1-bit units.

(a) Port mode

The port functions as an 8-bit I/O port. It can be specified as input port or output port in 1-bit units using the port 3 mode register. Regardless of whether input or output mode is specified, pull-up resistors can be connected in 1-bit units using pull-up resistor option register 3.

(b) Control mode

The port functions as timer I/O and external access status output.

(i) T100

This is the external clock input pin to the 16-bit timer/counter.

(ii) T101

This is the capture trigger signal input pin to capture/compare register 00.

(iii) T11, T12

These are the external clock input pins to the 8-bit timer/counter.

(iv) T00 to T02

These are timer output pins.

(v) EXA

This is the external access status output pin.

The EXA pin is provided only for the μ PD784218A, 784218AY Subseries.

(5) P40 to P47 (Port 4)

This is an 8-bit I/O port. In addition to being an I/O port, this port has the address/data bus function. LED can be driven directly.

The following operating modes are selectable in 1-bit units.

(a) Port mode

This port functions as an 8-bit I/O port. It can be specified as input port or output port in 1-bit units using the port 4 mode register. When used as an input port, pull-up resistors can be connected in 8-bit units with bit 4 of the pull-up resistor option register (PUO4).

(b) Control mode

The port functions as the low-order address/data bus pins (AD0 to AD7) when in the external memory expansion mode. If PUO4 = 1, pull-up resistors can be connected.

(6) P50 to P57 (Port 5)

This port is an 8-bit I/O port. In addition to being an I/O port, it has the address bus function. LED can be driven directly.

The following operating modes are selectable in 1-bit units.

(a) Port mode

The port functions as an 8-bit I/O port. It can be specified as input port or output port in 1-bit units using the port 5 mode register. When used as an input port, pull-up resistors can be connected in 8-bit units with bit 5 of the pull-up resistor option register (PUO5).

(b) Control mode

The port functions as the middle-order address bus pins (A8 to A15) when in the external memory expansion mode. If PUO5 = 1, pull-up resistors can be connected.

(7) P60 to P67 (Port 6)

This port is an 8-bit I/O port. In addition to being an I/O port, this port has the address bus function and control function when in the external memory expansion mode.

The following operating modes are selectable in 1-bit units.

(a) Port mode

The port functions as an 8-bit I/O port. It can be specified as input port or output port in 1-bit units using the port 6 mode register. When used as an input port, pull-up resistors can be connected in 8-bit units with bit 6 of the pull-up resistor option register (PUO6).

(b) Control mode

P60 to P63 function as the high-order address bus pins (A16 to A19) in the external memory expansion mode. P64 to P67 function as the control signal output pins ($\overline{\text{RD}}$, $\overline{\text{WR}}$, $\overline{\text{WAIT}}$, ASTB) in the external memory expansion mode. If PUO6 = 1 in the external memory expansion mode, the pull-up resistors can be connected.

Caution When external waits are not used during the external memory expansion mode, P66 can be used as an I/O port.

(8) P70 to P72 (Port 7)

This is a 3-bit I/O port. In addition to being an I/O port, this port has the data I/O and clock I/O functions of the serial interface.

The following operating modes are selectable in 1-bit units.

(a) Port mode

The port functions as a 3-bit I/O port. It can be specified as input port or output port in 1-bit units using the port 7 mode register. Regardless of whether input or output mode is specified, pull-up resistors can be connected in 1-bit units using pull-up resistor option register 7.

(b) Control mode

The port functions as data I/O and clock I/O of the serial interface.

(i) SI2, SO2

These are the I/O pins for serial data of the serial interface.

(ii) $\overline{\text{SCK2}}$

This is the I/O pin for the serial clock in the serial interface.

(iii) RxD2, TxD2

These are the serial data I/O pins of the asynchronous serial interface.

(iv) ASCK2

This is baud rate clock input pin of the asynchronous serial interface.

(9) P80 to P87 (Port 8)

This port is an 8-bit I/O port. In addition to being an I/O port, this port has the address bus function.

By detecting the falling edge, the interrupt control flag (KRIF) can be set to 1.

The following operating modes are selectable in 1-bit units.

(a) Port mode

The port functions as an 8-bit I/O port. It can be specified as input port or output port in 1-bit units using the port 8 mode register. Regardless of whether input or output mode is specified, pull-up resistors can be connected in 1-bit units using pull-up resistor option register 8.

(b) Control mode

The port functions as the low-order address bus pins (A0 to A7) when in the external memory expansion mode. If $\text{PU8n} = 1$ ($n = 0$ to 7), pull-up resistors can be connected.

(10) P90 to P95 (Port 9)

This port is a 6-bit I/O port.

LED can be driven directly.

It can be specified as input port or output port in 1-bit units using the port 9 mode register.

This is the N-channel open drain medium voltage I/O port.

It does not have on-chip pull-up resistors.

(11) P100 to P103 (Port 10)

This port is a 4-bit I/O port. In addition to being an I/O port, this port has the timer I/O function.

The following operating modes are selectable in 1-bit units.

(a) Port mode

The port functions as a 4-bit I/O port. It can be specified as input port or output port in 1-bit units. Regardless of whether input or output mode is specified, pull-up resistors can be connected in 1-bit units using pull-up resistor option register 10.

(b) Control mode

The port functions as the timer I/O port.

(i) TI5 to TI8

These are the external clock input pins for the 8-bit timer/counter.

(ii) TO5 to TO8

These are the timer output pins.

(12) P120 to P127 (Port 12)

This port is an 8-bit I/O port. In addition to being an I/O port, this port has the real-time output port function.

The following operating modes are selectable in 1-bit units.

(a) Port mode

The port functions as an 8-bit I/O port. It can be specified as input port or output port in 1-bit units using the port 12 mode register. Regardless of whether input or output mode is specified, pull-up resistors can be connected in 1-bit units using pull-up resistor option register 12.

(b) Control mode

The port functions as a real-time output port (RTP0 to RTP7) that outputs data synchronized with a trigger.

The pins specified as the real-time output port are read as 0.

(13) P130, P131 (Port 13)

This port is a 2-bit I/O port. In addition to being an I/O port, this port has the analog output function for the D/A converter.

The following operating modes can be specified in 2-bit units.

(a) Port mode

The port functions as a 2-bit I/O port. It can be specified as input port or output port in 1-bit units using the port 13 mode register.

It does not have on-chip pull-up resistors.

(b) Control mode

The port functions as the analog outputs (ANO0, ANO1) for the D/A converter. The values are undefined when the pins specified as analog output are read.

Caution If only one channel is used to the D/A converter when $AV_{REF1} < V_{DD}$, either of the following should be implemented for the pins that are not used as the analog output.

- Set 1 (input mode) for the port mode register (PM13 \times) and connect to V_{SS} .
- Set 0 (output mode) for the port mode register (PM13 \times). Set the output latch to 0 and output a low level.

(14) AV_{REF0}

This is the reference voltage input pin for the A/D converter.

If the A/D converter is not used, connect to V_{SS} .

(15) AV_{REF1}

This is the reference voltage input pin for the D/A converter.

If the D/A converter is not used, connect to V_{DD} .

(16) AV_{DD}

This is the analog voltage supply pin for the A/D converter. Even if the A/D converter is not used, always use this pin at the same potential as V_{DD} pin.

(17) AV_{SS}

This is the ground potential pin for the A/D converter. Even if the A/D converter is not used, always use this pin at the same potential as V_{SS} pin.

(18) \overline{RESET}

This is the active low system reset input pin.

(19) X1, X2

These are the crystal oscillator connection pins for main system clock oscillation.

When an external clock is supplied, input this clock signal to X1, and its inverted signal to X2.

(20) XT1, XT2

These are the crystal oscillator connection pins for subsystem clock oscillation.

When an external clock is supplied, input this clock signal to XT1, and its inverted signal to XT2.

(21) V_{DD}

This is the positive voltage supply pin.

(22) V_{SS}

This is the ground potential pin.

(23) V_{PP} (μ PD78F4216A, 78F4218A, 78F4216AY, 78F4218AY only)

This is the high-voltage application pin when setting the flash memory programming mode and writing or verifying the program.

In the normal operating mode, connect directly to V_{SS} or via a pull-down resistor. Connect a pull-down resistor to the V_{PP} pin in a system where the internal flash memory is rewritten on board. For the pull-down connection, use of a resistor with a resistance between 470 Ω and 10 k Ω is recommended.

(24) TEST

Connect directly to V_{SS} or via a pull-down resistor. For the pull-down connection, use of a resistor with a resistance between 470 Ω and 10 k Ω is recommended.

2.3 Pin I/O Circuit and Handling of Unused Pins

Table 2-1 shows the I/O circuit type for the pins and how to handle unused pins.
See Figure 2-1 for each type of I/O circuit.

Table 2-1. I/O Circuit Type for Each Pin and Handling Unused Pins (1/2)

Pin Symbol	I/O Circuit Type	I/O	Recommended Connection When Unused
P00/INTP0	8-N	I/O	Input: Connect to V _{SS} individually via a resistor. Output: Leave open.
P01/INTP1			
P02/INTP2/NMI			
P03/INTP3 to P06/INTP6			
P10/ANI0 to P17/ANI7	9	Input	Connect to V _{SS} or V _{DD} .
P20/RxD1/SI1	10-K	I/O	Input: Connect to V _{SS} individually via a resistor. Output: Leave open.
P21/TxD1/SO1	10-L		
P22/ASCK1/ $\overline{\text{SCK1}}$	10-K		
P23/PCL	10-L		
P24/BUZ			
P25/SDA0 ^{Note} /SI0	10-K		
P26/SO0	10-L		
P27/SCL0 ^{Note} / $\overline{\text{SCK0}}$	10-K		
P30/TO0 to P32/TO2	12-E		
P33/TI1, P34/TI2	8-N		
P35/TI00, P36/TI01	10-M		
P37/EXA	12-E		
P40/AD0 to P47/AD7	5-A		
P50/A8 to P57/A15			
P60/A16 to P63/A19			
P64/ $\overline{\text{RD}}$			
P64/ $\overline{\text{WR}}$			
P66/ $\overline{\text{WAIT}}$			
P67/ASTB			
P70/RxD2/SI2			
P71/TxD2/SO2	10-M		
P72/ASCK2/ $\overline{\text{SCK2}}$	8-N		
P80/A0 to P87/A7	12-E		
P90 to P95	13-D		

Note The SDA0 and SCL0 pins are provided only for the μ PD784216AY, 784218AY Subseries.

Table 2-1. I/O Circuit Type for Each Pin and Handling Unused Pins (2/2)

Pin Symbol	I/O Circuit Type	I/O	Recommended Connection When Unused
P100/TI5/TO5	8-N	I/O	Input: Connect to V _{SS} individually via a resistor. Output: Leave open.
P101/TI6/TO6			
P102/TI7/TO7			
P103/TI8/TO8			
P120/RTP0 to P127/RTP7	12-E		
P130/ANO0, P131/ANO1	12-F		
$\overline{\text{RESET}}$	12-G	Input	—
XT1	16	—	Connect to V _{SS} .
XT2			Leave open.
AV _{REF0}	—	—	Connect to V _{SS} .
AV _{REF1}			Connect to V _{DD} .
AV _{DD}			
AV _{SS}			Connect to V _{SS} .
TEST/V _{PP} ^{Note}			Connect directly to V _{SS} or via a pull-down resistor. For the pull-down connection, use of a resistor with a resistance between 470 Ω and 10 kΩ is recommended.

Note The V_{PP} pin is provided only for the μPD78F4216A, 78F4218A, 78F4216AY, and 78F4218AY.

Remark The type numbers are unified among the 78K Series, so they are not always serial within each product (there are some circuits that are not incorporated).

Figure 2-1. Pin I/O Circuit (1/2)

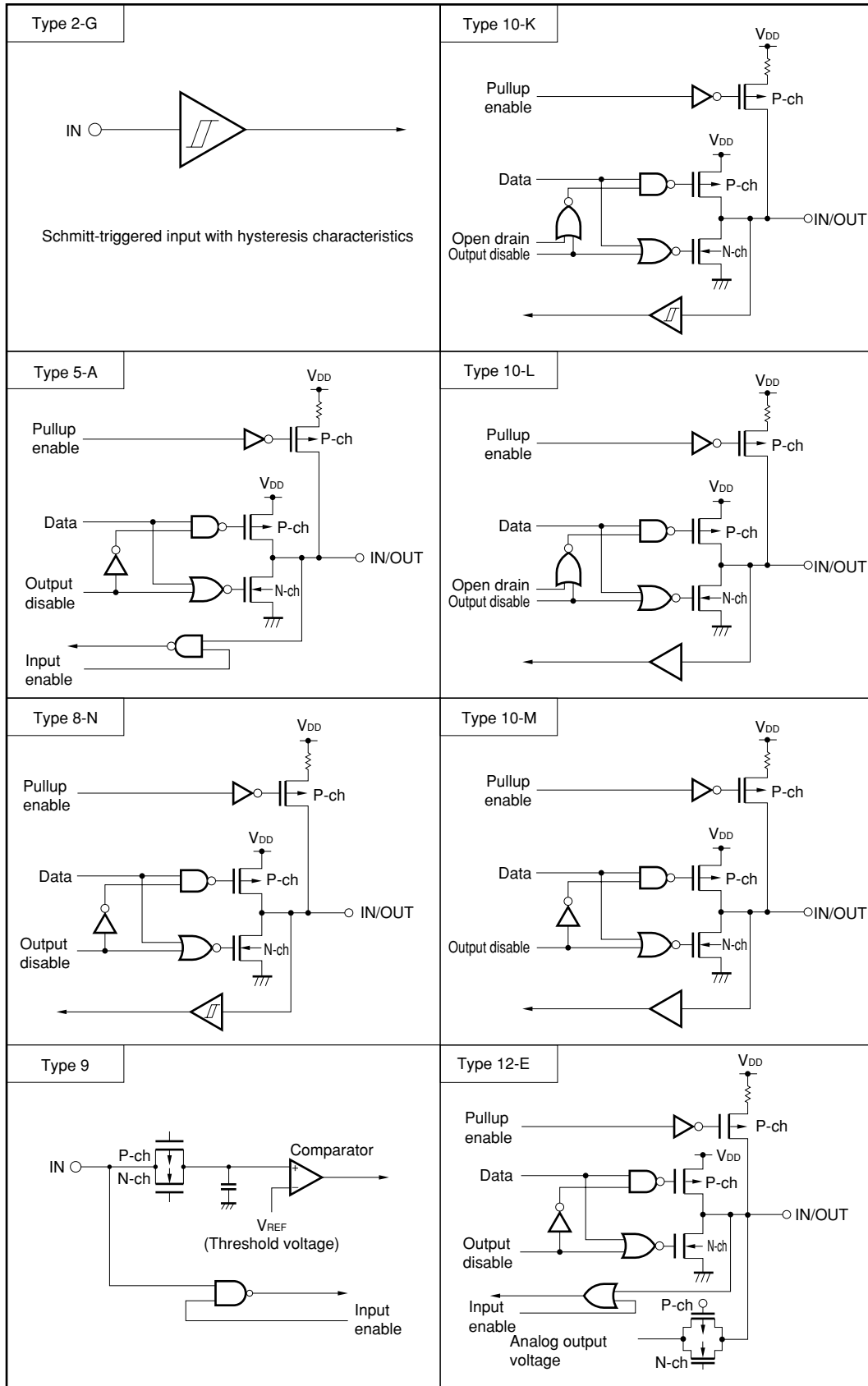
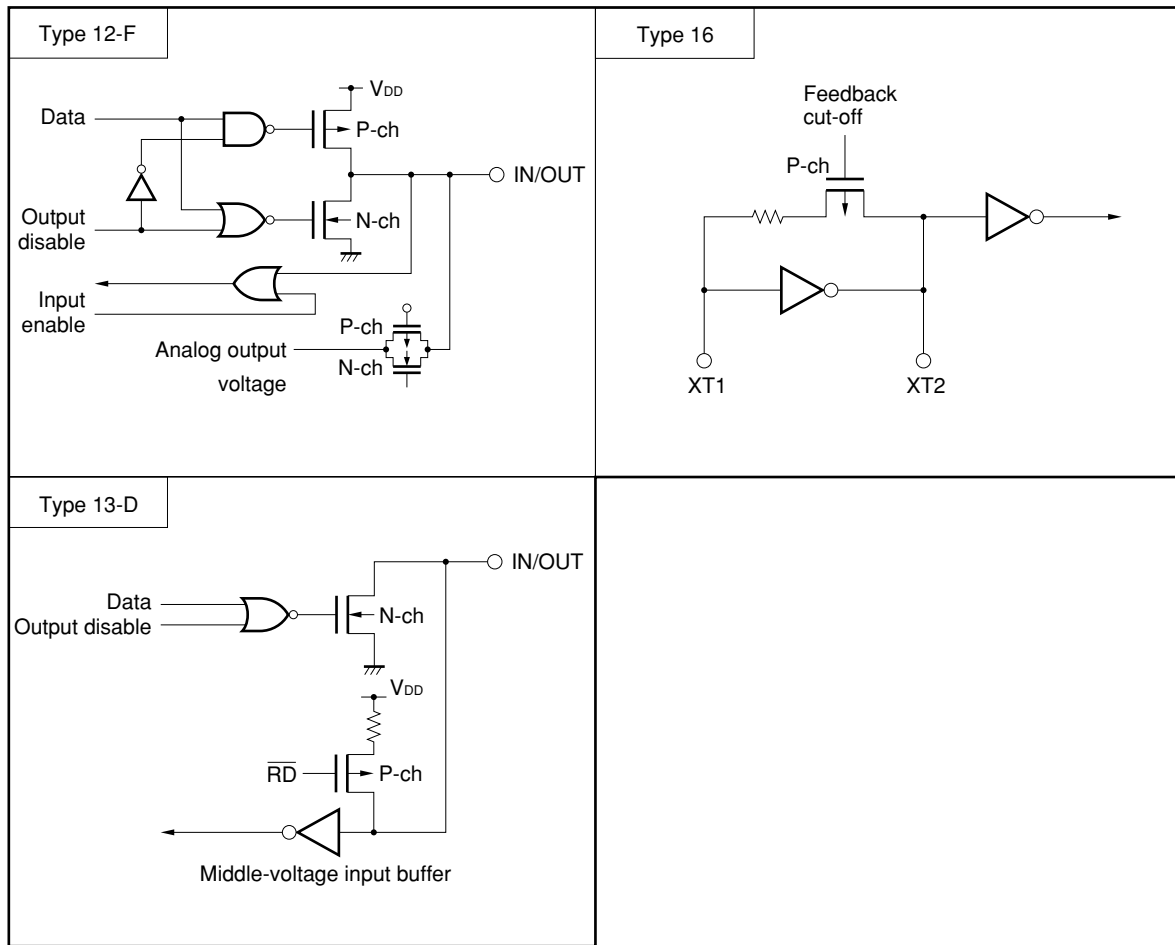


Figure 2-1. Pin I/O Circuit (2/2)



CHAPTER 3 CPU ARCHITECTURE

3.1 Memory Space

The μ PD784218A can access a 1 MB space. The mapping of the internal data area (special function register and internal RAM) differs depending on the LOCATION instruction. The LOCATION instruction must always be executed after releasing a reset and cannot be used more than once.

The program after releasing a reset must be as follows.

```
RSTVCT  CSEG AT 0
        DW  RSTSTRT
        :
INITSEG  CSEG BASE
RSTSTRT: LOCATION 0H; or LOCATION 0FH
        MOVG SP, #STKBGN
```

(1) When LOCATION 0H instruction is executed

- **Internal memory**

The internal data area and internal ROM area are mapped as follows.

Part Number	Internal Data Area	Internal ROM Area
μ PD784214A, μ PD784214AY	0F100H to 0FFFFH	00000H to 0F0FFH 10000H to 17FFFH
μ PD784215A, μ PD784215AY	0EB00H to 0FFFFH	00000H to 0EAFFH 10000H to 1FFFFH
μ PD784216A, μ PD784216AY	0DF00H to 0FFFFH	00000H to 0DEFFH 10000H to 1FFFFH
μ PD784217A, μ PD784217AY	0CD00H to 0FFFFH	00000H to 0CCFFH 10000H to 2FFFFH
μ PD784218A, μ PD784218AY		00000H to 0CCFFH 10000H to 3FFFFH

Caution The following areas that overlap the internal data area of the internal ROM cannot be used when the LOCATION 0H instruction is executed.

Part Number	Internal Data Area
μ PD784214A, μ PD784214AY	0F100H to 0FFFFH (3,840 bytes)
μ PD784215A, μ PD784215AY	0EB00H to 0FFFFH (5,376 bytes)
μ PD784216A, μ PD784216AY	0DF00H to 0FFFFH (8,448 bytes)
μ PD784217A, μ PD784217AY	0CD00H to 0FFFFH (13,056 bytes)
μ PD784218A, μ PD784218AY	

- **External memory**

The external memory is accessed in external memory expansion mode.

(2) When LOCATION 0FH instruction is executed

- **Internal memory**

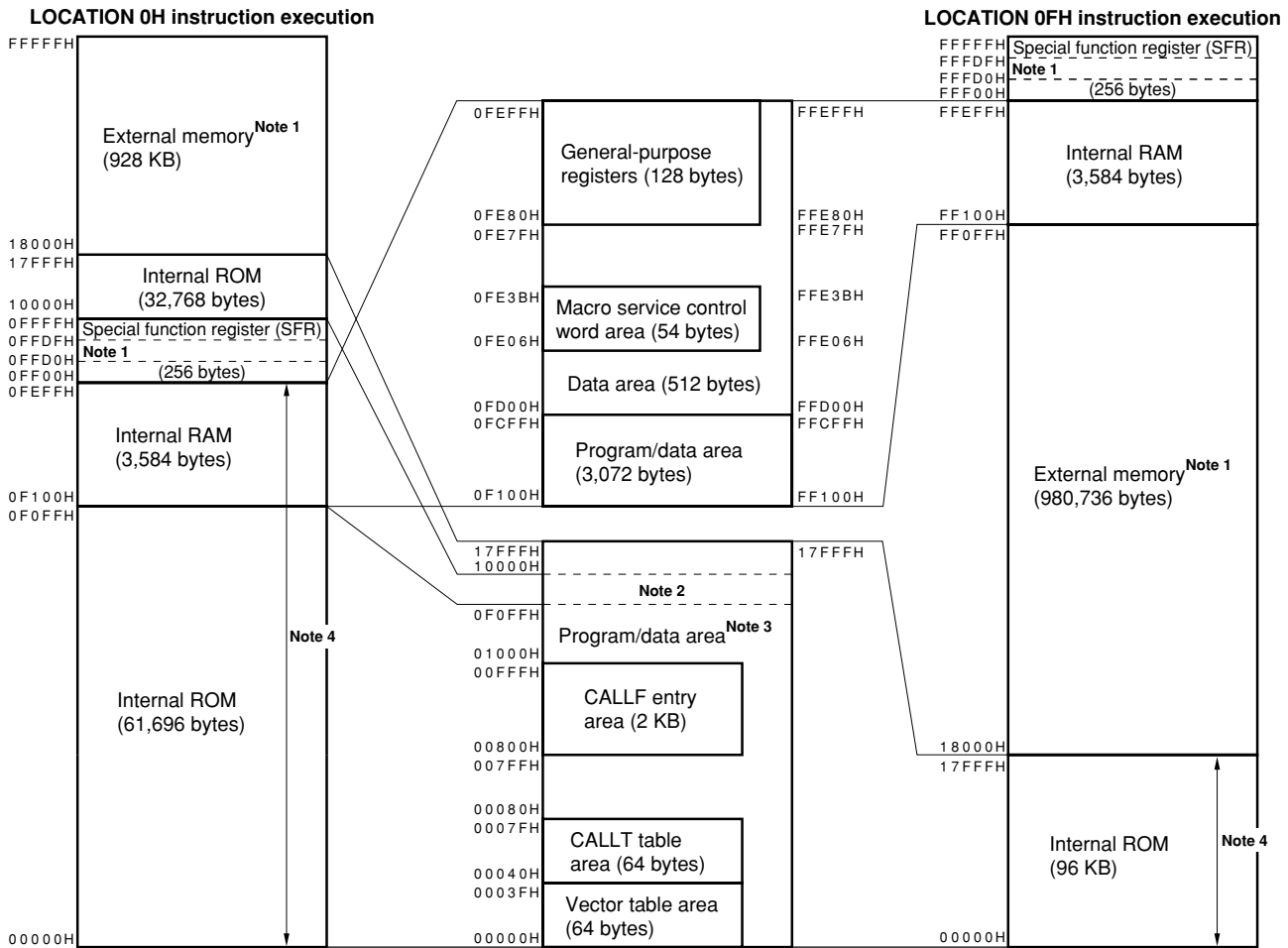
The internal data area and internal ROM area are mapped as follows.

Part Number	Internal Data Area	Internal ROM Area
μ PD784214A, μ PD784214AY	FF100H to FFFFFH	00000H to 17FFFH
μ PD784215A, μ PD784215AY	FEB00H to FFFFFH	00000H to 1FFFFH
μ PD784216A, μ PD784216AY	FDF00H to FFFFFH	00000H to 1FFFFH
μ PD784217A, μ PD784217AY	FCD00H to FFFFFH	00000H to 2FFFFH
μ PD784218A, μ PD784218AY		00000H to 3FFFFH

- **External memory**

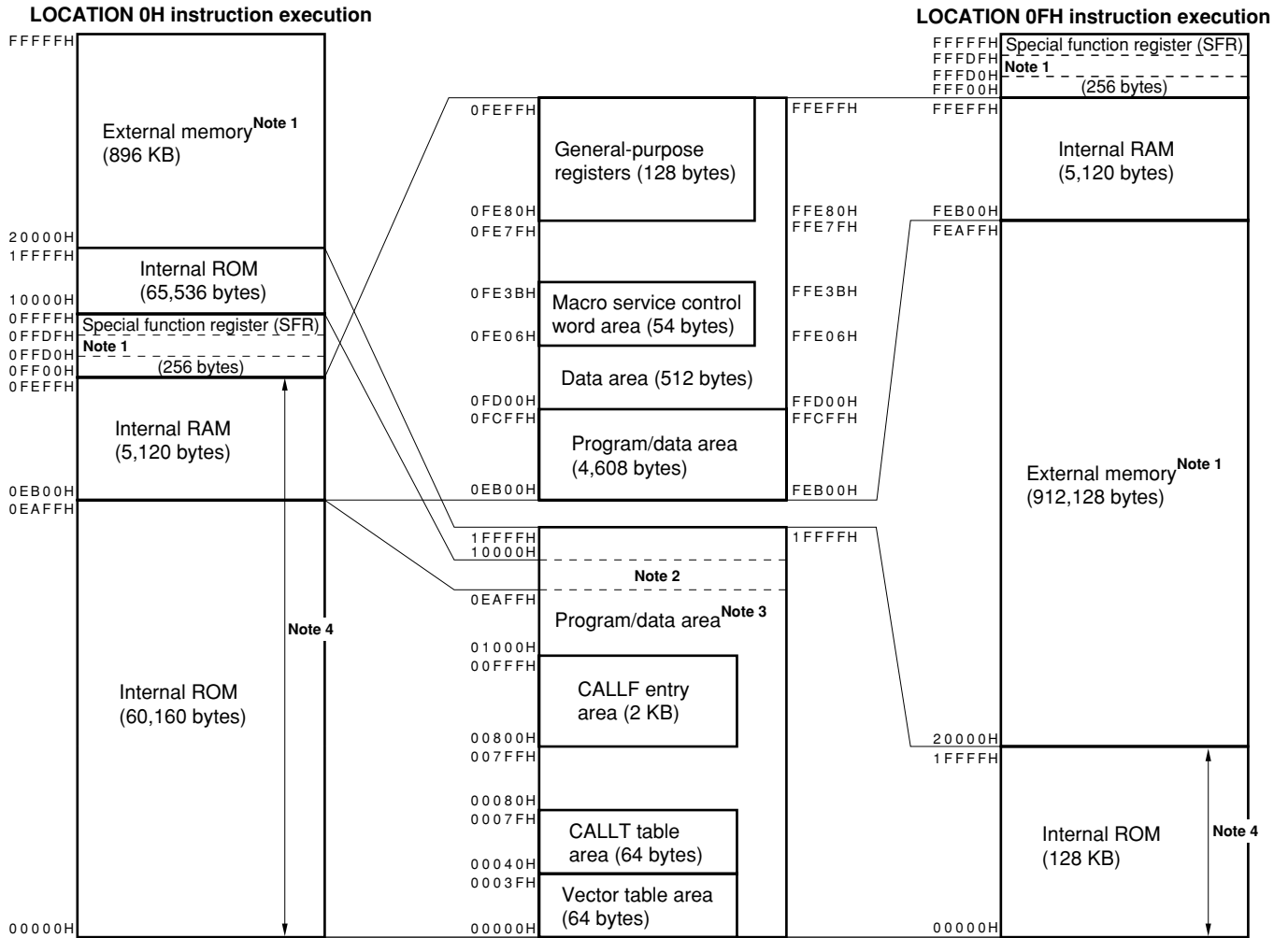
The external memory is accessed in external memory expansion mode.

Figure 3-1. μ PD784214A Memory Map



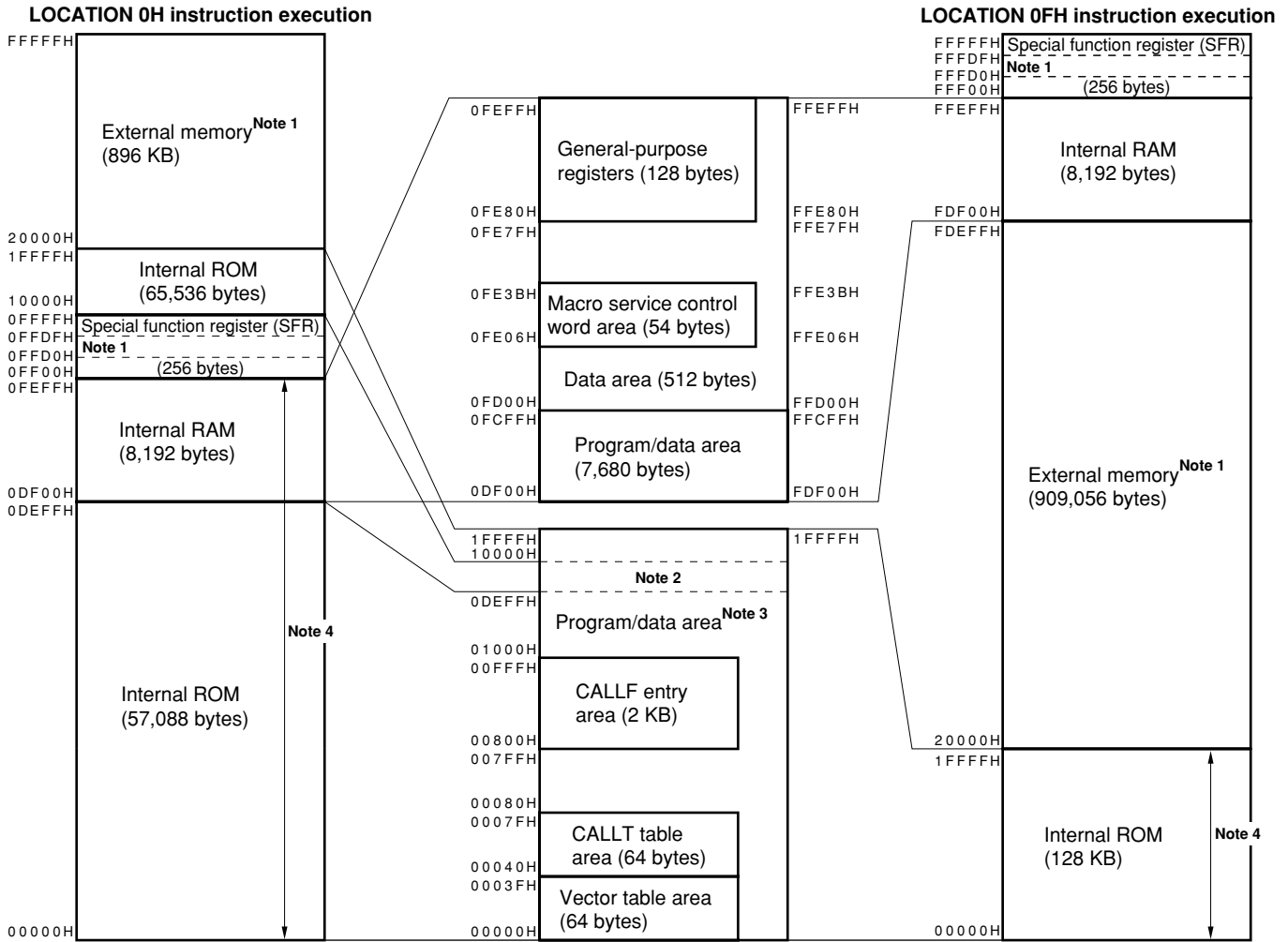
- Notes**
1. Access in the external memory expansion mode.
 2. The 3,840 bytes in this area can be used as the internal ROM only when the LOCATION 0FH instruction is executed.
 3. LOCATION 0H instruction execution: 94,464 bytes, LOCATION 0FH instruction execution: 98,304 bytes
 4. This is the base area and the entry area on resets or interrupts. However, the internal RAM is excluded on reset.

Figure 3-2. μ PD784215A Memory Map



- Notes**
1. Access in the external memory expansion mode.
 2. The 5,376 bytes in this area can be used as the internal ROM only when the LOCATION 0FH instruction is executed.
 3. LOCATION 0H instruction execution: 125,696 bytes, LOCATION 0FH instruction execution: 131,072 bytes
 4. This is the base area and the entry area on resets or interrupts. However, the internal RAM is excluded on reset.

Figure 3-3. μ PD784216A Memory Map



- Notes**
1. Access in the external memory expansion mode.
 2. The 8,448 bytes in this area can be used as the internal ROM only when the LOCATION 0FH instruction is executed.
 3. LOCATION 0H instruction execution: 122,624 bytes, LOCATION 0FH instruction execution: 131,072 bytes
 4. This is the base area and the entry area on resets or interrupts. However, the internal RAM is excluded on reset.

Figure 3-4. μ PD784217A Memory Map

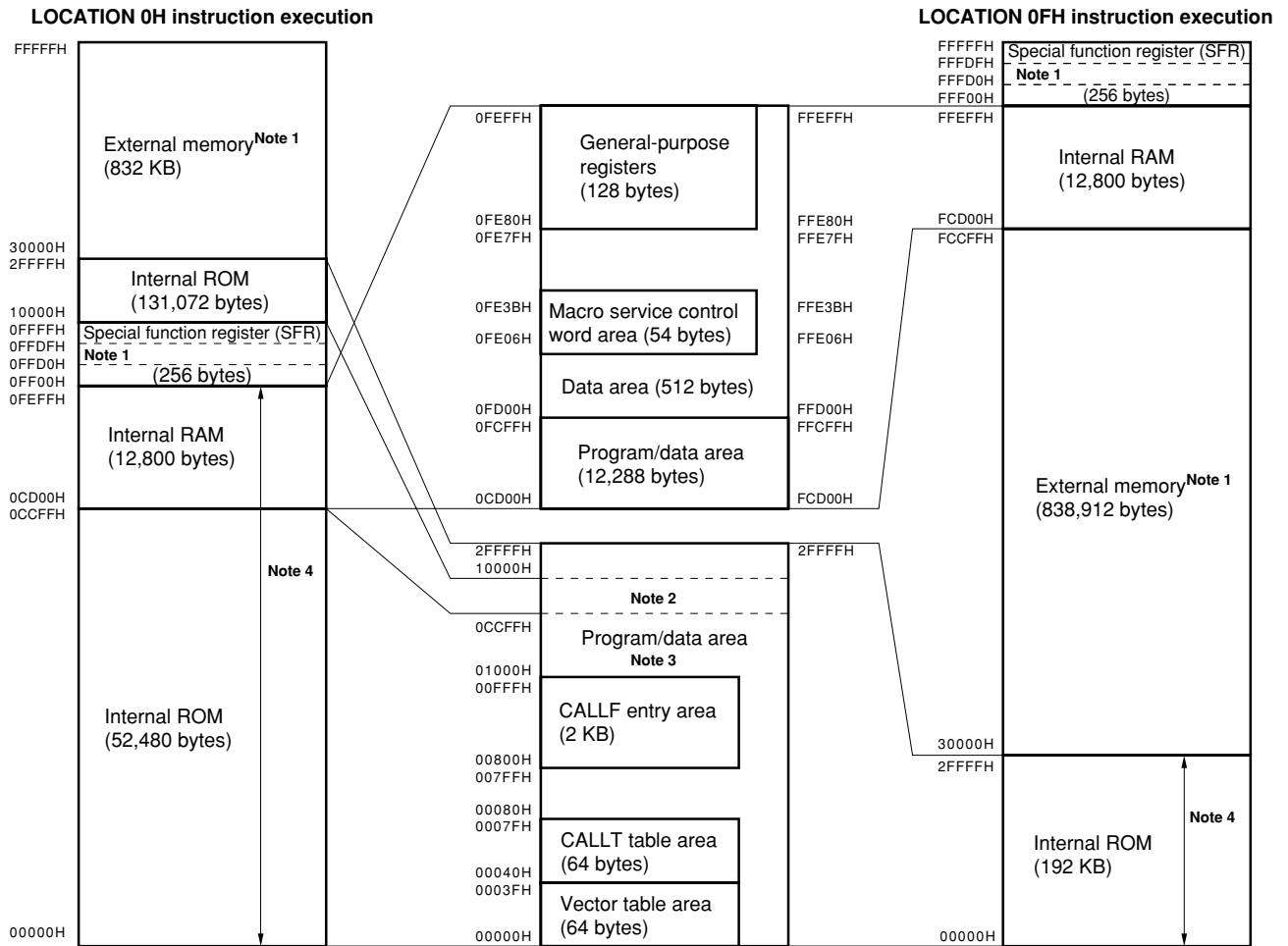
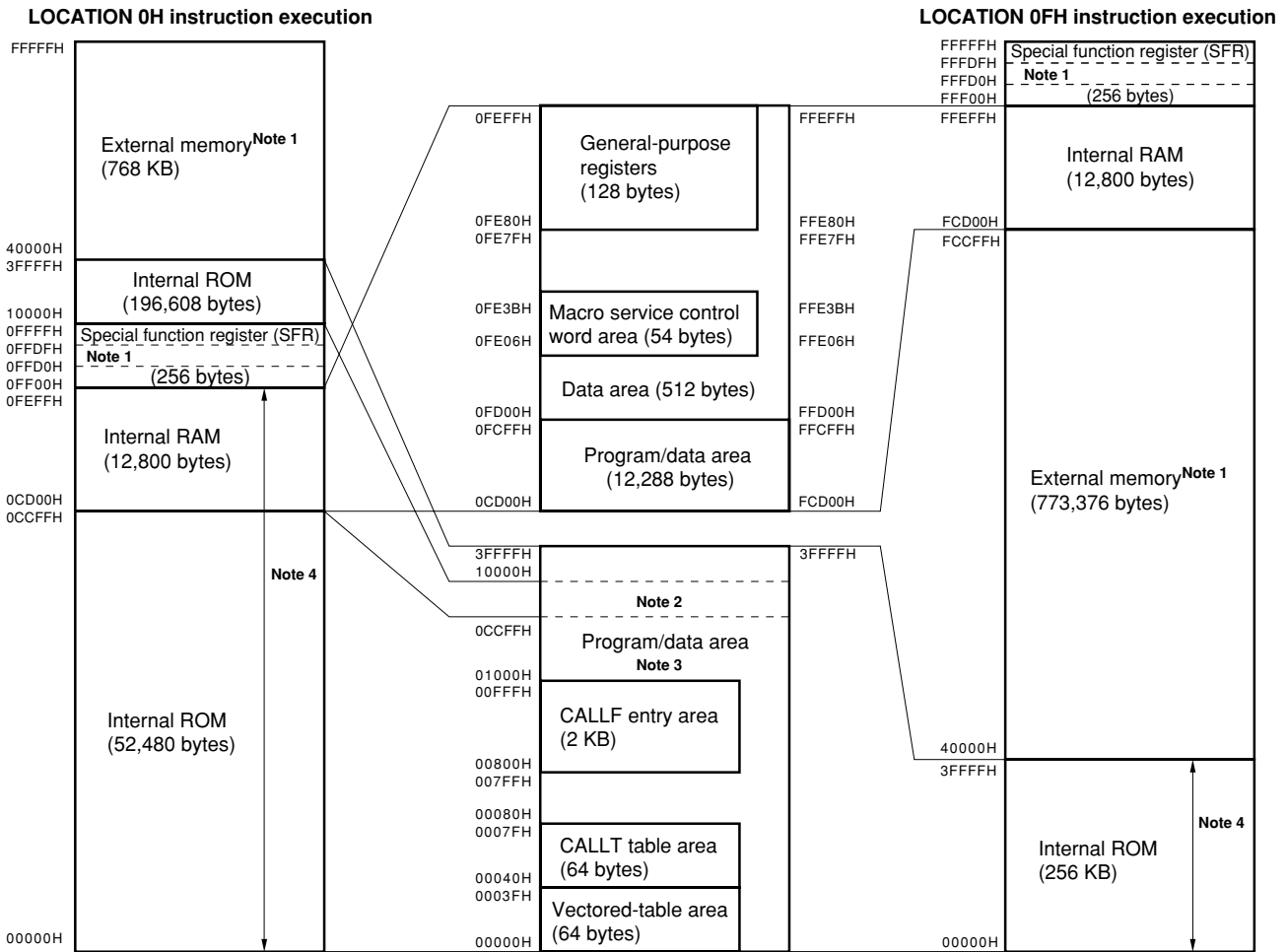


Figure 3-5. μ PD784218A Memory Map



- Notes**
1. Access in the external memory expansion mode.
 2. The 13,056 bytes in this area can be used as the internal ROM only when the LOCATION 0FH instruction is executed.
 3. LOCATION 0H instruction execution: 249,088 bytes; LOCATION 0FH instruction execution: 262,144 bytes
 4. This is the base area and the entry area upon reset or interrupt. However, the internal RAM is excluded for reset.

3.2 Internal ROM Area

The following versions in the μ PD784218A Subseries have on-chip ROMs that can store the programs and table data.

If the internal ROM area and internal data area overlap when the LOCATION 0H instruction is executed, the internal data area becomes the access target, and the overlapped part of the internal ROM area cannot be accessed.

Part Name	Internal ROM	Address Space	
		LOCATION 0H Instruction	LOCATION 0FH Instruction
μ PD784214A	96 K \times 8 bits	00000H to 0F0FFH 10000H to 17FFFH	00000H to 17FFFH
μ PD784215A	128 K \times 8 bits	00000H to 0EAFH 10000H to 1FFFFH	00000H to 1FFFFH
μ PD784216A μ PD78F4216A		00000H to 0DEFFH 10000H to 1FFFFH	
μ PD784217A	192 K \times 8 bits	00000H to 0CCFFH 10000H to 2FFFFH	00000H to 2FFFFH
μ PD784218A μ PD78F4218A	256 K \times 8 bits	00000H to 0CCFFH 10000H to 3FFFFH	00000H to 3FFFFH

The internal ROM can be accessed at high speed. Usually, a fetch is at the same speed as an external ROM fetch. By setting (to 1) the IFCH bit of the memory expansion mode register (MM), the high-speed fetch function is used. An internal ROM is fetched at high-speed fetch (fetch in two system clocks in 2-byte units).

If the instruction execution cycle similar to the external ROM fetch is selected, waits are inserted by the wait function. However, when a high-speed fetch is used, waits cannot be inserted for the internal ROM. However, do not set external waits for the internal ROM area. If an external wait is set for the internal ROM area, the CPU enters the deadlock state. The deadlock state is only released by a reset input.

$\overline{\text{RESET}}$ input causes an instruction execution cycle similar to the external ROM fetch cycle.

3.3 Base Area

The area from 0 to FFFFH becomes the base area. The base area is the target in the following uses.

- Reset entry address
- Interrupt entry address
- Entry address for CALLT instruction
- 16-bit immediate addressing mode (instruction address addressing)
- 16-bit direct addressing mode
- 16-bit register addressing mode (instruction address addressing)
- 16-bit register indirect addressing mode
- Short direct 16-bit memory indirect addressing mode

The vector table area, CALLT instruction table area, and CALLF instruction entry area are allocated in the base area.

When the LOCATION 0H instruction is executed, the internal data area is placed in the base area. Be aware that the program cannot be fetched from the internal high-speed RAM area and special function register (SFR) area in the internal data area. Also, use the data in the internal RAM area after initialization.

3.3.1 Vector table area

The 64-byte area from 00000H to 0003FH is reserved as the vector table area. The program start addresses for branching by interrupt requests and $\overline{\text{RESET}}$ input are stored in the vector table area. If context switching is used by each interrupt, the register bank number of the switch destination is stored.

The portion that is not used as the vector table can be used as program memory or data memory.

The values that can be written in the vector table are a 16-bit values. Therefore, branching can only be to the base area.

Table 3-1. Vector Table Address

Interrupt Source	Vector Table Address	Interrupt Source	Vector Table Address
BRK instruction	003EH	INTST1	001CH
TRAP0 (operand error)	003CH	INTSER2	001EH
NMI	0002H	INSR2	0020H
INTWDT (non-maskable)	0004H	INTCSI2	
INTWDT (maskable)	0006H	INTST2	0022H
INTP0	0008H	INTTM3	0024H
INTP1	000AH	INTTM00	0026H
INTP2	000CH	INTTM01	0028H
INTP3	000EH	INTTM1	002AH
INTP4	0010H	INTTM2	002CH
INTP5	0012H	INTAD	002EH
INTP6	0014H	INTTM5	0030H
INTIIC0 ^{Note}	0016H	INTTM6	0032H
INTCSI0		INTTM7	0034H
INTSER1	0018H	INTTM8	0036H
INTSR1	001AH	INTWT	0038H
INTCSI1		INTKR	003AH

Note Only in μ PD784216AY, 784218AY Subseries

3.3.2 CALLT instruction table area

The 64 KB area from 00040H to 0007FH can store the subroutine entry addresses for the 1-byte call instruction (CALLT).

In a CALLT instruction, this table is referenced and the base area address written in the table is branched to as the subroutine. Since a CALLT instruction is a 1-byte instruction, many subroutine call descriptions in the program can be CALLT instructions, so the object size of the program can be reduced. Since a maximum of 32 subroutine entry addresses can be described in the table, they should be registered in order from the most frequently described.

When not used as the CALLT instruction table, the area can be used as normal program memory or data memory.

3.3.3 CALLF instruction entry area

The area from 00800H to 00FFFH can be called directly by subroutine via the 2-byte call instruction (CALLF).

Since a CALLF instruction is a 2-byte call instruction, compared to using the CALL instruction (3-byte or 4-byte) of a subroutine call directly, the object size can be reduced.

When higher speed is required, describing subroutines directly in this area is effective.

If decreasing the object size is required, this can be done by describing an unconditional branch (BR) in this area and placing the actual subroutine outside this area. When a subroutine is called from five or more locations, reducing the object size is attempted. In this case, since only a 4-byte location for the BR instruction is occupied in the CALLF entry area, the object size of many subroutines can be reduced.

3.4 Internal Data Area

The internal data area consists of the internal RAM area and the special function register area (see **Figures 3-1** and **3-2**).

For the final address of the internal data area, either 0FFFFH (when executing the LOCATION 0H instruction) or FFFFFH (when executing the LOCATION 0FH instruction) can be selected by the LOCATION instruction. The address selection of the internal data area by this LOCATION 0H must be executed once immediately after a reset is released. Once either of them is selected, the other cannot be selected. The program after a reset is released must be as shown in the example. If the internal data area and another area are allocated to the same address, the internal data area becomes the access target, and the other area cannot be accessed.

```

Example  RSTVCT   CSEG AT 0
           DW      RSTSTRT
           :
           :
           INITSEG  CSEG BASE
           RSTSTRT: LOCATION 0H ; or LOCATION 0FH
           MOVG SP, #STKBGN

```

Caution When the LOCATION 0H instruction is executed, the program after releasing the reset must not overlap the internal data area. In addition, make sure the entry address of the servicing routine for a non-maskable interrupt such as NMI does not overlap the internal data area. The entry area for a maskable interrupt must be initialized before referencing the internal data area.

3.4.1 Internal RAM area

The μ PD784218A has an on-chip general-purpose static RAM.
This area has the following configuration.

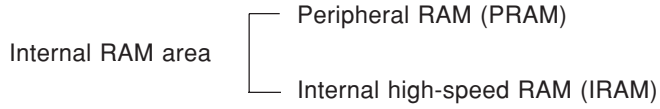


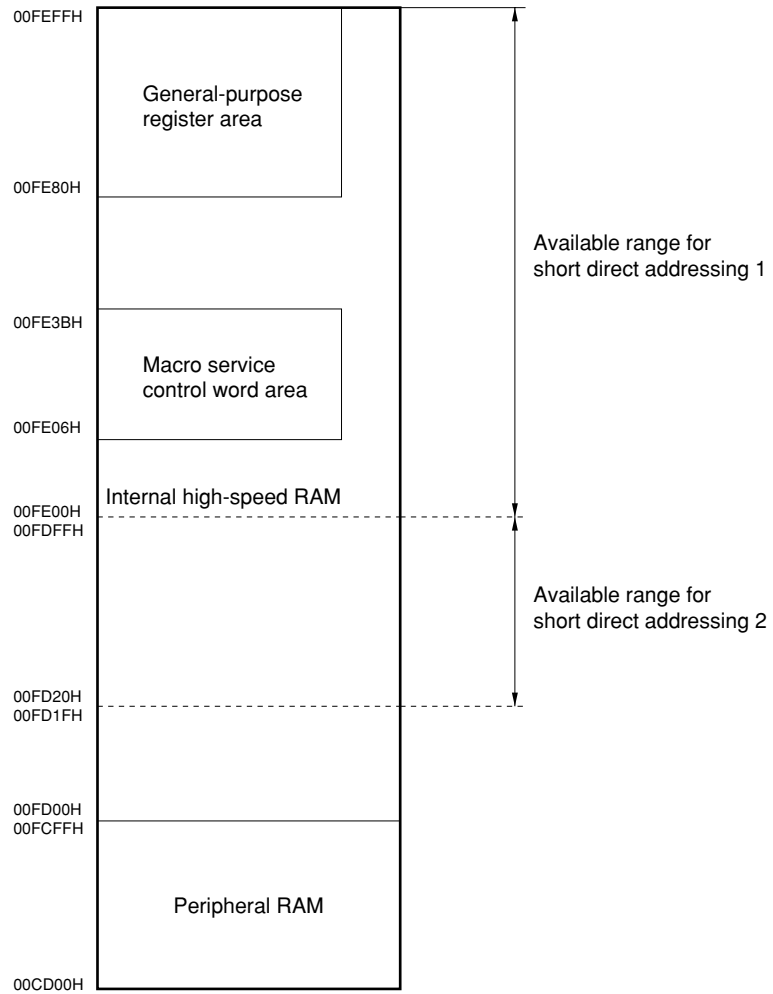
Table 3-2. Internal RAM Area List

Internal RAM Product Name	Internal RAM Area		
		Peripheral RAM: PRAM	Internal High-speed RAM: IRAM
μ PD784214A	3,584 bytes (0F100H to 0FEFFH)	3,072 bytes (0F100H to 0FCFFH)	512 bytes (0FD00H to 0FEFFH)
μ PD784215A	5,120 bytes (0EB00H to 0FEFFH)	4,608 bytes (0EB00H to 0FCFFH)	
μ PD784216A μ PD78F4216A	8,192 bytes (0DF00H to 0FEFFH)	7,680 bytes (0DF00H to 0FCFFH)	
μ PD784217A μ PD784218A μ PD78F4218A	12,800 bytes (0CD00H to 0FEFFH)	12,288 bytes (0CD00H to 0FCFFH)	

Remark The addresses in the table are the values when the LOCATION 0H instruction is executed. When the LOCATION 0FH instruction is executed, 0F0000H is added to the above values.

Figure 3-6 is the internal RAM memory map.

Figure 3-6. Internal RAM Memory Map



Remark The addresses in the figure are the values when the LOCATION 0H instruction is executed. When the LOCATION 0FH instruction is executed, 0F0000H is added to the above values.

(1) Internal high-speed RAM (IRAM)

The internal high-speed RAM can be accessed at high speed. The short direct addressing mode can be used for high-speed access to FD20H to FEFFH. The two short direct addressing modes, short direct addressing 1 and short direct addressing 2, are available depending on the address of the target. Both addressing modes have the same function. In some instructions, short direct addressing 2 has a shorter word length than short direct addressing 1. For details, refer to **78K/IV Series User's Manual — Instruction (U10905E)**.

A program cannot be fetched from IRAM. If a program is fetched from an address that is mapped for IRAM, CPU runaway occurs.

The following areas are reserved for IRAM.

- General-purpose register area: FE80H to FEFFH
- Macro service control word area: FE06H to FE3BH
- Macro service channel area: FE00H to FEFFH (The address is set by a macro service control word.)

When these areas do not use the reserved functions, they can be used as normal data memory.

Remark The addresses in this text are the addresses when the LOCATION 0H instruction is executed. When the LOCATION 0FH instruction is executed, 0F0000H is added to the values in this text.

(2) Peripheral RAM (PRAM)

The peripheral RAM (PRAM) is used as normal program memory or data memory. When used as the program memory, the program must be written beforehand in the peripheral RAM by a program.

A program fetch from the peripheral RAM is high speed because it can be executed in two clocks in 2-byte units.

3.4.2 Special function register (SFR) area

The special function register (SFR) of the on-chip peripheral hardware is mapped to the area from 0FF00H to 0FFFFH (Refer to **Figures 3-1** and **3-2**).

The area from 0FFD0H to 0FFDFH is mapped as the external SFR area. Peripheral I/O externally connected can be accessed in the external memory expansion mode (set by the memory expansion mode register (MM)).

Caution In this area, do not access an address that is not mapped in SFR. If such an address is mistakenly accessed, the CPU may enter the deadlock state. The deadlock state is released only by reset input.

Remark The addresses in this text are the addresses only when the LOCATION 0H instruction is executed. If the LOCATION 0FH instruction is executed, 0F0000H is added to the values in the text.

3.4.3 External SFR area

In the products of the μ PD784218A Subseries, the 16-byte area from 0FFD0H to 0FFDFH (during LOCATION 0H instruction execution, or from 0FFFD0H to 0FFDFH during LOCATION 0FH instruction execution) in the SFR area is mapped as the external SFR area. In the external memory expansion mode, the externally attached peripheral I/O can be accessed by using the address bus and address/data bus.

Since the external SFR area can be accessed by SFR addressing, the features are that peripheral I/O operations can be simplified; the object size can be reduced; and macro service can be used.

The bus operation when accessing an external SFR area is the same as a normal memory access.

3.5 External Memory Space

The external memory space is the memory space that can be accessed by setting the memory expansion mode register (MM). The program and table data can be stored and peripheral I/O devices can be assigned.

3.6 Memory Mapping of μ PD78F4216A and 78F4218A

IMS is a register that is set by software and is used to specify a part of the internal memory that is not to be used. By setting this register, the internal memory can be mapped identically to that of a mask ROM version with a different internal memory (ROM and RAM) capacity.

IMS is set with an 8-bit memory manipulation instruction.

$\overline{\text{RESET}}$ input sets IMS to FFH.

(1) μ PD78F4216A, 78F4216AY

Figure 3-7. Internal Memory Size Switching Register (IMS) Format (1/2)

Address: 0FFFCH After reset: FFH W

Symbol	7	6	5	4	3	2	1	0
IMS	1	1	ROM1	ROM0	1	1	RAM1	RAM0

ROM1	ROM0	Internal ROM capacity selections
0	0	48 KB
0	1	64 KB
1	0	96 KB
1	1	128 KB

RAM1	RAM0	Peripheral RAM capacity selections
0	0	3,072 bytes
0	1	4,608 bytes
1	0	6,114 bytes
1	1	7,680 bytes

- Cautions**
1. IMS is not provided in the mask ROM versions (μ PD784214A, 784215A, 784216A, 784214AY, 784215AY, and 784216AY). Even if a write instruction is executed to IMS in a mask ROM version, the instruction will be invalid.
 2. If the μ PD78F4216A or 78F4216AY is selected as the emulation CPU for an in-circuit emulator, the memory size is always the same as that of the μ PD784216A, “FFH”, even if an instruction that writes an address of IMS other than FFH is executed.

Table 3-3 shows the IMS setting values to make the memory mapping the same as that of the mask ROM versions.

Table 3-3. Setting Value of Internal Memory Size Switching Register (IMS)

Target Mask ROM Version	IMS Setting Value
μ PD784214A, 784214AY	ECH
μ PD78425A, 784215AY	FDH
μ PD78426A, 784216AY	FFH

(2) μ PD78F4218A, 78F4218AY

Figure 3-7. Internal Memory Size Switching Register (IMS) Format (2/2)

Address: 0FFFCH After reset: FFH W

Symbol	7	6	5	4	3	2	1	0
IMS	1	1	ROM1	ROM0	1	1	RAM1	RAM0

ROM1	ROM0	Internal ROM capacity selections
0	0	64 KB
0	1	128 KB
1	0	192 KB
1	1	256 KB

RAM1	RAM0	Peripheral RAM capacity selections
0	0	3,072 bytes
0	1	6,656 bytes
1	0	7,168 bytes
1	1	12,288 bytes

- Cautions**
1. IMS is not provided in the mask ROM versions (μ PD784217A, 784218A, 784217AY, and 784218AY). Even if a write instruction is executed to IMS in a mask ROM version, the instruction will be invalid.
 2. If the μ PD78F4218A or 78F4218AY is selected as the emulation CPU for an in-circuit emulator, the memory size is always the same as that of the μ PD784218A, "FFH", even if an instruction that writes an address of IMS other than FFH is executed.

Table 3-4 shows the IMS setting values to make the memory mapping the same as that of the mask ROM versions.

Table 3-4. Setting Value of Internal Memory Size Switching Register (IMS)

Target Mask ROM Version	IMS Setting Value
μ PD784217A, 784217AY	EFH
μ PD784218A, 784218AY	FFH

3.7 Control Registers

The control registers are the program counter (PC), program status word (PSW), and stack pointer (SP).

3.7.1 Program counter (PC)

This is a 20-bit binary counter that holds the address information about the program to be executed next (see **Figure 3-8**).

Usually, this counter is automatically incremented based on the number of bytes of the instruction to be fetched. When the instruction with branching is executed, the immediate data or register contents are set.

$\overline{\text{RESET}}$ input sets the 16-bit data at addresses 0 and 1 to the lower 16 bits of the PC, and 0000 to the higher four bits of the PC.

Figure 3-8. Program Counter (PC) Format



3.7.2 Program status word (PSW)

The program status word (PSW) is a 16-bit register that consists of various flags that are set and reset based on the result of the instruction execution.

A read or write access is performed in higher 8-bit (PSWH) and the lower 8-bit (PSWL) units. In addition, bit manipulation instructions can manipulate each flag.

The contents of the PSW are automatically saved on the stack when a vectored interrupt request is accepted and when a BRK instruction is executed, and are automatically restored when a RETI or RETB instruction is executed. When context switching is used, the contents are automatically saved to RP3, and automatically restored when a RETCS or RETCSB instruction is executed.

$\overline{\text{RESET}}$ input resets all of the bits to 0.

Be sure to write 0 in the bits indicated as "0" in Figure 3-9. The contents of bits indicated as "—" are undefined when read.

Figure 3-9. Program Status Word (PSW) Format

Symbol	7	6	5	4	3	2	1	0
PSWH	UF	RBS2	RBS1	RBS0	—	—	—	—
	7	6	5	4	3	2	1	0
PSWL	S	Z	RSS	AC	IE	P/V	0	CY

Each flag is described below.

(1) Carry flag (CY)

This is the flag that stores the carry or borrow of an operation result.

When a shift rotate instruction is executed, the value shifted out is stored. When a bit manipulation instruction is executed, this flag functions as the bit accumulator.

The state of the CY flag can be tested by a conditional branch instruction.

(2) Parity/overflow flag (P/V)

The P/V flag has the following two actions in accordance with the execution of the operation instruction.

The state of the P/V flag can be tested by a conditional branch instruction.

- **Parity flag action**

If the results of executing the logical instructions, shift rotate instructions, and CHKL and CHKLA instructions set the even number of bits to 1, the flag is set to 1. If the number of bits set to 1 is odd, the flag is reset to 0. However, for 16-bit shift instructions, only the lower 8 bits of the operation result are valid for the parity flag.

- **Overflow flag action**

The result of executing an arithmetic operation instruction sets the flag to 1 only if the result exceeds the numerical range expressed in two's complement. Otherwise, the flag is reset to 0. Specifically, the result of the exclusive OR of the carry from the MSB and the carry to the MSB becomes the flag contents. For example, in 8-bit arithmetic operations, the two's complement range is from 80H (−128) to 7FH (+127). If the operation result is out of this range, the flag is set to 1. If within this range, it is reset to 0.

Example The action of the overflow flag when an 8-bit addition instruction is executed is described next.

When 78H (+120) and 69H (+105) are added, the operation result becomes E1H (+225). Since the upper limit of two's complement is exceeded, the P/V flag is set to 1. In a two's complement expression, E1H becomes -31.

$$\begin{array}{r}
 78H (+120) = \quad 0111 \ 1000 \\
 +) \underline{69H (+105)} = +) \underline{0110 \ 1001} \\
 \quad 0 \ 1110 \ 0001 = -31 \ P/V = 1 \\
 \quad \uparrow \\
 \quad CY
 \end{array}$$

Next, since the operation result of the addition of the following two negative numbers falls within the two's complement range, the P/V flag is reset to 0.

$$\begin{array}{r}
 FBH (-5) = \quad 1111 \ 1011 \\
 +) \underline{F0H (-16)} = +) \underline{1111 \ 0000} \\
 \quad 1 \ 1110 \ 1011 = -21 \ P/V = 0 \\
 \quad \uparrow \\
 \quad CY
 \end{array}$$

(3) Interrupt request enable flag (IE)

This flag controls the CPU interrupt request acceptance.

If IE is 0, interrupts are disabled, and only non-maskable interrupts and unmasked macro services can be accepted. Otherwise, everything is disabled.

If IE is 1, the interrupt enable state is entered. Enabling the acceptance of interrupt requests is controlled by the interrupt mask flags that correspond to each interrupt request and the priority of each interrupt.

This flag is set to 1 by executing the EI instruction and is reset to 0 by executing the DI instruction or accepting an interrupt.

(4) Auxiliary carry flag (AC)

If the operation result has a carry from bit 3 or a borrow to bit 3, this flag is set to 1. Otherwise, the flag is reset to 0.

This flag is used when the ADJBA and ADJBS instructions are executing.

(5) Register set selection flag (RSS)

This flag sets the general-purpose registers that function as X, A, C, and B and the general-purpose register pairs (16 bits) that function as AX and BC.

This flag is used to maintain compatibility with the 78K/III Series. Always set this flag to 0 except when using a 78K/III Series program.

(6) Zero flag (Z)

This flag indicates that the operation result is 0.

If the operation result is 0, this flag is set to 1. Otherwise, it is reset to 0. The state of the Z flag can be tested by conditional branch instructions.

(7) Sign flag (S)

This flag indicates that the MSB in the operation result is 1.

The flag is set to 1 when the MSB of the operation result is 1. If 0, the flag is reset to 0. The S flag state can be tested by the conditional branch instructions.

(8) Register bank selection flags (RBS0 to RBS2)

This is the 3-bit flag that selects one of the eight register banks (register banks 0 to 7). (Refer to **Table 3-5**.) Three bit information that indicates the register bank selected by executing the SEL RBn instruction is stored.

Table 3-5. Register Bank Selection

RBS2	RBS1	RBS0	Set Register Bank
0	0	0	Register bank 0
0	0	1	Register bank 1
0	1	0	Register bank 2
0	1	1	Register bank 3
1	0	0	Register bank 4
1	0	1	Register bank 5
1	1	0	Register bank 6
1	1	1	Register bank 7

(9) User flag (UF)

This flag is set and reset by a user program and can be used in program control.

3.7.3 Using RSS bit

Basically, always use with the RSS bit fixed at 0.

The following descriptions discuss using a 78K/III Series program and a program that sets the RSS bit to 1. Reading is not necessary if the RSS bit is fixed at 0.

The RSS bit enables the functions in A (R1), X (R0), B (R3), C (R2), AX (RP0), and BC (RP1) to also be used in registers R4 to R7 (RP2, RP3). When this bit is effectively used, efficient programs in terms of program size and program execution can be written.

Sometimes, however, unexpected problems arise if used carelessly. Consequently, always set the RSS bit to 0. Use with the RSS bit set to 1 only when 78K/III Series programs will be used.

By setting the RSS bit to 0 in all programs, writing and debugging programs become more efficient.

Even if a program where the RSS bit is set to 1 is used, when possible, it is recommended to use the program after modifying the program so that the RSS bit is not set to 1.

(1) Using the RSS bit

- Registers used in instructions where the A, X, B, C, and AX registers are directly described in the operand column of the operation list (see 29.2)
- Registers that are implicitly specified in instructions that use the A, AX, B, and C registers by implied addressing
- Registers that are used in addressing in instructions that use the A, B, and C registers in indexed addressing and based indexed addressing

The registers used in these cases are switched in the following ways by the RSS bit.

- When RSS = 0
A→R1, X→R0, B→R3, C→R2, AX→RP0, BC→RP1
- When RSS = 1
A→R5, X→R4, B→R7, C→R6, AX→RP2, BC→RP3

The registers used in other cases always become the same registers regardless of the contents of the RSS bit. For registers A, X, B, C, AX, and BC in NEC Electronics assembler RA78K4, instruction code is generated for any register described by name or for registers set by an RSS pseudo instruction in the assembler. When the RSS bit is set or reset, always specify an RSS pseudo instruction immediately before (or immediately after) that instruction (see the following examples).

<Program examples>

- When RSS = 0

```
RSS 0          ; RSS pseudo instruction
CLR1 PSWL. 5
MOV B, A       ; This description corresponds to "MOV R3, R1".
```

- When RSS = 1

```
RSS 1          ; RSS pseudo instruction
SET1 PSWL. 5
MOV B, A       ; This description corresponds to "MOV R7, R5".
```

(2) Generation of instruction code in the RA78K4

- In the RA78K4, when an instruction with the same function as an instruction that directly specifies A or AX in the operand column in the operation list of the instruction is used, the instruction code that directly describes A or AX in the operand column is given priority and generated.

Example The MOV A, r instruction where r is B has the same function as the MOV r, r' instruction where r is A and r' is B. In addition, they have the same (MOV A, B) description in the assembler source program. In this case, RA78K4 generates code that corresponds to the MOV A, r instruction.

- If A, X, B, C, AX, or BC is described in an instruction that specifies r, r', rp, or rp' in the operand column, the A, X, B, C, AX, or BC instruction code generates the instruction code that specifies the following registers based on the operand of the RSS pseudo instruction in RA78K4.

Register	RSS = 0	RSS = 1
A	R1	R5
X	R0	R4
B	R3	R7
C	R2	R6
AX	RP0	RP2
BC	RP1	RP3

- If R0 to R7 and RP0 to RP4 are specified in r, r', rp, and rp' in the operand column, an instruction code that conforms to the specification is output (Instruction code that directly describes A or AX in the operand column is not output).
- The A, B, and C registers that are used in indexed addressing and based indexed addressing cannot be described as R1, R3, R2, or R5, R7, R6.

(3) Usage Cautions

Switching the RSS bit obtains the same effect as holding two register sets. However, be careful and write the program so that implicit descriptions in the program and dynamically changing the RSS bit during program execution always agree.

Also, since a program with RSS = 1 cannot be used in a program that uses context switching, the portability of the program becomes poor. Furthermore, since different registers having the same name are used, the readability of the program worsens, and debugging becomes difficult. Therefore, when RSS = 1 must be used, write the program while taking these problems into consideration.

A register that does not have the RSS bit set can be accessed by specifying the absolute name.

3.7.4 Stack pointer (SP)

The 24-bit register saves the starting address of the stack (LIFO: 00000H to FFFFFFFH) (refer to **Figure 3-10**). The stack is used for addressing during subroutine processing or interrupt servicing. Always set the most-significant four bits to zero.

The contents of the SP are decremented before writing to the stack area and incremented after reading from the stack (refer to **Figures 3-11** and **3-12**).

SP is accessed by special instructions.

Since the SP contents become undefined when $\overline{\text{RESET}}$ is input, always initialize the SP from the initialization program immediately after clearing the reset (before accepting a subroutine call or interrupt).

Example Initializing SP

```
MOVG SP, #0FEE0H ; SP ← 0FEE0H (when used from FEDFH)
```

Figure 3-10. Stack Pointer (SP) Format



Figure 3-11. Data Saved to Stack

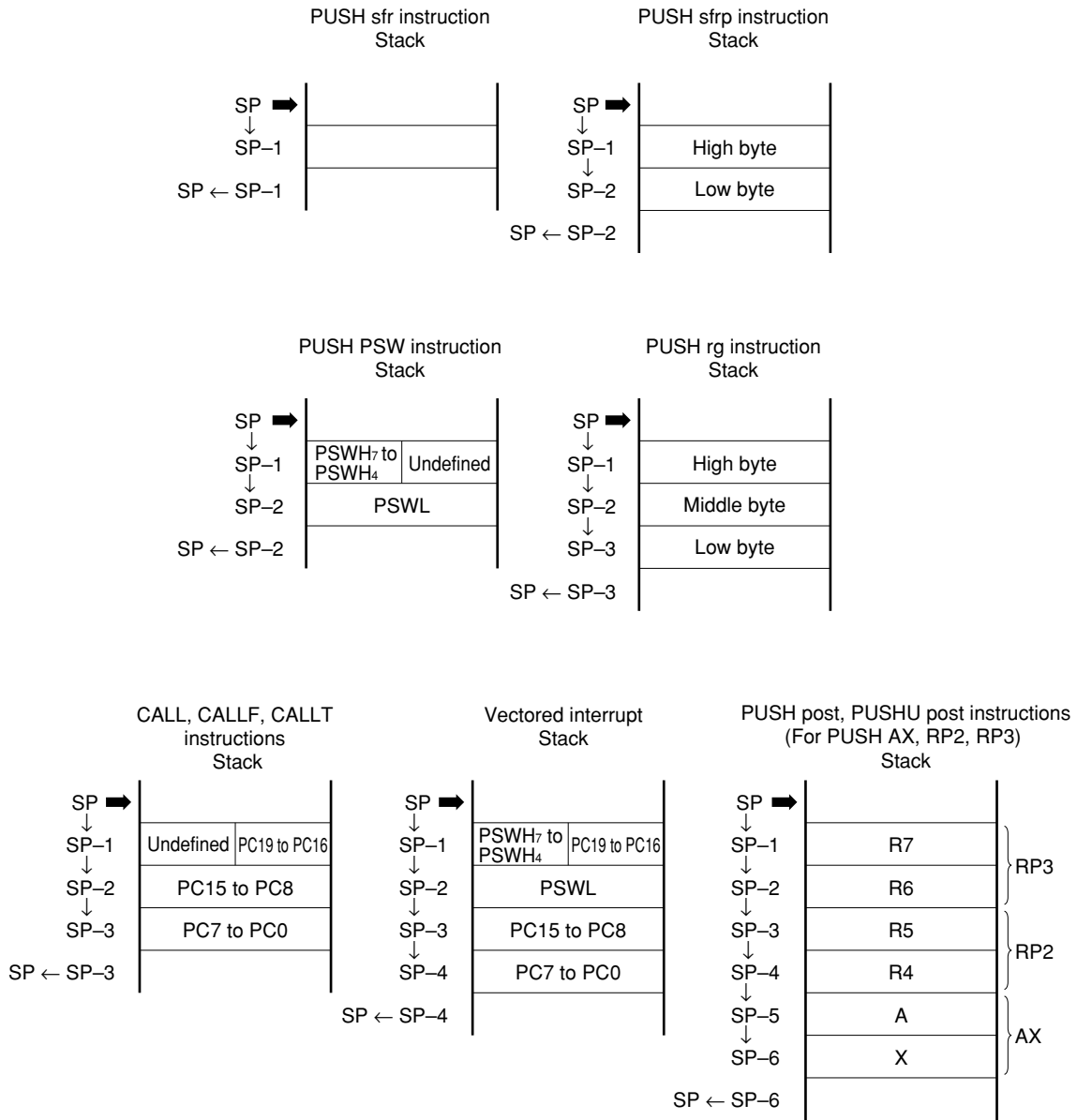
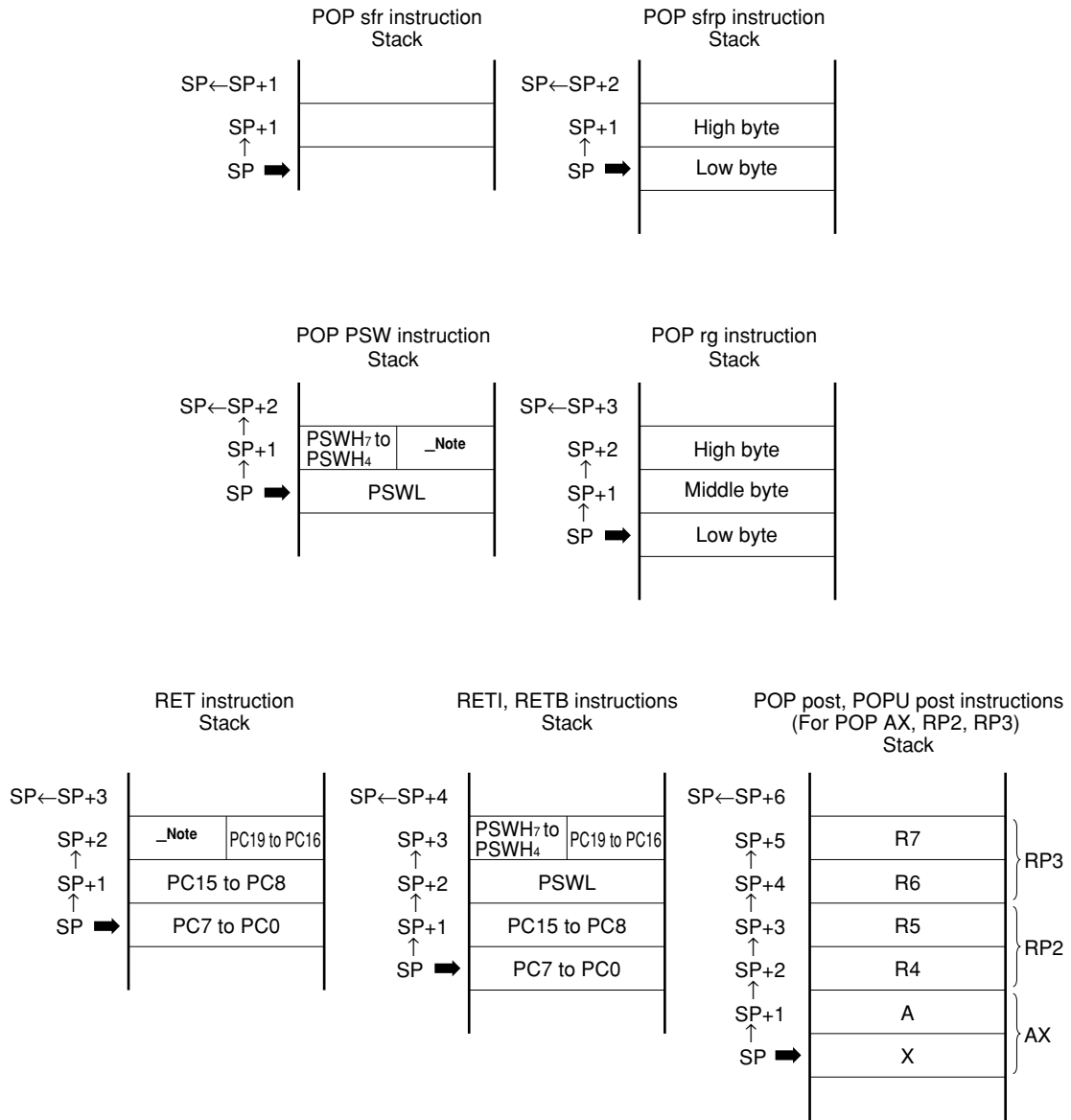


Figure 3-12. Data Restored from Stack



Note This 4-bit data is ignored.

- Cautions**
1. In stack addressing, the entire 1 MB space can be accessed, but the stack cannot be guaranteed in the SFR area and internal ROM area.
 2. The stack pointer (SP) becomes undefined when **RESET** is input. In addition, even when SP is in the undefined state, non-maskable interrupts can be accepted. Therefore, when the SP is in the undefined state immediately after the reset is cleared and a request for a non-maskable interrupt is generated, unexpected actions sometimes occur. To avoid this danger, always specify the following in the program after clearing a reset.

```
RSTVCT    CSEG AT 0
          DW    RSTSTRT
          :
INITSEG    CSEG BASE
RSTSTRT:   LOCATION 0H; or LOCATION 0FH
          MOVG SP, #STKBGN
```

3.8 General-Purpose Registers

3.8.1 Configuration

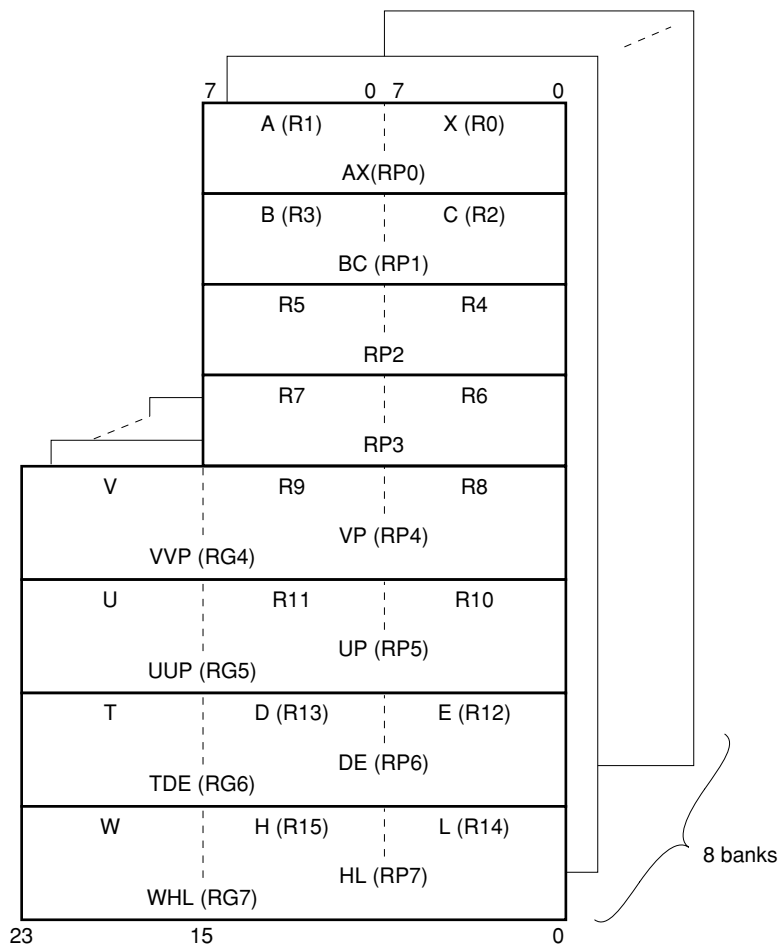
There are sixteen 8-bit general-purpose registers. In addition, two 8-bit general-purpose registers can be combined and used as a 16-bit general-purpose register. Furthermore, four of the 16-bit general-purpose registers are combined with an 8-bit register for address expansion and used as a 24-bit address specification register.

The general-purpose registers except for the V, U, T, and W registers for address expansion are mapped to the internal RAM.

These register sets provide eight banks and can be switched by the software or context switching.

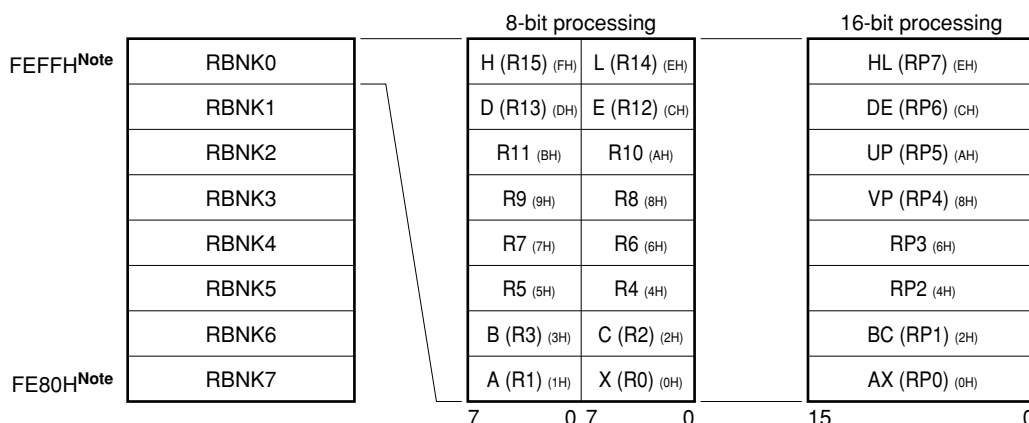
$\overline{\text{RESET}}$ input selects register bank 0. In addition, the register banks that are used in an executing program can be verified by reading the register bank selection flags (RBS0, RBS1, RBS2) in the PSW.

Figure 3-13. General-Purpose Register Format



Remark The parentheses enclose the absolute names.

Figure 3-14. General-Purpose Register Addresses

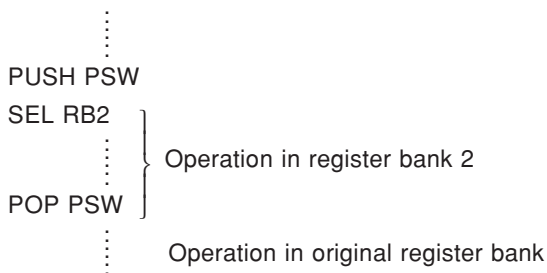


Note These are the addresses when the LOCATION 0H instruction is executed. The addresses when the LOCATION 0FH instruction is executed are the sum of the above values and 0F0000H.

Caution R4, R5, R6, R7, RP2, and RP3 can be used as the X, A, C, B, AX, and BC registers when the RSS bit in the PSW is set to 1. However, use this function only when using a 78K/III Series program.

Remark When changing the register bank and when returning to the original register bank is necessary, execute the SEL RBn instruction after using the PUSH PSW instruction to save the PSW to the stack. If the stack position is not changed when returning to the original state, the POP PSW instruction is used to return. When the register banks in the vectored interrupt processing program are updated, PSW is automatically saved on the stack when an interrupt is accepted and returned by the RETI and RETB instructions. Therefore, when one register bank is used in an interrupt servicing routine, only the SEL RBn instruction is executed, and the PUSH PSW or POP PSW instruction does not have to be executed.

Example When register bank 2 is specified



3.8.2 Functions

In addition to being manipulatable in 8-bit units, general-purpose registers can be a pair of two 8-bit registers and be manipulated in 16-bit units. Also four of the 16-bit registers can be combined with the 8-bit register for address expansion and manipulated in 24-bit units.

Each register can generally be used as the temporary storage for the operation result or the operand of the operation instruction between registers.

The area from 0FE80H to 0FEFFH (during LOCATION 0H instruction execution, or the 0FFE80H to 0FFEFFH during LOCATION 0FH instruction execution) can be accessed by specifying an address as normal data memory whether or not it is used as the general-purpose register area.

Since there are eight register banks in the 78K/IV Series, efficient programs can be written by suitably using the register banks in normal processing or interrupt processing.

Each register has the unique functions shown below.

A (R1):

- This register is primarily for 8-bit data transfers and operation processing. It can be combined with all of the addressing modes for 8-bit data.
- This register can be used to store bit data.
- This register can be used as a register that stores the offset value during indexed addressing or based indexed addressing.

X (R0):

- This register can store bit data.

AX (RP0):

- This register is primarily for 16-bit data transfers and operation results. It can be combined with all of the addressing modes for 16-bit data.

AXDE:

- When a DIVUX, MACW, or MACSW instruction is executed, this register can be used to store 32-bit data.

B (R3):

- This register functions as a loop counter and can be used by the DBNZ instruction.
- This register can store the offset in indexed addressing and based indexed addressing.
- This register is used as the data pointer in a MACW or MACSW instruction.

C (R2):

- This register functions as a loop counter and can be used by the DBNZ instruction.
- This register can store the offset in based indexed addressing.
- This register is used as the counter in string and SACW instructions.
- This register is used as the data pointer in a MACW or MACSW instruction.

RP2:

- When context switching is used, this register saves the low-order 16 bits of the program counter (PC).

RP3:

- When context switching is used, this register saves the most significant 4 bits of the program counter (PC) and the program status word (PSW) (except bits 0 to 3 in PSWH).

VVP (RG4):

- This register functions as a pointer and specifies the base address in register indirect addressing, based addressing, and based indexed addressing.

UUP (RG5):

- This register functions as a user stack pointer and implements another stack separate from the system stack by the PUSHU and POPU instructions.
- This register functions as a pointer and specifies the base address in register indirect addressing and based addressing.

DE (RP6), HL (RP7):

- This register stores the offset during indexed addressing and based indexed addressing.

TDE (RG6):

- This register functions as a pointer and specifies the base address in register indirect addressing and based addressing.
- This register functions as a pointer in string and SACW instructions.

WHL (RG7):

- This register primarily performs 24-bit data transfers and operation processing.
- This register functions as a pointer and specifies the base address in register indirect addressing and based addressing.
- This functions as a pointer in string and SACW instructions.

In addition to its function name (X, A, C, B, E, D, L, H, AX, BC, VP, UP, DE, HL, VVP, UUP, TDE, WHL) that emphasizes its unique function, each register can be described by its absolute name (R0 to R15, RP0 to RP7, RG4 to RG7). For the correspondence, refer to **Table 3-6**.

Table 3-6. Correspondence Between Function Names and Absolute Names

(a) 8-bit registers

Absolute Name	Function Name	
	RSS = 0	RSS = 1 ^{Note}
R0	X	
R1	A	
R2	C	
R3	B	
R4		X
R5		A
R6		C
R7		B
R8		
R9		
R10		
R11		
R12	E	E
R13	D	D
R14	L	L
R15	H	H

(b) 16-bit registers

Absolute Name	Function Name	
	RSS = 0	RSS = 1 ^{Note}
RP0	AX	
RP1	BC	
RP2		AX
RP3		BC
RP4	VP	VP
RP5	UP	UP
RP6	DE	DE
RP7	HL	HL

(c) 24-bit registers

Absolute Name	Function Name
RG4	VVP
RG5	UUP
RG6	TDE
RG7	WHL

Note Use RSS = 1 only when a 78K/III Series program is used.

Remark R8 to R11 do not have function names.

3.9 Special Function Registers (SFRs)

These registers are assigned special functions such as the mode register and control register of the on-chip peripheral hardware and are mapped to the 256-byte area from 0FF00H to 0FFFFH^{Note}.

Note These are the addresses when the LOCATION 0H instruction is executed. They are FFF00H to FFFFFH when the LOCATION 0FH instruction is executed.

Caution In this area, do not access an address that is not allocated by an SFR. If erroneously accessed, the μ PD784218A enters the deadlock state. The deadlock state is released only by reset input.

Table 3-7 shows the list of special function registers (SFRs). The meanings of the items are described next.

- Symbol ... This symbol indicates the on-chip SFR. In NEC Electronics assembler RA78K4, this is a reserved word. In C compiler CC78K4, it can be used as an sfr variable by a #pragma sfr directive.
- R/W ... Indicates whether the corresponding SFR can be read or written.
R/W: Can read/write
R: Read only
W: Write only
- Bit manipulation unit ... When the corresponding SFR is manipulated, the appropriate bit manipulation unit is indicated. An SFR that can manipulate 16 bits can be described in the sfrp operand. If specified by an address, an even address is described.
An SFR that can manipulate one bit can be described in bit manipulation instructions.
- After reset ... Indicates the state of each register when $\overline{\text{RESET}}$ is input.

Table 3-7. Special Function Register (SFR) List (1/5)

Address Note 1	Name of Special Function Register (SFR)	Symbol	R/W	Bit Manipulation Unit			After Reset
				1 Bit	8 Bits	16 Bits	
0FF00H	Port 0	P0	R/W	○	○	—	00H ^{Note 2}
0FF01H	Port 1	P1	R	○	○	—	
0FF02H	Port 2	P2	R/W	○	○	—	
0FF03H	Port 3	P3		○	○	—	
0FF04H	Port 4	P4		○	○	—	
0FF05H	Port 5	P5		○	○	—	
0FF06H	Port 6	P6		○	○	—	
0FF07H	Port 7	P7		○	○	—	
0FF08H	Port 8	P8		○	○	—	
0FF09H	Port 9	P9		○	○	—	
0FF0AH	Port 10	P10		○	○	—	
0FF0CH	Port 12	P12		○	○	—	
0FF0DH	Port 13	P13		○	○	—	
0FF10H	16-bit timer counter	TM0	R	—	—	○	0000H
0FF11H							
0FF12H	16-bit capture/compare register 00 (16-bit timer/event counter)	CR00	R/W	—	—	○	
0FF13H							
0FF14H	16-bit capture/compare register 01 (16-bit timer/event counter)	CR01		—	—	○	
0FF15H							
0FF16H	Capture/compare control register 0	CRC0		○	○	—	00H
0FF18H	16-bit timer mode control register	TMC0		○	○	—	
0FF1AH	16-bit timer output control register	TOC0		○	○	—	
0FF1CH	Prescaler mode register 0	PRM0		○	○	—	
0FF20H	Port 0 mode register	PM0		○	○	—	FFH
0FF22H	Port 2 mode register	PM2		○	○	—	
0FF23H	Port 3 mode register	PM3		○	○	—	
0FF24H	Port 4 mode register	PM4		○	○	—	
0FF25H	Port 5 mode register	PM5		○	○	—	
0FF26H	Port 6 mode register	PM6		○	○	—	
0FF27H	Port 7 mode register	PM7		○	○	—	
0FF28H	Port 8 mode register	PM8		○	○	—	
0FF29H	Port 9 mode register	PM9		○	○	—	
0FF2AH	Port 10 mode register	PM10		○	○	—	

- Notes**
1. These values are when the LOCATION 0H instruction is executed. When the LOCATION 0FH instruction is executed, F0000H is added to these values.
 2. Since each port is initialized in the input mode by a reset, in fact, 00H is not read out. The output latch is initialized to 0.

Table 3-7. Special Function Register (SFR) List (2/5)

Address Note 1	Name of Special Function Register (SFR)	Symbol		R/W	Bit Manipulation Unit			After Reset
					1 Bit	8 Bits	16 Bits	
0FF2CH	Port 12 mode register	PM12		R/W	○	○	—	FFH
0FF2DH	Port 13 mode register	PM13			○	○	—	
0FF30H	Pull-up resistor option register 0	PU0			○	○	—	00H
0FF32H	Pull-up resistor option register 2	PU2			○	○	—	
0FF33H	Pull-up resistor option register 3	PU3			○	○	—	
0FF37H	Pull-up resistor option register 7	PU7			○	○	—	
0FF38H	Pull-up resistor option register 8	PU8			○	○	—	
0FF3AH	Pull-up resistor option register 10	PU10			○	○	—	
0FF3CH	Pull-up resistor option register 12	PU12			○	○	—	
0FF40H	Clock output control register	CKS			○	○	—	
0FF42H	Port function control register ^{Note 2}	PF2			○	○	—	
0FF4EH	Pull-up resistor option register	PUO			○	○	—	
0FF50H	8-bit timer counter 1	TM1	TW1W	R	—	○	○	0000H
0FF51H	8-bit timer counter 2	TM2			—	○		
0FF52H	Compare register 10 (8-bit timer/event counter 1)	CR10	CR1W	R/W	—	○	○	
0FF53H	Compare register 20 (8-bit timer/event counter 2)	CR20			—	○		
0FF54H	8-bit timer mode control register 1	TMC1	TMC1W		○	○	○	
0FF55H	8-bit timer mode control register 2	TMC2			○	○		
0FF56H	Prescaler mode register 1	PRM1	PRM1W		○	○	○	
0FF57H	Prescaler mode register 2	PRM2			○	○		
0FF60H	8-bit timer counter 5	TM5	TM5W	R	—	○	○	
0FF61H	8-bit timer counter 6	TM6			—	○		
0FF62H	8-bit timer counter 7	TM7	TM7W		—	○	○	
0FF63H	8-bit timer counter 8	TM8			—	○		
0FF64H	Compare register 50 (8-bit timer/event counter 5)	CR50	CR5W	R/W	—	○	○	
0FF65H	Compare register 60 (8-bit timer/event counter 6)	CR60			—	○		
0FF66H	Compare register 70 (8-bit timer/event counter 7)	CR70	CR7W		—	○	○	
0FF67H	Compare register 80 (8-bit timer/event counter 8)	CR80			—	○		
0FF68H	8-bit timer mode control register 5	TMC5	TMC5W		○	○	○	
0FF69H	8-bit timer mode control register 6	TMC6			○	○		
0FF6AH	8-bit timer mode control register 7	TMC7	TMC7W		○	○	○	
0FF6BH	8-bit timer mode control register 8	TMC8			○	○		
0FF6CH	Prescaler mode register 5	PRM5	PRM5W		○	○	○	
0FF6DH	Prescaler mode register 6	PRM6			○	○		

Notes 1. These values are when the LOCATION 0H instruction is executed. When the LOCATION 0FH instruction is executed, F000H is added to these values.

2. Only in the μ PD784216AY, 784218AY Subseries

Table 3-7. Special Function Register (SFR) List (3/5)

Address Note 1	Name of Special Function Register (SFR)	Symbol		R/W	Bit Manipulation Unit			After Reset	
					1 Bit	8 Bits	16 Bits		
0FF6EH	Prescaler mode register 7	PRM7	PRM7W	R/W	○	○	○	0000H	
0FF6FH	Prescaler mode register 8	PRM8			○	○			
0FF70H	Asynchronous serial interface mode register 1	ASIM1		R/W	○	○	—	00H	
0FF71H	Asynchronous serial interface mode register 2	ASIM2			○	○	—		
0FF72H	Asynchronous serial interface status register 1	ASIS1		R	○	○	—		
0FF73H	Asynchronous serial interface status register 2	ASIS2			○	○	—		
0FF74H	Transmission shift register 1	TXS1		W	—	○	—	FFH	
	Reception buffer register 1	RXB1		R	—	○	—		
0FF75H	Transmission shift register 2	TXS2		W	—	○	—		
	Reception buffer register 2	RXB2		R	—	○	—		
0FF76H	Baud rate generator control register 1	BRGC1		R/W	○	○	—	00H	
0FF77H	Baud rate generator control register 2	BRGC2			○	○	—		
0FF7AH	Oscillation mode selection register	CC			○	○	—		
0FF80H	A/D converter mode register	ADM			○	○	—		
0FF81H	A/D converter input selection register	ADIS			○	○	—		
0FF83H	A/D conversion result register	ADCR		R	—	○	—	Undefined	
0FF84H	D/A conversion value setting register 0	DACs0		R/W	○	○	—	00H	
0FF85H	D/A conversion value setting register 1	DACs1			○	○	—		
0FF86H	D/A converter mode register 0	DAM0			○	○	—		
0FF87H	D/A converter mode register 1	DAM1			○	○	—		
0FF88H	ROM correction control register	CORC			○	○	—		
0FF89H	ROM correction address pointer H	CORAH			—	○	—		
0FF8AH	ROM correction address pointer L	CORAL			—	—	○		0000H
0FF8BH									
0FF8CH	External bus type selection register	EBTS		R/W	○	○	—	00H	
0FF8DH	External access status enable register	EXAE			○	○	—		
0FF90H	Serial operating mode register 0	CSIM0			○	○	—		
0FF91H	Serial operating mode register 1	CSIM1			○	○	—		
0FF92H	Serial operating mode register 2	CSIM2			○	○	—		
0FF94H	Serial I/O shift register 0	SIO0			—	○	—		
0FF95H	Serial I/O shift register 1	SIO1			—	○	—		
0FF96H	Serial I/O shift register 2	SIO2			—	○	—		
0FF98H	Real-time output buffer register L	RTBL			—	○	—		
0FF99H	Real-time output buffer register H	RTBH			—	○	—		

Note These values are when the LOCATION 0H instruction is executed. When the LOCATION 0FH instruction is executed, F000H is added to these values.

Table 3-7. Special Function Register (SFR) List (4/5)

Address Note 1	Name of Special Function Register (SFR)	Symbol		R/W	Bit Manipulation Unit			After Reset	
					1 Bit	8 Bits	16 Bits		
0FF9AH	Real-time output port mode register	RTPM		R/W	○	○	—	00H	
0FF9BH	Real-time output port control register	RTPC			○	○	—		
0FF9CH	Watch timer mode control register	WTM			○	○	—		
0FFA0H	External interrupt rising edge enable register	EGP0			○	○	—		
0FFA2H	External interrupt falling edge enable register	EGN0			○	○	—		
0FFA8H	In-service priority register	ISPR		R	○	○	—		
0FFA9H	Interrupt selection control register	SNMI		R/W	○	○	—		
0FFAAH	Interrupt mode control register	IMC			○	○	—	80H	
0FFACH	Interrupt mask flag register 0L	MK0L	MK0	R/W	○	○	○	FFFFH	
0FFADH	Interrupt mask flag register 0H	MK0H			○	○			
0FFAEH	Interrupt mask flag register 1L	MK1L	MK1		○	○	○		
0FFAFH	Interrupt mask flag register 1H	MK1H			○	○			
0FFB0H	I ² C bus control register ^{Note 2}	IICC0			R	○	○	—	00H
0FFB2H	Serial clock prescaler mode register ^{Note 2}	SPRM0				○	○	—	
0FFB4H	Slave address register ^{Note 2}	SVA0				—	○	—	
0FFB6H	I ² C bus status register ^{Note 2}	IICS0			R	○	○	—	
0FFB8H	Serial shift register ^{Note 2}	IIC0			R/W	○	○	—	
0FFC0H	Standby control register	STBC				—	○	—	30H
0FFC2H	Watchdog timer mode register	WDM		—		○	—	00H	
0FFC4H	Memory expansion mode register	MM		○		○	—	20H	
0FFC7H	Programmable wait control register 1	PWC1		○		○	—	AAH	
0FFC8H	Programmable wait control register 2	PWC2		W	—	—	○	AAAAH	
0FFCEH	Clock status register	PCS		R	○	○	—	32H	
0FFCFH	Oscillation stabilization time specification register	OSTS		R/W	○	○	—	00H	
0FFD0H to 0FFDFH	External SFR area	—			○	○	—	—	
0FFE0H	Interrupt control register (INTWDTM)	WDTIC			○	○	—	43H	
0FFE1H	Interrupt control register (INTP0)	PIC0			○	○	—		
0FFE2H	Interrupt control register (INTP1)	PIC1			○	○	—		
0FFE3H	Interrupt control register (INTP2)	PIC2			○	○	—		
0FFE4H	Interrupt control register (INTP3)	PIC3			○	○	—		
0FFE5H	Interrupt control register (INTP4)	PIC4			○	○	—		
0FFE6H	Interrupt control register (INTP5)	PIC5			○	○	—		
0FFE7H	Interrupt control register (INTP6)	PIC6			○	○	—		
0FFE8H	Interrupt control register (INTIIC0 ^{Note 2} /INTCSI0)	CSIIC0		○	○	—			

Notes 1. These values are when the LOCATION 0H instruction is executed. When the LOCATION 0FH instruction is executed, F000H is added to these values.

2. Only in the μ PD784216AY, 784218AY Subseries

Table 3-7. Special Function Register (SFR) List (5/5)

Address Note 1	Name of Special Function Register (SFR)	Symbol	R/W	Bit Manipulation Unit			After Reset
				1 Bit	8 Bits	16 Bits	
0FFE9H	Interrupt control register (INTSER1)	SERIC1	R/W	○	○	—	43H
0FFEAH	Interrupt control register (INTSR1/INTCSI1)	SRIC1		○	○	—	
0FFEBH	Interrupt control register (INTST1)	STIC1		○	○	—	
0FFECH	Interrupt control register (INTSER2)	SERIC2		○	○	—	
0FFEDH	Interrupt control register (INTSR2/INTCSI2)	SRIC2		○	○	—	
0FEEH	Interrupt control register (INTST2)	STIC2		○	○	—	
0FFEFH	Interrupt control register (INTTM3)	TMIC3		○	○	—	
0FFF0H	Interrupt control register (INTTM00)	TMIC00		○	○	—	
0FFF1H	Interrupt control register (INTTM01)	TMIC01		○	○	—	
0FFF2H	Interrupt control register (INTTM1)	TMIC1		○	○	—	
0FFF3H	Interrupt control register (INTTM2)	TMIC2		○	○	—	
0FFF4H	Interrupt control register (INTAD)	ADIC		○	○	—	
0FFF5H	Interrupt control register (INTTM5)	TMIC5		○	○	—	
0FFF6H	Interrupt control register (INTTM6)	TMIC6		○	○	—	
0FFF7H	Interrupt control register (INTTM7)	TMIC7		○	○	—	
0FFF8H	Interrupt control register (INTTM8)	TMIC8		○	○	—	
0FFF9H	Interrupt control register (INTWT)	WTIC		○	○	—	
0FFFAH	Interrupt control register (INTKR)	KRIC		○	○	—	
0FFFBH	Internal memory size switching register ^{Note 2}	IMS	W	—	○	—	FFH

- Notes**
1. These values are when the LOCATION 0H instruction is executed. When the LOCATION 0FH instruction is executed, F000H is added to these values.
 2. Only in the μ PD78F4216A, 78F4218A, 78F4216AY, and 78F4218AY

3.10 Cautions

(1) Program fetches are not possible from the internal high-speed RAM area (when executing the LOCATION 0H instruction: 0FD00H to 0FEFFH, when executing the LOCATION 0FH instruction: FFD00H to FFEFFH)

(2) Special function register (SFR)

Do not access an address that is allocated to an SFR in the area from 0FF00H to 0FFFFH^{Note}. If mistakenly accessed, the μ PD784218A enters the deadlock state. The deadlock state is released only by $\overline{\text{RESET}}$ input.

Note These addresses are when the LOCATION 0H instruction is executed. They are FFF00H to FFFFFH when the LOCATION 0FH instruction is executed.

(3) Stack pointer (SP) operation

Although the entire 1 MB space can be accessed by stack addressing, the stack cannot be guaranteed in the SFR area and the internal ROM area.

(4) Stack pointer (SP) initialization

The SP becomes undefined when $\overline{\text{RESET}}$ is input. Even after a reset is cleared, non-maskable interrupts can be accepted. Therefore, the SP enters an undefined state immediately after clearing the reset. When a non-maskable interrupt request is generated, unexpected operations sometimes occur. To minimize these dangers, always describe the following in the program immediately after clearing a reset.

```

RSTVCT    CSEG AT 0
          DW    RSTSTRT
          :
INITSEG   CSEG BASE
RSTSTRT:  LOCATION 0H; or LOCATION 0FH
          MOVG SP, #STKBGN

```

CHAPTER 4 CLOCK GENERATOR

4.1 Functions

The clock generator generates the clock to be supplied to the CPU and peripheral hardware. The following two types of system clock oscillators are available.

(1) Main system clock oscillator

This circuit oscillates at a frequency of 2 to 12.5 MHz. Oscillation can be stopped by setting the standby control register (STBC) to STOP mode (bit 1 (STP) = 1, bit 0 (HLT) = 0) or by stopping the main system clock (bit 2 of STBC (MCK) = 1) after switching to the subsystem clock.

(2) Subsystem clock oscillator

This circuit oscillates at the frequency of 32.768 kHz. Oscillation cannot be stopped. If the subsystem clock oscillator is not used, not using the internal feedback resistance can be set by STBC. This enables the power consumption to be decreased in the STOP mode.

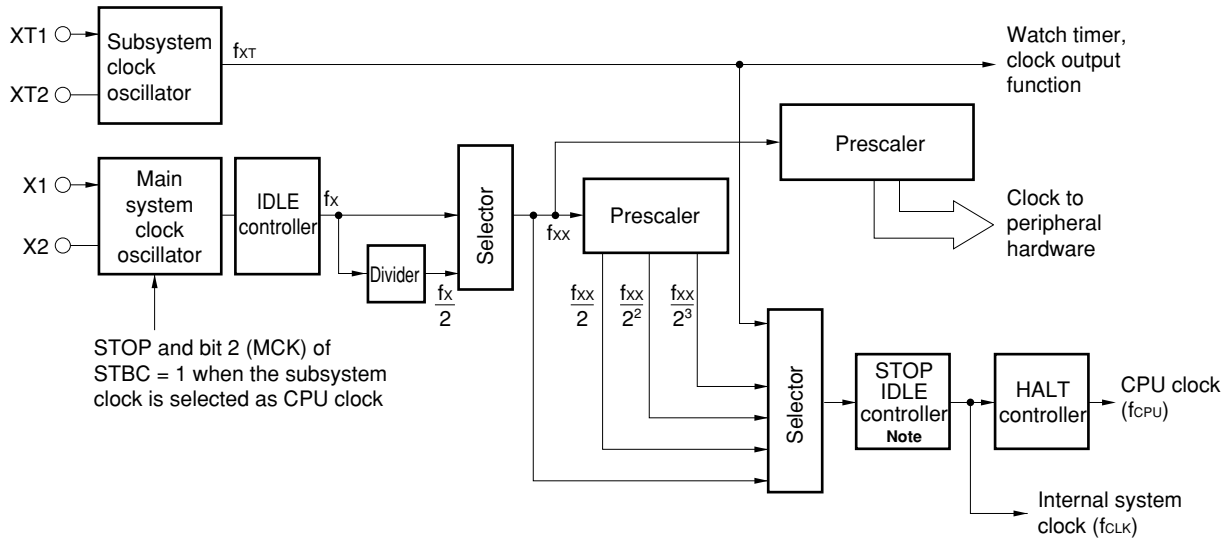
4.2 Configuration

The clock generator consists of the following hardware.

Table 4-1. Clock Generator Configuration

Item	Configuration
Control register	Standby control register (STBC) Oscillation mode selection register (CC) Clock status register (PCS) Oscillation stabilization time specification register (OSTS)
Oscillator	Main system clock oscillator Subsystem clock oscillator

Figure 4-1. Block Diagram of Clock Generator



Note The oscillation stabilization time is secured after STOP mode is released.

4.3 Control Registers

(1) Standby control register (STBC)

This register is used to set the standby mode and select internal system clock. For the details of the standby mode, refer to **CHAPTER 25 STANDBY FUNCTION**.

The write operation can be performed only using dedicated instructions to avoid entering into the standby mode due to an inadvertent program loop. This dedicated instruction, MOV STBC, #byte, has a special code structure (4 bytes). The write operation is performed only when the OP code of the 3rd byte and 4th byte are mutual 1's complements. When the 3rd byte and 4th byte are not mutual 1's complements, the write operation is not performed and an operand error interrupt is generated. In this case, the return address saved in the stack area indicates the address of the instruction that caused an error. Therefore, the address that caused an error can be determined from the return address that is saved in the stack area.

If a return from an operand error is performed simply with the RETB instruction, an infinite loop will be caused. Because the operand error interrupt occurs only in the case of an inadvertent program loop (if MOV STBC, #byte is described, only the correct dedicated instruction is generated in NEC Electronics RA78K4 assembler), initialize the system for the program that processes an operand error interrupt.

Other write instructions such as MOV STBC, A; AND STBC, #byte; and SET1 STBC.7 are ignored and no operation is performed. In other words, neither is a write operation to STBC performed nor is an interrupt such as an operand error interrupt generated. STBC can be read out any time by means of a data transfer instruction. RESET input sets STBC to 30H.

Figure 4-2 shows the format of STBC.

Figure 4-2. Standby Control Register (STBC) Format

Address: 0FFC0H After reset: 30H R/W

Symbol	7	6	5	4	3	2	1	0
STBC	SBK	CK2	CK1	CK0	0	MCK	STP	HLT

SBK	Subsystem clock oscillation control
0	Use oscillator (Internal feedback resistor is used.)
1	Stop oscillator (Internal feedback resistor is not used.)

CK2	CK1	CK0	CPU clock selection
0	0	0	f _{xx}
0	0	1	f _{xx} /2
0	1	0	f _{xx} /4
0	1	1	f _{xx} /8
1	1	1	f _{xT} (recommended)
1	×	×	f _{xT}

MCK	Main system clock oscillation control
0	Use oscillator (Internal feedback resistor is used.)
1	Stop oscillator (Internal feedback resistor is not used.)

STP	HLT	Operation specification flag
0	0	Normal operation mode
0	1	HALT mode (Automatically cleared upon cancellation of HALT mode)
1	0	STOP mode (Automatically cleared upon cancellation of STOP mode)
1	1	IDLE mode (Automatically cleared upon cancellation of IDLE mode)

Cautions 1. When using the STOP mode during external clock input, make sure to set to 1 the EXTC bit of the oscillation stabilization time specification register (OSTS) before setting the STOP mode. If the STOP mode is used during external clock input when the EXTC bit of OSTS has been cleared, the μ PD784218A may be damaged or its reliability may be impaired.

When setting to 1 the EXTC bit of OSTS, the clock with the opposite phase of the clock input to the X1 pin must be input to the X2 pin.

2. Perform the NOP instruction three times after a standby instruction (after standby release). Otherwise if contention arises between a standby instruction execution and an interrupt request, the standby instruction is not performed and the interrupt request is accepted after the execution of several instructions. The instructions executed before the interrupt request is accepted are instructions whose execution is started within 6 clocks maximum following execution of the standby instruction.

```

Example  MOV STBC, #byte
          NOP
          NOP
          NOP
          .
          .
          .
    
```

3. When CK2 = 0, the oscillation of the main system clock does not stop even if MCK is set to 1 (refer to 4.5.1 Main system clock operations).

- Remarks**
1. fxx: Main system clock frequency (fx or fx/2)
 fx: Main system clock oscillation frequency
 fxt: Subsystem clock oscillation frequency
 2. x: don't care

(2) Oscillation mode selection register (CC)

This register specifies whether clock output from the main system clock oscillator with the same frequency as the external clock is used to operate the internal circuit (through rate clock mode), or whether clock output that is half of the original frequency is used to operate the internal circuit.

CC is set by a 1-bit or 8-bit memory manipulation instruction.

$\overline{\text{RESET}}$ input sets CC to 00H.

Figure 4-3. Oscillation Mode Selection Register (CC) Format

Address: 0FF7AH After reset: 00H R/W

Symbol	7	6	5	4	3	2	1	0
CC	ENMP	0	0	0	0	0	0	0

ENMP	Main system clock selection
0	Half of original oscillation frequency
1	Through rate clock mode

- Cautions**
1. If the subsystem clock is selected via the standby control register (STBC), the ENMP bit specification becomes invalid.
 2. The ENMP bit cannot be reset by software. This bit is reset performing the system reset.

(3) Clock status register (PCS)

This register is a read-only 8-bit register that indicates the CPU clock operation status. By reading bit 2 and bits 4 to 7 of PCS, the relevant bit of the standby control register (STBC) can be read.

PCS is set by a 1-bit or 8-bit memory manipulation instruction.

RESET input sets PCS to 32H.

Figure 4-4. Clock Status Register (PCS) Format

Address: 0FFCEH After reset: 32H R

Symbol	7	6	5	4	3	2	1	0
PCS	SBK	CK2	CK1	CK0	0	MCK	1	CST

SBK	Feedback resistor status of subsystem clock
0	Internal feedback resistor is used.
1	Internal feedback resistor is not used.

CK2	CK1	CK0	CPU clock operating frequency
0	0	0	f_{xx}
0	0	1	$f_{xx}/2$
0	1	0	$f_{xx}/4$
0	1	1	$f_{xx}/8$
1	1	1	f_{xt} (recommended)
1	×	×	f_{xt}

MCK	Oscillation status of main system clock
0	Use oscillator
1	Stop oscillator

CST	CPU clock status
0	Main system clock operation
1	Subsystem clock operation

★

Caution [Timing at which bit 0 (CST) changes]

The CPU clock does not switch from the main system clock to the subsystem clock immediately after the standby control register (STBC) is set, but switches after synchronization of both clocks (main and subsystem) has been detected. Consequently, CST changes after synchronization detection. This is the same as when switching from the subsystem clock to the main system clock.

- Remarks**
1. f_{xx} : Main system clock frequency
 f_{xt} : Subsystem clock oscillation frequency
 2. ×: don't care

(4) Oscillation stabilization time specification register (OSTS)

This register specifies the operation of the oscillator. Either a crystal/ceramic resonator or external clock is set to the EXTC bit in OSTS as the clock used. The STOP mode can be set even during external clock input only when the EXTC bit is set 1.

OSTS is set by a 1-bit or 8-bit transfer instruction.

$\overline{\text{RESET}}$ input sets OSTS to 00H.

Figure 4-5. Oscillation Stabilization Time Specification Register (OSTS) Format

Address: 0FFCFH After reset: 00H R/W

Symbol	7	6	5	4	3	2	1	0
OSTS	EXTC	0	0	0	0	OSTS2	OSTS1	OSTS0

EXTC	External clock selection
0	Crystal/ceramic resonator is used
1	External clock is used

EXTC	OSTS2	OSTS1	OSTS0	Oscillation stabilization time selection
0	0	0	0	$2^{19}/f_{xx}$ (42.0 ms)
0	0	0	1	$2^{18}/f_{xx}$ (21.0 ms)
0	0	1	0	$2^{17}/f_{xx}$ (10.5 ms)
0	0	1	1	$2^{16}/f_{xx}$ (5.3 ms)
0	1	0	0	$2^{15}/f_{xx}$ (2.6 ms)
0	1	0	1	$2^{14}/f_{xx}$ (1.3 ms)
0	1	1	0	$2^{13}/f_{xx}$ (0.7 ms)
0	1	1	1	$2^{12}/f_{xx}$ (0.4 ms)
1	×	×	×	$512/f_{xx}$ (41.0 μ s)

- Cautions**
1. When a crystal/ceramic resonator is used, make sure to clear the EXTC bit to 0. If the EXTC bit is set to 1, oscillation stops.
 2. When using the STOP mode during external clock input, make sure to set the EXTC bit to 1 before setting the STOP mode. If the STOP mode is used during external clock input when the EXTC bit of OSTS has been cleared, the μ PD784218A may be damaged or its reliability may be impaired.
 3. If the EXTC bit is set to 1 during external clock input, the opposite phase of the clock input to the X1 pin must be input to the X2 pin. If the EXTC bit is set to 1, the μ PD784218A operates only with the clock input to the X2 pin.

- Remarks**
1. Figures in parentheses apply to operation with $f_{xx} = 12.5$ MHz.
 2. ×: don't care

4.4 System Clock Oscillator

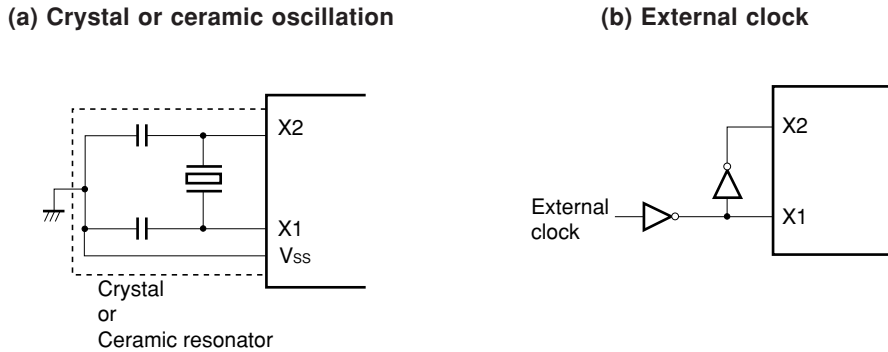
4.4.1 Main system clock oscillator

The main system clock oscillator oscillates with a crystal resonator or a ceramic resonator (standard: 12.5 MHz) connected to the X1 and X2 pins.

External clocks can be input to the main system clock oscillator. In this case, input a clock signal to the X1 pin and an antiphase clock signal to the X2 pin.

Figure 4-6 shows an external circuit of the main system clock oscillator.

Figure 4-6. External Circuit of Main System Clock Oscillator



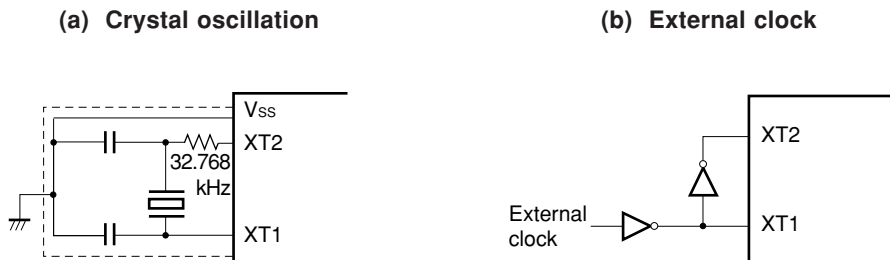
4.4.2 Subsystem clock oscillator

The subsystem clock oscillator oscillates with a crystal resonator (standard: 32.768 kHz) connected to the XT1 and XT2 pins.

External clocks can be input to the main system clock oscillator. In this case, input a clock signal to the XT1 pin and an antiphase clock signal to the XT2 pin.

Figure 4-7 shows an external circuit of the subsystem clock oscillator.

Figure 4-7. External Circuit of Subsystem Clock Oscillator



Cautions 1. When using a main system clock oscillator and a subsystem clock oscillator, carry out wiring in the broken line area in Figures 4-6 and 4-7 to prevent any effects from wiring capacities.

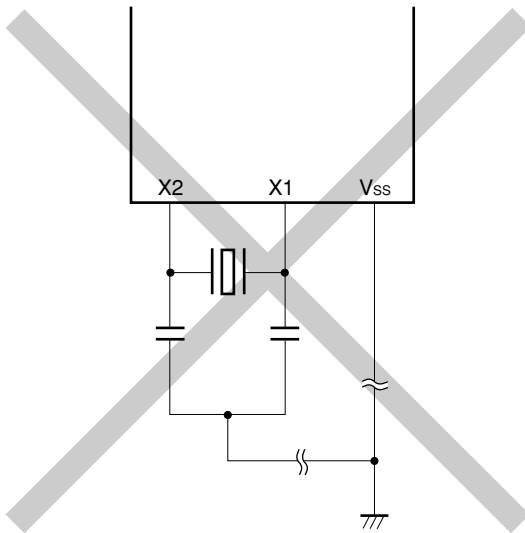
- Minimize the wiring length.
- Do not allow wiring to intersect with other signal conductors. Do not allow wiring to come near changing high current.
- Set the potential of the grounding position of the oscillator capacitor to that of V_{SS} . Do not ground to any ground pattern where high current is present.
- Do not fetch signals from the oscillator.

Take special note of the fact that the subsystem clock oscillator is a circuit with low-level amplification so that current consumption is maintained at low levels.

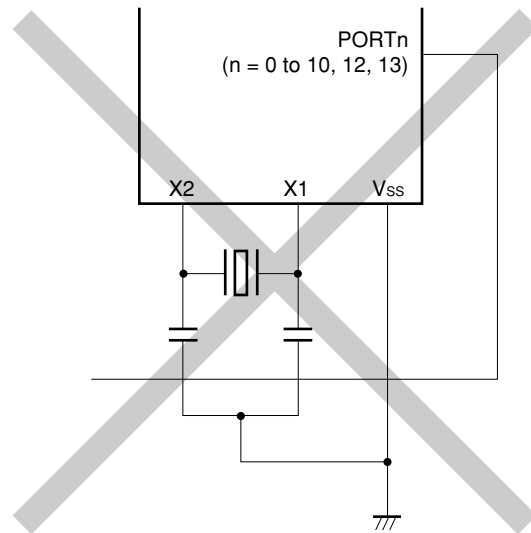
Figure 4-8 shows examples of oscillators that are connected incorrectly.

Figure 4-8. Examples of Oscillator Connected Incorrectly (1/2)

(a) Wiring of connection circuits is too long



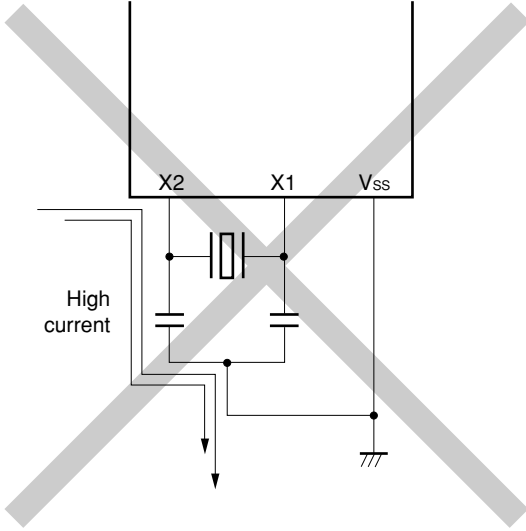
(b) Signal conductors intersect each other



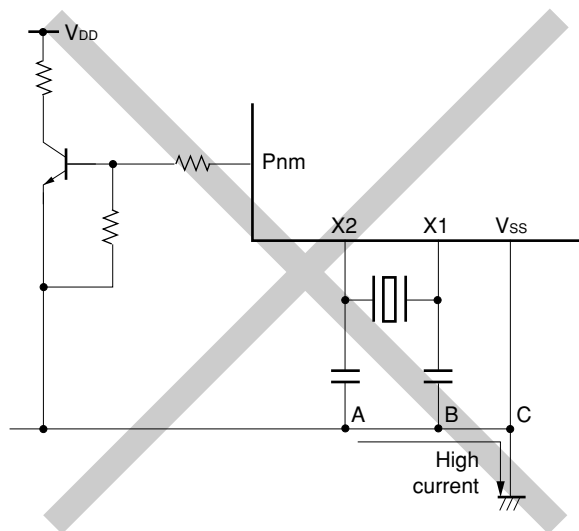
Remark When using a subsystem clock, replace X1 and X2 with XT1 and XT2, respectively. Also, insert resistors in series on the XT2 side.

Figure 4-8. Examples of Oscillator Connected Incorrectly (2/2)

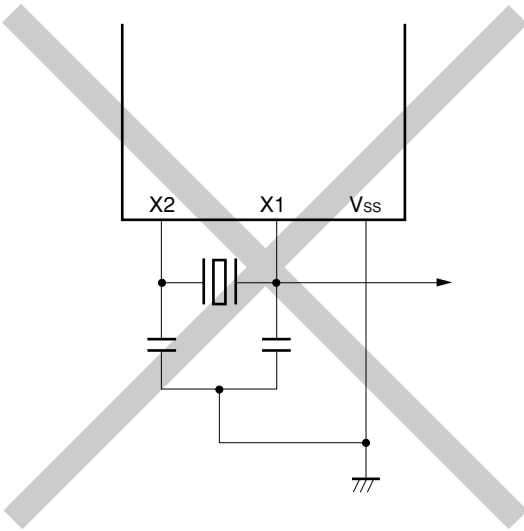
(c) Changing high current is too near a signal conductor



(d) Current flows through the ground line of the oscillator (potential at points A, B, and C fluctuate)



(e) Signals are fetched



Remark When using a subsystem clock, replace X1 and X2 with XT1 and XT2, respectively. Also, insert resistors in series on the XT2 side.

Cautions 2. When XT2 and X1 are wired in parallel, the cross-talk noise of X1 may increase with XT2, resulting in malfunctioning. To prevent this from occurring, it is recommended not to wire X1 and XT2 in parallel.

4.4.3 Frequency divider

The frequency divider divides the main system clock oscillator output (f_{xx}) and generates various clocks.

4.4.4 When no subsystem clocks are used

If it is not necessary to use subsystem clocks for low power consumption operations and clock operations, connect the XT1 and XT2 pins as follows.

XT1: Connect to V_{ss}

XT2: Leave open

In this state, however, some current may leak via the internal feedback resistor of the subsystem clock oscillator when the main system clock stops. To minimize leakage current, set bit 7 (SBK) of the standby control register (STBC) to 1. In this case also, connect the XT1 and XT2 pins as described above.

4.5 Clock Generator Operations

The clock generator generates the following types of clocks and controls the CPU operating mode including the standby mode.

- Main system clock (f_{xx})
- Subsystem clock (f_{xT})
- CPU clock (f_{CPU})
- Clock to peripheral hardware

The following clock generator functions and operations are determined with the standby control register (STBC) and the oscillation mode selection register (CC).

- Upon generation of the $\overline{\text{RESET}}$ signal, the lowest speed mode of the main system clock (1,280 ns when operated at 12.5 MHz) is selected (STBC = 30H, CC = 00H). Main system clock oscillation stops while low level is applied to the $\overline{\text{RESET}}$ pin.
- With the main system clock selected, one of the five CPU clock types (80 ns, 160 ns, 320 ns, 640 ns, 1,280 ns when operated at 12.5 MHz) can be selected by setting the STBC and CC.
- With the main system clock selected, two standby modes, the STOP mode and the HALT mode, are available. To decrease current consumption in the STOP mode, the subsystem clock feedback resistor can be disconnected to stop the subsystem clock with bit 7 (SBK) of STBC, when the system does not use a subsystem clock.
- STBC can be used to select the subsystem clock and to operate the system with low current consumption (30.5 μs when operated at 32.768 kHz).
- With the subsystem clock selected, main system clock oscillation can be stopped with STBC. The HALT mode can be used. However, the STOP mode cannot be used (Subsystem clock oscillation cannot be stopped).
- The main system clock is divided and supplied to the peripheral hardware. The subsystem clock is supplied to the 16-bit timer/counter, the watch timer, and clock output functions only. Thus, the 16-bit timer/counter (when watch timer output is selected for count clock during operation with a subsystem clock), the watch function, and the clock output function can also be continued in the standby state. However, since all other peripheral hardware operate with the main system clock, the peripheral hardware (except external input clock operation) also stops if the main system clock is stopped.

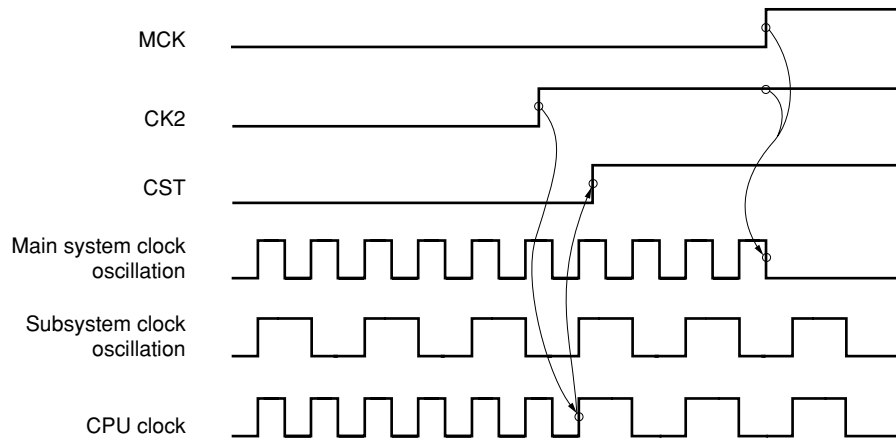
4.5.1 Main system clock operations

During operation with the main system clock (with bit 6 (CK2) of the standby control register (STBC) set to 0), the following operations are carried out.

- (a) Because the operation guarantee instruction execution speed depends on the power supply voltage, the instruction execution time can be changed by setting bits 4 to 6 (CK0 to CK2) of the STBC.
- (b) If bit 2 (MCK) of the STBC is set to 1 when operated with the main system clock, the main system clock oscillation does not stop. When bit 6 (CK2) of the STBC is set to 1 and the operation is switched to subsystem clock operation (CST = 1) after that, the main system clock oscillation stops (refer to **Figure 4-9**).

Figure 4-9. Main System Clock Stop Function (1/2)

(a) Operation when MCK is set after setting CK2 during main system clock operation



(b) Operation when MCK is set during main system clock operation

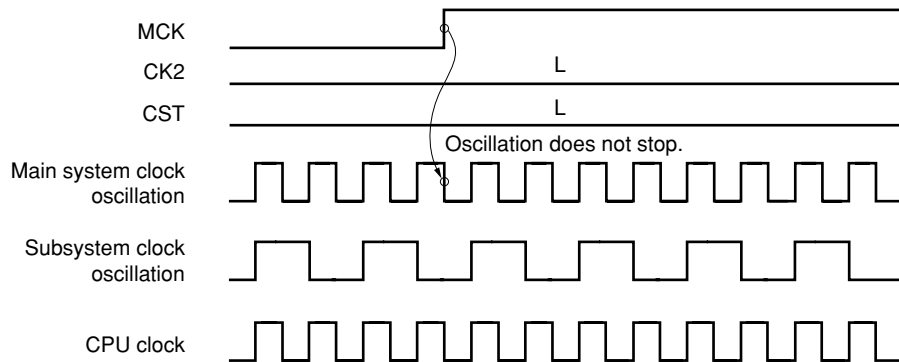
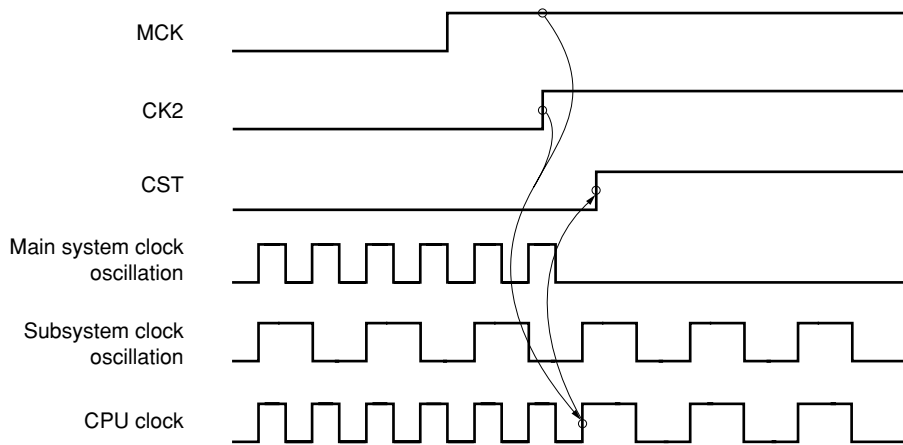


Figure 4-9. Main System Clock Stop Function (2/2)

(c) Operation when CK2 is set after setting MCK during main system clock operation



4.5.2 Subsystem clock operations

When operated with the subsystem clock (with bit 6 (CK2) of the standby control register (STBC) set to 1), the following operations are carried out.

- (a) The instruction execution time remains constant (minimum instruction execution time: 61 μ s when operated at 32.768 kHz) irrespective of the setting of bits 4 and 5 (CK0 and CK1) of the STBC.
- (b) Watchdog timer continues operating.

Caution Do not set the STOP mode while the subsystem clock is operating.

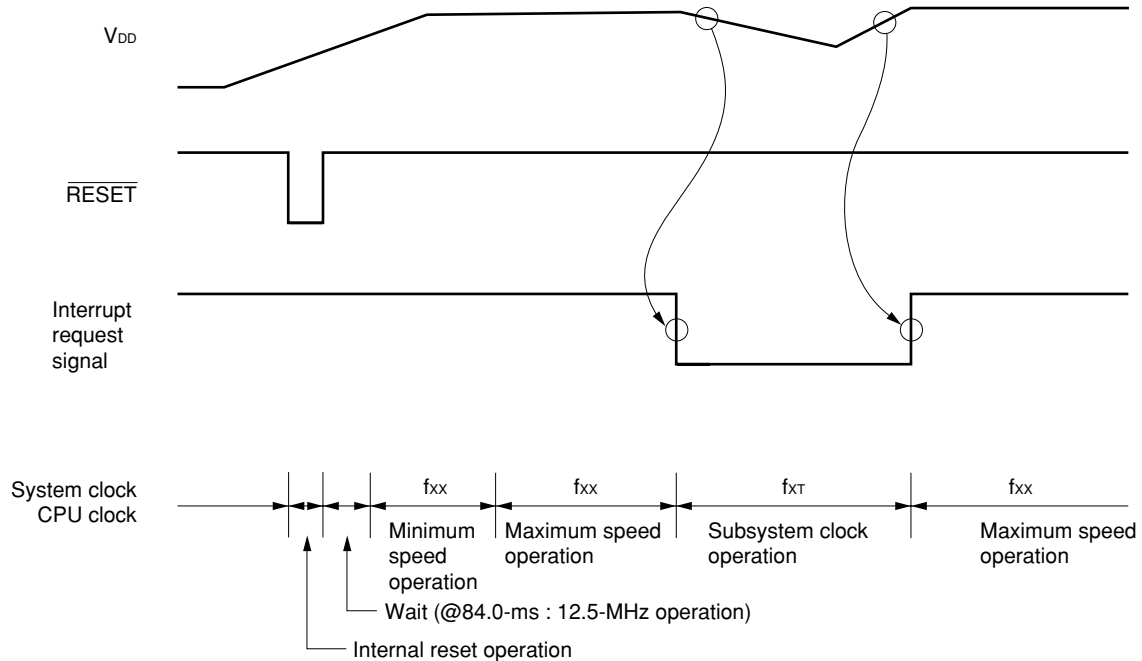
4.6 Changing System Clock and CPU Clock Settings

The system clock and CPU clock can be switched by means of bits 4 to 6 (CK0 to CK2) of the standby control register (STBC).

Whether the system is operating on the main system clock or the subsystem clock can be determined by the value of bit 0 (CST) of the clock status register (PCS).

This section describes the switching procedure between the system clock and the CPU clock.

Figure 4-10. System Clock and CPU Clock Switching



- (1) The CPU is reset by setting the $\overline{\text{RESET}}$ signal to low level after power-on. After that, when reset is released by setting the $\overline{\text{RESET}}$ signal to high level, the main system clock starts oscillating. At this time, the oscillation stabilization time ($2^{20}/f_x$) is secured automatically. After that, the CPU starts executing the instruction at the minimum speed of the main system clock (1,280 ns when operated at 12.5 MHz).
- (2) After the lapse of a sufficient time for the V_{DD} voltage to increase to enable operation at maximum speed, the STBC and CC are rewritten and maximum-speed operation is carried out.
- (3) Upon detection of a decrease in the V_{DD} voltage due to an interrupt, the main system clock is switched to the subsystem clock (which must be in a stable oscillation state).
- (4) Upon detection of V_{DD} voltage reset due to an interrupt, 0 is set to STBC bit 2 (MCK) and oscillation of the main system clock is started. After the lapse of time required for stabilization of oscillation, STBC is rewritten and maximum-speed operation is resumed.

Caution When a subsystem clock is being operated while the main system clock is stopped, if switching back to the main system clock, be sure to switch after securing the oscillation stabilization time by program.

CHAPTER 5 PORT FUNCTIONS

5.1 Digital Input/Output Ports

The ports shown in Figure 5-1, which enable a variety of controls, are provided. The function of each port is described in Table 5-1. On-chip pull-up resistors can be specified for ports 0, 2 to 8, 10, and 12 by software during input.

Figure 5-1. Port Configuration

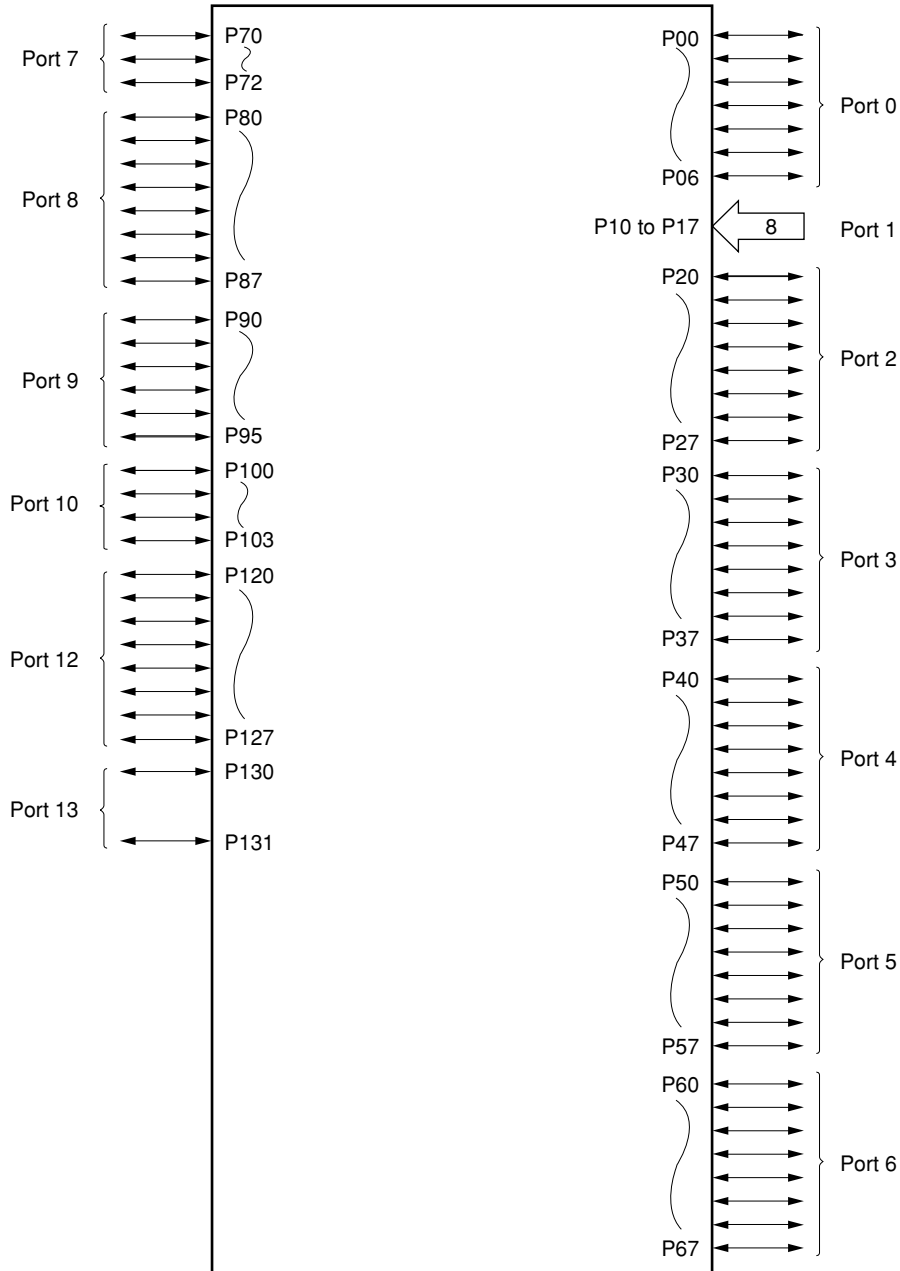


Table 5-1. Port Functions

Port	Pin Name	Function	Specification of Software Pull-Up Resistor
Port 0	P00 to P06	• Can be specified for input or output in 1-bit units	Specifiable in 1-bit units
Port 1	P10 to P17	• Input port	—
Port 2	P20 to P27	• Can be specified for input or output in 1-bit units	Specifiable in 1-bit units
Port 3	P30 to P37	• Can be specified for input or output in 1-bit units	Specifiable in 1-bit units
Port 4	P40 to P47	• Can be specified for input or output in 1-bit units • Can drive LED directly	Specifiable individually for each port
Port 5	P50 to P57	• Can be specified for input or output in 1-bit units • Can drive LED directly	Specifiable individually for each port
Port 6	P60 to P67	• Can be specified for input or output in 1-bit units	Specifiable individually for each port
Port 7	P70 to P72	• Can be specified for input or output in 1-bit units	Specifiable in 1-bit units
Port 8	P80 to P87	• Can be specified for input or output in 1-bit units	Specifiable in 1-bit units
Port 9	P90 to P95	• N-ch open drain I/O port • Can be specified for input or output in 1-bit units • Can drive LED directly	—
Port 10	P100 to P103	• Can be specified for input or output in 1-bit units	Specifiable in 1-bit units
Port 12	P120 to P127	• Can be specified for input or output in 1-bit units	Specifiable in 1-bit units
Port 13	P130, P131	• Can be specified for input or output in 1-bit units	—

5.2 Port Configuration

Ports consist of the following hardware:

Table 5-2. Port Configuration

Item	Configuration
Control register	Port mode register (PMm: m = 0, 2 to 10, 12, 13) Pull-up resistor option register (PUO, PUm: m = 0, 2, 3, 7, 8, 10, 12)
Port	Total: 86 ports (8 inputs, 78 inputs/outputs)
Pull-up resistor	Total: 70 (software control)

5.2.1 Port 0

Port 0 is a 7-bit input/output port with output latch. The P00 to P06 pins can specify the input mode/output mode in 1-bit units with the port 0 mode register. A pull-up resistor can be connected to the P00 to P06 pins via pull-up resistor option register 0, regardless of whether the input mode or output mode is specified.

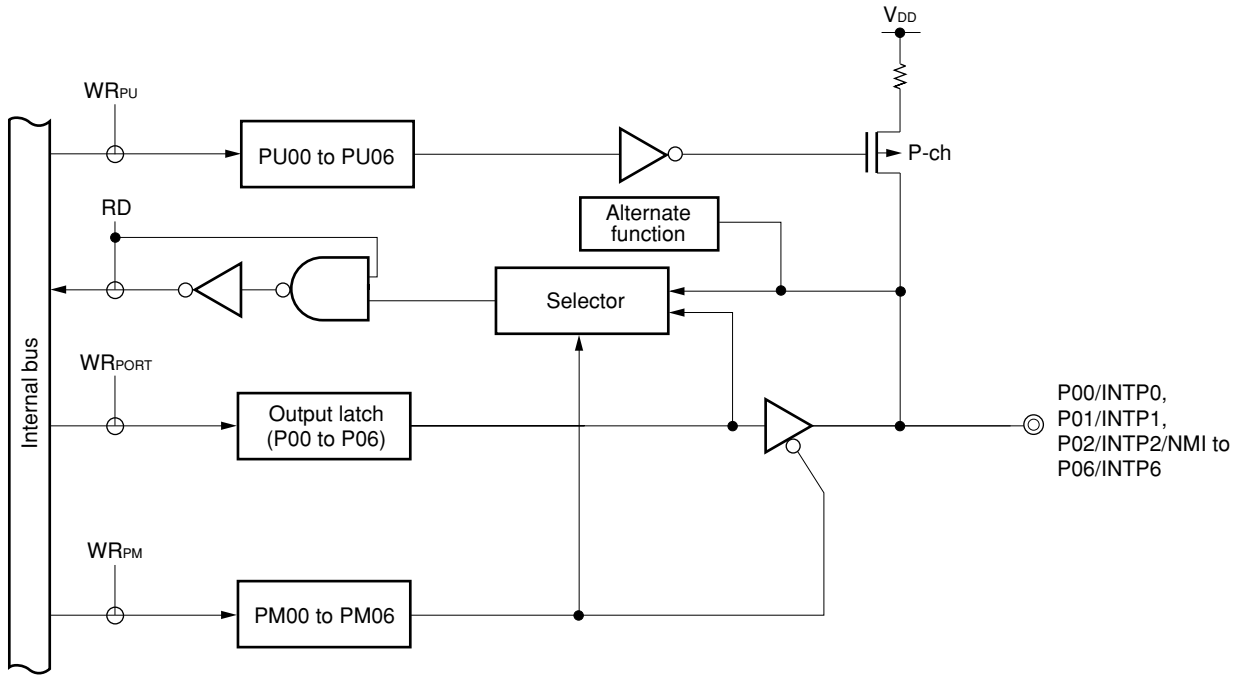
Port 0 also supports external interrupt request input as an alternate function.

$\overline{\text{RESET}}$ input sets port 0 to the input mode.

Figure 5-2 shows the block diagram of port 0.

Caution Even though port 0 is also used as an external interrupt input, when port 0 is not used as an interrupt input pin, be sure to set interrupt disabled by using the external interrupt rising edge enable register (EGP0) and external interrupt falling edge enable register (EGN0) or setting the interrupt enable flag (PMKn: n = 0 to 5) to 1. Otherwise, the interrupt request flag is set and unintentional interrupt servicing may be executed when specifying ports in output mode and thus changing the output level.

Figure 5-2. Block Diagram of P00 to P06



- PU: Pull-up resistor option register
- PM: Port mode register
- RD: Port 0 read signal
- WR: Port 0 write signal

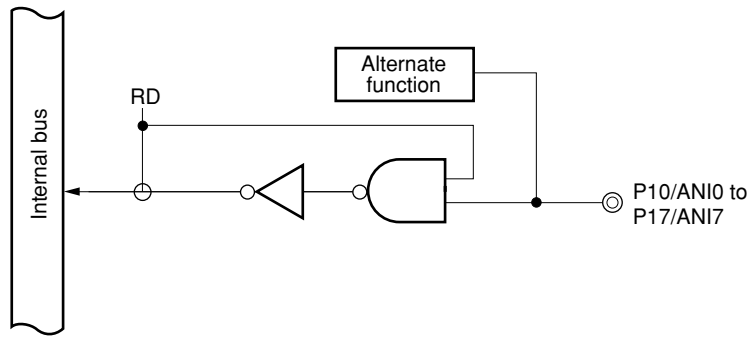
5.2.2 Port 1

This is an 8-bit input-only port with no on-chip pull-up resistor.

Port 1 supports A/D converter analog input as an alternate function.

Figure 5-3 shows a block diagram of port 1.

Figure 5-3. Block Diagram of P10 to P17



RD: Port 1 read signal

5.2.3 Port 2

Port 2 is an 8-bit input/output port with output latch. P20 to P27 pins can specify the input mode/output mode in 1-bit units with the port 2 mode register. A pull-up resistor can be connected to the P20 to P27 pins via pull-up resistor option register 2, regardless of whether the input mode or output mode is specified.

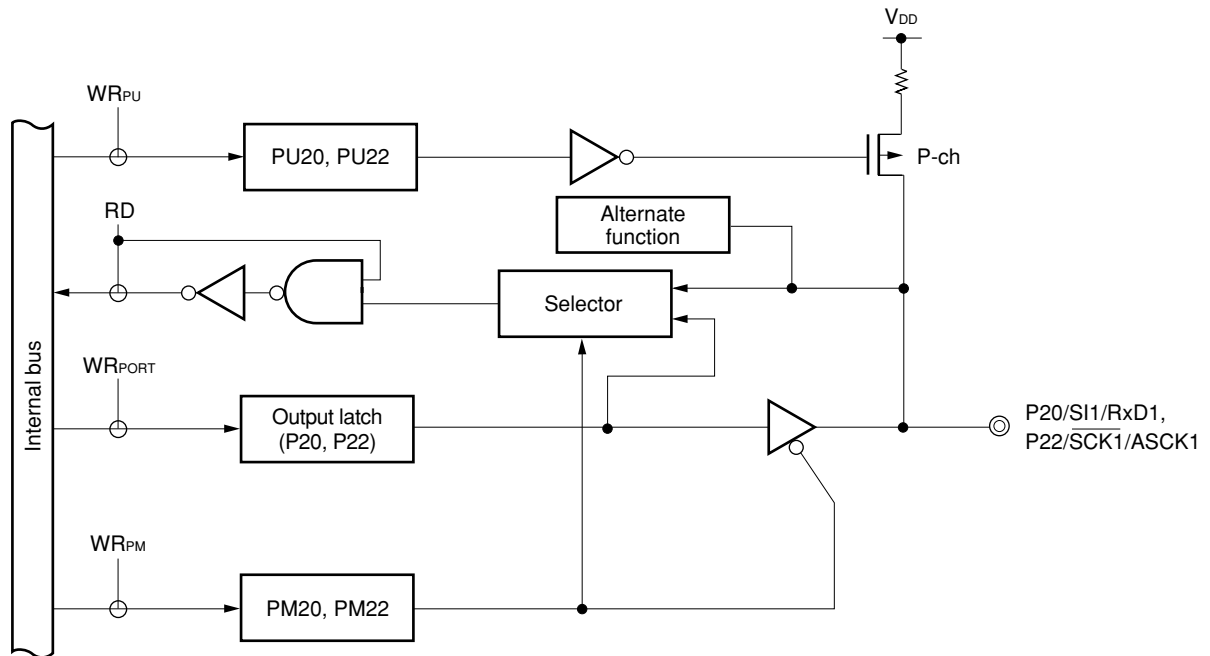
The P25 and P27 pins can be specified as N-ch open-drain with a port function control register (only μ PD784216AY, 784218AY Subseries).

Port 2 supports serial interface data input/output, clock input/output, clock output, and buzzer output as alternate functions.

$\overline{\text{RESET}}$ input sets port 2 to the input mode.

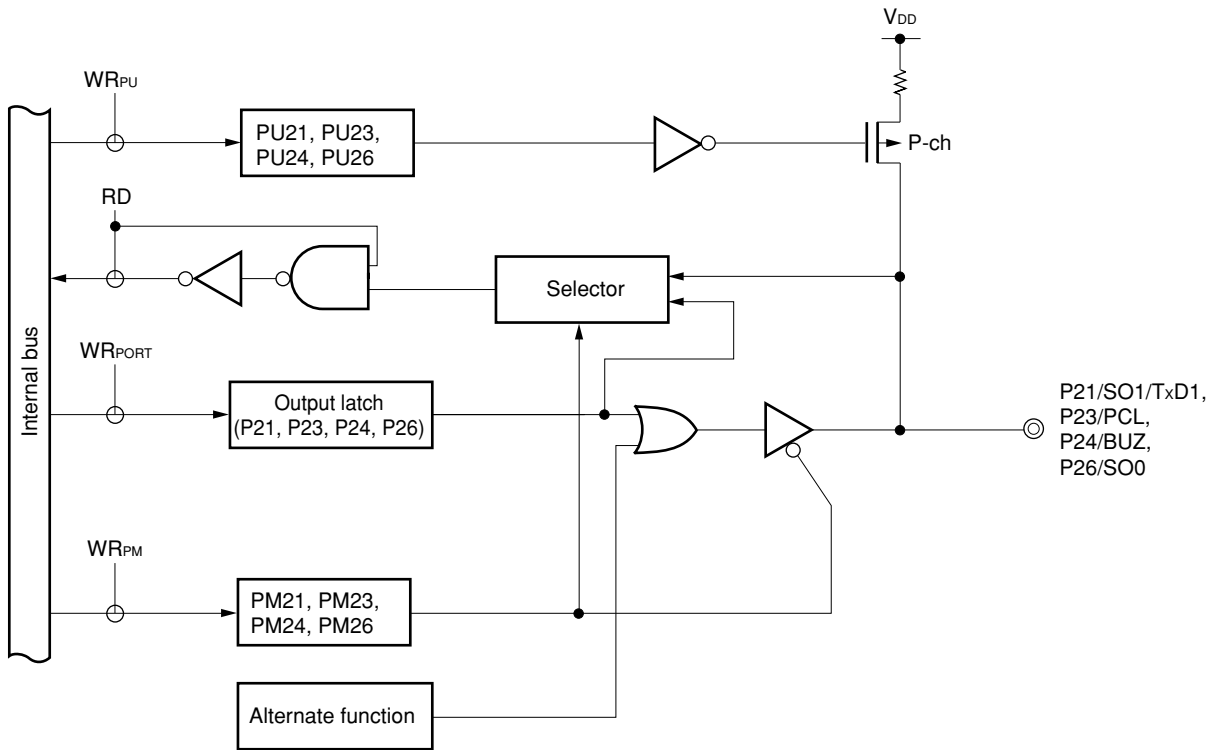
Figures 5-4 to 5-7 show block diagrams of port 2.

Figure 5-4. Block Diagram of P20 and P22



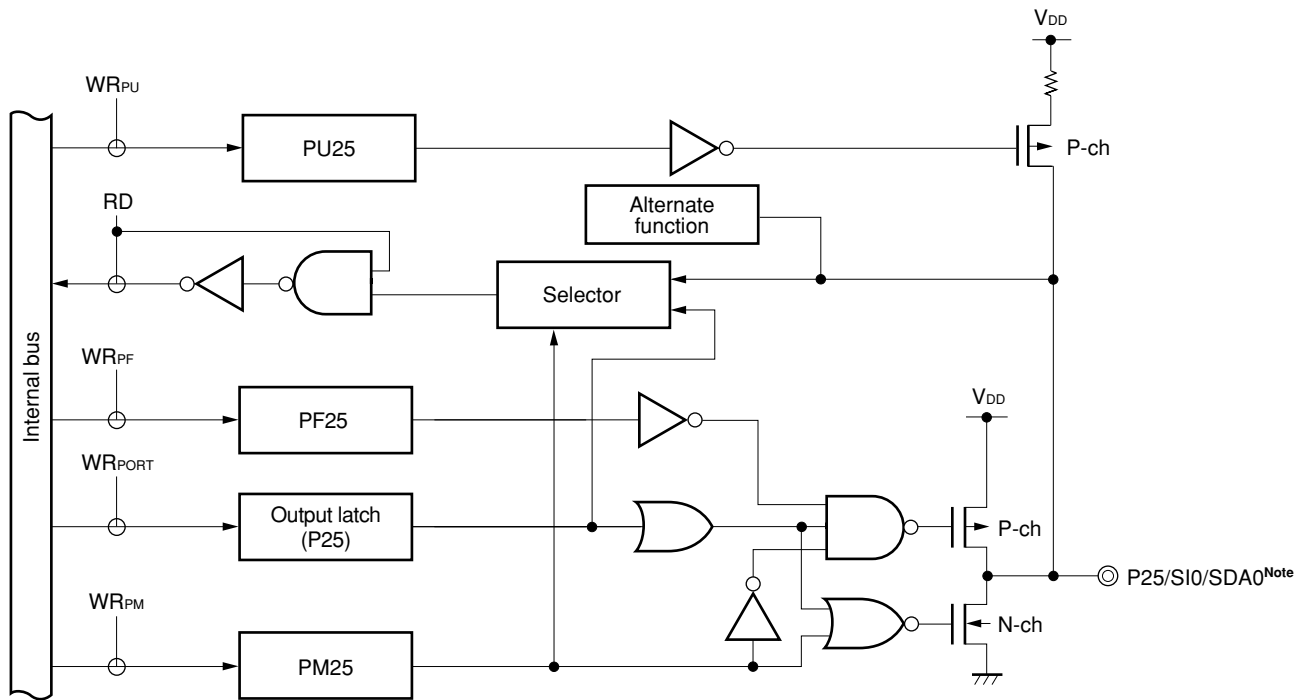
- PU: Pull-up resistor option register
- PM: Port mode register
- RD: Port 2 read signal
- WR: Port 2 write signal

Figure 5-5. Block Diagram of P21, P23, P24, and P26



- PU: Pull-up resistor option register
- PM: Port mode register
- RD: Port 2 read signal
- WR: Port 2 write signal

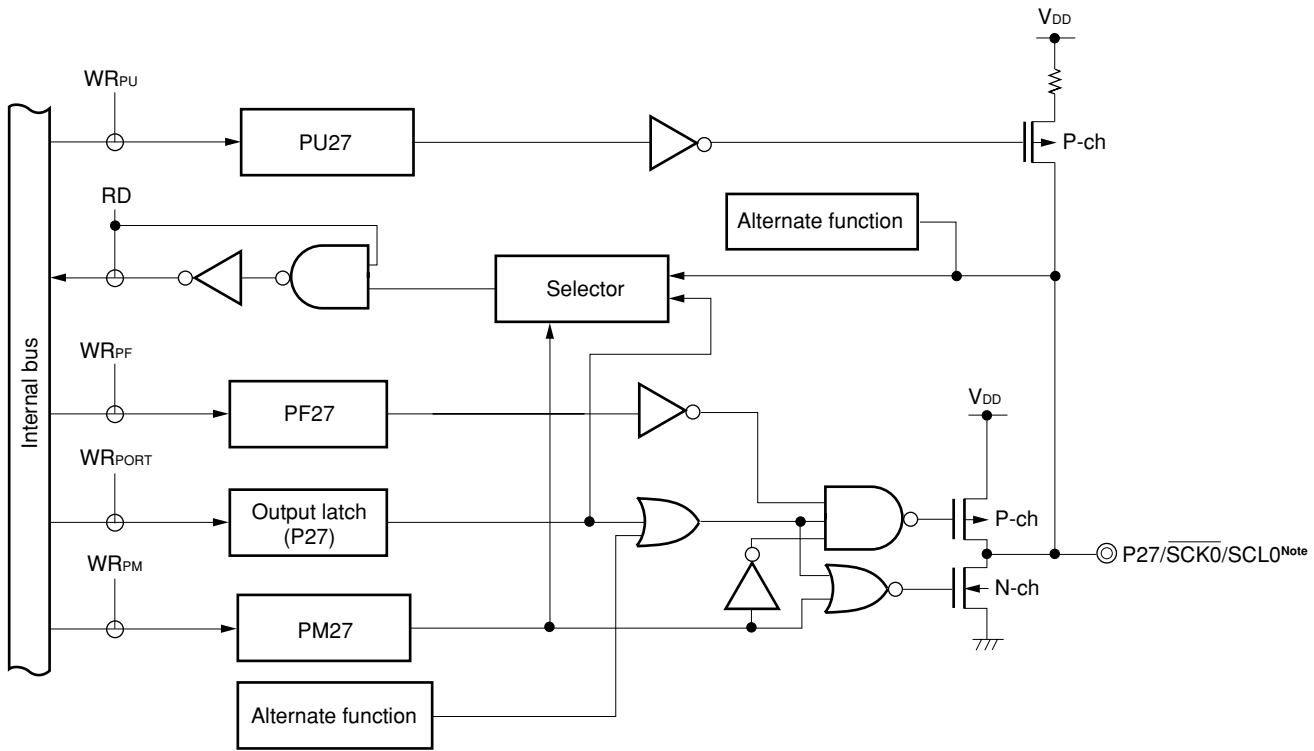
Figure 5-6. Block Diagram of P25



Note The SDA0 pin applies only to the μ PD784216AY, 784218AY Subseries.

- PU: Pull-up resistor option register
- PF: Port function control register
- PM: Port mode register
- RD: Port 2 read signal
- WR: Port 2 write signal

Figure 5-7. Block Diagram of P27



Note The SCL0 pin applies only to the μ PD784216AY, 784218AY Subseries.

- PU: Pull-up resistor option register
- PF: Port function control register
- PM: Port mode register
- RD: Port 2 read signal
- WR: Port 2 write signal

5.2.4 Port 3

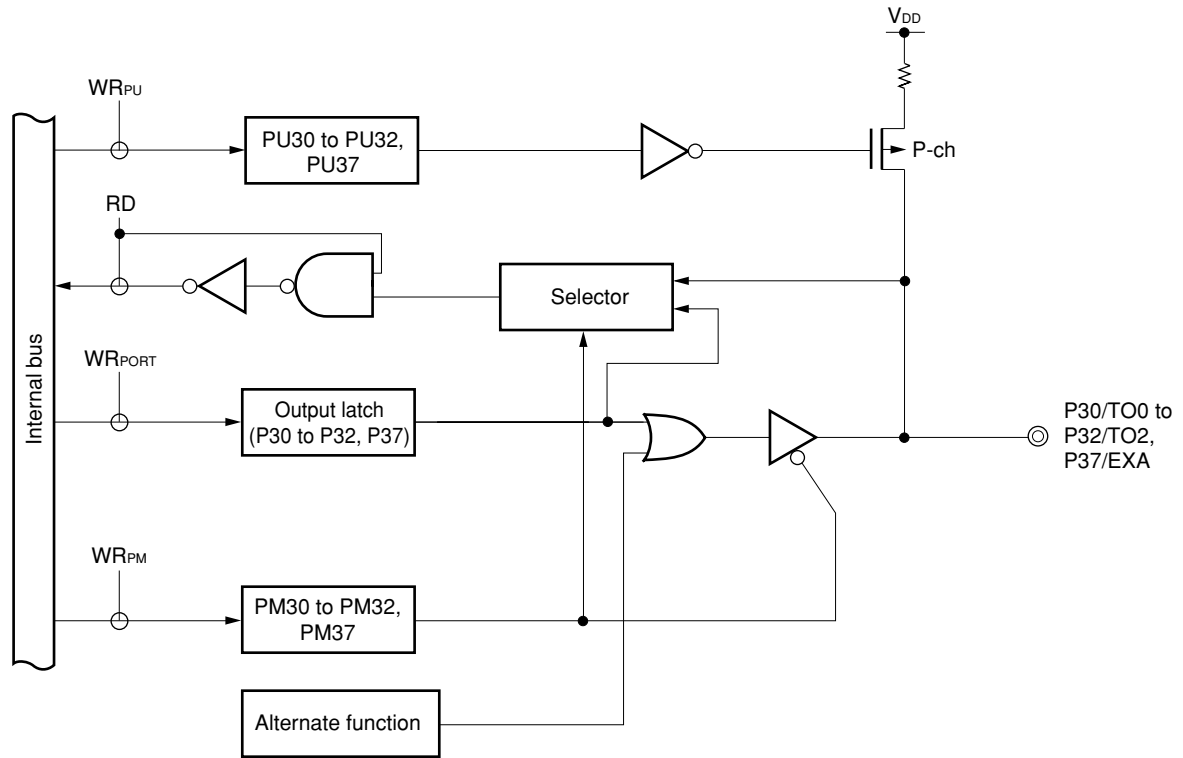
Port 3 is an 8-bit input/output port with output latch. The P30 to P37 pins can specify the input mode/output mode in 1-bit units with the port 3 mode register. A pull-up resistor can be connected to the P30 to P37 pins via pull-up resistor option register 3, regardless of whether the input mode or output mode is specified.

Port 3 supports timer input/output and external access status output as alternate functions.

$\overline{\text{RESET}}$ input sets port 3 to the input mode.

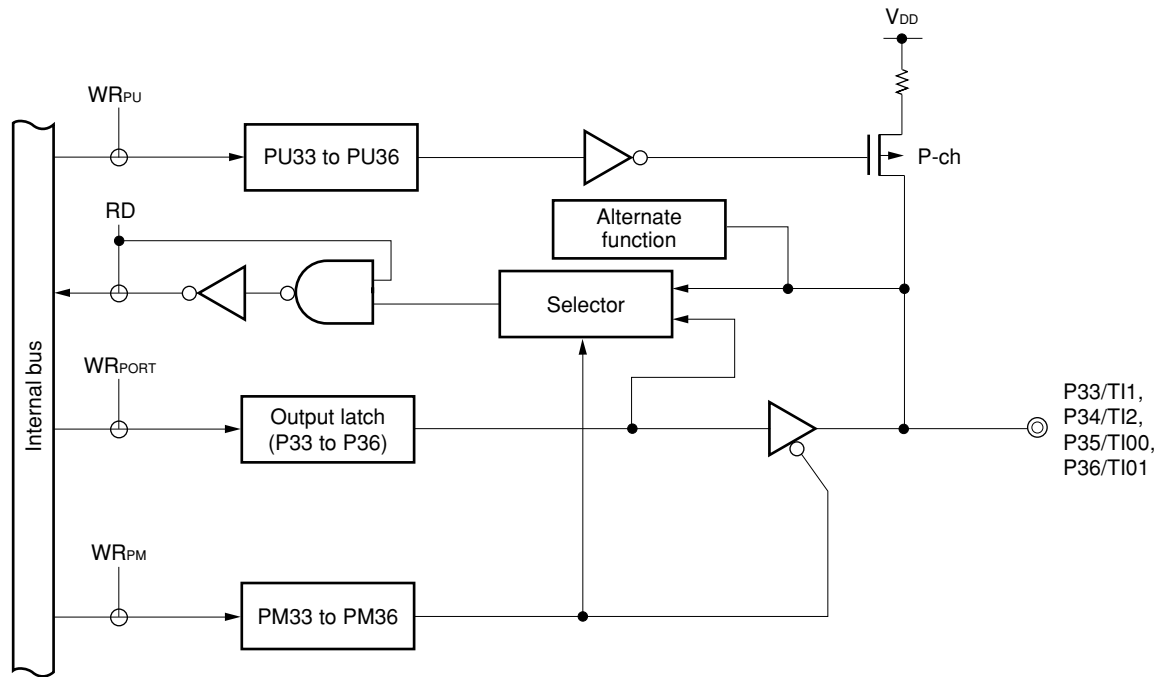
Figures 5-8 and 5-9 show block diagrams of port 3.

Figure 5-8. Block Diagram of P30 to P32 and P37



- PU: Pull-up resistor option register
- PM: Port mode register
- RD: Port 3 read signal
- WR: Port 3 write signal

Figure 5-9. Block Diagram of P33 to P36



- PU: Pull-up resistor option register
- PM: Port mode register
- RD: Port 3 read signal
- WR: Port 3 write signal

5.2.5 Port 4

Port 4 is an 8-bit input/output port with output latch. The P40 to P47 pins can specify the input mode/output mode in 1-bit units with the port 4 mode register. When the P40 to P47 pins are used as input ports, a pull-up resistor can be connected to them in 8-bit units with bit 4 (PUO4) of the pull-up resistor option register.

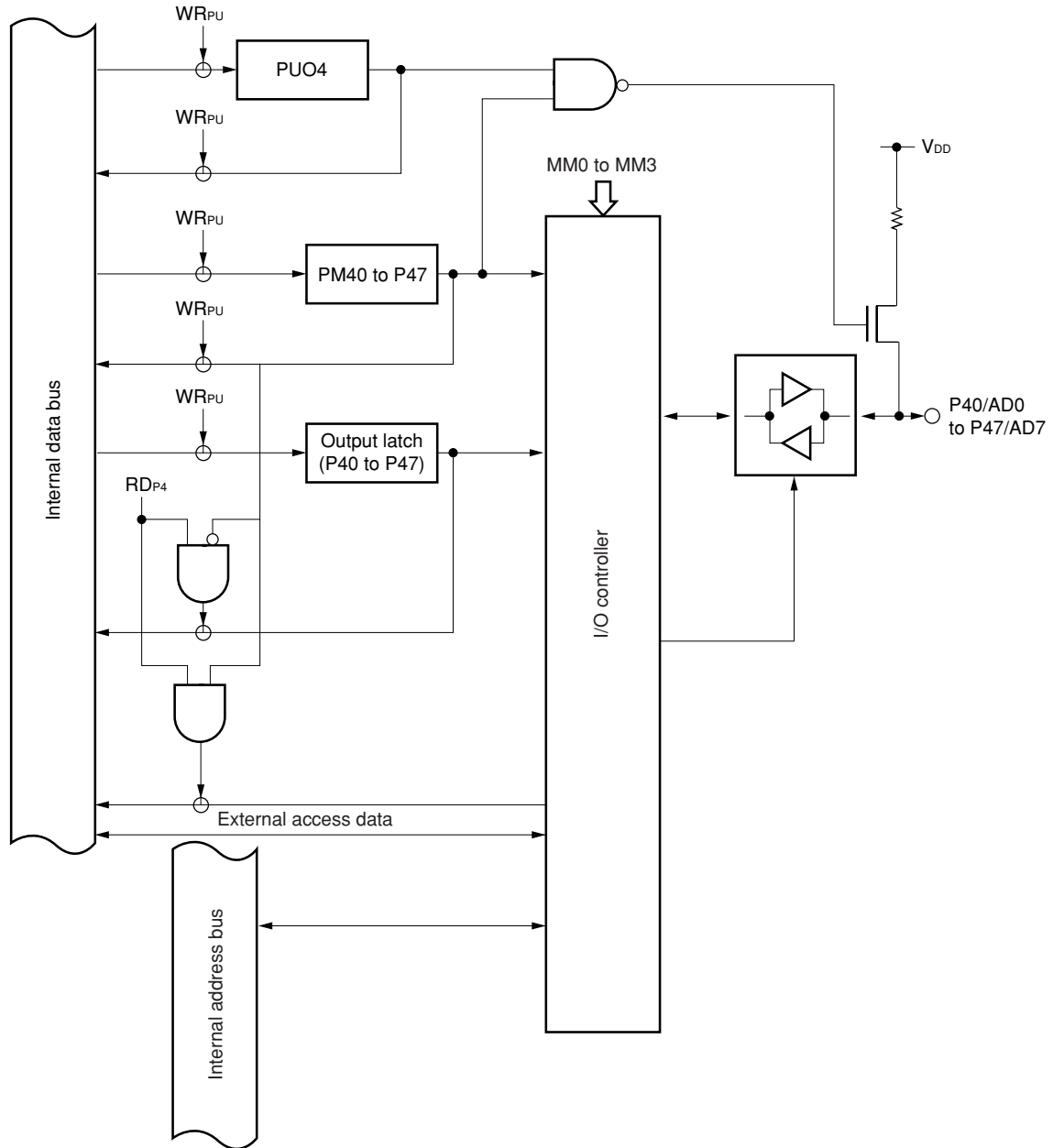
Port 4 can drive LED directly.

Port 4 supports the address/data bus function in the external memory expansion mode as an alternate function.

$\overline{\text{RESET}}$ input sets port 4 to the input mode.

Figure 5-10 shows a block diagram of port 4.

Figure 5-10. Block Diagram of P40 to P47



- PUO: Pull-up resistor option register
- PM: Port mode register
- RD: Port 4 read signal
- WR: Port 4 write signal

5.2.6 Port 5

Port 5 is an 8-bit input/output port with output latch. The P50 to P57 pins can specify the input mode/output mode in 1-bit units with the port 5 mode register. When the P50 to P57 pins are used as input ports, a pull-up resistor can be connected to them in 8-bit units with bit 5 (PUO5) of the pull-up resistor option register.

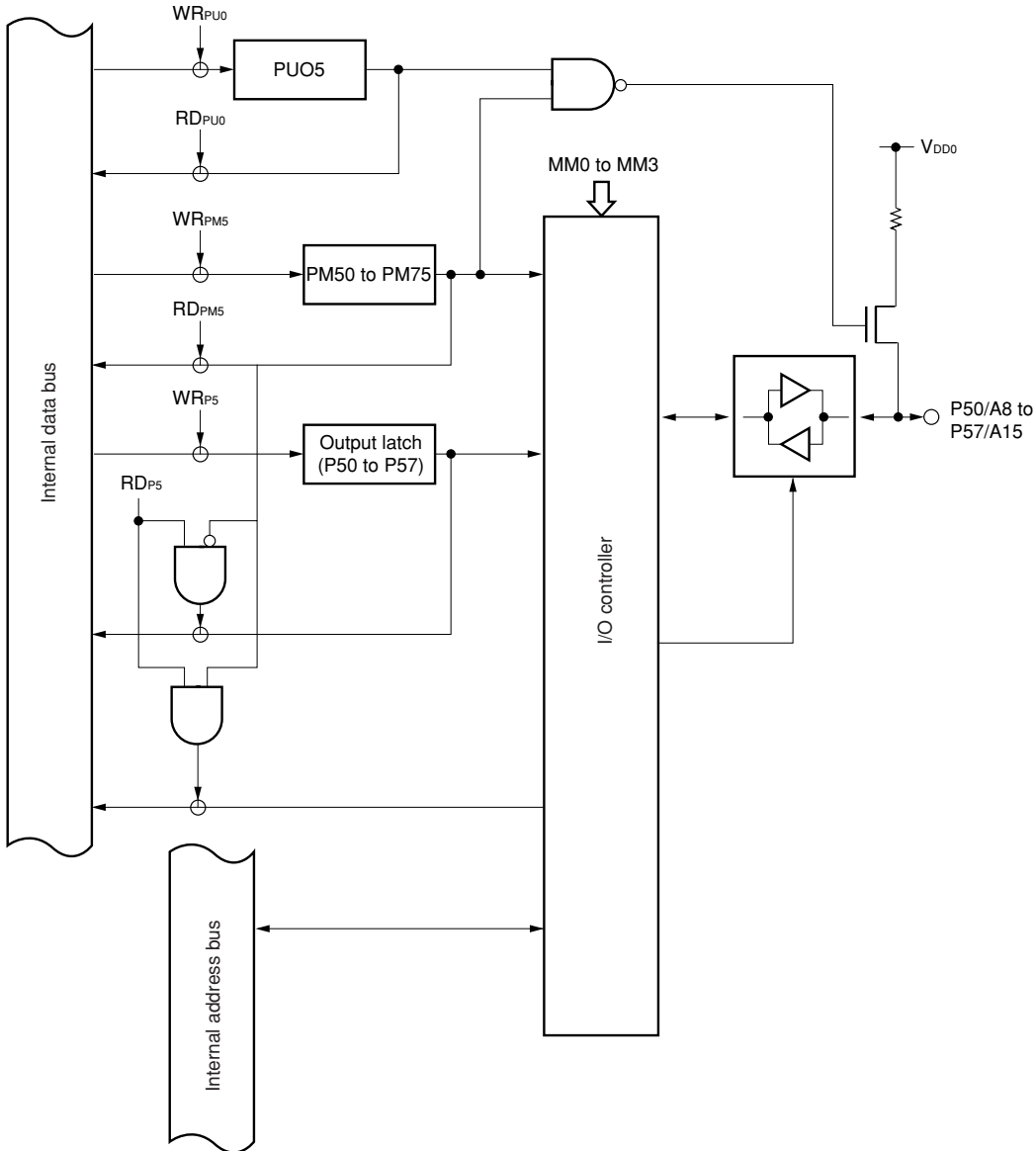
Port 5 can drive LEDs directly.

Port 5 supports the address bus function in the external memory expansion mode as an alternate function.

$\overline{\text{RESET}}$ input sets port 5 to the input mode.

Figure 5-11 shows a block diagram of port 5.

Figure 5-11. Block Diagram of P50 to P57



- PUO: Pull-up resistor option register
- PM: Port mode register
- RD: Port 5 read signal
- WR: Port 5 write signal
- MM0 to MM3: Bits 0 to 3 of the memory expansion mode register (MM)

5.2.7 Port 6

Port 6 is an 8-bit input/output port with output latch. The P60 to P67 pins can specify the input mode/output mode in 1-bit units with the port 6 mode register.

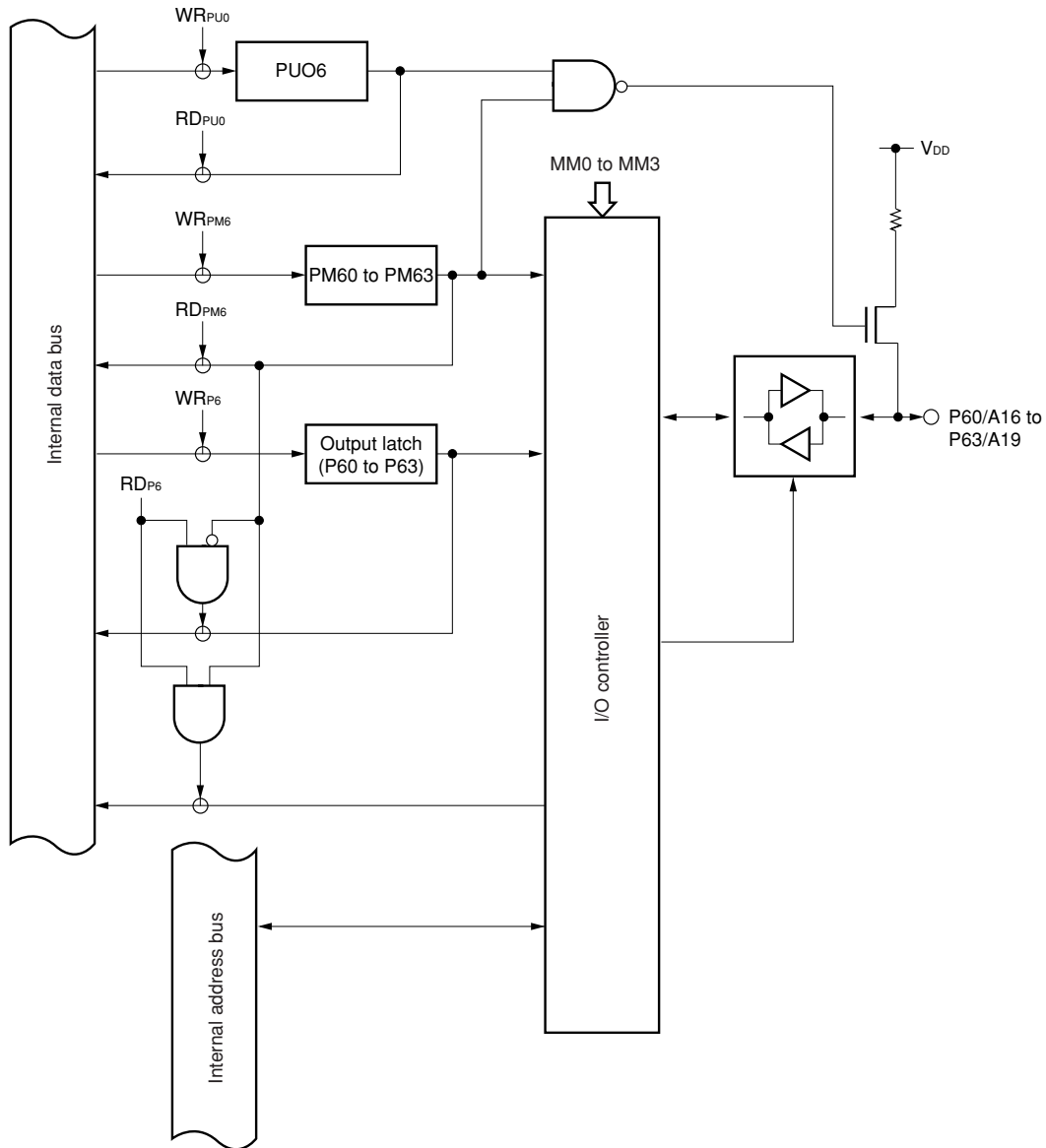
When pins P60 to P67 are used as input ports, a pull-up resistor can be connected to them in 8-bit units with bit 6 (PUO6) of the pull-up resistor option register.

Port 6 supports the address bus function and the control signal output function in external memory expansion mode as alternate functions.

$\overline{\text{RESET}}$ input sets port 6 to the input mode.

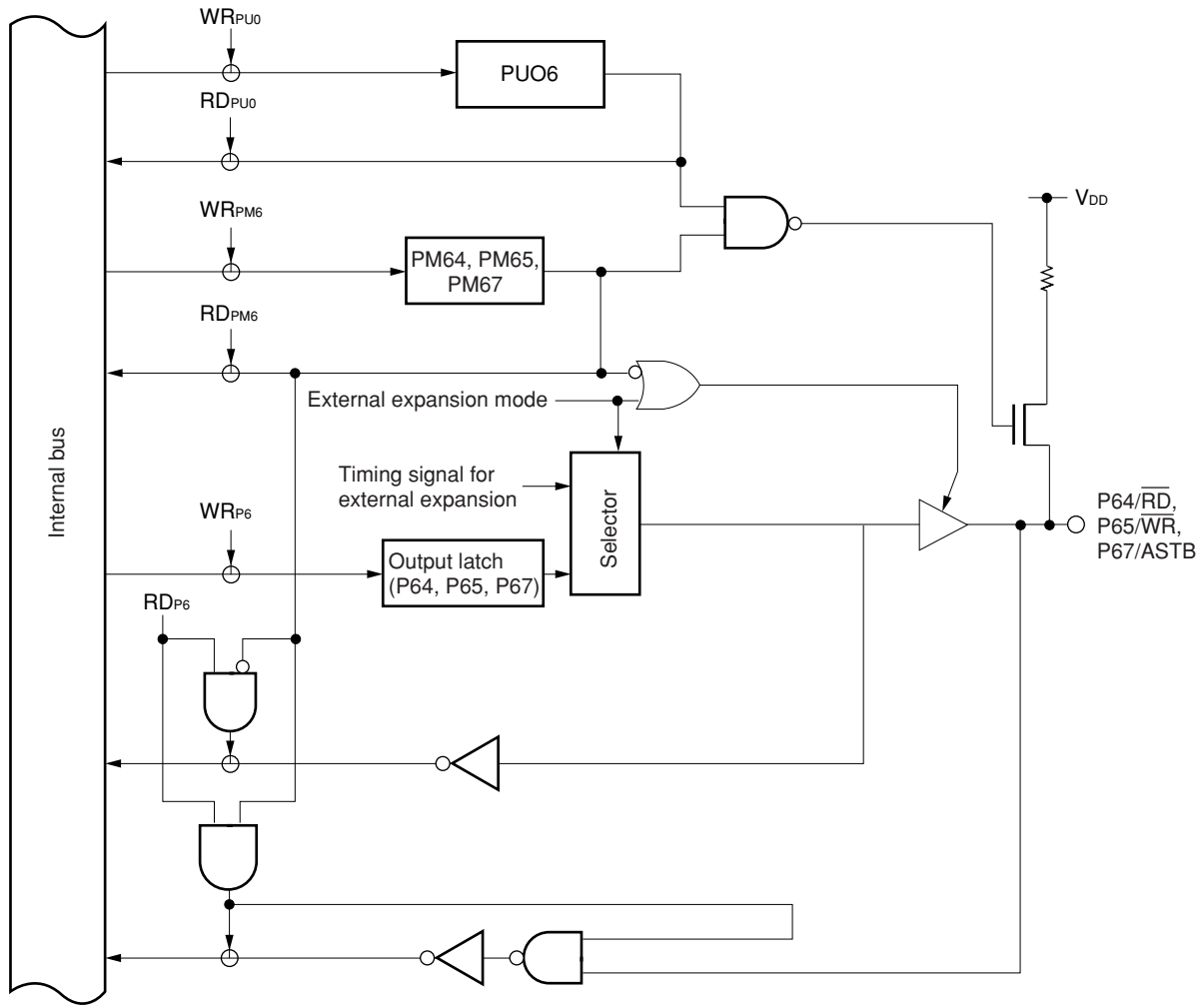
Figures 5-12 to 5-14 show block diagrams of port 6.

Figure 5-12. Block Diagram of P60 to P63



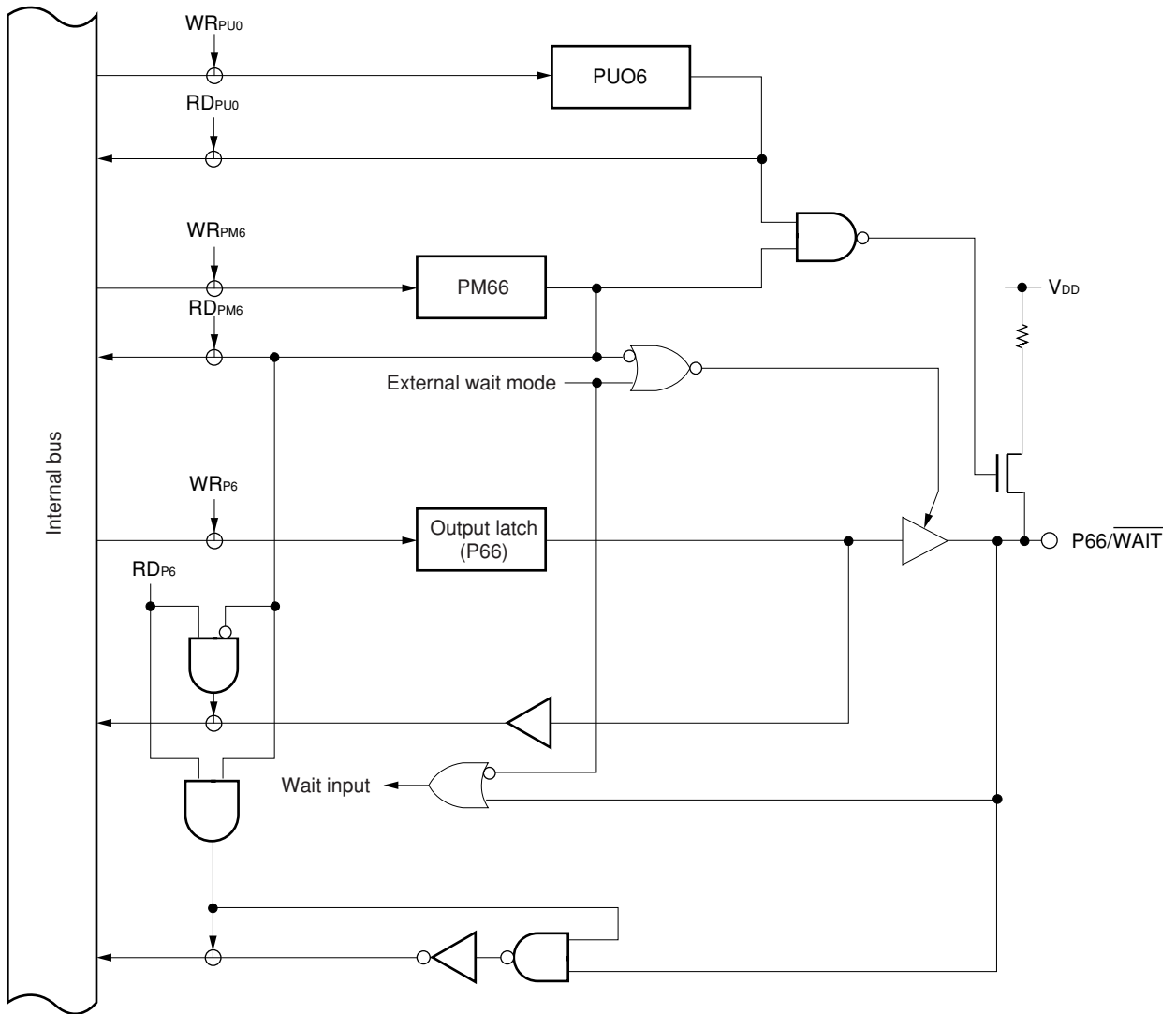
- PUO: Pull-up resistor option register
- PM: Port mode register
- RD: Port 5 read signal
- WR: Port 5 write signal
- MM0 to MM3: Bits 0 to 3 of the memory expansion mode register (MM)

Figure 5-13. Block Diagram of P64, P65, and P67



PUO: Pull-up resistor option register
 PM: Port mode register
 RD: Port 6 read signal
 WR: Port 6 write signal

Figure 5-14. Block Diagram of P66



PUO: Pull-up resistor option register
 PM: Port mode register
 RD: Port 6 read signal
 WR: Port 6 write signal

5.2.8 Port 7

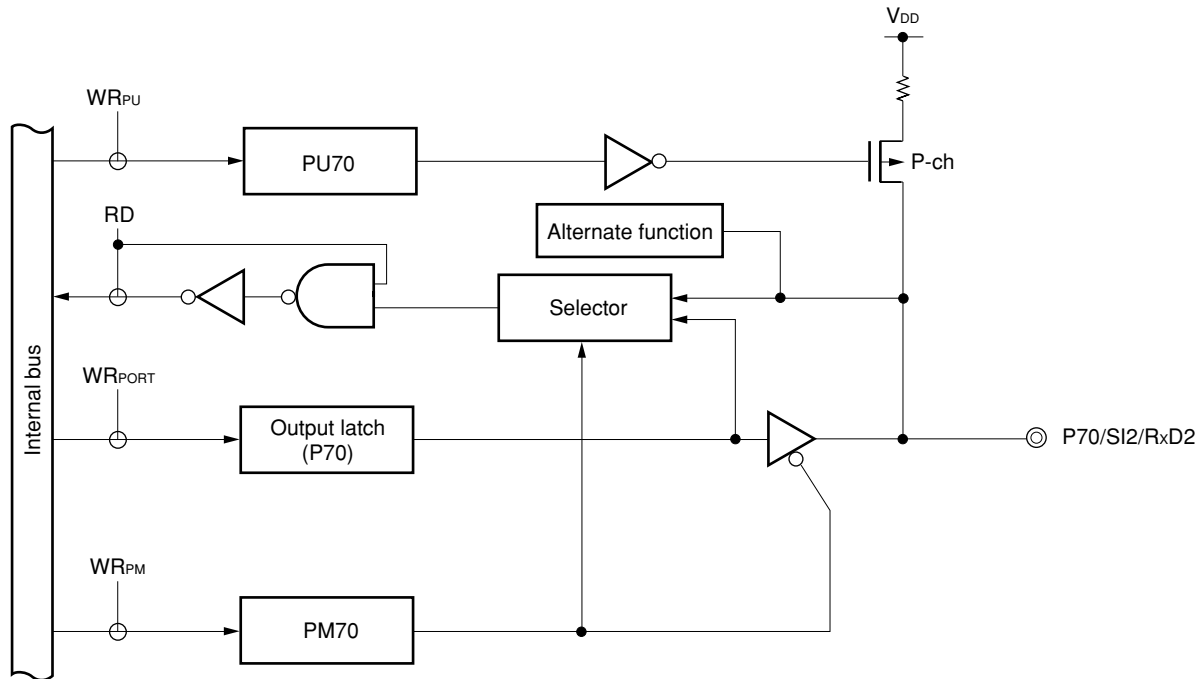
This is a 3-bit input/output port with output latch. Input mode/output mode can be specified in 1-bit units with the port 7 mode register. A pull-up resistor can be connected to the P70 to P72 pins via pull-up resistor option register 7, regardless of whether the input mode or output mode is specified.

Port 7 supports serial interface data input/output and clock input/output as alternate functions.

$\overline{\text{RESET}}$ input sets port 7 to the input mode.

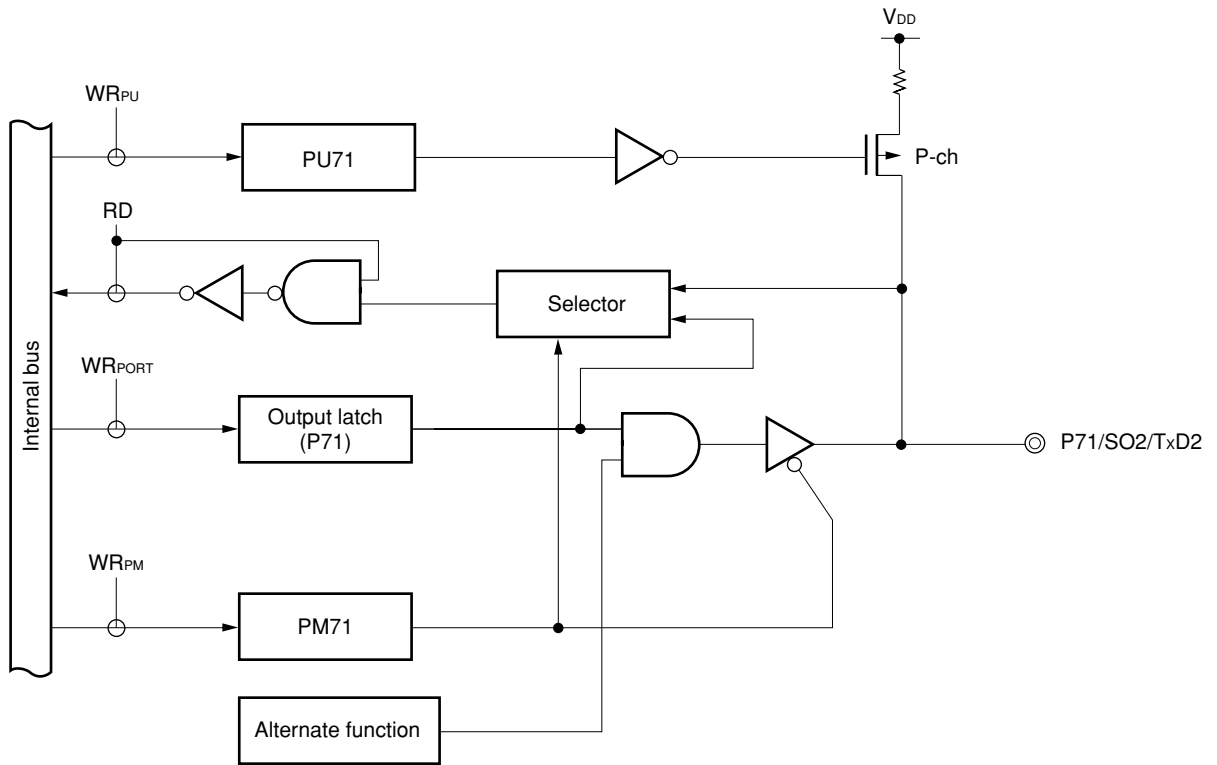
Figures 5-15 to 5-17 show block diagrams of port 7.

Figure 5-15. Block Diagram of P70



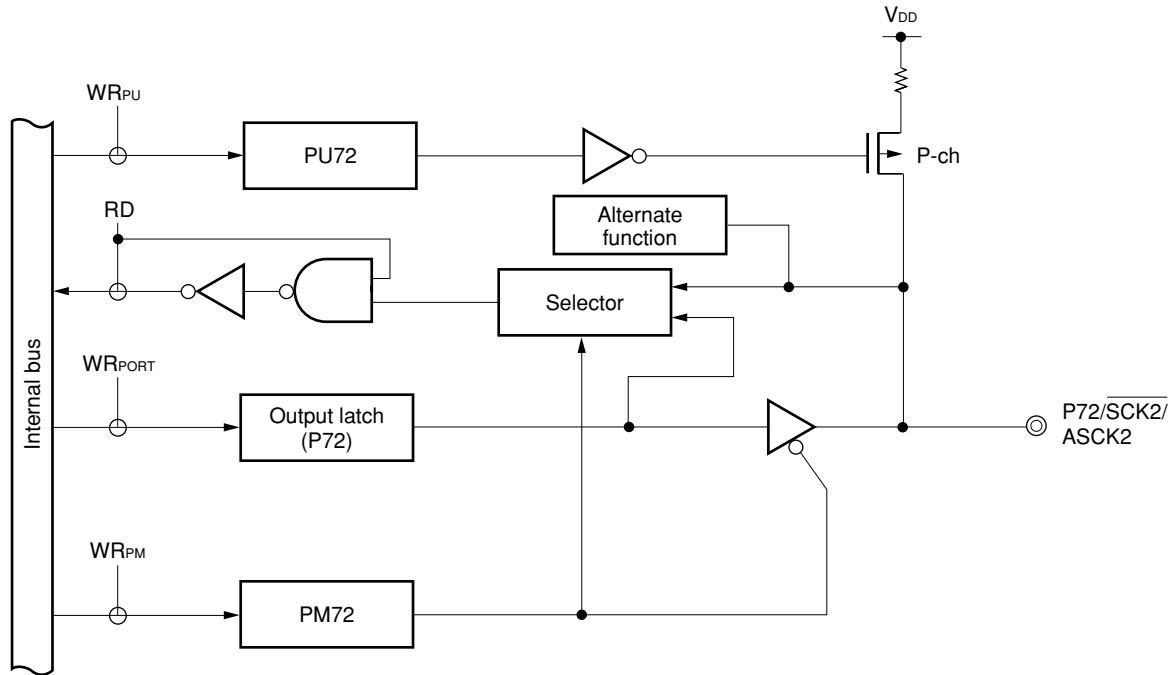
- PU: Pull-up resistor option register
- PM: Port mode register
- RD: Port 7 read signal
- WR: Port 7 write signal

Figure 5-16. Block Diagram of P71



PU: Pull-up resistor option register
 PM: Port mode register
 RD: Port 7 read signal
 WR: Port 7 write signal

Figure 5-17. Block Diagram of P72



- PU: Pull-up resistor option register
- PM: Port mode register
- RD: Port 7 read signal
- WR: Port 7 write signal

5.2.9 Port 8

This is an 8-bit input/output port with output latch. The P80 to P87 pins can be specified to input mode/output mode in 1-bit units with the port 8 mode register. A pull-up resistor can be connected to the P80 to P87 pins via pull-up resistor option register 8, regardless of whether the input mode or output mode is specified.

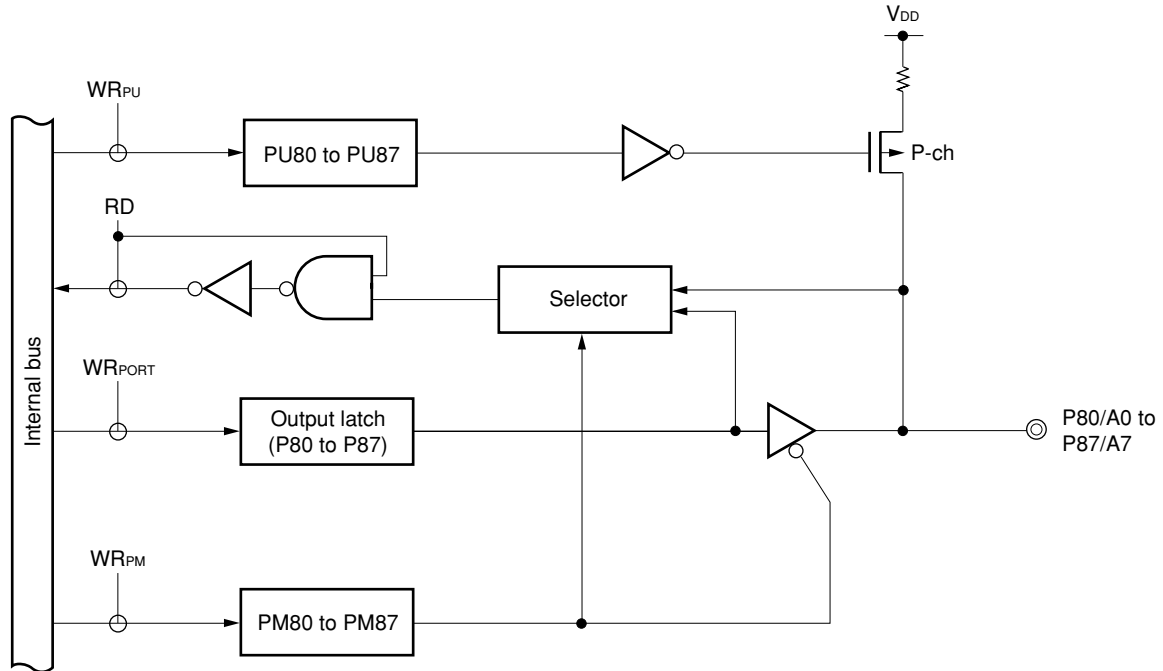
Interrupt control flag (KRIF) can be set to 1 with falling edge detection (key return interrupt).

Port 8 supports the address bus function in external memory expansion mode as an alternate function.

$\overline{\text{RESET}}$ input sets port 8 to the input mode.

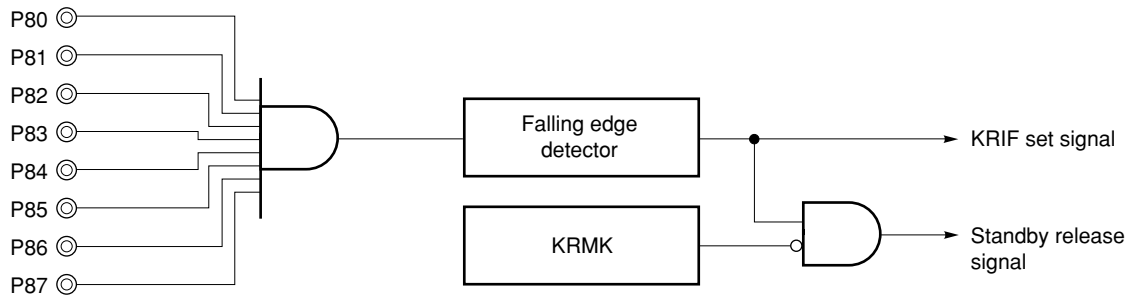
Figure 5-18 shows a block diagram of port 8.

Figure 5-18. Block Diagram of P80 to P87



- PU: Pull-up resistor option register
- PM: Port mode register
- RD: Port 8 read signal
- WR: Port 8 write signal

Figure 5-19. Block Diagram of Falling Edge Detection Circuit



5.2.10 Port 9

This is a 6-bit input/output port with output latch. The input/output mode can be specified for the P90 to P95 pins in 1-bit units with the port 9 mode register.

Port 9 is a N-ch open drain medium-voltage I/O port.

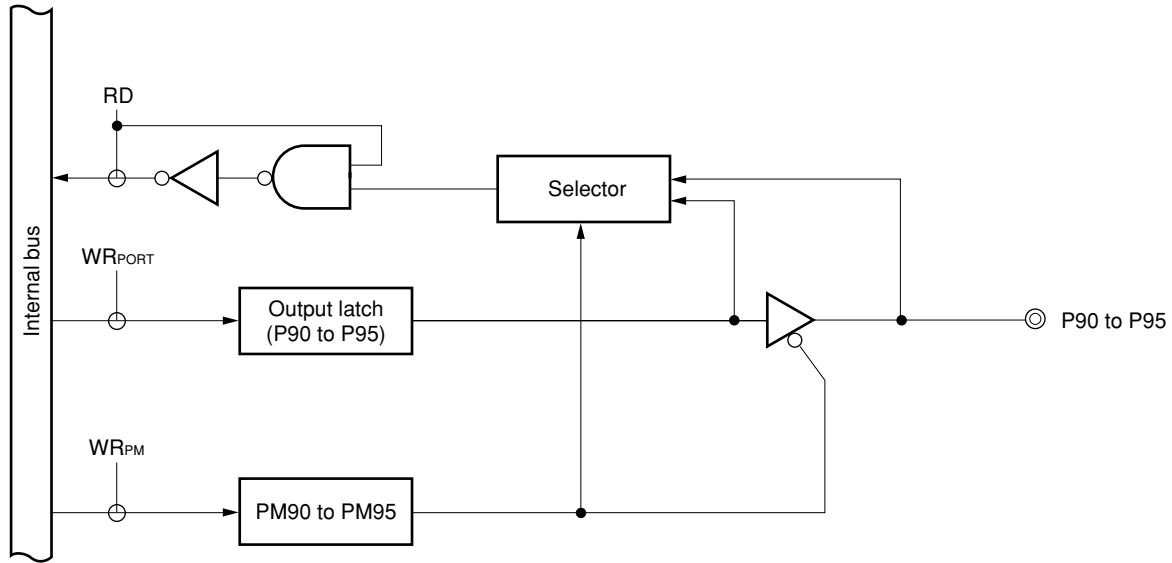
Port 9 does not include a pull-up resistor.

Port 9 can drive LEDs directly.

$\overline{\text{RESET}}$ input sets port 9 to the input mode.

Figure 5-20 shows a block diagram of port 9.

Figure 5-20. Block Diagram of P90 to P95



- PM: Port mode register
- RD: Port 9 read signal
- WR: Port 9 write signal

5.2.11 Port 10

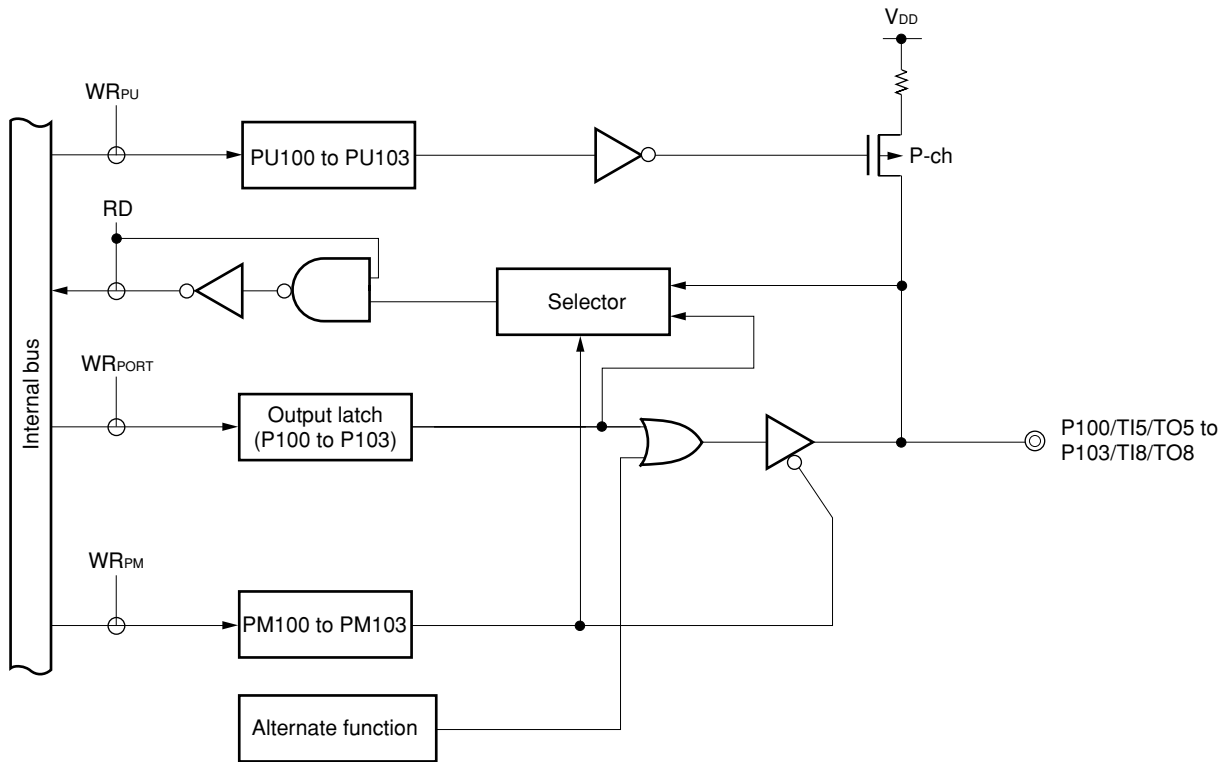
This is a 4-bit input/output port with output latch. The input mode/output mode can be specified in 1-bit units for the P100 to P103 pins with the port 10 mode register. A pull-up resistor can be connected to the P100 to P103 pins via pull-up resistor option register 10, regardless of whether the input mode or output mode is specified.

Port 10 supports timer input/output as an alternate function.

$\overline{\text{RESET}}$ input sets port 10 to the input mode.

Figure 5-21 shows a block diagram of port 10.

Figure 5-21. Block Diagram of P100 to P103



- PU: Pull-up resistor option register
- PM: Port mode register
- RD: Port 10 read signal
- WR: Port 10 write signal

5.2.12 Port 12

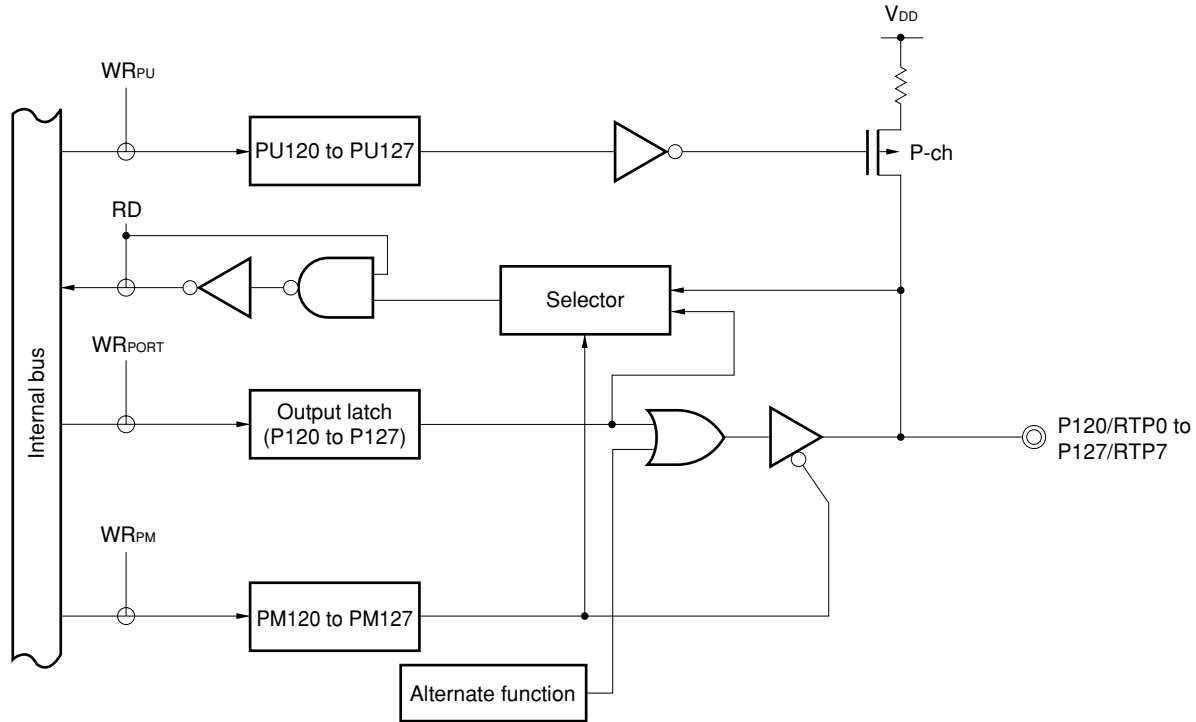
This is an 8-bit input/output port with output latch. Input mode/output mode can be specified in 1-bit units with the port 12 mode register. A pull-up resistor can be connected to the P120 to P127 pins via pull-up resistor option register 12, regardless of whether the input mode or output mode is specified.

Port 12 supports the real-time output function as an alternate function.

$\overline{\text{RESET}}$ input sets port 12 to the input mode.

Figure 5-22 shows a block diagram of port 12.

Figure 5-22. Block Diagram of P120 to P127



- PU: Pull-up resistor option register
- PM: Port mode register
- RD: Port 12 read signal
- WR: Port 12 write signal

5.2.13 Port 13

This is a 2-bit input/output port with output latch. The input mode/output mode can be specified in 1-bit units with the port 13 mode register. Port 13 does not include a pull-up resistor.

Port 13 supports D/A converter analog output as an alternate function.

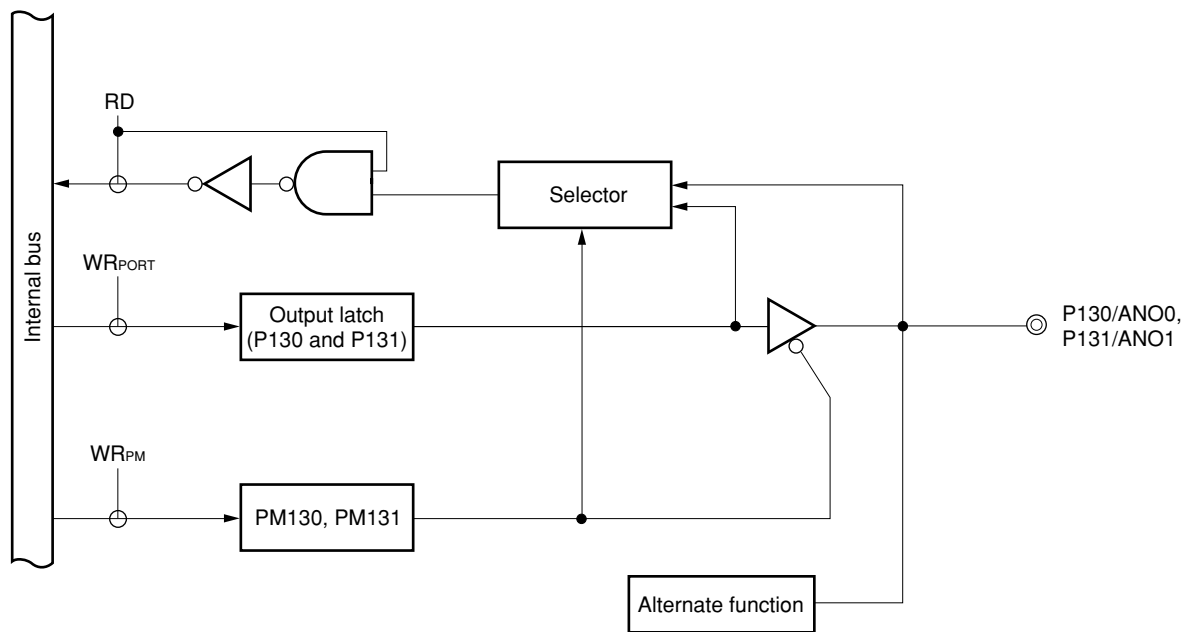
$\overline{\text{RESET}}$ input sets port 13 to the input mode.

Figure 5-23 shows a block diagram of port 13.

Caution When only either one of the D/A converter channels is used with $\text{AV}_{\text{REF}1} < V_{\text{DD}}$, the other pins that are not used as analog outputs must be set as follows:

- Set the port mode register ($\text{PM13}\times$) to 1 (input mode) and connect the pin to V_{SS} .
- Set the port mode register ($\text{PM13}\times$) to 0 (output mode) and the output latch to 0 to output low level from the pin.

Figure 5-23. Block Diagram of P130 and P131



PM: Port mode register
RD: Port 13 read signal
WR: Port 13 write signal

5.3 Control Registers

The following three types of registers control the ports.

- Port mode registers (PM0, PM2 to PM10, PM12, PM13)
- Pull-up resistor option registers (PU0, PU2, PU3, PU7, PU8, PU10, PU12, PUO)
- Port function control register (PF2)^{Note}

Note Applies only to the μ PD784216AY, 784218AY Subseries.

(1) Port mode registers (PM0, PM2 to PM10, PM12, PM13)

These registers are used to set port input/output in 1-bit units.

PM0, PM2 to PM10, PM12, and PM13 are set with a 1-bit or 8-bit memory manipulation instruction, respectively.

$\overline{\text{RESET}}$ input sets port mode registers to FFH.

When port pins are used as alternate function pins, set the port mode registers and output latches according to Table 5-3.

Caution Even though port 0 is also used as an external interrupt input, when port 0 is not used as an interrupt input pin, be sure to set interrupt disabled by using the external interrupt rising edge enable register (EGP0) and external interrupt falling edge enable register (EGN0) or setting the interrupt enable flag (PMKn: n = 0 to 5) to 1. Otherwise, the interrupt request flag is set and unintentional interrupt servicing may be executed when specifying ports in output mode and thus changing the output level.

Table 5-3. Port Mode Register and Output Latch Settings When Using Alternate Functions

Pin Name	Alternate Function		PM _{xx}	P _{xx}	Pin Name	Alternate Function		PM _{xx}	P _{xx}
	Name	I/O				Name	I/O		
P00, P01	INTP0, INTP1	Input	1	×	P35, P36	TI00, TI01	Input	1	×
P02	INTP2/NMI	Input	1	×	P37	EXA	Output	0	0
P03 to P06	INTP3 to INTP6	Input	1	×	P40 to P47	AD0 to AD7	I/O	× Note 2	
P10 to P17 ^{Note 1}	ANI0 to ANI7	Input	–		P50 to P57	A8 to A15	Output	× Note 2	
P20	RxD1/SI1	Input	1	×	P60 to P63	A16 to A19	Output	× Note 2	
P21	TxD1/SO1	Output	0	0	P64	$\overline{\text{RD}}$	Output	× Note 2	
P22	ASCK1	Input	1	×	P65	$\overline{\text{WR}}$	Output	× Note 2	
	SCK1	Input	1	×	P66	$\overline{\text{WAIT}}$	Input	× Note 2	
		Output	0	0	P67	ASTB	Output	× Note 2	
P23	PCL	Output	0	0	P70	RxD2/SI2	Input	1	×
P24	BUZ	Output	0	0	P71	TxD2/SO2	Output	0	0
P25	SI0	Input	1	×	P72	ASCK2	Input	1	×
	SDA0 ^{Note 4}	I/O	0	0		$\overline{\text{SCK2}}$	Input	1	×
P26	SO0	Output	0	0			Output	0	0
P27	$\overline{\text{SCK0}}$	Input	1	×	P80 to P87	A0 to A7	Output	× Note 3	
		Output	0	0	P100 to P103	TI5 to TI8	Input	1	×
	SCL0 ^{Note 4}	I/O	0	0			TO5 to TO8	Output	0
P30 to P32	TO0 to TO2	Output	0	0	P120 to P127	RTP0 to RTP7	Output	0	0
P33, P34	TI1, TI2	Input	1	×	P130, P131 ^{Note 1}	ANO0, ANO1	Output	1	×

- Notes**
1. If these ports are read out when these pins are used in the alternate function mode, undefined values are read.
 2. When the P40 to P47 pins, P50 to P57 pins, and P60 to P67 pins are used for an alternate function, set the function with the memory expansion mode register.
 3. When the P80 to P87 pins are used for an alternate function, set the function with the external bus type selection register.
 4. The SDA0 and SCL0 pins are provided only for the $\mu\text{PD784216AY}$, 784218AY Subseries.

- Cautions**
1. When not using external wait in the external memory expansion mode, the P66 pin can be used as an I/O port.
 2. When using the I²C bus mode, specify N-ch open-drain for the SCL0/P27 and SDA0/P25 pins by setting the port function control register (PF2).

Remark

- ×: don't care (not necessary to set)
- : Not available for the port mode register and output latch
- PM_{xx}: Port mode register
- P_{xx}: Port output latch

Figure 5-24. Port Mode Register Format

Address: 0FF20H, 0FF22H to 0FF2AH, 0FF2CH, 0FF2DH After reset: FFH R/W

Symbol	7	6	5	4	3	2	1	0
PM0	1	PM06	PM05	PM04	PM03	PM02	PM01	PM00
PM2	PM27	PM26	PM25	PM24	PM23	PM22	PM21	PM20
PM3	PM37	PM36	PM35	PM34	PM33	PM32	PM31	PM30
PM4	PM47	PM46	PM45	PM44	PM43	PM42	PM41	PM40
PM5	PM57	PM56	PM55	PM54	PM53	PM52	PM51	PM50
PM6	PM67	PM66	PM65	PM64	PM63	PM62	PM61	PM60
PM7	1	1	1	1	1	PM72	PM71	PM70
PM8	PM87	PM86	PM85	PM84	PM83	PM82	PM81	PM80
PM9	1	1	PM95	PM94	PM93	PM92	PM91	PM90
PM10	1	1	1	1	PM103	PM102	PM101	PM100
PM12	PM127	PM126	PM125	PM124	PM123	PM122	PM121	PM120
PM13	1	1	1	1	1	1	PM131	PM130

PMxn	Pxn pin I/O mode specification (<ul style="list-style-type: none"> x = 0: n = 0 to 6 x = 2 to 6, 8, 12: n = 0 to 7 x = 7: n = 0 to 2 x = 9: n = 0 to 5 x = 10: n = 0 to 3 x = 13: n = 0, 1)
0	Output mode (output buffer ON)
1	Input mode (output buffer OFF)

(2) Pull-up resistor option registers (PU0, PU2, PU3, PU7, PU8, PU10, PU12, PUO)

These registers are used to set whether to use an internal pull-up resistor at each port or not in 1-bit or 8-bit units. PUn (n = 0, 2, 3, 7, 8, 10, 12) can specify the pull-up resistor connection of each port pin. PUO can specify the pull-up resistor connection of ports 4, 5, and 6. Pull-up resistors are connected irrespective of whether an alternate function is used.

These registers are set by a 1-bit or 8-bit memory manipulation instruction.

$\overline{\text{RESET}}$ input sets these registers to 00H.

- Cautions**
- 1. Ports 1, 9, and 13 do not incorporate a pull-up resistor.**
 - 2. Ports 4, 5, 6, and 8 can connect a pull-up resistor during external memory expansion mode.**
 - 3. The pull-up resistor of ports 0, 2, 3, 7, 8, 10, and 12 is not disconnected even if these ports are set in the output mode. To use these ports in the output mode, it is recommended to clear the corresponding pull-up resistor option register to 0.**

Figure 5-25. Pull-Up Resistor Option Register Format

Address: 0FF30H, 0FF32H, 0FF33H, 0FF37H, 0FF38H, 0FF3AH, 0FF3CH After reset: 00H R/W

Symbol	<7>	<6>	<5>	<4>	<3>	<2>	<1>	<0>
PU0	0	PU06	PU05	PU04	PU03	PU02	PU01	PU00
PU2	PU27	PU26	PU25	PU24	PU23	PU22	PU21	PU20
PU3	PU37	PU36	PU35	PU34	PU33	PU32	PU31	PU30
PU7	0	0	0	0	0	PU72	PU71	PU70
PU8	PU87	PU86	PU85	PU84	PU83	PU82	PU81	PU80
PU10	0	0	0	0	PU103	PU102	PU101	PU100
PU12	PU127	PU126	PU125	PU124	PU123	PU122	PU121	PU120

PUxn	Pxn pin pull-up resistor specification { x = 0: n = 0 to 6 x = 2, 3, 8, 12: n = 0 to 7 x = 7: n = 0 to 2 x = 10: n = 0 to 3 }
0	No pull-up resistor connection
1	Pull-up resistor connection

Address: 0FF4EH After reset: 00H R/W

Symbol	7	<6>	<5>	<4>	3	2	1	0
PUO	0	PUO6	PUO5	PUO4	0	0	0	0

PUOn	Port n pull-up resistor specification (n = 4 to 6)
0	No pull-up resistor connection
1	Pull-up resistor connection

Caution Connecting pull-up resistors unnecessarily may increase the current consumption or latch up other devices, so specify a mode whereby pull-up resistors are only connected to the required parts. If required and not-required parts exist together, externally connect pull-up resistors to the required parts and set to the mode that specifies not to connect on-chip pull-up resistors.

(3) Port function control register (PF2)

This register specifies N-ch open-drain for pins P25 and P27.

PF2 is set by a 1-bit or 8-bit memory manipulation instruction.

$\overline{\text{RESET}}$ input sets PF2 to 00H.

Caution Only the $\mu\text{PD784216AY}$, 784218AY Subseries incorporates PF2. When using the I²C bus mode (serial interface), make sure to specify N-ch open-drain for the P25 and P27 pins.

Figure 5-26. Port Function Control Register (PF2) Format

Address: 0FF42H After reset: 00H R/W

Symbol	7	6	5	4	3	2	1	0
PF2	PF27	0	PF25	0	0	0	0	0

PF2n	P2n pin N-ch open-drain specification (n = 5, 7)
0	Don't set N-ch open-drain
1	Set N-ch open-drain

5.4 Operations

Port operations differ depending on whether the input or output mode is set, as shown below.

5.4.1 Writing to input/output port

(1) Output mode

A value is written to the output latch by a transfer instruction, and the output latch contents are output from the pin.

Once data is written to the output latch, it is retained until data is written to the output latch again.

(2) Input mode

A value is written to the output latch by a transfer instruction, but since the output buffer is OFF, the pin status does not change.

Once data is written to the output latch, it is retained until data is written to the output latch again.

Caution In the case of 1-bit memory manipulation instructions, although a single bit is manipulated, the port is accessed in 8-bit units. Therefore, on a port with a mixture of input and output pins, the output latch contents for pins specified as input are undefined except for the manipulated bit.

5.4.2 Reading from input/output port

(1) Output mode

The output latch contents are read by a transfer instruction. The output latch contents do not change.

(2) Input mode

The pin status is read by a transfer instruction. The output latch contents do not change.

5.4.3 Operations on input/output port

(1) Output mode

An operation is performed on the output latch contents, and the result is written to the output latch. The output latch contents are output from the pins.

Once data is written to the output latch, it is retained until data is written to the output latch again.

(2) Input mode

The output latch contents are undefined, but since the output buffer is OFF, the pin status does not change.

Caution In the case of 1-bit memory manipulation instructions, although a single bit is manipulated, the port is accessed in 8-bit units. Therefore, on a port with a mixture of input and output pins, the output latch contents for pins specified as input are undefined, except for the manipulated bit.

CHAPTER 6 REAL-TIME OUTPUT FUNCTIONS

6.1 Functions

The real-time output function transfers preset data in the real-time output buffer register to the output latch by hardware synchronized to the generation of a timer interrupt or an external interrupt and outputs it off the chip. Also, the pins for output off the chip are called the real-time output port.

Since jitter-free signals can be output by using the real-time output port, the operation is optimized for the control of stepping motors, for example.

The port mode or real-time output mode is bit selectable.

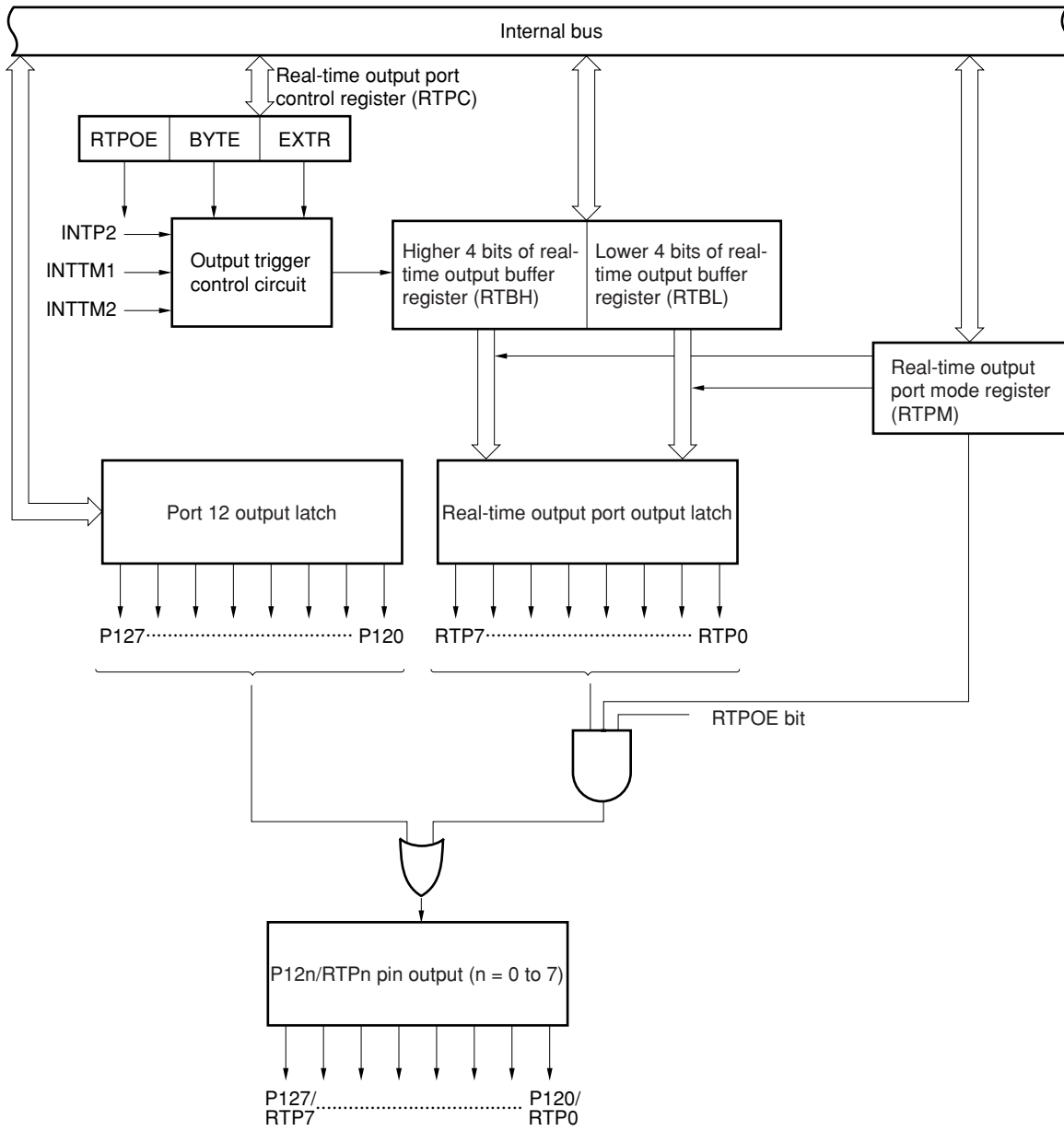
6.2 Configuration

The real-time output port consists of the following hardware.

Table 6-1. Real-Time Output Port Configuration

Item	Configuration
Register	Real-time output buffer registers (RTBL, RTBH)
Control register	Real-time output port mode register (RTPM) Real-time output port control register (RTPC)

Figure 6-1. Block Diagram of Real-Time Output Port



• **Real-time output buffer registers (RTBL, RTBH)**

These 4-bit registers save the output data beforehand. RTBL and RTBH are mapped to independent addresses in the special function register (SFR) as shown in Figure 6-2.

When the 4 bits × 2 channels operating mode is specified, RTBL and RTBH can be independently set with data. In addition, if the address of either RTBL or RTBH is specified, the data in both registers can be read in a batch. When the 8 bits × 1 channel operating mode is specified, writing 8-bit data to either RTBL or RTBH can set data in each register. In addition, if the address of either RTBL or RTBH is specified, the data in both registers can be read in a batch.

Table 6-2 lists the operations for manipulating RTBL and RTBH.

Figure 6-2. Real-Time Output Buffer Register Configuration

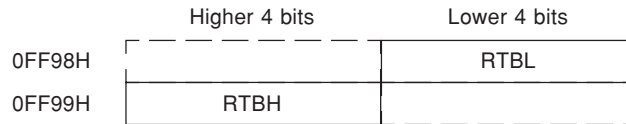


Table 6-2. Operations for Manipulating Real-Time Output Buffer Registers

Operating Mode	Manipulated Register	Reading ^{Note 1}		Writing ^{Note 2}	
		Higher 4 bits	Lower 4 bits	Higher 4 bits	Lower 4 bits
4 bits × 2 channels	RTBL	RTBH	RTBL	Invalid	RTBL
	RTBH	RTBH	RTBL	RTBH	Invalid
8 bits × 1 channel	RTBL	RTBH	RTBL	RTBH	RTBL
	RTBH	RTBH	RTBL	RTBH	RTBL

- Notes**
1. Only the bits specified in the real-time output port mode can be read. When the bits set in the port mode are read, zeros are read.
 2. After setting the real-time output port, set the output data in RTBL and RTBH until the real-time output trigger is generated.

6.3 Control Registers

The real-time output port is controlled by the following two registers.

- Real-time output port mode register (RTPM)
- Real-time output port control register (RTPC)

(1) Real-time output port mode register (RTPM)

This register sets the real-time output port mode and port mode selections in 1-bit units.

RTPM is set by a 1-bit or 8-bit memory manipulation instruction.

$\overline{\text{RESET}}$ input sets RTPM to 00H.

Figure 6-3. Real-Time Output Port Mode Register (RTPM) Format

Address: 0FF9AH After reset: 00H R/W

Symbol	7	6	5	4	3	2	1	0
RTPM	RTPM7	RTPM6	RTPM5	RTPM4	RTPM3	RTPM2	RTPM1	RTPM0

RTPMm	Real-time output port selection (m = 0 to 7)
0	Port mode
1	Real-time output port mode

Caution When used as a real-time output port, set the port for real-time output in the output mode.

(2) Real-time output port control register (RTPC)

This register sets the operating mode and output trigger of the real-time output port.

Table 6-3 shows the relationships between the operating modes and output triggers of the real-time output port.

RTPC is set by a 1-bit or 8-bit memory manipulation instruction.

RESET input sets RTPC to 00H.

Figure 6-4. Real-Time Output Port Control Register (RTPC) Format

Address: 0FF9BH After reset: 00H R/W

Symbol	<7>	6	<5>	<4>	3	2	1	0
RTPC	RTPOE	0	BYTE	EXTR	0	0	0	0

RTPOE	Real-time output port operation control
0	Operation disabled
1	Operation enabled ^{Note}

BYTE	Real-time output port operating mode
0	4 bits × 2 channels
1	8 bits × 1 channel

EXTR	Real-time output control by INTP2
0	INTP2 is not the real-time output trigger.
1	INTP2 is the real-time output trigger.

Note When real-time output operation is enabled (RTPOE = 1), the values of the real-time output buffer registers (RTBH and RTBL) are transferred into the output latch of the real-time output port.

Caution When INTP2 is specified as an output trigger, specify the valid edge using the external interrupt rising edge enable register (EGP0) and external interrupt falling edge enable register (EGN0).

Table 6-3. Operating Modes and Output Triggers of Real-Time Output Port

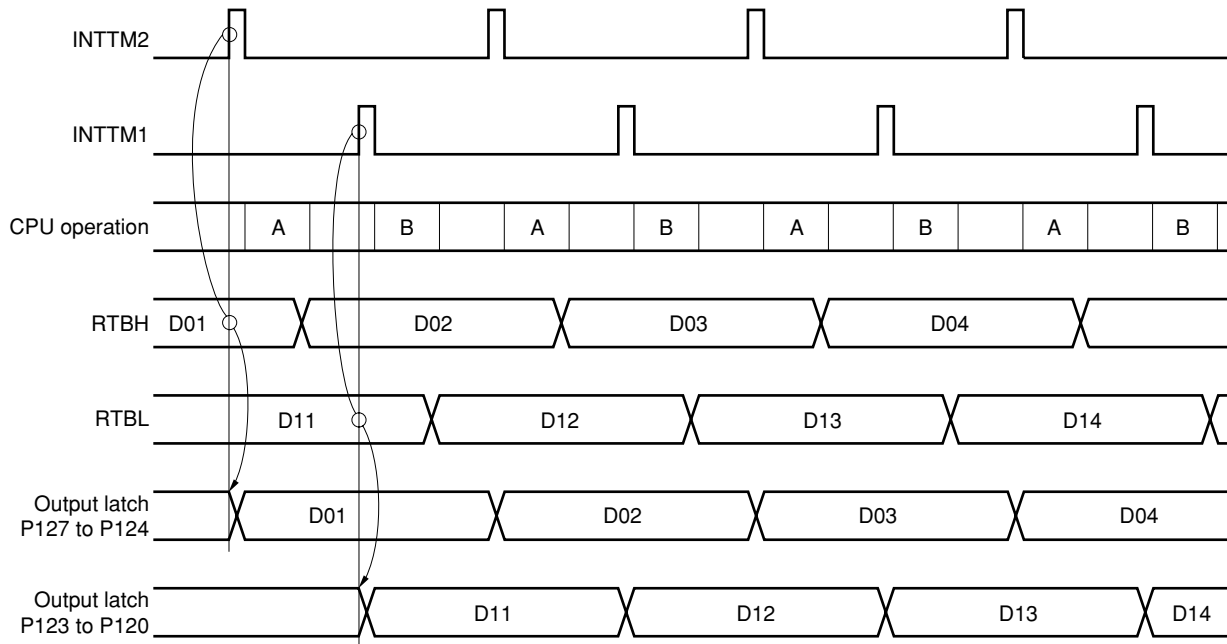
BYTE	EXTR	Operating Mode	RTBH → Port Output	RTBL → Port Output
0	0	4 bits × 2 channels	INTTM2	INTTM1
0	1		INTTM1	INTP2
1	0	8 bits × 1 channel	INTTM1	
1	1		INTP2	

6.4 Operation

When real-time output is enabled by bit 7 (RTPOE) = 1 in the real-time output port control register (RTPC), data in the real-time output buffer registers (RTBH, RTBL) are transferred to the output latch synchronized to the generation of the selected transfer trigger (set by EXTR and BYTE^{Note}). Based on the setting of the real-time output port mode register (RTPM), only the transferred data for the bits specified in the real-time output port are output from bits RTP0 to RTP7. A port set in the port mode by RTPM can be used as a general-purpose I/O port.

Note EXTR: Bit 4 of the real-time output port control register (RTPC)
 BYTE: Bit 5 of the real-time output port control register (RTPC)

Figure 6-5. Example of Operation Timing of Real-Time Output Port (EXTR = 0, BYTE = 0)



A: Software processing by INTTM2 (RTBH write)
 B: Software processing by INTTM1 (RTBL write)

6.5 Usage

- (1) Disabling the real-time output operation
Set bit 7 (RTPOE) = 0 in the real-time output port control register (RTPC).
- (2) Initial settings
 - Set the output latch to 0.
 - The value that is output by real-time output operation is the result of ORing the output latches of the port and the real-time output port (refer to **Figure 6-1 Block Diagram of Real-Time Output Port**). Therefore, after the real-time output operation is enabled, set the port output latch to 0 until the transfer trigger is generated.
 - Set the port in output mode.
 - Set the real-time output buffer registers (RTBH, RTBL) to the initial value.
- (3) Enable real-time output operation.
RTPOE = 1
After the real-time output operation is enabled, the values of RTBH and RTBL are latched to the real-time output port output latch.
- (4) When the selected transfer trigger is generated, the values of RTBH and RTBL are latched to the pin, and the next output is set to RTBH and RTBL by the interrupt processing corresponding to the trigger.
- (5) Hereafter, the next real-time output values are sequentially set in the RTBH and RTBL by the interrupt processing corresponding to the selected trigger.

6.6 Cautions

For the initial setting, set bit 7 (RTPOE) in the real-time output port control register (RTPC) to 0 to disable the real-time output operation.

CHAPTER 7 TIMER OVERVIEW

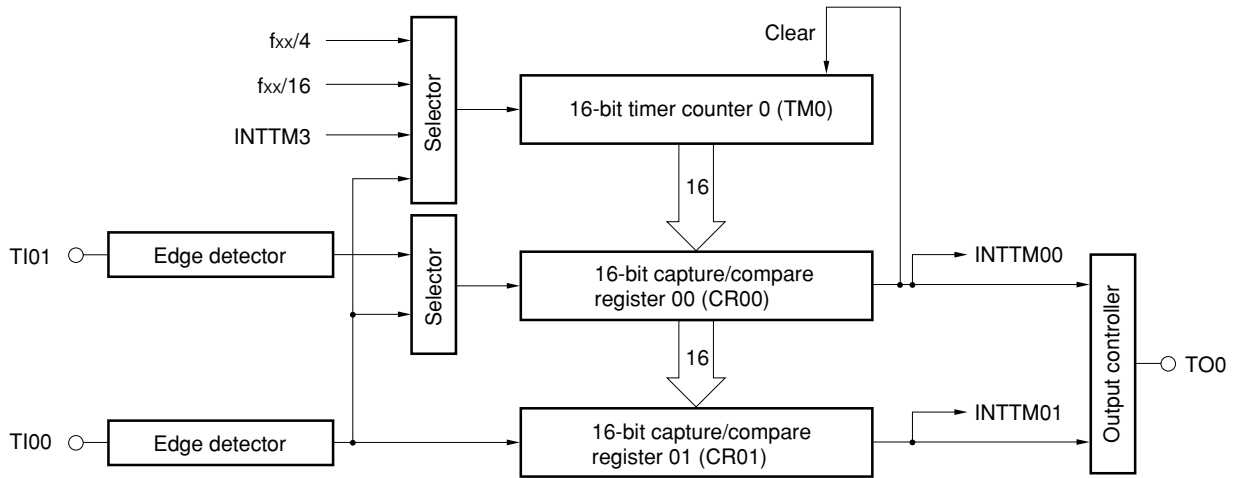
There are one on-chip 16-bit timer/event counter and six on-chip 8-bit timer/event counters.
 Since a total of eight interrupt requests is supported, these timer/counters can function as eight timer/counters.

Table 7-1. Timer/Counter Operation

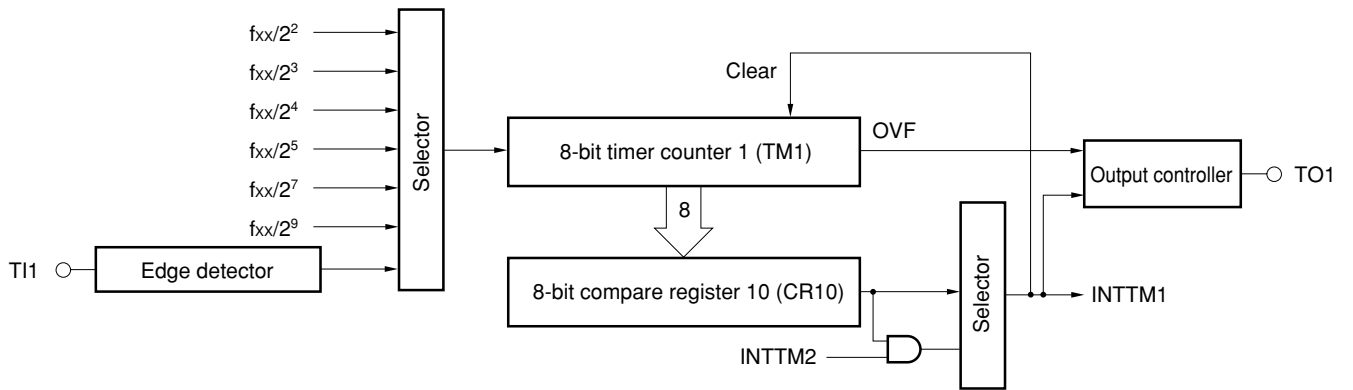
Name		16-Bit Timer/ Event Counter	8-Bit Timer/ Event Counter 1	8-Bit Timer/ Event Counter 2	8-Bit Timer/ Event Counter 5	8-Bit Timer/ Event Counter 6	8-Bit Timer/ Event Counter 7	8-Bit Timer/ Event Counter 8
Count width	8 bits	—	○	○	○	○	○	○
	16 bits	○	○		○		○	
Operating mode	Interval timer	1 ch	1 ch	1 ch	1 ch	1 ch	1 ch	1 ch
	External event counter	○	○	○	○	○	○	○
Function	Timer output	1 ch	1 ch	1 ch	1 ch	1 ch	1 ch	1 ch
	PPG output	○	—	—	—	—	—	—
	PWM output	—	○	○	○	○	○	○
	Square wave output	○	○	○	○	○	○	○
	One-shot pulse output	○	—	—	—	—	—	—
	Pulse width measurement	2 inputs	—	—	—	—	—	—
	No. of interrupt requests	2	1	1	1	1	1	1

Figure 7-1. Timer/Counter Block Diagram (1/2)

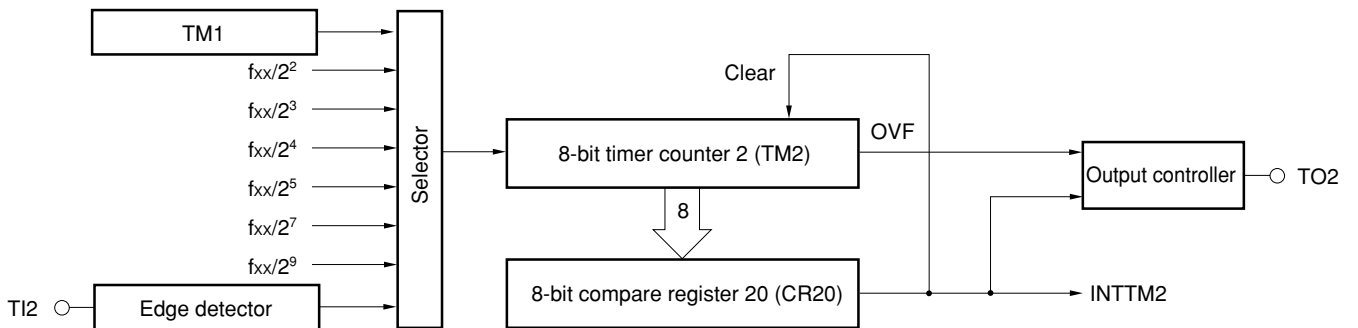
16-bit timer/event counter



8-bit timer/event counter 1



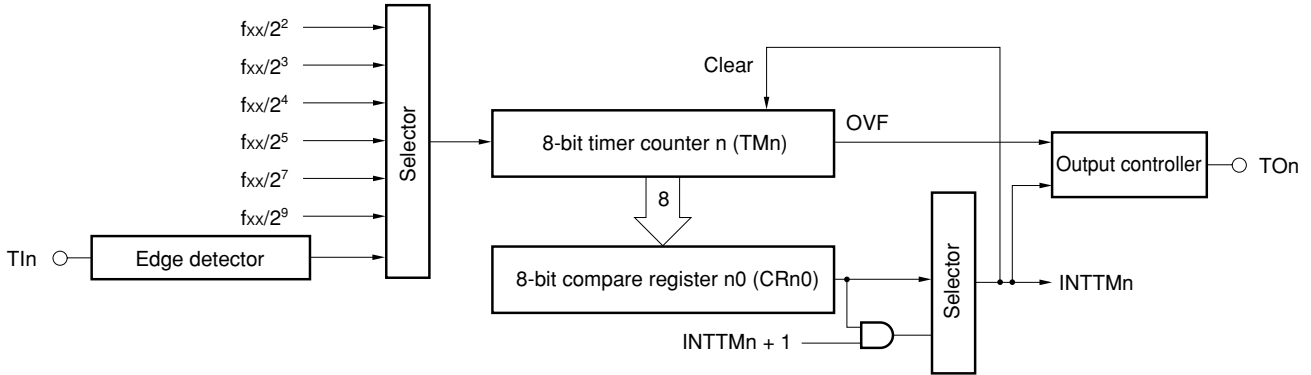
8-bit timer/event counter 2



Remark OVF: Overflow flag

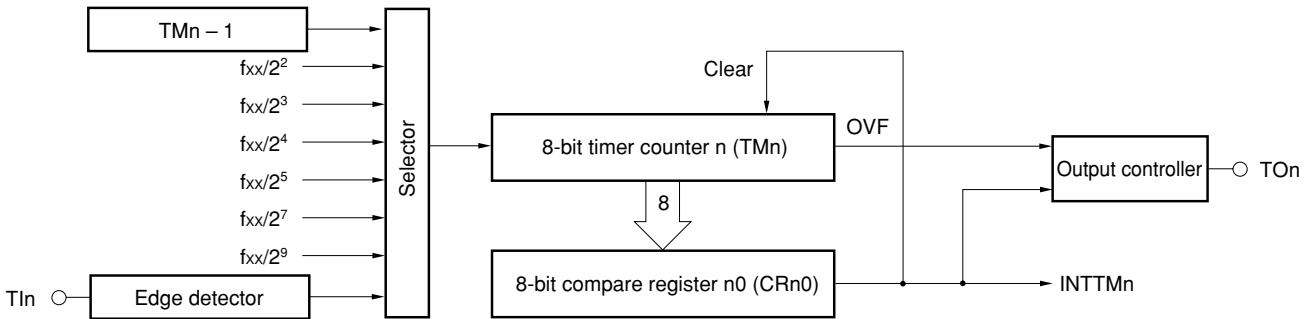
Figure 7-1. Timer/Counter Block Diagram (2/2)

8-bit timer/event counters 5 and 7



Remark n = 5 or 7

8-bit timer/event counters 6 and 8



Remark n = 6 or 8

CHAPTER 8 16-BIT TIMER/EVENT COUNTER

8.1 Function

The 16-bit timer/event counter has the following functions:

- Interval timer
- PPG output
- Pulse width measurement
- External event counter
- Square wave output
- One-shot pulse output

(1) Interval timer

When the 16-bit timer/event counter is used as an interval timer, it generates an interrupt request at predetermined time intervals.

(2) PPG output

The 16-bit timer/event counter can output a square wave whose frequency and output pulse width can be freely set.

(3) Pulse width measurement

The 16-bit timer/event counter can be used to measure the pulse width of a signal input from an external source.

(4) External event counter

The 16-bit timer/event counter can be used to measure the number of pulses of a signal input from an external source.

(5) Square wave output

The 16-bit timer/event counter can output a square wave with any frequency.

(6) One-shot pulse output

The 16-bit timer/event counter can output a one-shot pulse with any output pulse width.

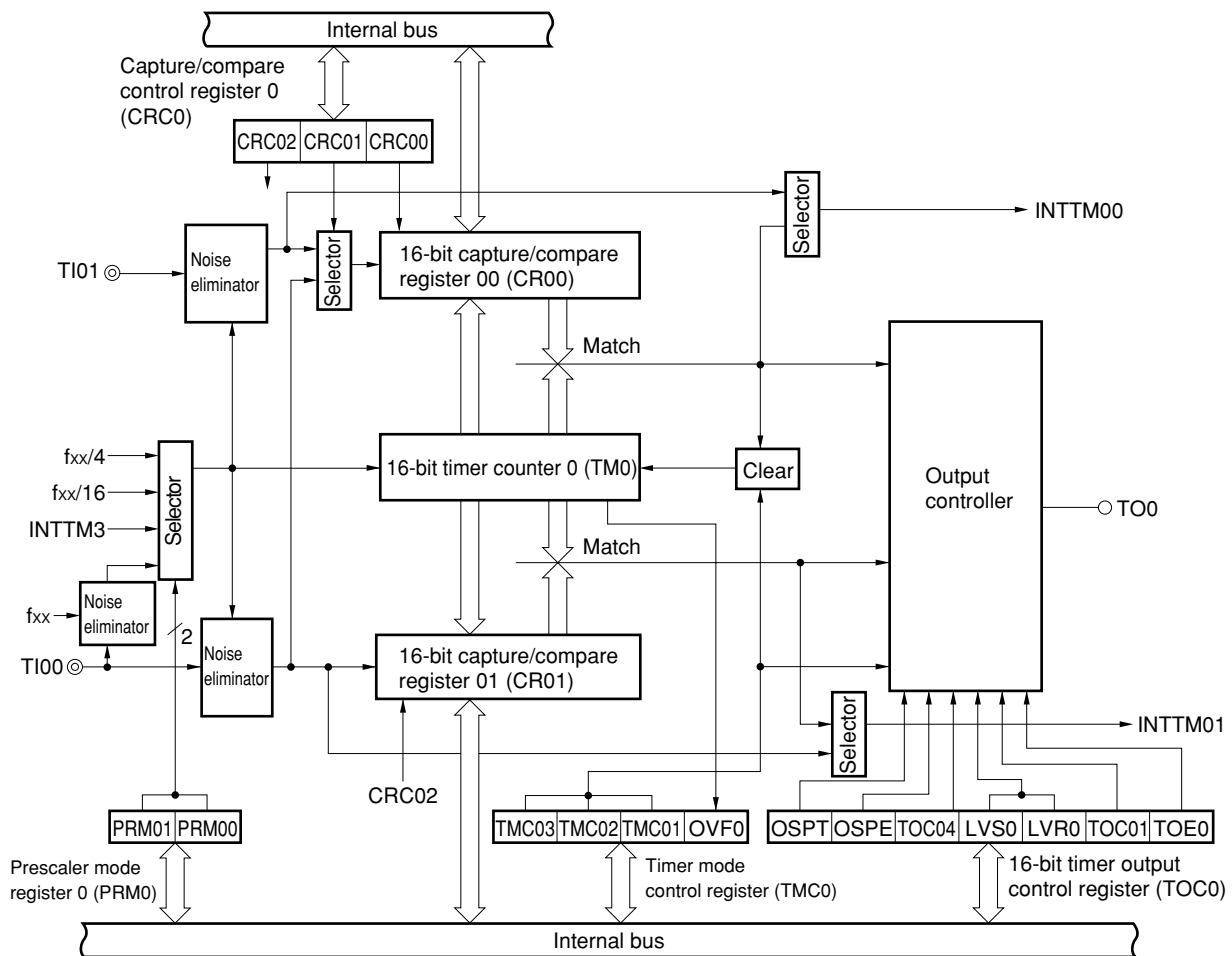
8.2 Configuration

The 16-bit timer/event counter consists of the following hardware:

Table 8-1. 16-Bit Timer/Event Counter Configuration

Item	Configuration
Timer counter	16 bits × 1 (TM0)
Register	16-bit capture/compare register: 16 bits × 2 (CR00, CR01)
Timer output	1 (TO0)
Control register	16-bit timer mode control register (TMC0) Capture/compare control register 0 (CRC0) 16-bit timer output control register (TOC0) Prescaler mode register 0 (PRM0)

Figure 8-1. Block Diagram of 16-Bit Timer/Event Counter



(1) 16-bit timer counter 0 (TM0)

TM0 is a 16-bit read-only register that counts count pulses.

The counter is incremented in synchronization with the rising edge of an input clock. If the count value is read during operation, input of the count clock is temporarily stopped, and the count value at that point is read. The count value is reset to 0000H in the following cases:

- <1> $\overline{\text{RESET}}$ is input .
- <2> TMC03 and TMC02 are cleared.
- <3> Valid edge of TI00 is input in the clear & start mode by inputting valid edge of TI00.
- <4> TM0 and CR00 match in the clear & start mode on match between TM0 and CR00.
- <5> Bit 6 of TOC0 (OSPT) is set or if the valid edge of TI00 is input in the one-shot pulse output mode.

(2) 16-bit capture/compare register 00 (CR00)

CR00 is a 16-bit register that functions as a capture register and as a compare register. Whether this register functions as a capture or compare register is specified by using bit 0 (CRC00) of capture/compare control register 0 (CRC0).

- **When using CR00 as compare register**

The value set to CR00 is always compared with the count value of 16-bit timer counter 0 (TM0). When the values of the two match, an interrupt request (INTTM00) is generated. When TM0 is used as an interval timer, CR00 can also be used as a register that holds the interval time.

- **When using CR00 as capture register**

The valid edge of the TI00 or TI01 pin can be selected as a capture trigger. The valid edge of TI00 and TI01 is set via prescaler mode register 0 (PRM0).

Tables 8-2 and 8-3 show the conditions that apply when the capture trigger is specified as the valid edge of the TI00 pin and the valid edge of the TI01 pin, respectively.

Table 8-2. Valid Edge of TI00 Pin and Capture Trigger of CR00

ES01	ES00	Valid Edge of TI00 Pin	Capture Trigger of CR00
0	0	Falling edge	Rising edge
0	1	Rising edge	Falling edge
1	0	Setting prohibited	Setting prohibited
1	1	Both rising and falling edges	No capture operation

Table 8-3. Valid Edge of TI01 Pin and Capture Trigger of CR00

ES01	ES00	Valid Edge of TI01 Pin	Capture Trigger of CR00
0	0	Falling edge	Falling edge
0	1	Rising edge	Rising edge
1	0	Setting prohibited	Setting prohibited
1	1	Both rising and falling edges	Both rising and falling edges

CR00 is set by a 16-bit memory manipulation instruction.

RESET input sets CR00 to 0000H.

Caution Set CR00 to the value other than 0000H. When using the register as an event counter, a count for one-pulse cannot be operated.

(3) 16-bit capture/compare register 01 (CR01)

This is a 16-bit register that can be used as a capture register and a compare register. Whether it is used as a capture register or compare register is specified by bit 2 (CRC02) of capture/compare control register 0 (CRC0).

- **When using CR01 as compare register**

The value set to CR01 is always compared with the count value of 16-bit timer counter 0 (TM0). When the values of the two match, an interrupt request (INTTM01) is generated.

- **When using CR01 as capture register**

The valid edge of the TI00 pin can be selected as a capture trigger. The valid edge of TI00 is specified by using prescaler mode register 0 (PRM0).

Table 8-4 shows the conditions that apply when the capture trigger is specified as the valid edge of the TI00 pin.

Table 8-4. Valid Edge of TI00 Pin and Capture Trigger of CR01

ES01	ES00	Valid Edge of TI00 Pin	Capture Trigger of CR01
0	0	Falling edge	Falling edge
0	1	Rising edge	Rising edge
1	0	Setting prohibited	Setting prohibited
1	1	Both rising and falling edges	Both rising and falling edges

CR01 is set by a 16-bit memory manipulation instruction.

$\overline{\text{RESET}}$ input sets CR01 to 0000H.

Caution Set CR01 to the value other than 0000H. When using an event counter, a count for one-pulse cannot be operated.

8.3 Control Registers

The following four types of registers control the 16-bit timer/event counter.

- 16-bit timer mode control register (TMC0)
- Capture/compare control register 0 (CRC0)
- 16-bit timer output control register (TOC0)
- Prescaler mode register 0 (PRM0)

(1) 16-bit timer mode control register (TMC0)

This register specifies the operation mode of the 16-bit timer; and the clear mode, output timing, and overflow detection of the 16-bit timer register.

TMC0 is set by a 1-bit or 8-bit memory manipulation instruction.

$\overline{\text{RESET}}$ input sets TMC0 to 00H.

Caution The 16-bit timer register starts operating when a value other than 0, 0 (operation stop mode) is set to TMC02 and TMC03. To stop the operation, set 0, 0 to TMC02 and TMC03.

Figure 8-2. Format of 16-Bit Timer Mode Control Register (TMC0)

Address: 0FF18H After reset: 00H R/W

Symbol	7	6	5	4	3	2	1	<0>
TMC0	0	0	0	0	TMC03	TMC02	TMC01	OVF0

TMC03	TMC02	TMC01	Selection of operating mode and clear mode	Selection of T00 output timing	Generation of interrupt
0	0	0	Operation stop (T00 is cleared to 0).	Not affected	Does not generate.
0	0	1			
0	1	0	Free-running mode	Match between T00 and CR00 or match between T00 and CR01	Generates on match between T00 and CR00 or match between T00 and CR01.
0	1	1		Match between T00 and CR00, match between T00 and CR01, or valid edge of TIO0	
1	0	0	Clears and starts at valid edge of TIO0.	Match between T00 and CR00 or match between T00 and CR01	
1	0	1		Match between T00 and CR00, match between T00 and CR01, or valid edge of TIO0	
1	1	0	Clears and starts on match between T00 and CR00.	Match between T00 and CR00 or match between T00 and CR01	
1	1	1		Match between T00 and CR00, match between T00 and CR01, or valid edge of TIO0	

OVF0	Detection of overflow of 16-bit timer register
0	Overflows.
1	Does not overflow.

Cautions 1. Before changing the clear mode and TO0 output timing, be sure to stop the timer operation (reset TMC02 and TMC03 to 0, 0).

The valid edge of the TI00 pin is selected by using prescaler mode register 0 (PRM0).

2. When a mode in which the timer is cleared and started on a match between TM0 and CR00, the OVF0 flag is set to 1 when the count value of TM0 changes from FFFFH to 0000H with CR00 set to FFFFH.

3. The software trigger (bit 6 (OSPT) of 16-bit timer output control register 0 (TOC0) = 1) and the external trigger (TI00 input) are always valid in one-shot pulse output mode.

If the software trigger is used in one-shot pulse output mode, the TI00 pin cannot be used as a general-purpose port pin. Therefore, fix the TI00 pin to either high level or low level.

Remark TO0: Output pin of 16-bit timer counter (TM0)

TI00: Input pin of 16-bit timer counter (TM0)

TM0: 16-bit timer register

CR00: Compare register 00

CR01: Compare register 01

(2) Capture/compare control register 0 (CRC0)

This register controls the operation of the capture/compare registers (CR00 and CR01). CRC0 is set by a 1-bit or 8-bit memory manipulation instruction. $\overline{\text{RESET}}$ input sets CRC0 to 00H.

Figure 8-3. Format of Capture/Compare Control Register 0 (CRC0)

Address: 0FF16H After reset: 00H R/W

Symbol	7	6	5	4	3	2	1	0
CRC0	0	0	0	0	0	CRC02	CRC01	CRC00

CRC02	Selection of operation mode of CR01
0	Operates as compare register.
1	Operates as capture register.

CRC01	Selection of capture trigger of CR00
0	Captured at valid edge of TI01.
1	Captured in reverse phase of valid edge of TI00.

CRC00	Selection of operation mode of CR00
0	Operates as compare register.
1	Operates as capture register.

- Cautions**
1. Before setting CRC0, be sure to stop the timer operation.
 2. When the mode in which the timer is cleared and started on a match between TM0 and CR00 is selected by the 16-bit timer mode control register (TMC0), do not specify CR00 as a capture register.

(3) 16-bit timer output control register (TOC0)

This register controls the operation of the 16-bit timer/event counter output controller by setting or resetting the R-S flip-flop (LV0), enabling or disabling reverse output, enabling or disabling output of the 16-bit timer/event counter, enabling or disabling one-shot pulse output operation, and selecting an output trigger for a one-shot pulse by software.

TOC0 is set by a 1-bit or 8-bit memory manipulation instruction.

$\overline{\text{RESET}}$ input sets TOC0 to 00H.

Figure 8-4 shows the format of TOC0.

Figure 8-4. Format of 16-Bit Timer Output Control Register (TOC0)

Address: 0FF1AH After reset: 00H R/W

Symbol	7	<6>	<5>	4	<3>	<2>	1	<0>
TOC0	0	OSPT	OSPE	TOC04	LVS0	LVR0	TOC01	TOE0

OSPT	Output trigger control of one-shot pulse by software
0	No one-shot pulse trigger
1	Uses one-shot pulse trigger.

OSPE	Controls of one-shot pulse output operation
0	Successive pulse output
1	One-shot pulse output

TOC04	Timer output control on match between CR01 and TM0
0	Disables reverse timer output F/F.
1	Enables reverse timer output F/F.

LVS0	LVR0	Timer output control by software
0	0	Not affected
0	1	Resets (0).
1	0	Sets (1).
1	1	Setting prohibited

TOC01	Timer output control on match between CR00 and TM0 and valid edge of TI00
0	Disables reverse timer output F/F.
1	Enables reverse timer output F/F.

TOE0	Output control of 16-bit timer/event counter
0	Disables output (output is fixed to 0 level).
1	Enables output.

- Cautions**
1. Before setting TOC0, be sure to stop the timer operation.
 2. LVS0 and LVR0 are 0 when read after data have been set to them.
 3. OSPT is 0 when read because it is automatically cleared after data has been set.

(4) Prescaler mode register 0 (PRM0)

This register selects a count clock of the 16-bit timer counter (TM0) and the valid edge of the TI00, TI01 input. PRM0 is set by a 1-bit or 8-bit memory manipulation instruction. $\overline{\text{RESET}}$ input sets PRM0 to 00H.

Figure 8-5. Format of Prescaler Mode Register 0 (PRM0)

Address: 0FF1CH After reset: 00H R/W

Symbol	7	6	5	4	3	2	1	0
PRM0	ES11	ES10	ES01	ES00	0	0	PRM01	PRM00

ES11	ES10	Selection of valid edge of TI01
0	0	Falling edge
0	1	Rising edge
1	0	Setting prohibited
1	1	Both falling and rising edges

ES01	ES00	Selection of valid edge of TI00
0	0	Falling edge
0	1	Rising edge
1	0	Setting prohibited
1	1	Both falling and rising edges

PRM01	PRM00	Selection of count clock
0	0	$f_{xx}/4$ (3.13 MHz)
0	1	$f_{xx}/16$ (781 kHz)
1	0	INTTM3 (Timer output for clock)
1	1	Valid edge of TI00

Caution When selecting the valid edge of TI00 as the count clock, do not specify the valid edge of TI00 to clear and start the timer and as a capture trigger. Set the count clock to be $f_{xx}/4$ or below.

Remark Figures in parentheses apply to operation with $f_{xx} = 12.5$ MHz

8.4 Operation

8.4.1 Operation as interval timer (16-bit operation)

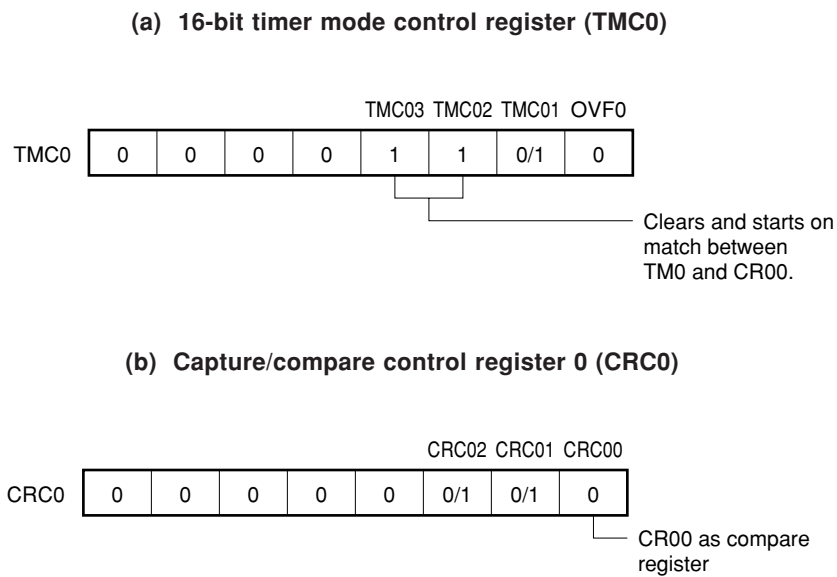
The 16-bit timer/event counter operates as an interval timer when the 16-bit timer mode control register (TMC0) and capture/compare control register 0 (CRC0) are set as shown in Figure 8-6.

In this case, the 16-bit timer/event counter repeatedly generates an interrupt at the time interval specified by the count value set in advance to 16-bit capture/compare register 00 (CR00).

When the count value of the 16-bit timer counter (TM0) matches the set value of CR00, the value of TM0 is cleared to 0, and the timer continues counting. At the same time, an interrupt request signal (INTTM00) is generated.

The count clock of the 16-bit timer/event counter can be selected by bits 0 and 1 (PRM00 and PRM01) of prescaler mode register 0 (PRM0).

Figure 8-6. Control Register Settings During Interval Timer Operation



Remark 0/1: When these bits are reset to 0 or set to 1, the other functions can be used along with the interval timer function. For details, refer to **Figures 8-2** and **8-3**.

Figure 8-7. Configuration of Interval Timer

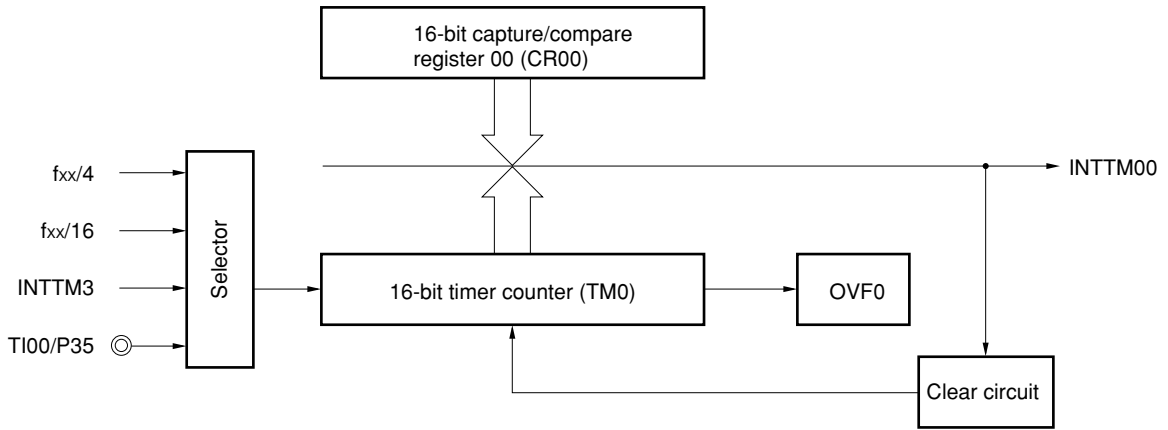
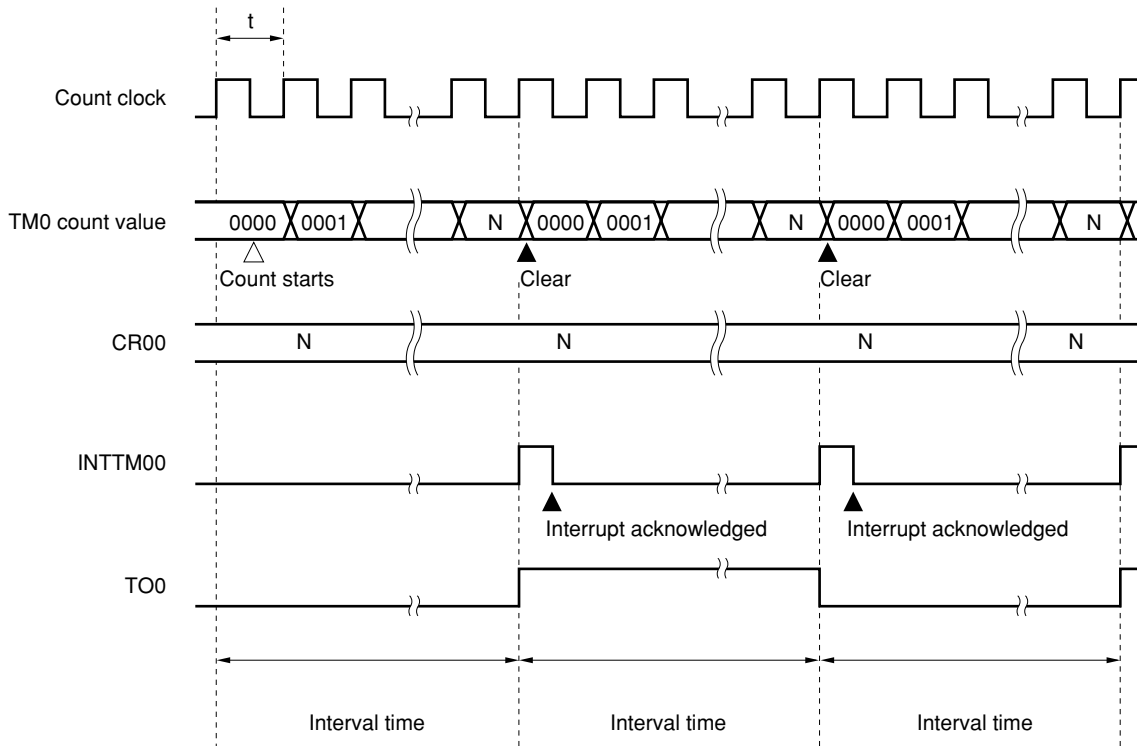


Figure 8-8. Timing of Interval Timer Operation



Remark Interval time = (N + 1) × t: N = 0001H to FFFFH

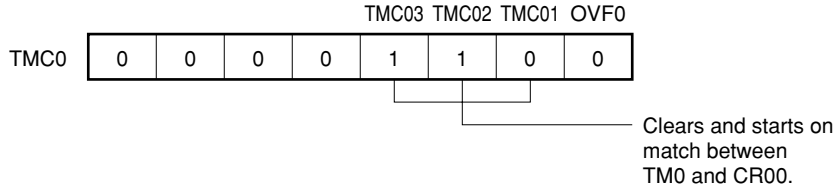
8.4.2 Operation as PPG output

The 16-bit timer/event counter can be used for PPG (Programmable Pulse Generator) output by setting the 16-bit timer mode control register (TMC0) and capture/compare control register 0 (CRC0) as shown in Figure 8-9.

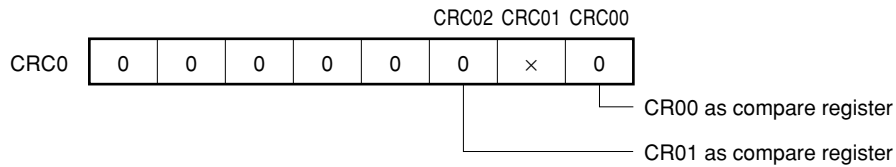
The PPG output function outputs a rectangular wave with a cycle specified by the count value set in advance to 16-bit capture/compare register 00 (CR00) and a pulse width specified by the count value set in advance to 16-bit capture/compare register 01 (CR01).

Figure 8-9. Control Register Settings During PPG Output Operation

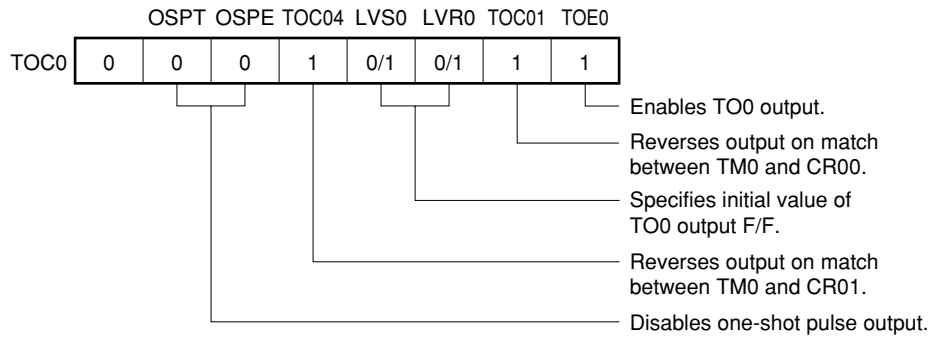
(a) 16-bit timer mode control register (TMC0)



(b) Capture/compare control register 0 (CRC0)



(c) 16-bit timer output control register (TOC0)



Remark x: don't care

Caution Set a value in the following range to CR00 and CR01.
 0000H < CR01 < CR00 ≤ FFFFH

8.4.3 Operation as pulse width measurement

The 16-bit timer counter (TM0) can be used to measure the pulse widths of the signals input to the TI00/P35 and TI01/P36 pins.

Measurement can be carried out with TM0 used as a free-running counter or by restarting the timer in synchronization with the edge of the signal input to the TI00/P35 pin.

(1) Pulse width measurement with free-running counter and one capture register

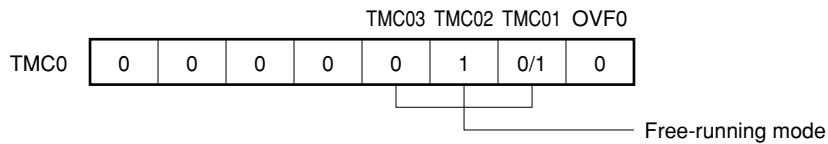
If the edge specified by prescaler mode register 0 (PRM0) is input to the TI00/P35 pin when the 16-bit timer counter (TM0) is used as a free-running counter (refer to **Figure 8-10**), the value of TM0 is loaded to 16-bit capture/compare register 01 (CR01), and an external interrupt request signal (INTTM01) is set.

The edge is specified by using bits 4 and 5 (ES00 and ES01) of prescaler mode register 0 (PRM0). The rising edge, falling edge, or both the rising and falling edges can be selected.

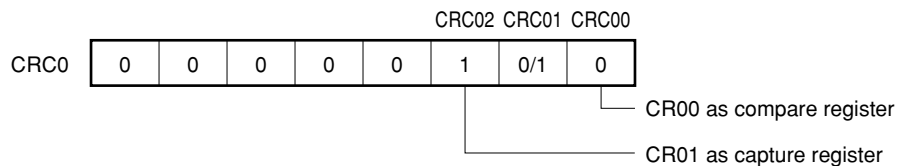
The valid edge is detected through sampling at a count clock cycle selected by prescaler mode register 0 (PRM0), and the capture operation is not performed until the valid level is detected two times. Therefore, noise with a short pulse width can be eliminated.

Figure 8-10. Control Register Settings During Pulse Width Measurement with Free-Running Counter and One Capture Register

(a) 16-bit timer mode control register (TMC0)



(b) Capture/compare control register 0 (CRC0)



Remark 0/1: When these bits are reset to 0 or set to 1, the other functions can be used along with the pulse width measurement function. For details, refer to **Figures 8-2** and **8-3**.

Figure 8-11. Configuration of Pulse Width Measurement with Free-Running Counter

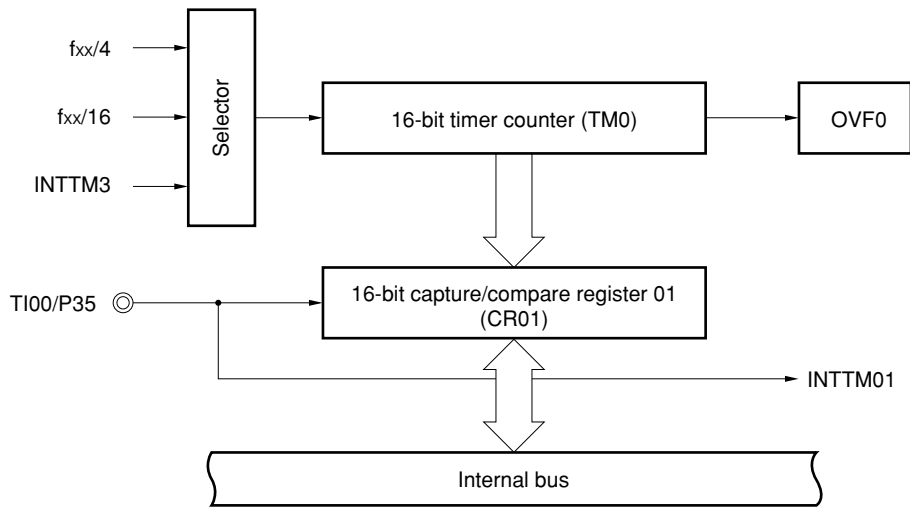
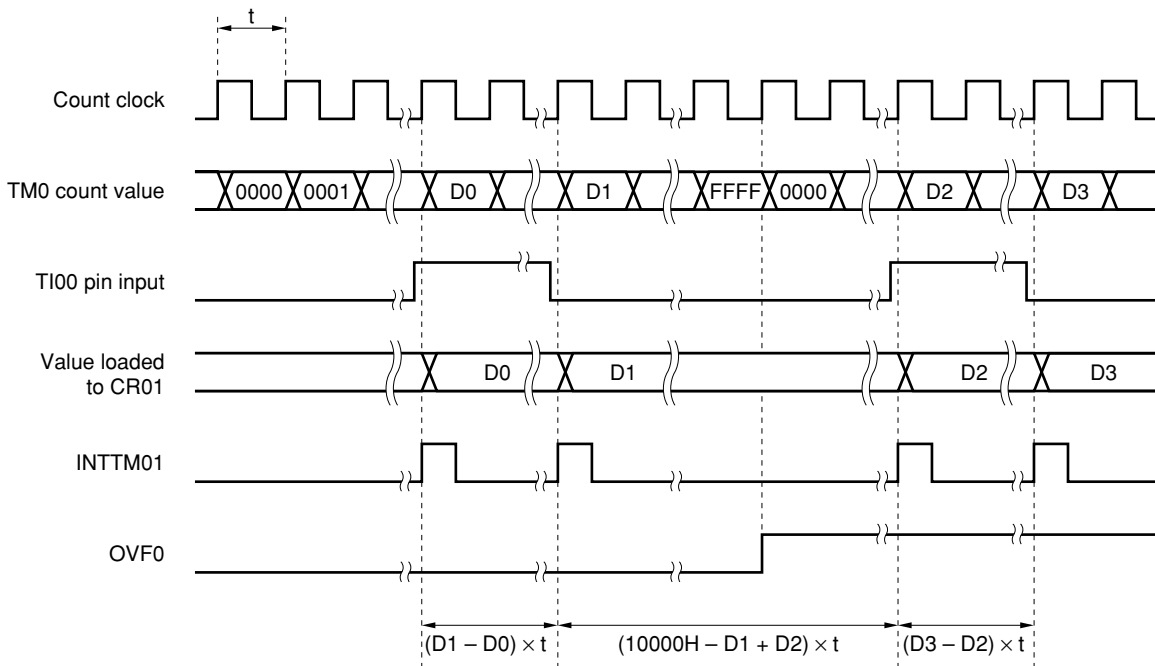


Figure 8-12. Timing of Pulse Width Measurement with Free-Running Counter and One Capture Register (with Both Edges Specified)



Caution For simplification purposes, delay due to noise elimination is not taken into consideration in the capture operation by TI00 pin input and in the interrupt request generation timing in the above figure. For a more accurate picture, refer to Figure 8-14 CR01 Capture Operation with Rising Edge Specified.

(2) Measurement of two pulse widths with free-running counter

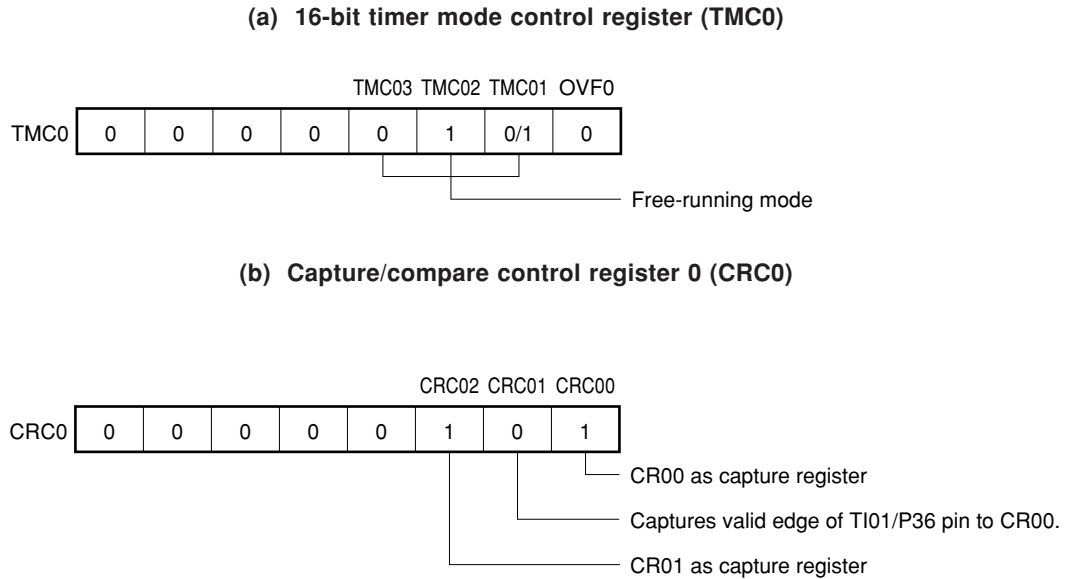
The pulse widths of the two signals respectively input to the TI00/P35 and TI01/P36 pins can be measured when the 16-bit timer counter (TM0) is used as a free-running counter (refer to **Figure 8-13**).

When the edge specified by bits 4 and 5 (ES00 and ES01) of prescaler mode register 0 (PRM0) is input to the TI00/P35 pin, the value of the TM0 is loaded to 16-bit capture/compare register 01 (CR01) and an external interrupt request signal (INTTM01) is set.

When the edge specified by bits 6 and 7 (ES10 and ES11) of prescaler mode register 0 (PRM0) is input to the TI01/P36 pin, the value of TM0 is loaded to 16-bit capture/compare register 00 (CR00), and an external interrupt request signal (INTTM00) is set.

The edges of the TI00/P35 and TI01/P36 pins are specified by bits 4 and 5 (ES00 and ES01) and bits 6 and 7 (ES10 and ES11) of PRM0, respectively. The rising, falling, or both rising and falling edges can be specified. The valid edge of the TI00/P35 pin and TI01/P36 pin is detected through sampling at a count clock cycle selected by prescaler mode register 0 (PRM0), and the capture operation is not performed until the valid level is detected two times. Therefore, noise with a short pulse width can be eliminated.

Figure 8-13. Control Register Settings During Measurement of Two Pulse Widths with Free-Running Counter



Remark 0/1: When these bits are reset to 0 or set to 1, the other functions can be used along with the pulse width measurement function. For details, refer to **Figures 8-2** and **8-3**.

• **Capture operation (free-running mode)**

The following figure illustrates the operation of the capture register when the capture trigger is input.

Figure 8-14. CR01 Capture Operation with Rising Edge Specified

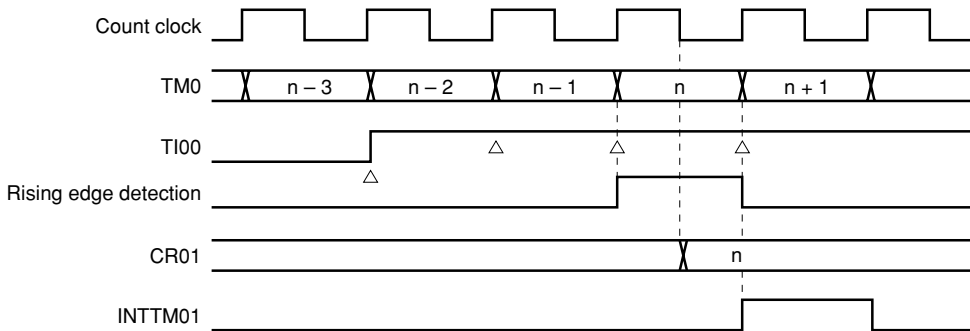
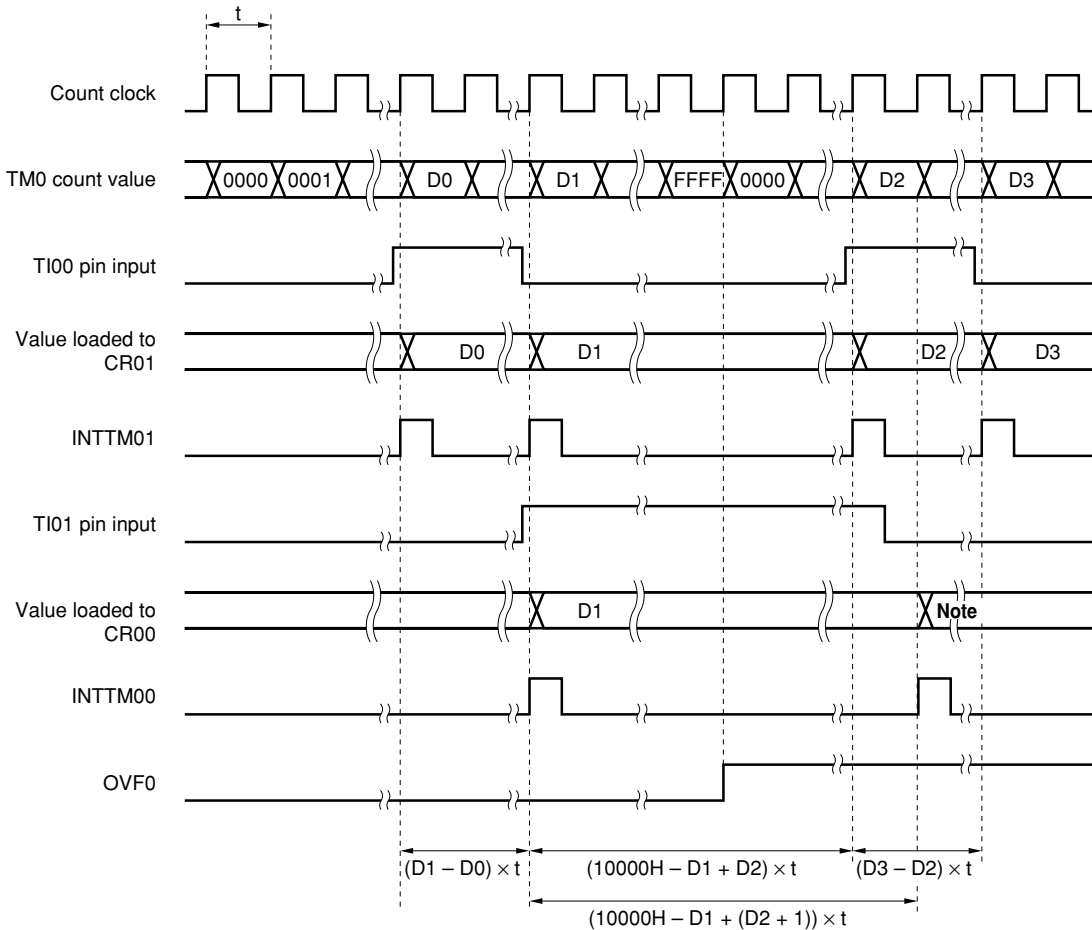


Figure 8-15. Timing of Pulse Width Measurement with Free-Running Counter (with Both Edges Specified)



Note D2 + 1

Caution For simplification purposes, delay due to noise elimination is not taken into consideration in the capture operation by TI00 pin input and in the interrupt request generation timing in the above figure. For a more accurate picture, refer to Figure 8-14 CR01 Capture Operation with Rising Edge Specified.

(3) Pulse width measurement with free-running counter and two capture registers

When the 16-bit timer counter (TM0) is used as a free-running counter (refer to **Figure 8-16**), the pulse width of the signal input to the TI00/P35 pin can be measured.

When the edge specified by bits 4 and 5 (ES00 and ES01) of prescaler mode register 0 (PRM0) is input to the TI00/P35 pin, the value of TM0 is loaded to 16-bit capture/compare register 01 (CR01), and an external interrupt request signal (INTTM01) is set.

The value of TM0 is also loaded to 16-bit capture/compare register 00 (CR00) when an edge reverse to the one that triggers capturing to CR01 is input.

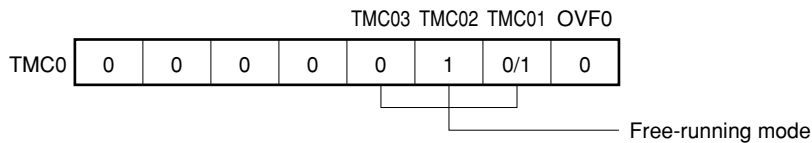
The edge of the TI00/P35 pin is specified by bits 4 and 5 (ES00 and ES01) of prescaler mode register 0 (PRM0). The rising or falling edge can be specified.

The valid edge of the TI00/P35 pin is detected through sampling at a count clock cycle selected by prescaler mode register 0 (PRM0), and the capture operation is not performed until the valid level is detected two times. Therefore, noise with a short pulse width can be eliminated.

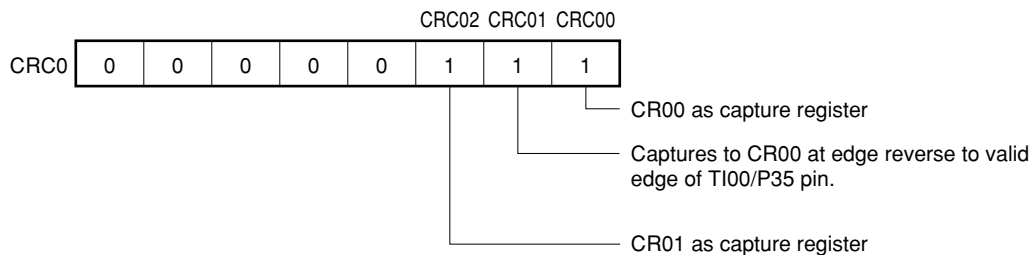
Caution If the valid edge of the TI00/P35 pin is specified to be both the rising and falling edges, 16-bit capture/compare register 00 (CR00) cannot perform its capture operation.

Figure 8-16. Control Register Settings During Pulse Width Measurement with Free-Running Counter and Two Capture Registers

(a) 16-bit timer mode control register (TMC0)

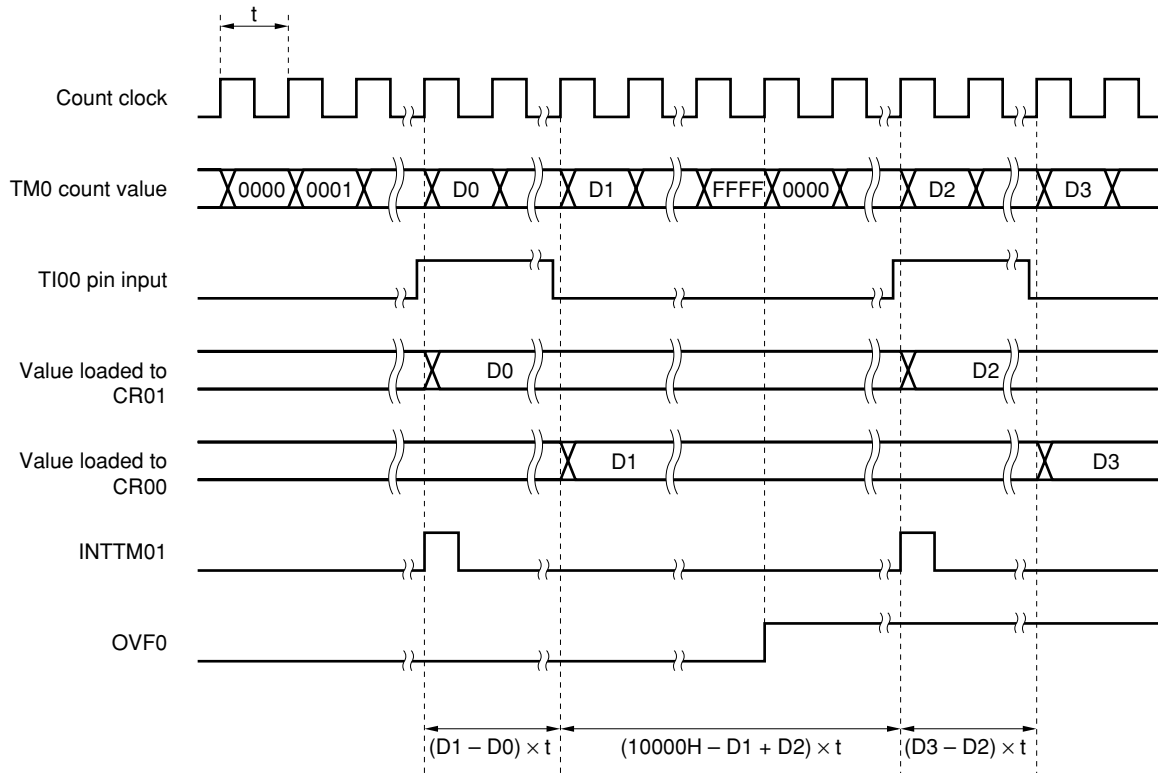


(b) Capture/compare control register 0 (CRC0)



Remark 0/1: When these bits are reset to 0 or set to 1, the other functions can be used along with the pulse width measurement function. For details, refer to **Figures 8-2** and **8-3**.

Figure 8-17. Timing of Pulse Width Measurement with Free-Running Counter and Two Capture Registers (with Rising Edge Specified)



Caution For simplification purposes, delay due to noise elimination is not taken into consideration in the capture operation by TIO0 pin input and in the interrupt request generation timing in the above figure. For a more accurate picture, refer to Figure 8-14 CR01 Capture Operation with Rising Edge Specified.

(4) Pulse width measurement by restarting

When the valid edge of the TI00/P35 pin is detected, the pulse width of the signal input to the TI00/P35 pin can be measured by clearing the 16-bit timer counter (TM0) once and then resuming counting after loading the count value of TM0 to 16-bit capture/compare register 01 (CR01) (refer to **Figure 8-18**).

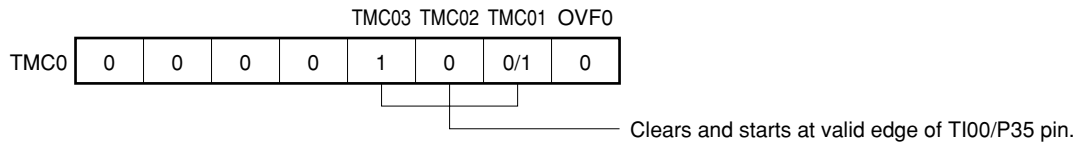
The edge of the TI00/P35 pin is specified by bits 4 and 5 (ES00 and ES01) of prescaler mode register 0 (PRM0). The rising or falling edge can be specified.

The valid edge is detected through sampling at a count clock cycle selected by prescaler mode register 0 (PRM0), and the capture operation is not performed until the valid level is detected two times. Therefore, noise with a short pulse width can be eliminated.

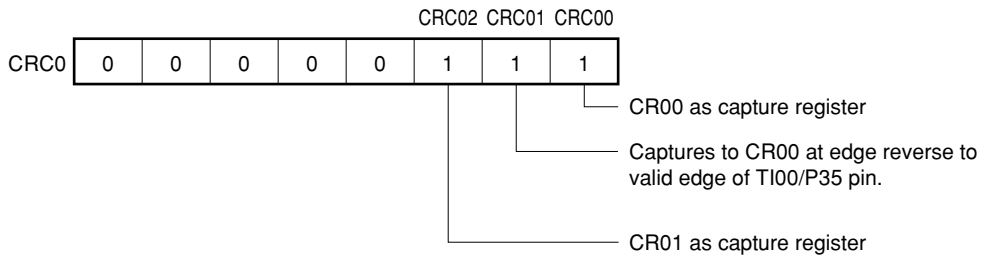
Caution If the valid edge of the TI00/P35 pin is specified to be both the rising and falling edges, 16-bit capture/compare register 00 (CR00) cannot perform its capture operation.

Figure 8-18. Control Register Settings During Pulse Width Measurement by Restarting

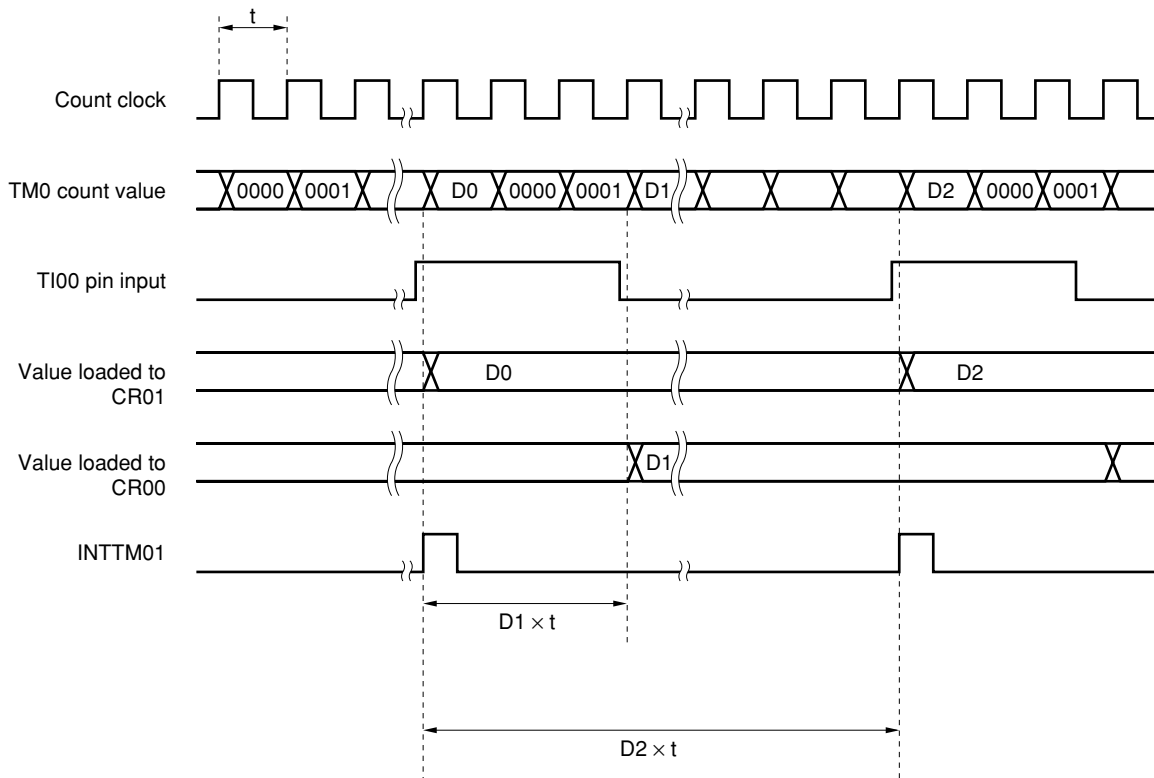
(a) 16-bit timer mode control register (TMC0)



(b) Capture/compare control register 0 (CRC0)



Remark 0/1: When these bits are reset to 0 or set to 1, the other functions can be used along with the pulse width measurement function. For details, refer to **Figures 8-2** and **8-3**.

Figure 8-19. Timing of Pulse Width Measurement by Restarting (with Rising Edge Specified)

Caution For simplification purposes, delay due to noise elimination is not taken into consideration in the capture operation by TI00 pin input and in the interrupt request generation timing in the above figure. For a more accurate picture, refer to Figure 8-14 CR01 Capture Operation with Rising Edge Specified.

8.4.4 Operation as external event counter

The 16-bit timer/counter can be used as an external event counter which counts the number of clock pulses input to the TI00/P35 pin from an external source by using the 16-bit timer counter (TM0).

Each time the valid edge specified by prescaler mode register 0 (PRM0) has been input to the TI00/P35 pin, TM0 is incremented.

To perform a count operation using the TI00/P35 pin input clock, specify the TI00 valid edge using bits 0 and 1 of PRM0 (PRM00, PRM01).

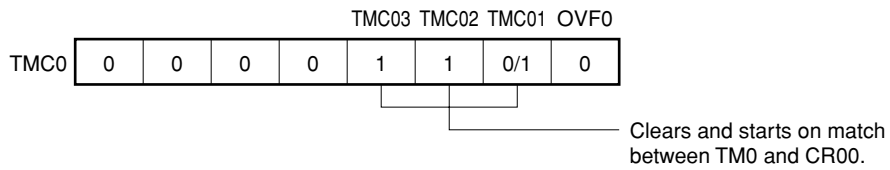
Set CR00 to a value other than 0000H (a 1-pulse counter can not be operated).

The edge of the TI00/P35 pin is specified by bits 4 and 5 (ES00 and ES01) of prescaler mode register 0 (PRM0). The rising, falling, or both the rising and falling edges can be specified.

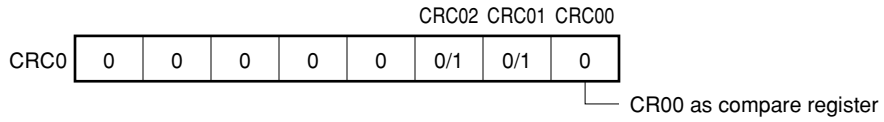
When using the TI00 pin input as the count clock, sampling for valid edge detection is locked by the main system clock (f_{xx}) and the capture operation is not performed until the valid level is detected two times. Therefore, noise with a short pulse width can be eliminated.

Figure 8-20. Control Register Settings During External Event Counter Mode

(a) 16-bit timer mode control register (TMC0)



(b) Capture/compare control register 0 (CRC0)



Remark 0/1: When these bits are reset to 0 or set to 1, the other functions can be used along with the external event counter function. For details, refer to **Figures 8-2** and **8-3**.

Figure 8-21. Configuration of External Event Counter

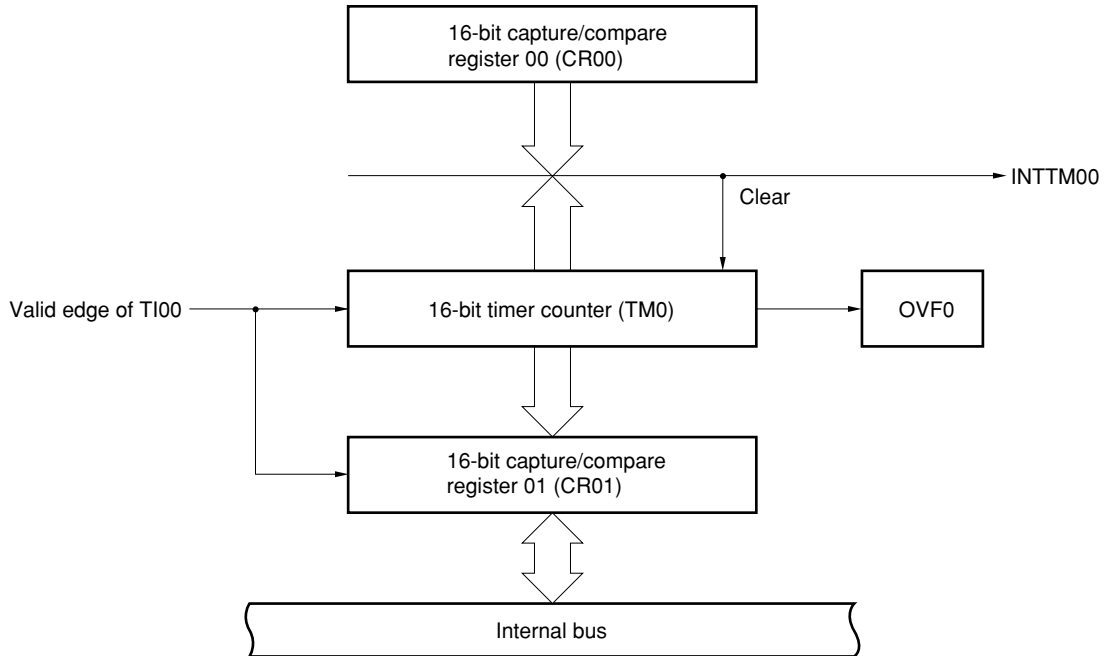
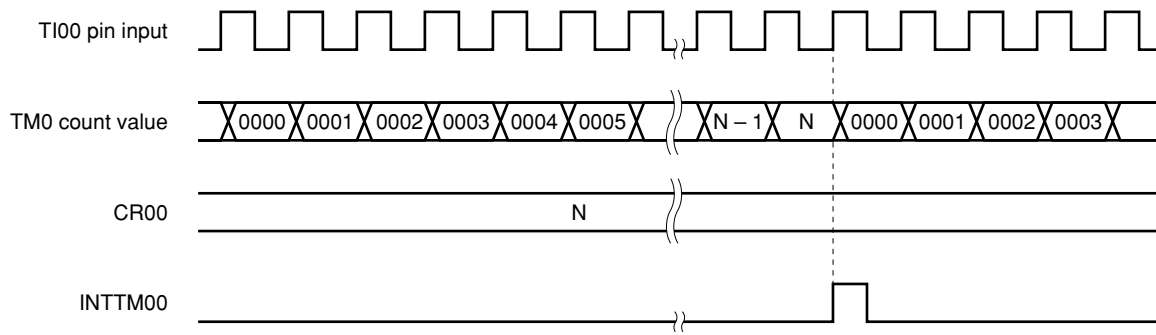


Figure 8-22. Timing of External Event Counter Operation (with Rising Edge Specified)

Caution Read TM0 when reading the count value of the external event counter.

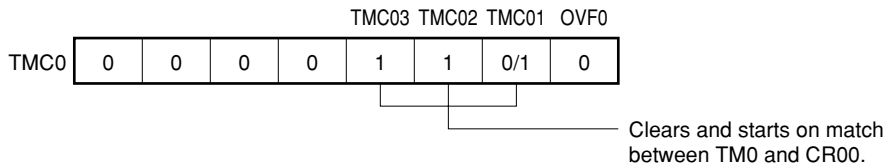
8.4.5 Operation as square wave output

The 16-bit timer/event counter can be used to output a square wave with any frequency at an interval specified by the count value set in advance to 16-bit capture/compare register 00 (CR00).

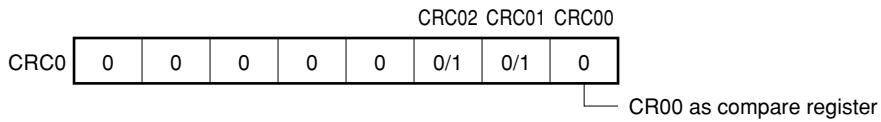
By setting bits 0 (TOE0) and 1 (TOC01) of 16-bit timer output control register (TOC0) to 1, the output status of the TO0/P30 pin is reversed at an interval specified by the count value set in advance to CR00. In this way, a square wave of any frequency can be output.

Figure 8-23. Control Register Settings During Square Wave Output Mode

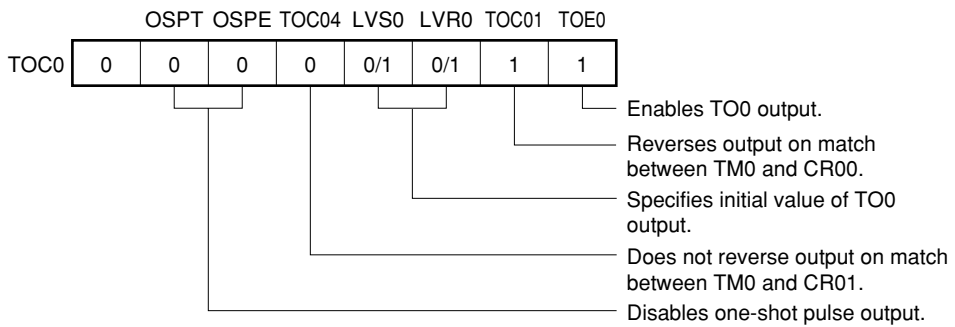
(a) 16-bit timer mode control register (TMC0)



(b) Capture/compare control register 0 (CRC0)

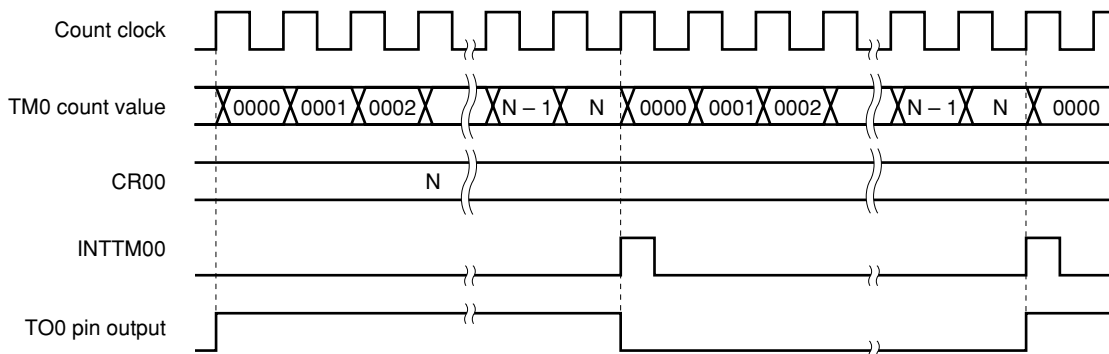


(c) 16-bit timer output control register (TOC0)



Remark 0/1: When these bits are reset to 0 or set to 1, the other functions can be used along with the square wave output function. For details, refer to **Figures 8-2, 8-3, and 8-4**.

Figure 8-24. Timing of Square Wave Output Operation



8.4.6 Operation as one-shot pulse output

The 16-bit timer/event counter can output a one-shot pulse in synchronization with a software trigger and an external trigger (TI00/P35 pin input).

(1) One-shot pulse output with software trigger

A one-shot pulse can be output from the TO0/P30 pin by setting the 16-bit timer mode control register (TMC0), capture/compare control register 0 (CRC0), and 16-bit timer output control register (TOC0) as shown in Figure 8-25, and by setting bit 6 (OSPT) of TOC0 by software.

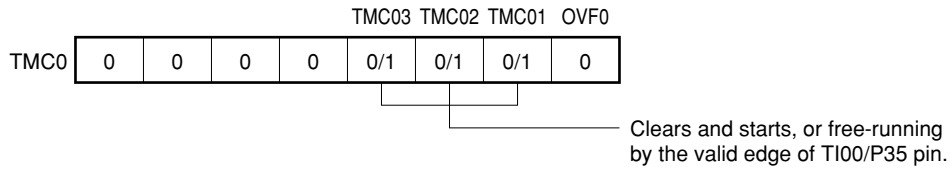
By setting OSPT to 1, the 16-bit timer/event counter is cleared and started, and its output is asserted active at the count value set in advance to 16-bit capture/compare register 01 (CR01). After that, the output is deasserted inactive at the count value set in advance to 16-bit capture/compare register 00 (CR00).

Even after the one-shot pulse has been output, TM0 continues its operation. To stop TM0, TMC0 must be reset to 00H.

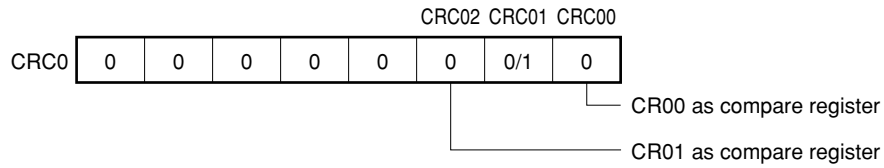
- Cautions**
- 1. Do not set OSPT to 1 while the one-shot pulse is being output. To output the one-shot pulse again, wait until INTTM00, which occurs on a match between TM0 and CR00, occurs.**
 - 2. The software trigger (bit 6 (OSPT) of 16-bit timer output control register 0 (TOC0) = 1) and the external trigger (TI00 input) are always valid in one-shot pulse output mode. If the software trigger is used in one-shot pulse output mode, the TI00 pin cannot be used as a general-purpose port pin. Therefore, fix the P35/TI00 pin to either high level or low level.**

Figure 8-25. Control Register Settings During One-Shot Pulse Output with Software Trigger

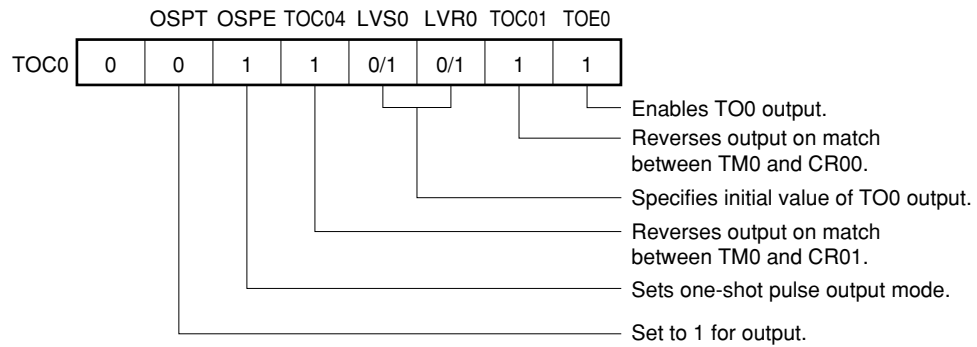
(a) 16-bit timer mode control register (TMC0)



(b) Capture/compare control register 0 (CRC0)



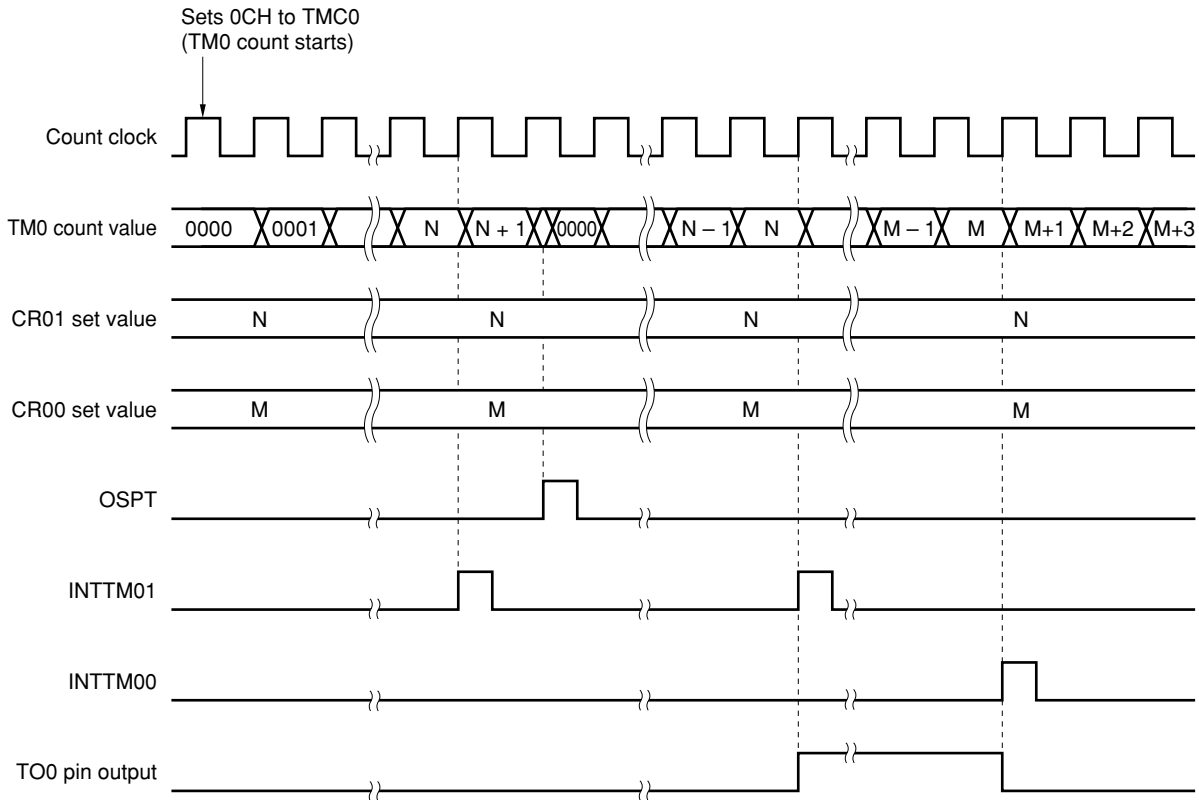
(c) 16-bit timer output control register (TOC0)



Remark 0/1: When these bits are reset to 0 or set to 1, the other functions can be used along with the one-shot pulse output function. For details, refer to **Figures 8-2, 8-3, and 8-4**.

Caution Set a value in the following range to CR00 and CR01.
 $0000H < CR01 < CR00 \leq FFFFH$

Figure 8-26. Timing of One-Shot Pulse Output Operation with Software Trigger



- Cautions**
1. The 16-bit timer register starts operating as soon as a value other than 0, 0 (operation stop mode) has been set to TMC02 and TMC03.
 2. The software trigger (bit 6 (OSPT) of 16-bit timer output control register 0 (TOC0) = 1) and the external trigger (TI00 input) are always valid in one-shot pulse output mode. If the software trigger is used in one-shot pulse output mode, the TI00 pin cannot be used as a general-purpose port pin. Therefore, fix the P35/TI00 pin to either high level or low level.

(2) One-shot pulse output with external trigger

A one-shot pulse can be output from the TO0/P30 pin by setting the 16-bit timer mode control register (TMC0), capture/compare control register 0 (CR00), and 16-bit timer output control register (TOC0) as shown in Figure 8-27, and by using the valid edge of the TI00/P35 pin as an external trigger.

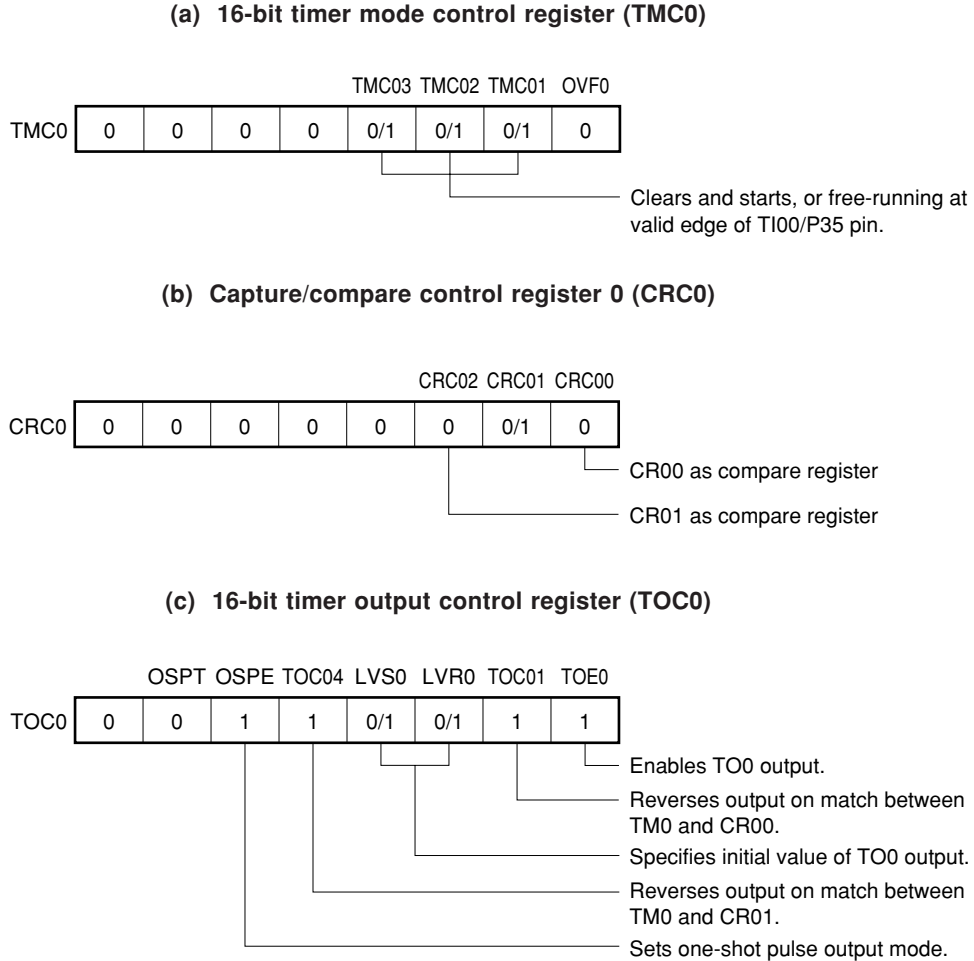
The valid edge of the TI00/P35 pin is specified by bits 4 and 5 (ES00 and ES01) of prescaler mode register 0 (PRM0). The rising, falling, or both the rising and falling edges can be specified.

When the valid edge of the TI00/P35 pin is detected, the 16-bit timer/event counter is cleared and started, and the output is asserted active at the count value set in advance to 16-bit capture/compare register 01 (CR01).

After that, the output is deasserted inactive at the count value set in advance to 16-bit capture/compare register 00 (CR00).

- Cautions**
1. If the external trigger is generated while the one-shot pulse is output, the counter is cleared and started, and the one-shot pulse is output again.
 2. The software trigger (bit 6 (OSPT) of 16-bit timer output control register 0 (TOC0) = 1) and the external trigger (TI00 input) are always valid in one-shot pulse output mode. If the software trigger is used in one-shot pulse output mode, the TI00 pin cannot be used as a general-purpose port pin. Therefore, fix the P35/TI00 pin to either high level or low level.

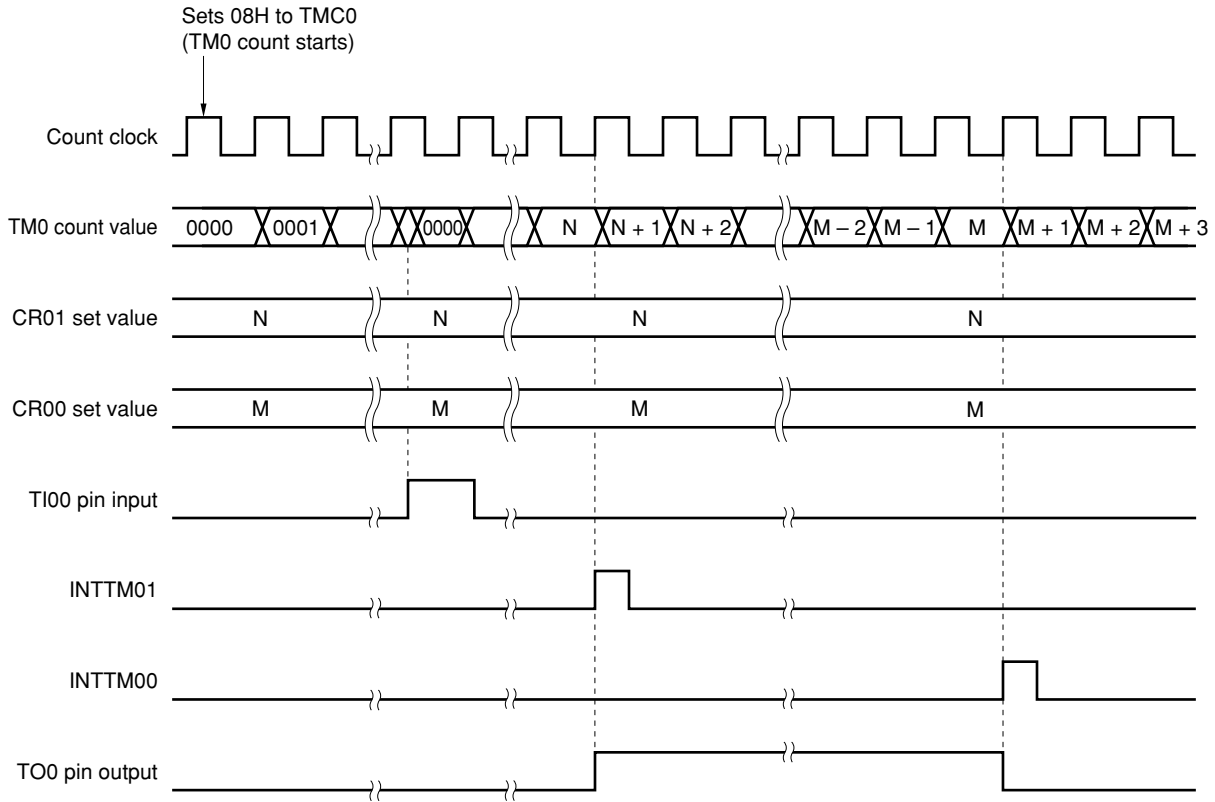
Figure 8-27. Control Register Settings During One-Shot Pulse Output with External Trigger



Remark 0/1: When these bits are reset to 0 or set to 1, the other functions can be used along with the one-shot pulse output function. For details, refer to **Figures 8-2, 8-3, and 8-4**.

Caution Set a value in the following range to CR00 and CR01.
 $0000H < CR01 < CR00 \leq FFFFH$

Figure 8-28. Timing of One-Shot Pulse Output Operation with External Trigger (with Rising Edge Specified)



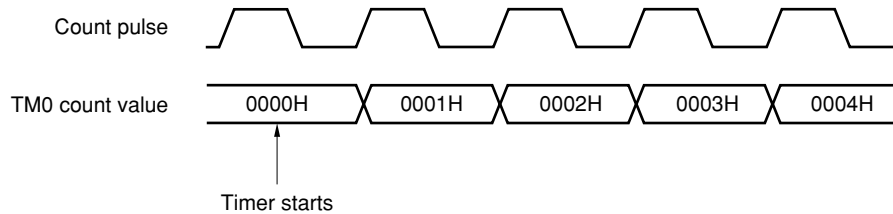
- Cautions**
1. The 16-bit timer register starts operating as soon as a value other than 0, 0 (operation stop mode) has been set to TMC02 and TMC03.
 2. The software trigger (bit 6 (OSPT) of 16-bit timer output control register 0 (TOC0) = 1) and the external trigger (TI00 input) are always valid in one-shot pulse output mode. If the software trigger is used in one-shot pulse output mode, the TI00 pin cannot be used as a general-purpose port pin. Therefore, fix the P35/TI00 pin to either high level or low level.

8.5 Cautions

(1) Error on starting timer

An error of up to 1 clock occurs before the match signal is generated after the timer has been started. This is because the 16-bit timer counter (TM0) is started asynchronously in respect to the count pulse.

Figure 8-29. Start Timing of 16-Bit Timer Register



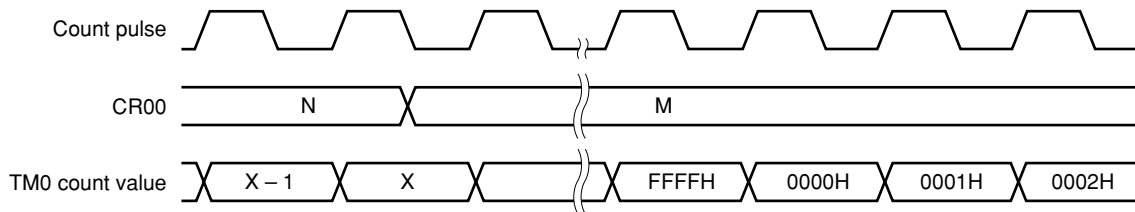
(2) Setting 16-bit compare register

Set 16-bit capture/compare register 00, 01 (CR00, CR01) to a value other than 0000H. When using this register as an event counter, a count for one-pulse cannot be operated.

(3) Setting compare register during timer count operation

If the value to which the current value of 16-bit capture/compare register 00 (CR00) has been changed is less than the value of the 16-bit timer counter (TM0), TM0 continues counting, overflows, and starts counting again from 0. If the new value of CR00 (M) is less than the old value (N), the timer must be restarted after the value of CR00 has been changed.

Figure 8-30. Timing After Changing Value of Compare Register During Timer Count Operation

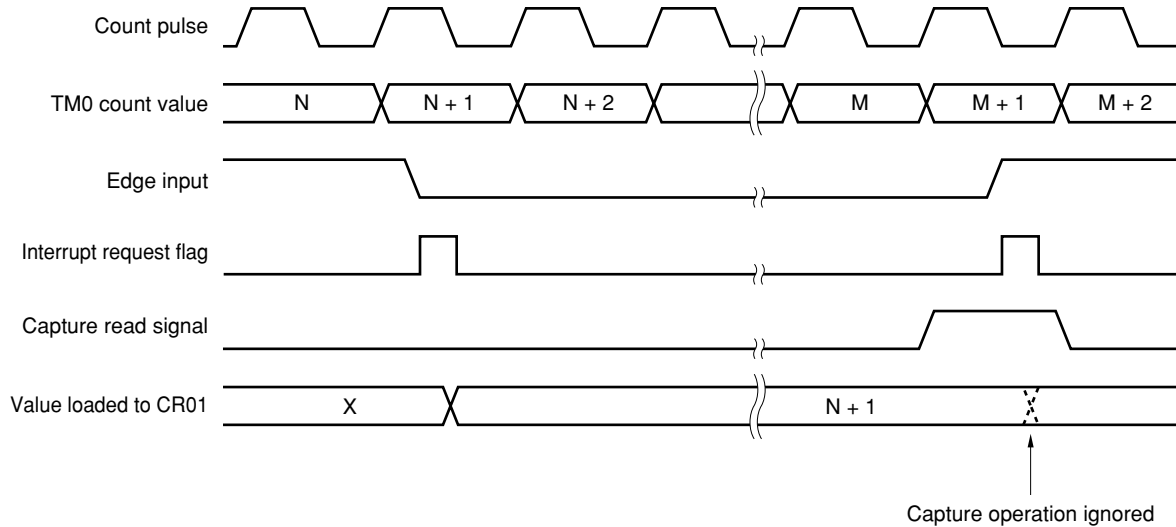


Remark $N > X > M$

(4) Data hold timing of capture register

If the valid edge is input to the TI00/P35 pin while 16-bit capture/compare register 01 (CR01) is read, CR01 does not perform the capture operation, and holds the data. However, the interrupt request flag (INTTM01) is set as a result of detection of the valid edge.

Figure 8-31. Data Hold Timing of Capture Register

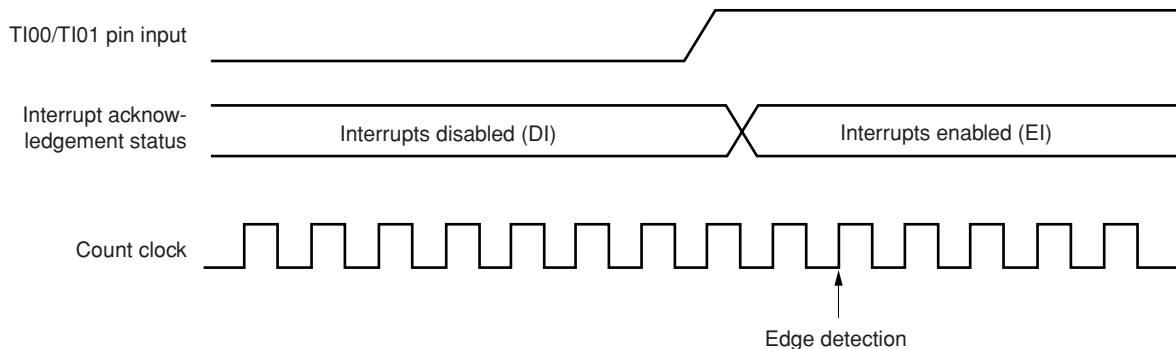


(5) Setting valid edge

Before setting the valid edge of the TI00/P35 pin, stop the timer operation by resetting bits 2 and 3 (TMC02 and TMC03) of the 16-bit timer mode control register (TMC0) to 0, 0. Set the valid edge by using bits 4 and 5 (ES00 and ES01) of prescaler mode register 0 (PRM0).

(6) Cautions on edge detection

- <1> When the TI00/TI01 pin is high level immediately after system reset, it may be detected as a rising edge after the first 16-bit timer/event counter operation is enabled. Bear this in mind when pulling up, etc.
- <2> Regardless of whether interrupt acknowledgement is disabled (DI) or enabled (EI), the edge of the external input signal is detected at the second clock after the signal is changed.



(7) Trigger for one-shot pulse

The software trigger (bit 6 (OSPT) of 16-bit timer output control register 0 (TOC0) = 1) and the external trigger (TI00 input) are always valid in one-shot pulse output mode.

If the software trigger is used in one-shot pulse output mode, the P35/TI00 pin cannot be used as a general-purpose port pin. Therefore, fix the P35/TI00 pin to either high level or low level.

(8) Re-triggering one-shot pulse

(a) One-shot pulse output by software

When a one-shot pulse is output, do not set OSPT to 1. Do not output the one-shot pulse again until INTTM00, which occurs on a match between TM0 and CR00, occurs.

(b) One-shot pulse output with external trigger

If the external trigger occurs while a one-shot pulse is output, the counter is cleared and started, and the one-shot pulse is output again.

(9) Operation of OVF0 flag

The OVF0 flag is set to 1 in the following case:

Select mode in which the 16-bit timer/event counter is cleared and started on a match between TM0 and CR00

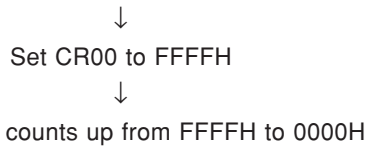
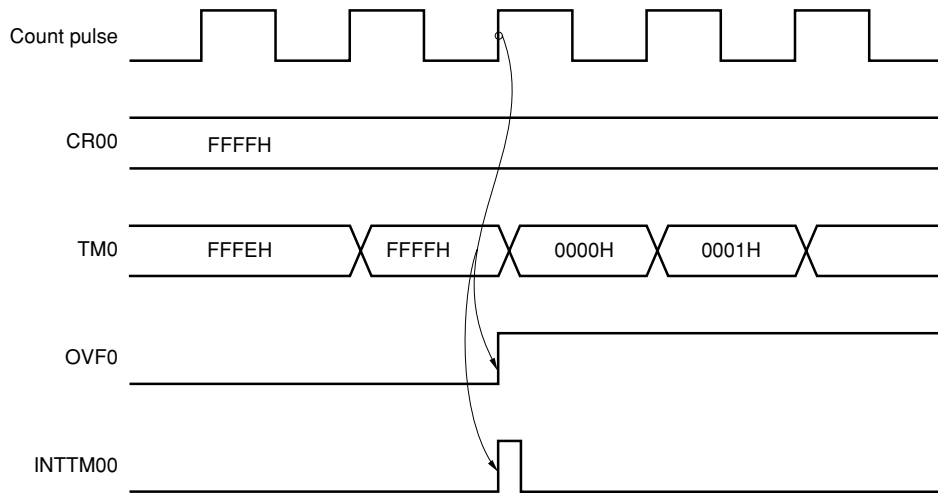


Figure 8-32. Operation Timing of OVF0 Flag



(10) Contention operation

<1> Contention between the read period of 16-bit capture/compare registers (CR00 and CR01) and the capture trigger input (CR00 and CR01 are used as capture registers)

The capture trigger input has priority. The read data of CR00 and CR01 is undefined.

<2> Match timing contention between the write period of 16-bit capture/compare registers (CR00 and CR01) and 16-bit timer counter (TM0) (CR00 and CR01 are used as compare registers)

Match detection is not normally performed. Do not perform the write operation of CR00 and CR01 around the match timing.

CHAPTER 9 8-BIT TIMER/EVENT COUNTER 1, 2

9.1 Functions

8-bit timer/event counter 1, 2 (TM1, TM2) have the following two modes.

- Mode using 8-bit timer/event counter 1, 2 (TM1, TM2) alone (individual mode)
- Mode using the cascade connection (16-bit resolution: cascade connection mode)

These two modes are described next.

(1) Mode using 8-bit timer/event counter 1, 2 alone (individual mode)

The timer operates as an 8-bit timer/event counter.

It can have the following functions.

- Interval timer
- External event counter
- Square wave output
- PWM output

(2) Mode using the cascade connection (16-bit resolution: cascade connection mode)

The timer operates as a 16-bit timer/event counter by connecting in cascade.

It can have the following functions.

- Interval timer with 16-bit resolution
- External event counter with 16-bit resolution
- Square wave output with 16-bit resolution

9.2 Configuration

8-bit timer/event counter 1, 2 consist of the following hardware.

Table 9-1. 8-Bit Timer/Event Counter 1, 2 Configuration

Item	Configuration
Timer counter	8 bits × 2 (TM1, TM2)
Register	8 bits × 2 (CR10, CR20)
Timer output	2 (TO1, TO2)
Control register	8-bit timer mode control register 1 (TMC1) 8-bit timer mode control register 2 (TMC2) Prescaler mode register 1 (PRM1) Prescaler mode register 2 (PRM2)

Figure 9-1. Block Diagram of 8-Bit Timer/Event Counter 1, 2 (1/2)

(1) 8-bit timer/event counter 1

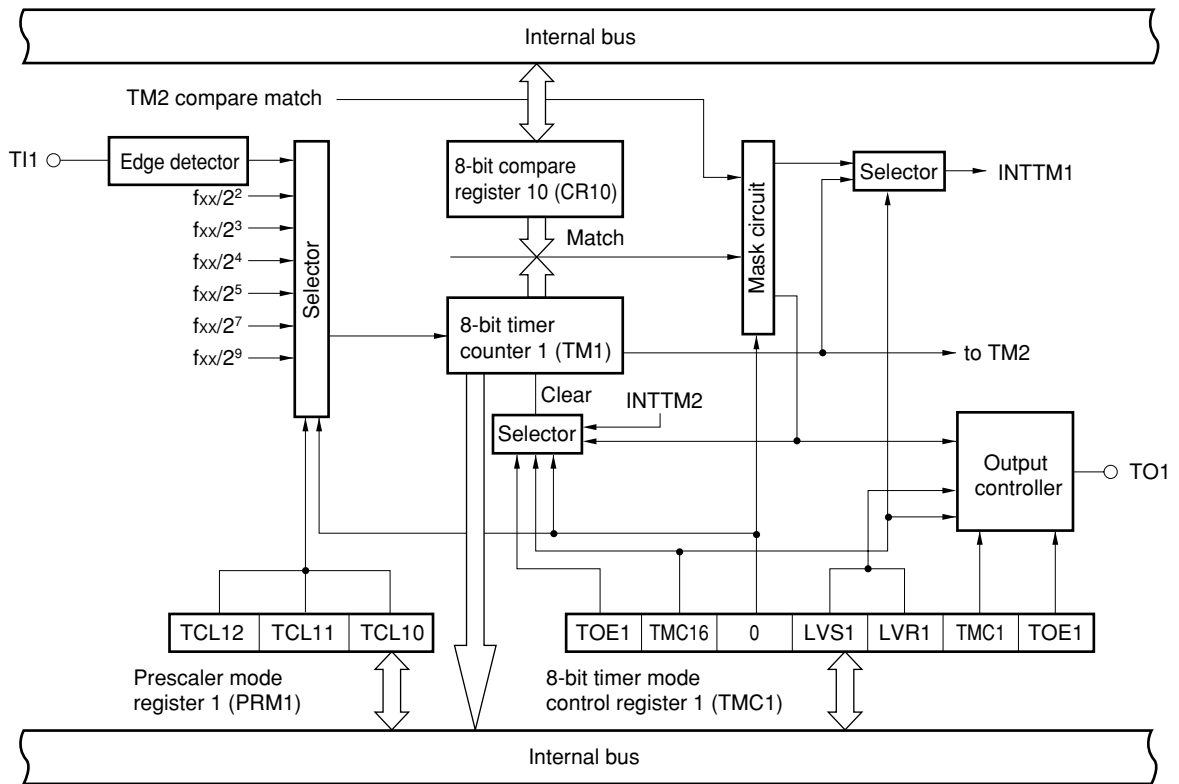
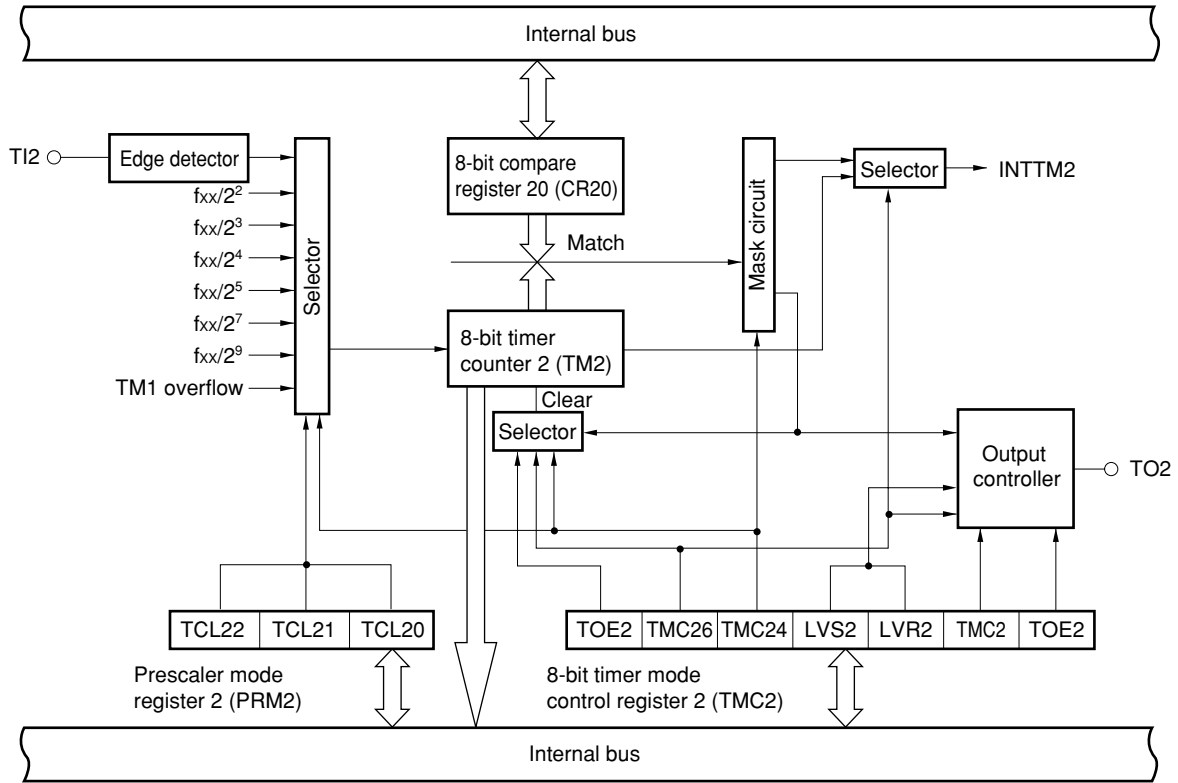


Figure 9-1. Block Diagram of 8-Bit Timer/Event Counter 1, 2 (2/2)

(2) 8-bit timer/event counter 2



(1) 8-bit timer counter 1, 2 (TM1, TM2)

TM1 and TM2 are 8-bit read-only registers that count the count pulses.

The counter is incremented in synchronization with the rising edge of the count clock. When the count is read out during operation, the count clock input temporarily stops and the count is read at that time. In the following cases, the count becomes 00H.

<1> $\overline{\text{RESET}}$ is input.

<2> TCE_n is cleared.

<3> TM_n and CR_{n0} match in the clear and start mode.

Caution In a cascade connection, the count becomes 00H by clearing both bit 7 (TCE1) of 8-bit timer mode control register 1 (TMC1) and bit 7 (TCE2) of 8-bit timer mode control register 2 (TMC2).

Remark n = 1, 2

(2) 8-bit compare register (CR10, CR20)

The value set in CR10 and CR20 are compared to the count in 8-bit timer counter 1 (TM1) and 8-bit timer counter 2 (TM2), respectively. If the two values match, interrupt requests (INTTM1, INTTM2) is generated (except in the PWM mode).

The values of CR10 and CR20 can be set in the range of 00H to FFH, and can be written during counting.

Caution While the timers are connected in cascade, always set data after stopping the timer. To stop timer operation, clear both bit 7 of TMC1 (TCE1) and bit 7 of TMC2 (TCE2).

9.3 Control Registers

The following four registers control 8-bit timer/event counter 1, 2.

- 8-bit timer mode control register 1, 2 (TMC1, TMC2)
- Prescaler mode register 1, 2 (PRM1, PRM2)

(1) 8-bit timer mode control register 1, 2 (TMC1, TMC2)

The TMC1 and TMC2 registers make the following six settings.

- <1> Controls the counting for 8-bit timer counter 1, 2 (TM1, TM2).
- <2> Selects the operating mode of 8-bit timer counter 1, 2 (TM1, TM2).
- <3> Selects the individual mode or cascade mode.
- <4> Sets the state of the timer output.
- <5> Controls the timer output or selects the active level during the PWM (free-running) mode.
- <6> Controls timer output.

TMC1 and TMC2 are set by a 1-bit or 8-bit memory manipulation instruction.

$\overline{\text{RESET}}$ input sets TMC1 and TMC2 to 00H.

Figures 9-2 and 9-3 show the TMC1 format and TMC2 format respectively.

Figure 9-2. Format of 8-Bit Timer Mode Control Register 1 (TMC1)

Address: 0FF54H After reset: 00H R/W

Symbol	<7>	6	5	4	<3>	<2>	1	<0>
TMC1	TCE1	TMC16	0	0	LVS1	LVR1	TMC11	TOE1

TCE1	TM1 count control
0	Counting is disabled (prescaler disabled) after the counter is cleared to 0.
1	Start counting

TMC16	TM1 operating mode selection
0	Clear and start mode when TM1 and CR10 match.
1	PWM (free-running) mode

LVS1	LVR1	Timer output control by software
0	0	No change
0	1	Reset (to 0).
1	0	Set (to 1).
1	1	Setting prohibited

TMC11	Other than PWM mode (TMC16 = 0)	PWM mode (TMC16 = 1)
	Timer output control	Active level selection
0	Disable inversion operation	Active high
1	Enable inversion operation	Active low

TOE1	Timer output control
0	Disable output (port mode)
1	Enable output

Caution When selecting the TM1 operation mode using TMC16, stop the timer operation in advance.

- Remarks**
1. In the PWM mode, the PWM output is set to the inactive level by TCE1 = 0.
 2. If LVS1 and LVR1 are read after setting data, 0 is read.

Figure 9-3. Format of 8-Bit Timer Mode Control Register 2 (TMC2)

Address: 0FF55H After reset: 00H R/W

Symbol	<7>	6	5	4	<3>	<2>	1	<0>
TMC2	TCE2	TMC26	0	TMC24	LVS2	LVR2	TMC21	TOE2

TCE2	TM2 count control
0	Counting is disabled (prescaler disabled) after the counter is cleared to 0.
1	Start counting

TMC26	TM2 operating mode selection
0	Clear and start mode when TM2 and CR20 match
1	PWM (free-running) mode

TMC24	Individual mode or cascade connection mode selection
0	Individual mode
1	Cascade connection mode (connection with TM1)

LVS2	LVR2	Timer output control by software
0	0	No change
0	1	Reset (to 0).
1	0	Set (to 1).
1	1	Setting prohibited

TMC21	Other than PWM mode (TMC26 = 0)	PWM mode (TMC26 = 1)
	Timer output control	Active level selection
0	Disable inversion operation	Active high
1	Enable inversion operation	Active low

TOE2	Timer output control
0	Disable output (port mode)
1	Enable output

Caution When selecting the TM2 operation mode using TMC26 or selecting discrete/cascade connection mode using TMC24, stop timer operation in advance. To stop the timer operation during cascade connection, clear both bit 7 (TCE1) of 8-bit timer mode control register 1 (TMC1) and bit 7 (TCE2) of TMC2.

Remarks 1. In the PWM mode, the PWM output is set to the inactive level by TCE2 = 0.
 2. If LVS2 and LVR2 are read after setting data, 0 is read.

(2) Prescaler mode register 1, 2 (PRM1, PRM2)

This register sets the count clock of 8-bit timer counter 1, 2 (TM1, TM2) and the valid edge of TI1, TI2 inputs.

PRM1 and PRM2 are set by a 1-bit or 8-bit memory manipulation instruction.

RESET input sets PRM1 and PRM2 to 00H.

Figure 9-4. Format of Prescaler Mode Register 1 (PRM1)

Address: 0FF56H After reset: 00H R/W

Symbol	7	6	5	4	3	2	1	0
PRM1	0	0	0	0	0	TCL12	TCL11	TCL10

TCL12	TCL11	TCL10	Count clock selection
0	0	0	Falling edge of TI1
0	0	1	Rising edge of TI1
0	1	0	$f_{xx}/4$ (3.13 MHz)
0	1	1	$f_{xx}/8$ (1.56 MHz)
1	0	0	$f_{xx}/16$ (781 kHz)
1	0	1	$f_{xx}/32$ (391 kHz)
1	1	0	$f_{xx}/128$ (97.6 kHz)
1	1	1	$f_{xx}/512$ (24.4 kHz)

- Cautions**
1. If writing data different than that of PRM1, stop the timer beforehand.
 2. Be sure to set bits 3 to 7 of PRM1 to 0.
 3. When specifying the valid edge of TI1 for the count clock, set the count clock to $f_{xx}/4$ or below.

Remark Figures in parentheses apply to operation with $f_{xx} = 12.5$ MHz.

Figure 9-5. Format of Prescaler Mode Register 2 (PRM2)

Address: 0FF57H After reset: 00H R/W

Symbol	7	6	5	4	3	2	1	0
PRM2	0	0	0	0	0	TCL22	TCL21	TCL20

TCL22	TCL21	TCL20	Count clock selection
0	0	0	Falling edge of TI2
0	0	1	Rising edge of TI2
0	1	0	$f_{xx}/4$ (3.13 MHz)
0	1	1	$f_{xx}/8$ (1.56 MHz)
1	0	0	$f_{xx}/16$ (781 kHz)
1	0	1	$f_{xx}/32$ (391 kHz)
1	1	0	$f_{xx}/128$ (97.6 kHz)
1	1	1	$f_{xx}/512$ (24.4 kHz)

- Cautions**
1. If writing data different than that of PRM2, stop the timer beforehand.
 2. Be sure to set bits 3 to 7 of PRM2 to 0.
 3. When specifying the valid edge of TI2 for the count clock, set the count clock to $f_{xx}/4$ or below.

Remark Figures in parentheses apply to operation with $f_{xx} = 12.5$ MHz.

9.4 Operation

9.4.1 Operation as interval timer (8-bit operation)

The timer operates as an interval timer that repeatedly generates interrupt requests at the interval of the preset count in 8-bit compare register 10, 20 (CR10, CR20).

If the count in 8-bit timer register 1, 2 (TM1, TM2) matches the value set in CR10, CR20, simultaneous to clearing the value of TM1, TM2 to 0 and continuing the count, the interrupt request signal (INTTM1, INTTM2) is generated.

The TM1 and TM2 count clocks can be selected with bits 0 to 2 (TCLn0 to TCLn2) in prescaler mode register 1, 2 (PRM1, PRM2).

<Setting method>

<1> Set each register.

- PRMn: Selects the count clock.
- CRn0: Compare value
- TMCn: Selects the clear and start mode when TMn and CRn0 match.
(TMCn = 0000×××0B, × is don't care)

<2> When TCEn = 1 is set, counting starts.

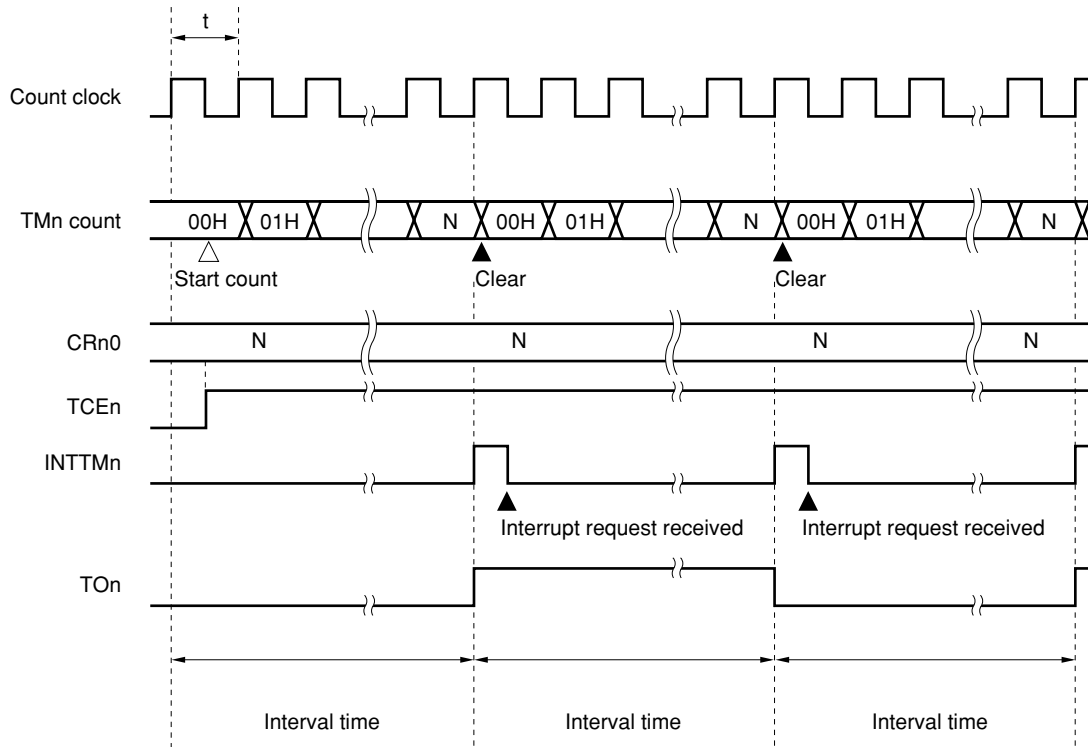
<3> When the values of TMn and CRn0 match, INTTMn is generated (TMn is cleared to 00H).

<4> Then, INTTMn is repeatedly generated during the same interval. When counting stops, set TCEn = 0.

Remark n = 1, 2

Figure 9-6. Timing of Interval Timer Operation (1/3)

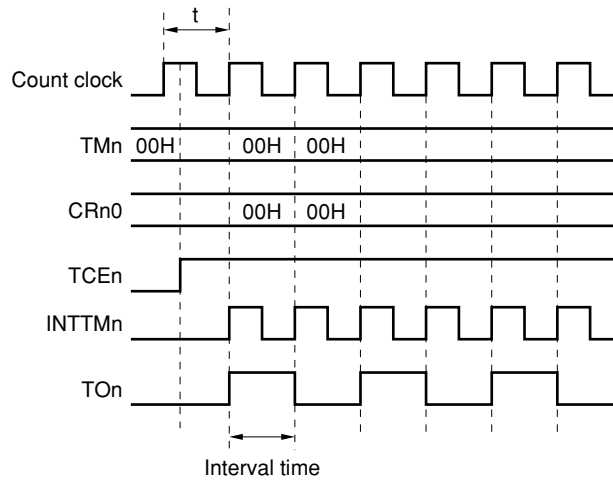
(a) Basic operation



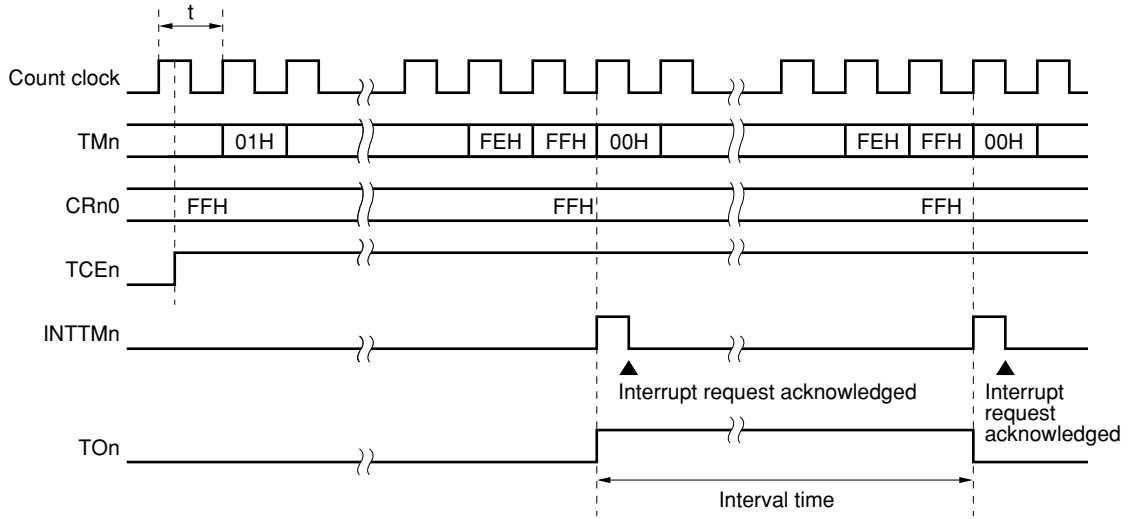
- Remarks**
1. Interval time = $(N + 1) \times t$: $N = 00H$ to FFH
 2. $n = 1, 2$

Figure 9-6. Timing of Interval Timer Operation (2/3)

(b) When CRn0 = 00H



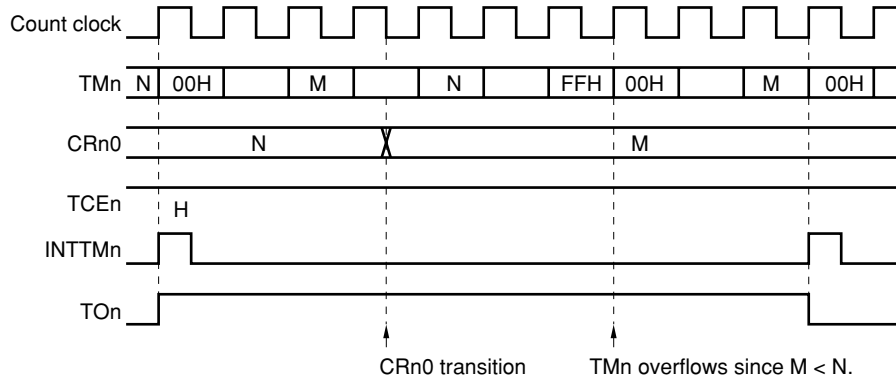
(c) When CRn0 = FFH



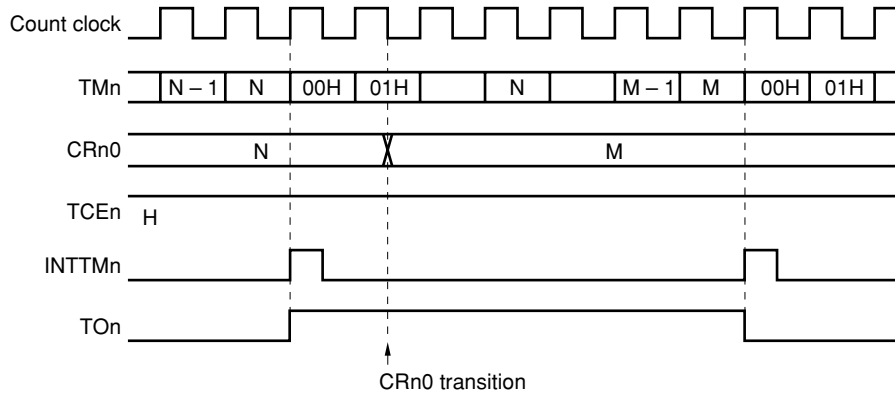
Remark n = 1, 2

Figure 9-6. Timing of Interval Timer Operation (3/3)

(d) Operated by CRn0 transition ($M < N$)



(e) Operated by CRn0 transition ($M > N$)



Remark n = 1, 2

9.4.2 Operation as external event counter

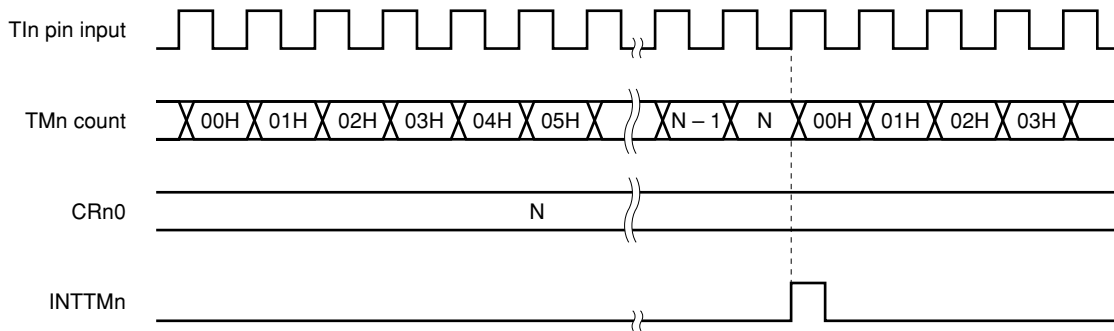
The external event counter counts the number of external clock pulses that are input to the TI1/P33 and TI2/P34 pins with 8-bit timer counter 1, 2 (TM1, TM2).

Each time a valid edge specified in prescaler mode register 1, 2 (PRM1, PRM2) is input, TM1 and TM2 are incremented. The edge setting is selected to be either a rising edge or falling edge.

If the counting of TM1 and TM2 matches with the values of 8-bit compare register 10, 20 (CR10, CR20), the TM1 and TM2 are cleared to 0 and the interrupt request signal (INTTM1, INTTM2) is generated.

INTTM1 and INTTM2 are generated each time when the value of the TM1 and TM2 matches the value of CR10 and CR20.

Figure 9-7. Timing of External Event Counter Operation (with Rising Edge Specified)



Remark N = 00H to FFH
n = 1, 2

9.4.3 Operation as square wave output (8-bit resolution)

A square wave having any frequency is output at the interval preset in 8-bit compare register 10, 20 (CR10, CR20).

By setting bit 0 (TOE1, TOE2) of 8-bit timer mode control register 1, 2 (TMC1, TMC2) to 1, the output state of TO1, TO2 is inverted with the count preset in CR10, CR20 as the interval. Therefore, a square wave output having any frequency (duty cycle = 50 %) is possible.

<Setting method>

<1> Set the registers.

- Set the port latch, which also functions as a timer output pin and the port mode register, to 0.
- PRMn: Select the count clock.
- CRn0: Compare value
- TMCn: Clear and start mode when TMn and CRn0 match.

LVS _n	LVR _n	Timer Output Control by Software
1	0	High level output
0	1	Low level output

Inversion of timer output enabled

Timer output enabled → TOEn = 1

<2> When TCEn = 1 is set, the counter starts operating.

<3> If the values of TMn and CRn0 match, the timer output inverts. Also, INTTMn is generated and TMn is cleared to 00H.

<4> Then, the timer output is inverted for the same interval to output a square wave from TOn.

Remark n = 1, 2

9.4.4 Operation as 8-bit PWM output

By setting bit 6 (TMC16, TMC26) of 8-bit timer mode control register 1, 2 (TMC1, TMC2) to 1, the timer operates as a PWM output.

Pulses with the duty cycle determined by the value set in 8-bit compare register 10, 20 (CR10, CR20) is output from TO1, TO2.

Set the width of the active level of the PWM pulse in CR10, CR20. The active level can be selected by bit 1 (TMC11, TMC12) in TMC1, TMC2.

The count clock can be selected by bits 0 to 2 (TCLn0 to TCLn2) of prescaler mode register 1, 2 (PRM1, PRM2).

The PWM output can be enabled and disabled by bit 0 (TOE1, TOE2) of TMC1, TMC2.

(1) Basic operation of the PWM output

<Setting method>

- <1> Set the port latch, which also functions as a timer output pin and the port mode register, to 0.
- <2> Set the active level width in 8-bit compare register (CRn0).
- <3> Select the count clock in prescaler mode register n (PRMn).
- <4> Set the active level in bit 1 (TMCn1) of TMCn.
- <5> Set bit 0 of TMCn (TOEn) to 1 to enable timer output.
- <6> If bit 7 (TCEn) of TMCn is set to 1, counting starts. When counting stops, set TCEn to 0.

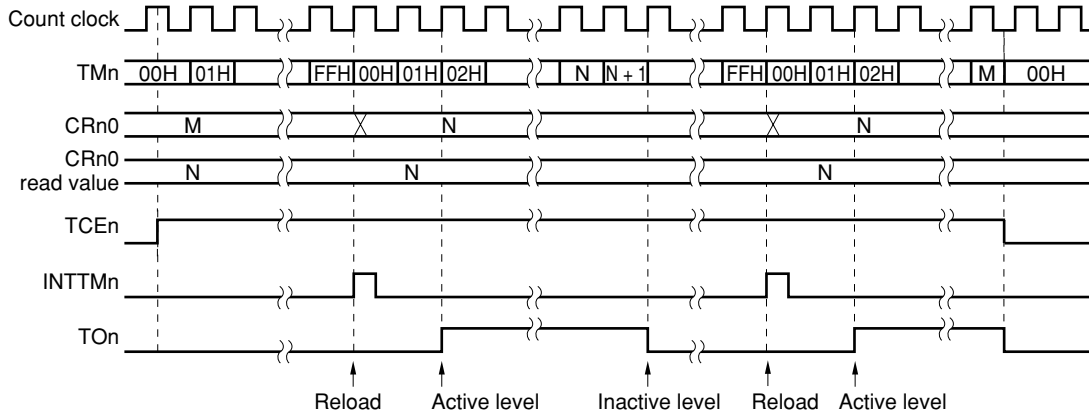
<PWM output operation>

- <1> When counting starts, the PWM output (output from TOn) outputs the inactive level until an overflow occurs.
- <2> When the overflow occurs, the active level is output. The active level is output until CRn0 and the count of 8-bit timer counter n (TMn) match.
- <3> The PWM output after CRn and the count match is the inactive level until an overflow occurs again.
- <4> Steps <2> and <3> repeat until counting stops.
- <5> If counting is stopped by TCEn = 0, the PWM output goes to the inactive level.

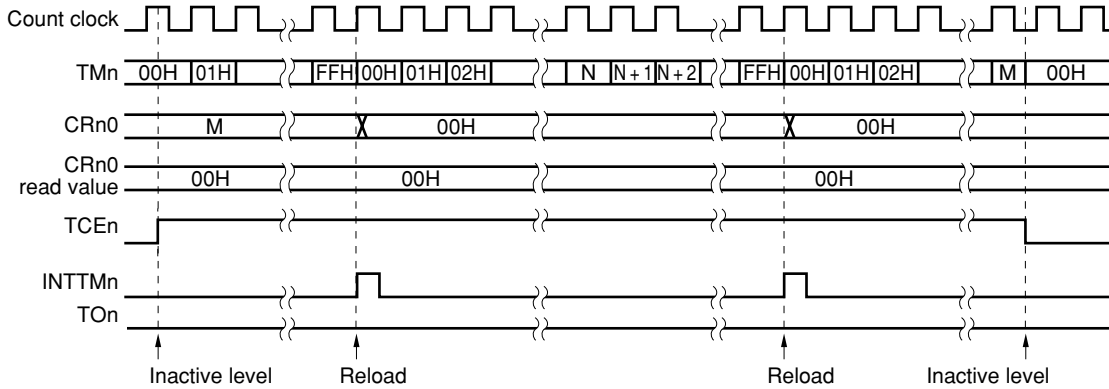
Remark n = 1, 2

Figure 9-8. Timing of PWM Output

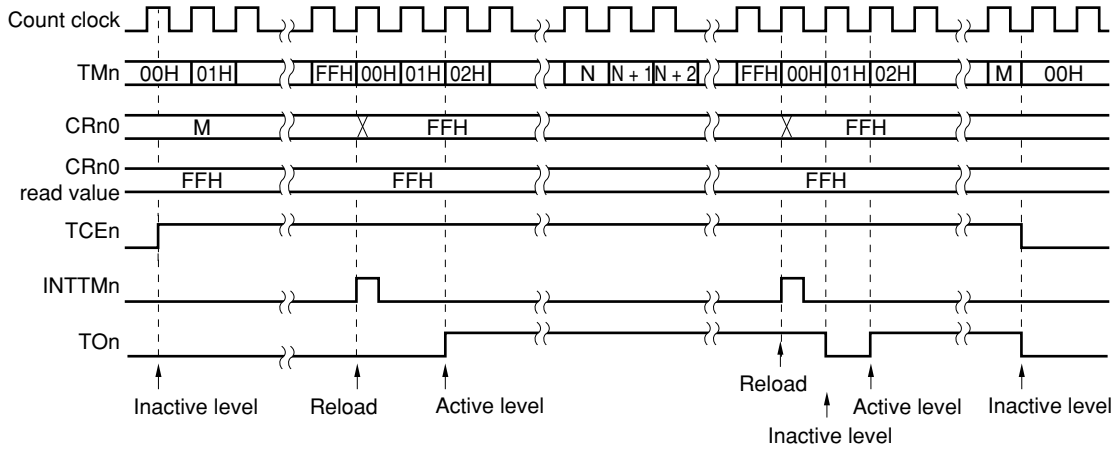
(a) Basic operation (active level = H)



(b) When CRn0 = 0



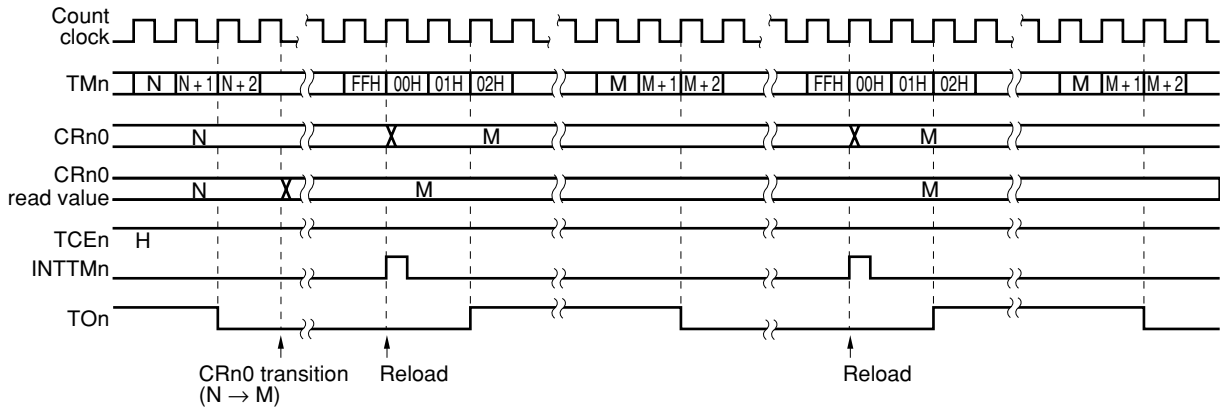
(c) When CRn0 = FFH



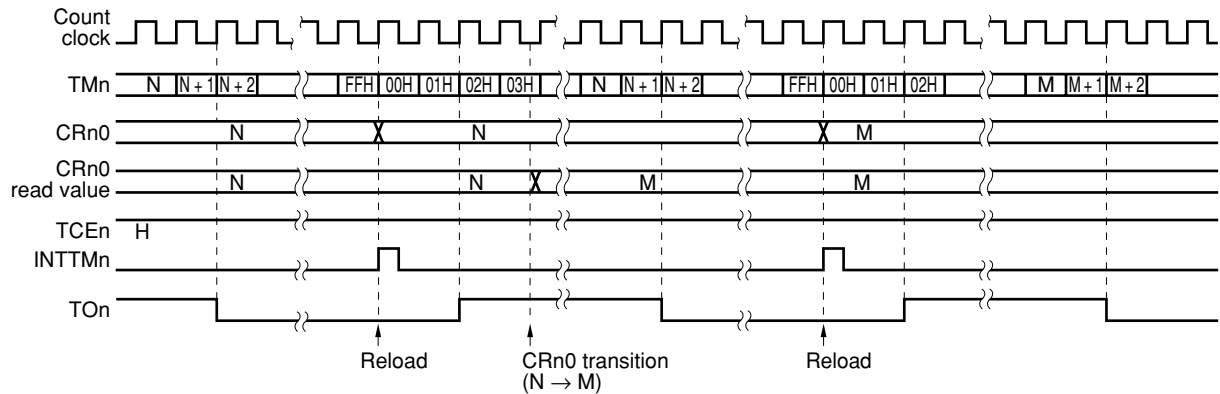
Remark n = 1, 2

Figure 9-9. Timing of Operation Based on CRn0 Transitions

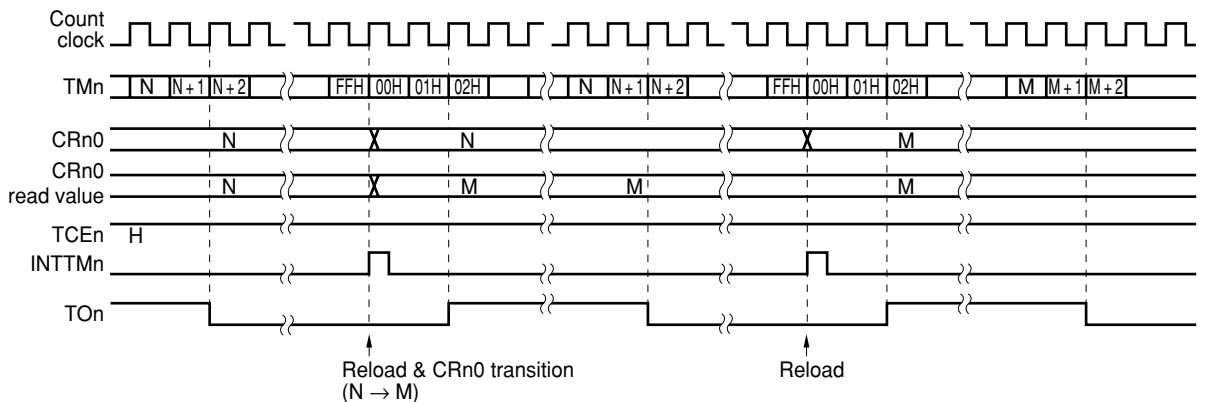
(a) When the CRn0 value from N to M before TMn overflows



(b) When the CRn0 value changes from N to M after TMn overflows



(c) When the CRn0 value changes from N to M during two clocks (00H, 01H) immediately after TMn overflows



Remarks 1. n = 1, 2

2. CRn0 (M): Master side, CRn0 (S): Slave side

9.4.5 Operation as interval timer (16-bit operation)

- **Cascade connection (16-bit timer) mode**

By setting bit 4 (TMC24) of 8-bit timer mode control register 2 (TMC2) to 1, the timer enters the timer/counter mode with 16-bit resolution.

With the count preset in 8-bit compare register 10, 20 (CR10, CR20) as the interval, the timer operates as an interval timer by repeatedly generating interrupt requests.

<Setting method>

<1> Set each register.

- PRM1: TM1 selects the count clock. TM2 connected in cascade are not used in setting.
- CRn0: Compare values (each compare value can be set from 00H to FFH).
- TMCn: Select the clear and start mode when TMn and CRn0 match.

$$\left. \begin{array}{l} \text{TM1} \rightarrow \text{TMC1} = 0000xxx0B, x: \text{don't care} \\ \text{TM2} \rightarrow \text{TMC2} = 0001xxx0B, x: \text{don't care} \end{array} \right\}$$

<2> Setting TCE2 = 1 for TMC2 and finally setting TCE1 = 1 in TMC1 starts the count operation.

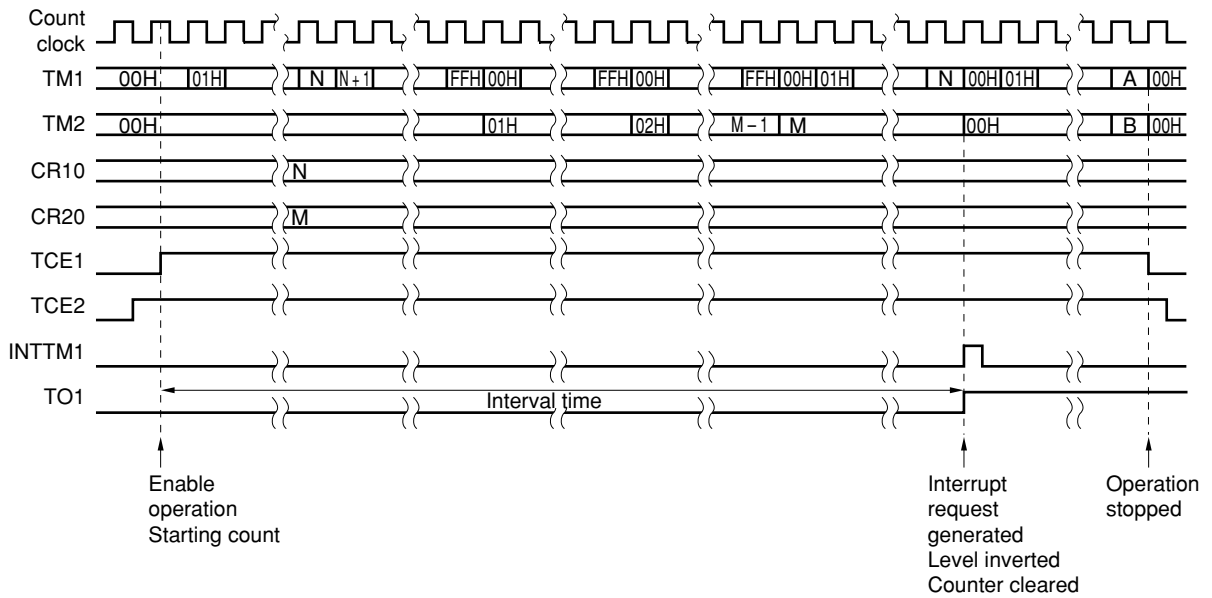
<3> If the values of TMn of all timers connected in cascade and CRn0 match, the INTTM1 of TM1 is generated. (TM1 and TM2 are cleared to 00H.)

<4> INTTM1 are repeatedly generated at the same interval.

- Cautions**
1. Always set the compare register (CR10, CR20) after stopping timer operation.
 2. If TM2 count matches CR20 even when used in a cascade connection, INTTM2 of TM2 is generated. Always mask TM2 in order to disable interrupts.
 3. The TCE1, TCE2 setting begins at TM2. Set the TM1 last.
 4. Restarting and stopping the count is possible by setting 1 or 0 only in TCE1 of TMC1. Note, however, that bit 7 (TCE1) of TMC1 and bit 7 (TCE2) of TMC2 must be cleared when setting the compare register (CR10, CR20).

Figure 9-10 shows a timing example of the cascade connection mode with 16-bit resolution.

Figure 9-10. Cascade Connection Mode with 16-Bit Resolution

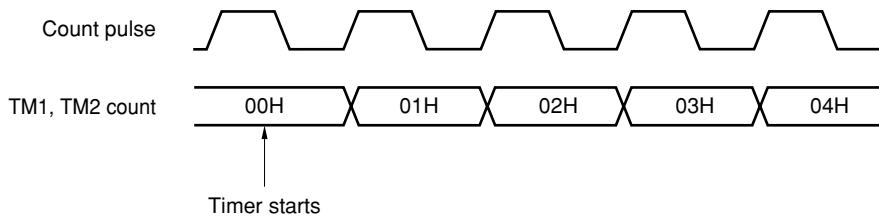


9.5. Cautions

(1) Error when the timer starts

The time until the match signal is generated after the timer starts has a maximum error of one clock. The reason is the starting of 8-bit timer counter 1, 2 (TM1, TM2) is asynchronous with respect to the count pulse.

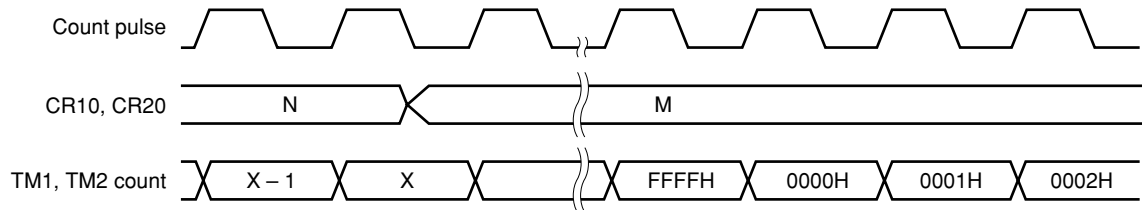
Figure 9-11. Start Timing of 8-Bit Timer Counter



(2) Operation after the compare register is changed while the timer is counting

If the value after 8-bit compare register 10, 20 (CR10, CR20) changes is less than the value of the 8-bit timer counter (TM1, TM2), counting continues, overflows, and counting starts again from 0. Consequently, when the value (M) after CR10, CR20 changes is less than the value (N) before the change, the timer must restart after CR10, CR20 changes.

Figure 9-12. Timing After Compare Register Changes During Timer Counting



Caution Except when the TI1, TI2 input is selected, always set TCE1 = 0, TCE2 = 0 before setting the STOP mode.

Remark $N > X > M$

(3) TM1, TM2 read out during timer operation

Since the count clock stops temporarily when TM1 and TM2 are read during operation, select for the count clock a waveform with a high and low level that exceed 2 cycles of the CPU clock.

When reading TM1 and TM2 during cascade connection, to avoid reading while the count is changing, take measures such as obtaining a count match by reading twice using software.

10.1 Functions

8-bit timer/event counter 5, 6 (TM5, TM6) have the following two modes.

- Mode using 8-bit timer/event counter 5, 6 (TM5, TM6) alone (individual mode)
- Mode using the cascade connection (16-bit resolution: cascade connection mode)

These two modes are described next.

(1) Mode using 8-bit timer/event counter 5, 6 alone (individual mode)

The timer operates as an 8-bit timer/event counter.

It can have the following functions.

- Interval timer
- External event counter
- Square wave output
- PWM output

(2) Mode using the cascade connection (16-bit resolution: cascade connection mode)

The timer operates as a 16-bit timer/event counter by connecting in cascade.

It can have the following functions.

- Interval timer with 16-bit resolution
- External event counter with 16-bit resolution
- Square wave output with 16-bit resolution

10.2 Configuration

8-bit timer/event counter 5, 6 consist of the following hardware.

Table 10-1. 8-Bit Timer/Event Counter 5, 6 Configuration

Item	Configuration
Timer counter	8 bits × 2 (TM5, TM6)
Register	8 bits × 2 (CR50, CR60)
Timer outputs	2 (TO5, TO6)
Control registers	8-bit timer mode control register 5 (TMC5) 8-bit timer mode control register 6 (TMC6) Prescaler mode register 5 (PRM5) Prescaler mode register 6 (PRM6)

Figure 10-1. Block Diagram of 8-Bit Timer/Event Counter 5, 6 (1/2)

(1) 8-bit timer/event counter 5

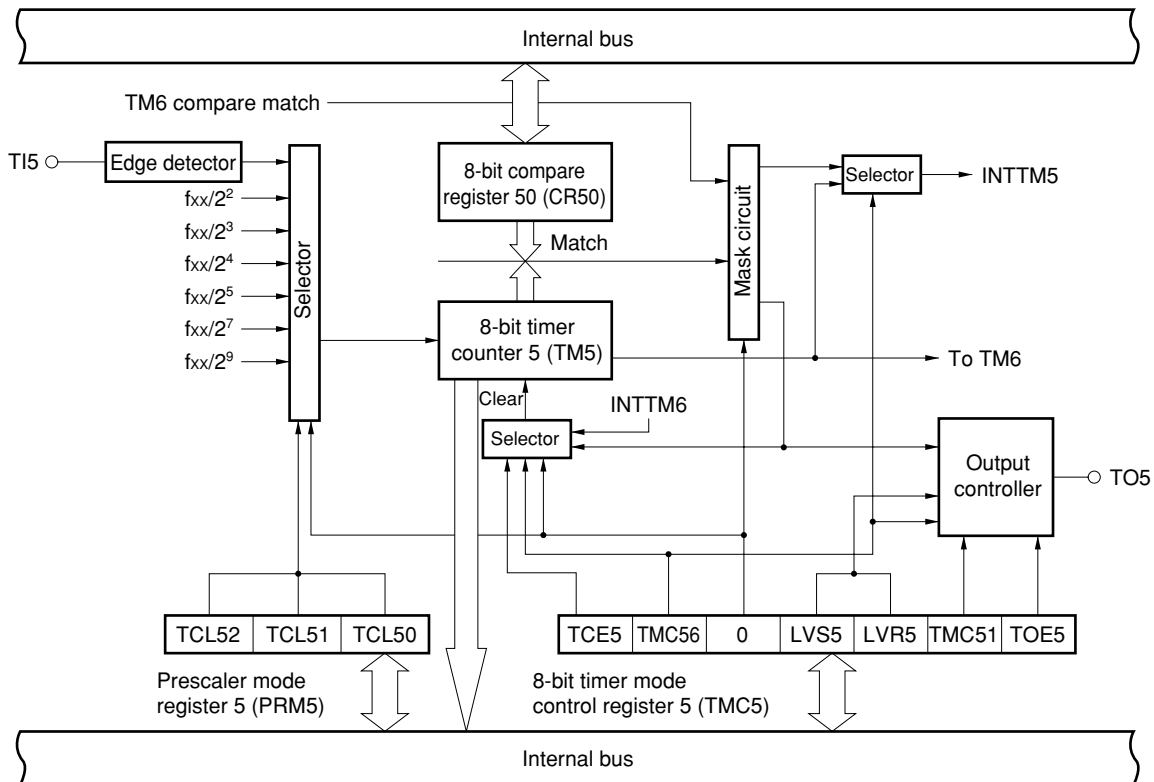
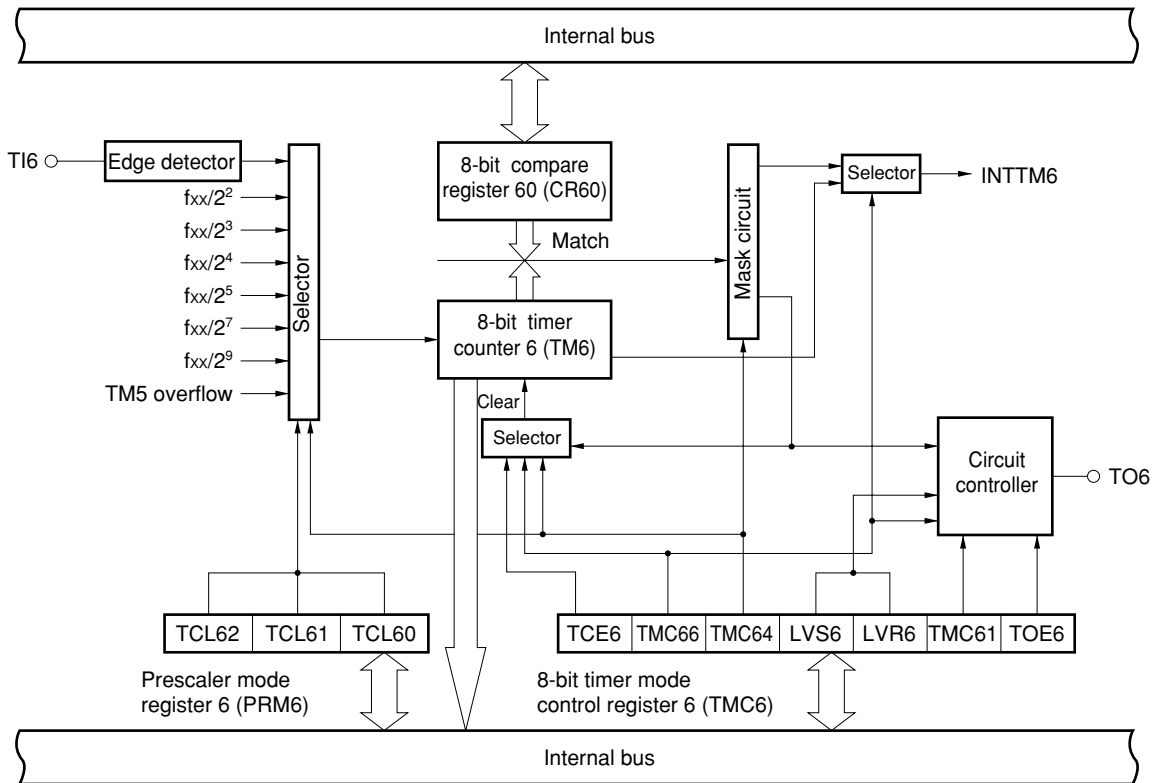


Figure 10-1. Block Diagram of 8-Bit Timer/Event Counter 5, 6 (2/2)

(2) 8-bit timer/event counter 6



(1) 8-bit timer counter 5, 6 (TM5, TM6)

TM5 and TM6 are 8-bit read-only registers that count the count pulses.

The counter is incremented in synchronization with the rising edge of the count clock. When the count is read out during operation, the count clock input temporarily stops and the count is read at that time. In the following cases, the count becomes 00H.

<1> $\overline{\text{RESET}}$ is input.

<2> TCE_n is cleared.

<3> TM_n and CR_{n0} match in the clear and start mode.

Caution In a cascade connection, the count becomes 00H by clearing bit 7 (TCE5) of 8-bit timer mode control register 5 (TMC5) and bit 7 (TCE6) of 8-bit timer mode control register 6 (TMC6).

Remark n = 5, 6

(2) 8-bit compare register (CR50, CR60)

The value set in CR50 and CR60 are compared to the count in 8-bit timer counter 5 (TM5) and 8-bit timer counter 6 (TM6), respectively. If the two values match, interrupt requests (INTTM5, INTTM6) is generated (except in the PWM mode).

The values of CR50 and CR60 can be set in the range of 00H to FFH, and can be written during counting.

Caution Be sure to stop the timer operation before setting data in cascade connection mode. To stop the timer operation, clear both bit 7 (TCE5) of TMC5 and bit 7 (TCE6) of TMC6.

10.3 Control Registers

The following four registers control 8-bit timer/event counter 5, 6.

- 8-bit timer mode control register 5, 6 (TMC5, TMC6)
- Prescaler mode register 5, 6 (PRM5, PRM6)

(1) 8-bit timer mode control register 5, 6 (TMC5, TMC6)

The TMC5 and TMC6 registers make the following six settings.

- <1> Controls the counting for 8-bit timer counter 5, 6 (TM5, TM6).
- <2> Selects the operating mode of 8-bit timer counter 5, 6 (TM5, TM6).
- <3> Selects the individual mode or cascade mode.
- <4> Sets the state of the timer output.
- <5> Controls the timer output or selects the active level during the PWM (free-running) mode.
- <6> Controls timer output.

TMC5 and TMC6 are set by a 1-bit or 8-bit memory manipulation instruction.

$\overline{\text{RESET}}$ input sets TMC5 and TMC6 to 00H.

Figures 10-2 and 10-3 show the TMC5 format and TMC6 format respectively.

Figure 10-2. Format of 8-Bit Timer Mode Control Register 5 (TMC5)

Address: 0FF68H After reset: 00H R/W

Symbol	<7>	6	5	4	<3>	<2>	1	<0>
TMC5	TCE5	TMC56	0	0	LVS5	LVR5	TMC51	TOE5

TCE5	TM5 count control
0	Counting is disabled (prescaler disabled) after the counter is cleared to 0.
1	Start counting

TMC56	TM5 operating mode selection
0	Clear and start mode when TM5 and CR50 match.
1	PWM (free-running) mode

LVS5	LVR5	Timer output control by software
0	0	No change
0	1	Reset (to 0).
1	0	Set (to 1).
1	1	Setting prohibited

TMC51	Other than PWM mode (TMC56 = 0)	PWM mode (TMC56 = 1)
	Timer output control	Active level selection
0	Disable inversion operation	Active high
1	Enable inversion operation	Active low

TOE5	Timer output control
0	Disable output (port mode)
1	Enable output

Caution When selecting the TM5 operation mode using TMC56, stop the timer operation in advance.

- Remarks**
1. In the PWM mode, the PWM output is set to the inactive level by TCE5 = 0.
 2. If LVS5 and LVR5 are read after setting data, 0 is read.

Figure 10-3. Format of 8-Bit Timer Mode Control Register 6 (TMC6)

Address: 0FF69H After reset: 00H R/W

Symbol	<7>	6	5	4	<3>	<2>	1	<0>
TMC6	TCE6	TMC66	0	TMC64	LVS6	LVR6	TMC61	TOE6

TCE6	TM6 count control
0	Counting is disabled (prescaler disabled) after the counter is cleared to 0.
1	Start counting

TMC66	TM6 operating mode selection
0	Clear and start mode when TM6 and CR60 match
1	PWM (free-running) mode

TMC64	Individual mode or cascade connection mode selection
0	Individual mode
1	Cascade connection mode (connection with TM5)

LVS6	LVR6	Timer output control by software
0	0	No change
0	1	Reset (to 0).
1	0	Set (to 1).
1	1	Setting prohibited

TMC61	Other than PWM mode (TMC66 = 0)	PWM mode (TMC66 = 1)
	Timer output control	Active level selection
0	Disable inversion operation	Active high
1	Enable inversion operation	Active low

TOE6	Timer output control
0	Disable output (port mode)
1	Enable output

Caution When selecting the TM6 operation mode using TMC66 or selecting discrete/cascade connection mode using TMC64, stop the timer operation in advance. To stop the timer operation during cascade connection, clear both bit 7 (TCE5) of 8-bit timer mode control register 5 (TMC5) and bit 7 (TCE6) of TMC6.

Remarks 1. In the PWM mode, the PWM output is set to the inactive level by TCE6 = 0.
 2. If LVS6 and LVR6 are read after setting data, 0 is read.

(2) Prescaler mode register 5, 6 (PRM5, PRM6)

This register sets the count clock of 8-bit timer counter 5, 6 (TM5, TM6) and the valid edge of TI5, TI6 inputs.

PRM5 and PRM6 are set by a 1-bit or 8-bit memory manipulation instruction.

RESET input sets PRM5 and PRM6 to 00H.

Figure 10-4. Format of Prescaler Mode Register 5 (PRM5)

Address: 0FF6CH After reset: 00H R/W

Symbol	7	6	5	4	3	2	1	0
PRM5	0	0	0	0	0	TCL52	TCL51	TCL50

TCL52	TCL51	TCL50	Count clock selection
0	0	0	Falling edge of TI5
0	0	1	Rising edge of TI5
0	1	0	f _{xx} /4 (3.13 MHz)
0	1	1	f _{xx} /8 (1.56 MHz)
1	0	0	f _{xx} /16 (781 kHz)
1	0	1	f _{xx} /32 (391 kHz)
1	1	0	f _{xx} /128 (97.6 kHz)
1	1	1	f _{xx} /512 (24.4 kHz)

- Cautions**
1. If writing data different than that of PRM5, stop the timer beforehand.
 2. Be sure to set bits 3 to 7 of PRM5 to 0.
 3. When specifying the valid edge of TI5 for the count clock, set the count clock to f_{xx}/4 or below.

Remark Figures in parentheses apply to operation with f_{xx} = 12.5 MHz.

Figure 10-5. Format of Prescaler Mode Register 6 (PRM6)

Address: 0FF6DH After reset: 00H R/W

Symbol	7	6	5	4	3	2	1	0
PRM6	0	0	0	0	0	TCL62	TCL61	TCL60

TCL62	TCL61	TCL60	Count clock selection
0	0	0	Falling edge of TI6
0	0	1	Rising edge of TI6
0	1	0	$f_{xx}/4$ (3.13 MHz)
0	1	1	$f_{xx}/8$ (1.56 MHz)
1	0	0	$f_{xx}/16$ (781 kHz)
1	0	1	$f_{xx}/32$ (391 kHz)
1	1	0	$f_{xx}/128$ (97.6 kHz)
1	1	1	$f_{xx}/512$ (24.4 kHz)

- Cautions**
1. If writing data different than that of PRM6, stop the timer beforehand.
 2. Be sure to set bits 3 to 7 of PRM6 to 0.
 3. When specifying the valid edge of TI6 for the count clock, set the count clock to $f_{xx}/4$ or below.

Remark Figures in parentheses apply to operation with $f_{xx} = 12.5$ MHz.

10.4 Operation

10.4.1 Operation as interval timer (8-bit operation)

The timer operates as an interval timer that repeatedly generates interrupt requests at the interval of the preset count in 8-bit compare register 50, 60 (CR50, CR60).

If the count in 8-bit timer counter 5, 6 (TM5, TM6) matches the value set in CR50, CR60, the value of TM5, TM6 is cleared to 0, counting continues, and the interrupt request signals (INTTM5, INTTM6) are generated.

The TM5 and TM6 count clocks can be selected with bits 0 to 2 (TCLn0 to TCLn2) in prescaler mode register 5, 6 (PRM5, PRM6).

<Setting method>

<1> Set each register.

- PRMn: Selects the count clock.
- CRn0: Compare value
- TMCn: Selects the clear and start mode when TMn and CRn0 match.
(TMCn = 0000xx0B, x is don't care)

<2> When TCEn = 1 is set, counting starts.

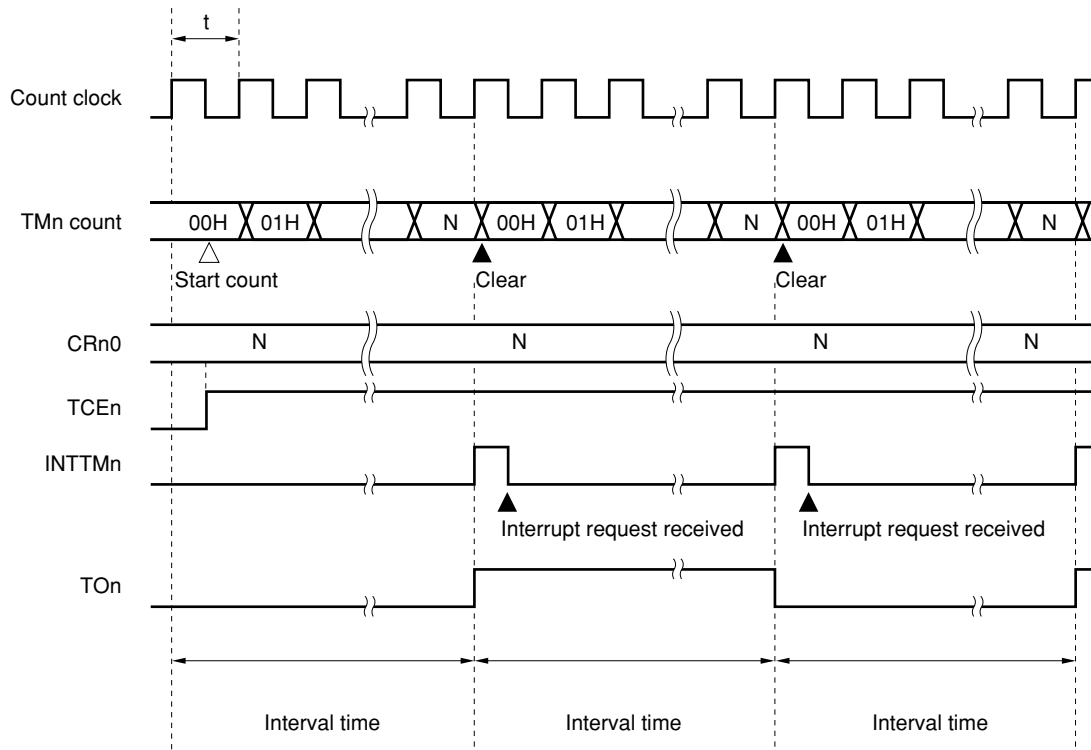
<3> When the values of TMn and CRn0 match, INTTMn is generated (TMn is cleared to 00H).

<4> Then, INTTMn is repeatedly generated during the same interval. When counting stops, set TCEn = 0.

Remark n = 5, 6

Figure 10-6. Timing of Interval Timer Operation (1/3)

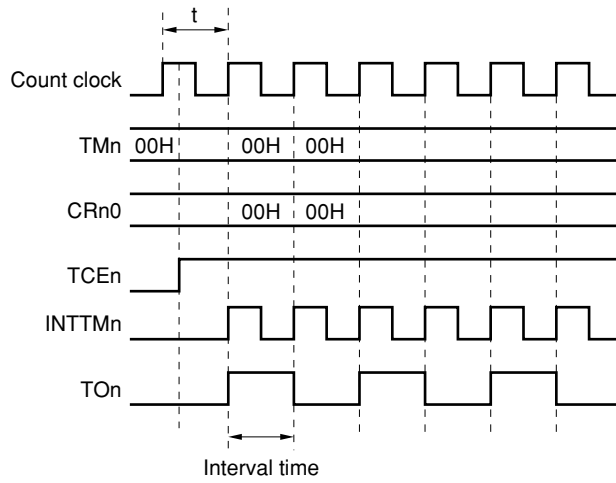
(a) Basic operation



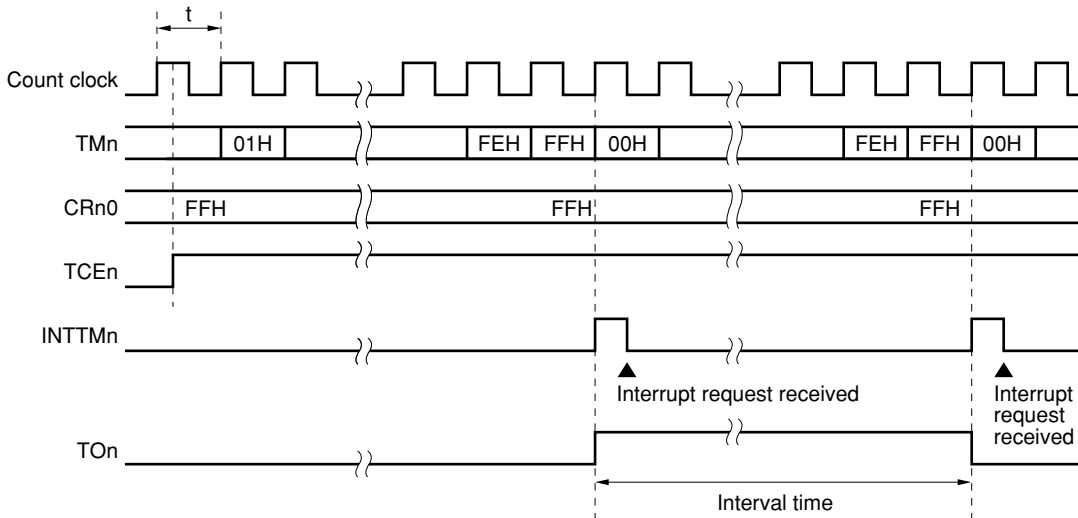
- Remarks**
1. Interval time = $(N + 1) \times t$; $N = 00H$ to FFH
 2. $n = 5, 6$

Figure 10-6. Timing of Interval Timer Operation (2/3)

(b) When CRn0 = 00H



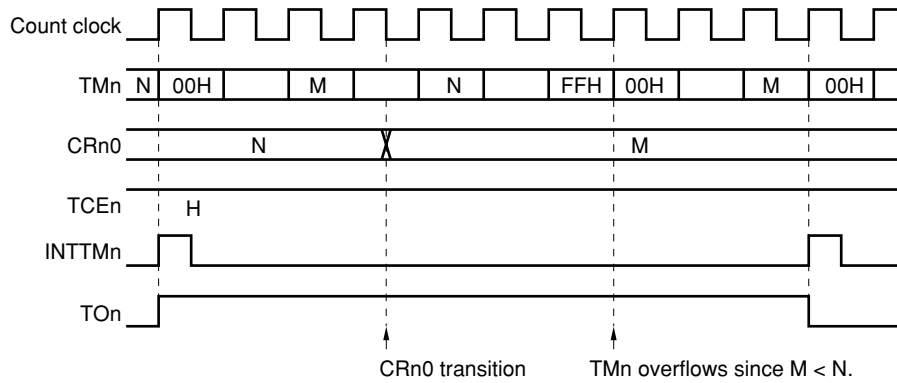
(c) When CRn0 = FFH



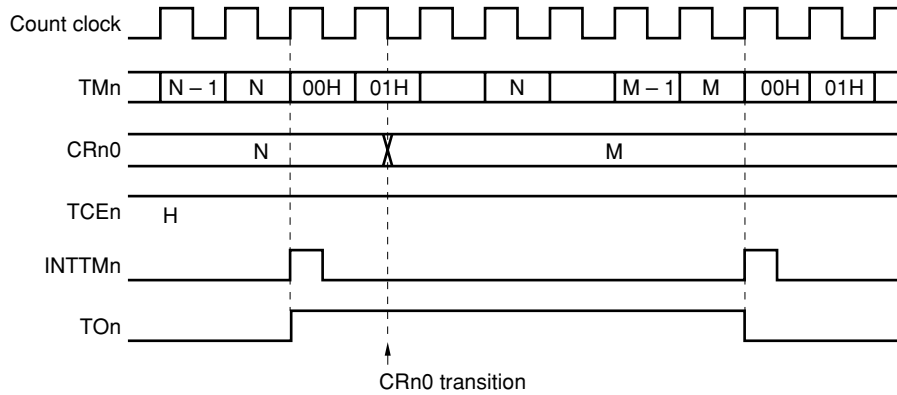
Remark n = 5, 6

Figure 10-6. Timing of Interval Timer Operation (3/3)

(d) Operated by CRn0 transition ($M < N$)



(e) Operated by CRn0 transition ($M > N$)



Remark $n = 5, 6$

10.4.2 Operation as external event counter

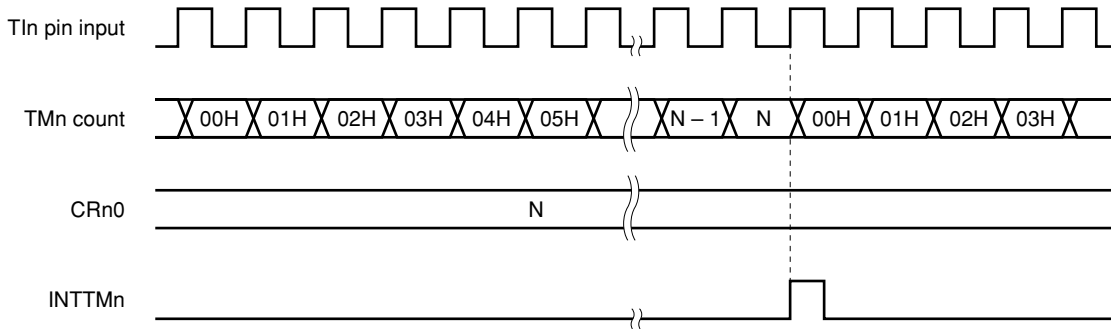
The external event counter counts the number of external clock pulses that are input to TI5/P100 and TI6/P101 pins with 8-bit timer counter 5, 6 (TM5, TM6).

Each time a valid edge specified in prescaler mode register 5, 6 (PRM5, PRM6) is input, TM5 and TM6 are incremented. The edge setting is selected to be either a rising edge or falling edge.

If the counting of TM5 and TM6 matches the values of 8-bit compare register 50, 60 (CR50, CR60), the TM5 and TM6 are cleared to 0 and the interrupt request signal (INTTM5, INTTM6) is generated.

INTTM5 and INTTM6 are generated each time when the value of the TM5 and TM6 matches with the value of CR50 and CR60.

Figure 10-7. Timing of External Event Counter Operation (with Rising Edge Specified)



Remark N = 00H to FFH
n = 5, 6

10.4.3 Operation as square wave output (8-bit resolution)

A square wave having any frequency is output at the interval preset in 8-bit compare register 5, 6 (CR50, CR60).

By setting bit 0 (TOE5, TOE6) of 8-bit timer mode control register 5, 6 (TMC5, TMC6) to 1, the output state of TO5, TO6 is inverted with the count preset in CR50, CR60 as the interval. Therefore, a square wave output having any frequency (duty cycle = 50 %) is possible.

<Setting method>

<1> Set the registers.

- Set the port latch, which also functions as a timer output pin and the port mode register, to 0.
- PRMn: Select the count clock.
- CRn0: Compare value
- TMCn: Clear and start mode when TMn and CRn0 match.

LVS _n	LVR _n	Timer Output Control by Software
1	0	High level output
0	1	Low level output

Inversion of timer output enabled

Timer output enabled → TOEn = 1

<2> When TCEn = 1 is set, the counter starts operating.

<3> If the values of TMn and CRn0 match, the timer output inverts. Also, INTTMn is generated and TMn is cleared to 00H.

<4> Then, the timer output is inverted for the same interval to output a square wave from TOn.

Remark n = 5, 6

10.4.4 Operation as 8-bit PWM output

By setting bit 6 (TMC56, TMC66) of 8-bit timer mode control register 5, 6 (TMC5, TMC6) to 1, the timer operates as a PWM output.

Pulses with the duty cycle determined by the value set in 8-bit compare register 50, 60 (CR50, CR60) is output from TO5, TO6.

Set the width of the active level of the PWM pulse in CR50, CR60. The active level can be selected by bit 1 (TMC51, TMC61) in TMC5, TMC6.

The count clock can be selected by bits 0 to 2 (TCLn0 to TCLn2) of prescaler mode register 5, 6 (PRM5, PRM6).

The PWM output can be enabled and disabled by bit 0 (TOE5, TOE6) of TMC5, TMC6.

(1) Basic operation of the PWM output

<Setting method>

- <1> Set the port latch, which also functions as a timer output pin and the port mode register, to 0.
- <2> Set the active level width in the 8-bit compare register (CRn0).
- <3> Select the count clock in prescaler mode register n (PRMn).
- <4> Set the active level in bit 1 (TMCn1) of TMCn.
- <5> Set bit 0 of TMCn (TOEn) to 1 to enable timer output.
- <6> If bit 7 (TCEn) of TMCn is set to 1, counting starts. When counting stops, set TCEn to 0.

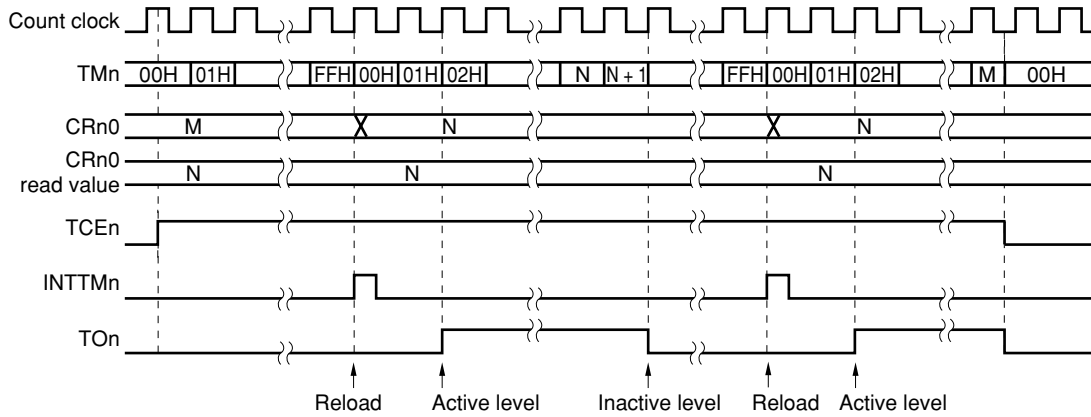
<PWM output operation>

- <1> When counting starts, the PWM output (output from TOn) outputs the inactive level until an overflow occurs.
- <2> When the overflow occurs, the active level is output. The active level is output until CRn0 and the count of 8-bit timer counter n (TMn) match.
- <3> The PWM output after CRn and the count match is the inactive level until an overflow occurs again.
- <4> Steps <2> and <3> repeat until counting stops.
- <5> If counting is stopped by TCEn = 0, the PWM output goes to the inactive level.

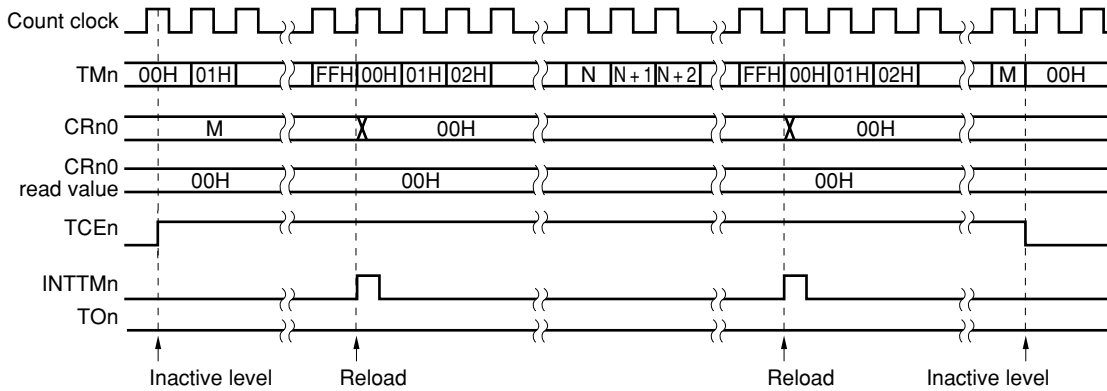
Remark n = 5, 6

Figure 10-8. Timing of PWM Output

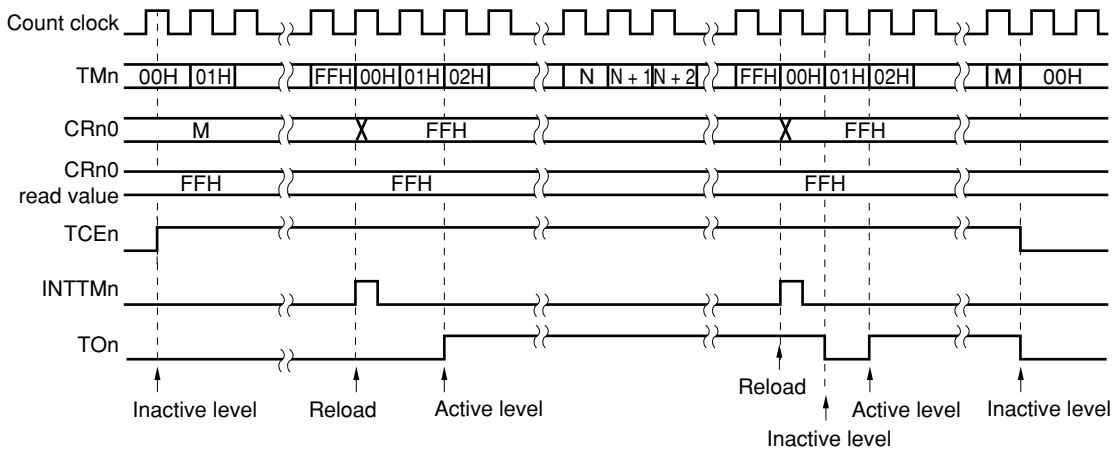
(a) Basic operation (active level = H)



(b) When CRn0 = 0



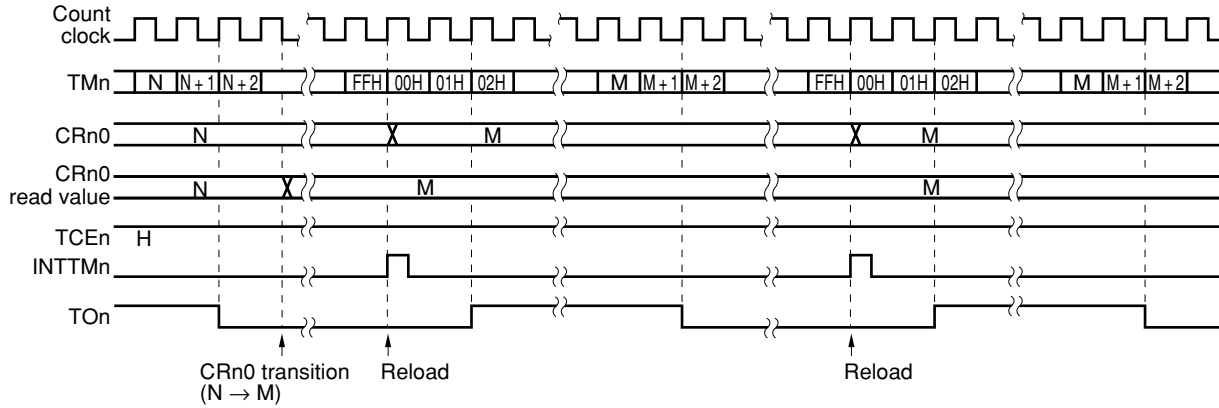
(c) When CRn0 = FFH



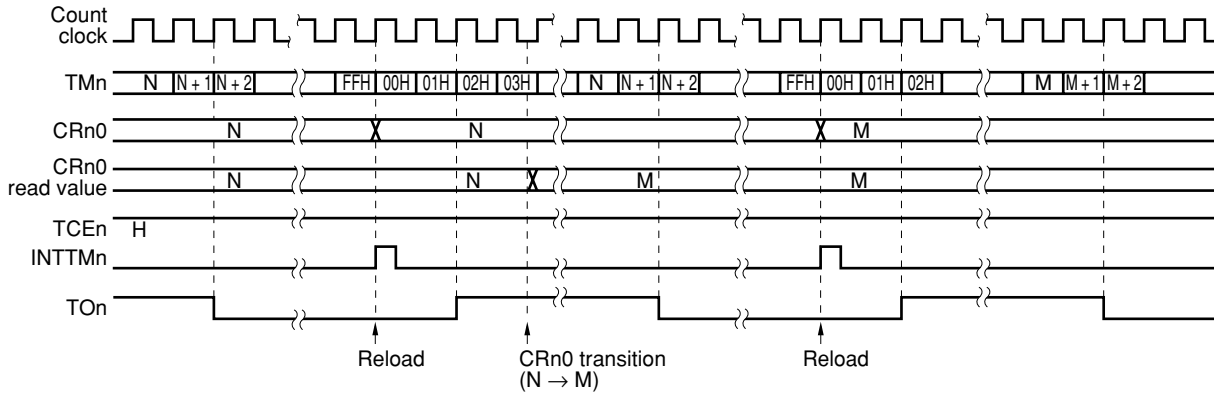
Remark $n = 5, 6$

Figure 10-9. Timing of Operation Based on CRn0 Transitions

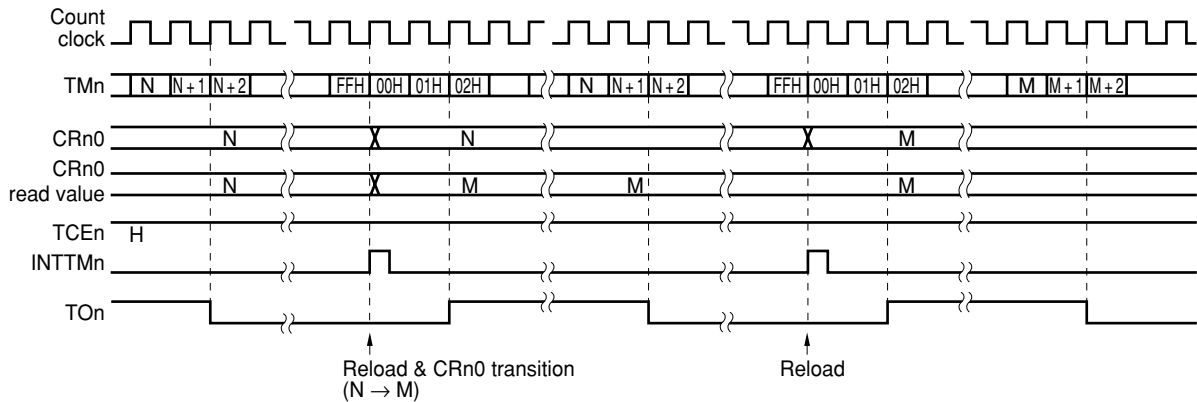
(a) When the CRn0 value changes from N to M before TMn overflows



(b) When the CRn0 value changes from N to M after TMn overflows



(c) When the CRn0 value changes from N to M during two clocks (00H, 01H) immediately after TMn overflows



- Remarks**
1. n = 1, 2
 2. CRn0(M): Master side, CRn0(S): Slave side

10.4.5 Operation as interval timer (16-bit operation)

- **Cascade connection (16-bit timer) mode**

By setting bit 4 (TMC64) of 8-bit timer mode control register 6 (TMC6) to 1, the timer enters the timer/counter mode with 16-bit resolution.

With the count preset in 8-bit compare register 50, 60 (CR50, CR60) as the interval, the timer operates as an interval timer by repeatedly generating interrupt requests.

<Setting method>

<1> Set each register.

- PRM5: TM5 selects the count clock. TM6 connected in cascade are not used in setting.
- CRn0: Compare values (Each compare value can be set from 00H to FFH.)
- TMCn: Select the clear and start mode when TMn and CRn0 match.

$$\left. \begin{array}{l} \text{TM5} \rightarrow \text{TMC5} = 0000xxx0B, x: \text{don't care} \\ \text{TM6} \rightarrow \text{TMC6} = 0001xxx0B, x: \text{don't care} \end{array} \right\}$$

<2> Setting TCE6 = 1 for TMC6 and finally setting TCE5 = 1 in TMC5 starts the count operation.

<3> If the values of TMn of all timers connected in cascade and CRn0 match, the INTTM5 of TM5 is generated. (TM5 and TM6 are cleared to 00H.)

<4> INTTM5 are repeatedly generated at the same interval.

Cautions 1. Always set the compare register (CR50, CR60) after stopping timer operation.

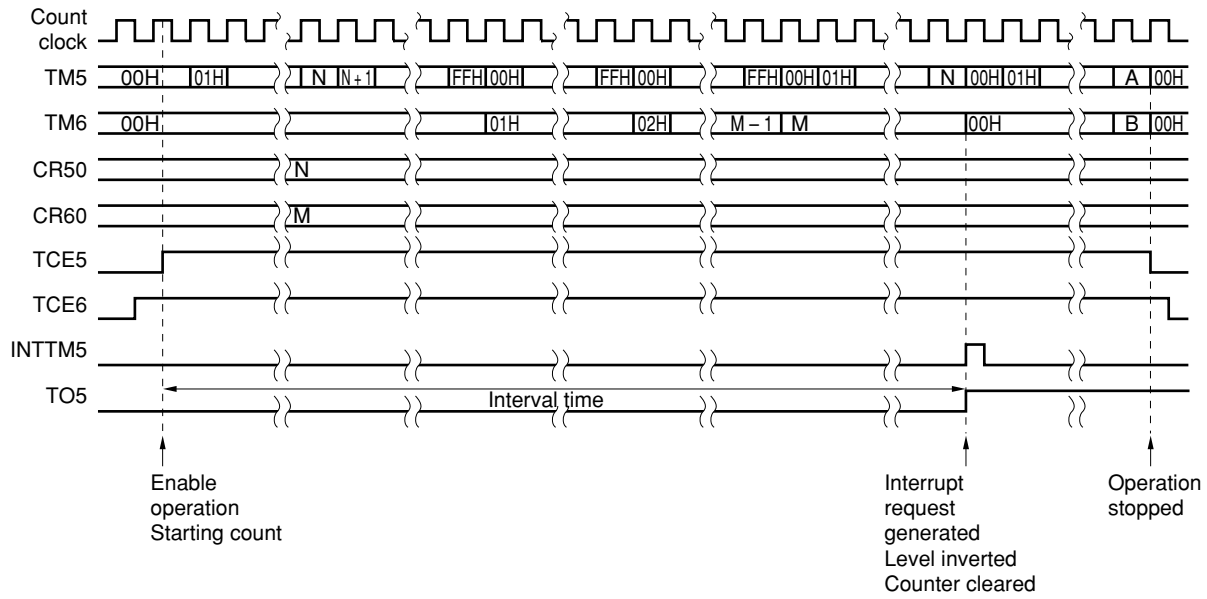
2. If TM6 count matches CR60 even when used in a cascade connection, INTTM6 of TM6 is generated. Always mask TM6 in order to disable interrupts.

3. The TCE5, TCE6 setting begins at TM6. Set the TM5 last.

4. Restarting and stopping the count is possible by setting 1 or 0 only in TCE5 of TMC5. Note, however, that bit 7 (TCE5) of TMC5 and bit 7 (TCE6) of TMC6 must be cleared when setting compare registers CR50 and CR60.

Figure 10-10 shows a timing example of the cascade connection mode with 16-bit resolution.

Figure 10-10. Cascade Connection Mode with 16-Bit Resolution

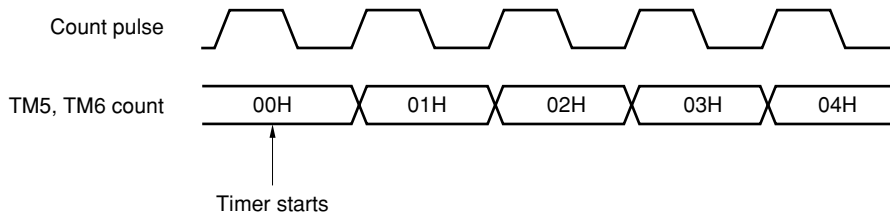


10.5 Cautions

(1) Error when the timer starts

The time until the match signal is generated after the timer starts has a maximum error of one clock. The reason is the starting of 8-bit timer counter 5, 6 (TM5, TM6) is asynchronous with respect to the count pulse.

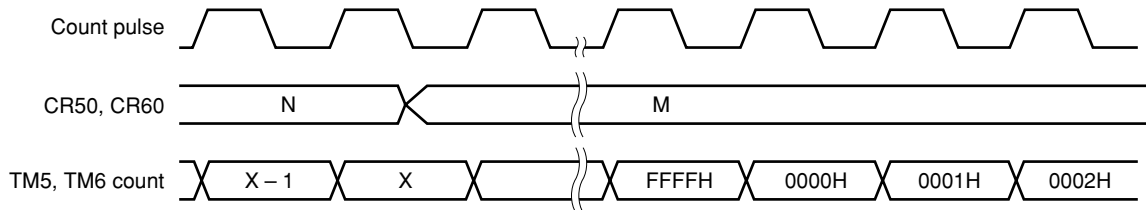
Figure 10-11. Start Timing of 8-Bit Timer Counter



(2) Operation after the compare register is changed while the timer is counting

If the value after 8-bit compare register 50, 60 (CR50, CR60) changes is less than the value of the 8-bit timer counter (TM5, TM6), counting continues, overflows, and counting starts again from 0. Consequently, when the value (M) after CR50, CR60 changes is less than the value (N) before the change, the timer must restart after CR50, CR60 changes.

Figure 10-12. Timing After Compare Register Changes During Timer Counting



Caution Except when the TI5, TI6 input is selected, always set TCE5 = 0, TCE6 = 0 before setting the STOP mode.

Remark $N > X > M$

(3) TM5, TM6 read out during timer operation

Since the count clock stops temporarily when TM5 and TM6 are read during operation, select for the count clock a waveform with a high and low level that exceed 2 cycles of the CPU clock.

When reading TM5 and TM6 in cascade connection mode, to avoid reading while the count is changing, take measures such as obtaining a count match by reading twice using software.

CHAPTER 11 8-BIT TIMER/EVENT COUNTER 7, 8

11.1 Functions

8-bit timer/event counter 7, 8 (TM7, TM8) have the following two modes.

- Mode using 8-bit timer/event counter 7, 8 (TM7, TM8) alone (individual mode)
- Mode using the cascade connection (16-bit resolution: cascade connection mode)

These two modes are described next.

(1) Mode using 8-bit timer/event counter 7, 8 alone (individual mode)

The timer operates as an 8-bit timer/event counter.

It can have the following functions.

- Interval timer
- External event counter
- Square wave output
- PWM output

(2) Mode using the cascade connection (16-bit resolution: cascade connection mode)

The timer operates as a 16-bit timer/event counter by connecting in cascade.

It can have the following functions.

- Interval timer with 16-bit resolution
- External event counter with 16-bit resolution
- Square wave output with 16-bit resolution

11.2 Configuration

8-bit timer/event counter 7, 8 are constructed from the following hardware.

Table 11-1. 8-Bit Timer/Event Counter 7, 8 Configuration

Item	Configuration
Timer counter	8 bits × 2 (TM7, TM8)
Register	8 bits × 2 (CR70, CR80)
Timer output	2 (TO7, TO8)
Control register	8-bit timer mode control register 7 (TMC7) 8-bit timer mode control register 8 (TMC8) Prescaler mode register 7 (PRM7) Prescaler mode register 8 (PRM8)

Figure 11-1. Block Diagram of 8-Bit Timer/Event Counter 7, 8 (1/2)

(1) 8-bit timer/event counter 7

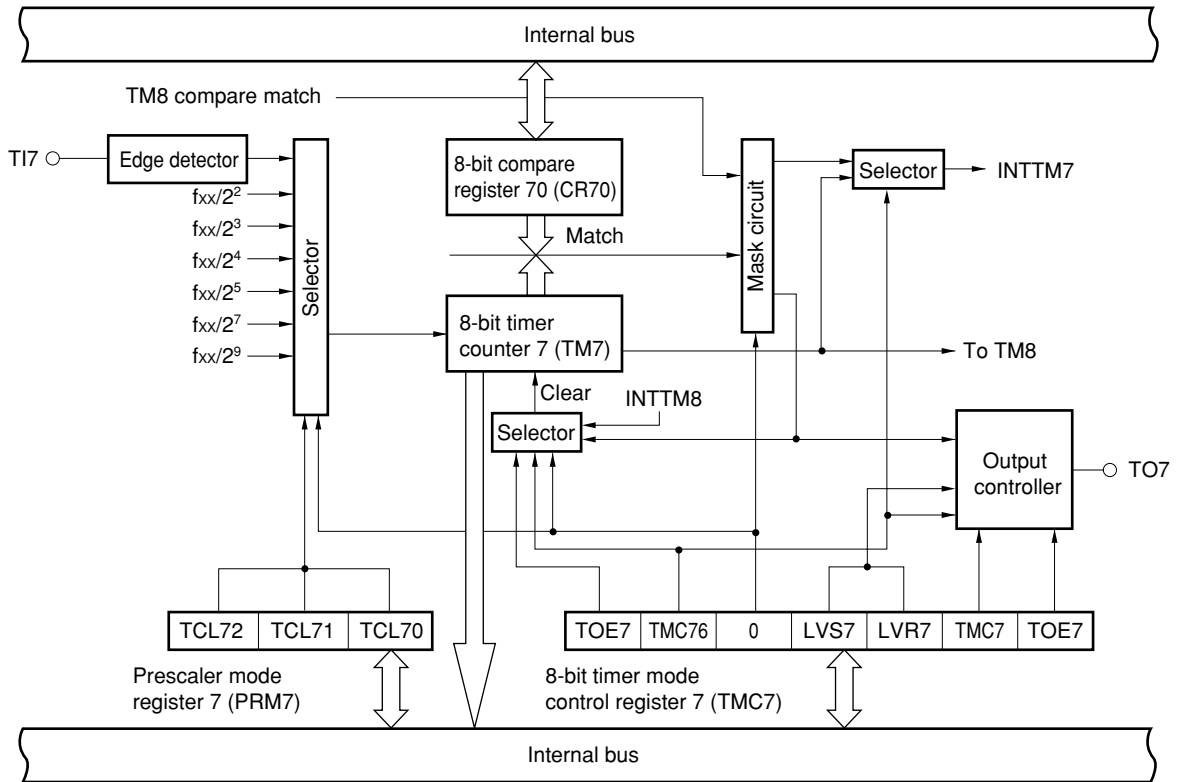
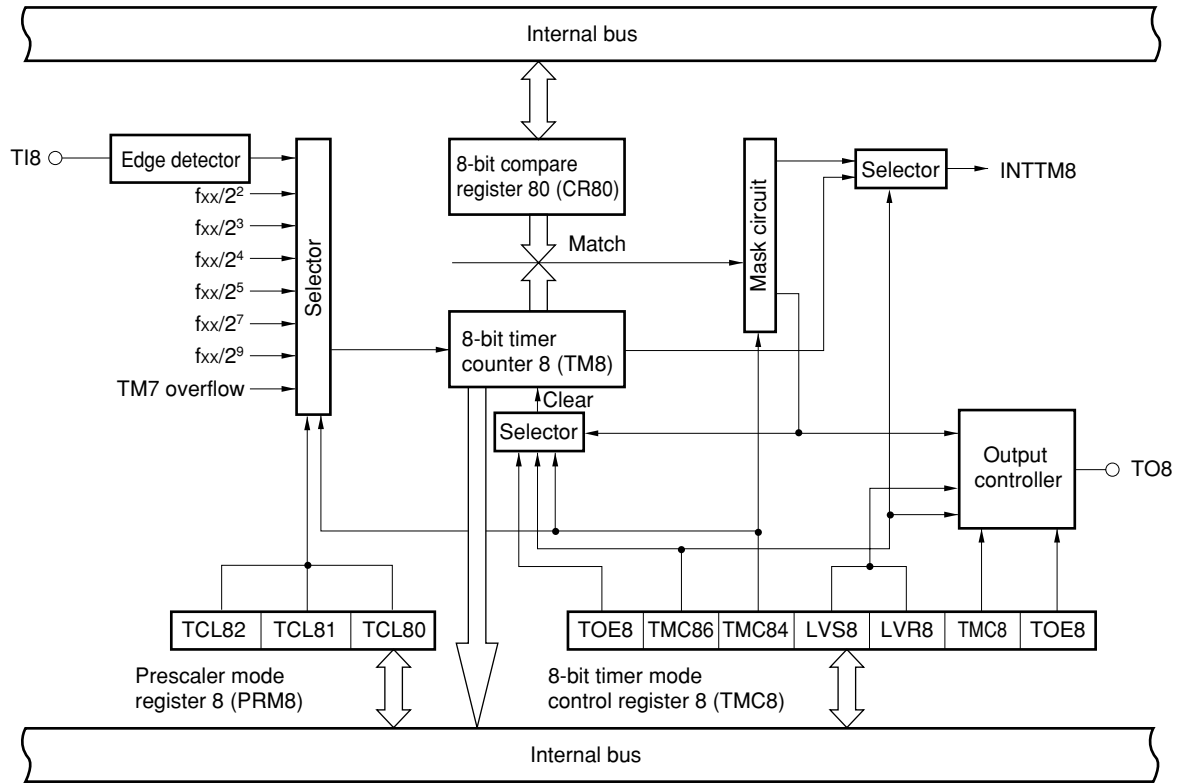


Figure 11-1. Block Diagram of 8-Bit Timer/Event Counter 7, 8 (2/2)

(1) 8-bit timer/event counter 8



(1) 8-bit timer counter 7, 8 (TM7, TM8)

TM7 and TM8 are 8-bit read-only registers that count the count pulses.

The counter is incremented synchronous to the rising edge of the count clock. When the count is read out during operation, the count clock input temporarily stops and the count is read at that time. In the following cases, the count becomes 00H.

- <1> $\overline{\text{RESET}}$ is input.
- <2> TCE_n is cleared.
- <3> TM_n and CR_{n0} match in the clear and start mode.

Caution In a cascade connection, the count becomes 00H by clearing bit 7 (TCE7) of 8-bit timer mode control register 7 (TMC7) and bit 7 (TCE8) of 8-bit timer mode control register 8 (TMC8).

Remark n = 7, 8

(2) 8-bit compare register (CR70, CR80)

The value set in CR70 and CR80 are compared to the count in 8-bit timer counter 7 (TM7) and 8-bit timer counter 8 (TM8), respectively. If the two values match, interrupt requests (INTTM7, INTTM8) is generated (except in the PWM mode).

The values of CR70 and CR80 can be set in the range of 00H to FFH, and can be written during counting.

Caution While the timers are connected in cascade, always set data after stopping the timer. To stop timer operation, clear both bit 7 of TMC7 (TCE7) and bit 7 of TMC8 (TCE8).

11.3 Control Registers

The following four registers control 8-bit timer/event counter 7, 8.

- 8-bit timer mode control register 7, 8 (TMC7, TMC8)
- Prescaler mode register 7, 8 (PRM7, PRM8)

(1) 8-bit timer mode control register 7, 8 (TMC7, TMC8)

The TMC7 and TMC8 registers make the following six settings.

- <1> Controls the counting for 8-bit timer counter 7, 8 (TM7, TM8)
- <2> Selects the operating mode of 8-bit timer counter 7, 8 (TM7, TM8)
- <3> Selects the individual mode or cascade mode
- <4> Sets the state of the timer output
- <5> Controls the timer output or selects the active level during the PWM (free-running) mode
- <6> Controls timer output

TMC7 and TMC8 are set by a 1-bit or 8-bit memory manipulation instruction.

$\overline{\text{RESET}}$ input sets TMC7 and TMC8 to 00H.

Figures 11-2 and 11-3 show the TMC7 format and TMC8 format respectively.

Figure 11-2. Format of 8-Bit Timer Mode Control Register 7 (TMC7)

Address: 0FF6AH After reset: 00H R/W

Symbol	<7>	6	5	4	<3>	<2>	1	<0>
TMC7	TCE7	TMC76	0	0	LVS7	LVR7	TMC71	TOE7

TCE7	TM7 count control
0	Counting is disabled (prescaler disabled) after the counter is cleared to 0.
1	Start counting

TMC76	TM7 operating mode selection
0	Clear and start mode when TM7 and CR70 match.
1	PWM (free-running) mode

LVS7	LVR7	Timer output control by software
0	0	No change
0	1	Reset (to 0).
1	0	Set (to 1).
1	1	Setting prohibited

TMC71	Other than PWM mode (TMC76 = 0)	PWM mode (TMC76 = 1)
	Timer output control	Active level selection
0	Disable inversion operation	Active high
1	Enable inversion operation	Active low

TOE7	Timer output control
0	Disable output (port mode)
1	Enable output

Caution When selecting the TM7 operation mode using TMC76, stop the timer operation in advance.

- Remarks**
1. In the PWM mode, the PWM output is set to the inactive level by TCE7 = 0.
 2. If LVS7 and LVR7 are read after setting data, 0 is read.

Figure 11-3. Format of 8-Bit Timer Mode Control Register 8 (TMC8)

Address: 0FF6BH After reset: 00H R/W

Symbol	<7>	6	5	4	<3>	<2>	1	<0>
TMC8	TCE8	TMC86	0	TMC84	LVS8	LVR8	TMC81	TOE8

TCE8	TM8 count control
0	Counting is disabled (prescaler disabled) after the counter is cleared to 0.
1	Start counting

TMC86	TM8 operating mode selection
0	Clear and start mode when TM8 and CR80 match
1	PWM (free-running) mode

TMC84	Individual mode or cascade connection mode selection
0	Individual mode
1	Cascade connection mode (connection with TM7)

LVS8	LVR8	Timer output control by software
0	0	No change
0	1	Reset (to 0)
1	0	Set (to 1)
1	1	Setting prohibited

TMC81	Other than PWM mode (TMC86 = 0)	PWM mode (TMC86 = 1)
	Timer output control	Active level selection
0	Disable inversion operation	Active high
1	Enable inversion operation	Active low

TOE8	Timer output control
0	Disable output (port mode)
1	Enable output

Caution When selecting the TM8 operation mode using TMC86 or selecting the discrete/cascade connection mode using TMC84, stop the timer operation in advance. To stop the timer operation during cascade connection, clear both bit 7 (TCE7) of 8-bit timer mode control register 7 (TMC7) and bit 7 (TCE8) of TMC8.

Remarks 1. In the PWM mode, the PWM output is set to the inactive level by TCE8 = 0.
 2. If LVS8 and LVR8 are read after setting data, 0 is read.

(2) Prescaler mode register 7, 8 (PRM7, PRM8)

This register sets the count clock of 8-bit timer counter 7, 8 (TM7, TM8) and the valid edge of TI7, TI8 inputs.

PRM7 and PRM8 are set by a 1-bit or 8-bit memory manipulation instruction.

RESET input sets PRM7 and PRM8 to 00H.

Figure 11-4. Format of Prescaler Mode Register 7 (PRM7)

Address: 0FF6EH After reset: 00H R/W

Symbol	7	6	5	4	3	2	1	0
PRM7	0	0	0	0	0	TCL72	TCL71	TCL70

TCL72	TCL71	TCL70	Count clock selection
0	0	0	Falling edge of TI7
0	0	1	Rising edge of TI7
0	1	0	$f_{xx}/4$ (3.13 MHz)
0	1	1	$f_{xx}/8$ (1.56 MHz)
1	0	0	$f_{xx}/16$ (781 kHz)
1	0	1	$f_{xx}/32$ (391 kHz)
1	1	0	$f_{xx}/128$ (97.6 kHz)
1	1	1	$f_{xx}/512$ (24.4 kHz)

- Cautions**
1. If writing data different than that of PRM7 is written, stop the timer beforehand.
 2. Be sure to set bits 3 to 7 of PRM7 to 0.
 3. When specifying the valid edge of TI7 for the count clock, set the count clock to $f_{xx}/4$ or below.

Remark Figures in parentheses apply to operation with $f_{xx} = 12.5$ MHz.

Figure 11-5. Format of Prescaler Mode Register 8 (PRM8)

Address: 0FF6FH After reset: 00H R/W

Symbol	7	6	5	4	3	2	1	0
PRM8	0	0	0	0	0	TCL82	TCL81	TCL80

TCL82	TCL81	TCL80	Count clock selection
0	0	0	Falling edge of T18
0	0	1	Rising edge of T18
0	1	0	$f_{xx}/4$ (3.13 MHz)
0	1	1	$f_{xx}/8$ (1.56 MHz)
1	0	0	$f_{xx}/16$ (781 kHz)
1	0	1	$f_{xx}/32$ (391 kHz)
1	1	0	$f_{xx}/128$ (97.6 kHz)
1	1	1	$f_{xx}/512$ (24.4 kHz)

- Cautions**
1. If writing data different than that of PRM8 is written, stop the timer beforehand.
 2. Be sure to set bits 3 to 7 of PRM8 to 0.
 3. When specifying the valid edge of T18 for the count clock, set the count clock to $f_{xx}/4$ or below.

Remark Figures in parentheses apply to operation with $f_{xx} = 12.5$ MHz.

11.4 Operation

11.4.1 Operation as interval timer (8-bit operation)

The timer operates as an interval timer that repeatedly generates interrupt requests at the interval of the preset count in 8-bit compare register 70, 80 (CR70, CR80).

If the count in 8-bit timer counter 7, 8 (TM7, TM8) matches the value set in CR70, CR80, simultaneous to clearing the value of TM7, TM8 to 0 and continuing the count, the interrupt request signal (INTTM7, INTTM8) is generated.

The TM7 and TM8 count clocks can be selected with bits 0 to 2 (TCLn0 to TCLn2) in prescaler mode register 7, 8 (PRM7, PRM8).

<Setting method>

<1> Set each register.

- PRMn: Selects the count clock.
- CRn0: Compare value
- TMCn: Selects the clear and start mode when TMn and CRn0 match.
(TMCn = 0000xxx0B, x is don't care)

<2> When TCEn = 1 is set, counting starts.

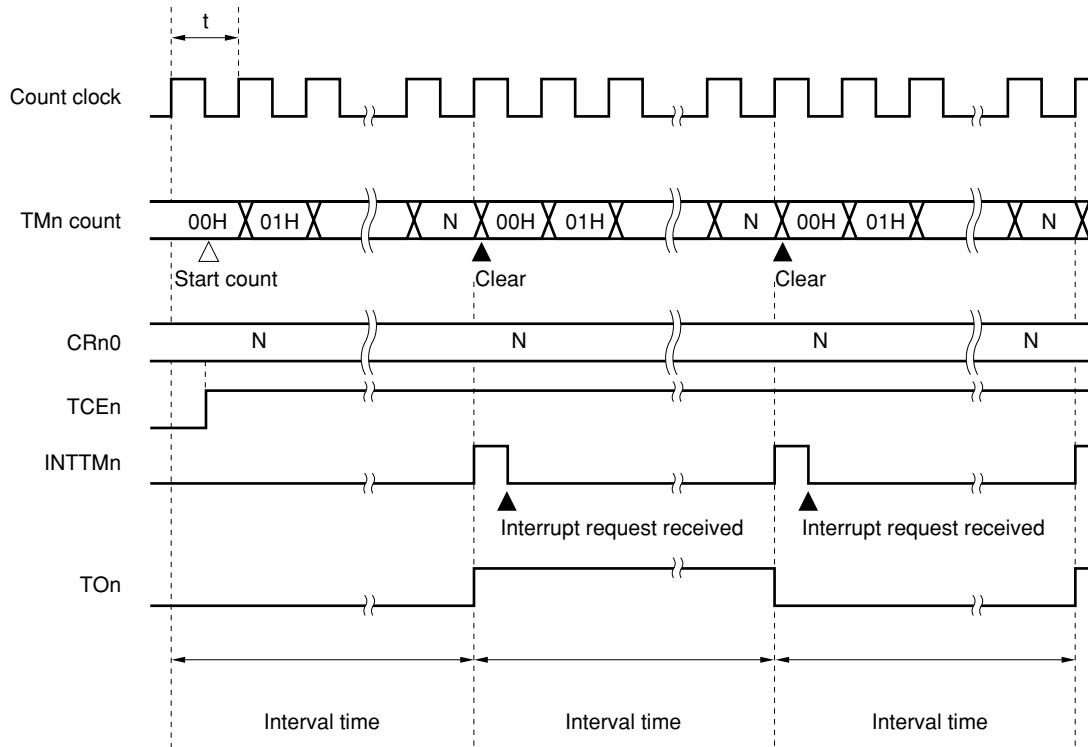
<3> When the values of TMn and CRn0 match, INTTMn is generated (TMn is cleared to 00H).

<4> Then, INTTMn is repeatedly generated during the same interval. When counting stops, set TCEn = 0.

Remark n = 7, 8

Figure 11-6. Timing of Interval Timer Operation (1/3)

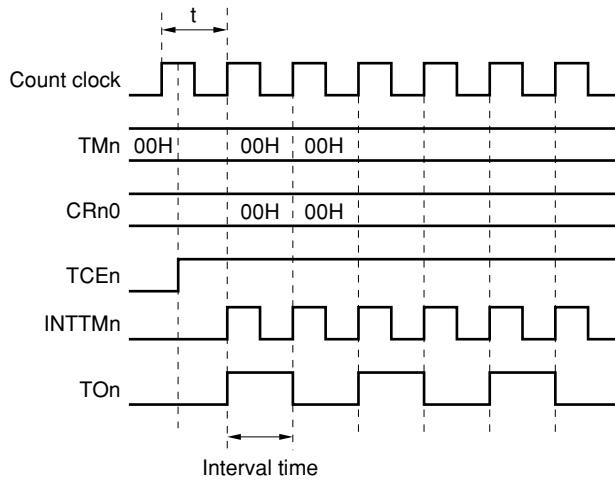
(a) Basic operation



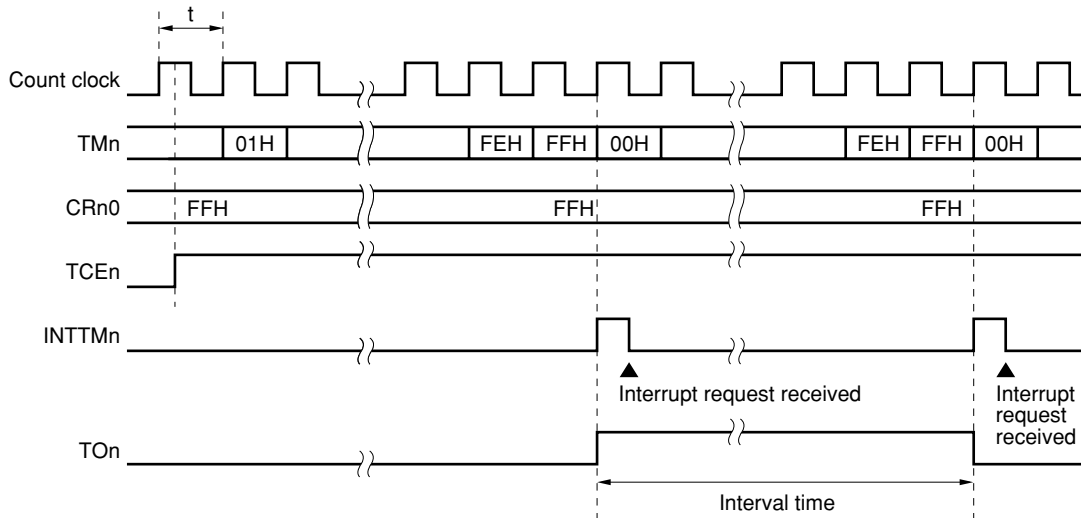
- Remarks**
1. Interval time = $(N + 1) \times t$; $N = 00H$ to FFH
 2. $n = 7, 8$

Figure 11-6. Timing of Interval Timer Operation (2/3)

(b) When CRn0 = 00H



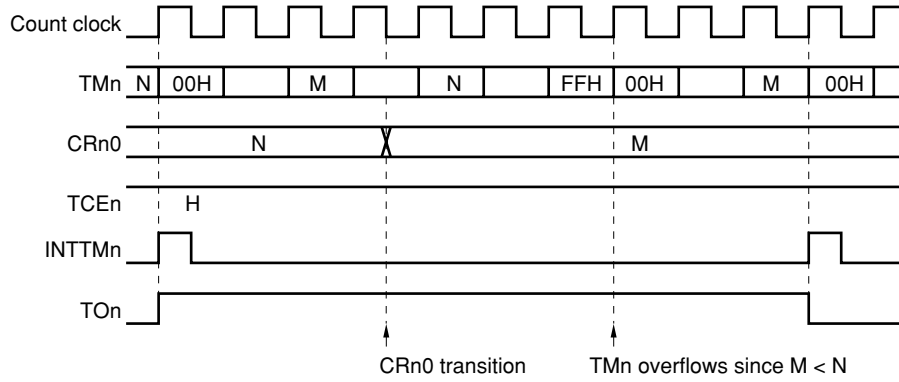
(c) When CRn0 = FFH



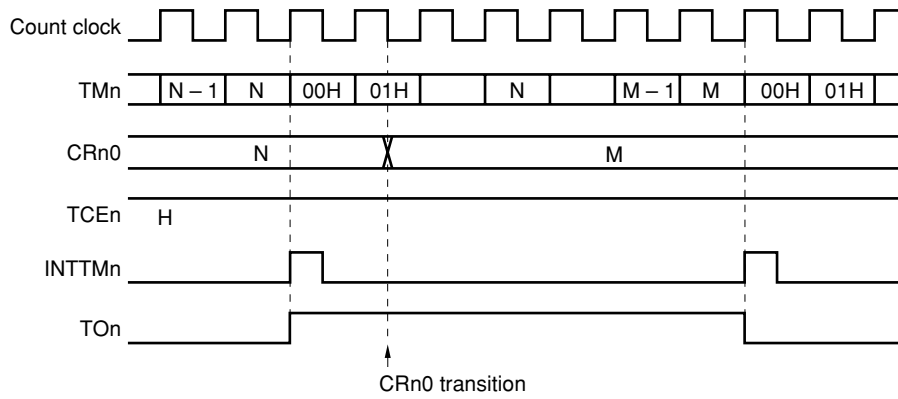
Remark $n = 7, 8$

Figure 11-6. Timing of Interval Timer Operation (3/3)

(d) Operated by CRn0 transition ($M < N$)



(e) Operated by CRn0 transition ($M > N$)



Remark n = 7, 8

11.4.2 Operation as external event counter

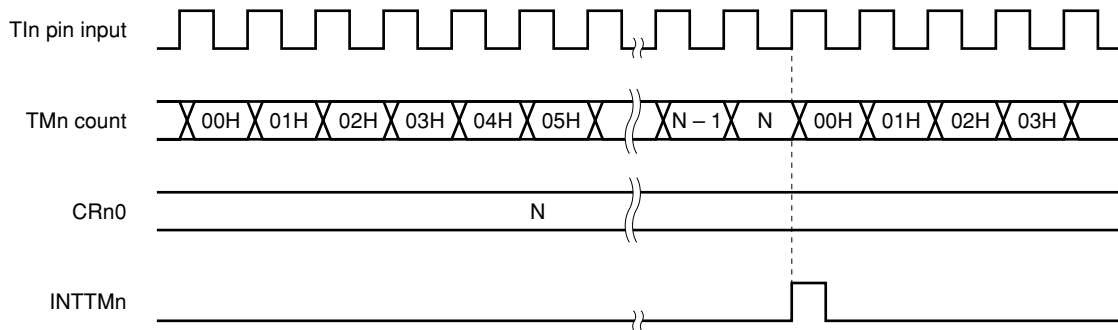
The external event counter counts the number of external clock pulses that are input to TI7/P102 and TI8/P103 pins with 8-bit timer counter 7, 8 (TM7, TM8).

Each time a valid edge specified in prescaler mode register 7, 8 (PRM7, PRM8) is input, TM7 and TM8 are incremented. The edge setting is selected to be either a rising edge or falling edge.

If the counting of TM7 and TM8 matches with the values of 8-bit compare register 70, 80 (CR70, CR80), the TM7 and TM8 are cleared to 0 and the interrupt request signal (INTTM7, INTTM8) is generated.

INTTM7 and INTTM8 are generated each time when the value of the TM7 and TM8 matches with the value of CR70 and CR80.

Figure 11-7. Timing of External Event Counter Operation (with Rising Edge Specified)



Remark N = 00H to FFH
n = 7, 8

11.4.3 Operation as square wave output (8-bit resolution)

A square wave having any frequency is output at the interval preset in 8-bit compare register 70, 80 (CR70, CR80).

By setting bit 0 (TOE7, TOE8) of 8-bit timer mode control register 7, 8 (TMC7, TMC8) to 1, the output state of TO7, TO8 is inverted with the count preset in CR70, CR80 as the interval. Therefore, a square wave output having any frequency (duty cycle = 50 %) is possible.

<Setting method>

<1> Set the registers.

- Set the port latch, which also functions as a timer output pin and the port mode register, to 0.
- PRMn: Select the count clock.
- CRn0: Compare value
- TMCn: Clear and start mode when TMn and CRn0 match.

LVS _n	LVR _n	Timer Output Control by Software
1	0	High level output
0	1	Low level output

Inversion of timer output enabled

Timer output enabled → TOEn = 1

<2> When TCEn = 1 is set, the counter starts operating.

<3> If the values of TMn and CRn0 match, the timer output inverts. Also, INTTMn is generated and TMn is cleared to 00H.

<4> Then, the timer output is inverted for the same interval to output a square wave from TOn.

Remark n = 7, 8

11.4.4 Operation as 8-bit PWM output

By setting bit 6 (TMC76, TMC86) of 8-bit timer mode control register 7, 8 (TMC7, TMC8) to 1, the timer operates as a PWM output.

Pulses with the duty cycle determined by the value set in 8-bit compare register 70, 80 (CR70, CR80) is output from TO7, TO8.

Set the width of the active level of the PWM pulse in CR70, CR80. The active level can be selected by bit 1 (TMC71, TMC81) in TMC7, TMC8.

The count clock can be selected by bits 0 to 2 (TCLn0 to TCLn2) of prescaler mode register 7, 8 (PRM7, PRM8).

The PWM output can be enabled and disabled by bit 0 (TOE7, TOE8) of TMC7, TMC8.

(1) Basic operation of the PWM output**<Setting method>**

- <1> Set the port latch, which also functions as a timer output pin and the port mode register, to 0.
- <2> Set the active level width in the 8-bit compare register (CRn0).
- <3> Select the count clock in prescaler mode register n (PRMn).
- <4> Set the active level in bit 1 (TMCn1) of TMCn.
- <5> Set bit 0 of TMCn (TOEn) to 1 to enable timer output.
- <6> If bit 7 (TCEn) of TMCn is set to 1, counting starts. When counting stops, set TCEn to 0.

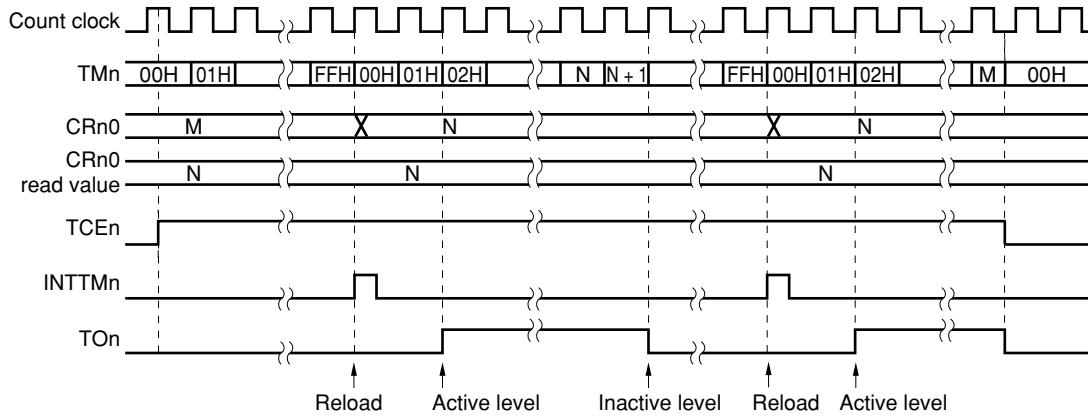
<PWM output operation>

- <1> When counting starts, the PWM output (output from TOn) outputs the inactive level until an overflow occurs.
- <2> When the overflow occurs, the active level is output. The active level is output until CRn0 and the count of 8-bit timer counter n (TMn) match.
- <3> The PWM output after CRn0 and the count match is the inactive level until an overflow occurs again.
- <4> Steps <2> and <3> repeat until counting stops.
- <5> If counting is stopped by TCEn = 0, the PWM output goes to the inactive level.

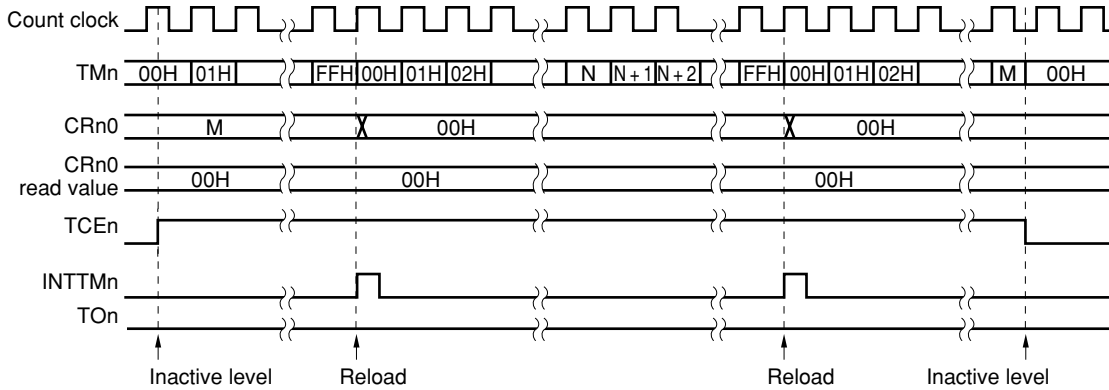
Remark n = 7, 8

Figure 11-8. Timing of PWM Output

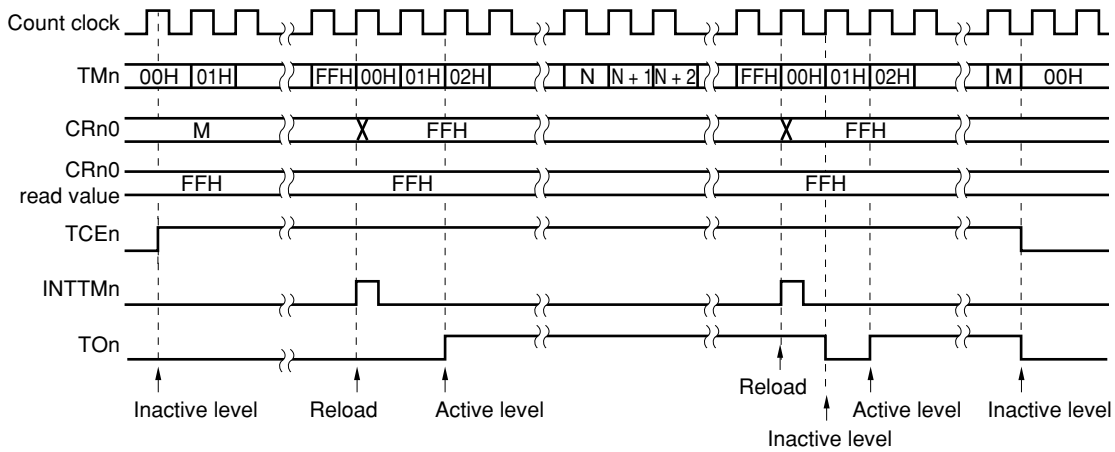
(a) Basic operation (active level = H)



(b) When CRn0 = 0



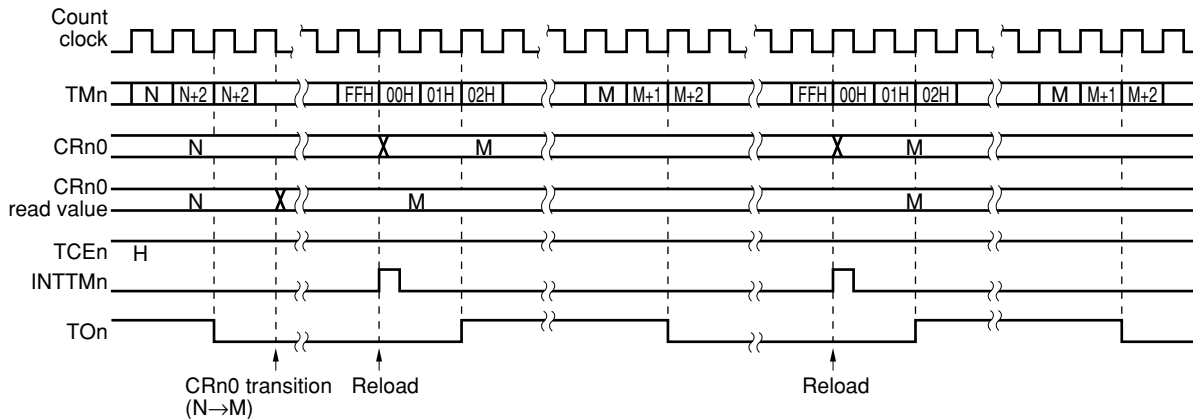
(c) When CRn0 = FFH



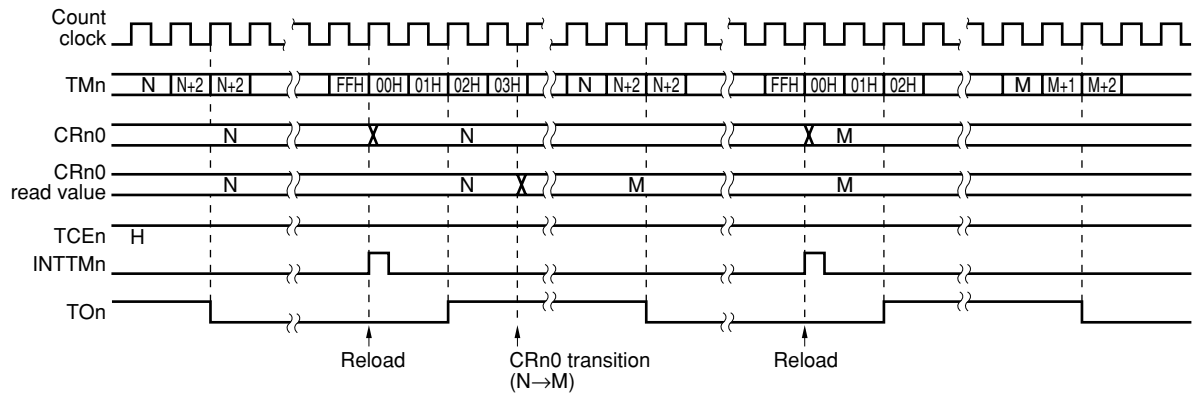
Remark n = 7, 8

Figure 11-9. Timing of Operation Based on CRn0 Transitions

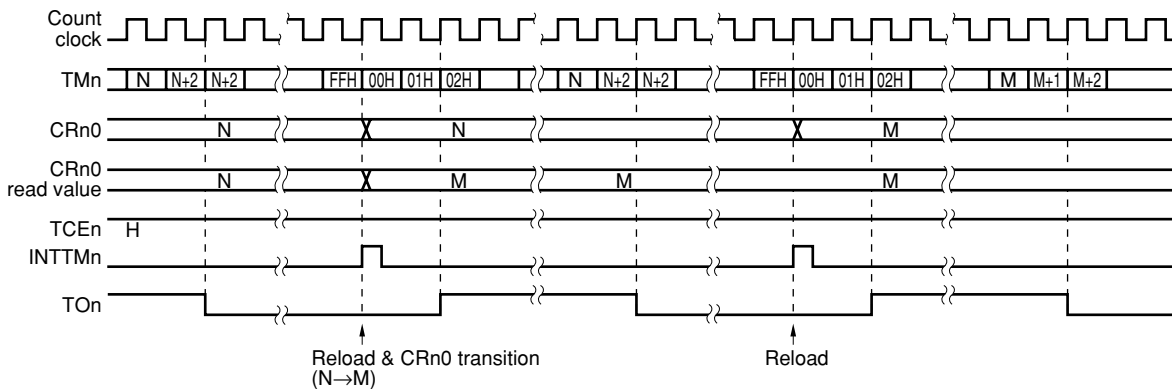
(a) When the CRn0 value changes from N to M before TMn overflows



(b) When the CRn0 value changes from N to M after TMn overflows



(c) When the CRn0 value changes from N to M during two clocks (00H, 01H) immediately after TMn overflows



Remarks 1. n = 7, 8

2. CRn0 (M): Master side, CRn0 (S): Slave side

11.4.5 Operation as interval timer (16-bit operation)

- **Cascade connection (16-bit timer) mode**

By setting bit 4 (TMC84) of 8-bit timer mode control register 8 (TMC8) to 1, the timer enters the timer/counter mode with 16-bit resolution.

With the count preset in 8-bit compare register 70, 80 (CR70, CR80) as the interval, the timer operates as an interval timer by repeatedly generating interrupt requests.

<Setting method>

<1> Set each register.

- PRM7: TM7 selects the count clock. TM8 connected in cascade are not used in setting.
- CRn0: Compare values (Each compare value can be set from 00H to FFH.)
- TMCn: Select the clear and start mode when TMn and CRn0 match.

$$\left. \begin{array}{l} \text{TM7} \rightarrow \text{TMC7} = 0000\text{x}\text{x}\text{x}0\text{B}, \text{x}: \text{don't care} \\ \text{TM8} \rightarrow \text{TMC8} = 0001\text{x}\text{x}\text{x}0\text{B}, \text{x}: \text{don't care} \end{array} \right\}$$

<2> Setting TCE8 = 1 for TMC8 and finally setting TCE7 = 1 in TMC7 starts the count operation.

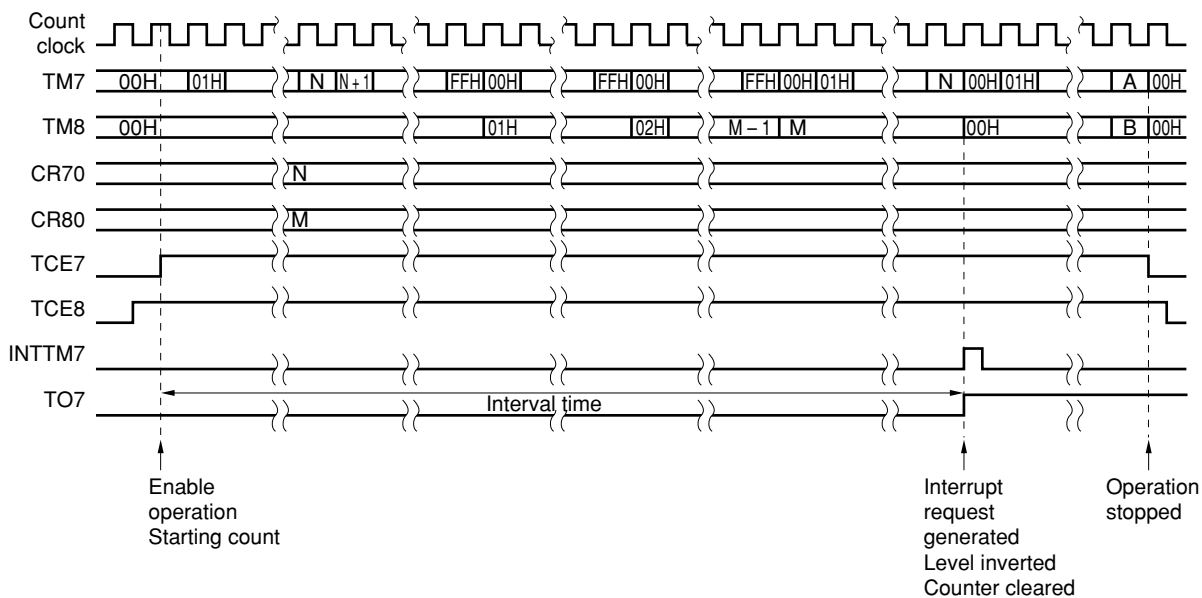
<3> If the values of TMn of all timers connected in cascade and CRn0 match, the INTTM7 of TM7 is generated. (TM7 and TM8 are cleared to 00H.)

<4> INTTM7 are repeatedly generated at the same interval.

- Cautions**
1. Always set the compare register (CR70, CR80) after stopping timer operation.
 2. If TM8 count matches CR80 even when used in a cascade connection, INTTM8 of TM8 is generated. Always mask TM8 in order to disable interrupts.
 3. The TCE7, TCE8 setting begins at TM8. Set the TM7 last.
 4. Restarting and stopping the count is possible by setting 1 or 0 only in TCE7 of TMC7. Note, however, that bit 7 (TCE7) of TMC7 and bit 7 (TCE8) of TMC8 must be cleared when setting compare registers CR70 and CR80.

Figure 11-10 shows a timing example of the cascade connection mode with 16-bit resolution.

Figure 11-10. Cascade Connection Mode with 16-Bit Resolution

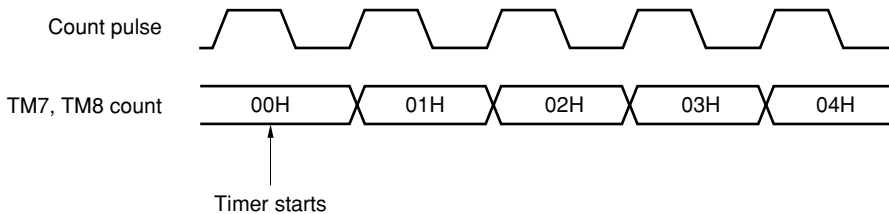


11.5 Cautions

(1) Error when the timer starts

The time until the match signal is generated after the timer starts has a maximum error of one clock. The reason is the starting of 8-bit timer counter 7, 8 (TM7, TM8) is asynchronous with respect to the count pulse.

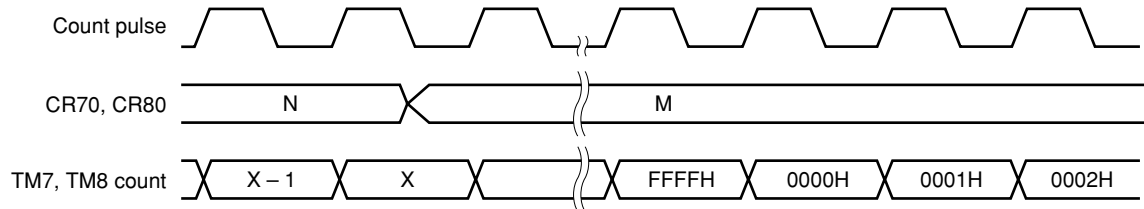
Figure 11-11. Start Timing of 8-Bit Timer Counter Register



(2) Operation after the compare register is changed while the timer is counting

If the value after 8-bit compare register 70, 80 (CR70, CR80) changes is less than the value of the 8-bit timer counter (TM7, TM8), counting continues, overflows, and counting starts again from 0. Consequently, when the value (M) after CR70, CR80 changes is less than the value (N) before the change, the timer must restart after CR70, CR80 changes.

Figure 11-12. Timing After Compare Register Changes During Timer Counting



Caution Except when the TI7, TI8 input is selected, always set TCE7 = 0, TCE8 = 0 before setting the STOP mode.

Remark $N > X > M$

(3) TM7, TM8 read out during timer operation

Since the count clock stops temporarily when TM7 and TM8 are read during operation, select for the count clock a waveform with a high and low level that exceed 2 cycles of the CPU clock.

When reading TM7 and TM8 in cascade connection mode, to avoid reading while the count is changing, take measures such as obtaining a count match by reading twice using software.

CHAPTER 12 WATCH TIMER

12.1 Function

The watch timer has the following functions:

- Watch timer
- Interval timer

The watch timer and interval timer functions can be used at the same time.

(1) Watch timer

The watch timer generates an interrupt request (INTWT) at time intervals of 0.5 seconds by using the main system clock of 4.19 MHz or subsystem clock of 32.768 kHz.

Caution The time interval of 0.5 seconds cannot be created with the 12.5 MHz main system clock. Use the 32.768 kHz subsystem clock to create the 0.5-second time interval.

(2) Interval timer

The watch timer generates an interrupt request (INTTM3) at time intervals specified in advance.

Table 12-1. Interval Time of Interval Timer

Interval Time	$f_{xx} = 12.5 \text{ MHz}$	$f_{xx} = 4.19 \text{ MHz}$	$f_{xt} = 32.768 \text{ kHz}$
$2^{11} \times 1/f_{xx}$	164 μs	488 μs	488 μs
$2^{12} \times 1/f_{xx}$	328 μs	977 μs	977 μs
$2^{13} \times 1/f_{xx}$	655 μs	1.95 ms	1.95 ms
$2^{14} \times 1/f_{xx}$	1.31 ms	3.91 ms	3.91 ms
$2^{15} \times 1/f_{xx}$	2.62 ms	7.81 ms	7.81 ms
$2^{16} \times 1/f_{xx}$	5.24 ms	15.6 ms	15.6 ms

Remark f_{xx} : Main system clock frequency
 f_{xt} : Subsystem clock oscillation frequency

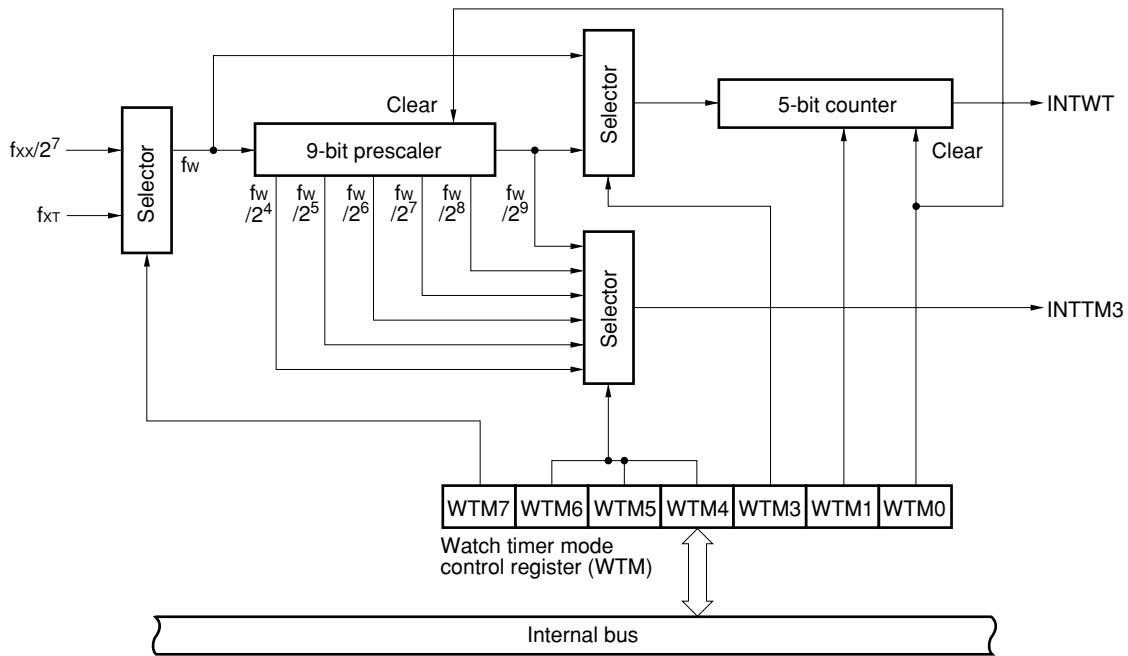
12.2 Configuration

The watch timer consists of the following hardware.

Table 12-2. Configuration of Watch Timer

Item	Configuration
Counter	5 bits × 1
Prescaler	9 bits × 1
Control register	Watch timer mode control register (WTM)

Figure 12-1. Block Diagram of Watch Timer



Remark f_{xx} : Main system clock frequency
 f_{xt} : Subsystem clock oscillation frequency

12.3 Control Register

- **Watch timer mode control register (WTM)**

This register enables or disables the count clock and operation of the watch timer, sets the interval time of the prescaler, controls the operation of the 5-bit counter, and sets the set time of the watch flag.

WTM is set by a 1-bit or 8-bit memory manipulation instruction.

$\overline{\text{RESET}}$ input sets WTM to 00H.

Figure 12-2. Format of Watch Timer Mode Control Register (WTM)

Address: 0FF9CH After reset: 00H R/W

Symbol	7	6	5	4	3	2	<1>	<0>
WTM	WTM7	WTM6	WTM5	WTM4	WTM3	0	WTM1	WTM0

WTM7	Selects count clock of watch timer
0	Main system clock ($f_{xx}/2^7$)
1	Subsystem clock (f_{xt})

WTM6	WTM5	WTM4	Selects interval time of prescaler
0	0	0	$2^4/f_w$ (488 μ s)
0	0	1	$2^5/f_w$ (977 μ s)
0	1	0	$2^6/f_w$ (1.95 ms)
0	1	1	$2^7/f_w$ (3.91 ms)
1	0	0	$2^8/f_w$ (7.81 ms)
1	0	1	$2^9/f_w$ (15.6 ms)
Other than above			Setting prohibited

WTM3	Selects set time of watch flag
0	$2^{14}/f_w$ (0.5 s)
1	$2^5/f_w$ (977 μ s)

WTM1	Controls operation of 5-bit counter
0	Clear after operation stop
1	Start

WTM0	Enables operation of watch timer
0	Operation stop (clear both prescaler and timer)
1	Operation enable

- Cautions**
1. Stop the timer operation before overwriting WTM.
 2. Do not overwrite WTM when both the watch timer and interval timer are being used. If the timer is stopped to overwrite WTM, both the prescaler and timer are cleared, causing an error to occur in the watch timer interrupt (INTWT).

- Remarks**
1. f_w : Watch timer clock frequency ($f_{xx}/2^7$ or f_{xt})
 f_{xx} : Main system clock frequency
 f_{xt} : Subsystem clock oscillation frequency
 2. Figures in parentheses apply to operation with $f_w = 32.768$ kHz.

12.4 Operation

12.4.1 Operation as watch timer

The watch timer operates with time intervals of 0.5 seconds with the main system clock (4.19 MHz) or subsystem clock (32.768 kHz).

The watch timer generates an interrupt request (INTWT) at fixed time intervals.

The count operation of the watch timer is started when bits 0 (WTM0) and 1 (WTM1) of the watch timer mode control register (WTM) are set to 1. When these bits are cleared to 0, the 5-bit counter is cleared, and the watch timer stops the count operation.

Only the watch timer can be started from zero seconds by clearing WTM1 to 0 when the interval timer operates at the same time. In this case, however, the 9-bit prescaler is not cleared. Therefore, an error of up to $1/f_w$ or $2^9 \times 1/f_w$ occurs at the first overflow (INTWT) after the watch timer has been started from zero seconds.

12.4.2 Operation as interval timer

The watch timer can also be used as an interval timer that repeatedly generates an interrupt request (INTTM3) at intervals specified by a count value set in advance.

The interval time can be selected by bits 4 to 6 (WTM4 to WTM6) of the watch timer mode control register (WTM).

Table 12-3. Interval Time of Interval Timer

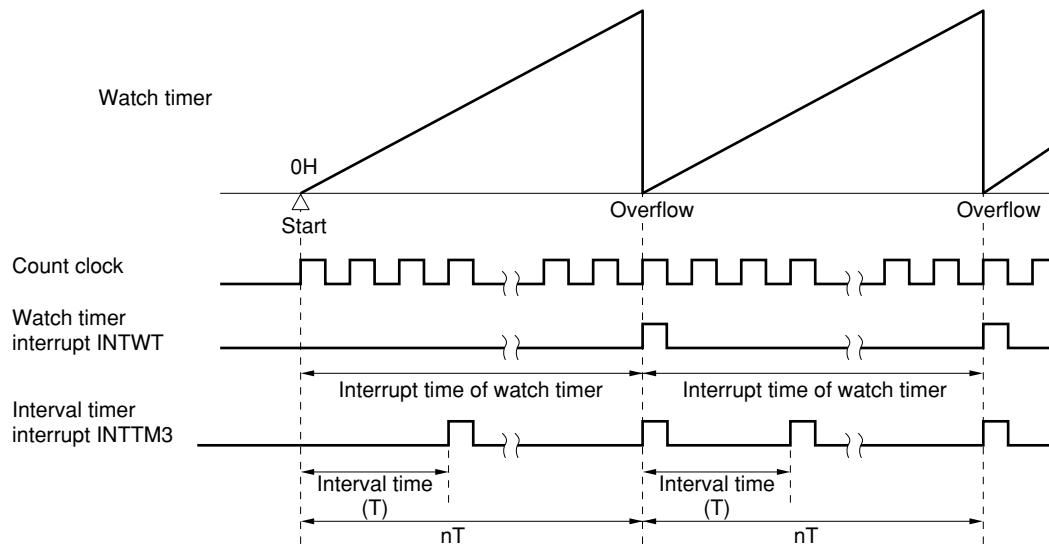
WTM6	WTM5	WTM4	Interval time	$f_{xx} = 12.5 \text{ MHz}$	$f_{xx} = 4.19 \text{ MHz}$	$f_{xt} = 32.768 \text{ kHz}$
0	0	0	$2^4 \times 1/f_w$	164 μs	488 μs	488 μs
0	0	1	$2^5 \times 1/f_w$	328 μs	977 μs	977 μs
0	1	0	$2^6 \times 1/f_w$	655 μs	1.95 ms	1.95 ms
0	1	1	$2^7 \times 1/f_w$	1.31 ms	3.91 ms	3.91 ms
1	0	0	$2^8 \times 1/f_w$	2.62 ms	7.81 ms	7.81 ms
1	0	1	$2^9 \times 1/f_w$	5.24 ms	15.6 ms	15.6 ms
Other than above			Setting prohibited			

Cautions 1. Stop the timer operation before overwriting WTM.

2. Do not overwrite WTM when both the watch timer and interval timer are being used. If the timer is stopped to overwrite WTM, both the prescaler and timer are cleared, causing an error to occur in the watch timer interrupt (INTWT).

Remark f_w : Watch timer clock frequency ($f_{xx}/2^7$ or f_{xt})
 f_{xx} : Main system clock frequency
 f_{xt} : Subsystem clock oscillation frequency

Figure 12-3. Operation Timing of Watch Timer/Interval Timer



Caution When enabling operation of the watch timer mode control register (WTM), watch timer, and 5-bit counter, the time until the first watch timer interrupt request (INTWT) is generated is not exactly the same time as set by bits 4 to 6 of WTM (WTM4 to WTM6). This is because the 5-bit counter starts counting 1 cycle after 9-bit prescaler output. Following the first INTWT generation, the INTWT signal is generated at the set interval time.

Remark n: Number of interval timer operations

CHAPTER 13 WATCHDOG TIMER

The watchdog timer detects runaway programs.

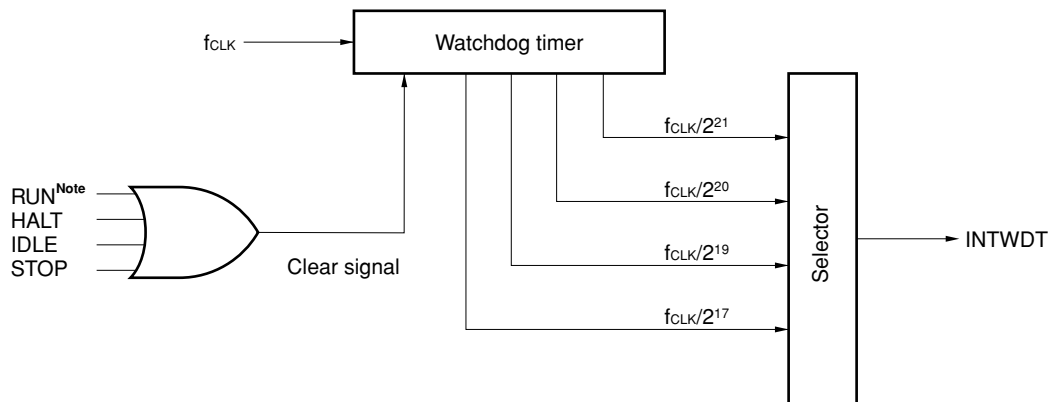
Program or system errors are detected by the generation of watchdog timer interrupts. Therefore, at each location in the program, the instruction that clears the watchdog timer (starts the count) within a constant time is input.

If the watchdog timer overflows without executing the instruction that clears the watchdog timer within the set period, a watchdog timer interrupt (INTWDT) is generated to signal a program error.

13.1 Configuration

Figure 13-1 shows a block diagram of the watchdog timer.

Figure 13-1. Watchdog Timer Block Diagram



Note Write 1 to bit 7 (RUN) of the watchdog timer mode register (WDM).

Remark f_{CLK}: Internal system clock (f_{xx} to f_{xx}/8), and subsystem clock

13.2 Control Register

- **Watchdog timer mode register (WDM)**

The WDM is the 8-bit register that controls watchdog timer operation.

To prevent the watchdog timer from erroneously clearing this register due to a runaway program, this register is only written by a special instruction. This special instruction has a special code format (4 bytes) in the MOV WDM, #byte instruction. Writing takes place only when the third and fourth op codes are mutual 1's complements.

If the third and fourth op codes are not mutual 1's complements and not written, the operand error interrupt is generated. In this case, the return address saved in the stack is the address of the instruction that caused the error. Therefore, the address that caused the error can be identified from the return address saved in the stack. If returning by simply using the RETB instruction from the operand error, an infinite loop results.

Since an operand error interrupt is generated only when the program is running wild (the correct special instruction is only generated when MOV WDM, #byte is described in the RA78K4 NEC Electronics assembler), make the program initialize the system.

Other write instructions (MOV WDM, A; AND WDM, #byte; SET1 WDM.7, etc.) are ignored and nothing happens. In other words, WDM is not written, and interrupts, such as operand error interrupts, are not generated.

After a system reset ($\overline{\text{RESET}}$ input), when the watchdog timer starts (when the RUN bit is set to 1), the WDM contents cannot change. Only a reset can stop the watchdog timer. The watchdog timer can be cleared by a special instruction.

The WDM can be read by 8-bit data transfer instructions.

$\overline{\text{RESET}}$ input sets WDM to 00H.

Figure 13-2 shows the WDM format.

Figure 13-2. Watchdog Timer Mode Register (WDM) Format

Address: 0FFC2H After reset: 00H R/W

Symbol	7	6	5	4	3	2	1	0
WDM	RUN	0	0	WDT4	0	WDT2	WDT1	0

RUN	Watchdog timer operation setting
0	Stops the watchdog timer.
1	Clears the watchdog timer and starts counting.

WDT4	Watchdog timer interrupt request priority
0	Watchdog timer interrupt request < NMI pin input interrupt request
1	Watchdog timer interrupt request > NMI pin input interrupt request

WDT2	WDT1	Count clock	Overflow time [ms] (f _{CLK} = 12.5 MHz)
0	0	f _{CLK} /2 ¹⁷	10.5
0	1	f _{CLK} /2 ¹⁹	41.9
1	0	f _{CLK} /2 ²⁰	83.9
1	1	f _{CLK} /2 ²¹	167.8

- Cautions**
1. Only the special instruction (MOV WDM, #byte) can write to the watchdog timer mode register (WDM).
 2. When writing to WDM to set the RUN bit to 1, write the same value every time. Even if different values are written, the contents written the first time cannot be updated.
 3. When the RUN bit is set to 1, it cannot be reset to 0 by the software.

Remark f_{CLK}: Internal system clock (f_{xx} to f_{xx}/8), and subsystem clock

13.3 Operations

13.3.1 Count operation

The watchdog timer is cleared by setting the RUN bit of the watchdog timer mode register (WDM) to 1 to start counting. After the RUN bit is set to 1, when the overflow time set by bits WDT2 and WDT1 in WDM has elapsed, a non-maskable interrupt (INTWDT) is generated.

If the RUN bit is reset to 1 before the overflow time elapses, the watchdog timer is cleared, and counting restarts.

13.3.2 Interrupt priority order

The watchdog timer interrupt (INTWDT) can be specified as either maskable or non-maskable according to the interrupt selection control register (SNMI) setting. When writing 0 to bit 1 (SDWT) of SNMI, the watchdog timer interrupt can be used as a non-maskable interrupt. In addition to the INTWDT, the non-maskable interrupts include the interrupt (NMI) from the NMI pin. By setting bit 4 of the watchdog timer mode register (WDM), the acceptance order when INTWDT and NMI are simultaneously generated can be set.

If accepting NMI is given priority, even if INTWDT is generated in an NMI processing program that is executing, INTWDT is not accepted, but is accepted after the NMI processing program ends.

13.4 Cautions

13.4.1 General cautions when using watchdog timer

- (1) The watchdog timer is one way to detect runaway operation, but all runaway operations cannot be detected. Therefore, in a device that particularly demands reliability, the runaway operation must be detected early not only by the on-chip watchdog timer but by an externally attached circuit; and when returning to the normal state or while in the stable state, processing like stopping the operation must be possible.
- (2) The watchdog timer cannot detect runaway operation in the following cases.
 - <1> When the watchdog timer is cleared in a timer interrupt servicing program
 - <2> When there are successive temporary stores of interrupt requests and macro services (see **23.9 When Interrupt Requests and Macro Service Are Temporarily Held Pending**)
 - <3> When runaway operation is caused by logical errors in the program (when each module in the program operates normally, but the entire system does not operate properly), and when the watchdog timer is periodically cleared
 - <4> When the watchdog timer is periodically cleared by an instruction group that is executed during runaway operation
 - <5> When the STOP, HALT, or IDLE mode is the result of runaway operation
 - <6> When the watchdog timer also runs wild when the CPU runs wild because of introduced noise

In cases <1>, <2>, and <3>, detection becomes possible by correcting the program.

In case <4>, the watchdog timer can be cleared only by the 4-byte special instruction. Similarly in <5>, if there is no 4-byte special instruction, the STOP, HALT, or IDLE mode cannot be set. Since the result of the runaway operation is to enter state <2>, three or more bytes of consecutive data must be a specific pattern (example, BT PSWL.bit, \$\$). Therefore, the results of <4>, <5>, and the runaway operation are believed to very rarely enter state <2>.

13.4.2 Cautions about μ PD784218A Subseries watchdog timer

- (1) Only the special instruction (MOV WDM, #byte) can write to the watchdog timer mode register (WDM).
- (2) If the RUN bit is set to 1 by writing to the watchdog timer mode register (WDM), write the same value every time. Even when different values are written, the contents written the first time cannot be changed.
- (3) If the RUN bit is set to 1, it cannot be reset to 0 by the software.

CHAPTER 14 A/D CONVERTER

14.1 Functions

The A/D converter converts analog inputs to digital values, and is configured by eight 8-bit resolution channels (ANI0 to ANI7).

Successive approximation is used as the conversion method, and conversion results are saved in the 8-bit A/D conversion result register (ADCR).

A/D conversion operation is activated by the following two methods.

(1) Hardware start

Conversion is started by trigger input (P03) (rising edge, falling edge, or both rising and falling edges can be specified).

(2) Software start

Conversion is started by setting the A/D converter mode register (ADM).

A/D converter selects one channel for analog input from ANI0 to ANI7 to perform A/D conversion. At the hardware start time, A/D conversion stops after the A/D conversion operation is completed, and an interrupt request (INTAD) is issued. At the software start time, the A/D conversion operation is repeated. Each time one A/D conversion is completed, an interrupt request (INTAD) is issued.

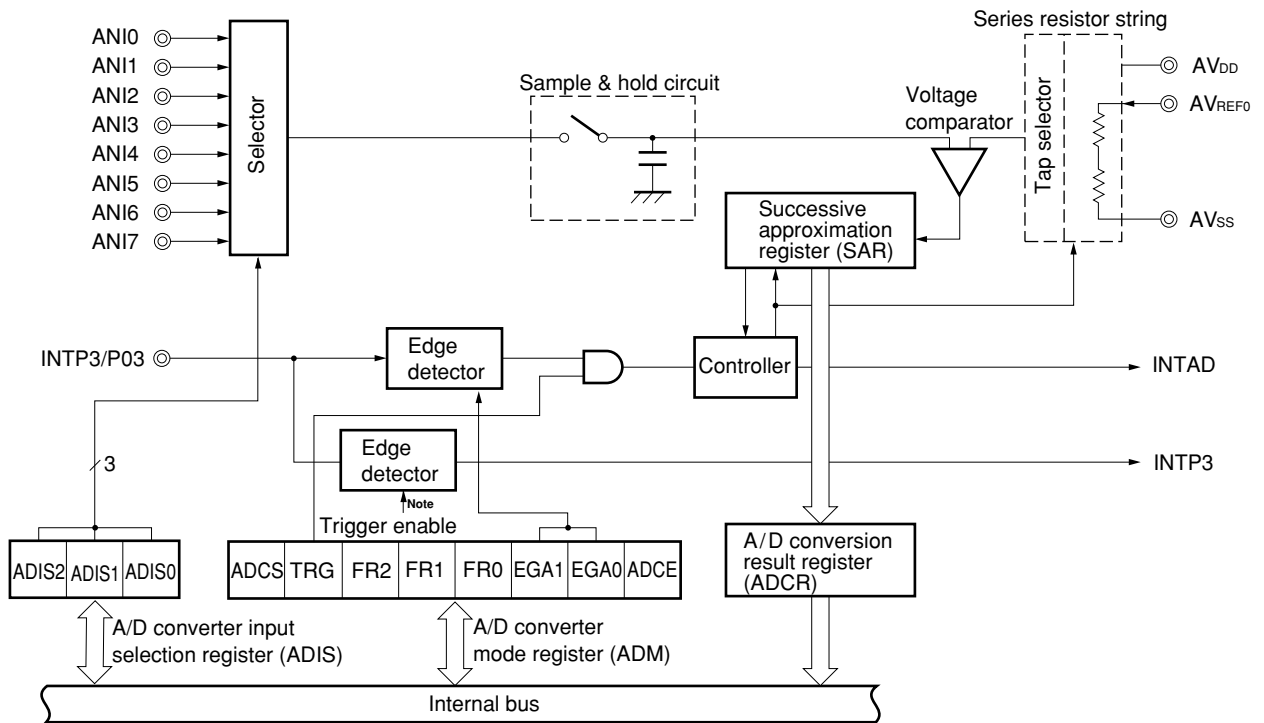
14.2 Configuration

The A/D converter has the following hardware configuration.

Table 14-1. A/D Converter Configuration

Item	Configuration
Analog input	8 channels (ANI0 to ANI7)
Control registers	A/D converter mode register (ADM) A/D converter input selection register (ADIS)
Registers	Successive approximation register (SAR) A/D conversion result register (ADCR)

Figure 14-1. A/D Converter Block Diagram



Note Valid edge specified with bit 3 of the EGP0, EGN0L registers (Refer to **Figure 22-1 Format of External Interrupt Rising Edge Enable Register (EGP0) and External Interrupt Falling Edge Enable Register (EGN0)**).

(1) Successive approximation register (SAR)

Compares the voltage of the analog input with the voltage tap (comparison voltage) from the series resistor string, and retains the result from the most significant bit (MSB).

When retaining the result to the least significant bit (LSB) (A/D conversion end), the contents of the SAR register are transferred to the A/D conversion result register.

(2) A/D conversion result register (ADCR)

Retains A/D conversion results. At the end of each A/D conversion operation, the conversion result from the successive approximation register is loaded.

ADCR is read with an 8-bit memory manipulation instruction.

RESET input makes its contents undefined.

(3) Sample & hold circuit

Samples analog input signals one by one as they are sent from the input circuit, and sends them to the voltage comparator. The sampled analog input voltages are saved during A/D conversion.

(4) Voltage comparator

Compares the analog input voltage with the output voltage of the series resistor string.

(5) Series resistor string

Connected between AV_{REF0} and AV_{SS} , generates the voltage that is compared with that of analog input.

(6) ANI0 to ANI7 pins

Eight analog input channels used for inputting analog data to the A/D converter for A/D conversion. Pins not selected for analog input with the A/D converter input selection register (ADIS) can be used as input ports.

- Cautions**
- 1. Use ANI0 to ANI7 input voltages within the rated voltage range. Inputting a voltage equal to or greater than AV_{REF0} , or equal to or smaller than AV_{SS} (even if within the absolute maximum rated range) will cause the channel's conversion values to become undefined, or may affect the conversion values of other channels.**
 - 2. Analog input (ANI0 to ANI7) pins alternate with input port (P10 to P17) pins. When performing an A/D conversion with the selection of any one of inputs from ANI0 to ANI7, do not execute input instructions to port 1 during conversion. Conversion resolution may decrease. When a digital pulse is applied to the pin which adjoins a pin in the A/D conversion, an expected A/D conversion value may not be acquired due to the coupling noise. Therefore do not apply a pulse to the pin which adjoins the pin in the A/D conversion.**

(7) AV_{REF0} pin

Used to input the reference voltage of the A/D converter.

Based on the voltage applied between AV_{REF0} and AV_{SS} , signals input to ANI0 to ANI7 are converted to digital signals.

(8) AV_{SS} pin

Ground pin of the A/D converter. Always use this pin at the same electric potential as the V_{SS} pin, even when not using the A/D converter.

(9) AV_{DD} pin

Analog power supply pin of the A/D converter. Always use this pin at the same electric potential as the V_{DD} pin, even when not using the A/D converter.

14.3 Control Registers

The A/D converter controls the following two registers.

- A/D converter mode register (ADM)
- A/D converter input selection register (ADIS)

(1) A/D converter mode register (ADM)

Used to set the A/D conversion time of analog input to be converted, start/stop of conversion operation, and external triggers.

ADM is set by a 1-bit or 8-bit memory manipulation instruction.

$\overline{\text{RESET}}$ input sets ADM to 00H.

Figure 14-2. A/D Converter Mode Register (ADM) Format

Address: 0FF80H After reset: 00H R/W

Symbol	<7>	<6>	<5>	<4>	<3>	<2>	<1>	<0>
ADM	ADCS	TRG	FR2	FR1	FR0	EGA1	EGA0	ADCE

ADCS	A/D conversion control
0	Conversion stop
1	Conversion enable

TRG	Software start/hardware start selection
0	Software start
1	Hardware start

FR2	FR1	FR0	A/D conversion time selection		
			Number of clocks	@f _{xx} = 12.5 MHz	@f _{xx} = 6.25 MHz
0	0	0	144/f _{xx}	Setting prohibited	23.0 μs
0	0	1	120/f _{xx}	Setting prohibited	19.2 μs
0	1	0	96/f _{xx}	Setting prohibited	15.4 μs
1	0	0	288/f _{xx}	23.0 μs	46.1 μs
1	0	1	240/f _{xx}	19.2 μs	38.4 μs
1	1	0	192/f _{xx}	15.4 μs	30.7 μs
Other than above			–	Setting prohibited	

EGA1	EGA0	External trigger signal valid edge selection
0	0	No edge detection
0	1	Detection of falling edge
1	0	Detection of rising edge
1	1	Detection of both falling and rising edges

ADCE	Reference voltage circuit control
0	Circuit stopped ^{Note}
1	Circuit operating

Note The reference voltage circuit operates when ADCE is 1.

Cautions 1. Set the A/D conversion time as follows:

When $V_{DD} = 2.7\text{ V to }5.5\text{ V}$: 14 μs or more

When $V_{DD} = 2.0\text{ V to }2.7\text{ V}$: 28 μs or more

When $V_{DD} = 1.9\text{ V to }2.0\text{ V}$: 48 μs or more (flash version only, such as $\mu\text{PD78F4218A}$)

When $V_{DD} = 1.8\text{ V to }2.0\text{ V}$: 48 μs or more (mask version only, such as $\mu\text{PD784218A}$)

2. When overwriting FR0 to FR2 to different data, temporarily end the A/D conversion operations before continuing.

3. If ADCS is set after ADCE is set and the following time has elapsed, the first A/D conversion value can be used.

When $V_{DD} = 2.7\text{ V to }5.5\text{ V}$: 14 μs or more

When $V_{DD} = 2.0\text{ V to }2.7\text{ V}$: 28 μs or more

When $V_{DD} = 1.9\text{ V to }2.0\text{ V}$: 48 μs or more (flash version only, such as $\mu\text{PD78F4218A}$)

When $V_{DD} = 1.8\text{ V to }2.0\text{ V}$: 48 μs or more (mask version only, such as $\mu\text{PD784218A}$)

4. If ADCS is set when ADCE = 0, the first A/D conversion value is undefined.

Remark fxx: Main system clock frequency (fx or fx/2)

fx: Main system clock oscillation frequency

(2) A/D converter input selection register (ADIS)

Used to specify the input ports for analog signals to be A/D converted.

ADIS can be set by a 1-bit or 8-bit memory manipulation instruction.

$\overline{\text{RESET}}$ input sets ADIS to 00H.

Figure 14-3. A/D Converter Input Selection Register (ADIS) Format

Address: 0FF81H After reset: 00H R/W

Symbol	7	6	5	4	3	2	1	0
ADIS	0	0	0	0	0	ADIS2	ADIS1	ADIS0

ADIS2	ADIS1	ADIS0	Analog input channel setting
0	0	0	ANI0
0	0	1	ANI1
0	1	0	ANI2
0	1	1	ANI3
1	0	0	ANI4
1	0	1	ANI5
1	1	0	ANI6
1	1	1	ANI7

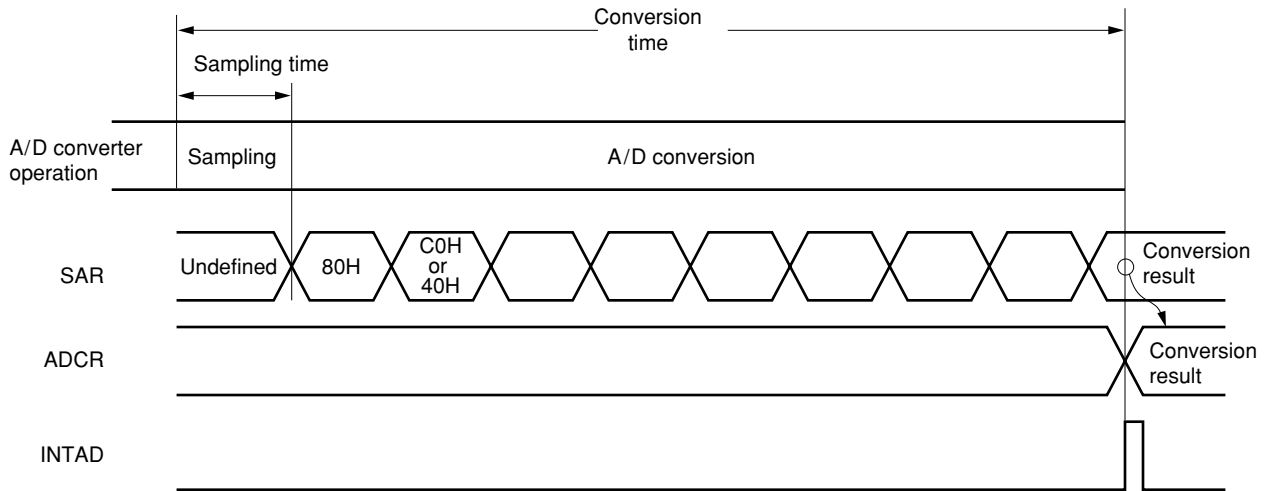
14.4 Operations

14.4.1 Basic operations of A/D converter

- <1> Select one channel for A/D conversion with the A/D converter input selection register (ADIS).
- <2> The voltage input to the selected analog input channel is sampled by the sample & hold circuit.
- <3> After sampling has been performed for a certain time, the sample & hold circuit enters the hold status, and the input analog voltage is held until A/D conversion ends.
- <4> Bit 7 of the successive approximation register (SAR) is set, and the tap selector brings the series resistor string voltage tap to half the AV_{REF0} level.
- <5> The series resistor string voltage tap and the analog input voltage difference are compared by the voltage comparator. If the analog input is equal to or greater than half the AV_{REF0} level, it is set to the MSB of SAR. If the analog input is equal to or smaller than one half the AV_{REF0} level, the MSB is reset.
- <6> Next, bit 6 of SAR is automatically set, and the next comparison is started. The series resistor string voltage tap is selected as shown below according to bit 7 to which a result has already been set.
 - Bit 7 = 1: $(3/4) AV_{REF0}$
 - Bit 7 = 0: $(1/4) AV_{REF0}$The voltage tap and analog input voltage are compared, and bit 6 of SAR is manipulated according to the result, as follows.
 - Analog input voltage \geq Voltage tap: Bit 6 = 1
 - Analog input voltage $<$ Voltage tap: Bit 6 = 0
- <7> Comparisons of this kind are repeated until bit 0 of SAR.
- <8> When comparison of all eight bits is completed, the valid digital result remains in SAR, and this value is transferred to the A/D conversion result register (ADCR) and latched.
At the same time, it is possible to have an A/D conversion end interrupt request (INTAD) issued.

Caution The value of the first A/D conversion is undefined if ADCS is set when bit 0 (ADCE) of the A/D converter mode register (ADM) is 0.

Figure 14-4. Basic Operations of A/D Converter



A/D conversion is performed continuously until ADM bit 7 (ADCS) is reset to 0 by software.

If a write operation to ADM or ADIS is performed during A/D conversion, the conversion operation is reset and conversion restarts from the beginning if the ADCS bit is set to 1.

RESET input makes ADCR undefined.

If bit 0 (ADCE) of the A/D converter mode register is not set to 1, the value of the first A/D conversion is undefined immediately after A/D conversion starts. Poll the A/D conversion end interrupt request (INTAD) and take measures such as discarding the first A/D conversion result.

14.4.2 Input voltage and conversion result

The relationship between the analog input voltage input to the analog input pins (ANI0 to ANI7) and the A/D conversion result (value saved in A/D conversion result register (ADCR)) is expressed by the following equation.

$$ADCR = \text{INT} \left(\frac{V_{IN}}{AV_{REF0}} \times 256 + 0.5 \right)$$

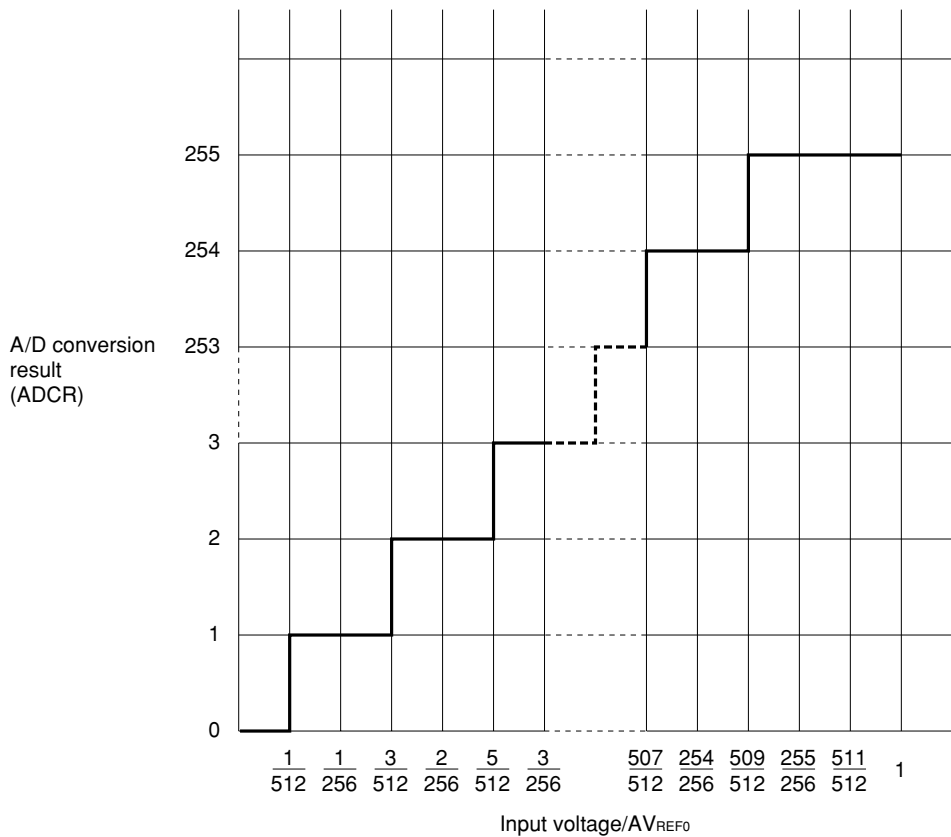
or

$$(ADCR - 0.5) \times \frac{AV_{REF0}}{256} \leq V_{IN} < (ADCR + 0.5) \times \frac{AV_{REF0}}{256}$$

Remark INT(): Function returning the integer portion of the value in parentheses
 V_{IN}: Analog input voltage
 AV_{REF0}: AV_{REF0} pin voltage
 ADCR: A/D conversion result register (ADCR) value

Figure 14-5 shows the relationship between analog input voltage and the A/D conversion result.

Figure 14-5. Relationship Between Analog Input Voltage and A/D Conversion Result



14.4.3 Operation mode of A/D converter

One channel is selected from ANI0 to ANI7 by the A/D converter input selection register (ADIS) and start the A/D conversion.

A/D conversion can be started in the following two ways.

- Hardware start: Conversion start by trigger input (P03)
- Software start: Conversion start by setting ADM

The A/D conversion result is saved in the A/D conversion result register (ADCR), and an interrupt request signal (INTAD) is issued at the same time.

(1) A/D conversion operation by hardware start

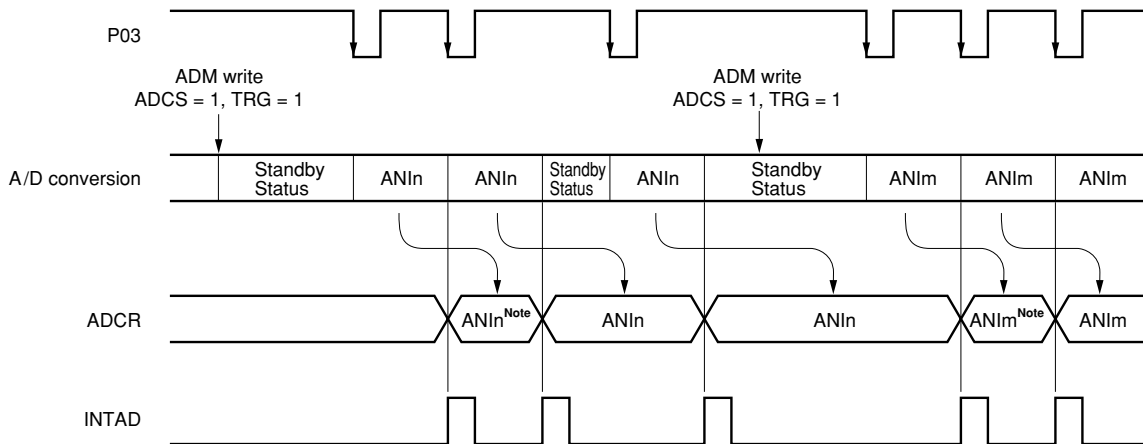
The A/D conversion operation can be made to enter the standby status by setting “1” to bit 6 (TRG) and bit 7 (ADCS) of the A/D converter mode register (ADM). When an external trigger signal (P03) is input, conversion of the voltage applied to the analog input pin set with ADIS begins.

When the A/D conversion ends, the conversion result is saved in the A/D conversion result register (ADCR), and an interrupt request signal (INTAD) is issued. When the A/D conversion operation that was started completes the first A/D conversion, no other A/D conversion operation is started unless an external trigger signal is input. When ADCS is rewritten during the operation of A/D conversion, that operation is interrupted and waits until an external trigger signal is input. When the external trigger signal is input again, the A/D conversion is performed from the beginning. When ADCS is rewritten during the standby for A/D conversion, the operation of A/D conversion starts at the time when the next external trigger input signal is input.

If, during A/D conversion, data that ADCS is 0 is written to ADM, A/D conversion is immediately stopped.

Caution When P03/INTP3 is used as the external trigger input (P03), specify a valid edge with bits 1 and 2 (EGA0 and EGA1) of the A/D converter mode register (ADM) and set 1 to the interrupt mask flag (PMK3).

Figure 14-6. A/D Conversion Operation by Hardware Start (with Falling Edge Specified)



Note If bit 0 (ADCE) of the A/D converter mode register is not set to 1, the value of the first A/D conversion is undefined immediately after A/D conversion starts. Poll the A/D conversion end interrupt request (INTAD) and take measures such as discarding the first A/D conversion result.

Remark n = 0, 1, , 7
m = 0, 1, , 7

(2) A/D conversion operation by software start

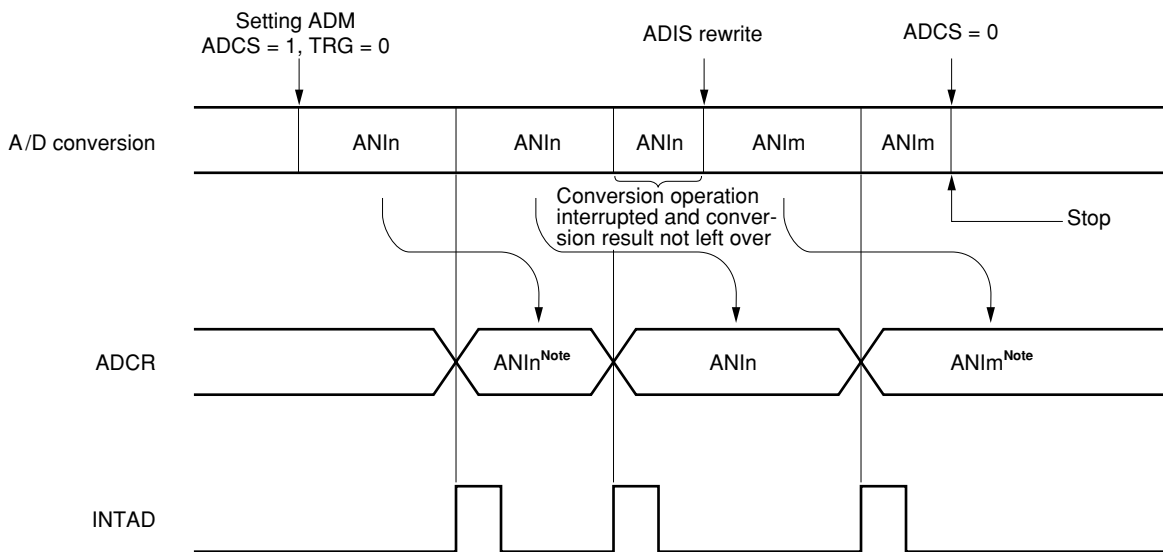
A/D conversion of the voltage applied to the analog input pin specified with ADIS is started by setting “0” to bit 6 (TRG) and “1” to bit 7 (ADCS) of the A/D converter mode register (ADM).

When A/D conversion ends, the conversion result is saved in the A/D conversion result register (ADCR), and an interrupt request signal (INTAD) is issued. When an A/D conversion operation that was started completes the first A/D conversion, the next A/D conversion starts immediately. A/D conversion operations are performed continuously until new data is written to ADM.

If, during A/D conversion, ADCS is rewritten, the A/D conversion operation being performed at that time is interrupted, and A/D conversion of the newly selected analog input channels starts.

If, during A/D conversion, data where ADCS is 0 is written to ADM, the A/D conversion operation is immediately stopped.

Figure 14-7. A/D Conversion Operation by Software Start



Note If bit 0 (ADCE) of the A/D converter mode register is not set to 1, the value of the first A/D conversion is undefined immediately after A/D conversion starts. Poll the A/D conversion end interrupt request (INTAD) and take measures such as discarding the first A/D conversion result.

Remark n = 0, 1, , 7
 m = 0, 1, , 7

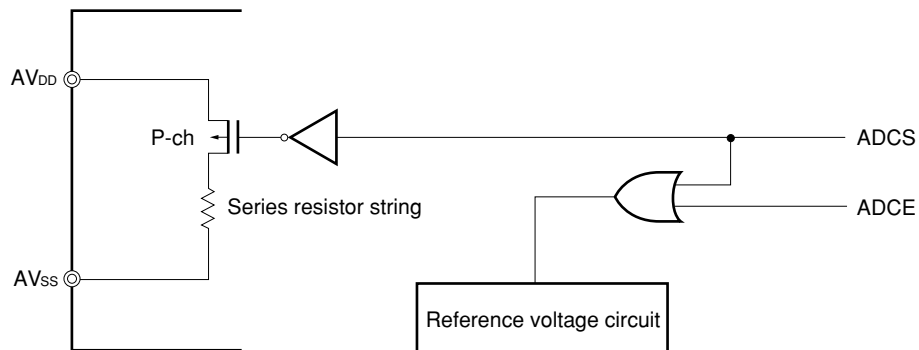
14.5 Cautions

(1) Current consumption standby mode

The A/D converter operation is stopped during the standby mode. At this time, the current consumption can be reduced by setting bit 7 (ADCS) of the A/D converter mode register (ADM) to 0 or by stopping the reference voltage circuit (bit of ADM (ADCE) = 0).

The method to reduce the current consumption in the standby mode is shown in Figure 14-8.

Figure 14-8. Method to Reduce Current Consumption in Standby Mode



(2) ANI0 to ANI7 input range

Use ANI0 to ANI7 input voltages within the rated voltage range. Inputting a voltage equal to or greater than AV_{REF0} , or equal to or smaller than AV_{SS} (even if within the absolute maximum rated range) will cause the channel's conversion values to become undefined, or may affect the conversion values of other channels.

(3) Contention operation

<1> Contention with ADCR read due to contention between A/D conversion result register (ADCR) write and instruction at conversion end

The read operation to ADCR is prioritized. After the read operation, a new conversion result is written to ADCR.

<2> Contention between ADCR write and external trigger signal input at conversion end

External trigger signals cannot be received during A/D conversion. Therefore, external trigger signals during ADCR write operation are not received.

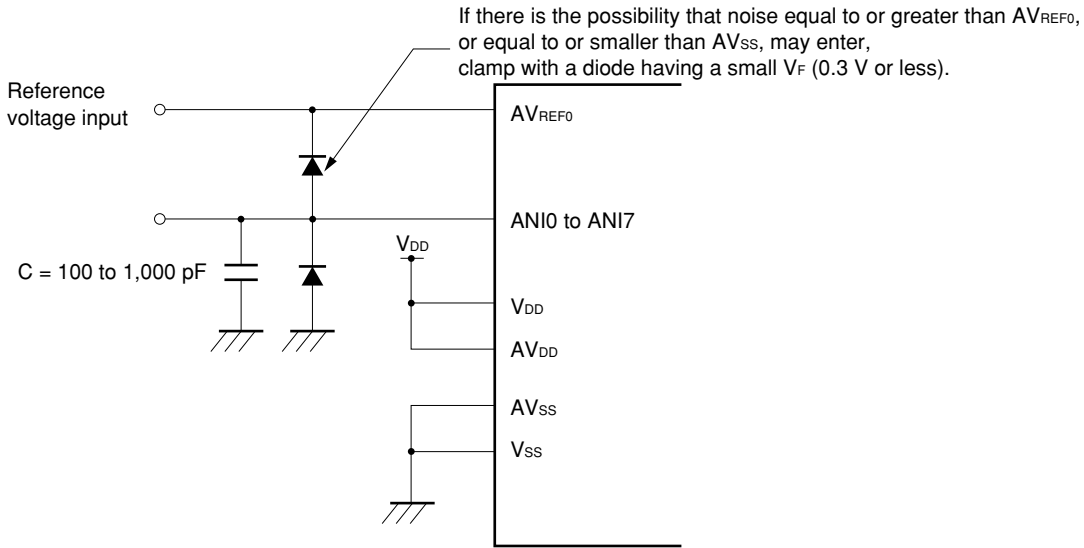
<3> Contention between ADCR write and A/D converter mode register (ADM) write, or between A/D converter input selection register (ADIS) write at conversion end

The write operation to ADM or ADIS is prioritized. Write to ADCR is not performed. Moreover, no interrupt signal (INTAD) is issued at conversion end.

(4) Anti-noise measures

Attention must be paid to noise fed to AV_{REF0} and ANI0 to ANI7 to preserve the 8-bit resolution. The influence of noise grows proportionally to the output impedance of the analog input source. Therefore, it is recommended to connect C externally, as shown in Figure 14-9.

Figure 14-9. Handling of Analog Input Pin



(5) ANI0/P10 to ANI7/P17

The analog input pins (ANI0 to ANI7) can also be used as an input port pin (P10 to P17). If any of ANI0 to ANI7 is selected and A/D conversion is performed, do not execute input instructions to PORT1 during conversion. This would result in a lowered resolution. Moreover, if a digital pulse is applied to pins adjacent to the pin for which A/D conversion is being performed, the A/D conversion value will not be obtained as expected because of coupling noise. Therefore, do not apply a pulse to pins adjacent to the pin for which A/D conversion is being performed.

(6) Input impedance of AV_{REF0} pin

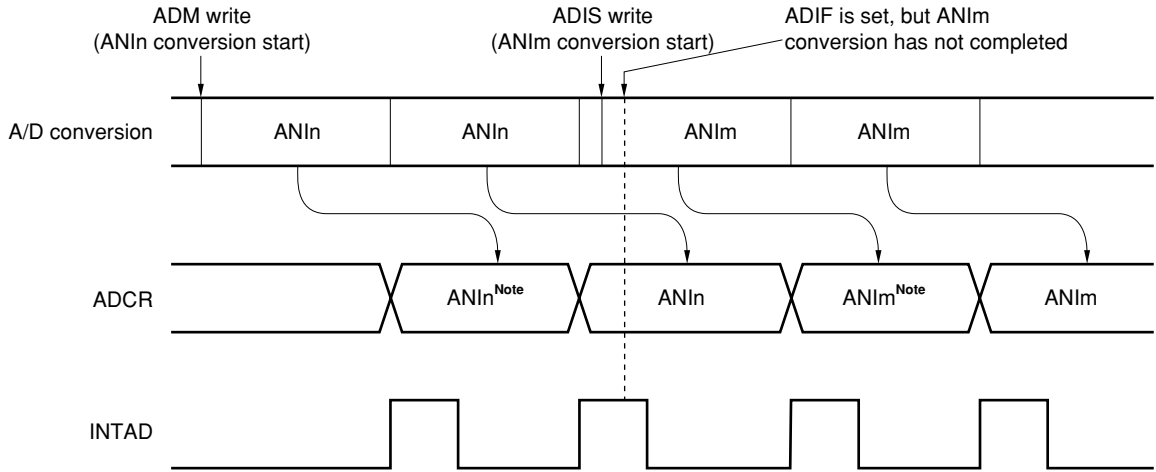
A series resistor string of approximately 46 k Ω is connected between the AV_{REF0} and AV_{SS} pins. Therefore, if the output impedance of the reference voltage source is high, connecting in parallel a series resistor string between the AV_{REF0} and AV_{SS} pins will result in a large reference voltage error.

(7) Interrupt request flag (ADIF)

The interrupt request flag (ADIF) is not cleared even if the A/D converter input select register (ADIS) is changed. Therefore, if the analog input pin is changed during A/D conversion, the A/D conversion result for the analog input immediately preceding the write operation to ADIS, and ADIF may be set. Also, if ADIF is read immediately after ADIS is written to, ADIF may be set even if A/D conversion for the analog input following the write operation to ADIS is not completed. These facts should be kept in mind.

Moreover, if A/D conversion is stopped once and then resumed, clear ADIF before resuming conversion.

Figure 14-10. A/D Conversion End Interrupt Generation Timing



Note If bit 0 (ADCE) of the A/D converter mode register is not set to 1, the value of the first A/D conversion is undefined immediately after A/D conversion starts. Poll the A/D conversion end interrupt request (INTAD) and take measures such as discarding the first A/D conversion result.

Remark n = 0, 1, ..., 7
m = 0, 1, ..., 7

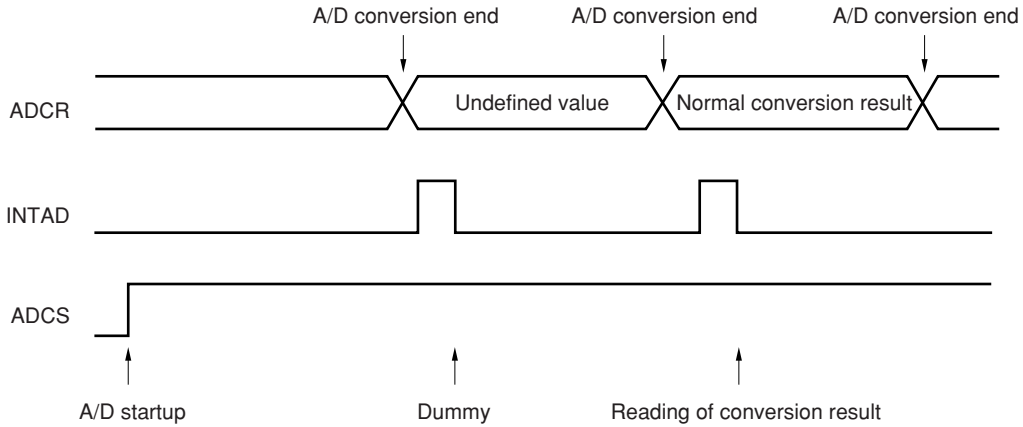
(8) Bit 0 (ADCE) of A/D converter mode register (ADM)

Setting ADCE to 1 allows the value of the first A/D conversion immediately after A/D conversion operation start to be used.

(9) Conversion results immediately after A/D conversion is started

If bit 7 (ADCS0) of the A/D converter mode register (ADM) is set to 1 without setting bit 0 (ADCE) to 1, the value of the first A/D conversion is undefined immediately after the A/D conversion operation starts. Poll the A/D conversion end interrupt request (INTAD) and take measures such as discarding the first conversion result.

Figure 14-11. Conversion Results Immediately After A/D Conversion Is Started



(10) Reading A/D conversion result register (ADCR)

If the conversion result register (ADCR) is read after stopping the A/D conversion operation, the conversion result may be undefined. Therefore, be sure to read ADCR before stopping operation of the A/D converter.

(11) Timing that makes the A/D conversion result undefined

If the timing of the end of A/D conversion and the timing of the stop of operation of the A/C converter conflict, the A/D conversion value may be undefined. Because of this, be sure to read the A/D conversion result while the A/D converter is in operation. Furthermore, when reading an A/D conversion result after the A/D converter operation has stopped, be sure to have done so by the time the next conversion result is complete. The conversion result read timing is shown in Figures 14-12 and 14-13 below.

Figure 14-12. Conversion Result Read Timing (When Conversion Result Is Undefined)

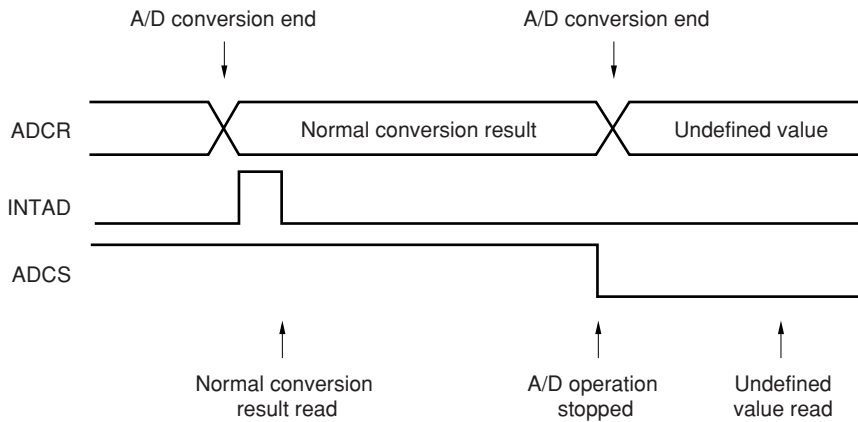
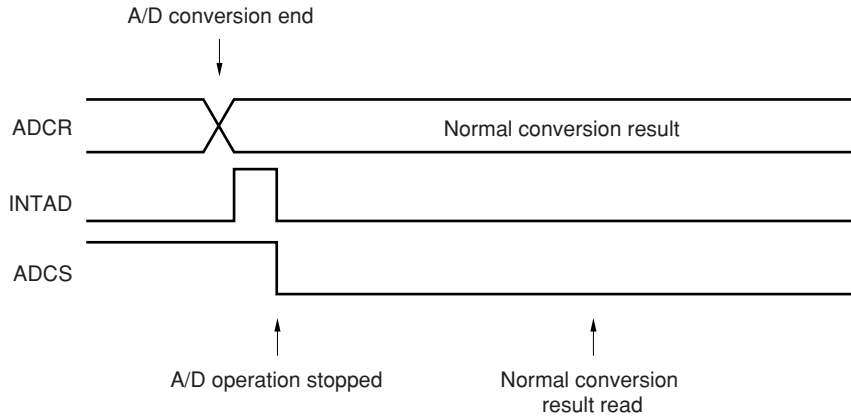


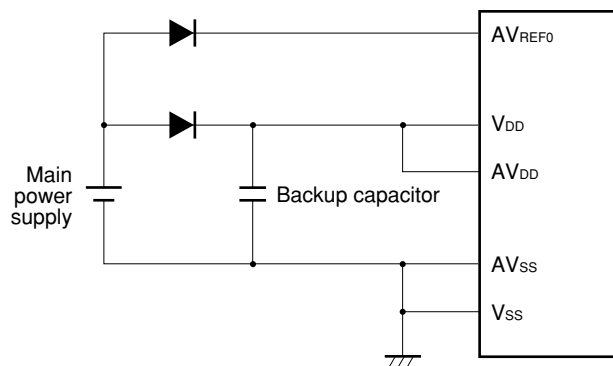
Figure 14-13. Conversion Result Read Timing (When Conversion Result Is Normal)**(12) Cautions on board design**

In order to avoid negative effects from digital circuit noise on the board, analog circuits must be placed as far away as possible from digital circuits. It is particularly important to prevent analog and digital signal lines from crossing or coming into close proximity, as A/D conversion characteristics are vulnerable to degradation from the induction of noise or other such factors.

(13) AV_{DD} pin

The AV_{DD} pin is the power supply pin of the analog circuit, and also supplies power to the ANI0/P10 to ANI7/P17 input circuits.

Therefore, be sure to apply the same electric potential level as V_{DD} as shown in Figure 14-14, even in applications that can be switched to a backup power supply.

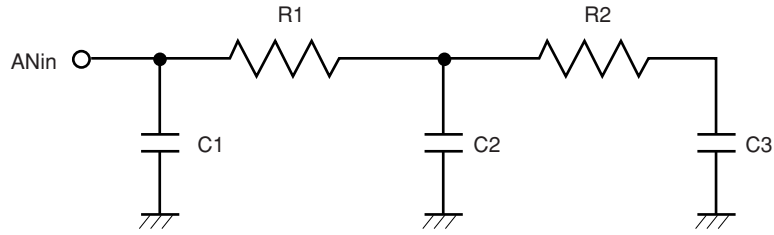
Figure 14-14. Handling of AV_{DD} Pin**(14) Internal equivalence circuit and allowable signal source impedance of ANI0 to ANI7**

In order to complete sampling within the sampling time and obtain a high enough A/D conversion accuracy, it is necessary to sufficiently reduce the impedance of the sensor and other signal sources. Figure 14-15 shows the internal equivalence circuit of the ANI0 to ANI7 pins in the microcontroller.

If the impedance of the signal source is high, it can be made to seem smaller by connecting a large capacitance to the ANI0 to ANI7 pins. A circuit example is shown in Figure 14-16. In this case, because a low pass filter is configured in the circuit, impedance will no longer be able to follow analog signals with large differential coefficients.

When converting high-speed analog signals or performing conversion in scan mode, be sure to insert a low-impedance buffer.

Figure 14-15. Internal Equivalence Circuit of ANI0 to ANI7 Pins



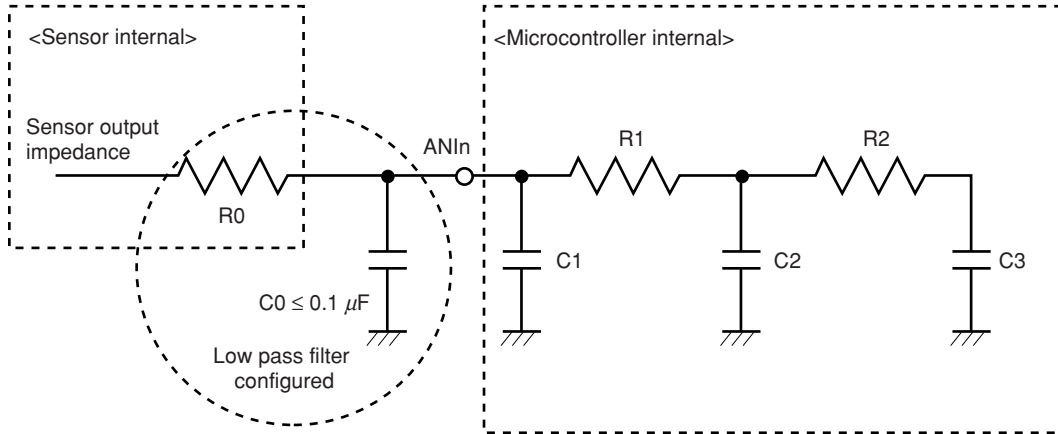
Remark n = 0 to 7

Table 14-2. Resistance and Capacitance Values for Equivalent Circuits (Reference Values)

V _{DD0}	R1	R2	C1	C2	C3
1.8 V	75 kΩ	30 kΩ	3 pF	4 pF	2 pF
2.7 V	12 kΩ	8 kΩ	3 pF	3 pF	2 pF
4.5 V	3 kΩ	2.7 kΩ	3 pF	1.4 pF	2 pF

Caution The resistance and capacitance values in Table 14-2 cannot be guaranteed.

Figure 14-16. Example of Circuit When Signal Source Impedance Is High



Remark n = 0 to 7

CHAPTER 15 D/A CONVERTER

15.1 Function

The D/A converter converts the digital input into analog values and consists of two channels of voltage output D/A converters with 8-bit resolution.

The conversion method is a R-2R resistor ladder.

Set DACE0 of D/A converter mode register 0 (DAM0) and DACE1 of D/A converter mode register 1 (DAM1) to start the D/A conversion.

The D/A converter has the following two modes.

(1) Normal mode

After D/A conversion, the analog voltage is immediately output.

(2) Real-time output mode

After D/A conversion, the analog voltage is output synchronized to the output trigger.

Since a sine wave is created when this mode is used, MSK modems can be easily incorporated into cordless phones.

Caution If only one channel of the D/A converter is used when $AV_{REF1} < V_{DD}$, make either of the following setting at pins that are not used for analog output.

- Set the port mode register (PM13 \times) to 1 (input mode) and connect to V_{SS} .
- Set the port mode register (PM13 \times) to 0 (output mode) and the output latch to 0, and output a low level.

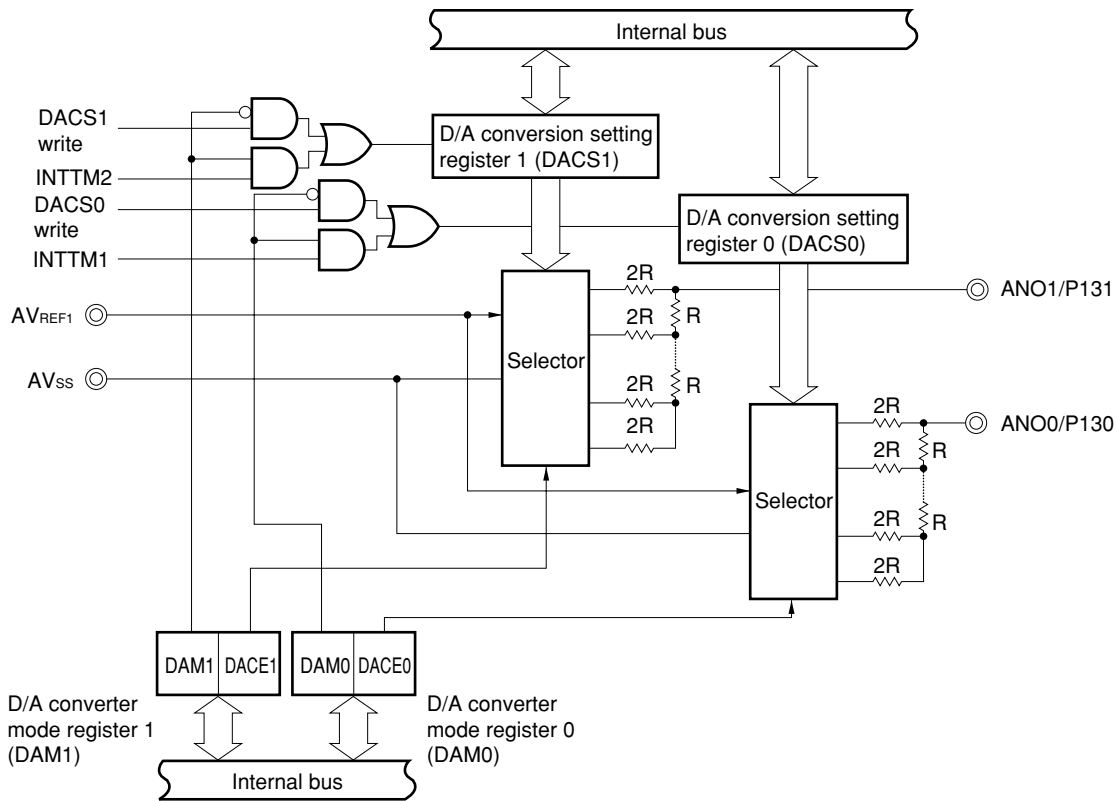
15.2 Configuration

The D/A converter has the following hardware.

Table 15-1. D/A Converter Configuration

Item	Configuration
Registers	D/A conversion setting register 0 (DACS0) D/A conversion setting register 1 (DACS1)
Control registers	D/A converter mode register 0 (DAM0) D/A converter mode register 1 (DAM1)

Figure 15-1. D/A Converter Block Diagram



(1) D/A conversion setting registers 0, 1 (DACS0, DACS1)

The DACS0 and DACS1 registers set the analog voltages that are output to the ANO0 and ANO1 pins, respectively.

DACS0 and DACS1 are set by 8-bit memory manipulation instructions.

$\overline{\text{RESET}}$ input sets DACS0 and DACS1 to 00H.

The analog voltages output by the ANO0 and ANO1 pins are determined by the following equation.

$$\text{ANO}n \text{ output voltage} = \text{AV}_{\text{REF1}} \times \frac{\text{DACS}n}{256}$$

n = 0, 1

- Cautions**
1. In the real-time output mode, when the data set in DACS0 and DACS1 are read before the output trigger is generated, the set data is not read and the previous data is read.
 2. In the real-time output mode, set the data of DACS0 and DACS1 until the next output trigger is generated after the output trigger is generated.

15.3 Control Registers

- **D/A converter mode registers 0, 1 (DAM0, DAM1)**

D/A converters are controlled by D/A converter mode registers 0, 1 (DAM0, DAM1). These registers enable or stop the operation of the D/A converters.

DAM0 and DAM1 are set by a 1-bit and 8-bit memory manipulation instruction.

$\overline{\text{RESET}}$ input sets DAM0 and DAM1 to 00H.

Figure 15-2. D/A Converter Mode Registers 0, 1 (DAM0, DAM1) Formats

Address: 0FF86H, 0FF87H After reset: 00H R/W

Symbol	7	6	5	4	3	2	1	<0>
DAMn	0	0	0	0	0	0	DAMn	DACEn

DAMn	D/A converter channel n operating mode
0	Normal mode
1	Real-time output mode

DACEn	D/A converter channel n control
0	Stop conversion
1	Enable conversion

- Cautions**
1. When the D/A converters are used, set the shared port pins to the input mode and disconnect the pull-up resistors.
 2. Always set bits 2 to 7 to 0.
 3. The output when the D/A converter operation has stopped enters high impedance state.
 4. The output triggers in the real-time output mode are INTTM1 in channel 0 and INTTM2 in channel 1.

Remark n = 0, 1

15.4 Operation

- <1> Select the operating mode in channel 0 in DAM0 of D/A converter mode register 0 (DAM0) and the operating mode of the channel 1 in DAM1 of D/A converter mode register 1 (DAM1).
- <2> Set the data that corresponds to the analog voltages that are output to pins ANO0/P130 and ANO1/P131 of D/A conversion setting registers 0 and 1 (DACS0, DACS1).
- <3> Set DACE0 of DAM0 and DACE1 of DAM1 to start D/A conversion in channels 0 and 1.
- <4> After D/A conversion in the normal mode, the analog voltages at pins ANO0/P130 and ANO1/P131 are immediately output. In the real-time output mode, the analog voltage is output synchronized to the output trigger.
- <5> In the normal mode, the output analog voltages are maintained until new data are set in DACS0 and DACS1. In the real-time output mode, after new data are set in DACS0 and DACS1, they are held until the next output trigger is generated.

Caution Set DACE0 and DACE1 after data are set in DACS0 and DACS1.

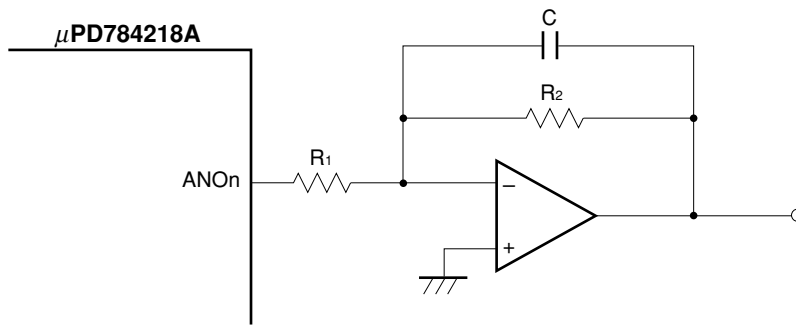
15.5 Cautions

(1) Output impedances of the D/A converters

Since the output impedances of the D/A converters are high, the current cannot be taken from the ANOn pin (n = 0,1). If the input impedance of the load is low, insert a buffer amp between the load and the ANOn pin. In addition, use the shortest possible wire from the buffer amp or load (to increase the output impedance). If the wire is long, surround it with a ground pattern.

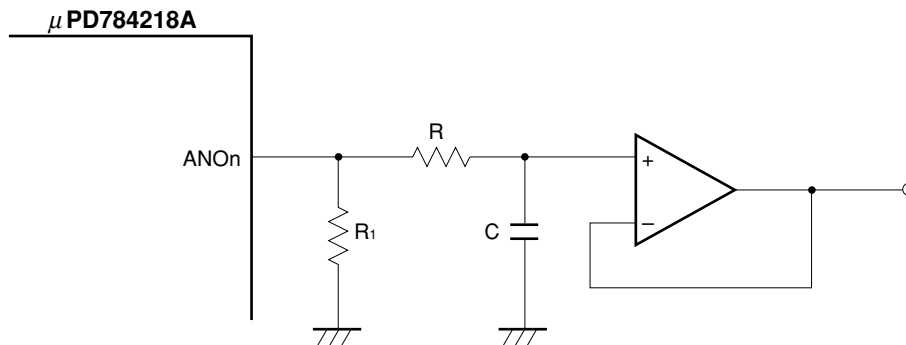
Figure 15-3. Buffer Amp Insertion Example

(a) Inverting Amp



- The input impedance of the buffer amp is R_1 .

(b) Voltage follower



- The input impedance of the buffer amp is R_1 .
- If there is no R_1 and RESET is low, the output is undefined.

(2) Output voltages of the D/A converters

Since the output voltages of the D/A converters change in stages, use the signals output from the D/A converters after passing them through low-pass filters.

(3) AV_{REF1} pin

When $AV_{REF1} < V_{DD}$ and the D/A converter is used in only one channel, handle the pins that are not used for analog output in either of the following ways.

- Set the port mode register (PM13 \times) to 1 (input mode) and connect to V_{SS} .
- Set the port mode register (PM13 \times) to 0 (output mode), set the output latch to 0, and output a low level.

CHAPTER 16 SERIAL INTERFACE OVERVIEW

The μ PD784218A Subseries has a serial interface with three independent channels. Therefore, communication outside and within the system can be simultaneous on the three channels.

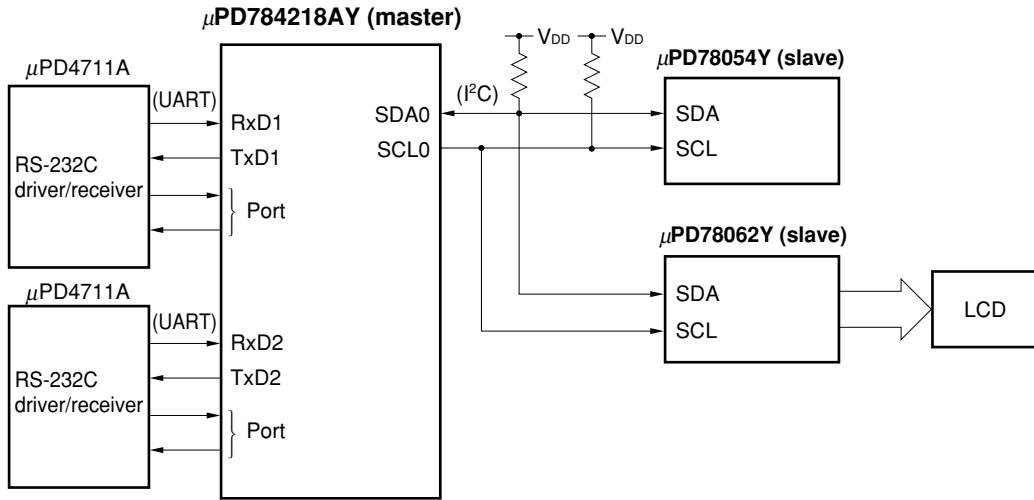
- Asynchronous serial interface (UART)/3-wire serial I/O (IOE) \times 2 channels
→ See **CHAPTER 17**.

- Clock-synchronized serial interface (CSI) \times 1 channel
 - 3-wire serial I/O mode (MSB first)
→ See **CHAPTER 18**.

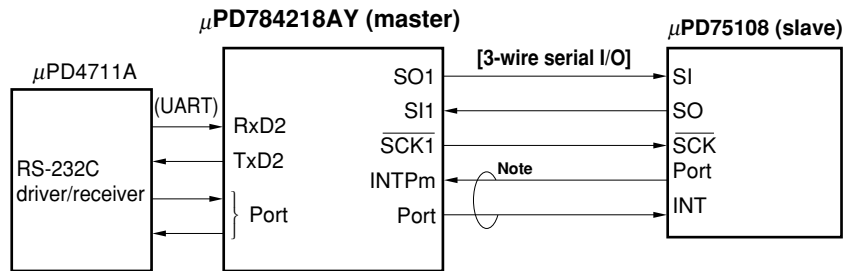
 - I²C bus mode (multimaster compatible) (only in the μ PD784216AY, 784218AY Subseries)
→ See **CHAPTER 19**.

Figure 16-1. Serial Interface Example

(a) UART + I²C



(b) UART + 3-wire serial I/O



Note Handshake lines

CHAPTER 17 ASYNCHRONOUS SERIAL INTERFACE/3-WIRE SERIAL I/O

The μ PD784218A provides on-chip two serial interface channels for which the asynchronous serial interface (UART) mode and the 3-wire serial I/O (IOE) mode can be selected.

These two serial interface channels have exactly the same functions.

Table 17-1. Designation Differences Between UART1/IOE1 and UART2/IOE2

Item	UART1/IOE1	UART2/IOE2
Pin name	P22/ASCK1/ $\overline{\text{SCK1}}$, P20/RxD1/SI1, P21/TxD1/SO2	P72/ASCK2/ $\overline{\text{SCK2}}$, P70/RxD2/SI2, P71/TxD2/SO2
Asynchronous serial interface mode register	ASIM1	ASIM2
Name of bits inside asynchronous serial interface mode register	TXE1, RXE1, PS11, PS10, CL1, SL1, ISRM1, IRDAM1	TXE2, RXE2, PS21, PS20, CL2, SL2, ISRM2, IRDAM2
Asynchronous serial interface status register	ASIS1	ASIS2
Name of bits inside asynchronous serial interface status register	PE1, FE1, OVE1	PE2, FE2, OVE2
Serial operation mode register	CSIM1	CSIM2
Name of bits inside serial operation mode register	CSIE1, MODE1, SCL11, SCL10	CSIE2, MODE2, SCL21, SCL20
Baud rate generator control register	BRGC1	BRGC2
Name of bits inside baud rate generator control register	TPS10 to TPS12, MDL10 to MDL13	TPS20 to TPS22, MDL20 to MDL23
Interrupt request name	INTSR1/INTCSI1, INTSER1, INTST1	INTSR2/INTCSI2, INTSER2, INTST2
Interrupt control register and name of bits used in this chapter	SRIC1, SERIC1, STIC1, SRIF1, SERIF1, STIF1	SRIC2, SERIC2, STIC2, SRIF2, SERIF2, STIF2

17.1 Switching Between Asynchronous Serial Interface Mode and 3-Wire Serial I/O Mode

The asynchronous serial interface mode and the 3-wire serial I/O mode cannot be used at the same time. Both these modes can be switched by setting the asynchronous serial interface mode registers (ASIM1, ASIM2) and the serial operation mode registers (CSIM1, CSIM2), as shown in Figure 17-1 below.

Figure 17-1. Switching Asynchronous Serial Interface Mode and 3-Wire Serial I/O Mode

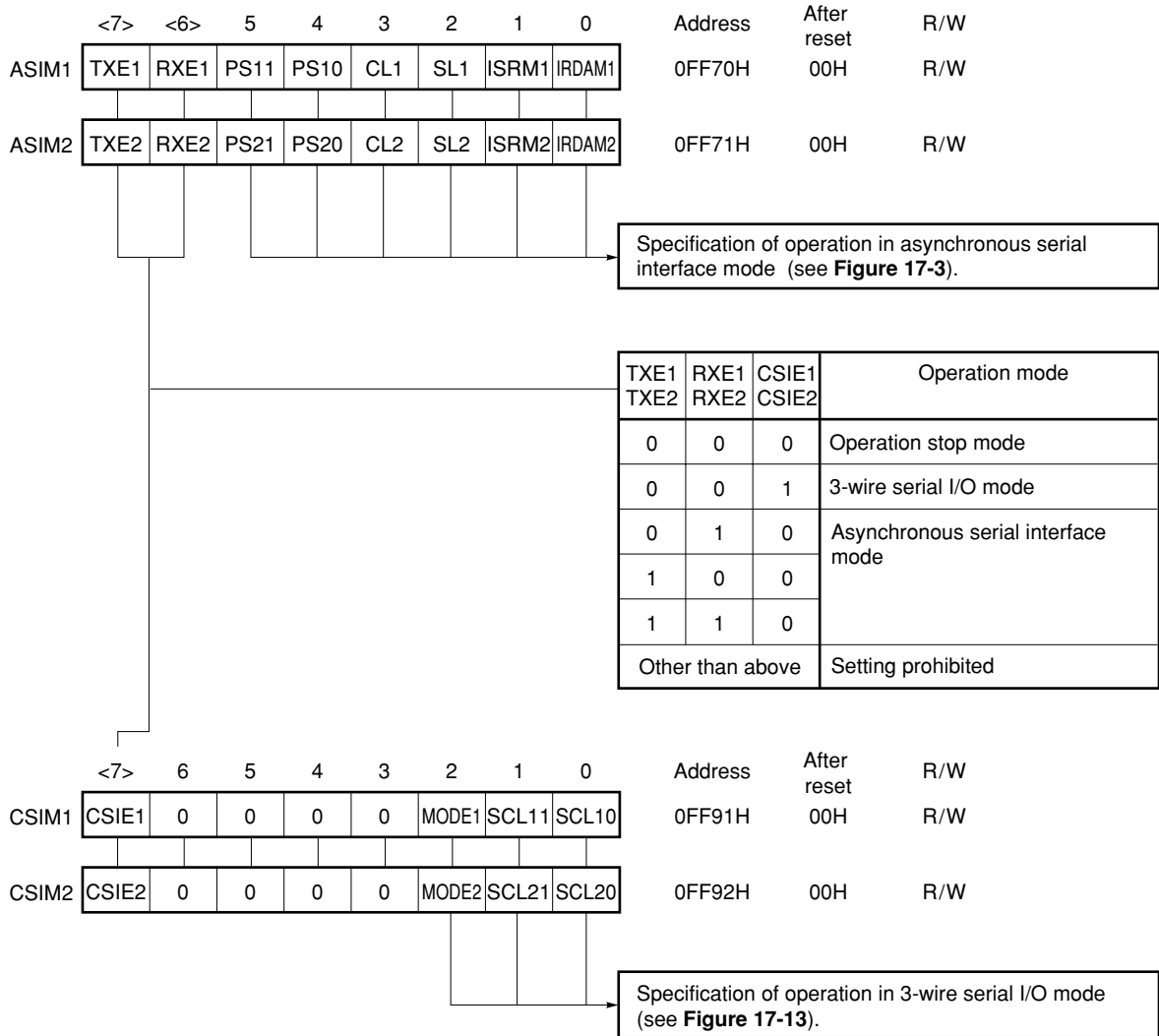


Table 17-2. Serial Interface Operation Mode Settings

(1) Operation stopped mode

ASIMn		CSIMn			PM20	P20	PM21	P21	PM22	P22	First Bit	Shift Clock	P20/RxD1/SI1	P21/TxD1/SO1	P22/ASCK1/SCK1
TXEn	RXEn	CSIEn	SCLn1	SCLn0	PM70	P70	PM71	P71	PM72	P72			P70/RxD2/SI2 Pin Function	P71/TxD2/SO2 Pin Function	P72/ASCK2/SCK2 Pin Function
0	0	0	×	×	×	×	×	×	×	×	–	–	P20 P70	P21 P71	P22 P72
Other than above											Setting prohibited				

(2) Asynchronous serial interface mode

ASIMn		CSIMn			PM20	P20	PM21	P21	PM22	P22	First Bit	Shift Clock	P20/RxD1/SI1	P21/TxD1/SO1	P22/ASCK1/SCK1
TXEn	RXEn	CSIEn	SCLn1	SCLn0	PM70	P70	PM71	P71	PM72	P72			P70/RxD2/SI2 Pin Function	P71/TxD2/SO2 Pin Function	P72/ASCK2/SCK2 Pin Function
1	0	0	×	×	×	×	0	0	1	×	LSB	External clock	P20 P70	TxDn (CMOS output)	ASCKn input
									×	×					P22 P72
0	1				1	×	×	×	1	×	External clock	Internal clock	RxDn	P21 P71	ASCKn input
									×	×					P22 P72
1	1						0	0	1	×	External clock	Internal clock	TxDn (CMOS output)		ASCKn input
									×	×					P22 P72
Other than above											Setting prohibited				

(3) 3-wire serial I/O mode

ASIMn		CSIMn			PM20	P20	PM21	P21	PM22	P22	First Bit	Shift Clock	P20/RxD1/SI1	P21/TxD1/SO1	P22/ASCK1/SCK1
TXEn	RXEn	CSIEn	SCLn1	SCLn0	PM70	P70	PM71	P71	PM72	P72			P70/RxD2/SI2 Pin Function	P71/TxD2/SO2 Pin Function	P72/ASCK2/SCK2 Pin Function
0	0	1	0	0	1	×	0	0	1	×	MSB	External clock	SIn	SON (CMOS output)	SCKn input
									0	0					SCKn output
Other than above											Setting prohibited				

- Notes**
1. These pins can be used for port functions.
 2. Refer to asynchronous serial interface mode (c) transmission.
 3. When only transmission is used, these pins can be used as P20, P70 (CMOS input/output).
 4. Refer to serial operation mode registers 1, 2 (CSIM1, CSIM2).

Remark ×: don't care
n = 1, 2

17.2 Asynchronous Serial Interface Mode

The asynchronous serial interface (UART: Universal Asynchronous Receiver Transmitter) offers the following three modes.

(1) Operation stop mode

This mode is used when serial transfer is not performed to reduce the power consumption.

(2) Asynchronous serial interface (UART) mode

This mode is used to send and receive 1-byte data that follows the start bit, and supports full-duplex transmission. A UART-dedicated baud rate generator is provided on-chip, enabling transmission at any baud rate within a broad range. The baud rate can also be defined by dividing the input clock to the ASCK pin.

The MIDI specification baud rate (31.25 kbps) can be used by utilizing the UART-dedicated baud rate generator.

(3) Infrared data transfer mode

17.2.1 Configuration

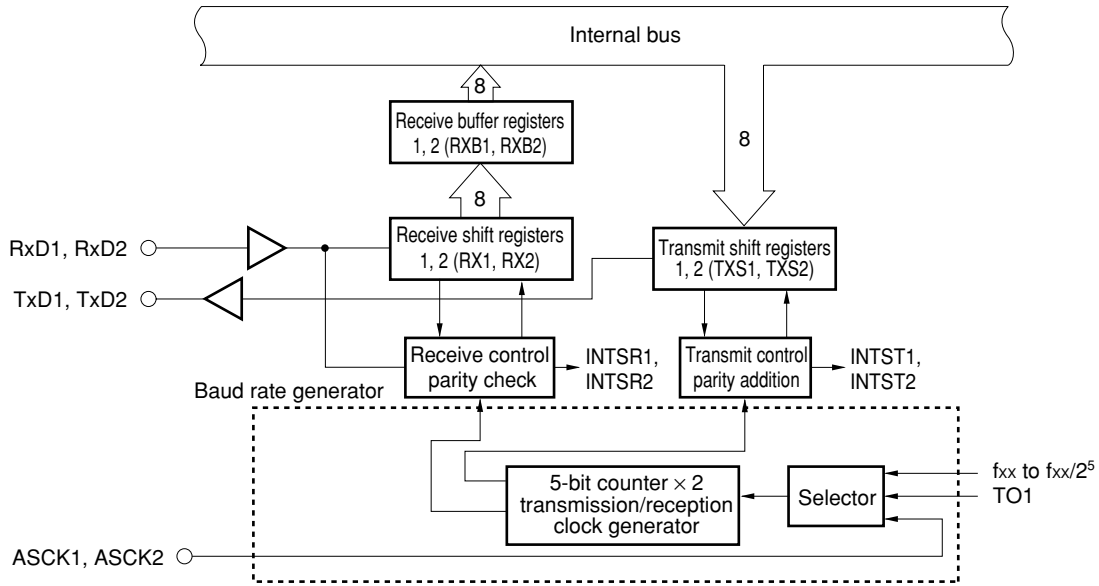
The asynchronous serial interface has the following hardware configuration.

Figure 17-2 gives the block diagram of the asynchronous serial interface.

Table 17-3. Asynchronous Serial Interface Configuration

Item	Configuration
Registers	Transmit shift registers (TXS1, TXS2) Receive shift registers (RX1, RX2) Receive buffer registers (RXB1, RXB2)
Control registers	Asynchronous serial interface mode registers (ASIM1, ASIM2) Asynchronous serial interface status registers (ASIS1, ASIS2) Baud rate generator control registers (BRGC1, BRGC2)

Figure 17-2. Block Diagram in Asynchronous Serial Interface Mode



(1) Transmit shift registers (TXS1, TXS2)

These registers are used to set transmit data. Data written to TXS1 and TXS2 is sent as serial data.

If a data length of 7 bits is specified, bits 0 to 6 of the data written to TXS1 and TXS2 are transferred as transmit data. Transmission is started by writing data to TXS1 and TXS2.

TXS1 and TXS2 can be written with an 8-bit memory manipulation instruction, but cannot be read.

$\overline{\text{RESET}}$ input sets TXS1 and TXS2 to FFH.

Caution Do not write to TXS1 and TXS2 during transmission.

TXS1, TXS2, and receive buffer registers (RXB1, RXB2) are allocated to the same address. Therefore, attempting to read TXS1 and TXS2 will result in reading the values of RXB1 and RXB2.

(2) Receive shift registers (RX1, RX2)

These registers are used to convert serial data input to the RxD1 and RxD2 pins to parallel data. Receive data is transferred to the receive buffer register (RXB1, RSB2) one byte at a time as it is received.

RX1 and RX2 cannot be directly manipulated by program.

(3) Receive buffer registers (RXB1, RXB2)

These registers are used to hold receive data. Each time one byte of data is received, new receive data is transferred from the receive shift registers (RX1, RX2).

If a data length of 7 bits is specified, receive data is transferred to bits 0 to 6 of RXB1 and RXB2, and the MSB of RXB1 and RXB2 always becomes 0.

RXB1 and RXB2 can be read by an 8-bit memory manipulation instruction, but cannot be written.

$\overline{\text{RESET}}$ input sets RXB1 and RXB2 to FFH.

Caution RXB1, RXB2, and transmit shift registers (TXS1, TXS2) are allocated to the same address.

Therefore, attempting to write to RXB1 and RXB2 will result in writing the values to TXS1 and TXS2.

(4) Transmission control circuit

This circuit controls transmit operations such as the addition of a start bit, parity bit, and stop bit(s) to data written to the transmit shift registers (TXS1, TXS2), according to the contents set to the asynchronous serial interface mode registers (ASIM1, ASIM2).

(5) Reception control circuit

This circuit controls reception according to the contents set to the asynchronous serial interface mode registers (ASIM1, ASIM2). It also performs error check for parity errors, etc., during reception. If it detects an error, it sets a value corresponding to the nature of the error in the asynchronous serial interface status registers (ASIS1, ASIS2).

17.2.2 Control registers

The asynchronous serial interface controls the following six types of registers.

- Asynchronous serial interface mode registers 1, 2 (ASIM1, ASIM2)
- Asynchronous serial interface status registers 1, 2 (ASIS1, ASIS2)
- Baud rate generator control registers 1, 2 (BRGC1, BRGC2)

(1) Asynchronous serial interface mode registers 1, 2 (ASIM1, ASIM2)

ASIM1 and ASIM2 are 8-bit registers that control serial transfer using the asynchronous serial interface.

ASIM1 and ASIM2 are set by a 1-bit or 8-bit memory manipulation instruction.

RESET input sets ASIM1 and ASIM2 to 00H.

Figure 17-3. Asynchronous Serial Interface Mode Registers 1, 2 (ASIM1, ASIM2) Format

Address: 0FF70H, 0FF71H After reset: 00H R/W

Symbol	<7>	<6>	5	4	3	2	1	0
ASIMn	TXEn	RXEn	PSn1	PSn0	CLn	SLn	ISRMn	IRDAMn

TXEn	RXEn	Operation mode	RxD1/P20, RxD2/P70 pin function	TxD1/P21, TxD2/P71 pin function
0	0	Operation stop	Port function	Port function
0	1	UART mode (Receive only)	Serial function	Port function
1	0	UART mode (Transmit only)	Port function	Serial function
1	1	UART mode (Transmit/Receive)	Serial function	Serial function

PSn1	PSn0	Parity bit specification
0	0	No parity
0	1	Always add 0 parity during transmission Do not perform parity check during reception (parity error not generated)
1	0	Odd parity
1	1	Even parity

CLn	Transmit data character length specification
0	7 bits
1	8 bits

SLn	Transmit data stop bit length specification
0	1 bit
1	2 bits

ISRMn	Receive completion interrupt control at error occurrence
0	Generate receive completion interrupt when error occurs
1	Do not generate receive completion interrupt when error occurs

IRDAMn	Infrared data transfer mode operation specification ^{Note 1}
0	UART (Transmit/Receive) mode
1	Infrared data transfer (Transmit/Receive) mode ^{Note 2}

- Notes**
1. Specification of the UART/infrared data transfer mode is controlled with TXEn and RXEn.
 2. When the infrared data transfer mode is used, be sure to set "0000" (set clock to $f_{sck}/16$) to bits 3 to 0 (MLDn3 to MLDn0) of baud rate generator control register n (BRGCn).

Caution Before switching the operation mode, stop serial transmission or reception.

Remark n = 1, 2

(2) Asynchronous serial interface status registers 1, 2 (ASIS1, ASIS2)

ASIS1 and ASIS2 are registers used display the type of error when a receive error occurs.

ASIS1 and ASIS2 can be read with 1-bit and 8-bit memory manipulation instructions.

$\overline{\text{RESET}}$ input sets ASIS1 and ASIS2 to 00H.

Figure 17-4. Asynchronous Serial Interface Status Registers 1, 2 (ASIS1, ASIS2) Format

Address: 0FF72H, 0FF73H After reset: 00H R/W

Symbol	7	6	5	4	3	<2>	<1>	<0>
ASISn	0	0	0	0	0	PEn	FEn	OVE n

PE n	Parity error flag
0	Parity error not generated
1	Parity error generated (when parity of transmit data does not match)

FEn	Framing error flag
0	Framing error not generated
1	Framing error generated ^{Note 1} (when stop bit(s) is not detected)

OVE n	Overrun error flag
0	Overrun error not generated
1	Overrun error generated ^{Note 2} (When next receive operation is completed before data from receive buffer register is read)

- Notes**
1. Even if the stop bit length has been set to 2 bits with bit 2 (SLn) of asynchronous serial interface mode register n (ASIMn), stop bit detection during reception is only 1 bit.
 2. Be sure to read receive buffer register n (RXBn) when an overrun error occurs. An overrun error is generated each time data is received until RXBn is read.

Remark n = 1, 2

(3) Baud rate generator control registers 1, 2 (BRGC1, BRGC2)

BRGC1 and BRGC2 are registers used to set the serial clock of the asynchronous serial interface.

BRGC1 and BRGC2 are set by a 1-bit or 8-bit memory manipulation instruction.

$\overline{\text{RESET}}$ input sets BRGC1 and BRGC2 to 00H.

Figure 17-5. Baud Rate Generator Control Registers 1, 2 (BRGC1, BRGC2) Format

Address: 0FF76H, 0FF77H After reset: 00H R/W

Symbol	7	6	5	4	3	2	1	0
BRGCn	0	TPSn2	TPSn1	TPSn0	MDLn3	MDLn2	MDLn1	MDLn0

TPSn2	TPSn1	TPSn0	5-bit counter source clock selection	m
0	0	0	External clock (ASCKn)	0
0	0	1	f_{xx} (12.5 MHz)	0
0	1	0	$f_{xx}/2$ (6.25 MHz)	1
0	1	1	$f_{xx}/4$ (3.13 MHz)	2
1	0	0	$f_{xx}/8$ (1.56 MHz)	3
1	0	1	$f_{xx}/16$ (781 kHz)	4
1	1	0	$f_{xx}/32$ (391 kHz)	5
1	1	1	TO1 (TM1 output)	0

MDLn3	MDLn2	MDLn1	MDLn0	Baud rate generator input clock selection	k
0	0	0	0	$f_{sck}/16$	0
0	0	0	1	$f_{sck}/17$	1
0	0	1	0	$f_{sck}/18$	2
0	0	1	1	$f_{sck}/19$	3
0	1	0	0	$f_{sck}/20$	4
0	1	0	1	$f_{sck}/21$	5
0	1	1	0	$f_{sck}/22$	6
0	1	1	1	$f_{sck}/23$	7
1	0	0	0	$f_{sck}/24$	8
1	0	0	1	$f_{sck}/25$	9
1	0	1	0	$f_{sck}/26$	10
1	0	1	1	$f_{sck}/27$	11
1	1	0	0	$f_{sck}/28$	12
1	1	0	1	$f_{sck}/29$	13
1	1	1	0	$f_{sck}/30$	14
1	1	1	1	Setting prohibited	–

- Cautions**
1. If a write operation to BRGCn is performed during communication, the baud rate generator output will become garbled and normal communication will not be achieved. Therefore, do not perform write operations to BRGCn during communication.
 2. Refer to the data sheet for details of the high-/low-level width of ASCKn when selecting the external clock (ASCKn) for the source clock of the 5-bit counter.

- Remarks**
1. $n = 1, 2$
 2. Data in parentheses is for when $f_{xx} = 12.5$ MHz
 3. f_{sck} : Source clock of 5-bit counter
 4. m: Value set in TPSn0 to TPSn2 ($0 \leq m \leq 5$)
 5. k: Value set in MDLn0 to MDLn3 ($0 \leq k \leq 14$)

17.3 Operation

The asynchronous serial interface has the following three types of operation modes.

- Operation stop mode
- Asynchronous serial interface (UART) mode
- Infrared data transfer mode

17.3.1 Operation stop mode

Serial transfer cannot be performed in the operation stop mode, resulting in reduced power consumption. Moreover, in the operation stop mode, pins can be used as regular ports.

(1) Register setting

Setting of the operation stop mode is done with asynchronous serial interface mode registers 1 and 2 (ASIM1, ASIM2).

ASIM1 and ASIM2 are set by a 1-bit or 8-bit memory manipulation instruction.

RESET input sets ASIM1 and ASIM2 to 00H.

Address: 0FF70H, 0FF71H After reset: 00H R/W

Symbol	<7>	<6>	5	4	3	2	1	0
ASIMn	TXEn	RXEn	PSn1	PSn0	CLn	SLn	ISRMn	IRDAMn

TXEn	RXEn	Operation mode	RxD1/P20, RxD2/P70 pin function	TxD1/P21, TxD2/P71 pin function
0	0	Operation stop	Port function	Port function
0	1	UART mode (Receive only)	Serial function	Port function
1	0	UART mode (Transmit only)	Port function	Serial function
1	1	UART mode (Transmit/Receive)	Serial function	Serial function

Caution Before switching the operation mode, stop serial transmission or reception.

Remark n = 1, 2

17.3.2 Asynchronous serial interface (UART) mode

This mode is used to transmit and receive the 1-byte data following the start bit. It supports full-duplex operation.

A UART-dedicated baud rate generator is incorporated enabling communication using any baud rate within a large range.

The MIDI standard's baud rate (31.25 kbps) can be used utilizing the UART-dedicated baud rate generator.

(1) Register setting

The UART mode is set with asynchronous serial interface mode registers 1 and 2 (ASIM1, ASIM2), asynchronous serial interface status registers 1 and 2 (ASIS1, ASIS2), and baud rate generator control registers 1 and 2 (BRGC1, BRGC2).

(a) Asynchronous serial interface mode registers 1, 2 (ASIM1, ASIM2)

ASIM1 and ASIM2 can be set by a 1-bit or 8-bit memory manipulation instruction.

RESET input sets ASIM1 and ASIM2 to 00H.

Address: 0FF70H, 0FF71H After reset: 00H R/W

Symbol	<7>	<6>	5	4	3	2	1	0
ASIMn	TXEn	RXEn	PSn1	PSn0	CLn	SLn	ISRMn	IRDAMn

TXEn	RXEn	Operation mode	RxD1/P20, RxD2/P70 pin function	TxD1/P21, TxD2/P71 pin function
0	0	Operation stop	Port function	Port function
0	1	UART mode (Receive only)	Serial function	Port function
1	0	UART mode (Transmit only)	Port function	Serial function
1	1	UART mode (Transmit/Receive)	Serial function	Serial function

PSn1	PSn0	Parity bit specification
0	0	No parity
0	1	Always add 0 parity during transmission Do not perform parity check during reception (parity error not generated)
1	0	Odd parity
1	1	Even parity

CLn	Transmit data character length specification
0	7 bits
1	8 bits

SLn	Transmit data stop bit length specification
0	1 bit
1	2 bits

ISRMn	Receive completion interrupt control at error occurrence
0	Generate receive completion interrupt when error occurs
1	Do not generate receive completion interrupt when error occurs

IRDAMn	Infrared data transfer mode operation specification ^{Note 1}
0	UART (Transmit/Receive) mode
1	Infrared data transfer (Transmit/Receive) mode ^{Note 2}

Notes 1. Specification of the UART or infrared data transfer mode is controlled with TXEn and RXEn.

2. When the infrared data transfer mode is used, be sure to set "0000" (set clock to f_{scK}/16) to bits 3 to 0 (MLDn3 to MLDn0) of baud rate generator control register n (BRGCn).

Caution Before switching the operation mode, stop serial transmission or reception.

Remark n = 1, 2

(b) Asynchronous serial interface status registers 1, 2 (ASIS1, ASIS2)

ASIS1 and ASIS2 can be read by a 1-bit or 8-bit memory manipulation instruction.

$\overline{\text{RESET}}$ input sets ASIS1 and ASIS2 to 00H.

Address: 0FF72H, 0FF73H After reset: 00H R

Symbol	7	6	5	4	3	<2>	<1>	<0>
ASISn	0	0	0	0	0	PEn	FEn	OVEEn

PEn	Parity error flag
0	Parity error not generated
1	Parity error generated (when parity of transmit data does not match)

FEn	Framing error flag
0	Framing error not generated
1	Framing error generated ^{Note 1} (when stop bit(s) is not detected)

OVEEn	Overrun error flag
0	Overrun error not generated
1	Overrun error generated ^{Note 2} (When next receive operation is completed before data from receive buffer register is read)

- Notes**
1. Even if the stop bit length has been set to 2 bits with bit 2 (SLn) of asynchronous serial interface mode register n (ASIMn), stop bit detection during reception is only 1 bit.
 2. Be sure to read receive buffer register n (RXBn) when an overrun error occurs. An overrun error is generated each time data is received until RXBn is read.

Remark n = 1, 2

(c) Baud rate generator control registers 1, 2 (BRGC1, BRGC2)

BRGC1 and BRGC2 are set by a 1-bit or 8-bit memory manipulation instruction.

$\overline{\text{RESET}}$ input sets BRGC1 and BRGC2 to 00H.

Address: 0FF76H, 0FF77H After reset: 00H R/W

Symbol	7	6	5	4	3	2	1	0
BRGCn	0	TPSn2	TPSn1	TPSn0	MDLn3	MDLn2	MDLn1	MDLn0

TPSn2	TPSn1	TPSn0	5-bit counter source clock selection	m
0	0	0	External clock (ASCKn)	0
0	0	1	f_{xx} (12.5 MHz)	0
0	1	0	$f_{xx}/2$ (6.25 MHz)	1
0	1	1	$f_{xx}/4$ (3.13 MHz)	2
1	0	0	$f_{xx}/8$ (1.56 MHz)	3
1	0	1	$f_{xx}/16$ (781 kHz)	4
1	1	0	$f_{xx}/32$ (391 kHz)	5
1	1	1	TO1 (TM1 output)	0

MDLn3	MDLn2	MDLn1	MDLn0	Baud rate generator input clock selection	k
0	0	0	0	$f_{sck}/16$	0
0	0	0	1	$f_{sck}/17$	1
0	0	1	0	$f_{sck}/18$	2
0	0	1	1	$f_{sck}/19$	3
0	1	0	0	$f_{sck}/20$	4
0	1	0	1	$f_{sck}/21$	5
0	1	1	0	$f_{sck}/22$	6
0	1	1	1	$f_{sck}/23$	7
1	0	0	0	$f_{sck}/24$	8
1	0	0	1	$f_{sck}/25$	9
1	0	1	0	$f_{sck}/26$	10
1	0	1	1	$f_{sck}/27$	11
1	1	0	0	$f_{sck}/28$	12
1	1	0	1	$f_{sck}/29$	13
1	1	1	0	$f_{sck}/30$	14
1	1	1	1	Setting prohibited	–

- Cautions**
1. If a write operation to BRGC1 and BRGC2 is performed during communication, the baud rate generator output will become garbled and normal communication will not be achieved. Therefore, do not perform write operations to BRGC1 and BRGC2 during communication.
 2. Refer to the data sheet for details of the high-/low-level width of ASCKn when selecting the external clock (ASCKn) for the source clock of the 5-bit counter.
 3. Set the 8-bit timer mode control register (TMC1) as follows when selecting TO1 for the source clock of the 5-bit counter.
TMC16 = 0, LVS1 = 0, LVR1 = 0, TMC11 = 1
Moreover, set TOE1 to 0 when TO1 is not output externally and to 1 when TO1 is output externally.

- Remarks**
1. n = 1, 2
 2. Figures in parentheses apply to operation at f_{xx} = 12.5 MHz.
 3. f_{sc}k: Source clock of 5-bit counter
 4. m: Value set in TPSn0 to TPSn2 (0 ≤ m ≤ 5)
 5. k: Value set in MDLn0 to MDLn3 (0 ≤ k ≤ 14)

The transmit/receive clock for the baud rate to be generated is the signal obtained by dividing the 5-bit counter source clock.

- **Generation of transmit/receive clock for baud rate**
The baud rate is obtained from the following equation.

$$[\text{Baud rate}] = \frac{T}{2^{m+1} \times (k + 16)} \text{ [Hz]}$$

T: 5-bit counter source clock

- When using a divided main system clock: Main system clock (f_{xx})
- When an external clock (ASCKn) is selected: Output frequency of ASCKn
- When the timer 1 output (TO1) is selected: Output frequency of TO1

m: Value set in TPSn0 to TPSn2 (0 ≤ m ≤ 5)

k: Value set in MDLn0 to MDLn3 (0 ≤ k ≤ 14)

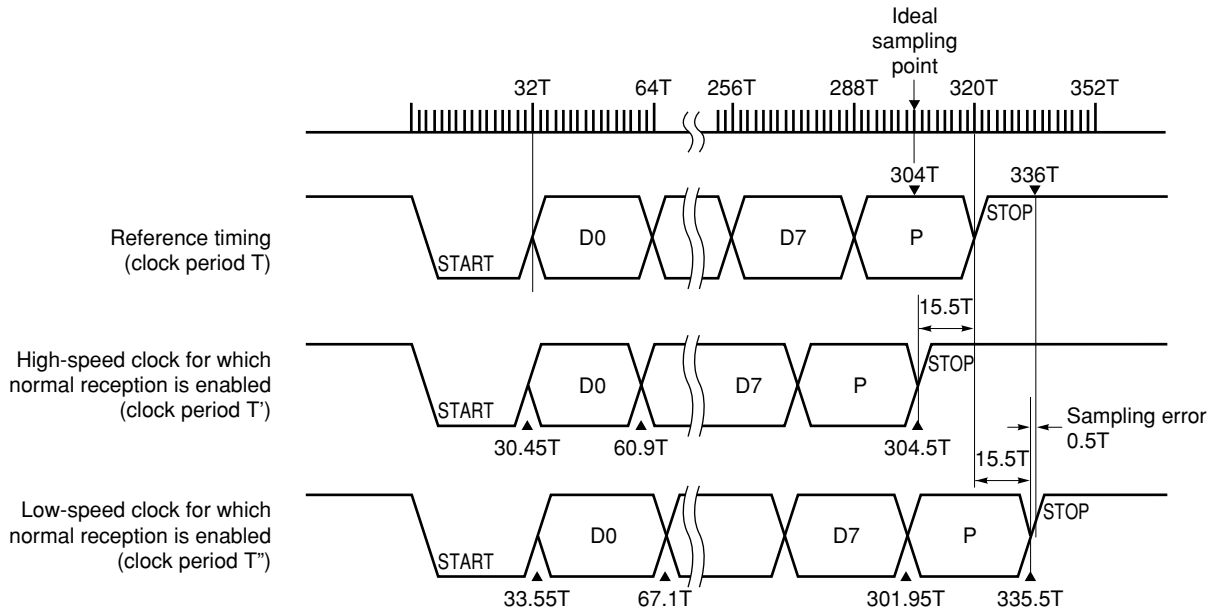
- **Baud rate capacity error range**
The baud rate capacity range depends on the number of bits per frame and the counter division ratio [1/(16 + k)].
Table 17-4 shows the relation between the main system clock and the baud rate, Figure 17-6 shows a baud rate capacity error example.

Table 17-4. Relationship Between Main System Clock and Baud Rate

Baud rate (bps)	f _{xx} = 12.5 MHz		f _{xx} = 6.25 MHz		f _{xx} = 3.00 MHz	
	BRGC Value	Error (%)	BRGC Value	Error (%)	BRGC Value	Error (%)
2,400	—	—	—	—	64H	2.34
4,800	—	—	64H	1.73	54H	2.34
9,600	64H	1.73	54H	1.73	44H	2.34
19,200	54H	1.73	44H	1.73	34H	2.34
31,250	49H	0.00	39H	0.00	28H	0
38,400	44H	1.73	34H	1.73	24H	2.34
76,800	34H	1.73	24H	1.73	14H	2.34
150K	24H	1.73	14H	1.73	—	—
300K	14H	1.73	—	—	—	—

Remark When TM1 output is used, 150 to 38,400 bps is supported (during operation with f_{xx} = 12.5 MHz)

Figure 17-6. Baud Rate Capacity Error Considering Sampling Errors (When k = 0)



Remark T: 5-bit counter source clock period

$$\text{Baud rate capacity error (k = 0)} = \frac{\pm 15.5}{320} \times 100 = 4.8438 (\%)$$

(2) Communication operation

(a) Data format

The transmission/reception data format consists of a start bit, character bits, parity bit, and stop bit(s) forming character frames, as shown in Figure 17-7.

Specification of the character bit length inside data frames, selection of the parity, and selection of the stop bit length, are performed with asynchronous serial interface mode register n (ASIMn).

Figure 17-7. Asynchronous Serial Interface Transmit/Receive Data Format



- Start bit 1 bit
- Character bits 7 bits/8 bits
- Parity bit Even parity/Odd parity/0 parity/No parity
- Stop bit(s) 1 bit/2 bits

If 7 bits has been selected as the number of character bits, only the lower 7 bits (bits 0 to 6) are valid. In the case of transmission, the highest bit (bit 7) is ignored. In the case of reception, the highest bit (bit 7) always becomes “0”.

The setting of the serial transfer rate is performed with asynchronous serial interface mode register n (ASIMn) and baud rate generator control register n (BRGCn).

If a serial data reception error occurs, it is possible to determine the contents of the reception error by reading the status of asynchronous serial interface status register n (ASISn).

Remark n = 1, 2

(b) Parity types and operations

Parity bits serve to detect bit errors in transmit data. Normally, the parity bit used on the transmit side and the receive side are of the same type. In the case of even parity and odd parity, it is possible to detect “1” bit (odd number) errors. In the case of 0 parity and no parity, errors cannot be detected.

(i) Even parity

- During transmission

Makes the number of “1”s in transmit data that includes the parity bit even. The value of the parity bit changes as follows.

If the number of “1” bits in transmit data is odd: 1
if the number of “1” bits in transmit data is even: 0

- During reception

The number of “1” bits in receive data that includes the parity bit is counted, and if it is odd, a parity error occurs.

(ii) Odd parity

- During transmission

Odd parity is the reverse of even parity. It makes the number of “1”s in transmit data that includes the parity bit odd. The value of the parity bit changes as follows.

If the number of “1” bits in transmit data is odd: 0
if the number of “1” bits in transmit data is even: 1

- During reception

The number of “1” bits in receive data that includes the parity bit is counted, and if it is even, a parity error occurs.

(iii) 0 Parity

During transmission, makes the parity bit “0”, regardless of the transmit data.

Parity bit check is not performed during reception. Therefore, no parity error occurs, regardless of whether the parity bit value is “0” or “1”.

(iv) No parity

No parity is appended to transmit data.

Receive data is received assuming that it has no parity bit. No parity error can occur because there is no parity bit.

(c) Transmission

Transmission is begun by writing transmit data to transmit shift register n (TXSn). The start bit, parity bit, and stop bit(s) are automatically added.

The contents of transmit shift register n (TXSn) are shifted out upon transmission start, and when transmit shift register n (TXSn) becomes empty, a transmit completion interrupt (INTSTn) is generated.

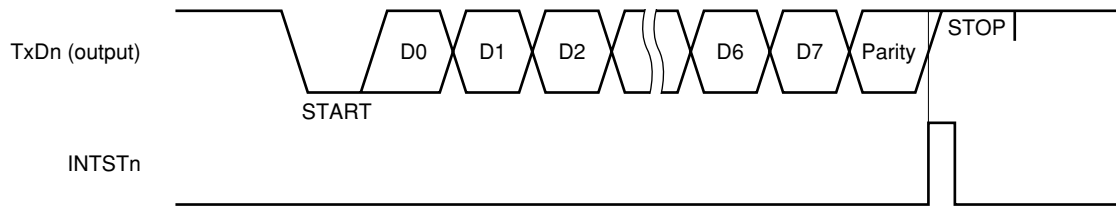
Caution In the case of UART transmission, follow the procedure below when performing transmission for the first time.

- <1> Set the port to the input mode (PM21 = 1 or PM71 = 1), and write 0 to the port latch.
- <2> Set bit 7 (TXEn) of asynchronous serial interface mode register n (ASIMn) to 1 to enable UART transmission (output a high level from the TXDn pin).
- <3> Set the port to the output mode (PM21 = 0 or PM71 = 0).
- <4> Write transmit data to TXSn, and start transmission.

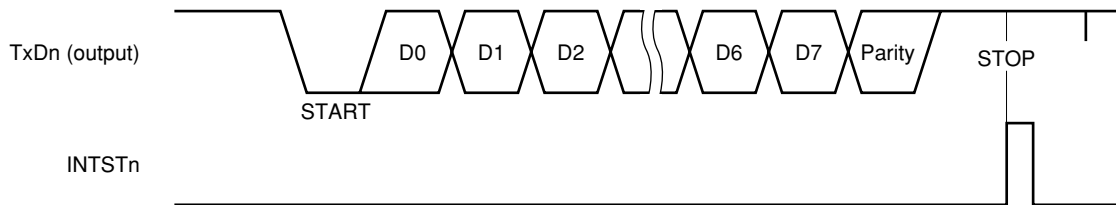
If the port is set to the output mode first, 0 will be output from the pins, which may cause malfunction.

Remark n = 1, 2

Figure 17-8. Asynchronous Serial Interface Transmit Completion Interrupt Timing



(a) Stop bit length: 1



(b) Stop bit length: 2

Caution Do not write to asynchronous serial interface mode register n (ASIMn) during transmission. If you write to the ASIMn register during transmission, further transmission operations may become impossible (in this case, input RESET to return to normal). Whether transmission is in progress or not can be judged by software, using the transmit completion interrupt (INTSTn) or the interrupt request flag (STIFn) set by INTSTn.

Remark n = 1, 2

(d) Reception

When the RXEn bit of asynchronous serial interface mode register n (ASIMn) is set to 1, reception is enabled and sampling of the RxDn pin input is performed.

Sampling of the RxDn pin input is performed by the serial clock set in baud rate generator control register n (BRGCn).

When the RxDn pin input becomes low level, the 5-bit counter of the baud rate generator starts counting, and outputs the data sampling start timing signal when half the time of the set baud rate has elapsed. If the result of re-sampling the RxDn pin input with this start timing signal is low level, the RxDn pin input is perceived as the start bit, the 5-bit counter is initialized and begins counting, and data sampling is performed. When, following the start bit, character data, the parity bit, and one stop bit are detected, reception of one frame of data is completed.

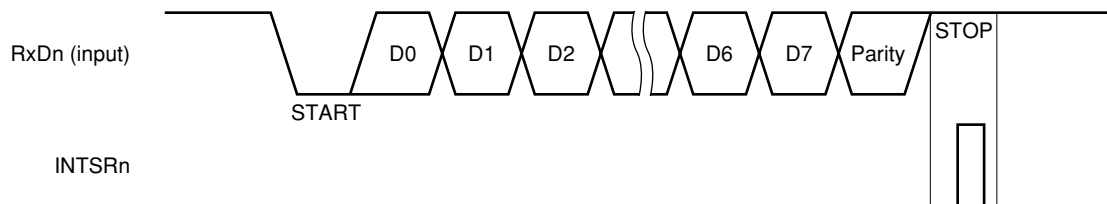
When reception of one frame of data is completed, the receive data in the shift register is transferred to receive buffer register n (RXBn), and a receive completion interrupt (INTSRn) is generated.

Moreover, even if an error occurs, the receive data for which the error occurred is transferred to RXBn. If an error occurs, when bit 1 (ISRMn) of ASIMn is cleared (0), INTSRn is generated (refer to **Figure 17-10**). When bit ISRMn is set (1), INTSRn is not generated.

When bit RXEn is reset to 0 during a receive operation, the receive operation is immediately stopped. At this time, the contents of RXBn and ASISn remain unchanged, and INTSRn and INTSERn are not generated.

Remark n = 1, 2

Figure 17-9. Asynchronous Serial Interface Receive Completion Interrupt Timing



Caution Even when a receive error occurs, be sure to read the receive buffer register (RXBn). If RXBn is not read, an overrun error will occur during reception of the next data, and the reception error status will continue indefinitely.

Remark n = 1, 2

(e) Receive error

Errors that occur during reception are of three types: parity errors, framing errors, and overrun errors. As the data reception result error flag is set inside asynchronous serial interface status register n (ASISn), the receive error interrupt (INTSERn) is generated. A receive error interruption is generated before a receive end interrupt (INTSRn). Receive error causes are shown in Table 17-5.

What type of error has occurred during reception can be detected by reading the contents of asynchronous serial interface status register n (ASISn) during processing of the receive error interrupt (refer to **Table 17-5** and **Figure 17-10**).

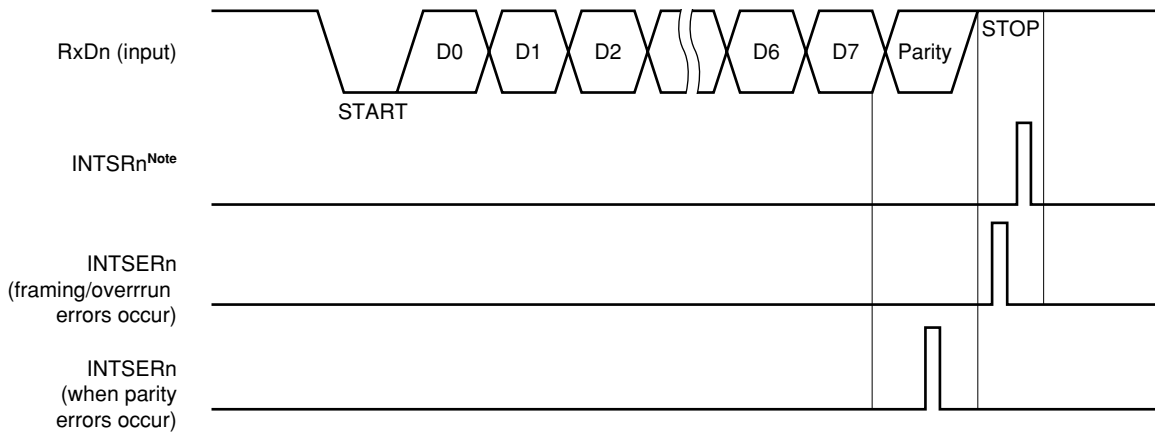
The contents of ASISn are reset to 0 either when receive buffer register n (RXBn) is read or when the next data is received (If the next data has an error, this error flag is set).

Remark n = 1, 2

Table 17-5. Receive Error Causes

Receive Error	Cause	ASISn
Parity error	Parity specified for transmission and parity of receive data don't match	04H
Framing error	Stop bit was not detected	02H
Overrun error	Next data reception was completed before data was read from the receive buffer register	01H

Figure 17-10. Receive Error Timing



Note If a receive error occurs, when bit ISRMn is set (1), INTSRn is not generated.

- Cautions**
1. The contents of the ASISn register are reset to 0 either when receive buffer register n (RXBn) is read or when the next data is received. To find out the contents of the error, be sure to read ASISn before reading RXBn.
 2. Be sure to read receive buffer register n (RXBn) even when a receive error occurs. If RXBn is not read, an overrun error will occur at reception of the next data, and the receive error status will continue indefinitely.

Remark n = 1, 2

17.3.3 Infrared data transfer mode

Infrared data transfer mode enables pulse output and pulse reception in the following data format. However this mode does not conform to the IrDA specifications.

(1) Data format

A comparison of the data format in the UART mode and the data format in the infrared data transfer mode is shown in Figure 17-11.

IR frames correspond to the bit strings of UART frames made up of a start bit, eight data bits, and a stop bit. The length of the electrical pulse transmitted/received with these IR frames is 3/16 of a 1-bit period. A pulse of 3/16 of a 1-bit period rises from the center of the bit period (see figure below).

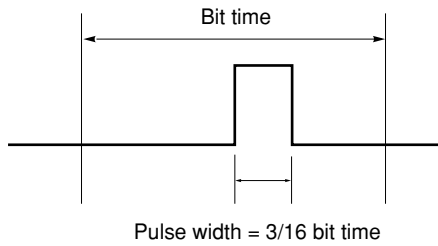
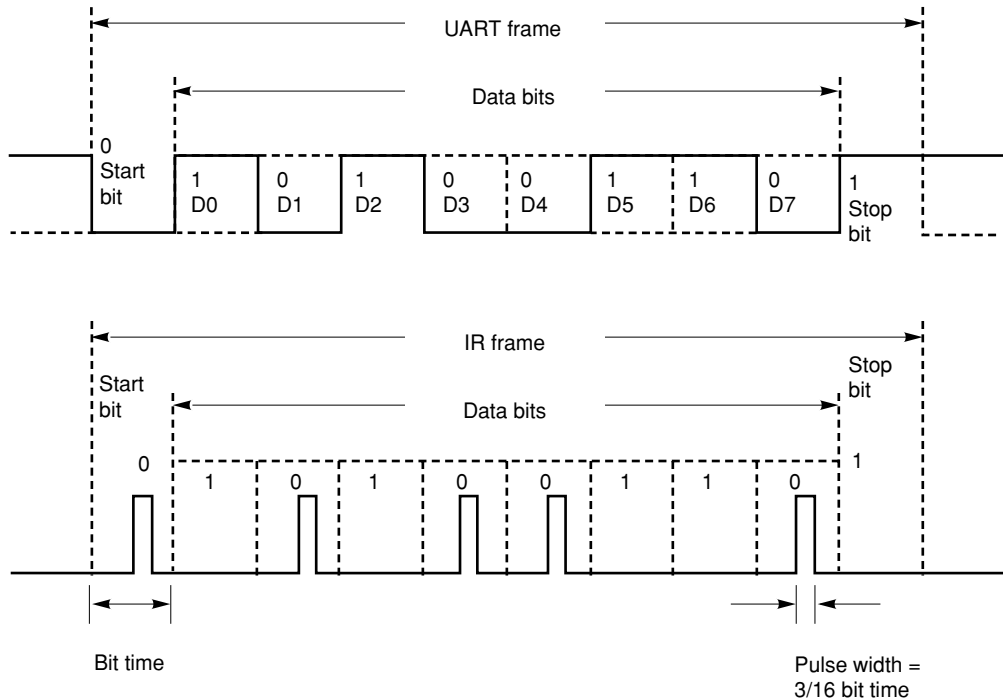


Figure 17-11. Comparison of Infrared Data Transfer Mode and UART Mode Data Formats



(2) Bit rate and pulse width

The bit rates, bit rate capacity errors, and pulse widths are shown in Table 17-6.

Per specifications, the minimum pulse width can be either 3/16 of the bit period or the minimum pulse width of a 115.2 kbps signal (1.63 μ s to 22 μ s capacity error), and thus is the same regardless of the bit rate.

The maximum pulse width is obtained by adding the greater of 2.5 % of the bit period or 1.08 μ s to 3/16 of the bit time.

Table 17-6. Bit Rate and Pulse Width Values

Bit Rate (kbits/s)	Bit Rate Capacity Error (% of bit rate)	Minimum Pulse Width (μ s) ^{Note 1}	Pulse Width 3/16 Rating (μ s)	Pulse Width Maximum Value (μ s)
2.4 ^{Note 2}	+/- 0.87	1.41	78.13	88.55
9.6 ^{Note 2}	+/- 0.87	1.41	19.53	22.13
19.2 ^{Note 2}	+/- 0.87	1.41	9.77	11.07
38.4 ^{Note 2}	+/- 0.87	1.41	4.88	5.96
57.6	+/- 0.87	1.41	3.26	4.34
115.2	+/- 0.87	1.41	1.63	2.71

Notes 1. The minimum value of the pulse width that can be received can be calculated as follows:

$$[\text{Minimum value of receivable pulse width}] = \frac{1}{16 \times [\text{Bit rate}]}$$

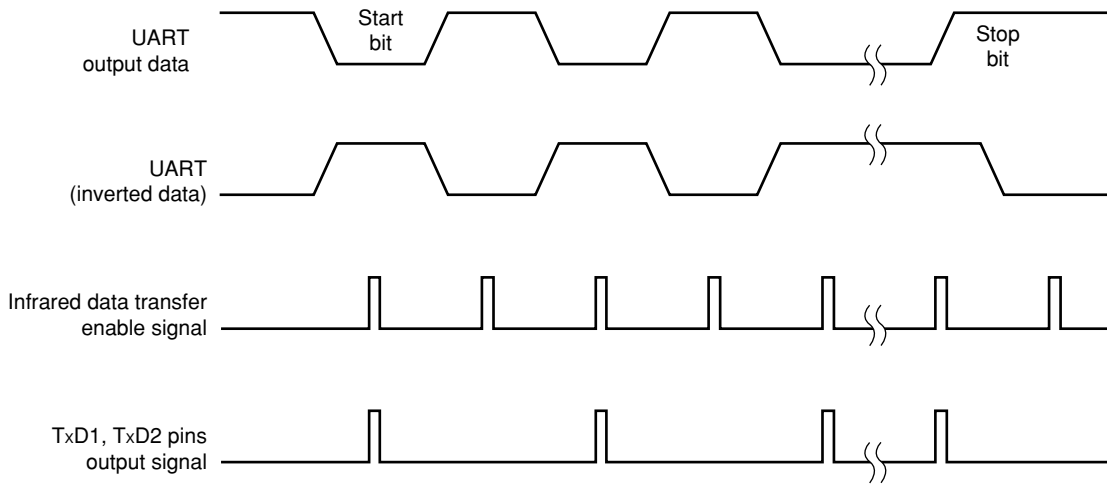
2. The minimum pulse width of 1.41 μ s cannot be detected unless the bit rate is 44.4 kbps or more.

An example of how to calculate the maximum pulse width when the bit rate is 2.4 kbps is shown below.

$$78.13 + (78.13 \times \frac{16}{3} \times 0.025) = 88.55 [\mu\text{s}]$$

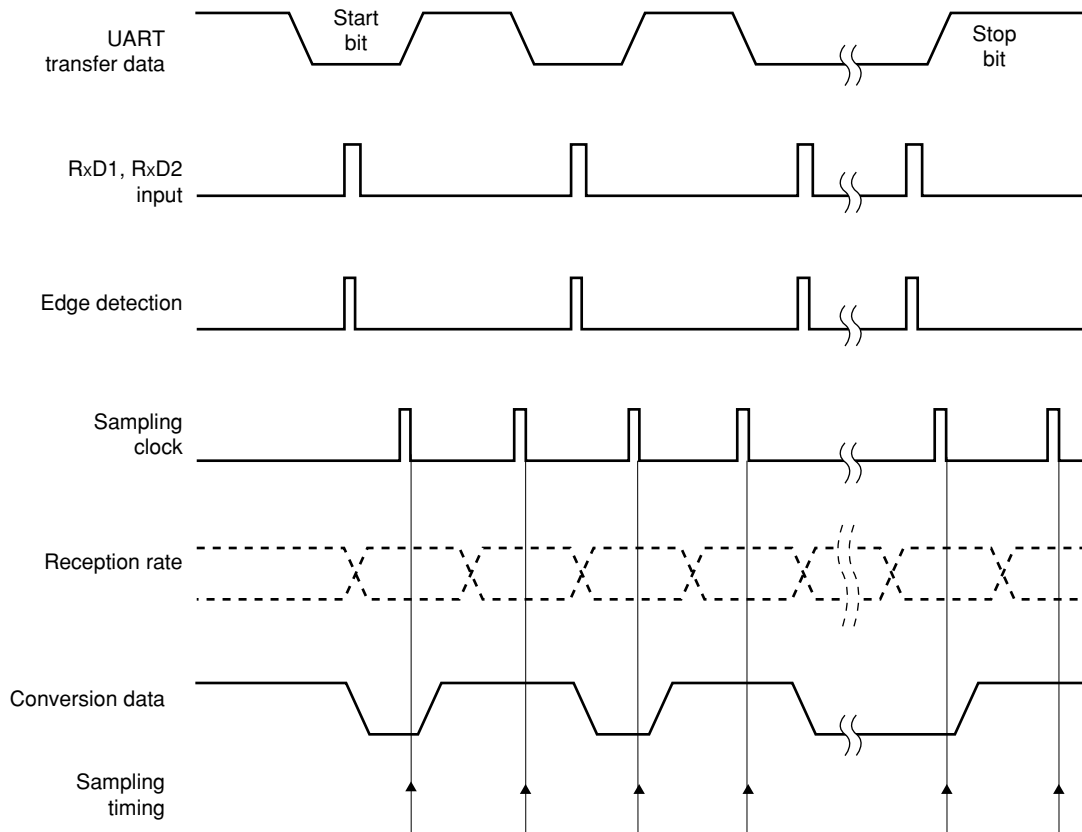
(3) I/O data and internal signals

• Transmission timing



• Reception timing

Reception of half data of set baud rate is delayed.



17.3.4 Standby mode operation

(1) HALT mode operation

Serial transfer operation is normally performed.

(2) STOP mode or IDLE mode operation

(a) When internal clock is selected as serial clock

Asynchronous serial interface mode register n (ASIMn), transmit shift register n (TXSn), receive shift register n (RXn), and receive buffer register n (RXBn) stop operation holding the value immediately before the clock stops.

If the clock stops (STOP mode) during transmission, the TxDn pin output data immediately before the clock stopped is held. If the clock stops during reception, receive data up to immediately before the clock stopped is stored, and subsequent operation is stopped. When the clock is restarted, reception is resumed.

Remark n = 1, 2

(b) When external clock is selected as serial clock

Serial transfer operation is performed normally. However, interrupt requests are pended without being acknowledged. Interrupt requests are acknowledged after the STOP mode or IDLE mode has been released through NMI input, INTP0 to INTP6 input, watch timer interrupt or key return interrupt (P80 to P87).

17.4 3-Wire Serial I/O Mode

This mode is used to perform 8-bit data transfer with the serial clock ($\overline{\text{SCK1}}$, $\overline{\text{SCK2}}$), serial output (SO1, SO2), and serial input (SI1, SI2) lines.

The 3-wire serial I/O mode supports simultaneous transmit/receive operation, thereby reducing the data transfer processing time.

The start bit of 8-bit data for serial transfer is fixed as the MSB.

The 3-wire serial I/O mode is effective when connecting a peripheral I/O with an on-chip clocked serial interface, a display controller, etc.

17.4.1 Configuration

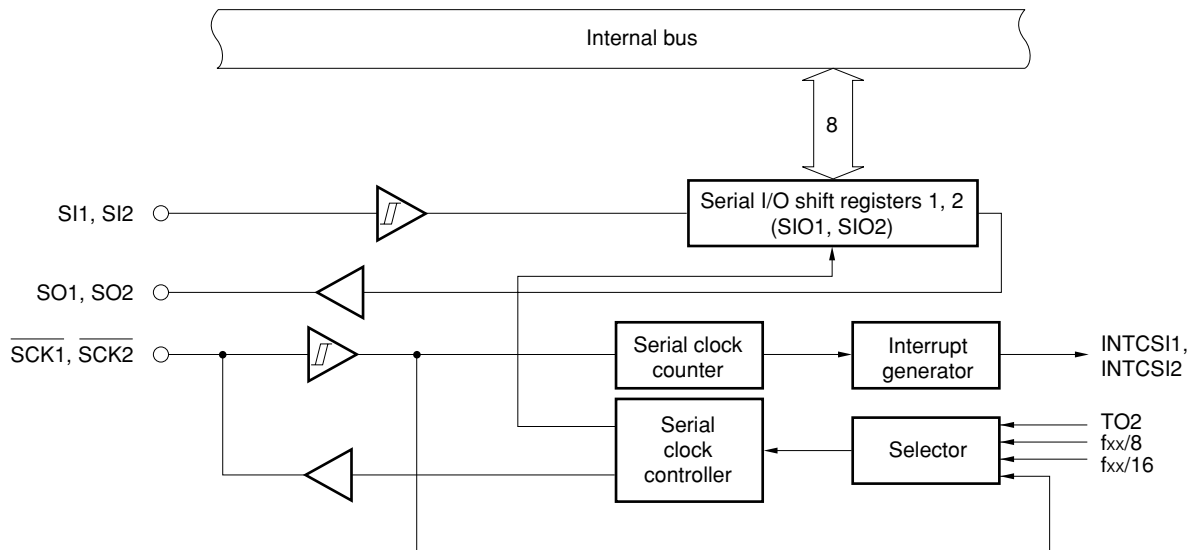
The 3-wire serial I/O mode has the following hardware configuration.

Figure 17-12 shows the block diagram for the 3-wire serial I/O mode.

Table 17-7. 3-Wire Serial I/O Configuration

Item	Configuration
Register	Serial I/O shift registers 1, 2 (SIO1, SIO2)
Control register	Serial operation mode registers 1, 2 (CSIM1, CSIM2)

Figure 17-12. Block Diagram in 3-Wire Serial I/O Mode



- **Serial I/O shift registers 1, 2 (SIO1, SIO2)**

These are 8-bit registers that perform parallel-serial conversion, and serial transmission/reception (shift operation) in synchronization with the serial clock.

SIO_n is set with an 8-bit memory manipulation instruction.

When bit 7 (CSIE_n) of the serial operation mode register (CSIM_n) is 1, serial operation can be started by writing/reading data to/from SIO_n.

During transmission, data written to SIO_n is output to the serial output pin (SO_n).

During reception, data is read into SIO_n from the serial input pin (SI_n).

RESET input sets SIO1 and SIO2 to 00H.

Caution During transfer operation, do not perform access to SIO_n other than access acting as a transfer start trigger (read and write are prohibited when MODEN = 0 and MODEN = 1, respectively).

Remark n = 1, 2

17.4.2 Control registers

 • **Serial operation mode registers 1, 2 (CSIM1, CSIM2)**

CSIM1 and CSIM2 are used to set the serial clock, operation mode, and operation enable/disable during the 3-wire serial I/O mode.

CSIM1 and CSIM2 can be set by a 1-bit or 8-bit memory manipulation instruction.

$\overline{\text{RESET}}$ input sets CSIM1 and CSIM2 to 00H.

Figure 17-13. Serial Operation Mode Registers 1, 2 (CSIM1, CSIM2) Format

Address: 0FF91H, 0FF92H After reset: 00H R/W

Symbol	<7>	6	5	4	3	2	1	0
CSIMn	CSIE _n	0	0	0	0	MODE _n	SCL _{n1}	SCL _{n0}

CSIE _n	SIO _n operation enable/disable setting		
	Shift register operation	Serial counter	Port
0	Operation disable	Clear	Port function ^{Note}
1	Operation enable	Counter operation enable	Serial function + port function

MODE _n	Transfer operation mode flag		
	Operation mode	Transfer start trigger	SIO _n output
0	Transmit or transmit/receive mode	SIO _n write	Normal output
1	Receive-only mode	SIO _n read	Fix to low level

SCL _{n1}	SCL _{n0}	Clock selection
0	0	External clock to $\overline{\text{SCK}}_n$
0	1	8-bit timer/counter 2 (TM2) output
1	0	$f_{xx}/8$ (1.56 MHz)
1	1	$f_{xx}/16$ (781 kHz)

- Notes**
- When CSIE_n = 0 (SIO_n operation stop status), pins connected to SIO_n, SIO_n, and $\overline{\text{SCK}}_n$ can be used as ports.
 - Set the external clock and TO2 to $f_{xx}/8$ or below when selecting the external clock ($\overline{\text{SCK}}_n$) and TM2 output (TO2) for the clock.

- Remarks**
- n = 1, 2
 - Figures in parentheses apply to operation with $f_{xx} = 12.5$ MHz.

17.4.3 Operation

The following two types of 3-wire serial I/O operation mode are available.

- Operation stop mode
- 3-wire serial I/O mode

(1) Operation stop mode

Serial transfer is not possible in the operation stop mode, which reduces power consumption. Moreover, in operation stop mode, pins can normally be used a I/O ports.

(a) Register setting

The operation stop mode is set by serial operation registers 1 and 2 (CSIM1, CSIM2). CSIM1 and CSIM2 can be set by a 1-bit or 8-bit memory manipulation instruction. RESET input sets CSIM1 and CSIM2 to 00H.

Figure 17-14. Serial Operation Mode Registers 1, 2 (CSIM1, CSIM2) Format

Address: 0FF91H, 0FF92H After reset: 00H R/W

Symbol	<7>	6	5	4	3	2	1	0
CSIMn	CSIE _n	0	0	0	0	MODE _n	SCL _{n1}	SCL _{n0}

CSIE _n	SIO _n operation enable/disable setting		
	Shift register operation	Serial counter	Port
0	Operation disable	Clear	Port function ^{Note}
1	Operation enable	Counter operation enable	Serial function + port function

Note When CSIE_n = 0 (SIO_n operation stop status), pins connected to SIn, SO_n, and \overline{SCKn} can be used as ports.

Remark n = 1, 2

(2) 3-wire serial I/O mode

The 3-wire serial I/O mode is effective when connecting a peripheral I/O with an on-chip clocked serial interface, a display controller, etc.

This mode is used to perform communication with the serial clock ($\overline{\text{SCK1}}$, $\overline{\text{SCK2}}$), serial output (SO1, SO2), and serial input (SI1, SI2) lines.

(a) Register setting

The 3-wire serial I/O mode is set by serial operation mode registers 1 and 2 (CSIM1, CSIM2).

CSIM1 and CSIM2 can be set by a 1-bit or 8-bit memory manipulation instruction.

$\overline{\text{RESET}}$ input sets CSIM1 and CSIM2 to 00H.

Figure 17-15. Serial Operation Mode Registers 1, 2 (CSIM1, CSIM2) Format

Address: 0FF91H, 0FF92H After reset: 00H R/W

Symbol	<7>	6	5	4	3	2	1	0
CSIMn	CSIE _n	0	0	0	0	MODE _n	SCL _{n1}	SCL _{n0}

CSIE _n	SIO _n operation enable/disable setting		
	Shift register operation	Serial counter	Port
0	Operation disable	Clear	Port function ^{Note}
1	Operation enable	Counter operation enable	Serial function + port function

MODE _n	Transfer operation mode flag		
	Operation mode	Transfer start trigger	SIO _n output
0	Transmit or transmit/receive mode	SIO _n write	Normal output
1	Receive-only mode	SIO _n read	Fix to low level

SCL _{n1}	SCL _{n0}	Clock selection
0	0	External clock to $\overline{\text{SCKn}}$
0	1	8-bit timer/counter 2 (TM2) output
1	0	$f_{xx}/8$ (1.56 MHz)
1	1	$f_{xx}/16$ (781 kHz)

Notes 1. When CSIE_n = 0 (SIO_n operation stop status), pins connected to SI_n, SO_n, and $\overline{\text{SCKn}}$ can be used as ports.

2. Set the external clock and TO2 to $f_{xx}/8$ or below when selecting the external clock ($\overline{\text{SCKn}}$) and TM2 output (TO2) for the clock.

Remarks 1. n = 1, 2

2. Figures in parentheses apply to operation with $f_{xx} = 12.5$ MHz.

(b) Communication operation

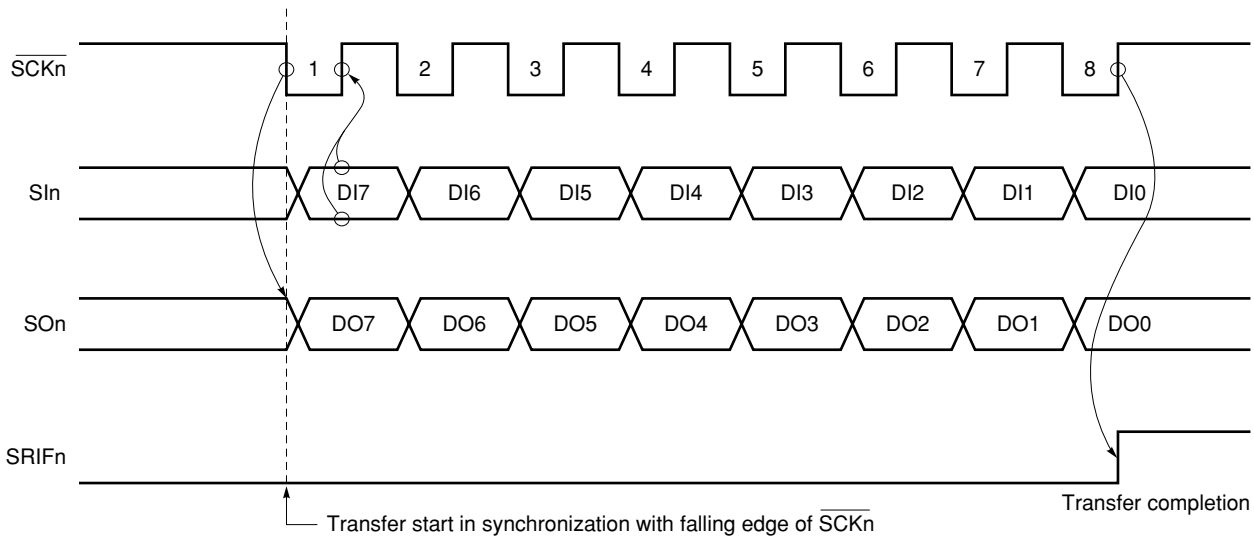
The 3-wire serial I/O mode performs data transmission/reception in 8-bit units. Data is transmitted and received one bit at a time in synchronization with the serial clock.

The shift operation of serial I/O shift register n (SIO_n) is performed in synchronization with the falling edge of the serial clock (\overline{SCKn}). Transmit data is held in the SIO_n latch, and is output from the SIO_n pin. Receive data input to the SIO_n pin is latched to SIO_n at the rising edge of the \overline{SCKn} signal.

SIO_n operation is automatically stopped when 8-bit transfer ends, and an interrupt request flag (SRIF_n) is set.

Remark n = 1, 2

Figure 17-16. 3-Wire Serial I/O Mode Timing



Remark n = 1, 2

(c) Transfer start

Serial transfer starts by setting (or reading) transfer data to serial I/O shift register n (SIO_n) when the following two conditions are satisfied.

- SIO_n operation control bit (CSIE_n) = 1
- Following 8-bit serial transfer, the internal serial clock is stopped, or \overline{SCKn} is high level
- Transmit or transmit/receive mode
When CSIE_n = 1 and MODE_n = 0, transfer is started with SIO_n write
- Receive-only mode
When CSIE_n = 1 and MODE_n = 1, transfer is started with SIO_n read

Remark n = 1, 2

Caution After data is written to SIO_n, transfer will not start even if CSIE_n is set to “1”.

Serial transfer automatically stops at the end of 8-bit transfer, and the interrupt request flag (SRIF_n) is set.

CHAPTER 18 3-WIRE SERIAL I/O MODE

18.1 Function

This mode transfers 8-bit data by using the three lines of the serial clock ($\overline{\text{SCK0}}$), the serial output (SO0), and the serial input (SI0).

Since the 3-wire serial I/O mode can perform simultaneous transmission and reception, the data transfer processing time becomes shorter.

The starting bit of the 8-bit data to be serially transferred is fixed at the MSB.

The 3-wire serial I/O mode is valid when the peripheral I/O or display controller equipped with a clocked serial interface is connected.

18.2 Configuration

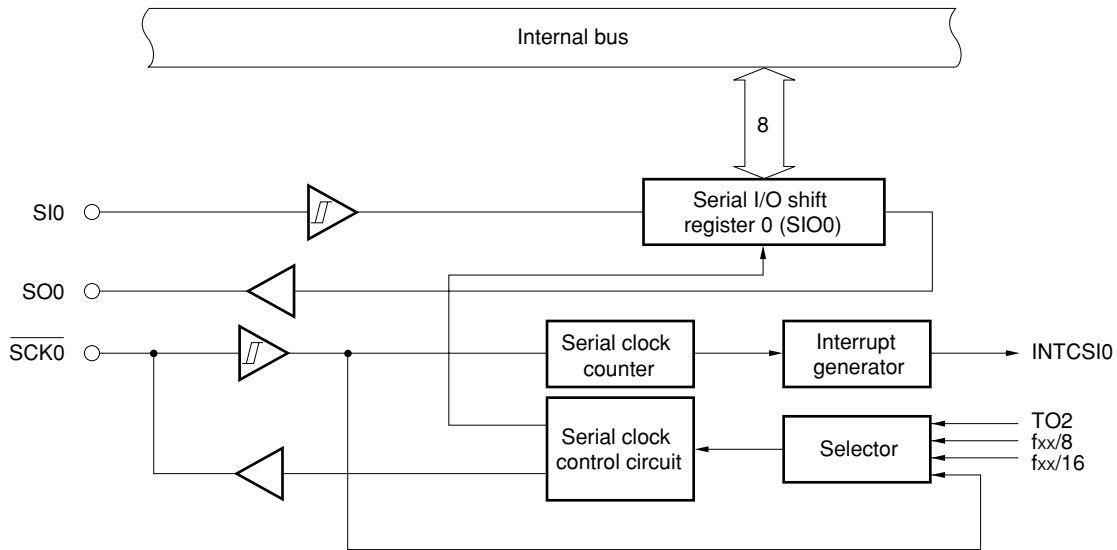
The 3-wire serial I/O mode consists of the following hardware.

Figure 18-1 is a block diagram of the clocked serial interface (CSI) in the 3-wire serial I/O mode.

Table 18-1. 3-Wire Serial I/O Configuration

Item	Configuration
Register	Serial I/O shift register 0 (SIO0)
Control register	Serial operating mode register 0 (CSIM0)

Figure 18-1. Block Diagram of Clocked Serial Interface (in 3-Wire Serial I/O Mode)



- **Serial I/O shift register 0 (SIO0)**

This 8-bit shift register performs parallel to serial conversion and serially communication (shift operation) synchronized to the serial clock.

SIO0 is set by an 8-bit memory manipulation instruction.

When bit 7 (CSIE0) in serial operation mode register 0 (CSIM0) is 1, serial operation starts by writing data to or reading it from SIO0.

When transmitting, the data written to SIO0 is output to the serial output (SO0).

When receiving, data is read from the serial input (SI0) to SIO0.

$\overline{\text{RESET}}$ input sets SIO0 to 00H.

Caution Do not access SIO0 during a transfer except for an access that becomes a transfer start trigger. (When MODE0 = 0, reading is disabled; and when MODE0 = 1, writing is disabled.)

18.3 Control Registers

- **Serial operation mode register 0 (CSIM0)**

The CSIM0 register sets the serial clock and operating mode to the 3-wire serial I/O mode, and enables or stops operation.

CSIM0 is set by a 1-bit or 8-bit memory manipulation instruction.

$\overline{\text{RESET}}$ input sets CSIM0 to 00H.

Figure 18-2. Serial Operation Mode Register 0 (CSIM0) Format

Address: 0FF90H After reset: 00H R/W

Symbol	<7>	6	5	4	3	2	1	0
CSIM0	CSIE0	0	0	0	0	MODE0	SCL01	SCL00

CSIE0	SIO0 operation enable/disable setting		
	Shift Register Operation	Serial Counter	Port
0	Disable operation	Clear	Port function ^{Note}
1	Enable operation	Enable count operation	Serial function + Port function

MODE0	Transfer operation mode flag		
	Operation Mode	Transfer Start Trigger	SO0 Output
0	Transmit or transmit/receive mode	SIO0 write	Normal output
1	Receive-only mode	SIO0 read	Fixed low

SCL01	SCL00	Clock selection
0	0	External clock to $\overline{\text{SCK0}}$
0	1	8-bit timer/counter 2 (TM2) output
1	0	$f_{xx}/8$ (1.56 MHz)
1	1	$f_{xx}/16$ (781 kHz)

Note If CSIE0 = 0 (SIO0 operation stopped state), the pins connected to SIO, SO0 and $\overline{\text{SCK0}}$ can function as ports.

Cautions 1. Set 8-bit timer mode control register 2 (TMC2) as follows when selecting 8-bit timer counter 2 (TM2) output as the clock.

TMC26 = 0, TMC24 = 0, LVS2 = 0, LVR2 = 0, TMC21 = 1

Moreover, set TOE2 to 0 when TO2 is not output externally and to 1 when TO2 is output externally.

2. Set the external clock and TO2 to $f_{xx}/8$ or below when selecting the external clock ($\overline{\text{SCKn}}$) and TM2 output (TO2) for the clock.

Remark Figures in parentheses apply to operation with $f_{xx} = 12.5$ MHz.

Table 18-2. Serial Interface Operation Mode Settings

(1) Operation stopped mode

CSIM0			PM25	P25	PM26	P26	PM27	P27	First Bit	Shift Clock	P25/SI0/SDA0 Pin Function	P26/SO0 Pin Function	P27/SCK0/SCL0 Pin Function
CSIE0	SCL01	SCL00											
0	×	×	× ^{Note 1}	× ^{Note 1}	× ^{Note 1}	× ^{Note 1}	× ^{Note 1}	× ^{Note 1}	–	–	P25	P26	P27
Other than above									Setting prohibited				

(2) 3-wire serial I/O mode

CSIM0			PM25	P25	PM26	P26	PM27	P27	First Bit	Shift Clock	P25/SI0/SDA0 Pin Function	P26/SO0 Pin Function	P27/SCK0/SCL0 Pin Function
CSIE0	SCL01	SCL00											
1	0	0	1 ^{Note 2}	× ^{Note 2}	0	0	1	×	MSB	External clock	SI0 ^{Note 2}	SO0 (CMOS output)	SCK0 input
	^{Note 3}	^{Note 3}				0	0	Internal clock		SCK0 output			
Other than above									Setting prohibited				

- Notes**
1. These pins can be used for port functions.
 2. When only transmission is used, this pin can be used as P25 (CMOS input/output).
 3. Refer to serial operation mode register 0 (CSIM0).

Remark ×: don't care

18.4 Operation

3-wire serial I/O has the following two operating modes.

- Operation stop mode
- 3-wire serial I/O mode

(1) Operation stop mode

Since serial transfers are not performed in the operation stop mode, power consumption can be decreased. In the operation stop mode, the pin can be used as an ordinary I/O port.

(a) Register settings

The operation stop mode is set in serial operation mode register 0 (CSIM0). CSIM0 is set by a 1-bit or 8-bit memory manipulation instruction. $\overline{\text{RESET}}$ input sets CSIM0 to 00H.

Figure 18-3. Serial Operation Mode Register 0 (CSIM0) Format

Address: 0FF90H After reset: 00H R/W

Symbol	<7>	6	5	4	3	2	1	0
CSIM0	CSIE0	0	0	0	0	MODE0	SCL01	SCL00

CSIE0	SIO0 operating enable/disable setting		
	Shift register operation	Serial counter	Port
0	Disable operation	Clear	Port function ^{Note}
1	Enable operation	Enable count operation	Serial function + Port function

Note If CSIE0 = 0 (SIO0 operation stopped state), the pins connected to SI0, SO0, and $\overline{\text{SCK0}}$ can function as ports.

(2) 3-wire serial I/O mode

The 3-wire serial I/O mode is valid when connected to peripheral I/O or a display controller equipped with the clocked serial interface.

Communication is over three lines, the serial clock ($\overline{SCK0}$), serial output (SO0), and serial input (SI0).

(a) Register setting

The 3-wire serial I/O mode is set in serial operation mode register 0 (CSIM0).

CSIM0 is set by a 1-bit or 8-bit memory manipulation instruction.

\overline{RESET} input sets CSIM0 to 00H.

Figure 18-4. Serial Operation Mode Register 0 (CSIM0) Format

Address: 0FF90H After reset: 00H R/W

Symbol	<7>	6	5	4	3	2	1	0
CSIM0	CSIE0	0	0	0	0	MODE0	SCL01	SCL00

CSIE0	SIO0 operation enable/disable setting		
	Shift Register Operation	Serial Counter	Port
0	Disable operation	Clear	Port function ^{Note}
1	Enable operation	Enable count operation	Serial function + Port function

MODE0	Transfer operation mode flag		
	Operation mode	Transfer start trigger	SO0 output
0	Transmit or transmit/receive mode	SIO0 write	Normal output
1	Receive-only mode	SIO0 read	Low level fixed

SCL01	SCL00	Clock selection
0	0	External clock to $\overline{SCK0}$
0	1	8-bit timer/counter 2 (TM2) output
1	0	$f_{xx}/8$ (1.56 MHz)
1	1	$f_{xx}/16$ (781 kHz)

Note If CSIE0 = 0 (SIO0 operation stopped state), the pins connected to SI0, SO0, and $\overline{SCK0}$ can function as ports.

Cautions 1. Set 8-bit timer mode control register 2 (TMC2) as follows when selecting 8-bit timer counter 2 (TM2) output as the clock.

TMC26 = 0, TMC24 = 0, LVS2 = 0, LVR2 = 0, TMC21 = 1

Moreover, set TOE2 to 0 when TO2 is not output externally and to 1 when TO2 is output externally.

2. Set the external clock and TO2 to $f_{xx}/8$ or below when selecting the external clock (\overline{SCKn}) and TM2 output (TO2) for the clock.

Remark Figures in parentheses apply to operation with $f_{xx} = 12.5$ MHz.

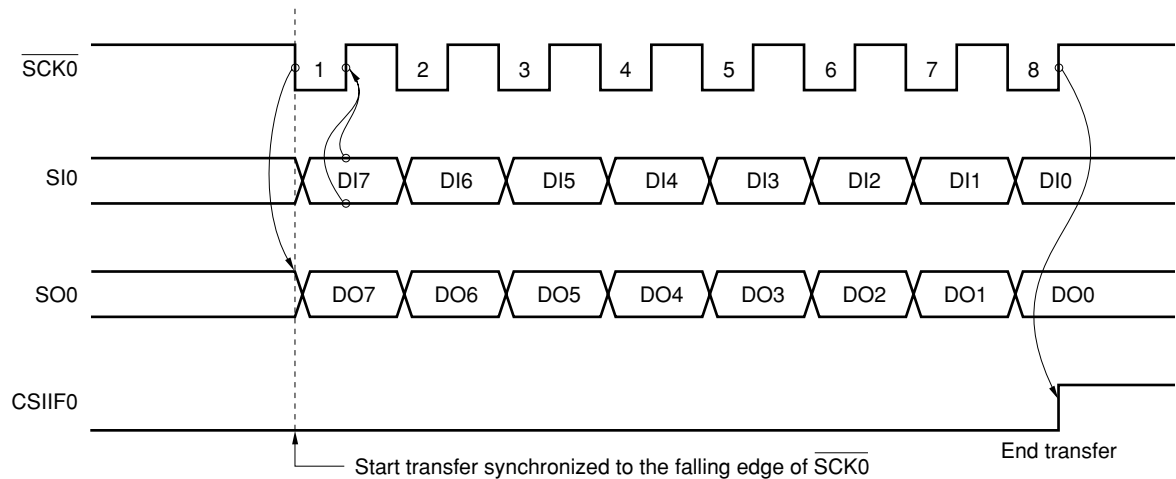
(b) Communication

The 3-wire serial I/O mode transmits and receives in 8-bit units. Data is transmitted and received with each bit synchronized to the serial clock.

The shifting of serial I/O shift register 0 (SIO0) is synchronized to the falling edge of the serial clock ($\overline{SCK0}$). The transmitted data are held in the latch and output from the SO0 pin. At the rising edge of $\overline{SCK0}$, the received data that was input at the SI0 pin is latched to SIO0.

The end of the 8-bit transfer automatically stops SIO0 operation and sets the interrupt request flag (CSIF0).

Figure 18-5. 3-Wire Serial I/O Mode Timing

**(c) Start transfer**

If the following two conditions are satisfied, the serial transfer starts when the transfer data is set in serial I/O shift register 0 (SIO0).

- Control bit (CSIE0) = 1 during SIO0 operation
- After an 8-bit serial transfer, the internal serial clock enters the stopped state or $\overline{SCK0}$ is high.
- Transmit or transmit/receive mode
 - When CSIE0 = 1 and MODE0 = 0, the transfer starts with an SIO0 write.
- Receive-only mode
 - When CSIE0 = 1 and MODE0 = 1, the transfer starts with an SIO0 read.

Caution Even if CSIE0 is set to 1 after the data is written to SIO0, transfer does not start.

Serial transfer is automatically stopped by the end of the 8-bit transfer, and the interrupt request flag (CSIF0) is set.

19.1 Overview of Function

- **I²C (Inter IC) bus mode (multimaster compatible)**

This interface communicates with devices that conform to the I²C bus format.

Eight bit data transfers with multiple devices are performed by the two lines of the serial clock (SCL0) and the serial data bus (SDA0).

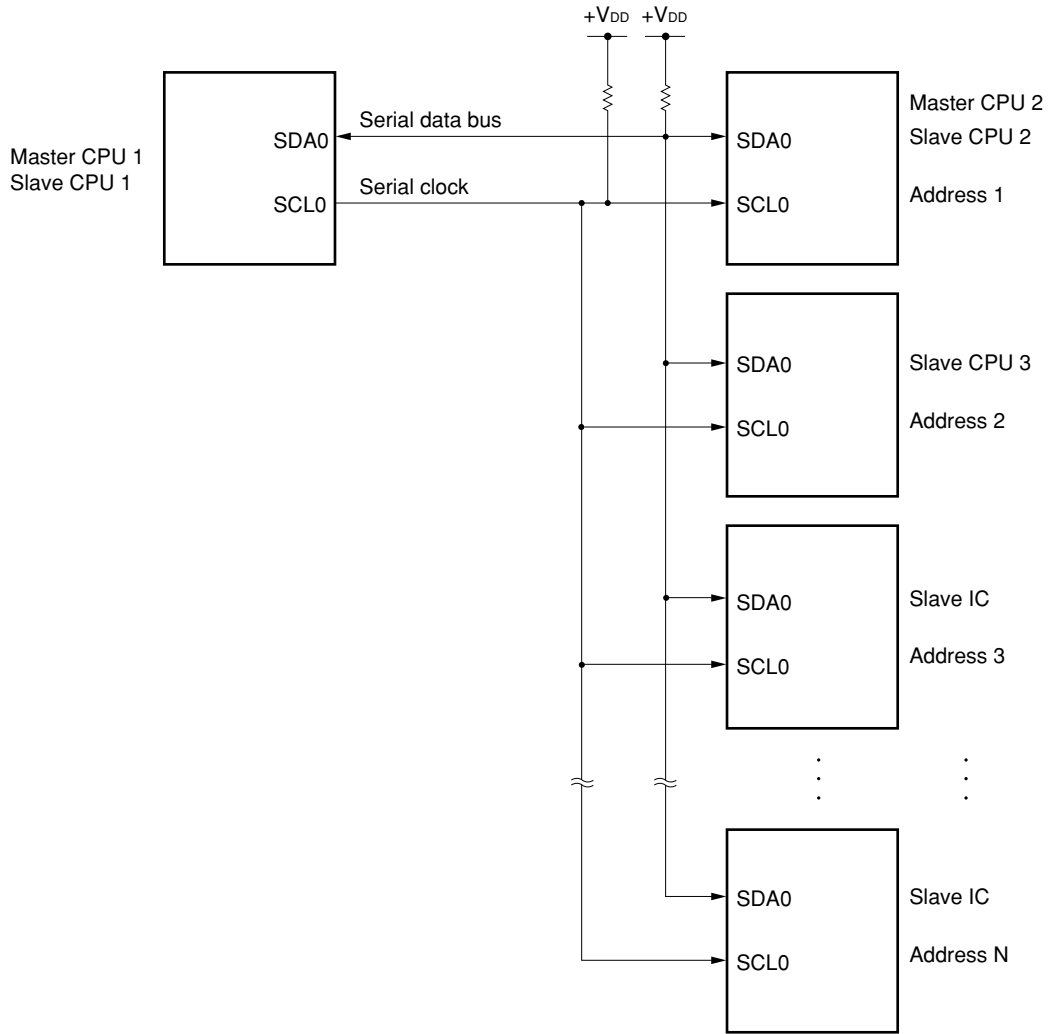
In the I²C bus mode, the master can output the start condition, data, and stop condition on the serial data bus to the slaves.

The slaves automatically detect the received data by hardware. The I²C bus control portion of the application program can be simplified by using this function.

Since SCL0 and SDA0 become open-drain outputs in the I²C bus mode, pull-up resistors are required on the serial clock line and serial data bus line.

- Cautions**
1. **If the power to the μ PD784218AY is disconnected while μ PD784218AY functions are not used, the problem is I²C communication will no longer be possible. Even when not used, do not disconnect the power to the μ PD784218AY.**
 2. **If the I²C bus mode is used, set the SCL0/P27 and SDA0/P25 pins to N-channel open-drains by setting the port function control register (PF2).**

Figure 19-1. Serial Bus Configuration Example in I²C Bus Mode



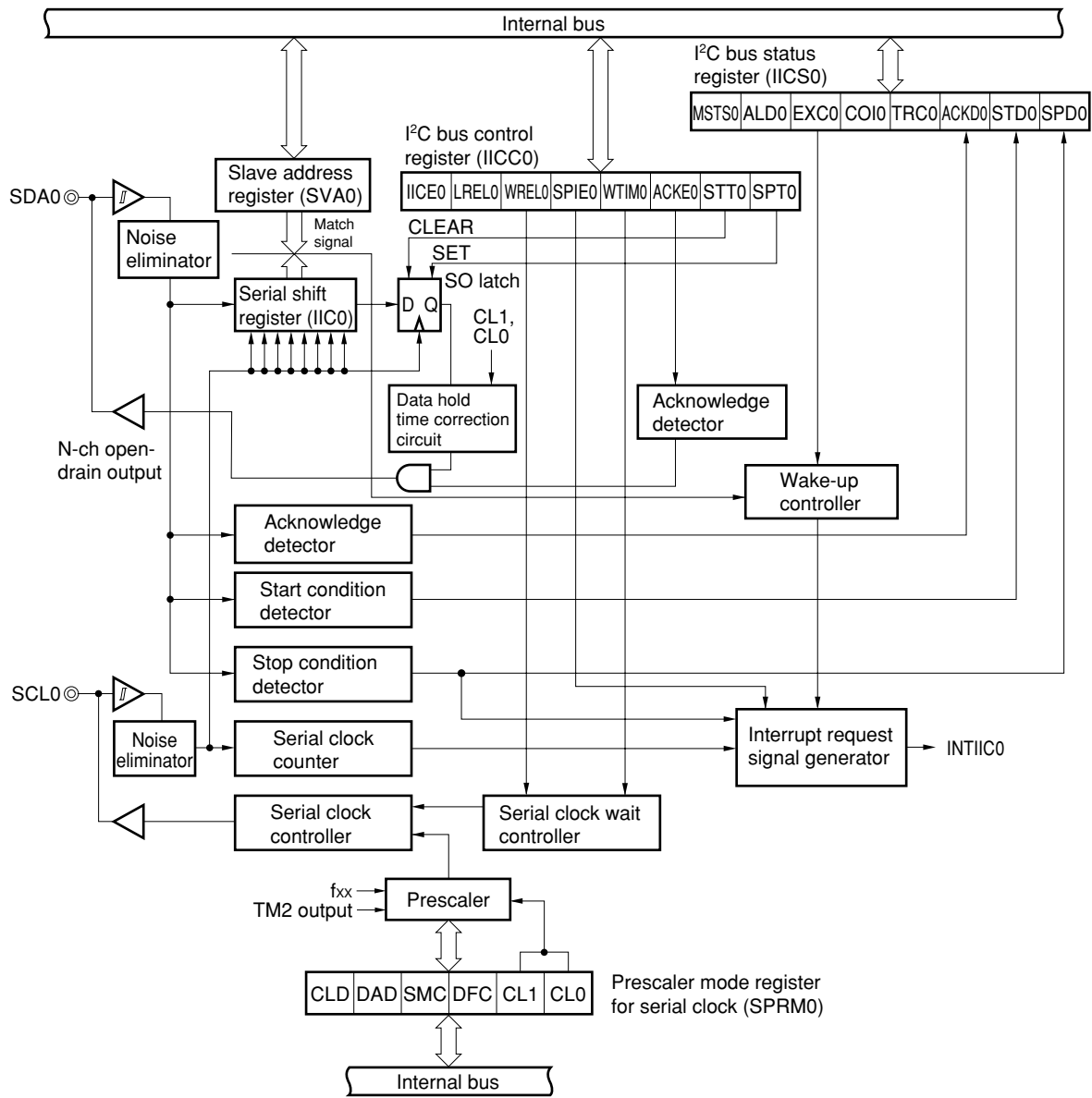
19.2 Configuration

The clocked serial interface in the I²C bus mode consists of the following hardware. Figure 19-2 is a block diagram of clocked serial interface (CSI) in the I²C bus mode.

Table 19-1. I²C Bus Mode Configuration

Item	Configuration
Registers	Serial shift register (IIC0)
	Slave address register (SVA0)
Control registers	I ² C bus control register (IICC0)
	I ² C bus status register (IICS0)
	Prescaler mode register for serial clock (SPRM0)

Figure 19-2. Block Diagram of Clocked Serial Interface (I²C Bus Mode)



(1) Serial shift register (IIC0)

The IIC0 register converts 8-bit serial data into 8-bit parallel data and 8-bit parallel data into 8-bit serial data. IIC0 is used in both transmission and reception.

The actual transmission and reception are controlled by writing and reading IIC0.

IIC0 is set by an 8-bit memory manipulation instruction.

$\overline{\text{RESET}}$ input sets IIC0 to 00H.

(2) Slave address register (SVA0)

When used as a slave, this register sets a slave address.

SVA0 is set by an 8-bit memory manipulation instruction.

$\overline{\text{RESET}}$ input sets SVA0 to 00H.

(3) SO latch

The SO latch holds the output level of the SDA0 pin.

(4) Wake-up controller

This circuit generates an interrupt request when the address set in the slave address register (SVA0) and the reception address matched, or when an extended code was received.

(5) Clock selector

This selects the sampling clock that is used.

(6) Serial clock counter

The serial clock that is output or input during transmission or reception is counted to check 8-bit data communication.

(7) Interrupt request signal generator

This circuit controls the generation of the interrupt request signal (INTIIC0).

The I²C interrupt request is generated by the following two triggers.

- Eighth or ninth clock of the serial clock (set by the WTIM0 bit^{Note})
- Interrupt request generated by detecting the stop condition (set by the SPIE0 bit^{Note})

Note WTIM0 bit: Bit 3 in the I²C bus control register (IICC0)

SPIE0 bit: Bit 4 in the I²C bus control register (IICC0)

(8) Serial clock controller

In the master mode, the clock output to pin SCL0 is generated by the sampling clock.

(9) Serial clock wait controller

This circuit controls the wait timing.

(10) Acknowledge output circuit, stop condition detector, start condition detector, acknowledge detector

These circuits output and detect the control signals.

(11) Data hold time correction circuit

This circuit generates the hold time of the data to the falling edge of the serial clock.

19.3 Control Registers

The I²C bus mode is controlled by the following three registers.

- I²C bus control register (IICC0)
- I²C bus status register (IICS0)
- Prescaler mode register for serial clock (SPRM0)

The following registers are also used.

- Serial shift register (IIC0)
- Slave address register (SVA0)

(1) I²C bus control register (IICC0)

The IICC0 register enables and disables the I²C bus mode, sets the wait timing, and sets other I²C bus mode operations.

IICC0 is set by a 1-bit or 8-bit memory manipulation instruction.

$\overline{\text{RESET}}$ input sets IICC0 to 00H.

Figure 19-3. I²C Bus Control Register (IICC0) Format (1/4)

Address: 0FFB0H After reset: 00H R/W

Symbol <7> <6> <5> <4> <3> <2> <1> <0>

IICC0	IICE0	LRELO	WRELO	SPIE0	WTIM0	ACKE0	STT0	SPT0
-------	-------	-------	-------	-------	-------	-------	------	------

IICE0	I ² C operation enabled	
0	Disables operation. Preset the I ² C bus status register (IICS0). Stops internal operation. SCL0 and SDA0 lines output low level.	
1	Enables operation.	
Clear condition (IICE0 = 0)		Set condition (IICE0 = 1)
<ul style="list-style-type: none"> Cleared by an instruction When $\overline{\text{RESET}}$ is input 		<ul style="list-style-type: none"> Set by an instruction

LRELO	Release communication	
0	Normal operation	
1	Releases microcontroller from the current communication and sets it in the wait state. Automatically clears after execution. The extended code that is unrelated to the base is used during reception. The SCL0 and SDA0 lines are put in the high impedance state. The following flags are cleared. • STD0 • ACKD0 • TRC0 • COI0 • EXC0 • MSTS0 • STT0 • SPT0	
Until the following communication participation conditions are satisfied, the wait state that was released from communication is entered.		
<ul style="list-style-type: none"> Start as the master after detecting the stop condition. Address match or extended code reception after the start condition 		
Clear condition (LRELO = 0) ^{Note}		Set condition (LRELO = 1)
<ul style="list-style-type: none"> Automatically cleared after execution. When $\overline{\text{RESET}}$ is input 		<ul style="list-style-type: none"> Set by an instruction

WRELO	Wait release	
0	The wait is not released.	
1	The wait is released. After the wait is released, it is automatically cleared.	
Clear condition (WRELO = 0) ^{Note}		Set condition (WRELO = 1)
<ul style="list-style-type: none"> Automatically cleared after execution. When $\overline{\text{RESET}}$ is input 		<ul style="list-style-type: none"> Set by an instruction

SPIE0	Enable/disable generation of interrupt requests by stop condition detection	
0	Disable	
1	Enable	
Clear condition (SPIE0 = 0) ^{Note}		Set condition (SPIE0 = 1)
<ul style="list-style-type: none"> Cleared by an instruction When $\overline{\text{RESET}}$ is input 		<ul style="list-style-type: none"> Set by an instruction

Note IICE0 = 0 makes this flag signal invalid.

Figure 19-3. I²C Bus Control Register (IICC0) Format (2/4)

WTIM0	Control of wait and interrupt request generation	
0	Interrupt request generated at the falling edge of the eighth clock For the master: After the eighth clock is output, wait with the clock output low. For the slave: After the eighth clock is input, the master waits with the clock low.	
1	Interrupt request generated at the falling edge of the ninth clock For the master: After the ninth clock is output, wait with the clock output low. For the slave: After the ninth clock is input, the master waits with the clock low.	
This bit setting becomes invalid during an address transfer, and becomes valid after the transfer ends. In the master, a wait is inserted at the falling edge of the ninth clock in an address transfer. The slave that received the base address inserts a wait at the falling edge of the ninth clock after the acknowledge is generated. The slave that received the extended code inserts the waits at the falling edge of the eighth clock.		
Clear condition (WTIM0 = 0) ^{Note}		Set condition (WTIM0 = 1)
<ul style="list-style-type: none"> • Cleared by an instruction • When RESET is input 		<ul style="list-style-type: none"> • Set by an instruction

ACKE0	Acknowledge control	
0	Acknowledge is disabled.	
1	Acknowledge is enabled. The SDA0 line during the ninth clock period goes low. However, the control is invalid during an address transfer. When EXC0 = 1, the control is valid.	
Clear condition (ACKE0 = 0) ^{Note}		Set condition (ACKE0 = 1)
<ul style="list-style-type: none"> • Cleared by an instruction • When RESET is input 		Set by an instruction

Note IICE0 = 0 makes this flag signal invalid.

Figure 19-3. I²C Bus Control Register (IICC0) Format (3/4)

STT0	Start condition trigger
0	The start condition is not generated.
1	<ul style="list-style-type: none"> • When the bus is released (stop condition): The start condition is generated (started as the master). The SDA0 line is changed from high to low, and the start condition is generated. Then, the standard time is guaranteed, and SCL0 goes low. • When not participating with the bus: The trigger functions as the start condition reserved flag. When set, the start condition is automatically generated after the bus is released. • Wait status (when master) The wait status is canceled and the restart condition is generated.
Set timing cautions <ul style="list-style-type: none"> • When the master is receiving: Setting during a transfer is prohibited. When ACKE0 = 0 is set, the end of reception can be set only during the wait period after the transmission to the slave. • When the master is transmitting: During the ACK0 acknowledge period, the start condition may not be normally generated. Set STT0 during the wait period. • Setting synchronized to SPT0 is prohibited. • Resetting between setting STT0 and the generation of the clear condition is prohibited. 	
Clear condition (STT0 = 0) ^{Note}	Set condition (STT0 = 1)
<ul style="list-style-type: none"> • Cleared by an instruction • IICE0 = 0 • LRL0 = 1 • When arbitration failed • Clear <u>after</u> generating the start condition in the master • When RESET is input 	<ul style="list-style-type: none"> • Set by an instruction

Note IICE0 = 0 makes this flag signal invalid.

Figure 19-3. I²C Bus Control Register (IICC0) Format (4/4)

SPT0	Stop condition trigger				
0	The stop condition is not generated.				
1	The stop condition is generated (ends the transfer as the master). After the SDA0 line goes low, the SCL0 line goes high, or wait until SCL0 goes high. Then, the standard time is guaranteed; the SDA0 line is changed from low to high; and the stop condition is generated.				
Set timing cautions <ul style="list-style-type: none"> When the master is receiving: Setting is prohibited during a transfer. When ACKE0 = 0, the end of reception can be set only during the wait period after transmitting to the slave. When the master is transmitting: During the ACK0 period, the stop condition may not be normally generated. Set SPT0 during the wait period. Setting synchronized to STT0 is prohibited. Resetting between setting SPT0 and the generation of the clear condition is prohibited. Set SPT0 only by the master. Note When WTIM0 = 0 is set, be aware that if SPT0 is set during the wait period after the eighth clock is output, the stop condition is generated during the high level of the ninth clock after the wait is released. When the ninth clock must be output, set WTIM0 = 0 → 1 during the wait period after the eighth clock is output, and set SPT0 during the wait period after the ninth clock is output. 					
<table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th style="width: 50%;">Clear condition (SPT0 = 0)</th> <th style="width: 50%;">Set condition (SPT0 = 1)</th> </tr> </thead> <tbody> <tr> <td> <ul style="list-style-type: none"> Cleared by an instruction IICE0 = 0 LRELO = 0 When arbitration failed Automatically clear after the stop condition is detected When RESET is input </td> <td> <ul style="list-style-type: none"> Set by an instruction </td> </tr> </tbody> </table>		Clear condition (SPT0 = 0)	Set condition (SPT0 = 1)	<ul style="list-style-type: none"> Cleared by an instruction IICE0 = 0 LRELO = 0 When arbitration failed Automatically clear after the stop condition is detected When RESET is input 	<ul style="list-style-type: none"> Set by an instruction
Clear condition (SPT0 = 0)	Set condition (SPT0 = 1)				
<ul style="list-style-type: none"> Cleared by an instruction IICE0 = 0 LRELO = 0 When arbitration failed Automatically clear after the stop condition is detected When RESET is input 	<ul style="list-style-type: none"> Set by an instruction 				

Note Set SPT0 only by the master. However, SPT0 must be set once, and the stop condition generated while the master is operating until the first stop condition is detected after operation is enabled. For details, refer to **19.5.15 Additional cautions**.

Cautions

- When bit 3 (TRC0) = 1 in the I²C bus status register (IICS0), after WRELO is set at the ninth clock and the wait is released, TRC0 is cleared, and the SDA0 line has a high impedance.
- SPT0 and STT0 are 0 when read after data has been set.

Remark

STD0: Bit 1 in the I²C bus status register (IICS0)
 ACKD0: Bit 2 in the I²C bus status register (IICS0)
 TRC0: Bit 3 in the I²C bus status register (IICS0)
 COI0: Bit 4 in the I²C bus status register (IICS0)
 EXC0: Bit 5 in the I²C bus status register (IICS0)
 MST0: Bit 7 in the I²C bus status register (IICS0)

(2) I²C bus status register (IICS0)

The IICS0 register displays the status of the I²C bus.

IICS0 is set by a 1-bit or 8-bit memory manipulation instruction. IICS0 can only be read.

$\overline{\text{RESET}}$ input sets IICS0 to 00H.

Figure 19-4. I²C Bus Status Register (IICS0) Format (1/3)

Address: 0FFB6H After reset: 00H R

Symbol	<7>	<6>	<5>	<4>	<3>	<2>	<1>	<0>
IICS0	MSTS0	ALD0	EXC0	COI0	TRC0	ACKD0	STD0	SPD0

MSTS0	Master state	
0	Slave state or communication wait state	
1	Master communication state	
Clear condition (MSTS0 = 0)		Set condition (MSTS0 = 1)
<ul style="list-style-type: none"> When the stop condition is detected When ALD0 = 1 Cleared by LREL0 = 1 When $\overline{\text{IICE0}} = 1 \rightarrow 0$ When $\overline{\text{RESET}}$ is input 		<ul style="list-style-type: none"> When start condition is generated

ALD0	Arbitration failed detection	
0	No arbitration state or arbitration win state	
1	Arbitration failed state. MSTS0 is cleared.	
Clear condition (ALD0 = 0)		Set condition (ALD0 = 1)
<ul style="list-style-type: none"> Automatically cleared after IICS0 is read^{Note} When $\overline{\text{IICE0}} = 1 \rightarrow 0$ When $\overline{\text{RESET}}$ is input 		<ul style="list-style-type: none"> When arbitration failed

EXC0	Extended code reception detection	
0	The extended code is not received.	
1	The extended code is received.	
Clear condition (EXC0 = 0)		Set condition (EXC0 = 1)
<ul style="list-style-type: none"> When the start condition is detected When the stop condition is detected Cleared by LREL0 = 1 When $\overline{\text{IICE0}} = 1 \rightarrow 0$ When $\overline{\text{RESET}}$ is input 		<ul style="list-style-type: none"> When the most significant four bits of the received address data are 0000 or 1111 (set by the rising edge of the eighth clock)

Note This is cleared when a bit manipulation instruction is executed for a bit not in IICS0.

Figure 19-4. I²C Bus Status Register (IICS0) Format (2/3)

COI0	Address match detection	
0	The address does not match.	
1	The address matches.	
Clear condition (COI0 = 0)		Set condition (COI0 = 1)
<ul style="list-style-type: none"> • During start condition detection • During stop condition detection • Cleared by LREL0 = 1 • When IICE0 = 1 → 0 • When RESET is input 		<ul style="list-style-type: none"> • When the received address matches the base address (SVA0) (set at the rising edge of the eighth clock)

TRC0	Transmission/reception state detection	
0	Reception state (not the transmission state). The SDA0 line has high impedance.	
1	Transmission state. The value in the SO latch can be output to the SDA0 line (valid after the falling edge of the ninth clock of the first byte)	
Clear condition (TRC0 = 0)		Set condition (TRC0 = 1)
<ul style="list-style-type: none"> • When the stop condition is detected • Cleared by LREL0 = 1 • When IICE0 = 1 → 0 • Cleared by WREL0 = 1^{Note} • When ALD0 = 0 → 1 • When RESET is input <p>In the master</p> <ul style="list-style-type: none"> • When 1 is output to the LSB of the first byte (transfer direction specification bit) <p>In the slave</p> <ul style="list-style-type: none"> • When the start condition is detected <p>When not participating in the communication</p>		<p>In the master</p> <ul style="list-style-type: none"> • When the start condition is generated <p>In the slave</p> <ul style="list-style-type: none"> • When 1 is input to the LSB of the first byte (transfer direction specification bit)

ACKD0	Acknowledge detection	
0	The acknowledge is not detected.	
1	The acknowledge is detected.	
Clear condition (ACKD0 = 0)		Set condition (ACKD0 = 1)
<ul style="list-style-type: none"> • When the stop condition is detected • At the rising edge of the first clock in the next byte • Cleared by LREL0 = 1 • When IICE0 = 1 → 0 • When RESET is input 		<ul style="list-style-type: none"> • When the SDA0 line is low at the rising edge of the ninth clock of SCL0

Note If a wait is canceled by setting bit 5 (WREL0) of I²C bus control register 0 (IICC0) at the ninth clock while bit 3 (TRC0) of I²C bus status register 0 (IICS0) is 1, TRC0 is cleared and the SDA0 line becomes high impedance.

Figure 19-4. I²C Bus Status Register (IICS0) Format (3/3)

STD0	Start condition detection	
0	The start condition is not detected.	
1	The start condition is detected. This indicates the address transfer period.	
Clear condition (STD0 = 0)		Set condition (STD0 = 1)
<ul style="list-style-type: none"> When the stop condition is detected At the rising edge of the first clock of the next byte after transferring the address Cleared by LREL0 = 1 When $\overline{\text{IICE0}} = 1 \rightarrow 0$ When RESET is input 		<ul style="list-style-type: none"> When the start condition is detected

SPD0	Stop condition detection	
0	The stop condition is not detected.	
1	The stop condition is detected. Communication is ended by the master, and the bus is released.	
Clear condition (SPD0 = 0)		Set condition (SPD0 = 1)
<ul style="list-style-type: none"> After the bit is set, at the rising edge of the first clock in the address transfer byte after detecting the start condition When $\overline{\text{IICE0}} = 1 \rightarrow 0$ When RESET is input 		<ul style="list-style-type: none"> When the stop condition is detected

Remark LREL0: Bit 6 of the I²C bus control register (IICC0)

IICE0: Bit 7 of the I²C bus control register (IICC0)

(3) Prescaler mode register for serial clock (SPRM0)

The SPRM0 register sets the transfer clock of the I²C bus.

SPRM0 is set by a 1-bit or 8-bit memory manipulation instruction.

RESET input sets SPRM0 to 00H.

Figure 19-5. Format of Prescaler Mode Register for Serial Clock (SPRM0) (1/2)

Address: 0FFB2H After reset: 00H R/W^{Note}

Symbol	7	6	<5>	<4>	3	2	1	0
SPRM0	0	0	CLD	DAD	SMC	DFC	CL1	CL0

CLD	SCL0 line level detection (valid only when IICE0 = 1)	
0	Detects a low SCL0 line.	
1	Detects a high SCL0 line.	
Clear condition (CLD = 0)		Set condition (CLD = 1)
<ul style="list-style-type: none"> When the SCL0 line is low When IICE0 = 0 When RESET is input 		<ul style="list-style-type: none"> When the SCL0 line is high

DAD	SDA0 line level detection (valid only when IICE0 = 1)	
0	Detects a low SDA0 line.	
1	Detects a high SDA0 line.	
Clear condition (DAD = 0)		Set condition (DAD = 1)
<ul style="list-style-type: none"> When the SDA0 line is low When IICE0 = 0 When RESET is input 		<ul style="list-style-type: none"> When the SDA0 line is high

Note Bits 4 and 5 are read only.

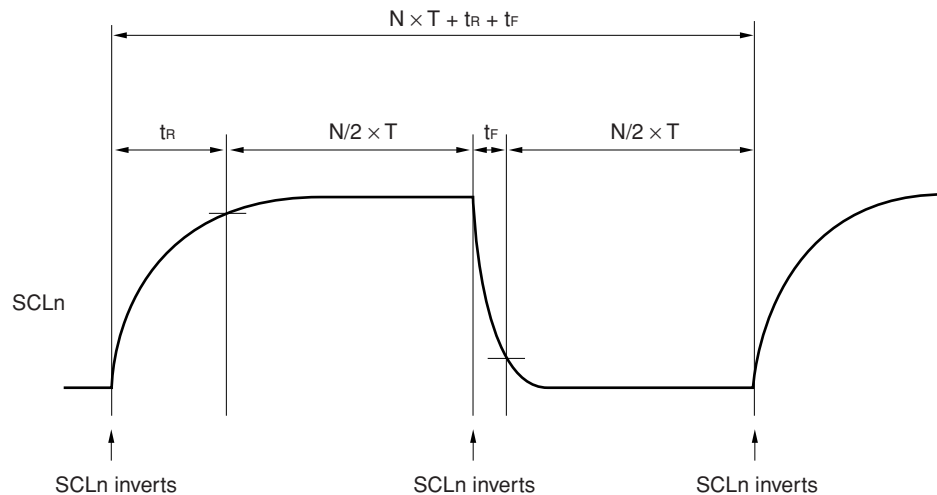
Figure 19-5. Format of Prescaler Mode Register for Serial Clock (SPRM0) (2/2)

SMC ^{Note 1}	DFC ^{Note 2}	CL1	CL0	Transfer clock	f _{xx} setting allowable range
0	1/0	0	0	f _{xx} /44	2 to 4.19 MHz
0	1/0	0	1	f _{xx} /86	4.19 to 8.38 MHz
0	1/0	1	0	f _{xx} /172	8.38 to 12.5 MHz
0	1/0	1	1	TM2 output/66	
1	1/0	0	1/0	f _{xx} /24	4 to 8.38 MHz
1	1/0	1	0	f _{xx} /48	8 to 12.5 MHz
1	1/0	1	1	TM2 output/18	

- Notes**
- SMC: Bit to change operation mode
 0: Operates in normal mode
 1: Operates in high-speed mode
 - DFC: Bit to control digital filter operation
 0: Digital filter off
 1: Digital filter on

- Cautions**
- Rewrite the SPRM0 after clearing the IICE0.
 - Set the transfer clock as follows:
 When SMC = 0: 100 kHz or below
 When SMC = 1: 400 kHz or below

- Remarks**
- IICE0: Bit 7 of I²C bus control register 0 (IICC0)
 - The transfer clock does not change due to the ON/OFF setting of bit 2 (DFC) in high-speed mode.
 - IIC clock: Clock frequency when f_{xx}/N is selected



IIC clock frequency: $f_{SCL} = 1/(N \times T + t_r + t_f)$
 $T = 1/f_{xx}$, t_r : SCLn rise time, t_f : SCLn fall time

Example When $f_{xx} = 12.5$ MHz, $N = 172$, $t_r = 200$ ns, $t_f = 50$ ns
 IIC clock frequency: $1/(172 \times 80$ ns + 200 ns + 50 ns) $\cong 71.4$ kHz

(4) Serial shift register (IIC0)

This register performs serial communication (shift operation) synchronized to the serial clock.

Although this register can be read and written in 1-bit and 8-bit units, do not write data to IIC0 during a data transfer.

Address: 0FFB8H After reset: 00H R/W

Symbol	7	6	5	4	3	2	1	0
IIC0								

(5) Slave address register (SVA0)

This register stores the slave address of the I²C bus.

It can be read and written in 8-bit units, but bit 0 is fixed at zero.

Address: 0FFB4H After reset: 00H R/W

Symbol	7	6	5	4	3	2	1	0
SVA0								0

19.4 I²C Bus Mode Function

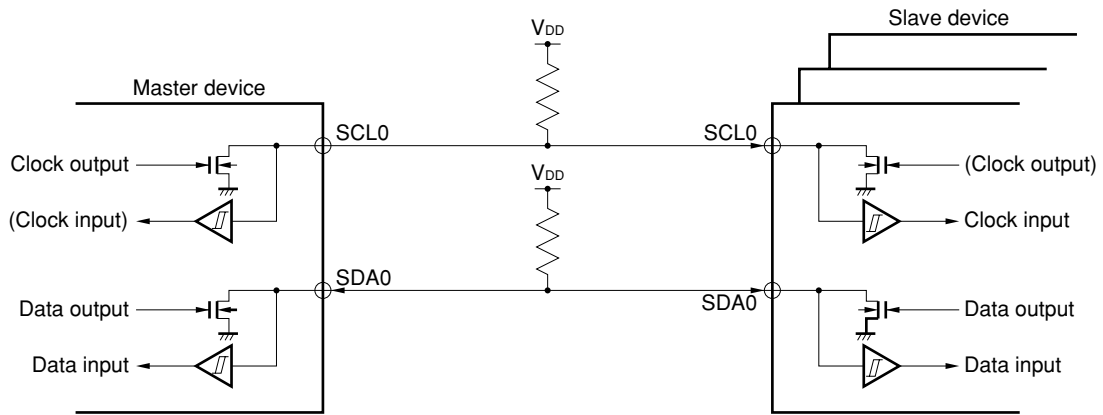
19.4.1 Pin Configuration

The serial clock pin (SCL0) and the serial data bus pin (SDA0) have the following configurations.

- (1) SCL0 I/O pin for the serial clock
 The outputs to both the master and slave are N-channel open-drains. The input is a Schmitt input.
- (2) SDA0 Shared I/O pin for serial data
 The outputs to both the master and slave are N-channel open-drains. The input is a Schmitt input.

Since the outputs of the serial clock line and serial data bus line are N-channel open-drains, external pull-up resistors are required.

Figure 19-6. Pin Configuration

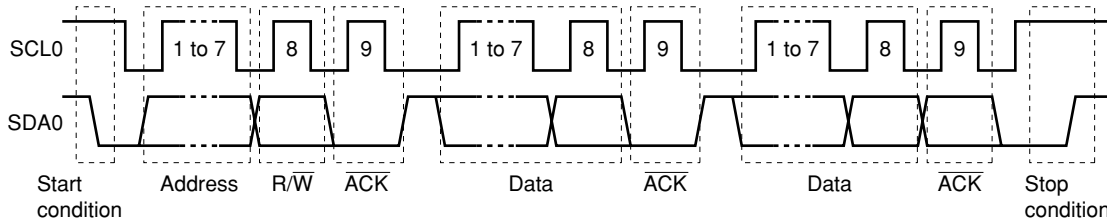


19.5 I²C Bus Definitions and Control Method

Next, the serial data communication formats of the I²C bus and the meanings of the signals used are described.

Figure 19-7 shows the transfer timing of the start condition, data, and stop condition that are output on the serial data bus of the I²C bus.

Figure 19-7. Serial Data Transfer Timing of I²C Bus



The master outputs the start condition, slave address, and stop condition.

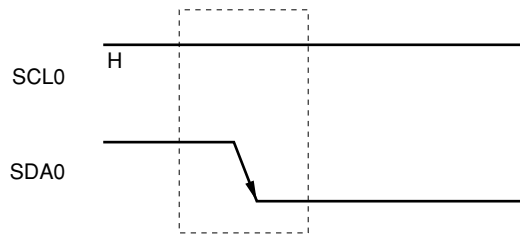
The acknowledge signal ($\overline{\text{ACK}}$) can be output by either the master or slave (Normally, this is output on side receiving 8-bit data).

The serial clock (SCL0) continues to the master output. However, the slave can extend the SCL0 low-level period and insert waits.

19.5.1 Start condition

When the SCL0 pin is high, the start condition is the SDA0 pin changing from high to low. The start conditions for the SCL0 and SDA0 pins are the signals output when the master starts the serial transfer to the slave. The slave has hardware that detects the start condition.

Figure 19-8. Start Condition



The start condition is output when bit 1 (STT0) of the I²C bus control register (IICC0) is set to 1 in the stop condition detection state (SPD0: when bit 0 in the I²C bus status register (IICS0) = 1). In addition, when the start condition is detected, bit 1 (STD0) in IICS0 is set to 1.

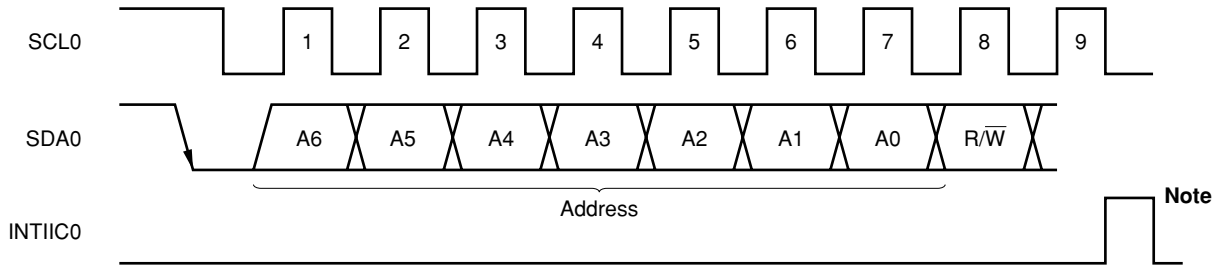
19.5.2 Address

The 7-bit data following the start condition defines the address.

The address is 7-bit data that is output so that the master selects a specific slave from the multiple slaves connected to the bus line. Therefore, the slaves on the bus line must have different addresses.

The slave detects this condition by hardware, and determines whether the 7-bit data matches the slave address register (SVA0). After the slave was selected when the 7-bit data matched the SVA0 value, communication with the master continues until the master sends a start or stop condition.

Figure 19-9. Address



Note When data other than base address or extended code was received during slave operation, INTIIC0 is not generated.

The address is output by matching the slave address and the transfer direction described in **19.5.3 Transfer direction specification** to the serial shift register (IIC0) in 8 bits. In addition, the received address is written to IIC0. The slave address is allocated to the most significant seven bits of IIC0.

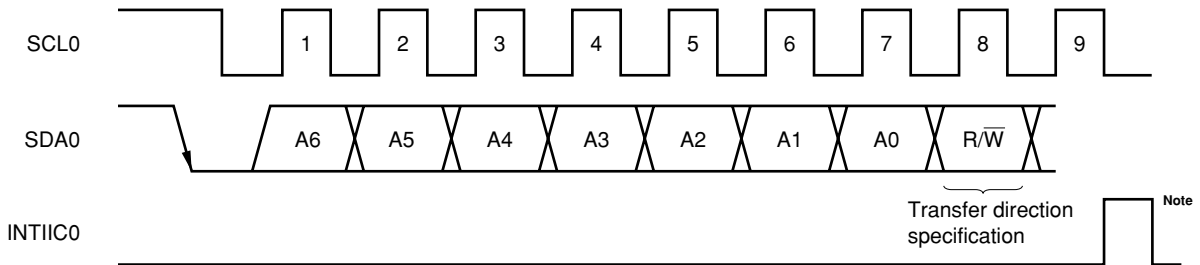
19.5.3 Transfer direction specification

Since the master specifies the transfer direction after the 7-bit address, 1-bit data is transmitted.

A transfer direction specification bit of 0 indicates that the master transmits the data to the slave.

A transfer direction specification bit of 1 indicates that the master receives the data from the slave.

Figure 19-10. Transfer Direction Specification



Note When data other than base address or extended code is received during slave operation, INTIIC0 is not generated.

19.5.4 Acknowledge signal ($\overline{\text{ACK}}$)

The acknowledge signal verifies the reception of the serial data on the transmitting and receiving sides.

The receiving side returns the acknowledge signal each time 8-bit data is received. Usually, after transmitting 8-bit data, the transmitting side receives an acknowledge signal. However, if the master receives, the acknowledge signal is not output when the last data is received. After an 8-bit transmission, the transmitting side detects whether the receiving side returned an acknowledge signal. If an acknowledge signal is returned, the following processing is performed assuming that reception was correctly performed. Since reception has not been performed correctly if the acknowledge signal is not returned from the slave, the master outputs the stop condition to stop transmission.

If an acknowledge signal is not returned, the following two causes are considered.

- (1) The reception is not correct.
- (2) The last data has been received.

When the receiving side sets the SDA0 line low at the ninth clock, the acknowledge signal becomes active (normal reception response).

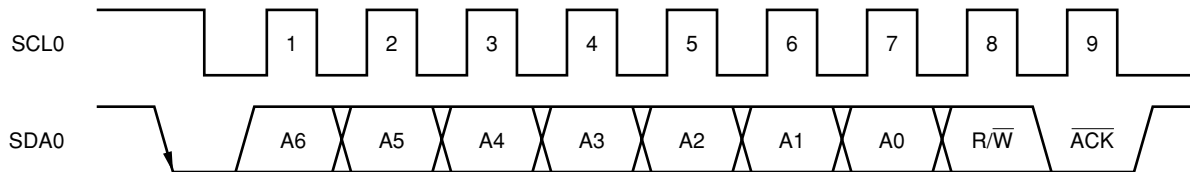
If bit 2 (ACKE0) in the I²C bus control register (IICC0) = 1, the enable automatic generation of the acknowledge signal state is entered.

Bit 3 (TRC0) in the I²C bus status register (IICS0) is set by the data in the eighth bit following the 7-bit address information. However, set ACEK0 = 1 in the reception state when TRC0 bit is 0.

When the slave is receiving (TRC0 = 0), the slave side receives multiple bytes and the next data is not required, when ACEK0 = 0, the master side cannot start the next transfer.

Similarly, the next data is not needed when the master is receiving (TRC0 = 0), set ACEK0 = 0 so that the $\overline{\text{ACK}}$ signal is not generated when you want to output a restart or stop condition. This prevents the output of MSB data in the data on the SDA0 line when the slave is transmitting (transmission stopped).

Figure 19-11. Acknowledge Signal



When receiving the base address, the automatic output of the acknowledge is synchronized to the falling edge of the eighth clock of SCL0 regardless of the ACEK0 value. When receiving at an address other than the base address, the acknowledge signal is not output.

The output method of the acknowledge signal when receiving data is as follows based on the wait timing.

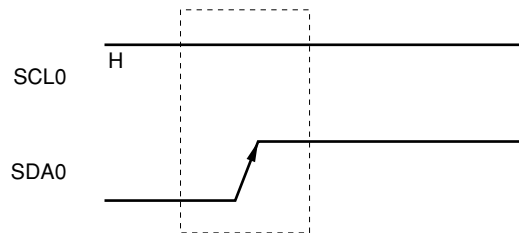
- When 8 clock waits are selected: The acknowledge signal is synchronized to the falling edge of the eighth clock of SCL output by setting ACKE0 = 1 before the wait is released.
- When 9 clock waits are selected: By setting ACKE0 = 1 beforehand, the acknowledge signal is synchronized to the falling edge of the eighth clock of SCL0 and is automatically output.

19.5.5 Stop condition

When the SCL0 pin is high and the SDA0 pin changes from low to high, the stop condition results.

The stop condition is the signal output by the master to the slave when serial transfer ends. The slave has hardware that detects the stop condition.

Figure 19-12. Stop Condition



The stop condition is generated when bit 0 (SPT0) of the I²C bus control register (IICC0) is set to 1. And when the stop condition is detected, if bit 0 (SPD0) in the I²C bus status register (IICS0) is set to 1 and bit 4 (SPIE0) of IICC0 is also set to 1, INTIIC0 is generated.

19.5.6 Wait signal ($\overline{\text{WAIT}}$)

The wait signal notifies the other side that the master or slave is being prepared (wait state) for data communication.

The wait state is notified to the other side by setting the SCL0 pin low. When both the master and the slave are released from the wait state, the next transfer can start.

Figure 19-13. Wait Signal (1/2)

(1) The master has a 9 clock wait, and the slave has an 8 clock wait
(Master: transmitting, Slave: receiving, ACKE0 = 1)

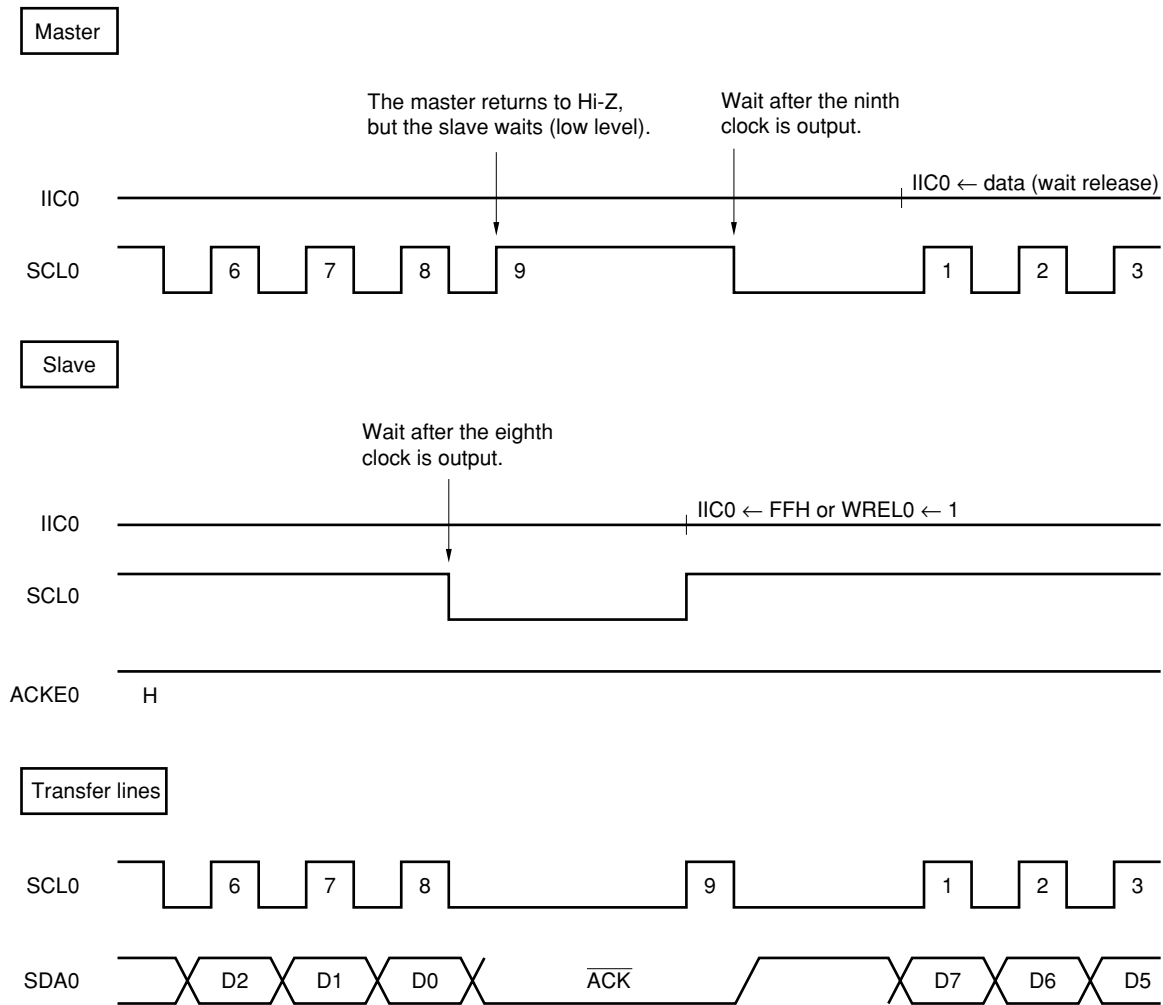
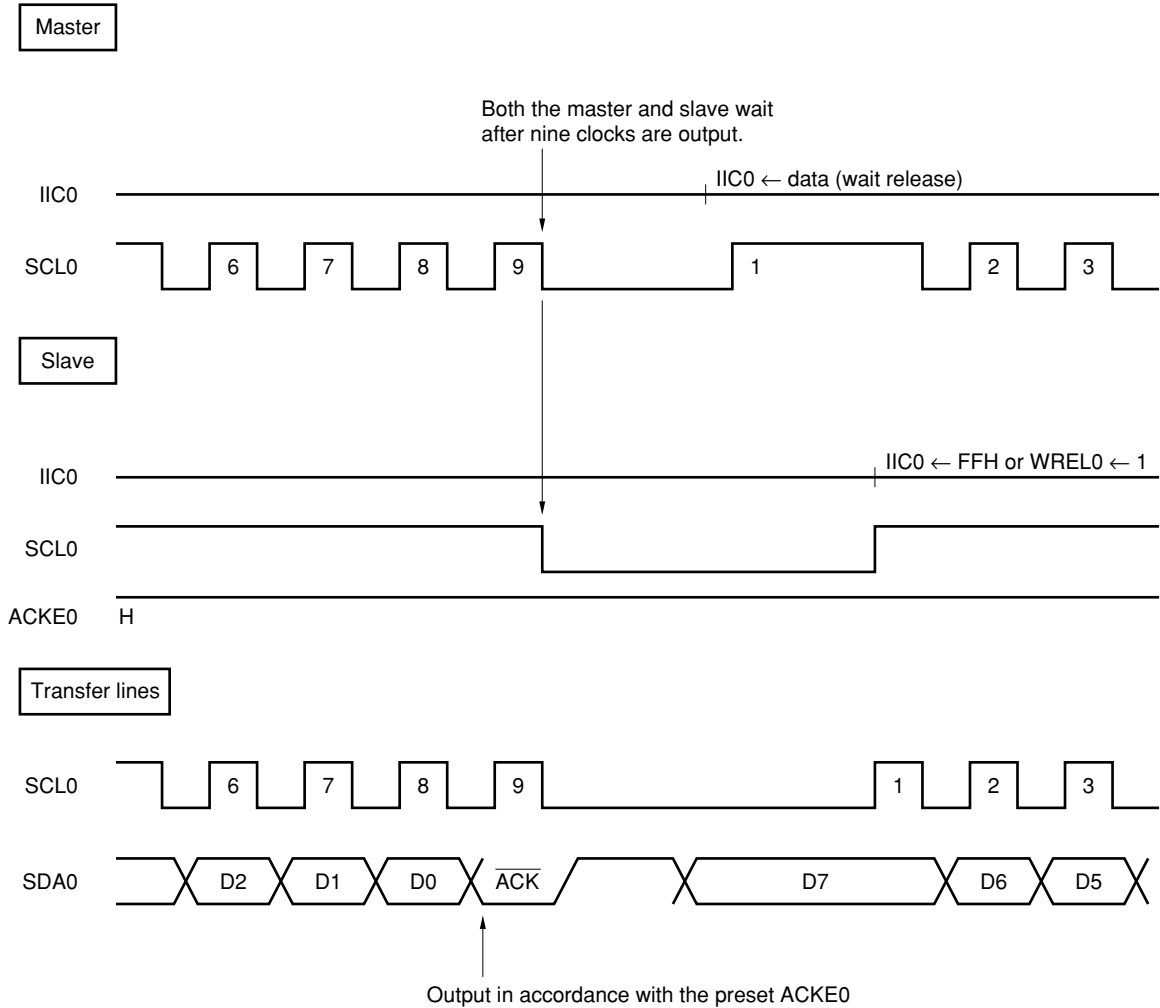


Figure 19-13. Wait Signal (2/2)

(2) Both the master and slave have 9 clock waits
(Master: transmitting, Slave: receiving, ACKE0 = 1)



Remark ACKE0: Bit 2 in the I²C bus control register (IICC0)
WREL0: Bit 5 in the I²C bus control register (IICC0)

A wait is automatically generated by setting bit 3 (WTIM0) of the I²C bus control register (IICC0).

Normally, when bit 5 (WREL0) in IICC0 = 1 or FFH is written to the serial shift register (IIC0), the receiving side releases the wait; when data is written to IIC0, the transmitting side releases the wait.

In the master, the wait can be released by the following methods.

- IICC0 bit 1 (STT0) = 1
- IICC0 bit 0 (SPT0) = 1

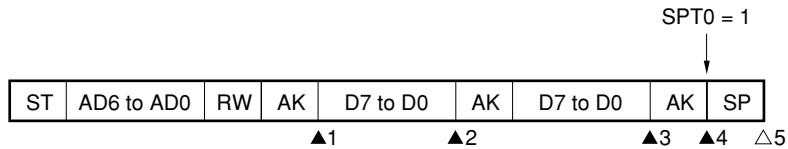
19.5.7 I²C interrupt request (INTIIC0)

This section describes the values of the I²C bus status register (IICS0) at the INTIIC0 interrupt request generation timing and the INTIIC0 interrupt request timing.

(1) Master operation

(a) Start - Address - Data - Data - Stop (normal communication)

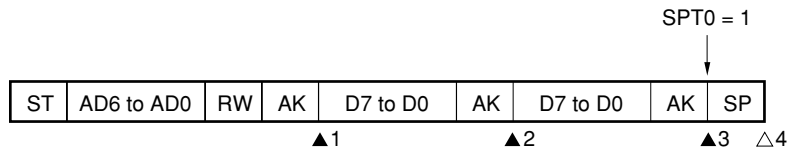
<1> When WTIM0 = 0



- ▲1: IICS0 = 10xxx110B
- ▲2: IICS0 = 10xxx000B
- ▲3: IICS0 = 10xxx000B (WTIM0 = 1)
- ▲4: IICS0 = 10xxxx00B
- △5: IICS0 = 0000001B

Remarks ▲: Always generated.
 △: Generated only when SPIE0 = 1
 ×: Don't care

<2> When WTIM0 = 1

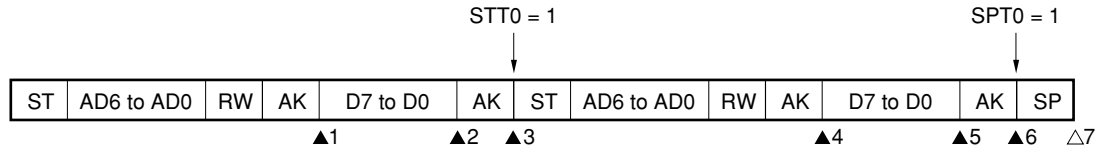


- ▲1: IICS0 = 10xxx110B
- ▲2: IICS0 = 10xxx100B
- ▲3: IICS0 = 10xxxx00B
- △4: IICS0 = 0000001B

Remarks ▲: Always generated.
 △: Generated only when SPIE0 = 1
 ×: Don't care

(b) Start - Address - Data - Start - Address - Data - Stop (Restart)

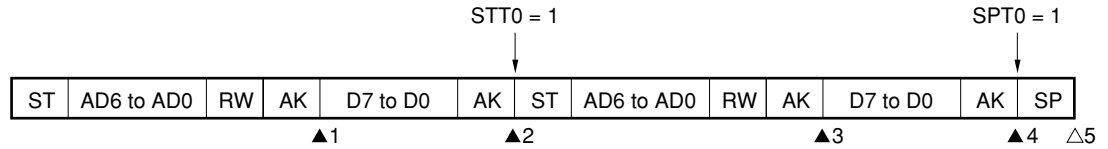
<1> When WTIM0 = 0



- ▲1: IICS0 = 10xxx110B
- ▲2: IICS0 = 10xxx000B (WTIM0 = 1)
- ▲3: IICS0 = 10xxxx00B (WTIM0 = 0)
- ▲4: IICS0 = 10xxx110B (WTIM0 = 0)
- ▲5: IICS0 = 10xxx000B (WTIM0 = 1)
- ▲6: IICS0 = 10xxxx00B
- △7: IICS0 = 0000001B

Remarks ▲: Always generated.
 △: Generated only when SPIE0 = 1
 ×: Don't care

<2> When WTIM0 = 1

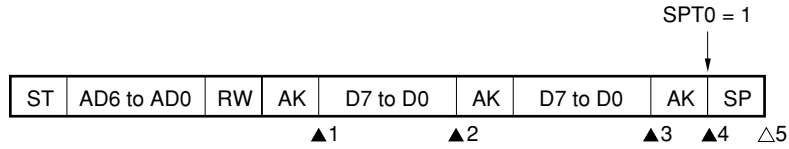


- ▲1: IICS0 = 10xxx110B
- ▲2: IICS0 = 10xxxx00B
- ▲3: IICS0 = 10xxx110B
- ▲4: IICS0 = 10xxxx00B
- △5: IICS0 = 0000001B

Remarks ▲: Always generated.
 △: Generated only when SPIE0 = 1
 ×: Don't care

(c) Start - Code - Data - Data - Stop (Extended code transmission)

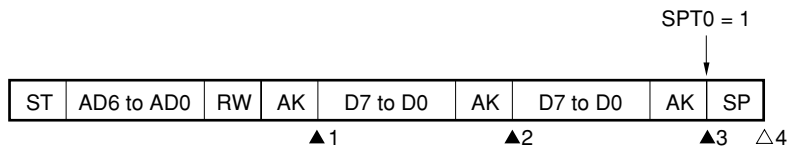
<1> When WTIM0 = 0



- ▲1: IICS0 = 1010×110B
- ▲2: IICS0 = 1010×000B
- ▲3: IICS0 = 1010×000B (WTIM0 = 1)
- ▲4: IICS0 = 1010××00B
- Δ5: IICS0 = 00000001B

Remarks ▲: Always generated.
 Δ: Generated only when SPIE0 = 1
 ×: Don't care

<2> When WTIM0 = 1



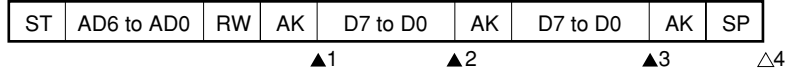
- ▲1: IICS0 = 1010×110B
- ▲2: IICS0 = 1010×100B
- ▲3: IICS0 = 1010××00B
- Δ4: IICS0 = 00000001B

Remarks ▲: Always generated.
 Δ: Generated only when SPIE0 = 1
 ×: Don't care

(2) Slave operation (when receiving slave address data (SVA0 match))

(a) Start - Address - Data - Data - Stop

<1> When WTIM0 = 0



▲1: IICS0 = 0001×110B

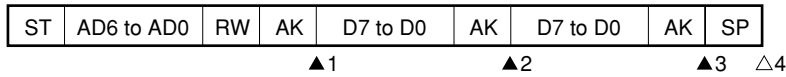
▲2: IICS0 = 0001×000B

▲3: IICS0 = 0001×000B

△4: IICS0 = 00000001B

Remarks ▲: Always generated.
 △: Generated only when SPIE0 = 1
 ×: Don't care

<2> When WTIM0 = 1



▲1: IICS0 = 0001×110B

▲2: IICS0 = 0001×100B

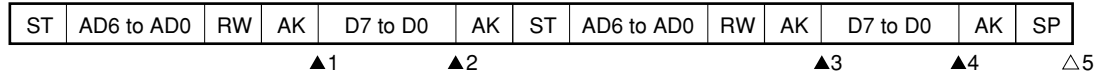
▲3: IICS0 = 0001××00B

△4: IICS0 = 00000001B

Remarks ▲: Always generated.
 △: Generated only when SPIE0 = 1
 ×: Don't care

(b) Start - Address - Data - Start - Address - Data - Stop

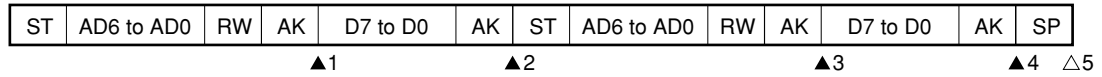
<1> When WTIM0 = 0 (SVA0 match after restart)



- ▲1: IICS0 = 0001×110B
- ▲2: IICS0 = 0001×000B
- ▲3: IICS0 = 0001×110B
- ▲4: IICS0 = 0001×000B
- △5: IICS0 = 00000001B

Remarks ▲: Always generated.
 △: Generated only when SPIE0 = 1
 ×: Don't care

<2> When WTIM0 = 1 (SVA0 match after restart)

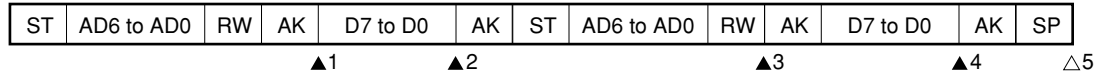


- ▲1: IICS0 = 0001×110B
- ▲2: IICS0 = 0001××00B
- ▲3: IICS0 = 0001×110B
- ▲4: IICS0 = 0001××00B
- △5: IICS0 = 00000001B

Remarks ▲: Always generated.
 △: Generated only when SPIE0 = 1
 ×: Don't care

(c) Start - Address - Data - Start - Code - Data - Stop

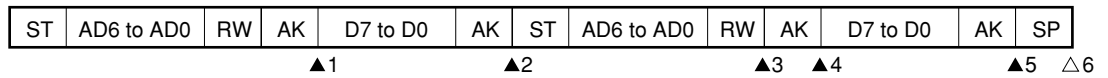
<1> When WTIM0 = 0 (extended code received after restart)



- ▲1: IICS0 = 0001×110B
- ▲2: IICS0 = 0001×000B
- ▲3: IICS0 = 0010×010B
- ▲4: IICS0 = 0010×000B
- △5: IICS0 = 00000001B

Remarks ▲: Always generated.
 △: Generated only when SPIE0 = 1
 ×: Don't care

<2> When WTIM0 = 1 (extended code received after restart)

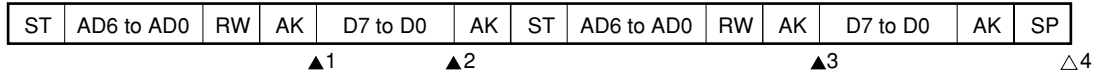


- ▲1: IICS0 = 0001×110B
- ▲2: IICS0 = 0001××00B
- ▲3: IICS0 = 0010×010B
- ▲4: IICS0 = 0010×110B
- ▲5: IICS0 = 0010××00B
- △6: IICS0 = 00000001B

Remarks ▲: Always generated.
 △: Generated only when SPIE0 = 1
 ×: Don't care

(d) Start - Address - Data - Start - Address - Data - Stop

<1> When WTIM0 = 0 (no address match after restart (not extended code))



- ▲1: IICS0 = 0001×110B
- ▲2: IICS0 = 0001×000B
- ▲3: IICS0 = 0000××10B
- △4: IICS0 = 00000001B

Remarks ▲: Always generated.
 △: Generated only when SPIE0 = 1
 ×: Don't care

<2> When WTIM0 = 1 (no address match after restart (not extended code))



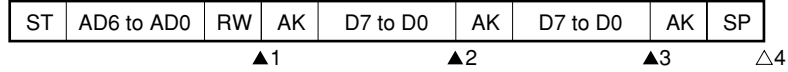
- ▲1: IICS0 = 0001×110B
- ▲2: IICS0 = 0001××00B
- ▲3: IICS0 = 0000××10B
- △4: IICS0 = 00000001B

Remarks ▲: Always generated.
 △: Generated only when SPIE0 = 1
 ×: Don't care

(3) Slave operation (when receiving the extended code)

(a) Start - Code - Data - Data - Stop

<1> When WTIM0 = 0



▲1: IICS0 = 0010×010B

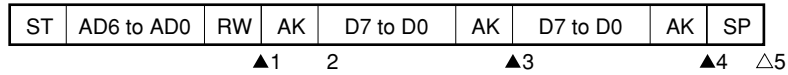
▲2: IICS0 = 0010×000B

▲3: IICS0 = 0010×000B

△4: IICS0 = 00000001B

- Remarks** ▲: Always generated.
 △: Generated only when SPIE0 = 1
 ×: Don't care

<2> When WTIM0 = 1



▲1: IICS0 = 0010×010B

▲2: IICS0 = 0010×110B

▲3: IICS0 = 0010×100B

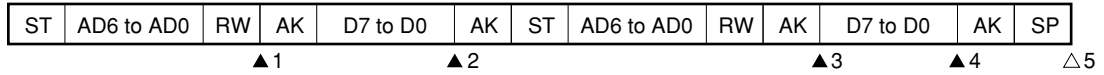
▲4: IICS0 = 0010××00B

△5: IICS0 = 00000001B

- Remarks** ▲: Always generated.
 △: Generated only when SPIE0 = 1
 ×: Don't care

(b) Start - Code - Data - Start - Address - Data - Stop

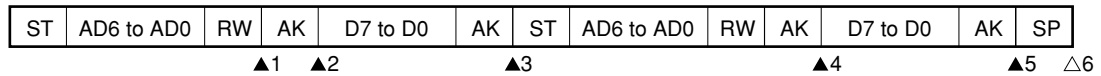
<1> When WTIM0 = 0 (SVA0 match after restart)



- ▲1: IICS0 = 0010×010B
- ▲2: IICS0 = 0010×000B
- ▲3: IICS0 = 0001×110B
- ▲4: IICS0 = 0001×000B
- △5: IICS0 = 00000001B

Remarks ▲: Always generated.
 △: Generated only when SPIE0 = 1
 ×: Don't care

<2> When WTIM0 = 1 (SVA0 match after restart)

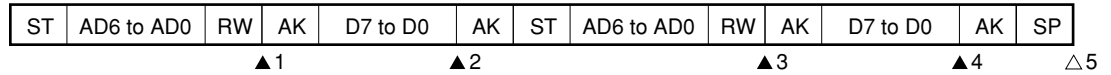


- ▲1: IICS0 = 0010×010B
- ▲2: IICS0 = 0010×110B
- ▲3: IICS0 = 0010××00B
- ▲4: IICS0 = 0001×110B
- ▲5: IICS0 = 0001××00B
- △6: IICS0 = 00000001B

Remarks ▲: Always generated.
 △: Generated only when SPIE0 = 1
 ×: Don't care

(c) Start - Code - Data - Start - Code - Data - Stop

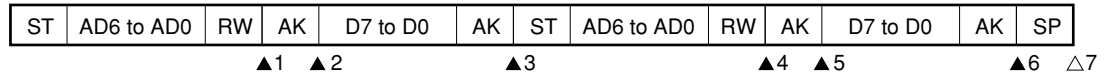
<1> When WTIM0 = 0 (extended code received after restart)



- ▲1: IICSO = 0010×010B
- ▲2: IICSO = 0010×000B
- ▲3: IICSO = 0010×010B
- ▲4: IICSO = 0010×000B
- △5: IICSO = 00000001B

Remarks ▲: Always generated.
 △: Generated only when SPIE0 = 1
 ×: Don't care

<2> When WTIM0 = 1 (extended code received after restart)

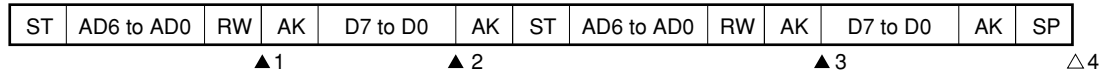


- ▲1: IICSO = 0010×010B
- ▲2: IICSO = 0010×110B
- ▲3: IICSO = 0010××00B
- ▲4: IICSO = 0010×010B
- ▲5: IICSO = 0010×110B
- ▲6: IICSO = 0010××00B
- △7: IICSO = 00000001B

Remarks ▲: Always generated.
 △: Generated only when SPIE0 = 1
 ×: Don't care

(d) Start - Code - Data - Start - Address - Data - Stop

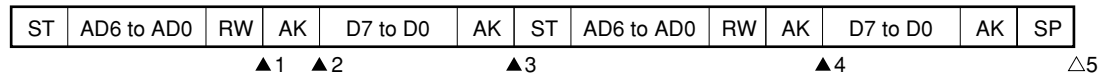
<1> When WTIM0 = 0 (no address match after restart (not an extended code))



- ▲1: IIC50 = 0010×010B
- ▲2: IIC50 = 0010×000B
- ▲3: IIC50 = 00000×10B
- △4: IIC50 = 00000001B

Remarks ▲: Always generated.
 △: Generated only when SPIE0 = 1
 ×: Don't care

<2> When WTIM0 = 1 (no address match after restart (not an extended code))

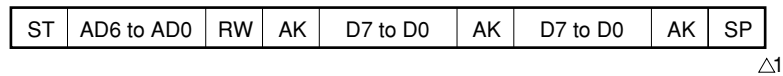


- ▲1: IIC50 = 0010×010B
- ▲2: IIC50 = 0010×110B
- ▲3: IIC50 = 0010××00B
- ▲4: IIC50 = 00000×10B
- △5: IIC50 = 00000001B

Remarks ▲: Always generated.
 △: Generated only when SPIE0 = 1
 ×: Don't care

(4) Not participating in communication

(a) Start - Code - Data - Data - Stop



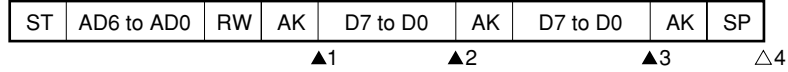
- △1: IIC50 = 00000001B

Remarks △: Generated only when SPIE0 = 1

(5) Arbitration failed operation (operates as the slave after arbitration fails)

(a) When arbitration failed while transmitting slave address data

<1> When WTIM0 = 0



▲1: IICS0 = 0101×110B (**Example:** Read ALD0 during interrupt servicing.)

▲2: IICS0 = 0001×000B

▲3: IICS0 = 0001×000B

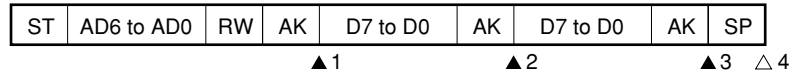
△4: IICS0 = 00000001B

Remarks ▲: Always generated.

△: Generated only when SPIE0 = 1

×: Don't care

<2> When WTIM0 = 1



▲1: IICS0 = 0101×110B (**Example:** Read ALD0 during interrupt servicing.)

▲2: IICS0 = 0001×100B

▲3: IICS0 = 0001××00B

△4: IICS0 = 00000001B

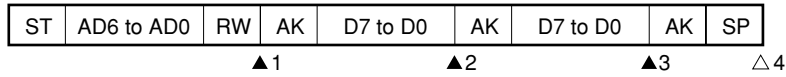
Remarks ▲: Always generated.

△: Generated only when SPIE0 = 1

×: Don't care

(b) When arbitration failed while transmitting an extended code

<1> When WTIM0 = 0



▲1: IICS0 = 0110×010B (**Example:** Read ALD0 during interrupt servicing.)

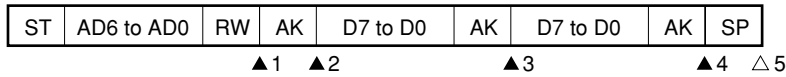
▲2: IICS0 = 0010×000B

▲3: IICS0 = 0010×000B

△4: IICS0 = 00000001B

Remarks ▲: Always generated.
 △: Generated only when SPIE0 = 1
 ×: Don't care

<2> When WTIM0 = 1



▲1: IICS0 = 0110×010B (**Example:** Read ALD0 during interrupt servicing.)

▲2: IICS0 = 0010×110B

▲3: IICS0 = 0010×100B

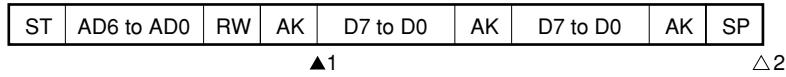
▲4: IICS0 = 0010××00B

△5: IICS0 = 00000001B

Remarks ▲: Always generated.
 △: Generated only when SPIE0 = 1
 ×: Don't care

(6) Arbitration failed operation (no participation after arbitration failed)

(a) When arbitration failed while transmitting slave address data



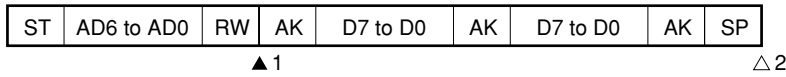
▲1: IICS0 = 01000110B (**Example:** Read ALD0 during interrupt servicing.)

△2: IICS0 = 00000001B

Remarks ▲: Always generated.

△: Generated only when SPIE0 = 1

(b) When arbitration failed while transmitting an extended code



▲1: IICS0 = 0110x010B (**Example:** Read ALD0 during interrupt servicing.)

Set LREL0 = 1 from the software.

△2: IICS0 = 00000001B

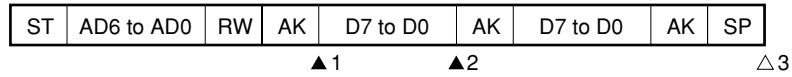
Remarks ▲: Always generated.

△: Generated only when SPIE0 = 1

x: Don't care

(c) When arbitration failed during a data transfer

<1> When WTIM0 = 0



▲1: IICS0 = 10001110B

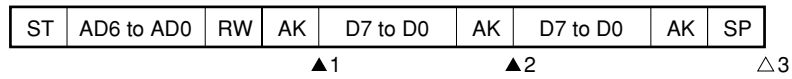
▲2: IICS0 = 01000000B (**Example:** Read ALD0 during interrupt servicing.)

△3: IICS0 = 00000001B

Remarks ▲: Always generated.

△: Generated only when SPIE0 = 1

<2> When WTIM0 = 1



▲1: IICS0 = 10001110B

▲2: IICS0 = 01000100B (**Example:** Read ALD0 during interrupt servicing.)

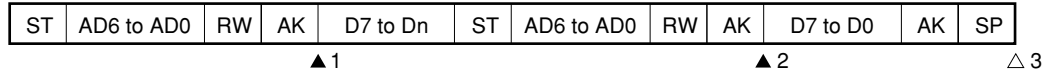
△3: IICS0 = 00000001B

Remarks ▲: Always generated.

△: Generated only when SPIE0 = 1

(d) When failed in the restart condition during a data transfer

<1> Not an extended code (Example: SVA0 match)



▲1: IICS0 = 1000×110B

▲2: IICS0 = 01000110B (Example: Read ALD0 during interrupt servicing.)

△3: IICS0 = 00000001B

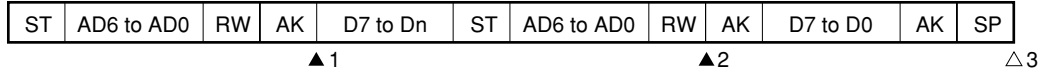
Remarks ▲: Always generated.

△: Generated only when SPIE0 = 1

×: Don't care

Dn = D6 to D0

<2> Extended code



▲1: IICS0 = 1000×110B

▲2: IICS0 = 0110×010B (Example: Read ALD0 during interrupt servicing.)

IICC0:LREL0 = 1 set by software.

△3: IICS0 = 00000001B

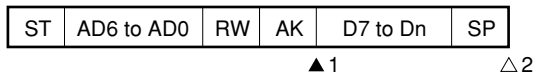
Remarks ▲: Always generated.

△: Generated only when SPIE0 = 1

×: Don't care

Dn = D6 to D0

(e) When failed in the stop condition during a data transfer



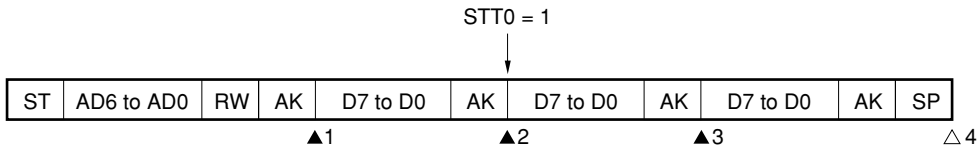
▲1: IICS0 = 1000×110B

△2: IICS0 = 01000001B

Remarks ▲: Always generated.
 △: Generated only when SPIE0 = 1
 ×: Don't care
 Dn = D6 to D0

(f) When arbitration failed at a low data level and the restart condition was about to be generated

When WTIM0 = 1



▲1: IICS0 = 1000×110B

▲2: IICS0 = 1000××00B

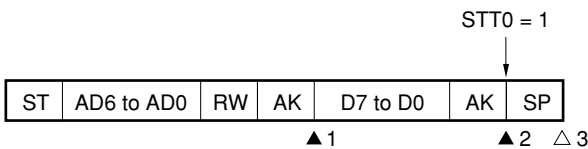
▲3: IICS0 = 01000100B (**Example:** Read ALD0 during interrupt servicing.)

△4: IICS0 = 00000001B

Remarks ▲: Always generated.
 △: Generated only when SPIE0 = 1
 ×: Don't care

(g) When arbitration failed in a stop condition and the restart condition was about to be generated

When WTIM0 = 1



▲1: IICS0 = 1000×110B

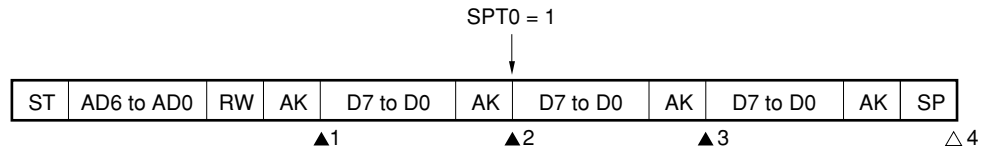
▲2: IICS0 = 1000××00B

△3: IICS0 = 01000001B

Remarks ▲: Always generated.
 △: Generated only when SPIE0 = 1
 ×: Don't care

(h) When arbitration failed in the low data level and the stop condition was about to be generated

When WTIM0 = 1



▲1: IICS0 = 1000×110B

▲2: IICS0 = 1000××00B

▲3: IICS0 = 01000000B (**Example:** Read ALD0 during interrupt servicing)

△4: IICS0 = 00000001B

Remarks ▲: Always generated.

△: Generated only when SPIE0 = 1

×: Don't care

19.5.8 Interrupt request (INTIIC0) generation timing and wait control

By setting the WTIM0 bit in the I²C bus control register (IICC0), INTIIC0 is generated at the timing shown in Table 19-2 and wait control is performed.

Table 19-2. INTIIC0 Generation Timing and Wait Control

WTIM0	During Slave Operation			During Master Operation		
	Address	Data Reception	Data Transmission	Address	Data Reception	Data Transmission
0	gNotes 1, 2	gNote 2	gNote 2	9	8	8
1	gNotes 1, 2	gNote 2	gNote 2	9	9	9

Notes 1. The INTIIC0 signal and wait of the slave are generated on the falling edge of the ninth clock only when the address set in the slave address register (SVA0) matches.

In this case, $\overline{\text{ACK}}$ is output regardless of the ACKE0 setting. The slave that received the extended code generates INTIIC0 at the falling edge of the eighth clock.

2. When the address that received SVA0 does not match, INTIIC0 and wait are not generated.

Remark The numbers in the table indicate the number of clocks in the serial clock. In addition, the interrupt request and wait control are both synchronized to the falling edge of the serial clock.

(1) When transmitting and receiving an address

- When the slave is operating: The interrupt and wait timing are determined regardless of the WTIM0 bit.
- When the master is operating: The interrupt and wait timing are generated by the falling edge of the ninth clock regardless of the WTIM0 bit.

(2) When receiving data

- When the master and slave are operating: The interrupt and wait timing are set by the WTIM0 bit.

(3) When transmitting data

- When the master and slave are operating: The interrupt and wait timing are set by the WTIM0 bit.

(4) Releasing a wait

The following four methods release a wait.

- WREL0 = 1 in the I²C bus control register (IICC0)
- Writing to the serial shift register (IIC0)
- Setting the start condition (STT0 = 1 in IICC0)
- Setting the stop condition (SPT0 = 1 in IICC0)

When eight clock waits are selected (WTIM0 = 0), the output level of $\overline{\text{ACK}}$ must be determined before releasing the wait.

(5) Stop condition detection

INTIIC0 is generated when the stop condition is detected.

19.5.9 Address match detection

In the I²C bus mode, the master can select a specific slave device by transmitting the slave address.

An address match is automatically detected by the hardware. When the base address is set in the slave address register (SVA0), if the slave address transmitted from the master matches the address set in SVA0, or if the extended code is received, an INTIIC0 interrupt request occurs.

19.5.10 Error detection

In the I²C bus mode, since the state of the serial bus (SDA0) during transmission is introduced into the serial shift register (IIC0) of the transmitting device, transmission errors can be detected by comparing the IIC0 data before and after the transmission. In this case, if two data differ, the decision is that a transmission error was generated.

19.5.11 Extended codes

- (1) If the most significant four bits of the receiving address are 0000 or 1111, an extended code is received and the extended code received flag (EXC0) is set. The interrupt request (INTIIC0) is generated at the falling edge of the eighth clock. The base address stored in the slave address register (SVA0) is not affected.
- (2) In 10-bit address transfers, the following occurs when 111110xx is set in SVA0 and 111110xx0 is transferred from the master. However, INTIIC0 is generated at the falling edge of the eighth clock.
- Most significant 4 bits of data match: EXC0 = 1^{Note}
 - 7-bit data match: COI0 = 1^{Note}

Note EXC0: Bit 5 of the I²C bus status register (IICS0)
 COI0: Bit 4 of the I²C bus status register (IICS0)

- (3) Since the processing after an interrupt request is generated differs depending on the data that follows the extended code, the software performs this processing.
 For example, when operation as a slave is not desired after an extended code is received, enter the next communication wait state by setting bit 6 (LRELO) of the I²C bus control register (IICC0) to 1.

Table 19-3. Definitions of Extended Code Bits

Slave Address	R/W Bit	Description
0000 000	0	General call address
0000 000	1	Start byte
0000 001	×	CBUS address
0000 010	×	Address reserved in the different bus format
1111 0xx	×	10-bit slave address setting

19.5.12 Arbitration

When multiple masters simultaneously output start conditions (when STT0 = 1 occurs before STD0 = 1^{Note}), the master communicates while the clock is adjusted until the data differ. This operation is called arbitration.

A master that failed arbitration sets the arbitration failed flag (ALD0) of the I²C bus status register (IICS0) at the timing of the failed arbitration. The SCL0 and SDA0 lines enter the high impedance state, and the bus is released.

Failed arbitration is detected when ALD0 = 1 by software at the timing of the interrupt request generated next (eighth or ninth clock, stop condition detection, etc.).

At the timing for generating the interrupt request, refer to **19.5.7 I²C interrupt request (INTIIC0)**.

Note STD0: Bit 1 in the I²C bus status register (IICS0)
 STT0: Bit 1 in the I²C bus control register (IICC0)

Figure 19-14. Example of Arbitration Timing

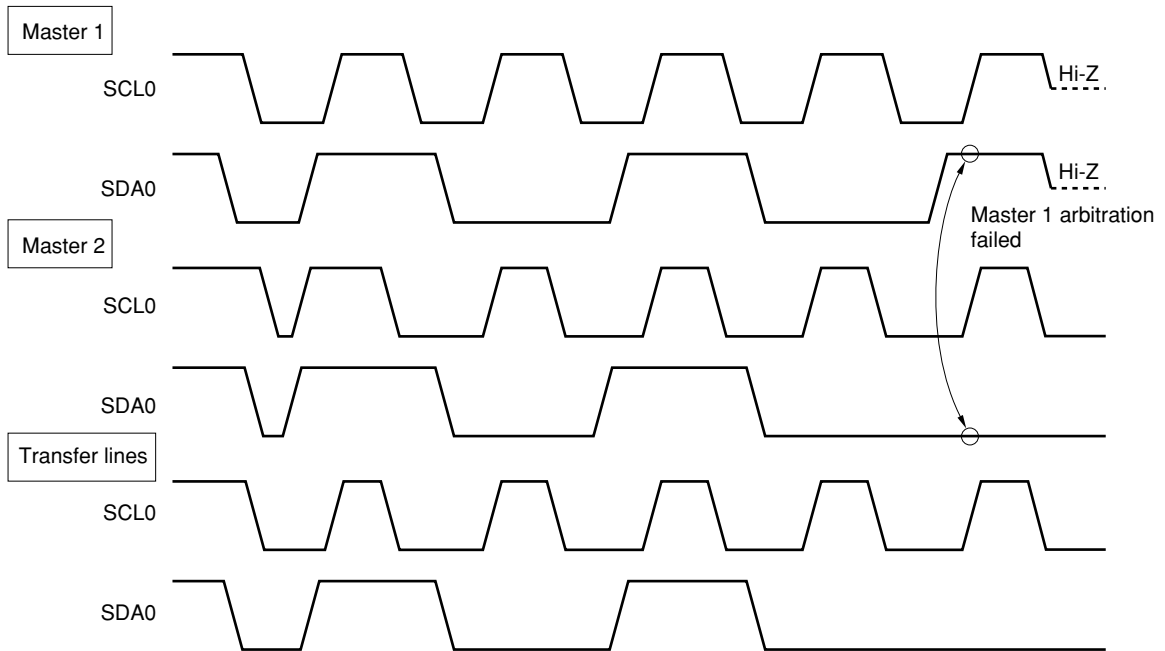


Table 19-4. Arbitration Generation States and Interrupt Request Generation Timing

Arbitration Generation State	Interrupt Request Generation Timing
During address transmission	Falling edge of clock 8 or 9 after byte transfer ^{Note 1}
Read/write information after address transmission	
During extended code transmission	
Read/write information after extended code transmission	
During data transmission	
During $\overline{\text{ACK}}$ transfer period after data transmission	
Restart condition detection during data transfer	
Stop condition detection during data transfer	When stop condition is output (SPIE0 = 1) ^{Note 2}
Data is low when the restart condition is about to be output.	Falling edge of clock 8 or 9 after byte transfer ^{Note 1}
The restart condition should be output, but the stop condition is detected.	Stop condition is output (SPIE0 = 1) ^{Note 2}
Data is low when the stop condition is about to be output.	Falling edge of clock 8 or 9 after byte transfer ^{Note 1}
SCL0 is low when the restart condition is about to be output.	

Notes 1. If WTIM0 = 1 (bit 3 = 1 in the I²C bus control register (IICC0)), an interrupt request is generated at the timing of the falling edge of the ninth clock. If WTIM0 = 0 and the slave address of the extended code is received, an interrupt request is generated at the timing of the falling edge of the eighth clock.

2. When arbitration is possible, use the master to set SPIE0 = 1.

Remark SPIE0: Bit 5 in the I²C bus control register (IICC0)

19.5.13 Wake-up function

This is a slave function of the I²C bus and generates the interrupt request (INTIIC0) when the base address and extended code were received.

When the address does not match, an unused interrupt request is not generated, and efficient processing is possible.

When the start condition is detected, the wake-up standby function is entered. Since the master can become a slave in an arbitration failure (when a start condition was output), the wake-up standby function is entered while the address is transmitted.

However, when the stop condition is detected, the generation of interrupt requests is enabled or disabled based on the setting of bit 5 (SPIE0) in the I²C bus control register (IICC0) unrelated to the wake-up function.

19.5.14 Communication reservation

When you want the master to communicate after being in the not participating state in the bus, the start condition can be transmitted when a bus is released by reserving communication. The following two states are included when the bus does not participate.

- When there was no arbitration in the master and the slave
- When the extended code is received and operation is not as a slave (bus released when \overline{ACK} is not returned, and bit 6 (LREL0) = 1 in the I²C bus control register (IICC0))

When bit 1 (STT0) of IICC0 is set in the not participating state in the bus, after the bus is released (after stop condition detection), the start condition is automatically generated, and the wait state is entered. When the bus release is detected (stop condition detection), the address transfer starts as the master by the write operation of the serial shift register (IIC0). In this case, set bit 4 (SPIE0) in IICC0.

When STT0 is set, whether it operates as a start condition or for communication reservation is determined by the bus state.

- When the bus is released Start condition generation
- When the bus is not released (standby state) Communication reservation

To verify whether STT0 operates as a communication reservation, set STT0 and use MST0 (bit 7 in the I²C bus status register (IICS0)) after the wait time elapses.

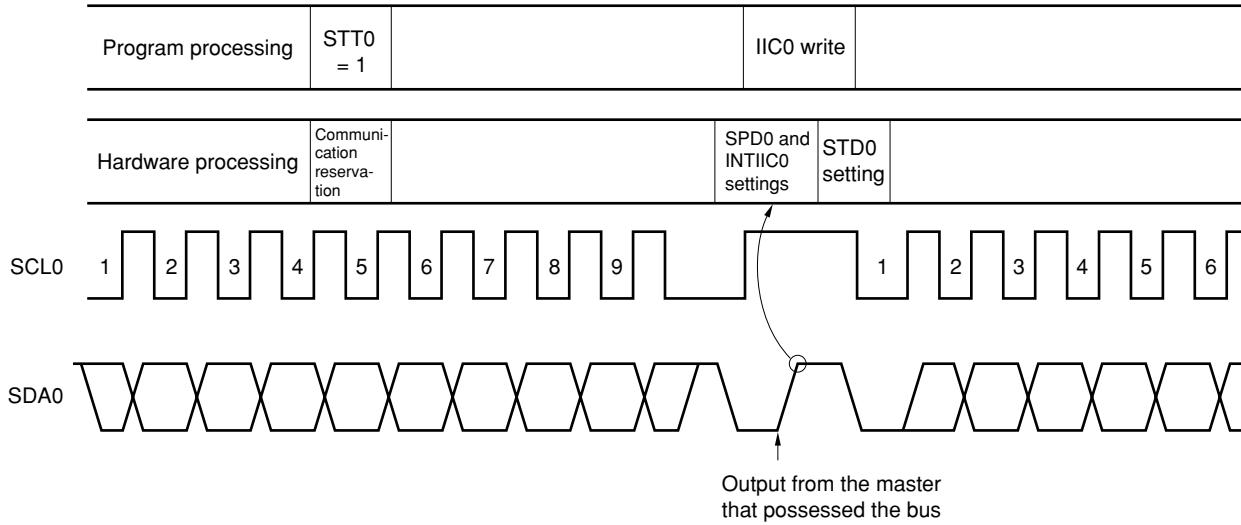
Use the software to save the wait time which is a time listed in Table 19-5. The wait time can be set by bits 3, 1, and 0 (SMC, CL1, and CL0) in the prescaler mode register for the serial clock (SPRM0).

Table 19-5. Wait Times

SMC	CL1	CL0	Wait Time
0	0	0	26 clocks × 1/f _{xx}
0	0	1	46 clocks × 1/f _{xx}
0	1	0	92 clocks × 1/f _{xx}
0	1	1	37 clocks × 1/TM2 output
1	0	0	16 clocks × 1/f _{xx}
1	0	1	
1	1	0	32 clocks × 1/f _{xx}
1	1	1	13 clocks × 1/TM2 output

Figure 19-15 shows the timing of communication reservation.

Figure 19-15. Timing of Communication Reservation



- IIC0: Serial shift register
- STT0: Bit 1 in the I²C bus control register (IICC0)
- STD0: Bit 1 in the I²C bus status register (IICS0)
- SPD0: Bit 0 in the I²C bus status register (IICS0)

The communication reservation is accepted at the following timing. After bit 1 (STD0) = 1 in the I²C bus status register (IICS0), the communication is reserved by bit 1 (STT0) = 1 in the I²C bus control register (IICC0) until the stop condition is detected.

Figure 19-16. Communication Reservation Acceptance Timing

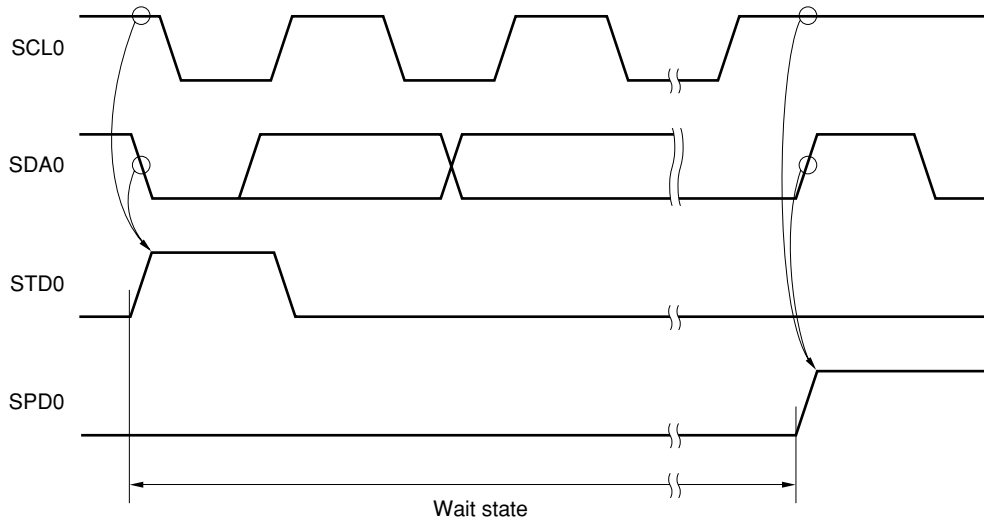
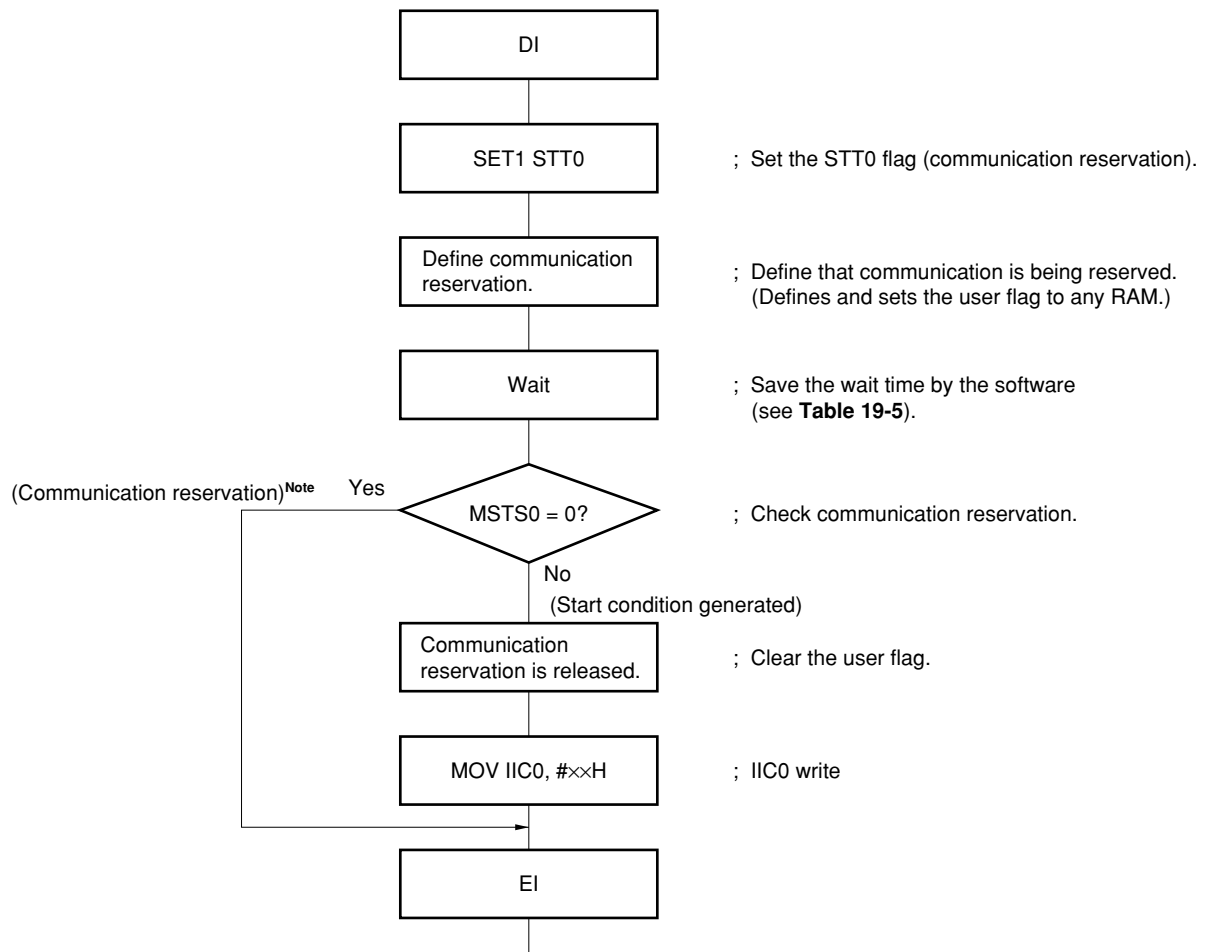


Figure 19-17 shows the communication reservation procedure.

Figure 19-17. Communication Reservation Procedure



Note When the communication is being reserved, the serial shift register (IIC0) is written by the stop condition interrupt.

Remark STT0: Bit 1 in the I²C bus control register (IICC0)
 MSTS0: Bit 7 in the I²C bus status register (IICS0)
 IIC0: Serial shift register

19.5.15 Additional cautions

After a reset, when the master is communicating from the state where the stop condition is not detected (bus is not released), perform master communication after the stop condition is first generated and the bus is released.

The master cannot communicate in the state where the bus is not released (the stop condition is not detected) in the multi-master.

The following procedure generates the stop condition.

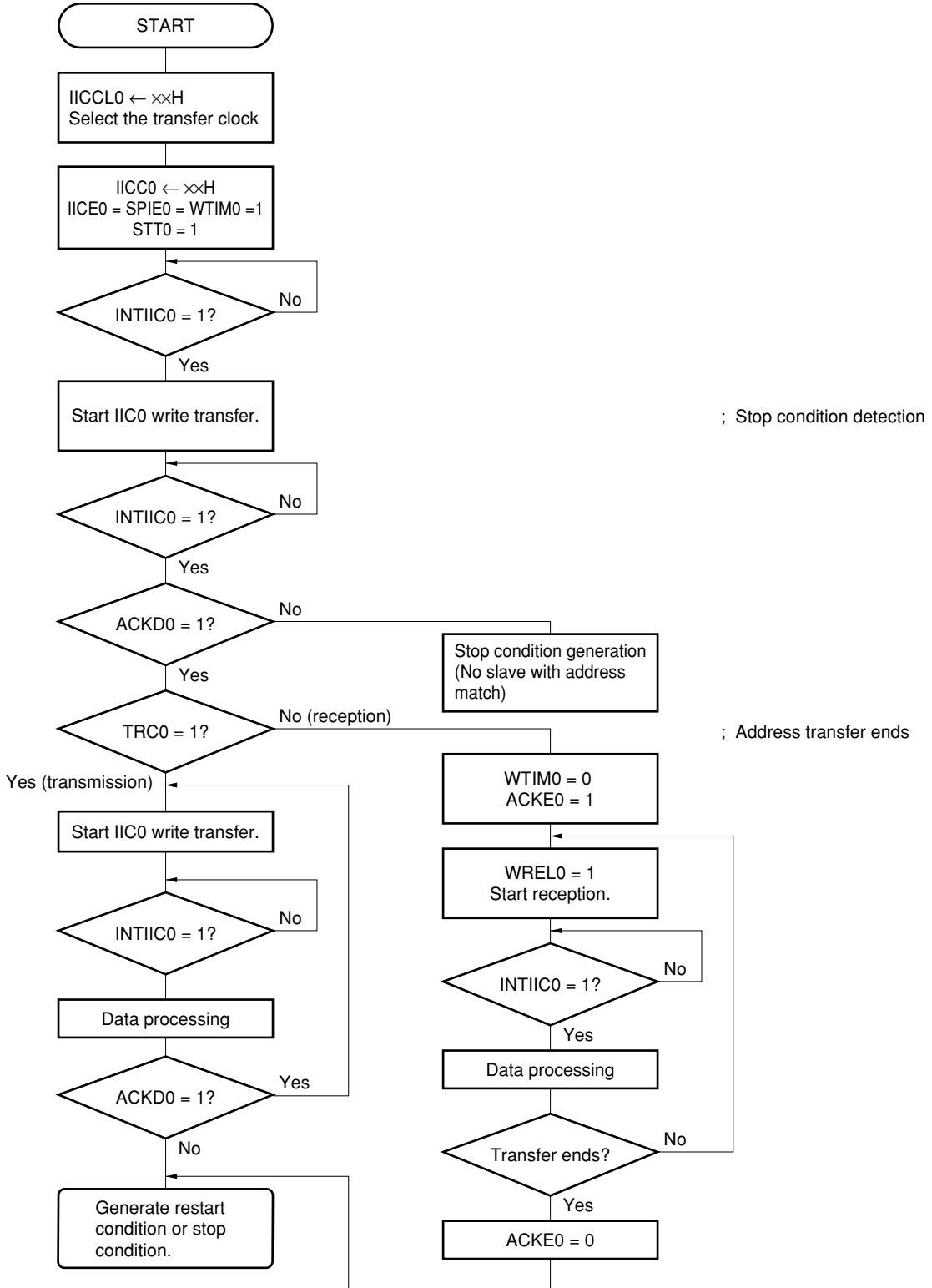
- <1> Set the prescaler mode register for the serial clock (SPRM0).
- <2> Set bit 7 (IICE0) in the I²C bus control register (IICC0).
- <3> Set bit 0 of IICC0.

19.5.16 Communication operation

(1) Master operation

The following example shows the master operating procedure.

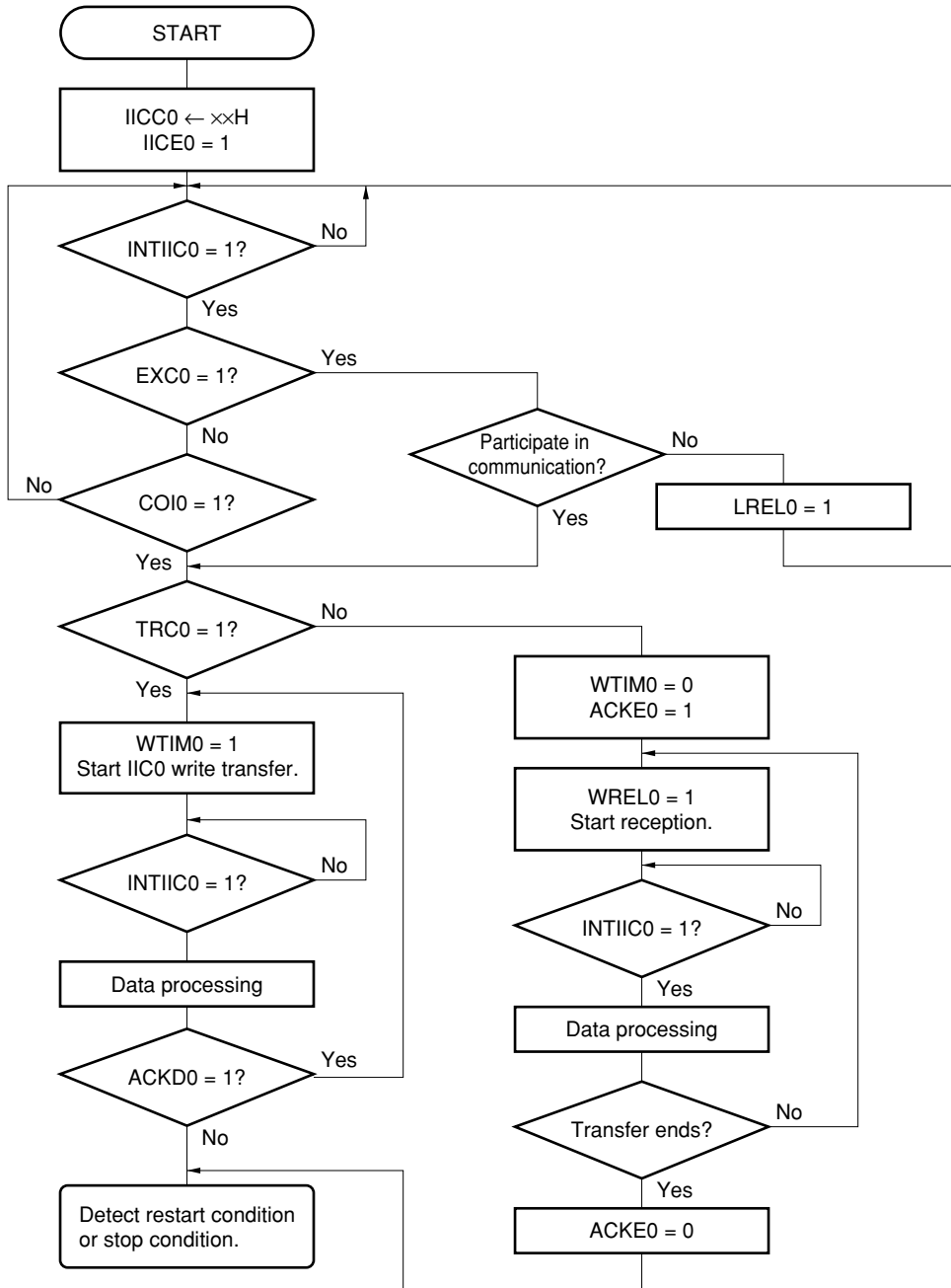
Figure 19-18. Master Operating Procedure



(2) Slave operation

The following example is the slave operating procedure.

Figure 19-19. Slave Operating Procedure



19.6 Timing Charts

In the I²C bus mode, the master outputs an address on the serial bus and selects one of the slave devices from multiple slave devices as the communication target.

The master transmits the TRC0 bit, bit 3 of the I²C bus status register (IICS0), that indicates the transfer direction of the data after the slave address and starts serial communication with the slave.

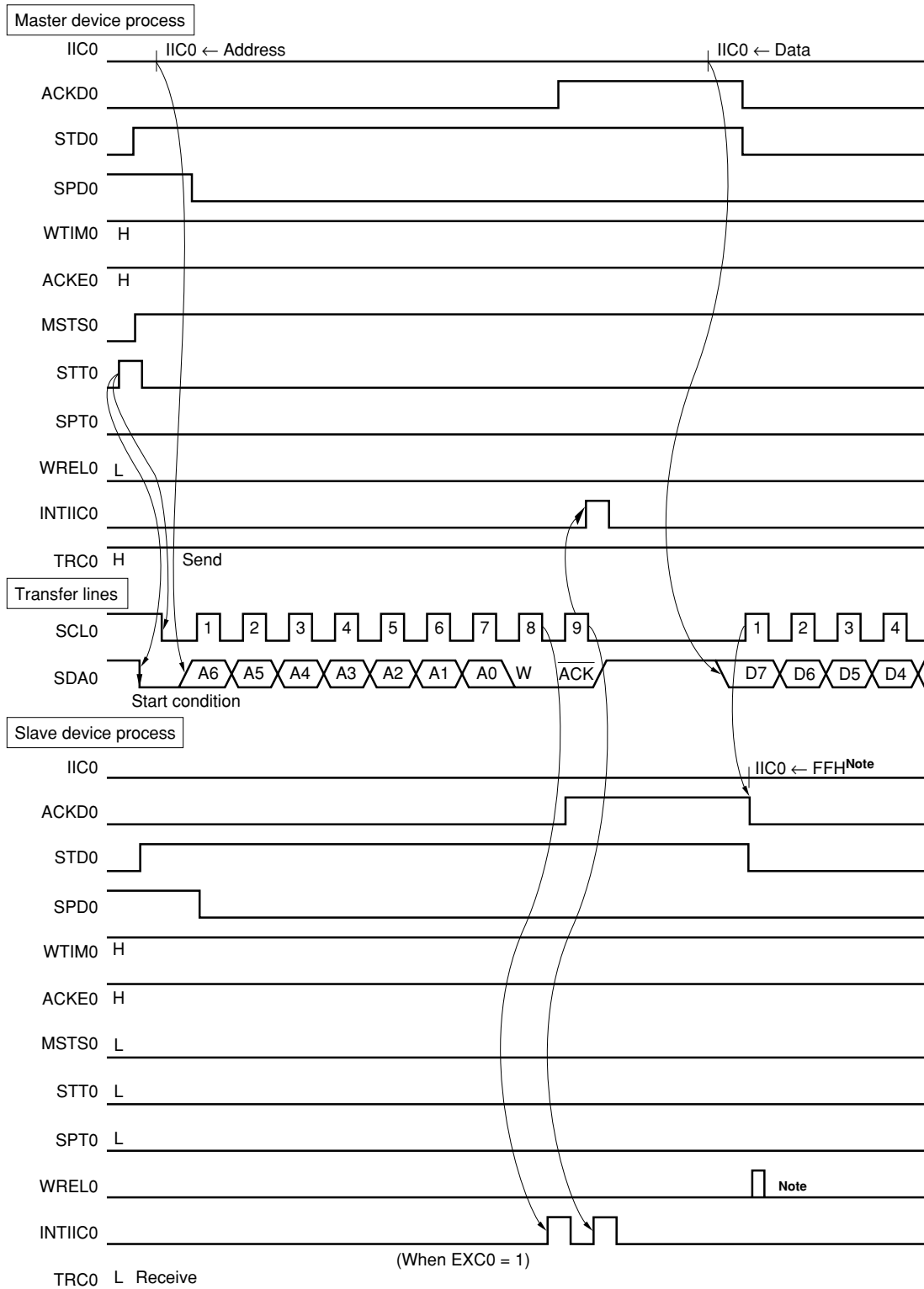
Figures 19-20 and 19-21 are the timing charts for data communication.

Shifting of the shift register (IIC0) is synchronized to the falling edge of the serial clock (SCL0). The transmission data is transferred to the SO0 latch and output from the SDA0 pin with the MSB first.

The data input at the SDA0 pin is received by IIC0 at the rising edge of SCL0.

Figure 19-20. Master → Slave Communication Example
(When Master and Slave Select 9 Clock Waits) (1/3)

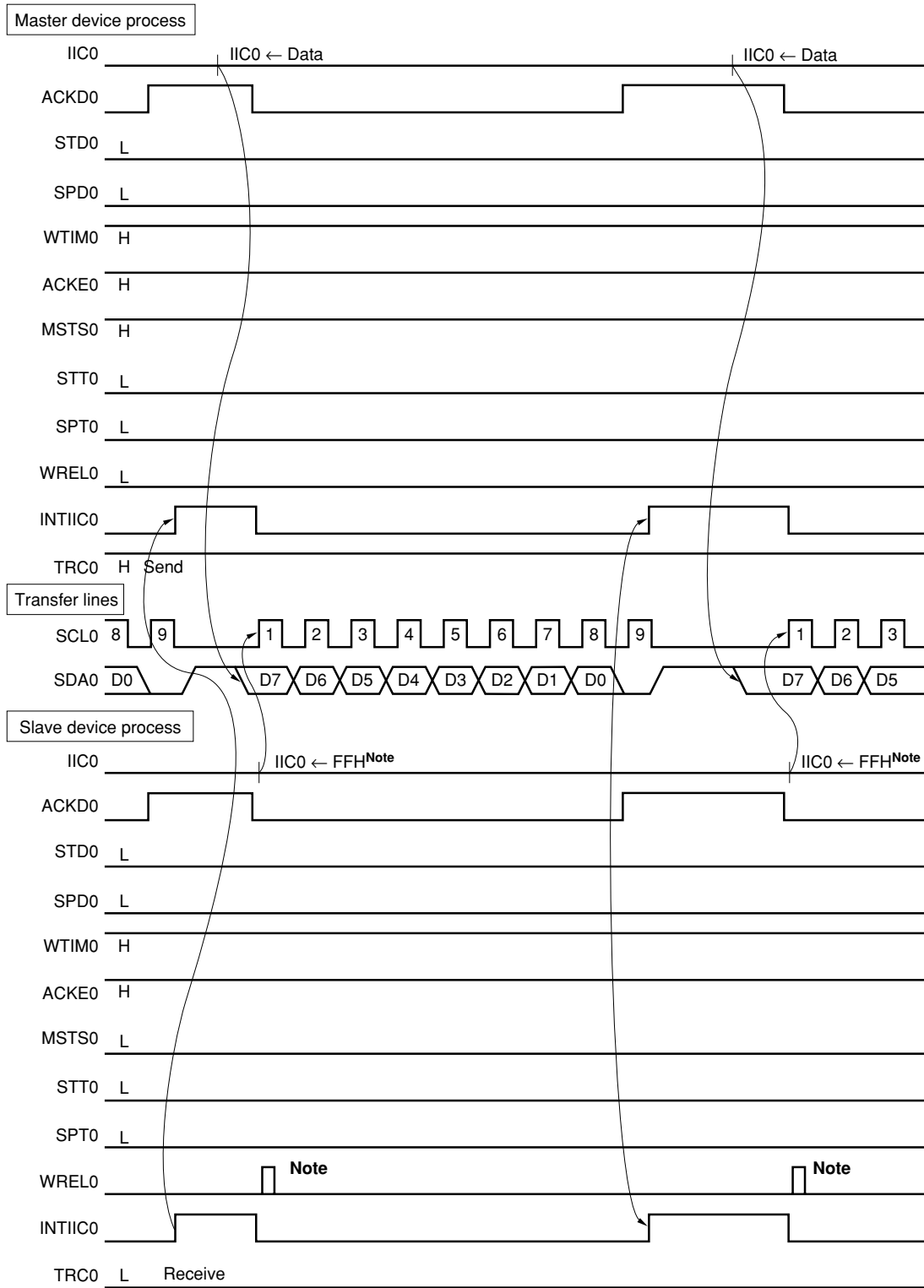
(1) Start Condition - Address



Note Release the slave wait by either IIC0 ← FFH or setting WRELO.

**Figure 19-20. Master → Slave Communication Example
(When Master and Slave Select 9 Clock Waits) (2/3)**

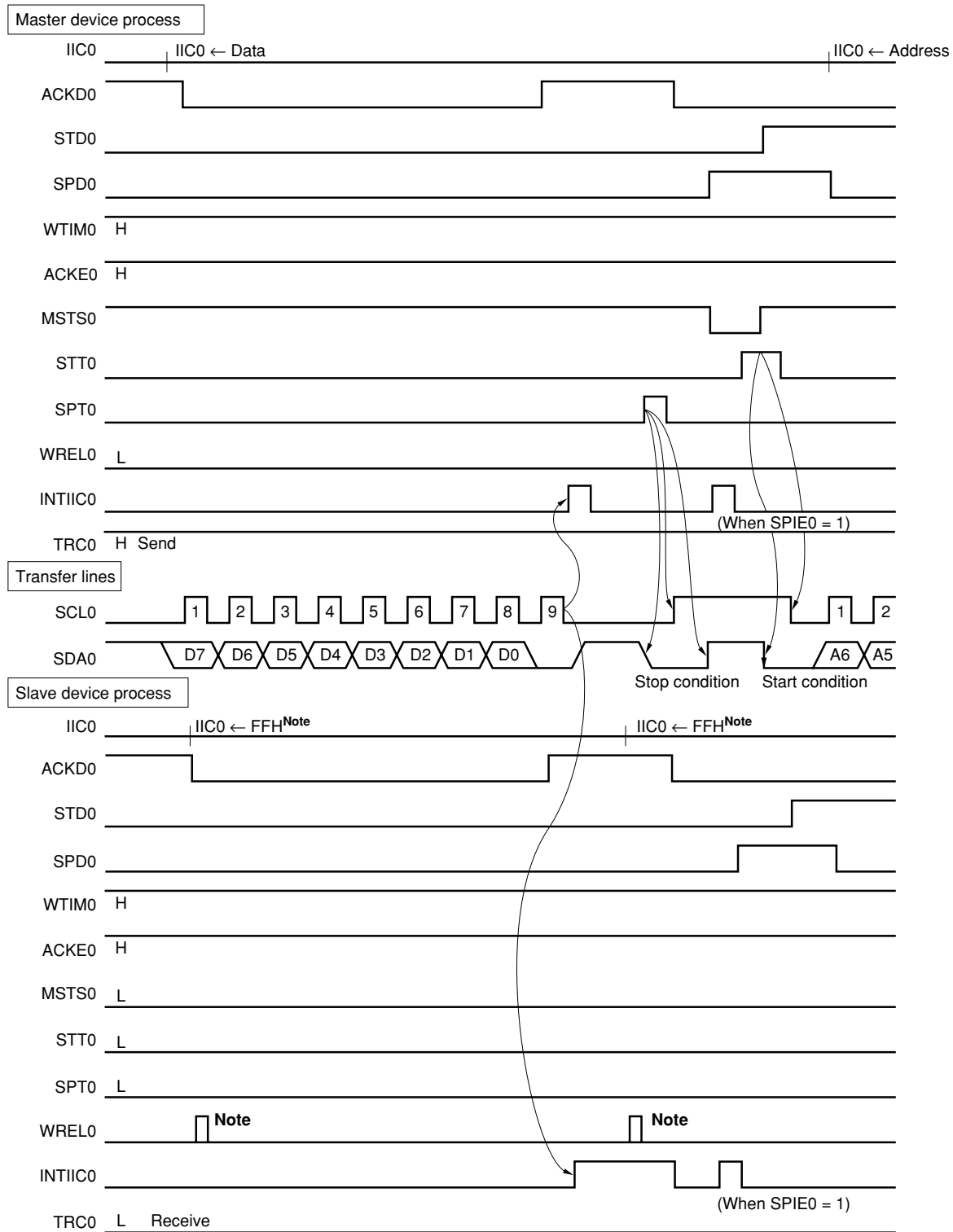
(2) Data



Note Release the slave wait by either IIC0 ← FFH or setting WREL0.

**Figure 19-20. Master → Slave Communication Example
(When Master and Slave Select 9 Clock Waits) (3/3)**

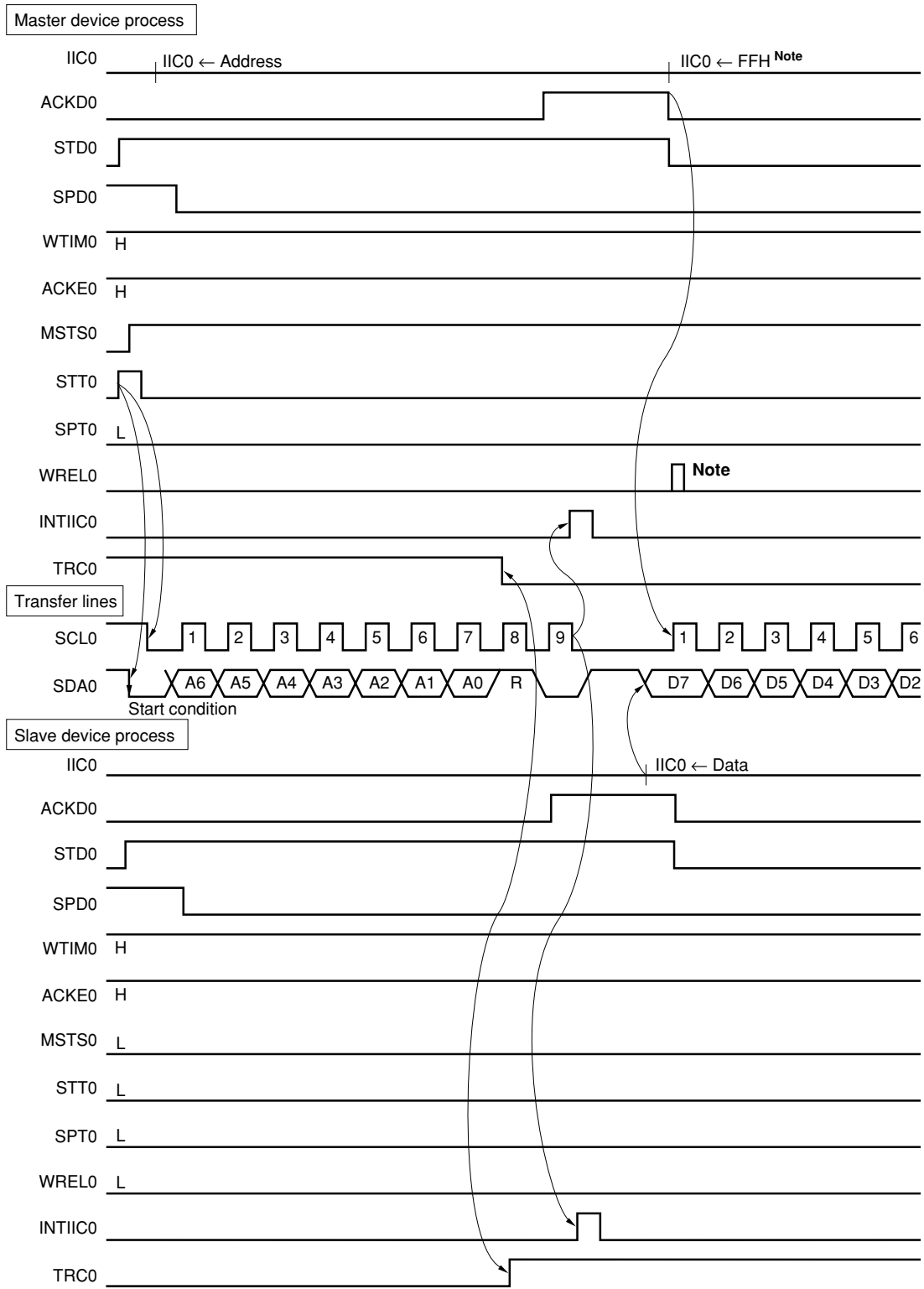
(3) Stop Condition



Note Release the slave wait by either IIC0 ← FFH or setting WRELO.

Figure 19-21. Slave → Master Communication Example
(When Master and Slave Select 9 Clock Waits) (1/3)

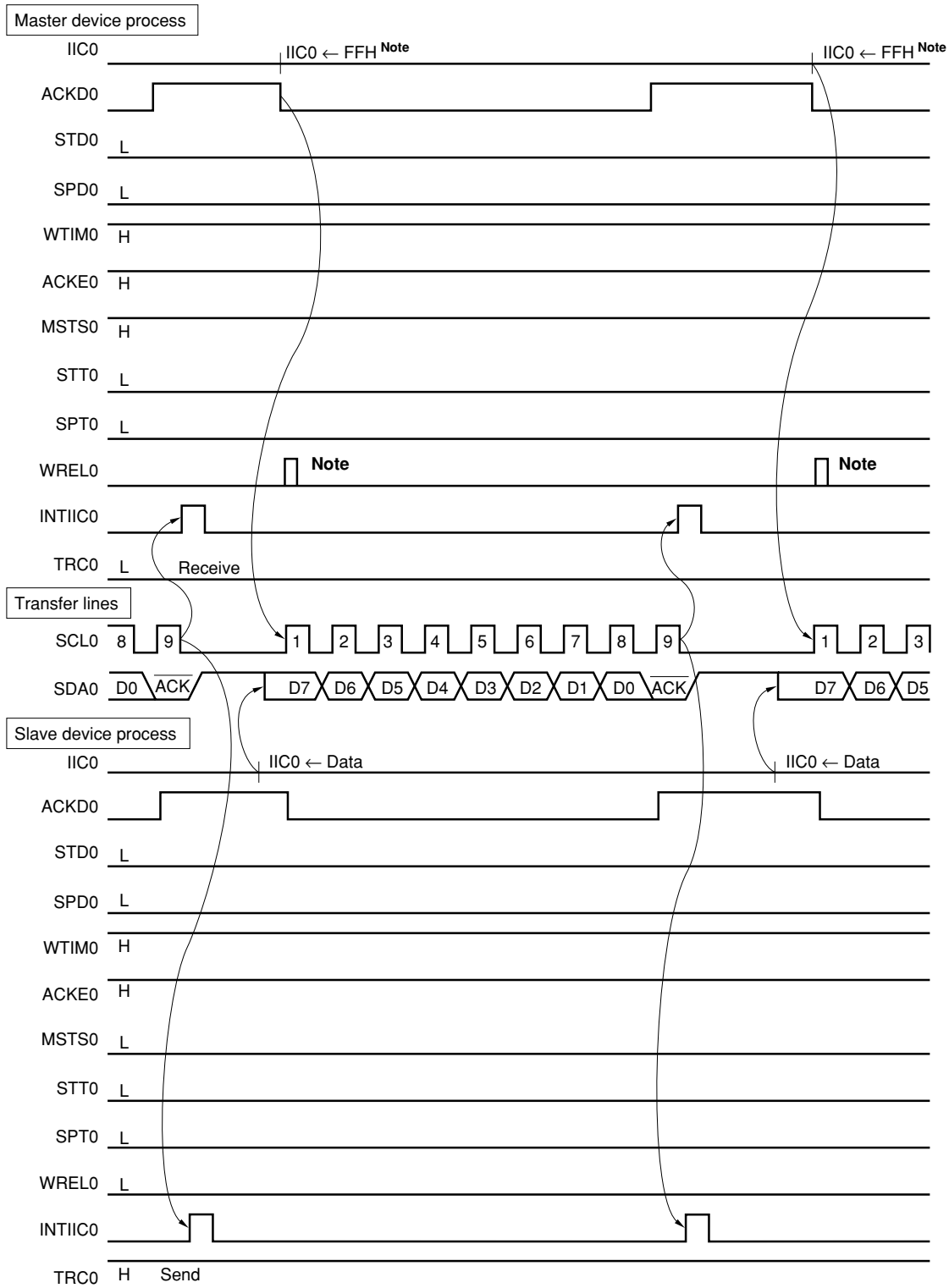
(1) Start Condition - Address



Note Release the slave wait by either IIC0 ← FFH or setting WRELO.

Figure 19-21. Slave → Master Communication Example
(When Master and Slave Select 9 Clock Waits) (2/3)

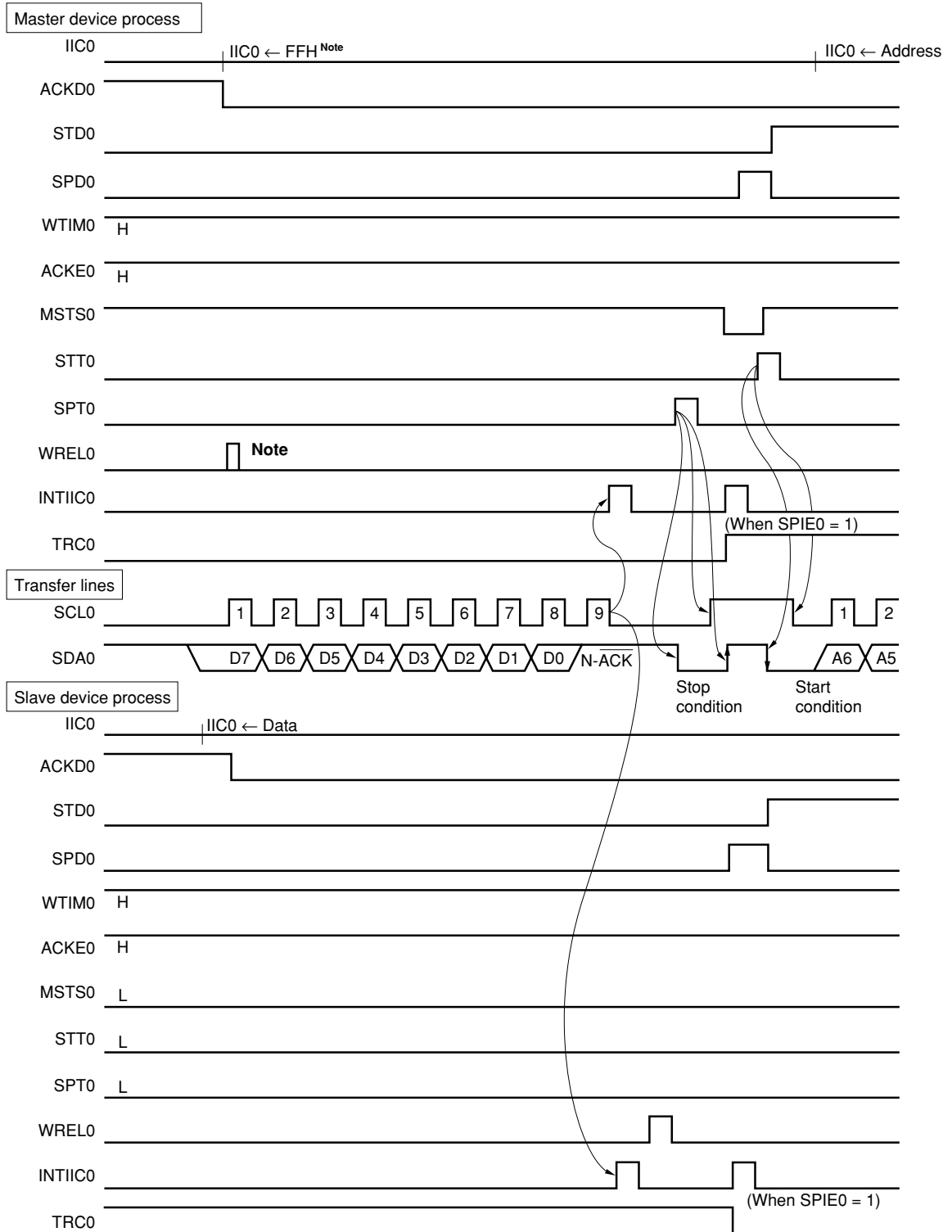
(2) Data



Note Release the slave wait by either IIC0 ← FFH or setting WRELO.

**Figure 19-21. Slave → Master Communication Example
(When Master and Slave Select 9 Clock Waits) (3/3)**

(3) Stop Condition



Note Release the slave wait by either IIC0 ← FFH or setting WRELO.

CHAPTER 20 CLOCK OUTPUT FUNCTION

20.1 Functions

The clock output function is used to output the clock supplied to a peripheral LSI and carrier output during remote transmission. The clock selected by means of the clock output control register (CKS) is output from the PCL/P23 pin.

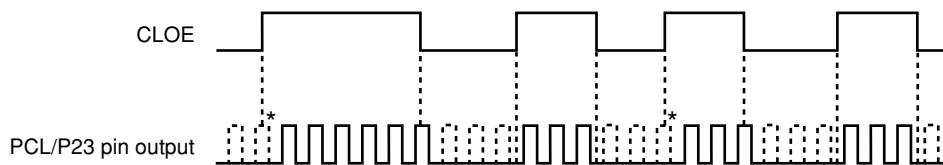
To output the clock pulse, follow the procedure described below.

- <1> Select the output frequency of the clock pulse (while clock pulse output is disabled) with bits 0 to 3 (CCS0 to CCS3) of CKS.
- <2> Set 0 in output latch P23.
- <3> Set bit 3 (PM23) of the port 2 mode register (PM2) to 0 (to set the output mode).
- <4> Set bit 4 (CLOE) of CKS to 1.

Caution If the output latch of P23 is set to 1, clock output cannot be used.

Remark The clock output function is designed so that pulses with a narrow width are not output when clock output enable/disable is switched (See "*" in **Figure 20-1**).

Figure 20-1. Remote Control Output Application Example



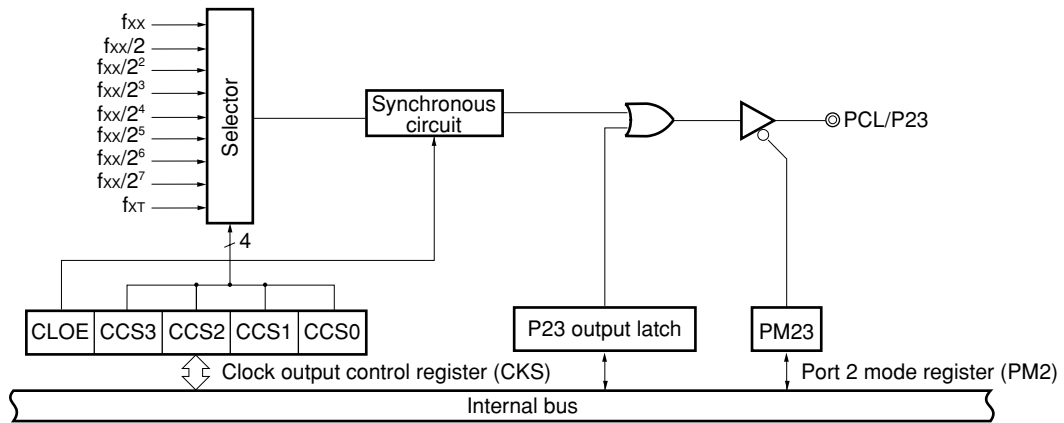
20.2 Configuration

The clock output function consists of the following hardware.

Table 20-1. Clock Output Function Configuration

Item	Configuration
Control register	Clock output control register (CKS) Port 2 mode register (PM2)

Figure 20-2. Clock Output Function Block Diagram



20.3 Control Registers

The following two types of registers are used to control the clock output function.

- Clock output control register (CKS)
- Port 2 mode register (PM2)

(1) Clock output control register (CKS)

This register sets the PCL output clock.

CKS is set by a 1-bit or 8-bit memory manipulation instruction.

$\overline{\text{RESET}}$ input sets CKS to 00H.

Remark CKS provides a function for setting the buzzer output clock besides setting the PCL output clock.

Figure 20-3. Clock Output Control Register (CKS) Format

Address: 0FF40H After reset: 00H R/W

Symbol	7	6	5	4	3	2	1	0
CKS	BZOE	BCS1	BCS0	CLOE	CCS3	CCS2	CCS1	CCS0

BZOE	Buzzer Output Control (See Figure 21-2)
------	---

BCS1	BCS0	Buzzer Output Frequency Selection (See Figure 21-2)
------	------	---

CLOE	Clock output control
0	Clock output stop
1	Clock output start

CCS3	CCS2	CCS1	CCS0	Clock output frequency selection
0	0	0	0	f_{xx} (12.5 MHz)
0	0	0	1	$f_{xx}/2$ (6.25 MHz)
0	0	1	0	$f_{xx}/4$ (3.13 MHz)
0	0	1	1	$f_{xx}/8$ (1.56 MHz)
0	1	0	0	$f_{xx}/16$ (781 kHz)
0	1	0	1	$f_{xx}/32$ (391 kHz)
0	1	1	0	$f_{xx}/64$ (195 kHz)
0	1	1	1	$f_{xx}/128$ (97.7 kHz)
1	0	0	0	f_{XT} (32.768 kHz)
Other than above				Setting prohibited

- Remarks**
1. f_{xx} : Main system clock frequency (f_x or $f_x/2$)
 2. f_x : Main system clock oscillation frequency
 3. f_{XT} : Subsystem clock oscillation frequency
 4. Figures in parentheses apply to operation with $f_{xx} = 12.5$ MHz or $f_{XT} = 32.768$ kHz.

(2) Port 2 mode register (PM2)

This register sets input/output for port 2 in 1-bit units.

When using the P23/PCL pin for clock output, set the output latches of PM23 and P23 to 0.

PM2 is set by a 1-bit or 8-bit memory manipulation instruction.

$\overline{\text{RESET}}$ input sets PM2 to FFH.

Figure 20-4. Port 2 Mode Register (PM2) Format

Address: 0FF22H After reset: FFH R/W

Symbol	7	6	5	4	3	2	1	0
PM2	PM27	PM26	PM25	PM24	PM23	PM22	PM21	PM20

PM2n	P2n pin input/output mode selection (n = 0 to 7)
0	Output mode (output buffer ON)
1	Input mode (output buffer OFF)

CHAPTER 21 BUZZER OUTPUT FUNCTIONS

21.1 Function

This function outputs a square wave at the frequencies of 1.5 kHz, 3.1 kHz, 6.1 kHz, and 12.2 kHz. The buzzer frequency selected by the clock output control register (CKS) is output from the BUZ/P24 pin.

The following procedure outputs the buzzer frequency.

- <1> Select the buzzer output frequency by using bits 5 to 7 (BCS0, BCS1, BZOE) of CKS.
- <2> Set the P24 output latch to 0.
- <3> Set bit 4 (PM24) of the port 2 mode register (PM2) to 0 (set the output mode).

Caution When the output latch of P24 is set to 1, the buzzer output cannot be used.

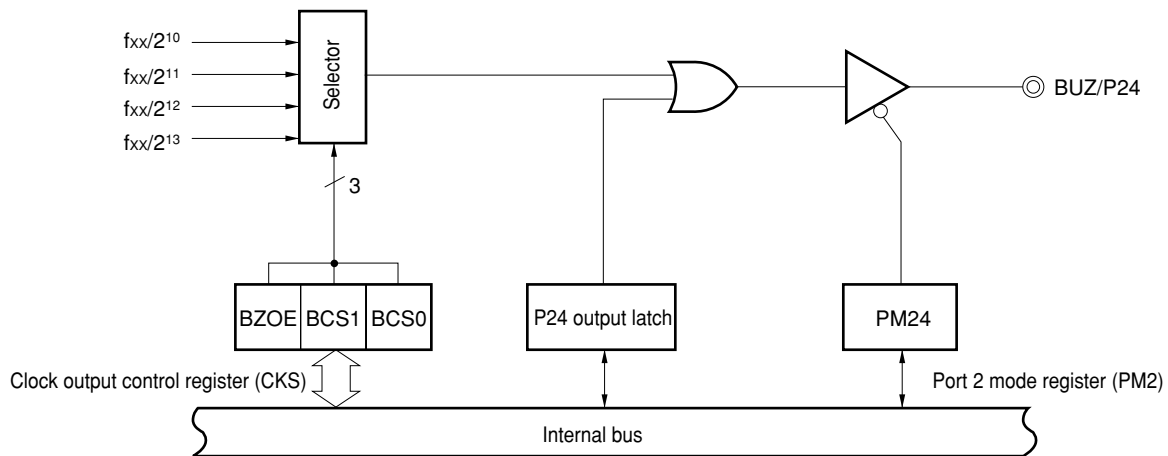
21.2 Configuration

The buzzer output function consists of the following hardware.

Table 21-1. Buzzer Output Function Configuration

Item	Configuration
Control register	Clock output control register (CKS) Port 2 mode register (PM2)

Figure 21-1. Buzzer Output Function Block Diagram



21.3 Control Registers

The buzzer output function is controlled by the following two registers.

- Clock output control register (CKS)
- Port 2 mode register (PM2)

(1) Clock output control register (CKS)

This register sets the frequency of the buzzer output.

CKS is set by a 1-bit or 8-bit memory manipulation instruction.

RESET input sets CKS to 00H.

Remark CKS has the function of setting the clock for PCL output except for the buzzer output frequency setting.

Figure 21-2. Clock Output Control Register (CKS) Format

Address: 0FF40H After reset: 00H R/W

Symbol	7	6	5	4	3	2	1	0
CKS	BZOE	BCS1	BCS0	CLOE	CCS3	CCS2	CCS1	CCS0

BZOE	Buzzer output control
0	Stop buzzer output
1	Start buzzer output

BCS1	BCS0	Buzzer output frequency selection
0	0	$f_{xx}/2^{10}$ (12.2 kHz)
0	1	$f_{xx}/2^{11}$ (6.1 kHz)
1	0	$f_{xx}/2^{12}$ (3.1 kHz)
1	1	$f_{xx}/2^{13}$ (1.5 kHz)

CLOE	Clock output control (refer to Figure 20-3)
------	---

CCS3	CCS2	CCS1	CCS0	Clock output frequency selection (refer to Figure 20-3)
------	------	------	------	---

- Remarks**
1. f_{xx} : Main system clock frequency (f_x or $f_x/2$)
 2. f_x : Main system clock oscillation frequency
 3. Figures in parentheses apply to operation with $f_{xx} = 12.5$ MHz.

(2) Port 2 mode register (PM2)

This register sets port 2 I/O in 1-bit units.

When the P24/BUZ pin is used as the buzzer output function, set the output latches of PM24 and P24 to 0.

PM2 is set by a 1-bit or 8-bit memory manipulation instruction.

$\overline{\text{RESET}}$ input sets PM2 to FFH.

Figure 21-3. Port 2 Mode Register (PM2) Format

Address: 0FF22H After reset: FFH R/W

Symbol	7	6	5	4	3	2	1	0
PM2	PM27	PM26	PM25	PM24	PM23	PM22	PM21	PM20

PM2n	P2n pin I/O mode selection (n = 0 to 7)
0	Output mode (output buffer on)
1	Input mode (output buffer off)

CHAPTER 22 EDGE DETECTION FUNCTION

The P00 to P06 pins have an edge detection function that can be programmed to detect the rising edge or falling edge and sends the detected edge to on-chip hardware components.

The edge detection function is always functioning, even in the STOP mode and IDLE mode.

22.1 Control Registers

- **External interrupt rising edge enable register (EGP0), external interrupt falling edge enable register (EGN0)**

The EGP0 and EGN0 registers specify the effective edge to be detected by the P00 to P06 pins.

They can read/write with an 8-bit manipulation instruction or a bit manipulation instruction.

RESET input sets the EGP0 and EGN0 to 00H.

Figure 22-1. Format of External Interrupt Rising Edge Enable Register (EGP0) and External Interrupt Falling Edge Enable Register (EGN0)

Address: 0FFA0H After reset: 00H R/W

Symbol	7	6	5	4	3	2	1	0
EGP0	0	EGP6	EGP5	EGP4	EGP3	EGP2	EGP1	EGP0

Address: 0FFA2H After reset: 00H R/W

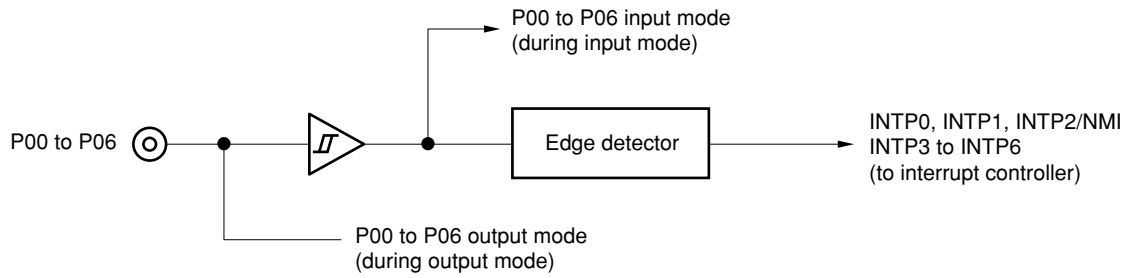
Symbol	7	6	5	4	3	2	1	0
EGN0	0	EGN6	EGN5	EGN4	EGN3	EGN2	EGN1	EGN0

EGPn	EGNn	INTPn pin effective edge (n = 0 to 6)
0	0	Interrupt disable
0	1	Falling edge
1	0	Rising edge
1	1	Both rising and falling edges

22.2 Edge Detection of P00 to P06 Pins

The P00 to P06 pins do not incorporate an analog delay-based noise eliminator. Therefore, a valid edge is input to the pins and edge detection is performed (acknowledged) immediately after passing through the hysteresis-type input buffer.

Figure 22-2. Block Diagram of P00 to P06 Pins



CHAPTER 23 INTERRUPT FUNCTIONS

The μ PD784218A is provided with three interrupt request service modes; vectored interrupt, context switching, and macro service (refer to **Table 23-1**). These three service modes can be set as required in the program. However, interrupt service by macro service can only be selected for interrupt request sources provided with the macro service processing mode shown in Table 23-2. Context switching cannot be selected for non-maskable interrupts or operand error interrupts.

Multiple-interrupt control using 4 priority levels can easily be performed for maskable vectored interrupts.

Table 23-1. Interrupt Request Service Modes

Interrupt Request Service Mode	Servicing Performed	PC & PSW Contents	Service
Vectored interrupts	Software	Saving to & restoration from stack	Executed by branching to service program at address ^{Note} specified by vector table
Context switching		Saving to & restoration from fixed area in register bank	Executed by automatic switching to register bank specified by vector table and branching to service program at address ^{Note} specified by fixed area in register bank
Macro service	Hardware (firmware)	Retained	Execution of pre-set service such as data transfers between memory and I/O

Note The start addresses of all interrupt service programs must be in the base area. If the body of a service program cannot be located in the base area, a branch instruction to the service program should be written in the base area.

23.1 Interrupt Request Sources

The μ PD784218A has 32 interrupt request sources as shown in Table 23-2, with an interrupt vector table allocated to each.

Table 23-2. Interrupt Request Sources (1/2)

Type of Interrupt Request	Default Priority	Interrupt Request Generating Source	Generating Unit	Interrupt Control Register Name	Context Switching	Macro Service	Macro Service Control Word Address	Vector Table Address
Software	None	BRK instruction execution	—	—	Not possible	Not possible	—	003EH
		BRKCS instruction execution	—	—	Possible	Not possible	—	—
Operand error (TRAP0)	None	Invalid operand in MOV STBC, #byte instruction or MOV WDM, #byte instruction, and LOCATION instruction	—	—	Not possible	Not possible	—	003CH
Non-maskable	None	NMI (pin input edge detection)	Edge detection	—	Not possible	Not possible	—	0002H
		INTWDT (watchdog timer overflow)	Watchdog timer	—	Not possible	Not possible	—	0004H

Table 23-2. Interrupt Request Sources (2/2)

Type of Interrupt Request	Default Priority	Interrupt Request Generating Source	Generating Unit	Interrupt Control Register Name	Context Switching	Macro Service	Macro Service Control Word Address	Vector Table Address				
Maskable	0	INTWDTM (Watchdog timer overflow)	Watchdog timer	WDTIC	Possible	Possible	0FE06H	0006H				
	1	INTP0 (Pin input edge detection)	Edge detection	PIC0			0FE08H	0008H				
	2	INTP1 (Pin input edge detection)		PIC1			0FE0AH	000AH				
	3	INTP2 (Pin input edge detection)		PIC2			0FE0CH	000CH				
	4	INTP3 (Pin input edge detection)		PIC3			0FE0EH	000EH				
	5	INTP4 (Pin input edge detection)		PIC4			0FE10H	0010H				
	6	INTP5 (Pin input edge detection)		PIC5			0FE12H	0012H				
	7	INTP6 (Pin input edge detection)		PIC6			0FE14H	0014H				
	8	INTIIC0 (CSI0 I ² C bus transfer end) ^{Note}	Clocked serial interface	CSIIIC0			Possible	Possible	0FE16H	0016H		
		INTCSI0 (CSI0 3-wire transfer end)										
	9	INTSER1 (ASI1 UART reception error)	Asynchronous serial interface/ clocked	SERIC1							0FE18H	0018H
	10	INTSR1 (ASI1 UART reception end)		SRIC1							0FE1AH	001AH
		INTCSI1 (CSI1 3-wire transfer end)	serial interface 1	STIC1							0FE1CH	001CH
	11	INTST1 (ASI1 UART transmission end)		STIC1							0FE1CH	001CH
	12	INTSER2 (ASI2 UART reception error)	Asynchronous serial interface/ clocked	SERIC2							0FE1EH	001EH
	13	INTSR2 (ASI2 UART reception end)		SRIC2							0FE20H	0020H
		INTCSI2 (CSI2 3-wire transfer end)	serial interface 2	STIC2							0FE22H	0022H
	14	INTST2 (ASI2 UART transmission end)		STIC2							0FE22H	0022H
	15	INTTM3 (Reference time interval signal from watch timer)	Watch timer	TMIC3							0FE24H	0024H
	16	INTTM00 (Match signal generation of 16-bit timer register and capture/compare register (CR00))	Timer/counter	TMIC00							0FE26H	0026H
	17	INTTM01 (Match signal generation of 16-bit timer register and capture/compare register (CR01))		TMIC01							0FE28H	0028H
	18	INTTM1 (Match signal generation of 8-bit timer/counter 1)	Timer/counter 1	TMIC1							0FE2AH	002AH
	19	INTTM2 (Match signal generation of 8-bit timer/counter 2)	Timer/counter 2	TMIC2							0FE2CH	002CH
	20	INTAD (A/D converter conversion end)	A/D converter	ADIC							0FE2EH	002EH
	21	INTTM5 (Match signal generation of 8-bit timer/counter 5)	Timer/counter 5	TMIC5							0FE30H	0030H
	22	INTTM6 (Match signal generation of 8-bit timer/counter 6)	Timer/counter 6	TMIC6							0FE32H	0032H
23	INTTM7 (Match signal generation of 8-bit timer/counter 7)	Timer/counter 7	TMIC7	0FE34H	0034H							
24	INTTM8 (Match signal generation of 8-bit timer/counter 8)	Timer/counter 8	TMIC8	0FE36H	0036H							
25	INTWT (Watch timer overflow)	Watch timer	WTIC	0FE38H	0038H							
26	INTKR (Falling edge detection of port 8)	Edge detection	KRIC	0FE3AH	003AH							

Note μ PD784216AY, 784218AY Subseries only

- Remarks**
1. The default priority is a fixed number. This indicates the order of priority when interrupt requests specified as having the same priority are generated simultaneously.
 2. ASI: Asynchronous serial interface
CSI: Clocked serial interface
 3. The watchdog timer has two interrupt sources, a non-maskable interrupt (INTWDT) and a maskable interrupt (INTWDTM), either (but not both) of which can be selected.

23.1.1 Software interrupts

Interrupts by software consist of the BRK instruction which generates a vectored interrupt and the BRKCS instruction which performs context switching.

Software interrupts are acknowledged even in the interrupt disabled state, and are not subject to priority control.

23.1.2 Operand error interrupts

These interrupts are generated if there is an illegal operand in an MOV STBC, #byte instruction or MOV WDM, #byte instruction, and LOCATION instruction.

Operand error interrupts are acknowledged even in the interrupt disabled state, and are not subject to priority control.

23.1.3 Non-maskable interrupts

A non-maskable interrupt is generated by NMI pin input or the watchdog timer.

Non-maskable interrupts are acknowledged unconditionally^{Note}, even in the interrupt disabled state. They are not subject to interrupt priority control, and are of higher priority than any other interrupt.

Note Except during execution of the service program for the same non-maskable interrupt, and during execution of the service program for a higher-priority non-maskable interrupt

23.1.4 Maskable interrupts

A maskable interrupt is one subject to masking control according to the setting of an interrupt mask flag. In addition, acknowledgement enabling/disabling can be specified for all maskable interrupts by means of the IE flag in the program status word (PSW).

In addition to normal vectored interruption, maskable interrupts can be acknowledged by context switching and macro service (though some interrupts cannot use macro service: refer to **Table 23-2**).

The priority order for maskable interrupt requests when interrupt requests of the same priority are generated simultaneously is predetermined (default priority) as shown in Table 23-2. Also, multiprocessing control can be performed with interrupt priorities divided into 4 levels. However, macro service requests are acknowledged without regard to priority control or the IE flag.

23.2 Interrupt Service Modes

There are three μ PD784218A interrupt service modes, as follows:

- Vectored interrupt service
- Macro service
- Context switching

23.2.1 Vectored interrupt service

When an interrupt is acknowledged, the program counter (PC) and program status word (PSW) are automatically saved to the stack, a branch is made to the address indicated by the data stored in the vector table, and the interrupt service routine is executed.

23.2.2 Macro service

When an interrupt is acknowledged, CPU execution is temporarily suspended and a data transfer is performed by hardware. Since macro service is performed without the intermediation of the CPU, it is not necessary to save or restore CPU statuses such as the program counter (PC) and program status word (PSW) contents. This is therefore very effective in improving the CPU service time (refer to **23.8 Macro Service Function**).

23.2.3 Context switching

When an interrupt is acknowledged, the prescribed register bank is selected by hardware, a branch is made to a pre-set vector address in the register bank, and at the same time the current program counter (PC) and program status word (PSW) are saved in the register bank (refer to **23.4.2 BRKCS instruction software interrupt (software context switching) acknowledgement operation** and **23.7.2 Context switching**).

Remark “Context” refers to the CPU registers that can be accessed by a program while that program is being executed. These registers include general registers, the program counter (PC), program status word (PSW), and stack pointer (SP).

23.3 Interrupt Processing Control Registers

μ PD784218A interrupt processing is controlled for each interrupt request by various control registers that perform interrupt processing specification. The interrupt control registers are listed in Table 23-3.

Table 23-3. Control Registers

Register Name	Symbol	Function
Interrupt control registers	WDTIC, PIC0, PIC1, PIC2, PIC3, PIC4, PIC5, PIC6, CSIIC0, SERIC1, SRIC1, STIC1, SERIC2, SRIC2, STIC2, TMIC3, TMIC00, TMIC01, TMIC1, TMIC2, ADIC, TMIC5, TMIC6, TMIC7, TMIC8, WTIC, KRIC	Registers to record generation of interrupt request, control masking, specify vectored interrupt processing or macro service processing, enable or disable context switching function, and specify priority.
Interrupt mask registers	MK0 (MK0L, MK0H) MK1 (MK1L, MK1H)	Control masking of maskable interrupt request. Associated with mask control flag in interrupt control register. Can be accessed in word or byte units.
In-service priority register	ISPR	Records priority of interrupt request currently acknowledged.
Interrupt mode control register	IMC	Controls nesting of maskable interrupt with priority specified to lowest level (level 3).
Interrupt selection control register	SNMI	Selects whether to use input signal from P02 pin and interrupt signal from watchdog timer as maskable interrupt or NMI.
Watchdog timer mode register	WDM	Specifies priorities of interrupt by NMI pin input and overflow of watchdog timer.
Program status word	PSW	Enables or disables accepting maskable interrupt.

An interrupt control register is allocated to each interrupt source. The flags of each register perform control of the contents corresponding to the relevant bit position in the register. The interrupt control register flag names corresponding to each interrupt request signal are shown in Table 23-4.

Table 23-4. Flag List of Interrupt Control Registers for Interrupt Requests

Default Priority	Interrupt Request Signal	Interrupt Control Register					
			Interrupt Request Flag	Interrupt Mask Flag	Macro Service Enable Flag	Priority Specification Flag	Context Switching Enable Flag
0	INTWDTM	WDTIC	WDTIF	WDTMK	WDTISM	WDTPR0 WDTPR1	WDTCSSE
1	INTP0	PIC0	PIF0	PMK0	PISM0	PPR00 PPR01	PCSE0
2	INTP1	PIC1	PIF1	PMK1	PISM1	PPR10 PPR11	PCSE1
3	INTP2	PIC2	PIF2	PMK2	PISM2	PPR20 PPR21	PCSE2
4	INTP3	PIC3	PIF3	PMK3	PISM3	PPR30 PPR31	PCSE3
5	INTP4	PIC4	PIF4	PMK4	PISM4	PPR40 PPR41	PCSE4
6	INTP5	PIC5	PIF5	PMK5	PISM5	PPR50 PPR51	PCSE5
7	INTP6	PIC6	PIF6	PMK6	PISM6	PPR60 PPR61	PCSE6
8	INTIIC0 INTCSI0	CSIC0	CSIF0	CSIMK0	CSISM0	CSIPR00 CSIPR01	CSICSE0
9	INTSER1	SERIC1	SERIF1	SERMK1	SERISM1	SERPR10 SERPR11	SERCSE1
10	INTSR1 INTCSI1	SRIC1	SRIF1	SRMK1	SRISM1	SRPR10 SRPR11	SRCSE1
11	INTST1	STIC1	STIF1	STMK1	STISM1	STPR10 STPR11	STCSE1
12	INTSER2	SERIC2	SERIF2	SERMK2	SERISM2	SERPR20 SERPR21	SERCSE2
13	INTSR2 INTCSI2	SRIC2	SRIF2	SRMK2	SRISM2	SRPR20 SRPR21	SRCSE2
14	INTST2	STIC2	STIF2	STMK2	STISM2	STPR20 STPR21	STCSE2
15	INTTM3	TMIC3	TMIF3	TMMK3	TMISM3	TMPR30 TMPR31	TMCSE3
16	INTTM00	TMIC00	TMIF00	TMMK00	TMISM00	TMPR000 TMPR001	TMCSE00
17	INTTM01	TMIC01	TMIF01	TMMK01	TMISM01	TMPR010 TMPR011	TMCSE01
18	INTTM1	TMIC1	TMIF1	TMMK1	TMISM1	TMPR10 TMPR11	TMCSE1
19	INTTM2	TMIC2	TMIF2	TMMK2	TMISM2	TMPR20 TMPR21	TMCSE2
20	INTAD	ADIC	ADIF	ADMK	ADISM	ADPR00 ADPR01	ADCSE
21	INTTM5	TMIC5	TMIF5	TMMK5	TMISM5	TMPR50 TMPR51	TMCSE5
22	INTTM6	TMIC6	TMIF6	TMMK6	TMISM6	TMPR60 TMPR61	TMCSE6
23	INTTM7	TMIC7	TMIF7	TMMK7	TMISM7	TMPR70 TMPR71	TMCSE7
24	INTTM8	TMIC8	TMIF8	TMMK8	TMISM8	TMPR80 TMPR81	TMCSE8
25	INTWT	WTIC	WTIF	WTMK	WTISM	WTPR0 WTPR1	WTCSE
26	INTKR	KRIC	KRIF	KRMK	KRISM	KRPR0 KRPR1	KRCSE

23.3.1 Interrupt control registers

An interrupt control register is allocated to each interrupt source, and performs priority control, mask control, etc., for the corresponding interrupt request. The interrupt control register format is shown in Figure 23-1.

(1) Priority specification flags (xxPR1, xxPR0)

The priority specification flags specify the priority on an individual interrupt source basis for the 27 maskable interrupts.

Up to 4 priority levels can be specified, and a number of interrupt sources can be specified at the same level. Among maskable interrupt sources, level 0 is the highest priority.

If multiple interrupt requests are generated simultaneously among interrupt source of the same priority level, they are acknowledged in default priority order.

These flags can be manipulated bit-wise by software.

$\overline{\text{RESET}}$ input sets all bits to 1.

(2) Context switching enable flag (xxCSE)

The context switching enable flag specifies that a maskable interrupt request is to be serviced by context switching.

In context switching, the register bank specified beforehand is selected by hardware, a branch is made to a vector address stored beforehand in the register bank, and at the same time the current contents of the program counter (PC) and program status word (PSW) are saved in the register bank.

Context switching is suitable for real-time processing, since execution of interrupt servicing can be started faster than with normal vectored interrupt servicing.

This flag can be manipulated bit-wise by software.

$\overline{\text{RESET}}$ input sets all bits to 0.

(3) Macro service enable flag (xxISM)

The macro service enable flag specifies whether an interrupt request corresponding to that flag is to be handled by vectored interruption or context switching, or by macro service.

When macro service processing is selected, at the end of the macro service (when the macro service counter reaches 0) the macro service enable flag is automatically cleared (0) by hardware (vectored interrupt service/context switching service).

This flag can be manipulated bit-wise by software.

$\overline{\text{RESET}}$ input sets all bits to 0.

(4) Interrupt mask flag (xxMK)

An interrupt mask flag specifies enabling/disabling of vectored interrupt servicing and macro service processing for the interrupt request corresponding to that flag.

The interrupt mask flag contents are not changed by the start of interrupt service, etc., and are the same as the interrupt mask register contents (refer to **23.3.2 Interrupt mask registers (MK0, MK1)**).

Macro service processing requests are also subject to mask control, and macro service requests can also be masked with this flag.

This flag can be manipulated by software.

$\overline{\text{RESET}}$ input sets all bits to 1.

(5) Interrupt request flag (xxIF)

An interrupt request flag is set (1) by generation of the interrupt request that corresponds to that flag. When the interrupt is acknowledged, the flag is automatically cleared (0) by hardware.

This flag can be manipulated by software.

$\overline{\text{RESET}}$ input sets all bits to 0.

Figure 23-1. Interrupt Control Register (××ICn) (1/3)

Address: 0FFE0H to 0FFE8H	After reset: 43H				R/W			
Symbol	<7>	<6>	<5>	<4>	3	2	<1>	<0>
WDTIC	WDTIF	WDTMK	WDTISM	WDCSE	0	0	WDTPR1	WDTPR0
PIC0	PIF0	PMK0	PISM0	PCSE0	0	0	PPR01	PPR00
PIC1	PIF1	PMK1	PISM1	PCSE1	0	0	PPR11	PPR10
PIC2	PIF2	PMK2	PISM2	PCSE2	0	0	PPR21	PPR20
PIC3	PIF3	PMK3	PISM3	PCSE3	0	0	PPR31	PPR30
PIC4	PIF4	PMK4	PISM4	PCSE4	0	0	PPR41	PPR40
PIC5	PIF5	PMK5	PISM5	PCSE5	0	0	PPR51	PPR50
PIC6	PIF6	PMK6	PISM6	PCSE6	0	0	PPR61	PPR60
CSIIIC0	CSIIF0	CSIMK0	CSIISM0	CSICSE0	0	0	CSIPR01	CSIPR00

××IFn	Interrupt request generation
0	No interrupt request (Interrupt signal is not generated)
1	Interrupt request (Interrupt signal is generated)

××MKn	Interrupt processing enable/disable
0	Interrupt processing enable
1	Interrupt processing disable

××ISMn	Interrupt processing mode specification
0	Vectored interrupt processing/Context switching processing
1	Macro service processing

××CSEn	Context switching processing specification
0	Processing with vectored interrupt
1	Processing with context switching

××PRn1	××PRn0	Interrupt request priority specification
0	0	Priority 0 (Highest priority)
0	1	Priority 1
1	0	Priority 2
1	1	Priority 3

Figure 23-1. Interrupt Control Register (××ICn) (2/3)

Address: 0FFE9H to 0FFF1H	After reset: 43H				R/W			
Symbol	<7>	<6>	<5>	<4>	3	2	<1>	<0>
SERIC1	SERIF1	SERMK1	SERISM1	SERCSE1	0	0	SERPR11	SERPR10
SRIC1	SRIF1	SRMK1	SRISM1	SRCSE1	0	0	SRPR11	SRPR10
STIC1	STIF1	STMK1	STISM1	STCSE1	0	0	STPR11	STPR10
SERIC2	SERIF2	SERMK2	SERISM2	SERCSE2	0	0	SERPR21	SERPR20
SRIC2	SRIF2	SRMK2	SRISM2	SRCSE2	0	0	SRPR21	SRPR20
STIC2	STIF2	STMK2	STISM2	STCSE2	0	0	STPR21	STPR20
TMIC3	TMIF3	TMMK3	TMISM3	TMCSE3	0	0	TMPR31	TMPR30
★ TMIC00	TMIF00	TMMK00	TMISM00	TMCSE00	0	0	TMPR001	TMPR000
TMIC01	TMIF01	TMMK01	TMISM01	TMCSE01	0	0	TMPR011	TMPR010

××IFn	Interrupt request generation
0	No interrupt request (Interrupt signal is not generated)
1	Interrupt request (Interrupt signal is generated)

××MKn	Interrupt processing enable/disable
0	Interrupt processing enable
1	Interrupt processing disable

××ISMn	Interrupt processing mode specification
0	Vectored interrupt processing/Context switching processing
1	Macro service processing

××CSEn	Context switching processing specification
0	Processing with vectored interrupt
1	Processing with context switching

××PRn1	××PRn0	Interrupt request priority specification
0	0	Priority 0 (Highest priority)
0	1	Priority 1
1	0	Priority 2
1	1	Priority 3

Figure 23-1. Interrupt Control Register (××ICn) (3/3)

	Address: 0FFF2H to 0FFFAH				After reset: 43H		R/W	
Symbol	<7>	<6>	<5>	<4>	3	2	<1>	<0>
TMIC1	TMIF1	TMMK1	TMISM1	TMCSE1	0	0	TMPR11	TMPR10
TMIC2	TMIF2	TMMK2	TMISM2	TMCSE2	0	0	TMPR21	TMPR20
ADIC	ADIF	ADMK	ADISM	ADCSE	0	0	ADPR01	ADPR00
TMIC5	TMIF5	TMMK5	TMISM5	TMCSE5	0	0	TMPR51	TMPR50
TMIC6	TMIF6	TMMK6	TMISM6	TMCSE6	0	0	TMPR61	TMPR60
TMIC7	TMIF7	TMMK7	TMISM7	TMCSE7	0	0	TMPR71	TMPR70
TMIC8	TMIF8	TMMK8	TMISM8	TMCSE8	0	0	TMPR81	TMPR80
WTIC	WTIF	WTMK	WTISM	WTCSE	0	0	WTPR1	WTPR0
KRIC	KRIF	KRMK	KRISM	KRCSE	0	0	KRPR1	KRPR0

××IFn	Interrupt request generation
0	No interrupt request (Interrupt signal is not generated)
1	Interrupt request (Interrupt signal is generated)

××MKn	Interrupt processing enable/disable
0	Interrupt processing enable
1	Interrupt processing disable

××ISMn	Interrupt processing mode specification
0	Vectored interrupt processing/Context switching processing
1	Macro service processing

××CSEn	Context switching processing specification
0	Processing with vectored interrupt
1	Processing with context switching

××PRn1	××PRn0	Interrupt request priority specification
0	0	Priority 0 (Highest priority)
0	1	Priority 1
1	0	Priority 2
1	1	Priority 3

23.3.2 Interrupt mask registers (MK0, MK1)

The MK0 and MK1 are composed of interrupt mask flags. MK0 and MK1 are 16-bit registers which can be manipulated as a 16-bit unit. MK0 can be manipulated in 8 bit units using MK0L and MK0H, and similarly MK1 can be manipulated using MK1L and MK1H.

In addition, each bit of the MK0 and MK1 can be manipulated individually with a bit manipulation instruction. Each interrupt mask flag controls enabling/disabling of the corresponding interrupt request.

When an interrupt mask flag is set (1), acknowledgement of the corresponding interrupt request is disabled.

When an interrupt mask flag is cleared (0), the corresponding interrupt request can be acknowledged as a vectored interrupt or macro service request.

Each interrupt mask flag in the MK0 and MK1 is the same flag as the interrupt mask flag in the interrupt control register. The MK0 and MK1 are provided for en bloc control of interrupt masking.

After $\overline{\text{RESET}}$ input, the MK0 and MK1 are set to FFFFH, and all maskable interrupts are disabled.

Figure 23-2. Format of Interrupt Mask Registers (MK0, MK1)

<Byte access>

Address: 0FFACH to 0FFAFH After reset: FFH R/W

Symbol	7	6	5	4	3	2	1	0
MK0L	PMK6	PMK5	PMK4	PMK3	PMK2	PMK1	PMK0	WDTMK
MK0H	TMMK3	STMK2	SRMK2	SERMK2	STMK1	SRMK1	SERMK1	CSIMK0
MK1L	TMMK7	TMMK6	TMMK5	ADMK	TMMK2	TMMK1	TMMK01	TMMK00
MK1H	1	1	1	1	1	KRMK	WTMK	TMMK8

××MKn	Interrupt request enable/disable
0	Interrupt processing enable
1	Interrupt processing disable

<Word access>

Address: 0FFACH, 0FFAEH After reset: FFFFH R/W

Symbol	15	14	13	12	11	10	9	8
MK0	TMMK3	STMK2	SRMK2	SERMK2	STMK1	SRMK1	SERMK1	CSIMK0
	7	6	5	4	3	2	1	0
MK1	PMK6	PMK5	PMK4	PMK3	PMK2	PMK1	PMK0	WDTMK
	15	14	13	12	11	10	9	8
	1	1	1	1	1	KRMK	WTMK	TMMK8
MK1	7	6	5	4	3	2	1	0
	TMMK7	TMMK6	TMMK5	ADMK	TMMK2	TMMK1	TMMK01	TMMK00

××MKn	Interrupt request enable/disable
0	Interrupt processing enable
1	Interrupt processing disable

23.3.3 In-service priority register (ISPR)

The ISPR shows the priority level of the maskable interrupt currently being serviced and the non-maskable interrupt being processed. When a maskable interrupt request is acknowledged, the bit corresponding to the priority of that interrupt request is set (1), and remains set until the service program ends. When a non-maskable interrupt is acknowledged, the bit corresponding to the priority of that non-maskable interrupt is set (1), and remains set until the service program ends.

When an RETI instruction or RETCS instruction is executed, the bit, among those set (1) in the ISPR, that corresponds to the highest-priority interrupt request is automatically cleared (0) by hardware.

The contents of the ISPR are not changed by execution of an RETB or RETCSB instruction. $\overline{\text{RESET}}$ input clears the ISPR register to 00H.

Figure 23-3. Format of In-Service Priority Register (ISPR)

Address: 0FFA8H	After reset: 00H				R			
Symbol	7	6	5	4	3	2	1	0
ISPR	NMIS	WDTS	0	0	ISPR3	ISPR2	ISPR1	ISPR0

NMIS	NMI processing status
0	NMI interrupt is not accepted.
1	NMI interrupt is accepted.

WDTS	Watchdog timer interrupt processing status
0	Watchdog timer interrupt is not accepted.
1	Watchdog timer interrupt is accepted.

ISPRn	Priority level (n = 0 to 3)
0	Interrupt of priority level n is not accepted.
1	Interrupt of priority level n is accepted.

Caution The in-service priority register (ISPR) is a read-only register. The microcontroller may malfunction if this register is written.

23.3.4 Interrupt mode control register (IMC)

The IMC contains the PRSL flag. The PRSL flag specifies enabling/disabling of nesting of maskable interrupts for which the lowest priority level (level 3) is specified.

When the IMC is manipulated, the interrupt disabled state (DI state) should be set first to prevent misoperation. The IMC can be read or written to with an 8-bit manipulation instruction or bit manipulation instruction. $\overline{\text{RESET}}$ input sets the IMC register to 80H.

Figure 23-4. Format of Interrupt Mode Control Register (IMC)

Address: 0FFAAH	After reset: 80H	R/W						
Symbol	7	6	5	4	3	2	1	0
IMC	PRSL	0	0	0	0	0	0	0

PRSL	Nesting control of maskable interrupt (lowest level)
0	Interrupts with level 3 (lowest level) can be nested.
1	Nesting of interrupts with level 3 (lowest level) is disabled.

23.3.5 Watchdog timer mode register (WDM)

The WDT4 bit of the WDM specifies the priority of NMI pin input non-maskable interrupts and watchdog timer overflow non-maskable interrupts.

The WDM can be written to only by a dedicated instruction. This dedicated instruction, MOV WDM, #byte, has a special code configuration (4 bytes), and a write is not performed unless the 3rd and 4th bytes of the operation code are mutual 1's complements.

If the 3rd and 4th bytes of the operation code are not mutual 1's complements, a write is not performed and an operand error interrupt is generated. In this case, the return address saved in the stack area is the address of the instruction that was the source of the error, and thus the address that was the source of the error can be identified from the return address saved in the stack area.

If recovery from an operand error is simply performed by means of an RETB instruction, an endless loop will result.

As an operand error interrupt is only generated in the event of an inadvertent program loop (with the NEC Electronics assembler, RA78K4, only the correct dedicated instruction is generated when MOV WDM, #byte is written), system initialization should be performed by the program.

Other write instructions (MOV WDM, A; AND WDM, #byte; and SET1 WDM.7) are ignored and do not perform any operation. That is, a write is not performed to the WDM, and an interrupt such as an operand error interrupt is not generated.

The WDM can be read at any time by a data transfer instruction.

$\overline{\text{RESET}}$ input clears the WDM register to 00H.

Figure 23-5. Format of Watchdog Timer Mode Register (WDM)

Address: 0FFC2H			After reset: 00H				R/W	
Symbol	7	6	5	4	3	2	1	0
WDM	RUN	0	0	WDT4	0	WDT2	WDT1	0
	RUN	Specifies operation of watchdog timer (refer to Figure 13-2).						
	WDT4	Priority of watchdog timer interrupt request						
	0	Watchdog timer interrupt request < NMI pin input interrupt request						
	1	Watchdog timer interrupt request > NMI pin input interrupt request						
	WDT2	WDT1	Specifies count clock of watchdog timer (refer to Figure 13-2).					

Caution The watchdog timer mode register (WDM) can be written only by using a dedicated instruction (MOV WDM, #byte).

23.3.6 Interrupt selection control register (SNMI)

The SNMI selects whether to use interrupt request signals from the watchdog timer and inputs from the P02 pin as maskable interrupt signals or non-maskable interrupts.

Since the bit of this register can be set (1) only once after reset, the bit should be cleared (0) by reset.

The SNMI is set with a 1-bit or 8-bit memory manipulation instruction.

$\overline{\text{RESET}}$ input sets the SNMI to 00H.

Figure 23-6. Format of Interrupt Selection Control Register (SNMI)

Address: 0FFA9H	After reset: 00H	R/W						
Symbol	7	6	5	4	3	2	1	0
SNMI	0	0	0	0	0	0	SWDT	SNMI

SWDT	Watchdog timer interrupt selection
0	Use as non-maskable interrupt. Interrupt processing cannot be disabled with interrupt mask register.
1	Use as maskable interrupt. Vectored interrupts and macro service can be used. Interrupt processing can be disabled with interrupt mask register.

SNMI	P02 pin function selection
0	Use as INTP2. Vectored interrupts and macro service can be used. Interrupt processing can be disabled with interrupt mask register. At this time, release of the standby mode with the P02 pin is accomplished with a maskable interrupt.
1	Use as MNI. Interrupt processing cannot be disabled with interrupt mask register. At this time, release of the standby mode with the P02 pin is accomplished with NMI.

23.3.7 Program status word (PSW)

The PSW is a register that holds the current status regarding instruction execution results and interrupt requests. The IE flag that sets enabling/disabling of maskable interrupts is mapped in the lower 8 bits of the PSW (PSWL).

PSWL can be read or written to with an 8-bit manipulation instruction, and can also be manipulated with a bit manipulation instruction or dedicated instruction (EI/DI).

When a vectored interrupt is acknowledged or a BRK instruction is executed, PSWL is saved to the stack and the IE flag is cleared (0). PSWL is also saved to the stack by the PUSH PSW instruction, and is restored from the stack by the RETI, RETB and POP PSW instructions.

When context switching or a BRKCS instruction is executed, PSWL is saved to a fixed area in the register bank, and the IE flag is cleared (0). PSWL is restored from the fixed area in the register bank by an RETCSI or RETCSB instruction.

$\overline{\text{RESET}}$ input sets PSWL to 00H.

Figure 23-7. Format of Program Status Word (PSWL)

After reset: 00H

Symbol	7	6	5	4	3	2	1	0
PSWL	S	Z	RSS	AC	IE	P/V	0	CY

S	Used for normal instruction execution
Z	
RSS	
AC	

IE	Enable or disable accepting interrupt
0	Disable
1	Enable

P/V	Used for normal instruction execution
CY	

23.4 Software Interrupt Acknowledgement Operations

A software interrupt is acknowledged in response to execution of a BRK or BRKCS instruction. Software interrupts cannot be disabled.

23.4.1 BRK instruction software interrupt acknowledgement operation

When a BRK instruction is executed, the program status word (PSW) and program counter (PC) are saved in that order to the stack, the IE flag is cleared (0), the vector table (003EH/003FH) contents are loaded into the lower 16 bits of the PC, and 0000B into the higher 4 bits, and a branch is performed (the start of the service program must be in the base area).

The RETB instruction must be used to return from a BRK instruction software interrupt.

Caution The RETI instruction must not be used to return from a BRK instruction software interrupt. Use the RETB instruction.

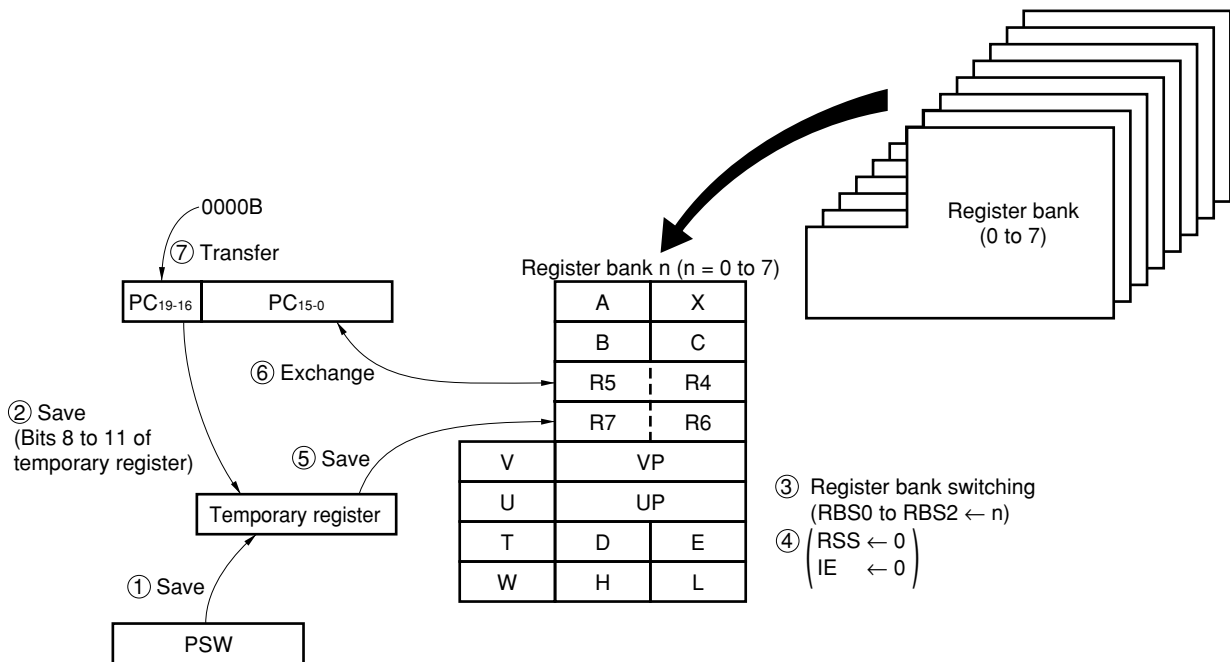
23.4.2 BRKCS instruction software interrupt (software context switching) acknowledgement operation

The context switching function can be initiated by executing a BRKCS instruction.

The register bank to be used after context switching is specified by the BRKCS instruction operand.

When a BRKCS instruction is executed, the program branches to the start address of the interrupt service program (which must be in the base area) stored beforehand in the specified register bank, and the contents of the program status word (PSW) and program counter (PC) are saved in the register bank.

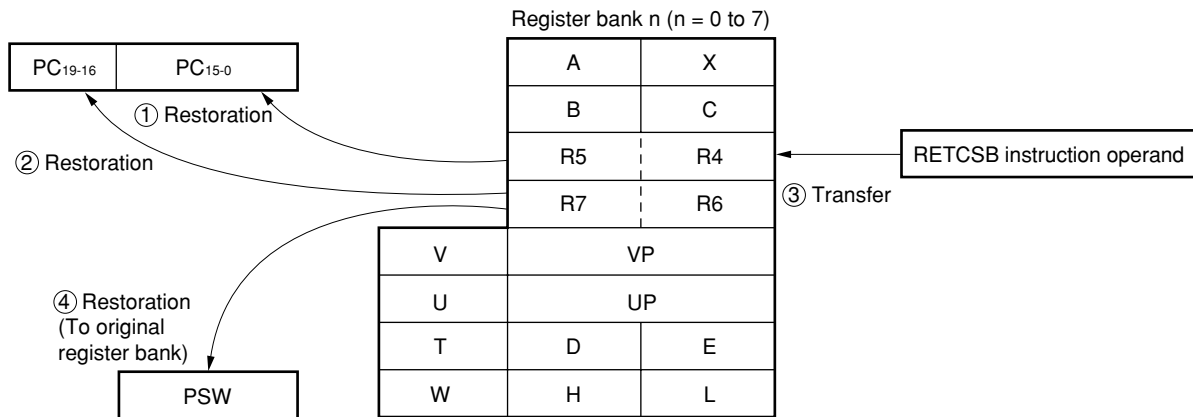
Figure 23-8. Context Switching Operation by Execution of BRKCS Instruction



The RETCSB instruction is used to return from a software interrupt due to a BRKCS instruction. The RETCSB instruction must specify the start address of the interrupt service program for the next time context switching is performed by a BRKCS instruction. This interrupt service program start address must be in the base area.

Caution The RETCS instruction must not be used to return from a BRKCS instruction software interrupt. Use the RETCSB instruction.

Figure 23-9. Return from BRKCS Instruction Software Interrupt (RETCSB Instruction Operation)



23.5 Operand Error Interrupt Acknowledge

An operand error interrupt is generated when the data obtained by inverting all the bits of the 3rd byte of the operand of an MOV STBC, #byte instruction, LOCATION instruction, or an MOV WDM, #byte instruction does not match the 4th byte of the operand. Operand error interrupts cannot be disabled.

When an operand error interrupt is generated, the program status word (PSW) and the start address of the instruction that caused the error are saved to the stack, the IE flag is cleared (0), the vector table value is loaded into the program counter (PC), and a branch is performed (within the base area only).

As the address saved to the stack is the start address of the instruction in which the error occurred, simply writing an RETB instruction at the end of the operand error interrupt service program will result in generation of another operand error interrupt. You should therefore either process the address in the stack or initialize the program by referring to **23.12 Restoring Interrupt Function to Initial State**.

23.6 Non-Maskable Interrupt Acknowledge

Non-maskable interrupts are acknowledged even in the interrupt disabled state. Non-maskable interrupts can be acknowledged at all times except during execution of the service program for an identical non-maskable interrupt or a non-maskable interrupt of higher priority.

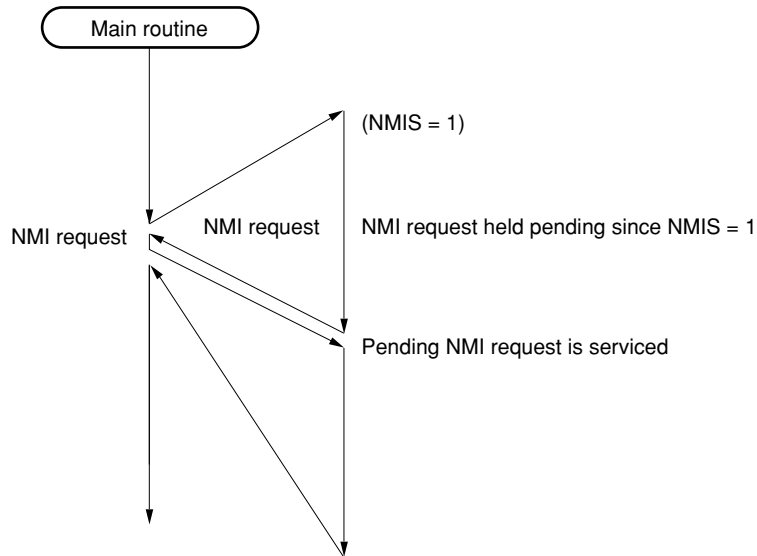
The relative priorities of non-maskable interrupts are set by the WDT4 bit of the watchdog timer mode register (WDM) (see **23.3.5 Watchdog timer mode register (WDM)**).

Except in the cases described in **23.9 When Interrupt Requests and Macro Service Are Temporarily Held Pending**, a non-maskable interrupt request is acknowledged immediately. When a non-maskable interrupt request is acknowledged, the program status word (PSW) and program counter (PC) are saved in that order to the stack, the IE flag is cleared (0), the in-service priority register (ISPR) bit corresponding to the acknowledged non-maskable interrupt is set (1), the vector table contents are loaded into the PC, and a branch is performed. The ISPR bit that is set (1) is the NMIS bit in the case of a non-maskable interrupt due to edge input to the NMI pin, and the WDTS bit in the case of watchdog timer overflow.

When the non-maskable interrupt service program is executed, non-maskable interrupt requests of the same priority as the non-maskable interrupt currently being executed and non-maskable interrupts of lower priority than the non-maskable interrupt currently being executed are held pending. A pending non-maskable interrupt is acknowledged after completion of the non-maskable interrupt service program currently being executed (after execution of the RETI instruction). However, even if the same non-maskable interrupt request is generated more than once during execution of the non-maskable interrupt service program, only one non-maskable interrupt is acknowledged after completion of the non-maskable interrupt service program.

Figure 23-10. Non-Maskable Interrupt Request Acknowledgement Operations (1/2)

(a) When a new NMI request is generated during NMI service program execution



(b) When a watchdog timer interrupt request is generated during NMI service program execution (when the watchdog timer interrupt priority is higher (when WDT4 in the WDM = 1))

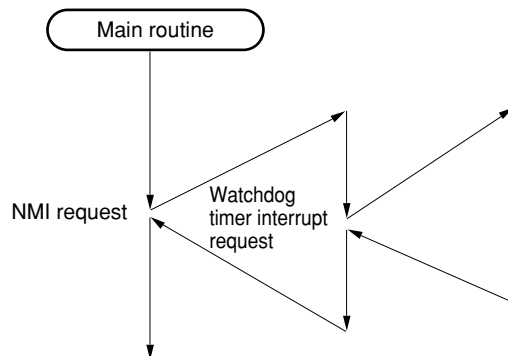
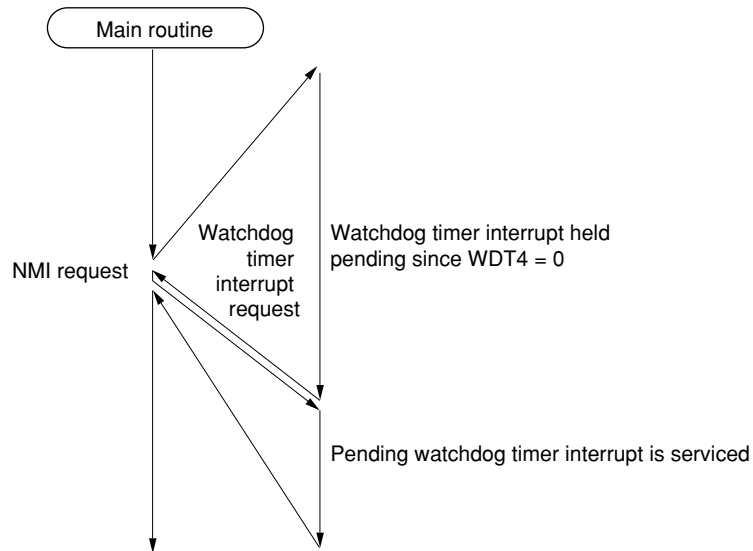
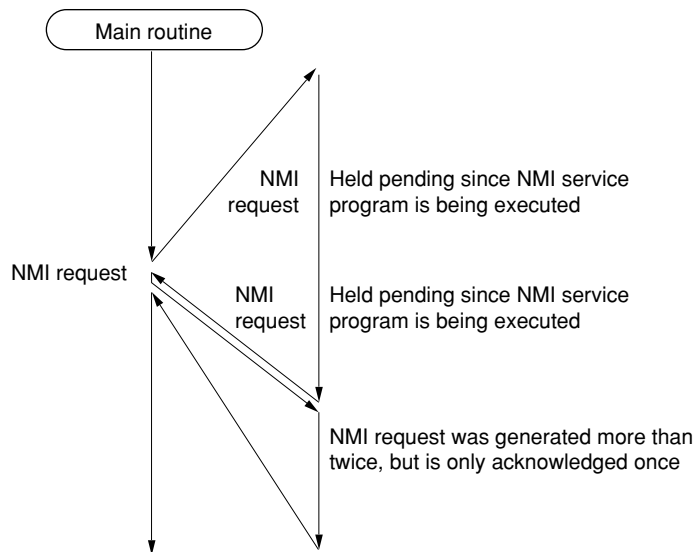


Figure 23-10. Non-Maskable Interrupt Request Acknowledgement Operations (2/2)

- (c) When a watchdog timer interrupt request is generated during NMI service program execution (when the NMI interrupt priority is higher (when WDT4 in the WDM = 0))



- (d) When an NMI request is generated twice during NMI service program execution



- Cautions**
1. Macro service requests are acknowledged and serviced even during execution of a non-maskable interrupt service program. If you do not want macro service processing to be performed during a non-maskable interrupt service program, you should manipulate the interrupt mask register in the non-maskable interrupt service program to prevent macro service generation.
 2. The RETI instruction must be used to return from a non-maskable interrupt. Subsequent interrupt acknowledgement will not be performed normally if a different instruction is used. If you restart a program from the initial state after a non-maskable interrupt acknowledgement, refer to 23.12 Restoring Interrupt Function to Initial State.
 3. Non-maskable interrupts are always acknowledged, except during non-maskable interrupt service program execution (except when a high non-maskable interrupt request is generated during execution of a low-priority non-maskable interrupt service program) and for a certain period after execution of the special instructions shown in 23.9. Therefore, a non-maskable interrupt will be acknowledged even when the stack pointer (SP) value is undefined, in particular after reset release, etc. In this case, depending on the value of the SP, it may happen that the program counter (PC) and program status word (PSW) are written to the address of a write-inhibited special function register (SFR) (see Table 3-6 in 3.9 Special Function Registers (SFRs)), and the CPU becomes deadlocked, or an unexpected signal is output from a pin, or the PC and PSW are written to an address in which RAM is not mounted, with the result that the return from the non-maskable interrupt service program is not performed normally and a runaway occurs.

Therefore, the program following $\overline{\text{RESET}}$ release must be as shown below.

```
CSEG AT 0
DW  STRT
CSEG BASE
STRT:
LOCATION 0FH; or LOCATION 0
MOVG SP, #imm24
```


23.7 Maskable Interrupt Acknowledge

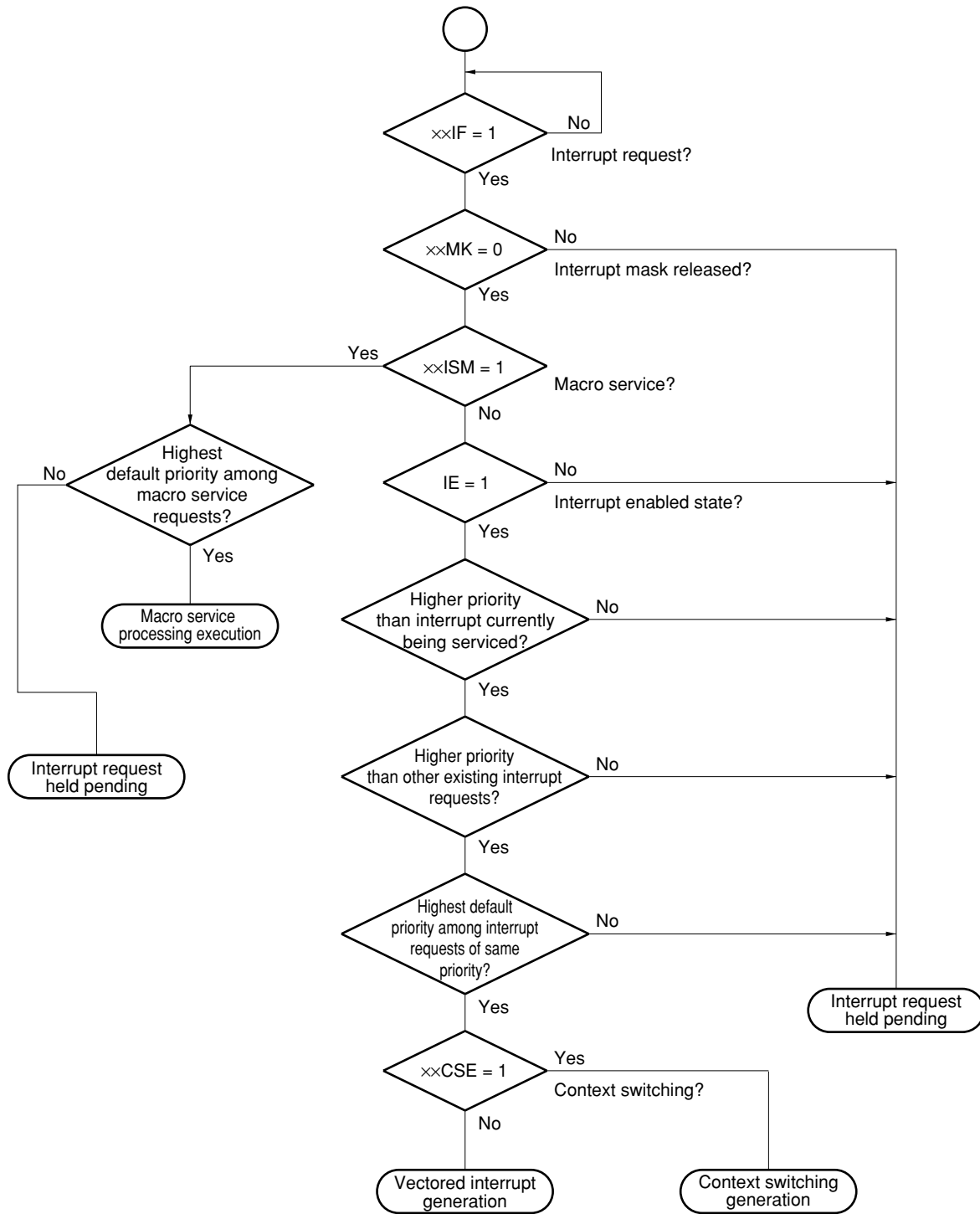
A maskable interrupt can be acknowledged when the interrupt request flag is set (1) and the mask flag for that interrupt is cleared (0). When servicing is performed by macro service, the interrupt is acknowledged and serviced by macro service immediately. In the case of vectored interruption and context switching, an interrupt is acknowledged in the interrupt enabled state (when the IE flag is set (1)) if the priority of that interrupt is one for which acknowledgement is permitted.

If maskable interrupt requests are generated simultaneously, the interrupt for which the highest priority is specified by the priority specification flag is acknowledged. If the interrupts have the same priority specified, they are acknowledged in accordance with their default priorities.

A pending interrupt is acknowledged when a state in which it can be acknowledged is established.

The interrupt acknowledgement algorithm is shown in Figure 23-11.

Figure 23-11. Interrupt Acknowledgement Processing Algorithm



23.7.1 Vectored interrupt

When a vectored interrupt maskable interrupt request is acknowledged, the program status word (PSW) and program counter (PC) are saved in that order to the stack, the IE flag is cleared (0) (the interrupt disabled state is set), and the in-service priority register (ISPR) bit corresponding to the priority of the acknowledged interrupt is set (1). Also, data in the vector table predetermined for each interrupt request is loaded into the PC, and a branch is performed. The return from a vectored interrupt is performed by means of the RETI instruction.

Caution When a maskable interrupt is acknowledged by vectored interrupt, the RETI instruction must be used to return from the interrupt. Subsequent interrupt acknowledgement will not be performed normally if a different instruction is used.

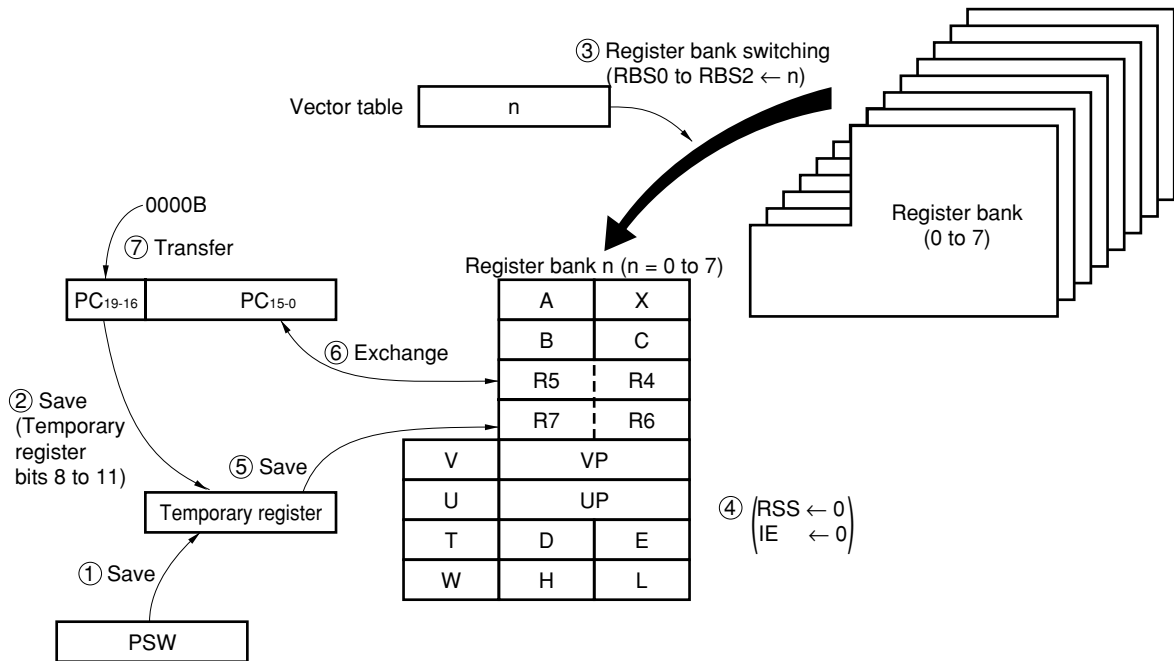
23.7.2 Context switching

Initiation of the context switching function is enabled by setting (1) the context switching enable flag of the interrupt control register.

When an interrupt request for which the context switching function is enabled is acknowledged, the register bank specified by 3 bits of the lower address (even address) of the corresponding vector table address is selected.

The vector address stored beforehand in the selected register bank is transferred to the program counter (PC), and at the same time the contents of the PC and program status word (PSW) up to that time are saved in the register bank and branching is performed to the interrupt service program.

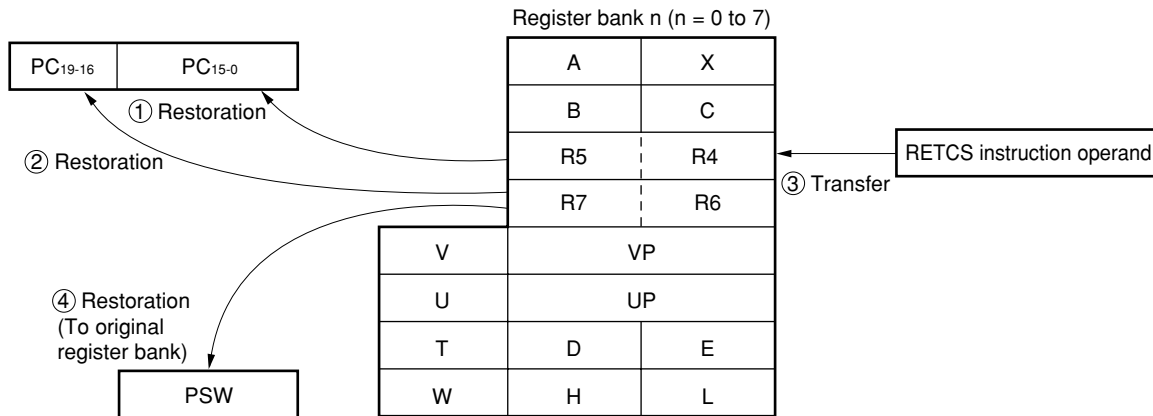
Figure 23-12. Context Switching Operation by Generation of Interrupt Request



The RETCS instruction is used to return from an interrupt that uses the context switching function. The RETCS instruction must specify the start address of the interrupt service program to be executed when that interrupt is acknowledged next. This interrupt service program start address must be in the base area.

Caution The RETCS instruction must be used to return from an interrupt serviced by context switching. Subsequent interrupt acknowledgement will not be performed normally if a different instruction is used.

Figure 23-13. Return from Interrupt That Uses Context Switching by Means of RETCS Instruction



23.7.3 Maskable interrupt priority levels

The μ PD784218A performs multiple interrupt servicing in which an interrupt is acknowledged during servicing of another interrupt. Multiple interrupts can be controlled by priority levels.

There are two kinds of priority control, control by default priority and programmable priority control in accordance with the setting of the priority specification flag. In priority control by means of default priority, interrupt service is performed in accordance with the priority preassigned to each interrupt request (default priority) (refer to **Table 23-2**). In programmable priority control, interrupt requests are divided into four levels according to the setting of the priority specification flag. Interrupt requests for which multiple interruption is permitted are shown in Table 23-5.

Since the IE flag is cleared (0) automatically when an interrupt is acknowledged, when multiple interruption is used, the IE flag should be set (1) to enable interrupts by executing an IE instruction in the interrupt service program, etc.

Table 23-5. Multiple Interrupt Servicing

Priority of Interrupt Currently Being Acknowledged	ISPR Value	IE Flag in PSW	PRSL Flag in IMC	Acknowledgeable Maskable Interrupts
No interrupt being acknowledged	00000000	0	×	• All macro service only
		1	×	• All maskable interrupts
3	00001000	0	×	• All macro service only
		1	0	• All maskable interrupts
		1	1	• All macro service • Maskable interrupts specified as priority 0/1/2
2	0000×100	0	×	• All macro service only
		1	×	• All macro service • Maskable interrupts specified as priority 0/1
1	0000××10	0	×	• All macro service only
		1	×	• All macro service • Maskable interrupts specified as priority 0
0	0000×××1	×	×	• All macro service only
Non-maskable interrupts	1000×××× 0100×××× 1100××××	×	×	• All macro service only

Figure 23-14. Examples of Servicing When Another Interrupt Request Is Generated During Interrupt Service (1/3)

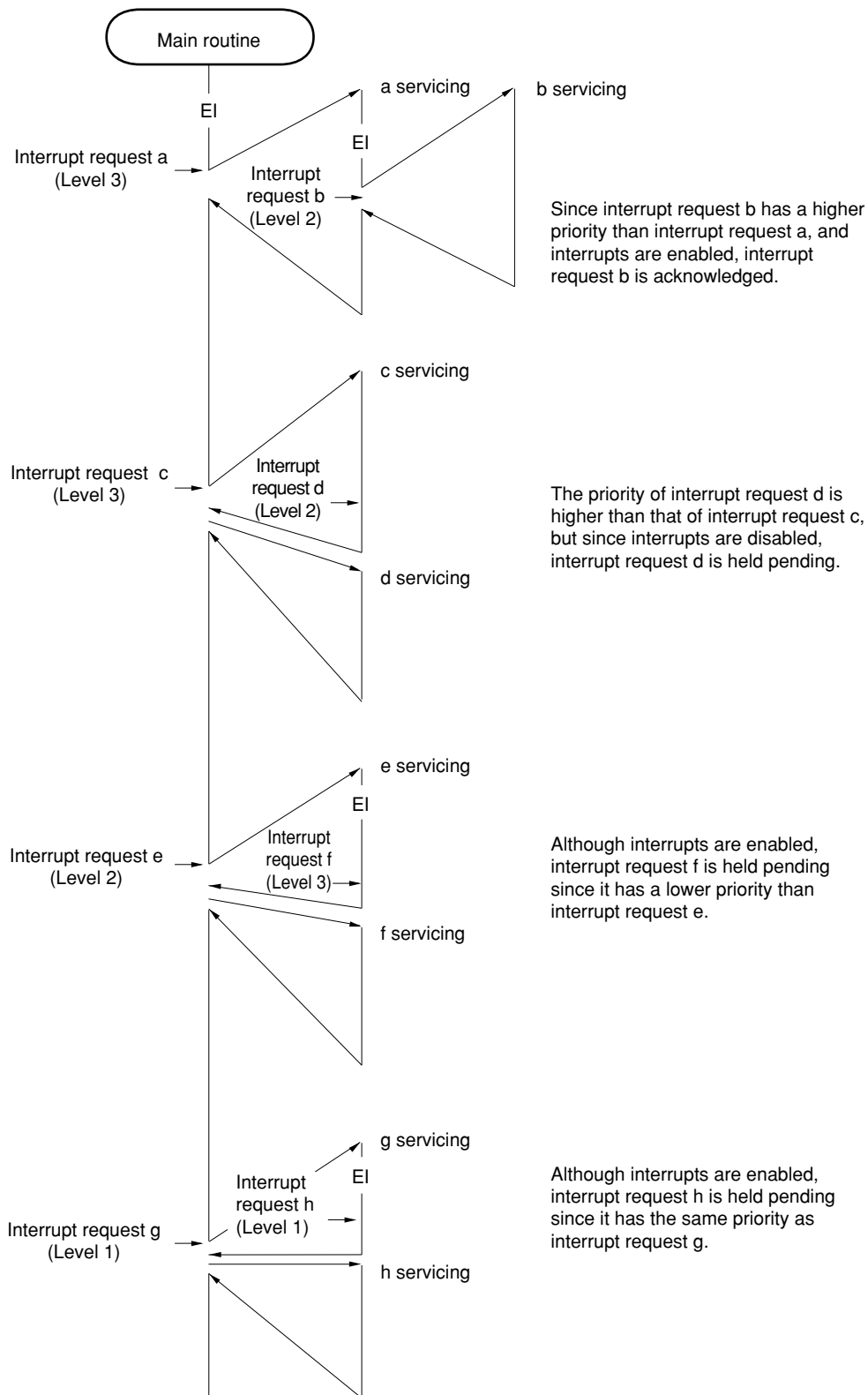
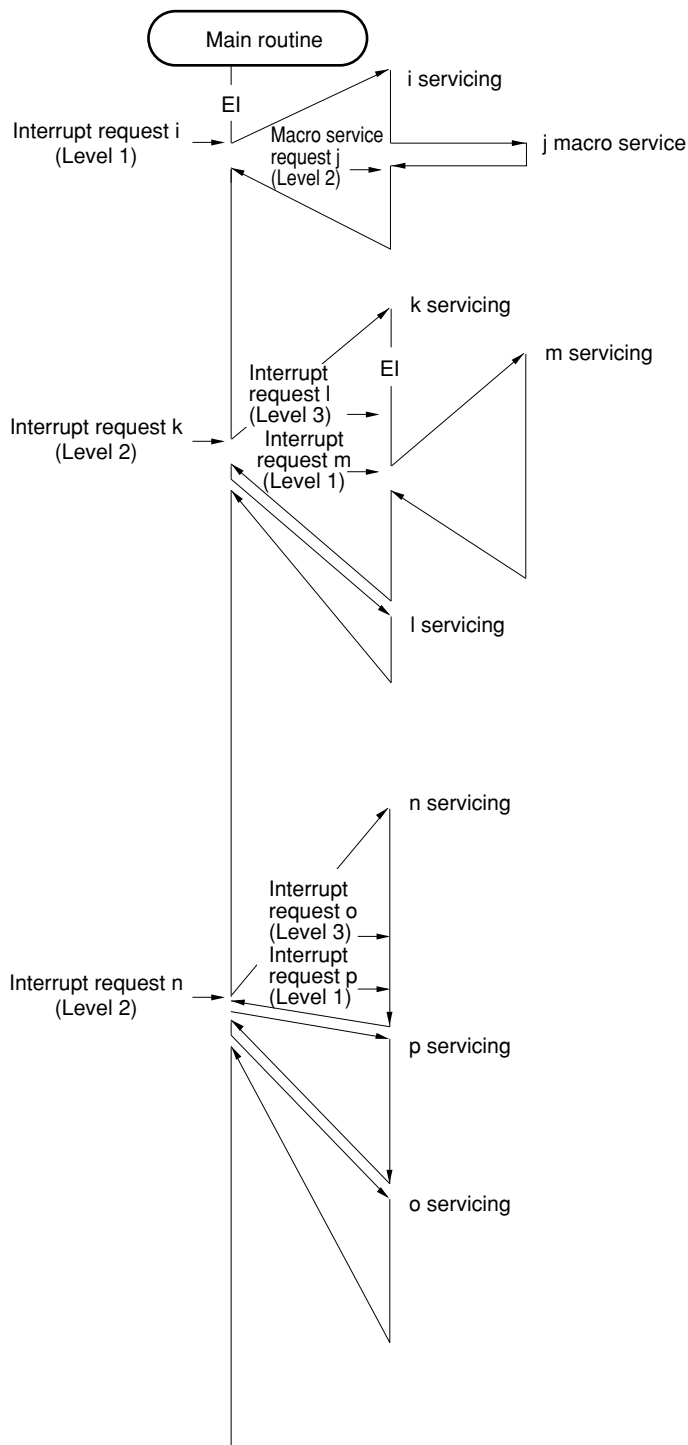


Figure 23-14. Examples of Servicing When Another Interrupt Request Is Generated During Interrupt Service (2/3)

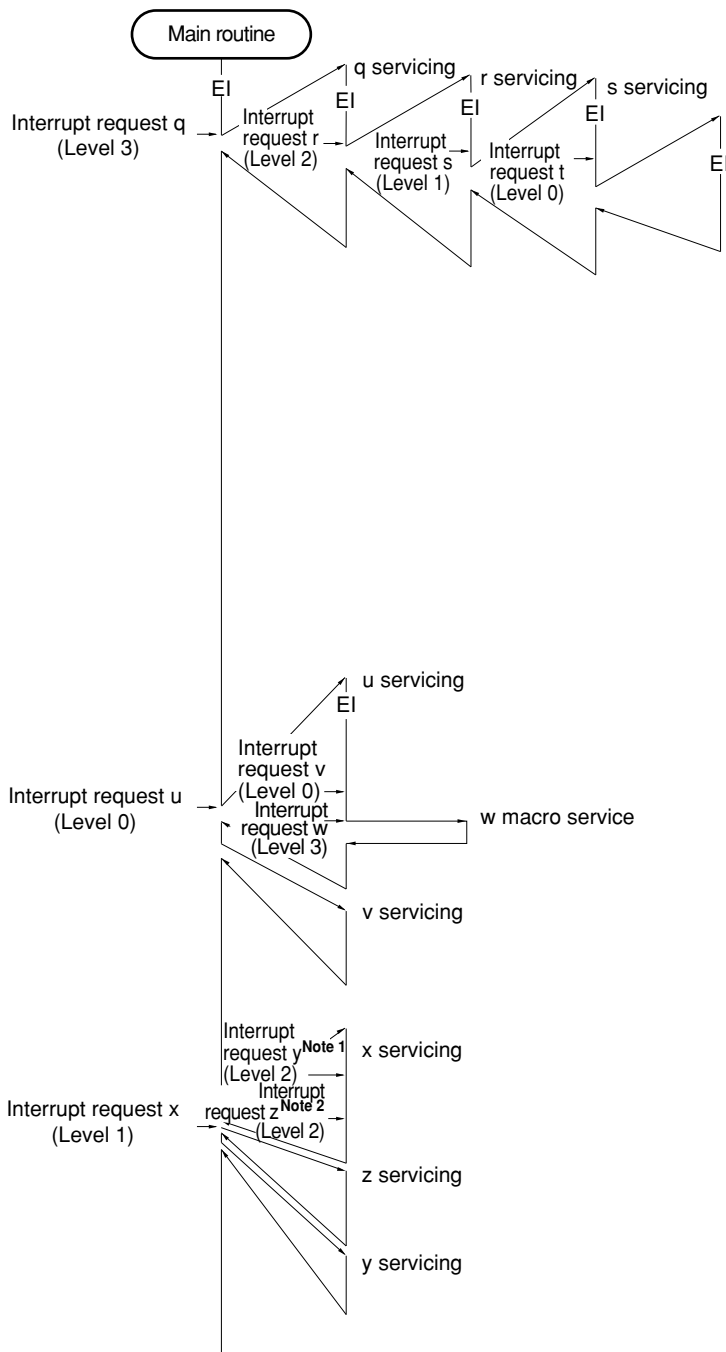


The macro service request is serviced irrespective of interrupt enabling/disabling and priority.

The interrupt request l is held pending since it has a lower priority than interrupt request k. Interrupt request m generated after interrupt request l has a higher priority, and is therefore acknowledged first.

Since servicing of interrupt request n performed in the interrupt disabled state, interrupt requests o and p are held pending. After interrupt request n servicing, the pending interrupt requests are acknowledged. Although interrupt request o was generated first, interrupt request p has a higher priority and is therefore acknowledged first.

Figure 23-14. Examples of Servicing When Another Interrupt Request Is Generated During Interrupt Service (3/3)



Multiple acknowledgement of levels 3 to 0. If the PRSL bit of the IMC register is set (1), only macro service requests and non-maskable interrupts generate nesting beyond this. If the PRSL bit of the IMC register is cleared (0), level 3 interrupts can also be nested during level 3 interrupt servicing (see Figure 23-16).

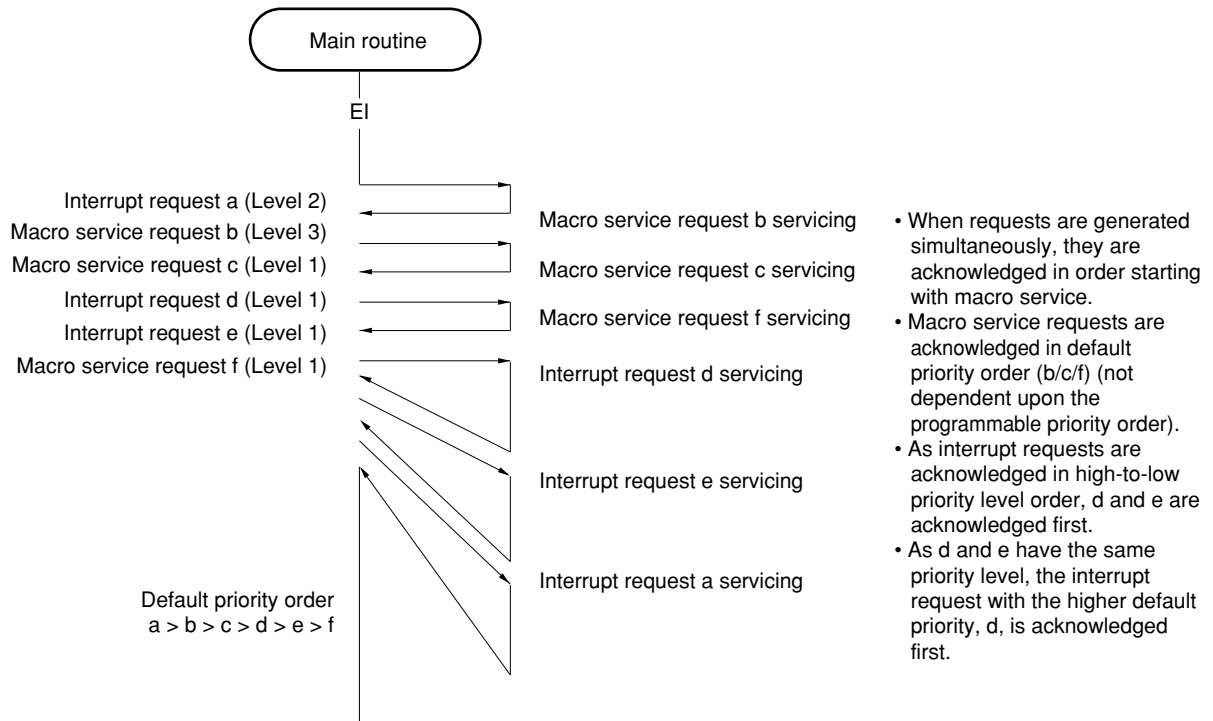
Even though the interrupt enabled state is set during servicing of level 0 interrupt request u, the interrupt request is not acknowledged but held pending even though its priority is 0. However, the macro service request is acknowledged and serviced irrespective of its level and even though there is a pending interrupt with a higher priority level.

Pending interrupt requests y and z are acknowledged after servicing of interrupt request x. As interrupt requests y and z have the same priority level, interrupt request z which has the higher default priority is acknowledged first, irrespective of the order in which the interrupt requests were generated.

- Notes**
1. Low default priority
 2. High default priority

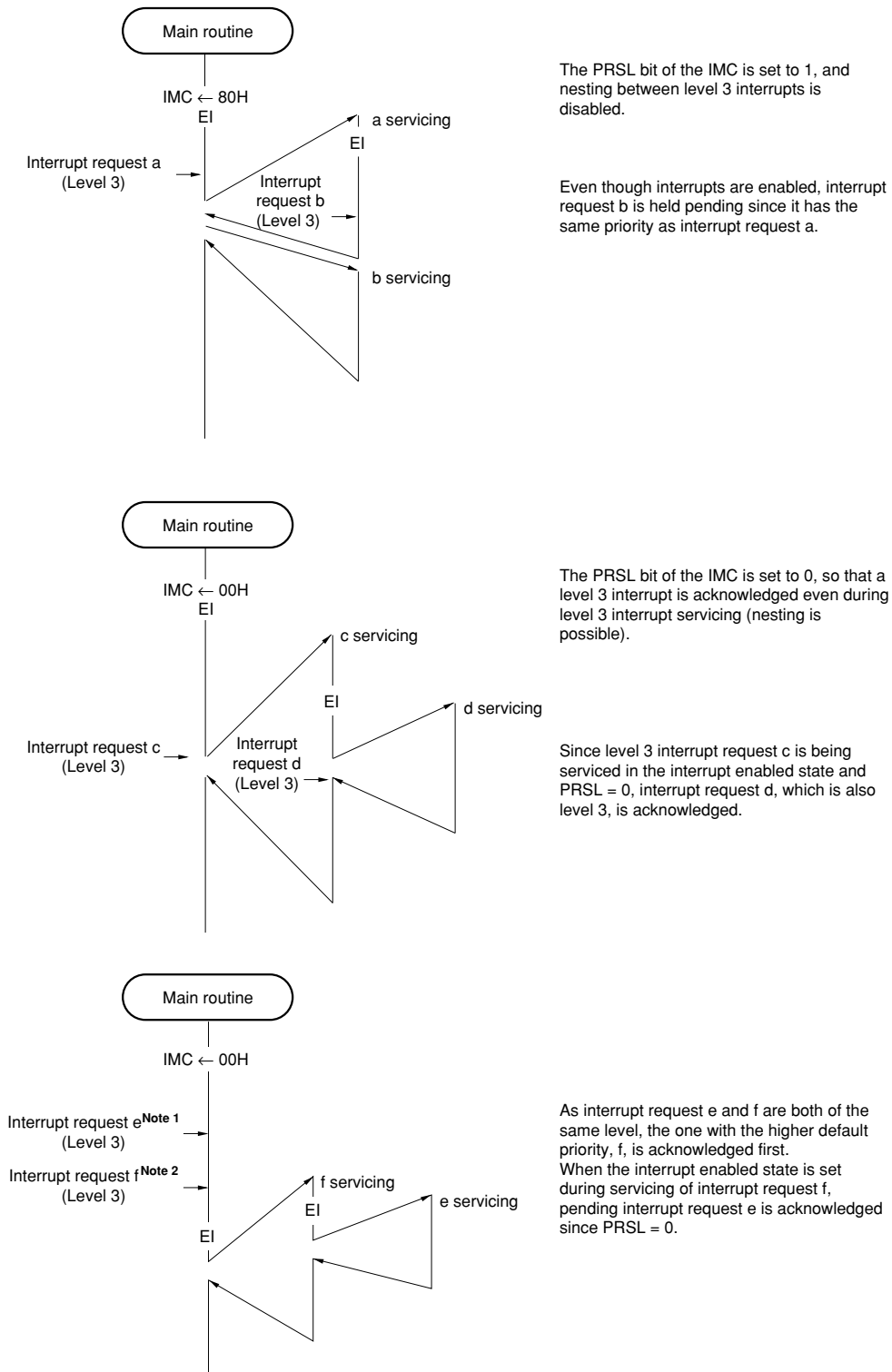
- Remarks**
1. “a” to “z” in the figure above are arbitrary names used to differentiate between the interrupt requests and macro service requests.
 2. High/low default priorities in the figure indicate the relative priority levels of the two interrupt requests.

Figure 23-15. Examples of Servicing of Simultaneously Generated Interrupts



Remark “a” to “f” in the figure above are arbitrary names used to differentiate between the interrupt requests and macro service requests.

Figure 23-16. Differences in Level 3 Interrupt Acknowledgement According to IMC Register Setting



The PRSL bit of the IMC is set to 1, and nesting between level 3 interrupts is disabled.

Even though interrupts are enabled, interrupt request b is held pending since it has the same priority as interrupt request a.

The PRSL bit of the IMC is set to 0, so that a level 3 interrupt is acknowledged even during level 3 interrupt servicing (nesting is possible).

Since level 3 interrupt request c is being serviced in the interrupt enabled state and PRSL = 0, interrupt request d, which is also level 3, is acknowledged.

As interrupt request e and f are both of the same level, the one with the higher default priority, f, is acknowledged first. When the interrupt enabled state is set during servicing of interrupt request f, pending interrupt request e is acknowledged since PRSL = 0.

- Notes**
1. Low default priority
 2. High default priority

- Remarks**
1. "a" to "f" in the figure above are arbitrary names used to differentiate the interrupt requests.
 2. High/low default priorities in the figure indicate the relative priority levels of the two interrupt requests.

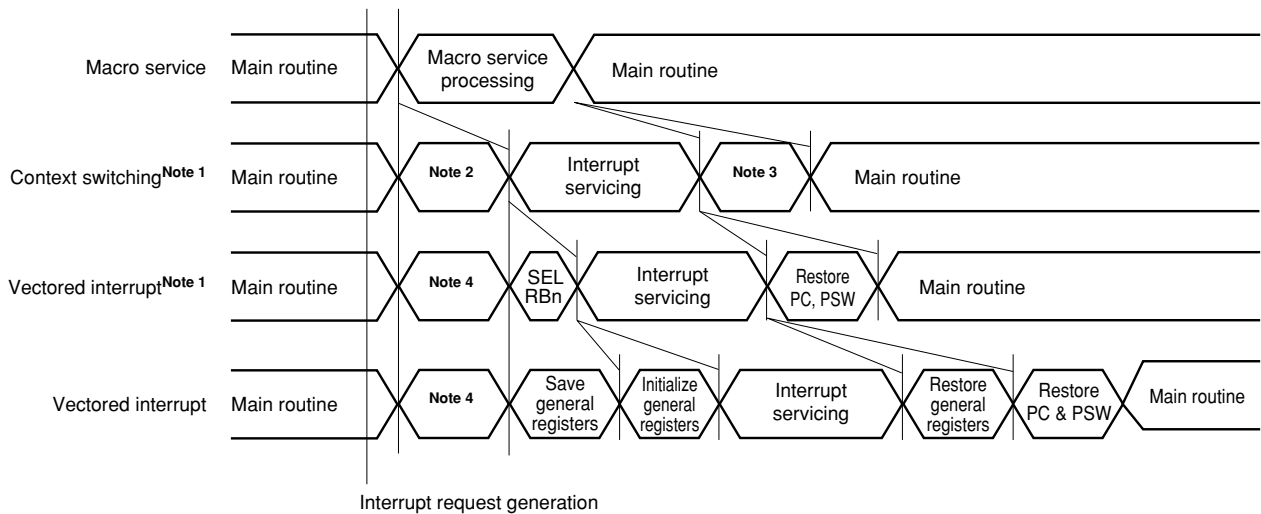
23.8 Macro Service Function

23.8.1 Outline of macro service function

Macro service is one method of servicing interrupts. With a normal interrupt, the program counter (PC) and program status word (PSW) are saved, and the start address of the interrupt service program is loaded into the PC, but with macro service, different processing (mainly data transfers) is performed instead of this processing. This enables interrupt requests to be responded to quickly, and moreover, since transfer processing is faster than processing by a program, the processing time can also be reduced.

Also, since a vectored interrupt is generated after processing has been performed the specified number of times, another advantage is that vectored interrupt programs can be simplified.

Figure 23-17. Differences Between Vectored Interrupt and Macro Service Processing



- Notes**
1. When register bank switching is used, and an initial value has been set in the register beforehand
 2. Register bank switching by context switching, saving of PC and PSW
 3. Register bank, PC and PSW restoration by context switching
 4. PC and PSW saved to the stack, vector address loaded into PC

23.8.2 Types of macro service

Macro service can be used with the 27 kinds of interrupts shown in Table 23-6. There are four kinds of operation, which can be used to suit the application.

Table 23-6. Interrupts for Which Macro Service Can Be Used

Default Priority	Interrupt Request Generation Source	Generating Unit	Macro Service Control Word Address
0	INTWDTM (Watchdog timer overflow)	Watchdog timer	0FE06H
1	INTP0 (Pin input edge detection)	Edge detection	0FE08H
2	INTP1 (Pin input edge detection)		0FE0AH
3	INTP2 (Pin input edge detection)		0FE0CH
4	INTP3 (Pin input edge detection)		0FE0EH
5	INTP4 (Pin input edge detection)		0FE10H
6	INTP5 (Pin input edge detection)		0FE12H
7	INTP6 (Pin input edge detection)		0FE14H
8	INTIIC0 (CSI0 I ² C bus transfer end) ^{Note}	Clocked serial interface	0FE16H
	INTCSI0 (CSI0 3-wire transfer end)		
9	INTSER1 (ASI1 UART reception error)	Asynchronous serial interface/ clocked serial interface 1	0FE18H
10	INTSR1 (ASI1 UART reception end)		0FE1AH
	INTCSI1 (CSI1 3-wire transfer end)		
11	INTST1 (ASI1 UART transmission end)	Asynchronous serial interface/ clocked serial interface 2	0FE1CH
12	INTSER2 (ASI2 UART reception error)		0FE1EH
13	INTSR2 (ASI2 UART reception end)		0FE20H
	INTCSI2 (CSI2 3-wire transfer end)		
14	INTST2 (ASI2 UART transmission end)		0FE22H
15	INTTM3 (Reference time interval signal from watch timer)	Watch timer	0FE24H
16	INTTM00 (Match signal generation of 16-bit timer register and capture/compare register (CR00))	Timer/counter	0FE26H
17	INTTM01 (Match signal generation of 16-bit timer register and capture/compare register (CR01))		0FE28H
18	INTTM1 (Match signal generation of 8-bit timer/counter 1)	Timer/counter 1	0FE2AH
19	INTTM2 (Match signal generation of 8-bit timer/counter 2)	Timer/counter 2	0FE2CH
20	INTAD (A/D converter conversion end)	A/D converter	0FE2EH
21	INTTM5 (Match signal generation of 8-bit timer/counter 5)	Timer/counter 5	0FE30H
22	INTTM6 (Match signal generation of 8-bit timer/counter 6)	Timer/counter 6	0FE32H
23	INTTM7 (Match signal generation of 8-bit timer/counter 7)	Timer/counter 7	0FE34H
24	INTTM8 (Match signal generation of 8-bit timer/counter 8)	Timer/counter 8	0FE36H
25	INTWT (Watch timer overflow)	Watch timer	0FE38H
26	INTKR (Falling edge detection of port 8)	Edge detection	0FE3AH

Note μ PD784216AY, 784218AY Subseries only

- Remarks**
1. The default priority is a fixed number. This indicates the order of priority when macro service requests are generated simultaneously,
 2. ASI: Asynchronous serial interface
CSI: Clocked serial interface

There are four kinds of macro service, as shown below.

(1) Type A

One byte or one word of data is transferred between a special function register (SFR) and memory each time an interrupt request is generated, and a vectored interrupt request is generated when the specified number of transfers have been performed.

Memory that can be used in the transfers is limited to internal RAM addresses 0FE00H to 0FEFFH when the LOCATION 0H instruction is executed, and addresses 0FFE00H to 0FFEFFH when the LOCATION 0FH instruction is executed.

The specification method is simple and is suitable for low-volume, high-speed data transfers.

(2) Type B

As with type A, one byte or one word of data is transferred between a special function register (SFR) and memory each time an interrupt request is generated, and a vectored interrupt request is generated when the specified number of transfers have been performed.

The SFR and memory to be used in the transfers is specified by the macro service channel (the entire 1 MB memory space can be used).

This is a general version of type A, suitable for large volumes of transfer data.

(3) Type C

Data is transferred from memory to two special function registers (SFR) each time an interrupt request is generated, and a vectored interrupt request is generated when the specified number of transfers have been performed.

With type C macro service, not only are data transfers performed to two locations in response to a single interrupt request, but it is also possible to add output data ring control and a function that automatically adds data to a compare register. The entire 1 MB memory space can be used.

Type C is mainly used with the INTTM1 and INTTM2 interrupts, and is used for stepping motor control, etc., by macro service, with RTBL or RTBH and CR10, CR1W used as the SFRs to which data is transferred.

(4) Counter mode

This mode is to decrement the macro service counter (MSC) when an interrupt occurs and is used to count the division operation of an interrupt and interrupt generator.

When MSC is 0, a vectored interrupt can be generated.

To restart the macro service, MSC must be set again.

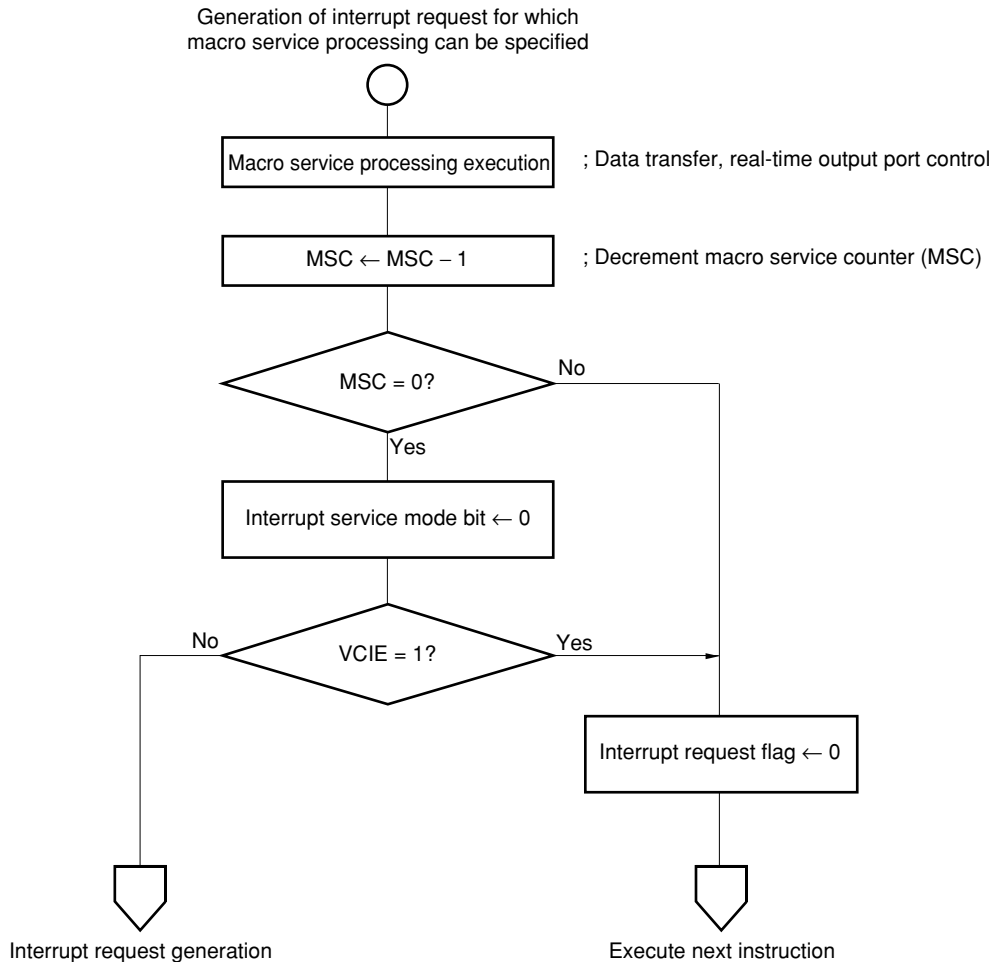
MSC is fixed to 16 bits and cannot be used as an 8-bit counter.

23.8.3 Basic macro service operation

Interrupt requests for which the macro service processing generated by the algorithm shown in Figure 23-11 can be specified are basically serviced in the sequence shown in Figure 23-18.

Interrupt requests for which macro service processing can be specified are not affected by the status of the IE flag, but are disabled by setting (1) an interrupt mask flag in the interrupt mask register (MK0). Macro service processing can be executed in the interrupt disabled state and during execution of an interrupt service program.

Figure 23-18. Macro Service Processing Sequence



The macro service type and transfer direction are determined by the value set in the macro service control word mode register. Transfer processing is then performed using the macro service channel specified by the channel pointer according to the macro service type.

The macro service channel is memory which contains the macro service counter which records the number of transfers, the transfer destination and transfer source pointers, and data buffers, and can be located at any address in the range FE00H to FEFFH when the LOCATION 0H instruction is executed, or FFE00H to FFEFFH when the LOCATION 0FH instruction is executed.

23.8.4 Operation at end of macro service

In macro service, processing is performed the number of times specified during execution of another program. Macro service ends when the processing has been performed the specified number of times (when the macro service counter (MSC) reaches 0). Either of two operations may be performed at this point, as specified by the VCIE bit (bit 7) of the macro service mode register for each macro service.

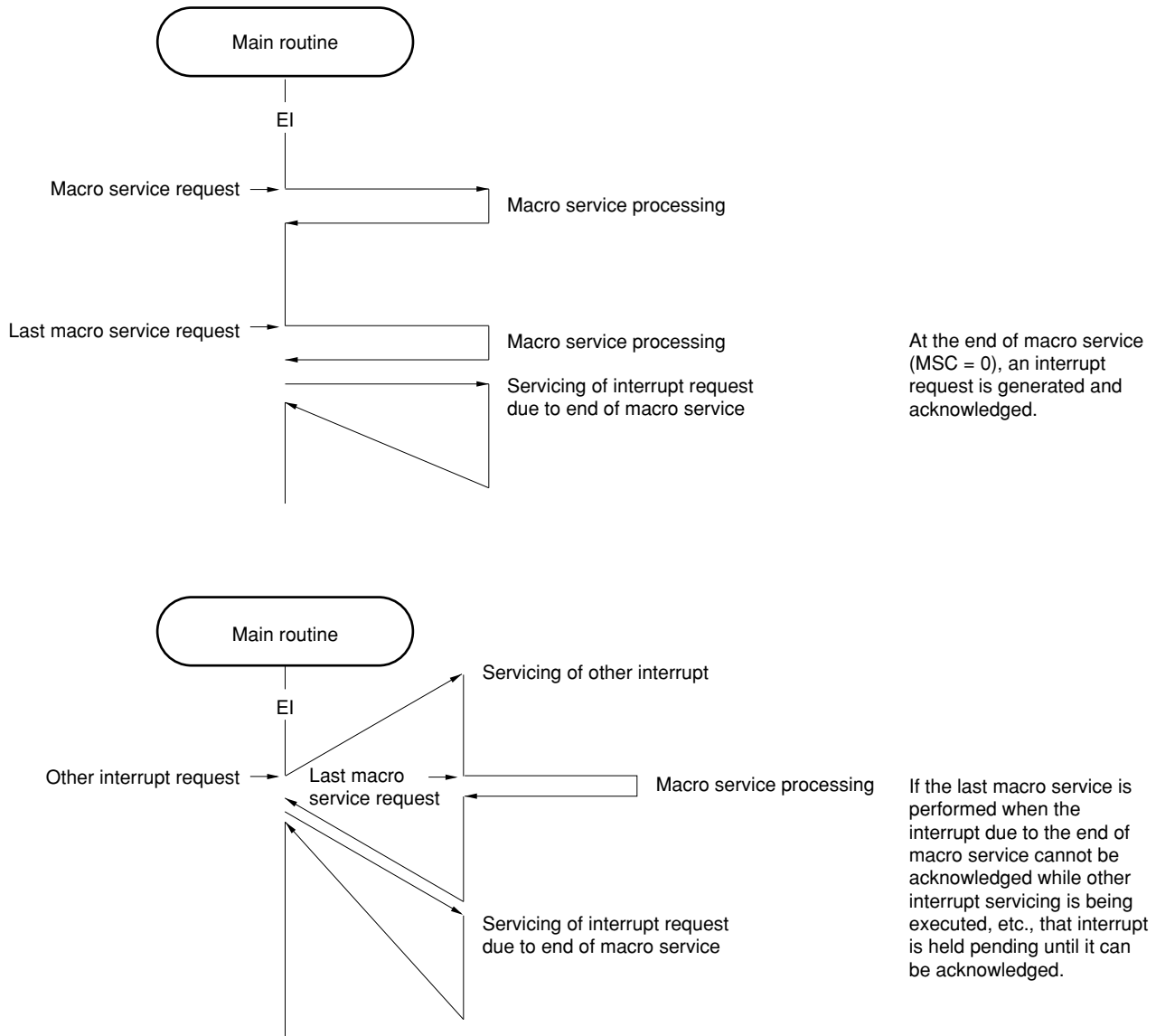
(1) When VCIE bit is 0

In this mode, an interrupt is generated as soon as the macro service ends. Figure 23-18 shows an example of macro service and interrupt acknowledgement operations when the VCIE bit is 0.

This mode is used when a series of operations end with the last macro service processing performed, for instance. It is mainly used in the following cases:

- Asynchronous serial interface receive data buffering (INTSR1, INTSR2)
- A/D conversion result fetch (INTAD)
- Compare register update as the result of a match between a timer register and the compare register (INTTM00, INTTM01, INTTM1, INTTM2, INTTM5 to INTTM8)

Figure 23-19. Operation at End of Macro Service When VCIE = 0



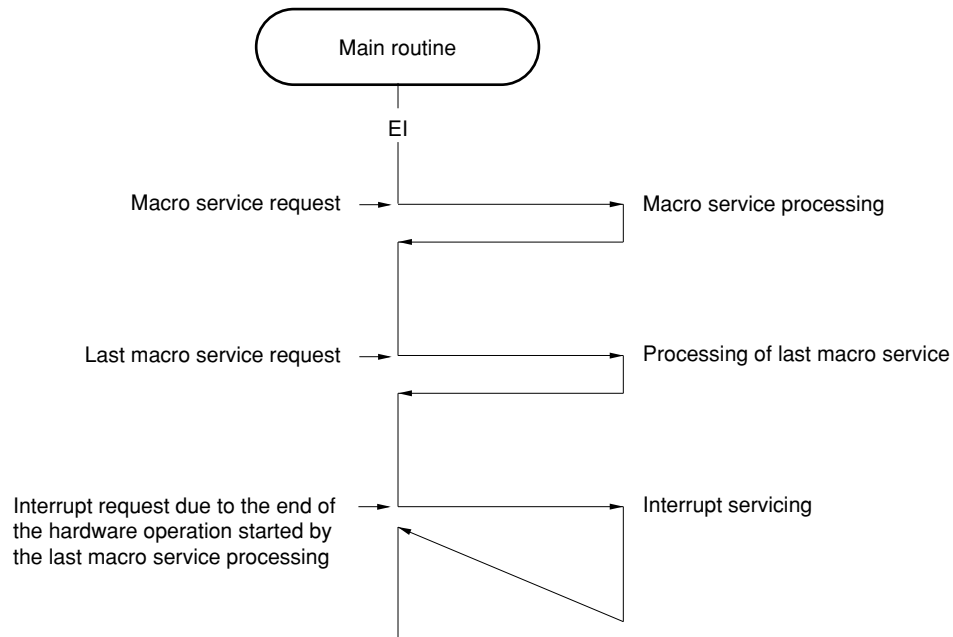
(2) When VCIE bit is 1

In this mode, an interrupt is not generated after macro service ends. Figure 23-20 shows an example of macro service and interrupt acknowledgement operations when the VCIE bit is 1.

This mode is used when the final operation is to be started by the last macro service processing performed, for instance. It is mainly used in the following cases:

- Clocked serial interface data transfers (INTCSI0, INTCSI1, INTCSI2)
- Asynchronous serial interface data transmission (INTST1, INTST2)
- To stop a stepping motor in the case of stepping motor control by means of macro service type C using the real-time output port and timer/counter (INTTM1, INTTM2)

Figure 23-20. Operation at End of Macro Service When VCIE = 1



23.8.5 Macro service control registers

(1) Macro service control word

The μ PD784218A's macro service function is controlled by the macro service mode register and macro service channel pointer. The macro service processing mode is set by means of the macro service mode register, and the macro service channel address is indicated by the macro service channel pointer.

The macro service mode register and macro service channel pointer are mapped onto the part of the internal RAM shown in Figure 23-21 for each macro service as the macro service control word.

When macro service processing is performed, the macro service mode register and channel pointer values corresponding to the interrupt requests for which macro service processing can be specified must be set beforehand.

Figure 23-21. Macro Service Control Word Format

Reserved word	Address		Source
KRCHP	0FE3BH	Channel pointer	} INTKR
KRMD	0FE3AH	Mode register	
WTCHP	0FE39H	Channel pointer	} INTWT
WTMD	0FE38H	Mode register	
CCHP8	0FE37H	Channel pointer	} INTTM8
CMMD8	0FE36H	Mode register	
CCHP7	0FE35H	Channel pointer	} INTTM7
CMMD7	0FE34H	Mode register	
CCHP6	0FE33H	Channel pointer	} INTTM6
CMMD6	0FE32H	Mode register	
CCHP5	0FE31H	Channel pointer	} INTTM5
CMMD5	0FE30H	Mode register	
ADCHP	0FE2FH	Channel pointer	} INTAD
ADMD	0FE2EH	Mode register	
CCHP2	0FE2DH	Channel pointer	} INTTM2
CMMD2	0FE2CH	Mode register	
CCHP1	0FE2BH	Channel pointer	} INTTM1
CMMD1	0FE2AH	Mode register	
CCHP01	0FE29H	Channel pointer	} INTTM01
CMMD01	0FE28H	Mode register	
CCHP00	0FE27H	Channel pointer	} INTTM00
CMMD00	0FE26H	Mode register	
CCHP3	0FE25H	Channel pointer	} INTTM3
CMMD3	0FE24H	Mode register	
STCHP2	0FE23H	Channel pointer	} INTST2
STMMD2	0FE22H	Mode register	
CSICHP2/SRCHP2	0FE21H	Channel pointer	} INTSR2/INTCSI2
CSIMMD2/SRMMD2	0FE20H	Mode register	
SERCHP2	0FE1FH	Channel pointer	} INTSER2
SERMMD2	0FE1EH	Mode register	
STCHP1	0FE1DH	Channel pointer	} INTST1
STMMD1	0FE1CH	Mode register	
CSICHP1/SRCHP1	0FE1BH	Channel pointer	} INTSR1/INTCSI1
CSIMMD1/SRMMD1	0FE1AH	Mode register	
SERCHP1	0FE19H	Channel pointer	} INTSER1
SERMMD1	0FE18H	Mode register	
CSICHP0/IICHP	0FE17H	Channel pointer	} INTIIC0 ^{Note} /INTCSI0
CSIMMD0/IICMD	0FE16H	Mode register	
PCHP6	0FE15H	Channel pointer	} INTP6
PMMD6	0FE14H	Mode register	
PCHP5	0FE13H	Channel pointer	} INTP5
PMMD5	0FE12H	Mode register	
PCHP4	0FE11H	Channel pointer	} INTP4
PMMD4	0FE10H	Mode register	
PCHP3	0FE0FH	Channel pointer	} INTP3
PMMD3	0FE0EH	Mode register	
PCHP2	0FE0DH	Channel pointer	} INTP2
PMMD2	0FE0CH	Mode register	
PCHP1	0FE0BH	Channel pointer	} INTP1
PMMD1	0FE0AH	Mode register	
PCHP0	0FE09H	Channel pointer	} INTP0
PMMD0	0FE08H	Mode register	
WDTCHP	0FE07H	Channel pointer	} INTWDTM
WDTMD	0FE06H	Mode register	

Note μ PD784216AY, 784218AY Subseries only

(2) Macro service mode register

The macro service mode register is an 8-bit register that specifies the macro service operation. This register is written in internal RAM as part of the macro service control word (refer to **Figure 23-21**).

The format of the macro service mode register is shown in Figure 23-22.

Figure 23-22. Macro Service Mode Register Format (1/2)

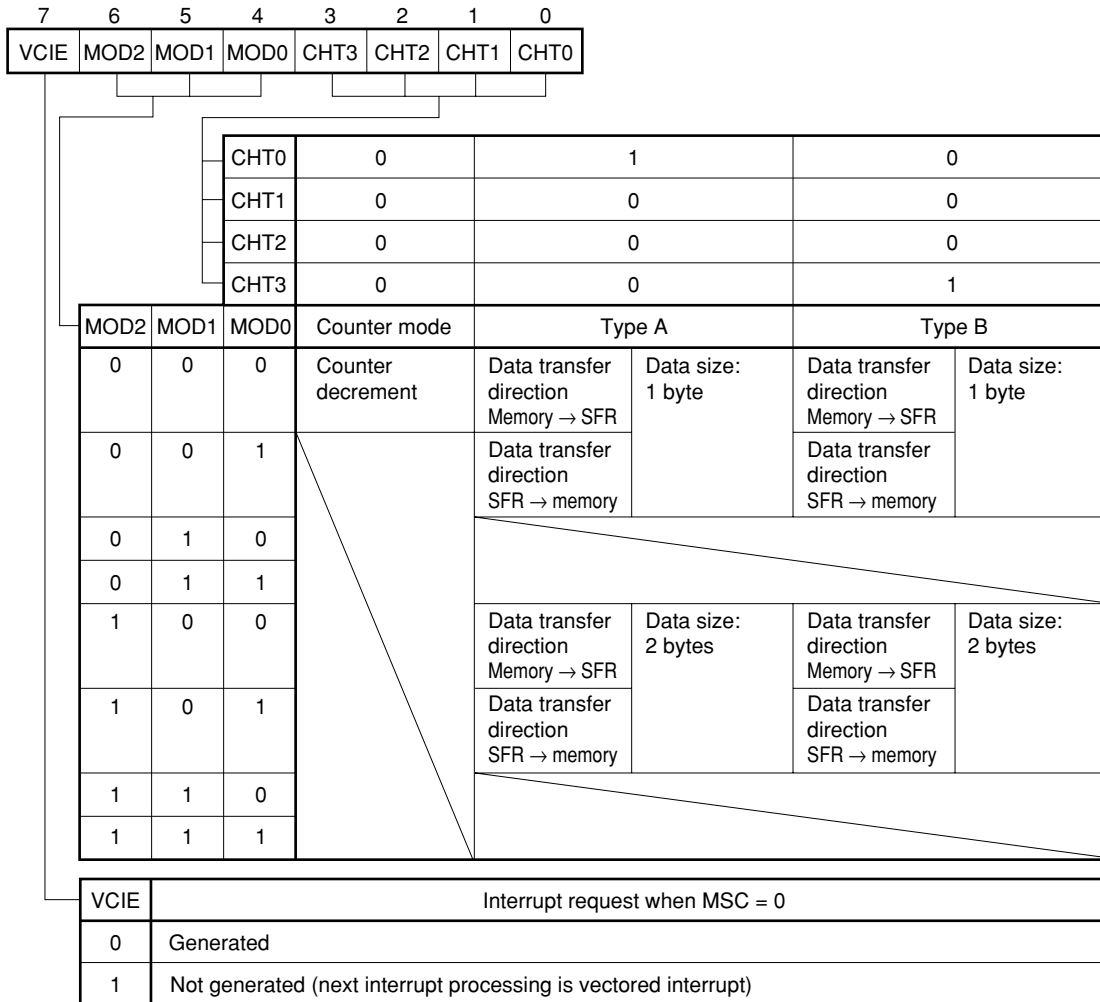
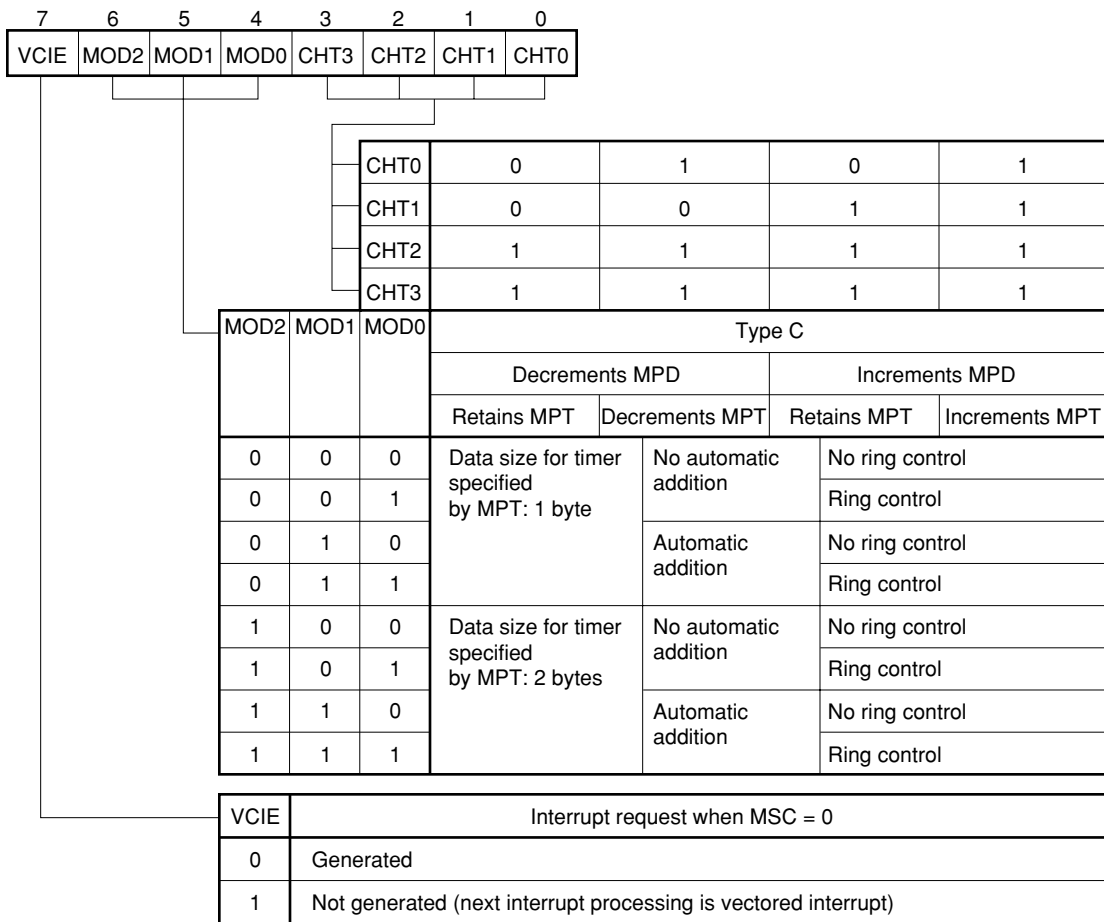


Figure 23-22. Macro Service Mode Register Format (2/2)



(3) Macro service channel pointer

The macro service channel pointer specifies the macro service channel address. The macro service channel can be located in the 256-byte space from FE00H to FEFFH when the LOCATION 0H instruction is executed, or FFE00H to FFEFFH when the LOCATION 0FH instruction is executed, and the higher 16 bits of the address are fixed. Therefore, the lower 8 bits of the data stored to the highest address of the macro service channel are set in the macro service channel pointer.

23.8.6 Macro service type A

(1) Operation

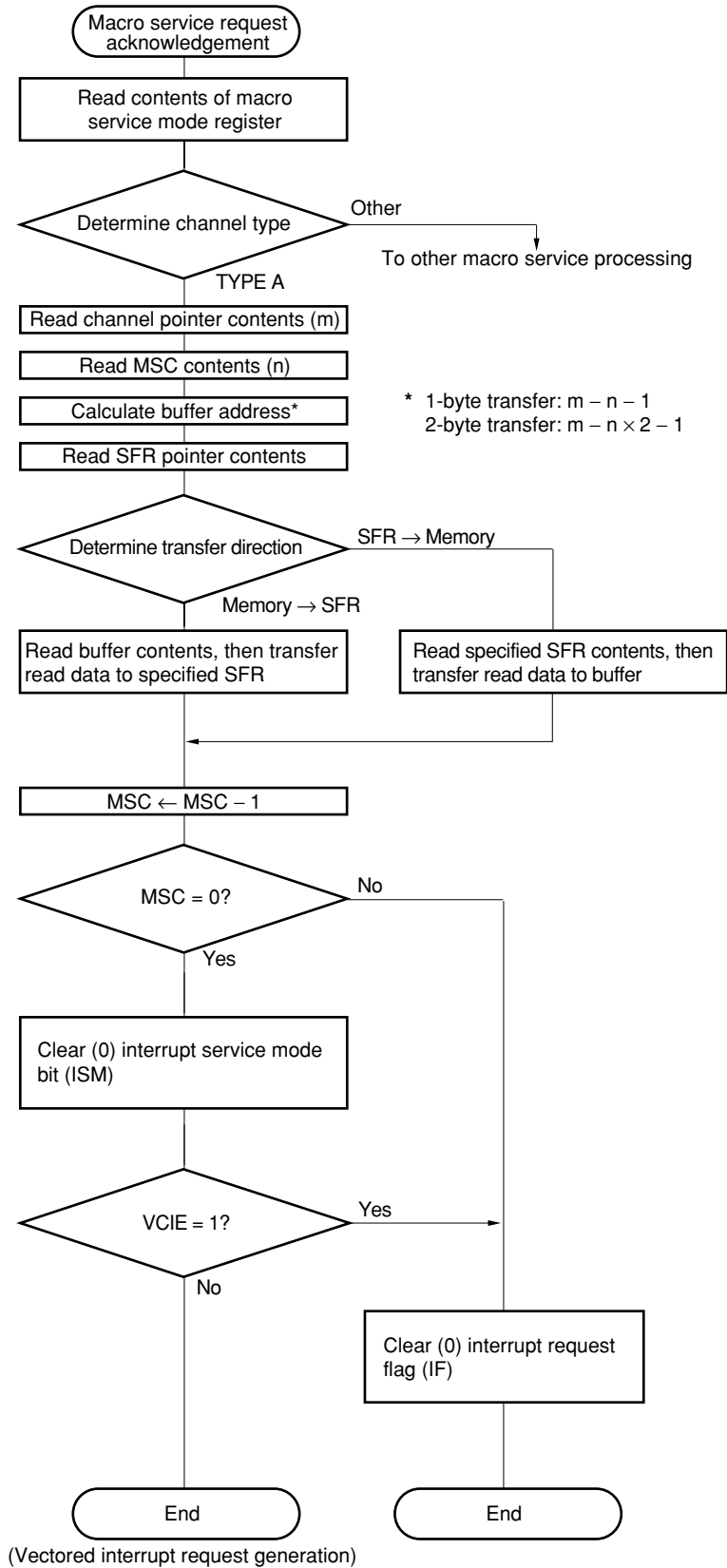
Data transfers are performed between buffer memory in the macro service channel and an SFR specified in the macro service channel.

With type A, the data transfer direction can be selected as memory-to-SFR or SFR-to-memory.

Data transfers are performed the number of times set beforehand in the macro service counter. One macro service processing transfers 8-bit or 16-bit data.

Type A macro service is useful when the amount of data to be transferred is small, as transfers can be performed at high speed.

Figure 23-23. Macro Service Data Transfer Processing Flow (Type A)

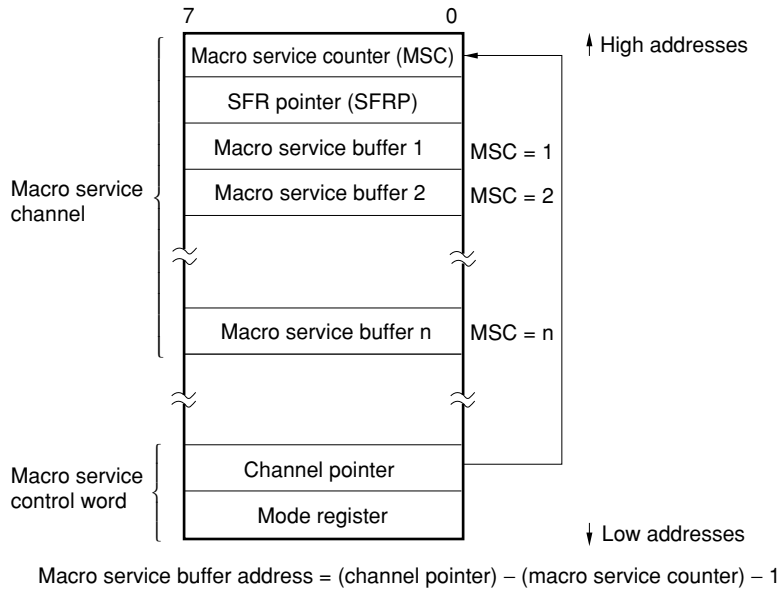


(2) Macro service channel configuration

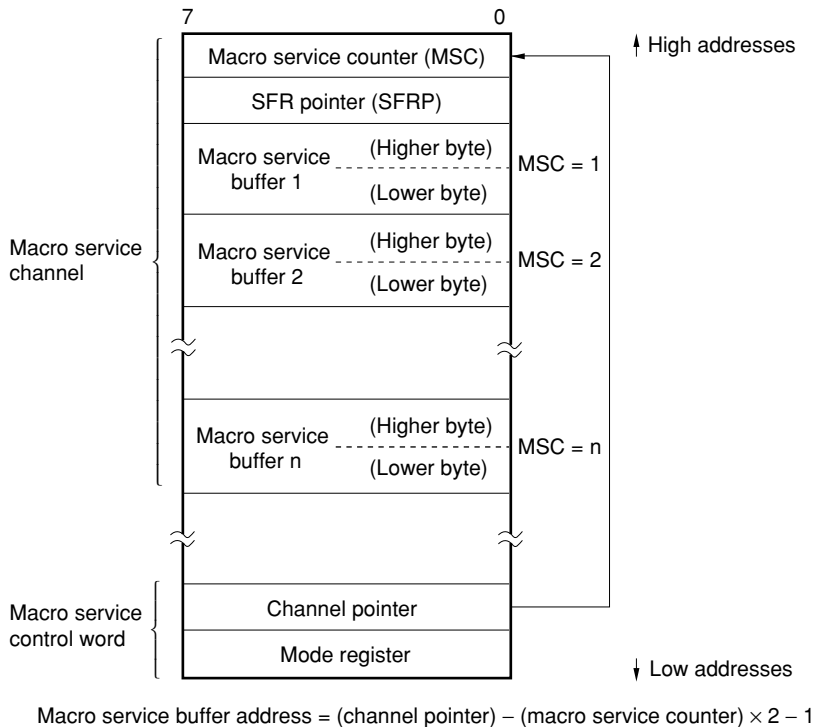
The channel pointer and 8-bit macro service counter (MSC) indicate the buffer address in internal RAM (FE00H to FEFFH when the LOCATION 0H instruction is executed, or FFE00H to FFEFFH when the LOCATION 0FH instruction is executed) which is the transfer source or transfer destination (refer to **Figure 23-24**). In the channel pointer, the lower 8 bits of the address are written to the macro service counter in the macro service channel. The SFR involved with the access is specified by the SFR pointer (SFRP). The lower 8 bits of the SFR address are written to the SFRP.

Figure 23-24. Type A Macro Service Channel

(a) 1-byte transfers



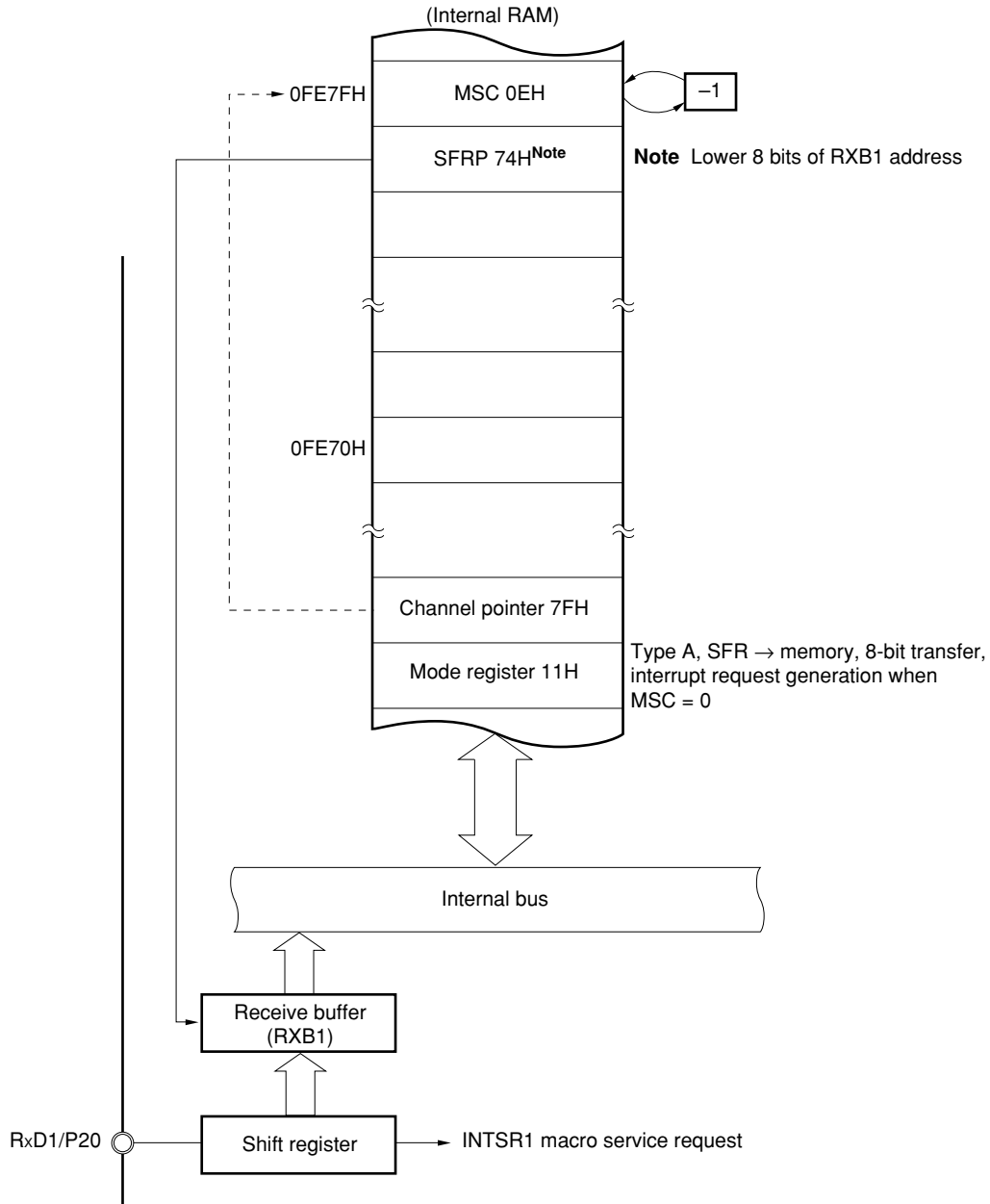
(b) 2-byte transfers



(3) Example of use of type A

An example is shown below in which data received via the asynchronous serial interface is transferred to a buffer area in RAM.

Figure 23-25. Asynchronous Serial Reception



Remark Addresses in the figure are the values when the **LOCATION 0H** instruction is executed. When the **LOCATION 0FH** instruction is executed, **0F0000H** should be added to the values in the figure.

23.8.7 Macro service type B

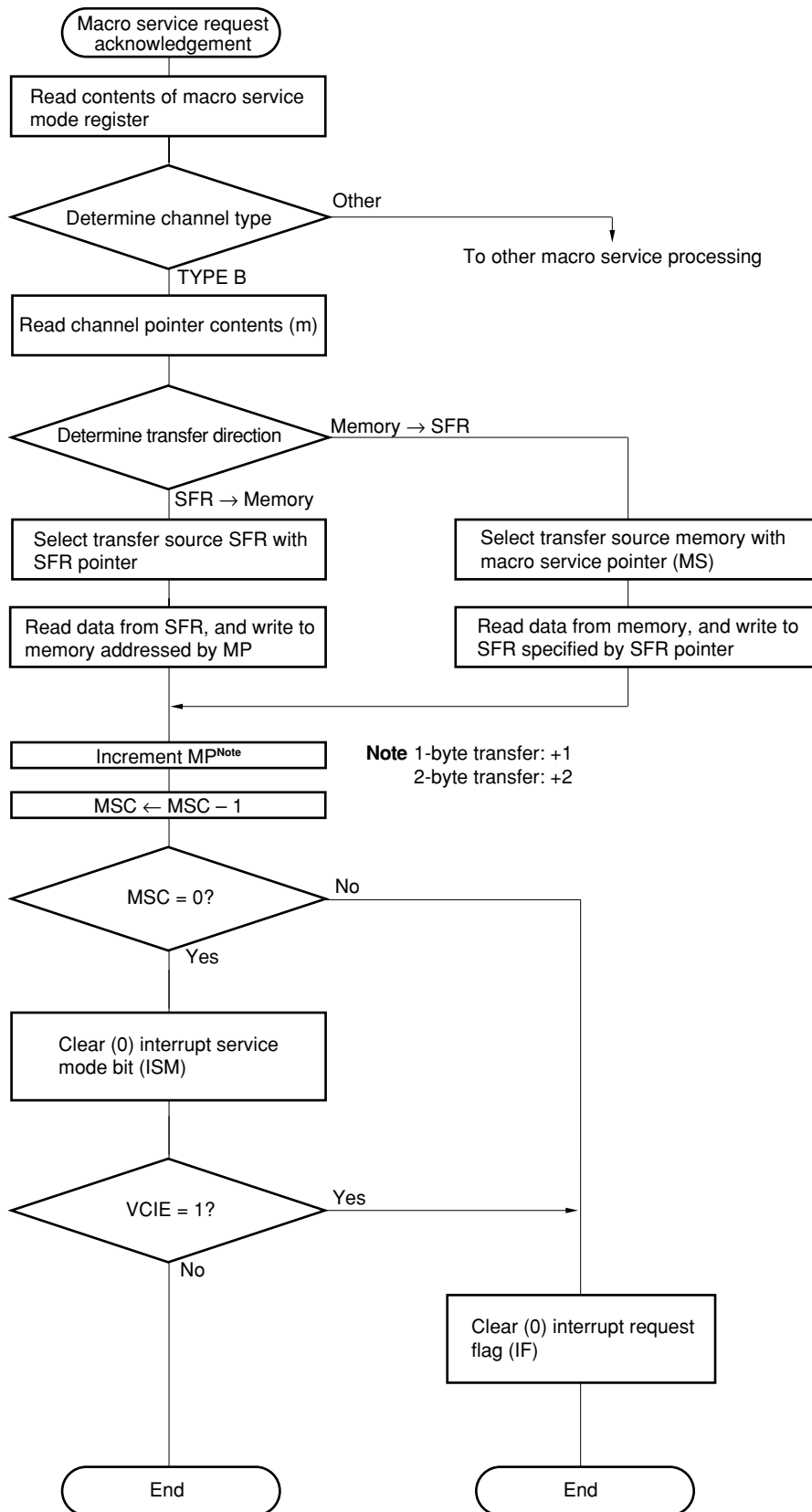
(1) Operation

Data transfers are performed between a data area in memory and an SFR specified by the macro service channel. With type B, the data transfer direction can be selected as memory-to-SFR or SFR-to-memory.

Data transfers are performed the number of times set beforehand in the macro service counter. One macro service processing transfers 8-bit or 16-bit data.

This type of macro service is macro service type A for general purposes and is ideal for processing a large amount of data because up to 64 KB when 8-bit data is transferred or up to 128 KB when 16-bit data is transferred can be set in any 1 MB address space as data buffer area.

Figure 23-26. Macro Service Data Transfer Processing Flow (Type B)



(Vectored interrupt request generation)

(2) Macro service channel configuration

The macro service pointer (MP) indicates the data buffer area in the 1 MB memory space that is the transfer destination or transfer source.

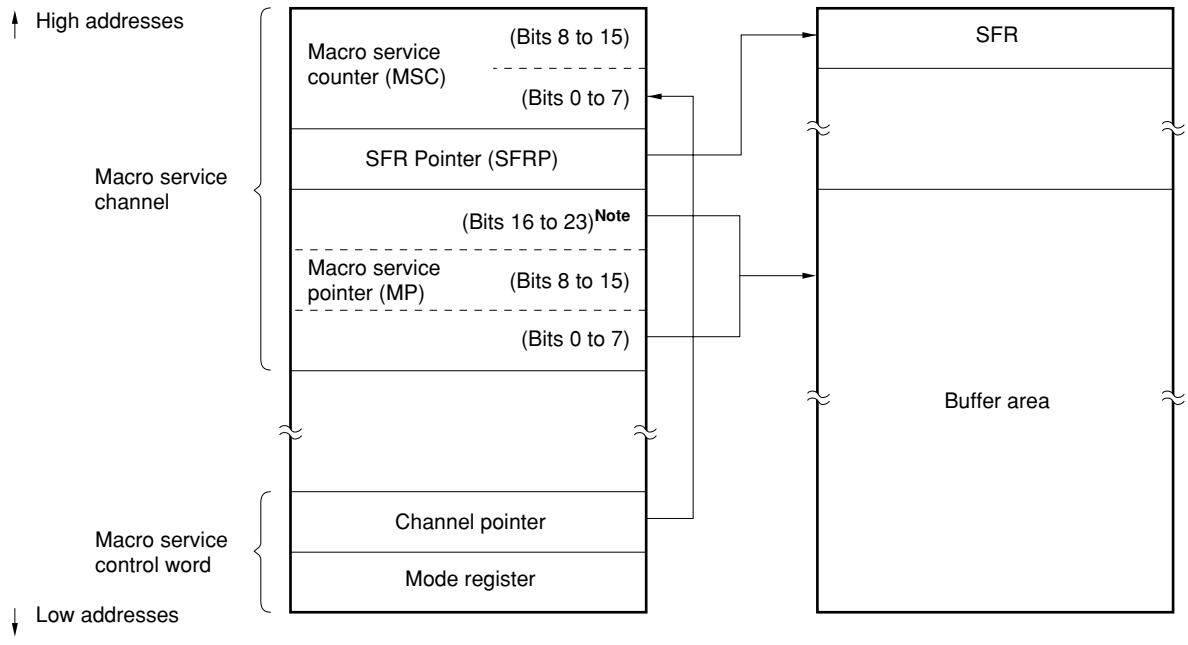
The lower 8 bits of the SFR that is the transfer destination or transfer source is written to the SFR pointer (SFRP).

The macro service counter (MSC) is a 16-bit counter that specifies the number of data transfers.

The macro service channel that stores the MP, SFRP and MSC is located in internal RAM space addresses 0FE00H to 0FEFFH when the LOCATION 0H instruction is executed, or 0FFE00H to 0FFEFFH when the LOCATION 0FH instruction is executed.

The macro service channel is indicated by the channel pointer as shown in Figure 23-27. In the channel pointer, the lower 8 bits of the address are written to the macro service counter in the macro service channel.

Figure 23-27. Type B Macro Service Channel



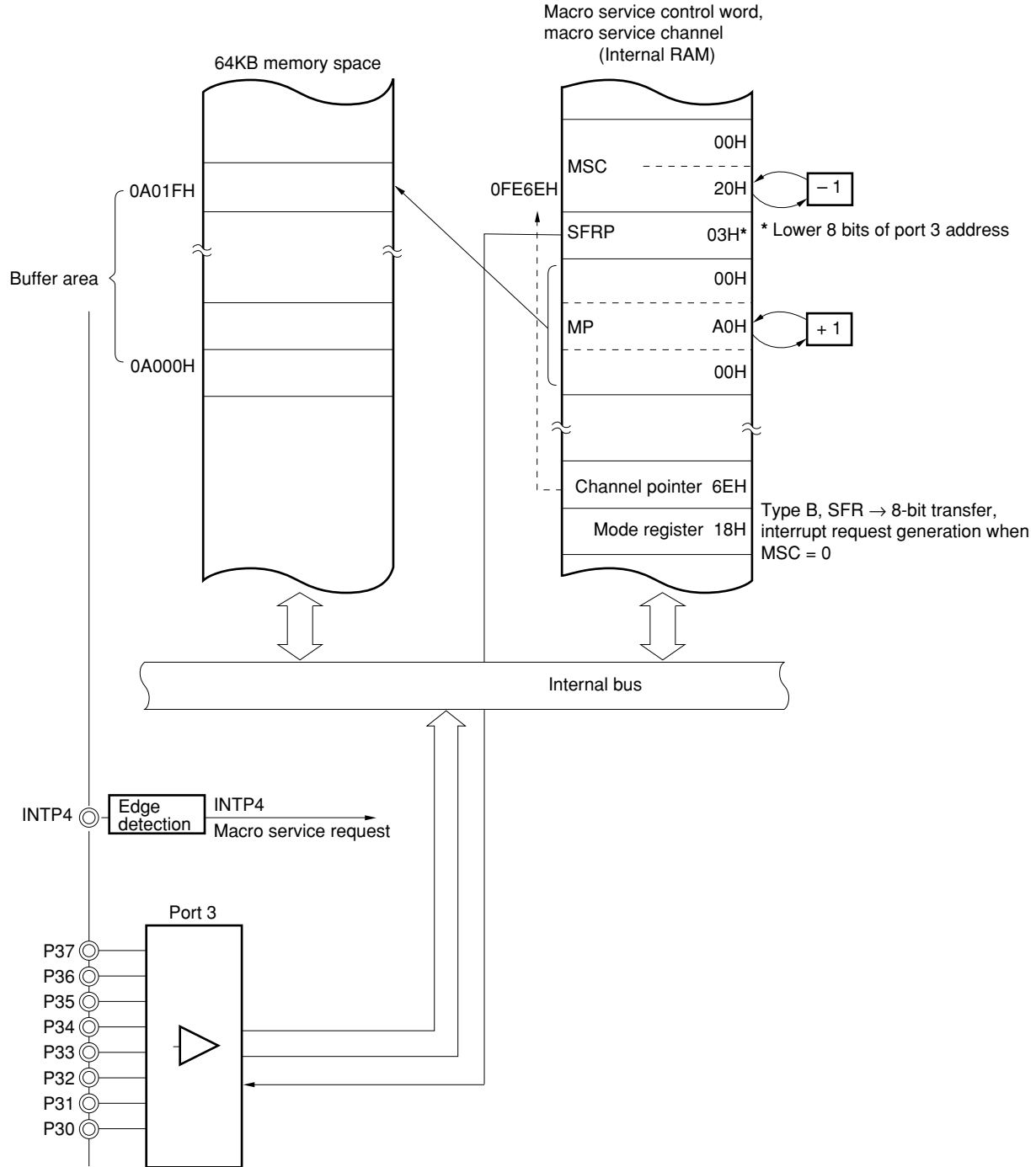
Macro service buffer address = macro service pointer

Note Bits 20 to 23 must be set to 0.

(3) Example of use of type B

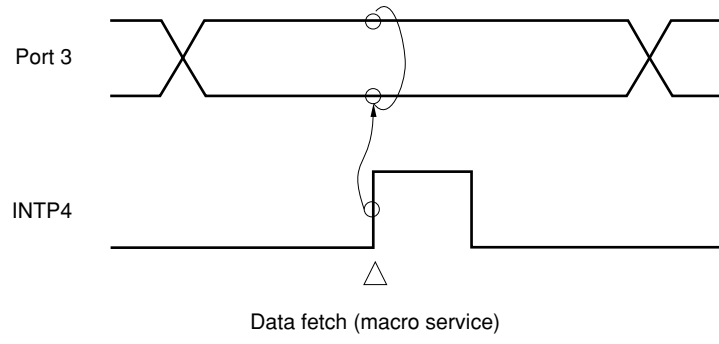
An example is shown below in which parallel data is input from port 3 in synchronization with an external signal. The INTP4 external interrupt pin is used for synchronization with the external signal.

Figure 23-28. Parallel Data Input Synchronized with External Interrupts



Remark Macro service channel addresses in the figure are the values when the LOCATION 0H instruction is executed. When the LOCATION 0FH instruction is executed, 0F0000H should be added to the values in the figure.

Figure 23-29. Parallel Data Input Timing



23.8.8 Macro service type C

(1) Operation

In type C macro service, data in the memory specified by the macro service channel is transferred to two SFRs, for timer use and data use, specified by the macro service channel in response to a single interrupt request (the SFRs can be freely selected). An 8-bit or 16-bit timer SFR can be selected.

In addition to the basic data transfers described above, type C macro service, the following functions can be added to type C macro service to reduce the size of the buffer area and alleviate the burden on software.

These specifications are made by using the mode register of the macro service control word.

(a) Updating of timer macro service pointer

It is possible to choose whether the timer macro service pointer (MPT) is to be kept as it is or incremented/decremented. The MPT is incremented or decremented in the same direction as the data macro service pointer (MPD).

(b) Updating of data macro service pointer

It is possible to choose whether the data macro service pointer (MPD) is to be incremented or decremented.

(c) Automatic addition

The current compare register value is added to the data addressed by the timer macro service pointer (MPT), and the result is transferred to the compare register. If automatic addition is not specified, the data addressed by the MPT is simply transferred to the compare register.

(d) Ring control

An output data pattern of the length specified beforehand is automatically output repeatedly.

Figure 23-30. Macro Service Data Transfer Processing Flow (Type C) (1/2)

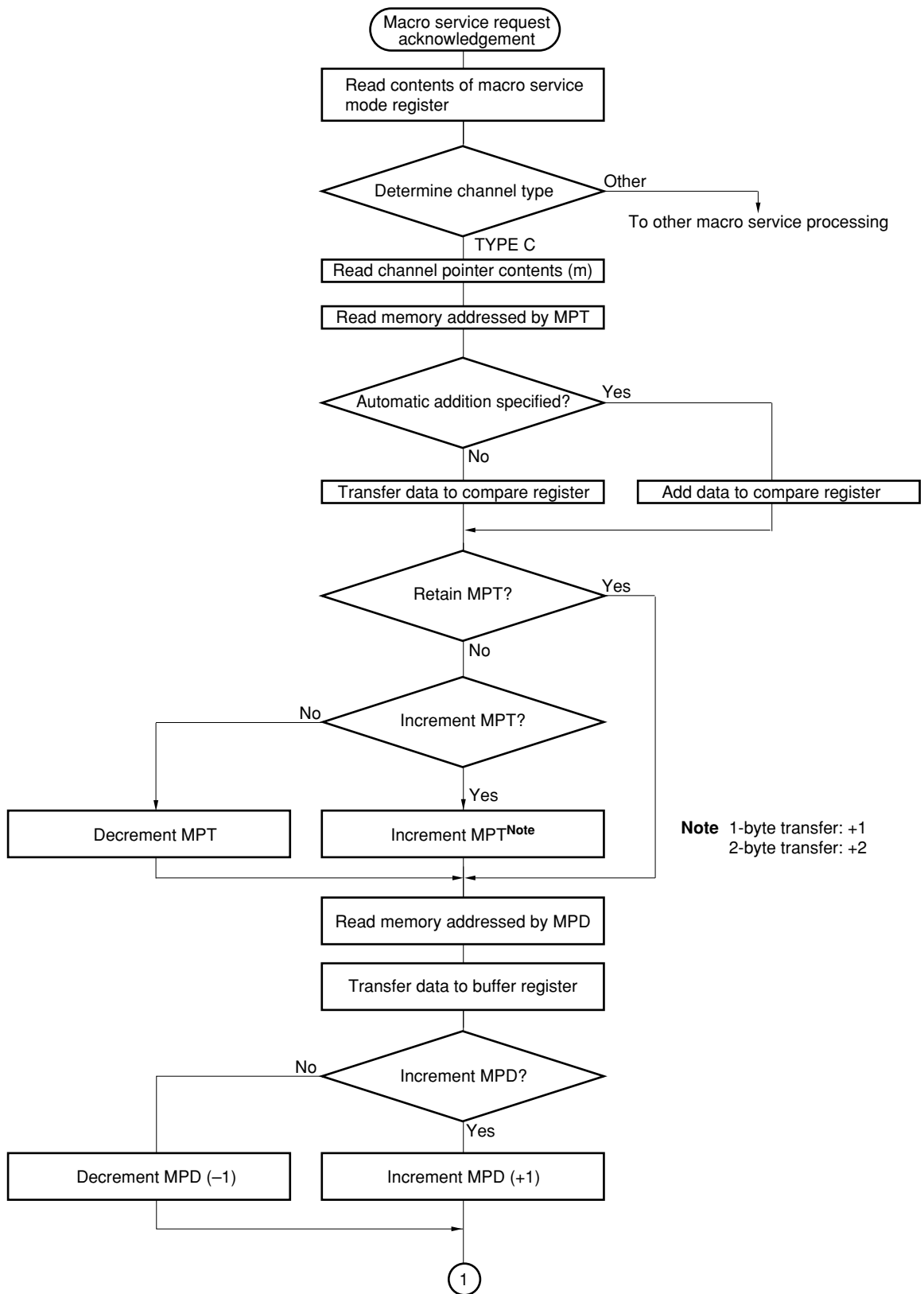
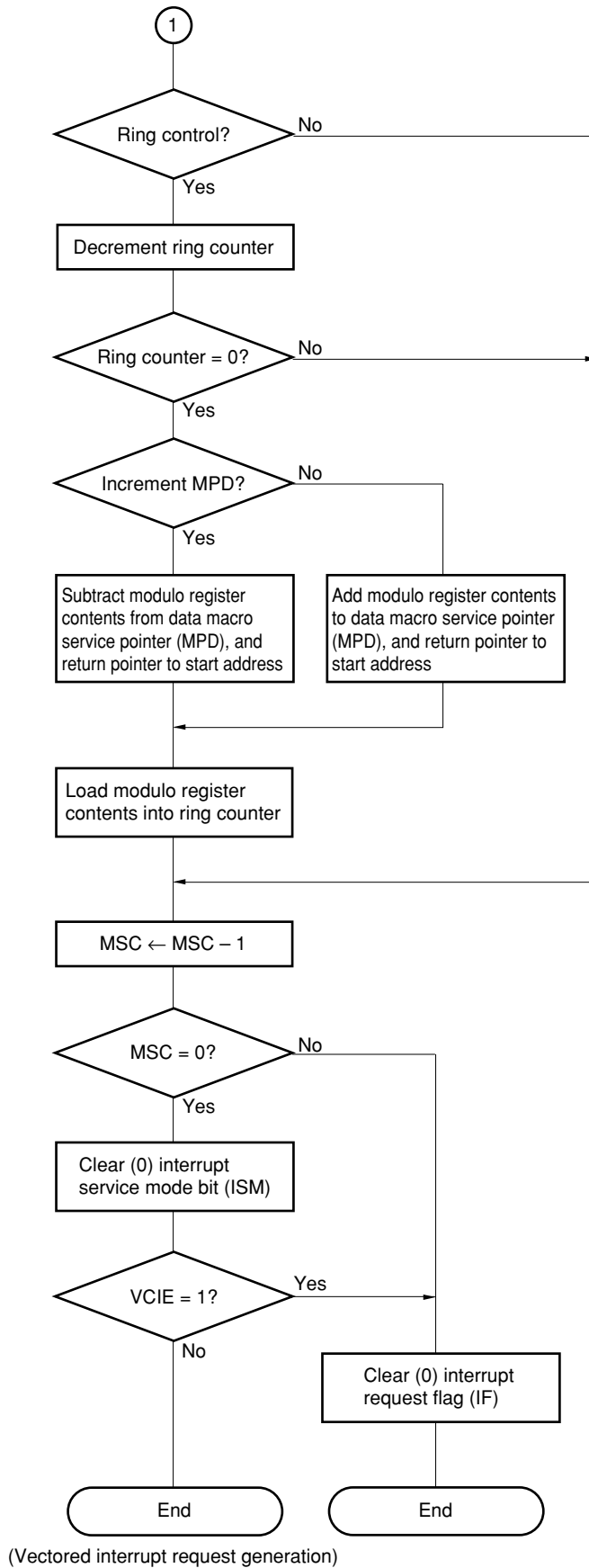


Figure 23-30. Macro Service Data Transfer Processing Flow (Type C) (2/2)



(2) Macro service channel configuration

There are two kinds of type C macro service channel, as shown in Figure 23-31.

The timer macro service pointer (MPT) mainly indicates the data buffer area in the 1 MB memory space to be transferred or added to the timer/counter compare register.

The data macro service pointer (MPD) indicates the data buffer area in the 1 MB memory space to be transferred to the real-time output port.

The modulo register (MR) specifies the number of repeat patterns when ring control is used.

The ring counter (RC) holds the step in the pattern when ring control is used. When initialization is performed, the same value as in the MR is normally set in this counter.

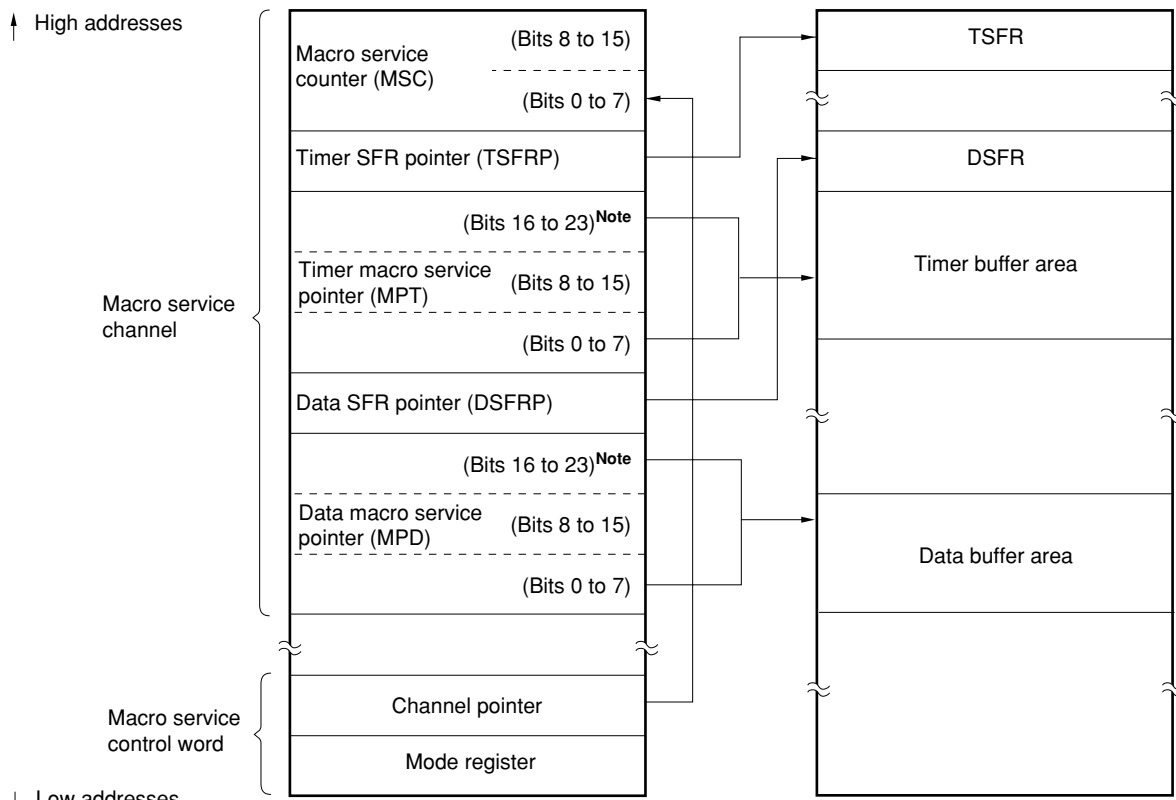
The macro service counter (MSC) is a 16-bit counter that specifies the number of data transfers.

The low-order 8 bits of the SFR that is the transfer destination is written to the timer SFR pointer (TSFRP) and data SFR pointer (DSFRP).

The macro service channel that stores these pointers and counters is located in internal RAM space addresses 0FE00H to 0FEFFH when the LOCATION 0H instruction is executed, or 0FFE00H to 0FFEFFH when the LOCATION 0FH instruction is executed. The macro service channel is indicated by the channel pointer as shown in Figure 23-31. In the channel pointer, the lower 8 bits of the address are written to the macro service counter in the macro service channel.

Figure 23-31. Type C Macro Service Channel (1/2)

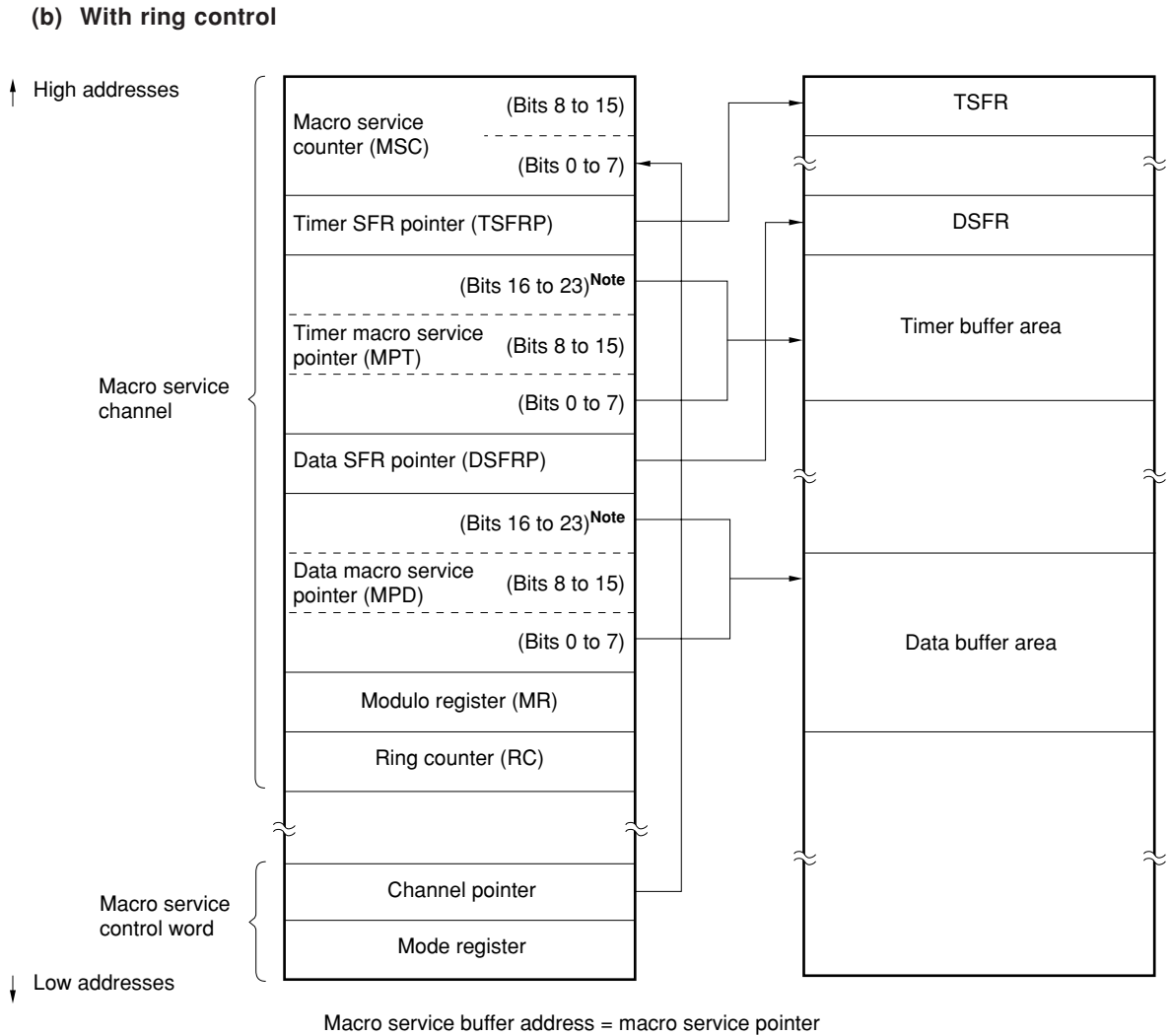
(a) No ring control



Macro service buffer address = macro service pointer

Note Bits 20 to 23 must be set to 0.

Figure 23-31. Type C Macro Service Channel (2/2)



Note Bits 20 to 23 must be set to 0.

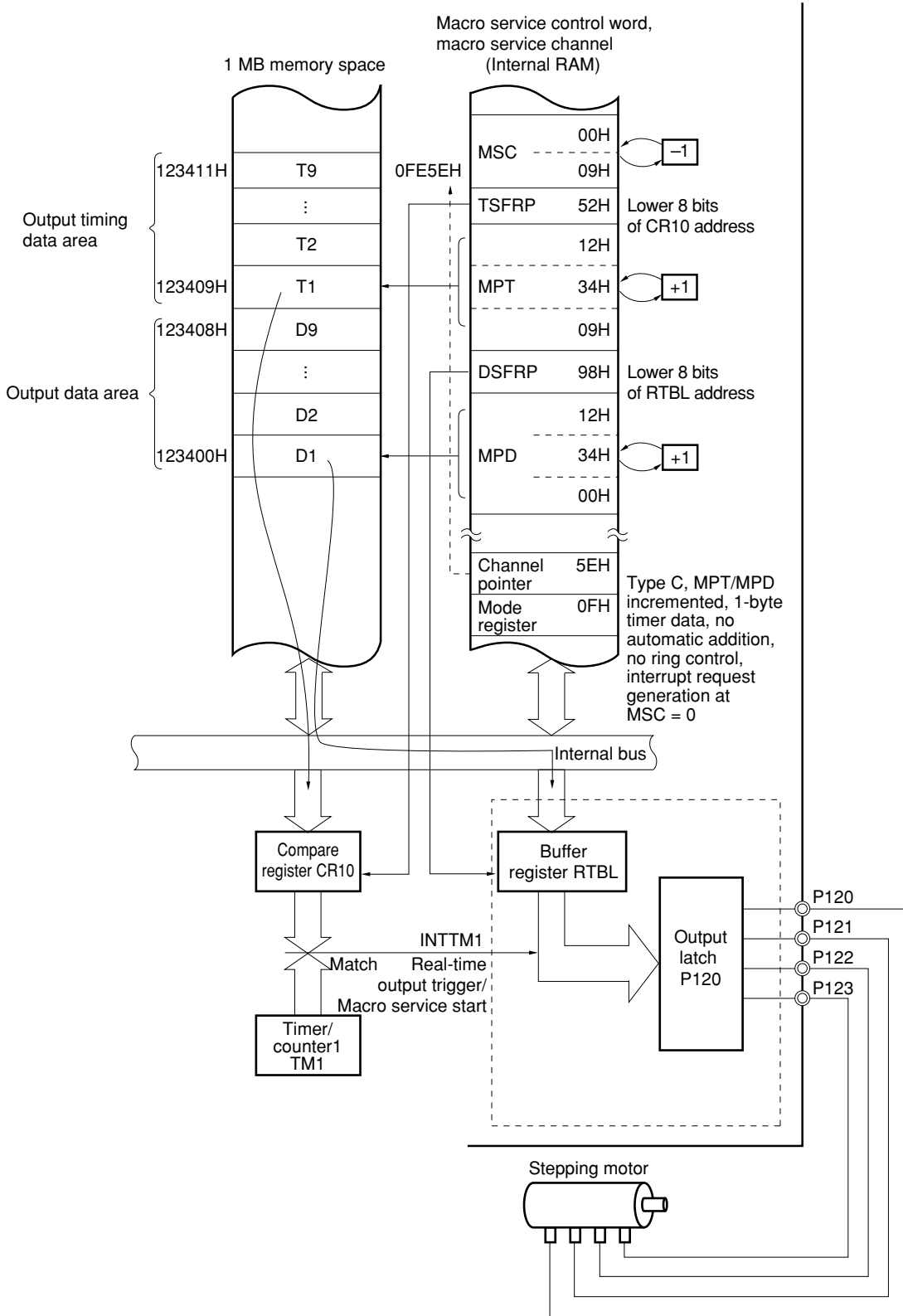
(3) Examples of use of type C

(a) Basic operation

An example is shown below in which the output pattern to the real-time output port and the output interval are directly controlled.

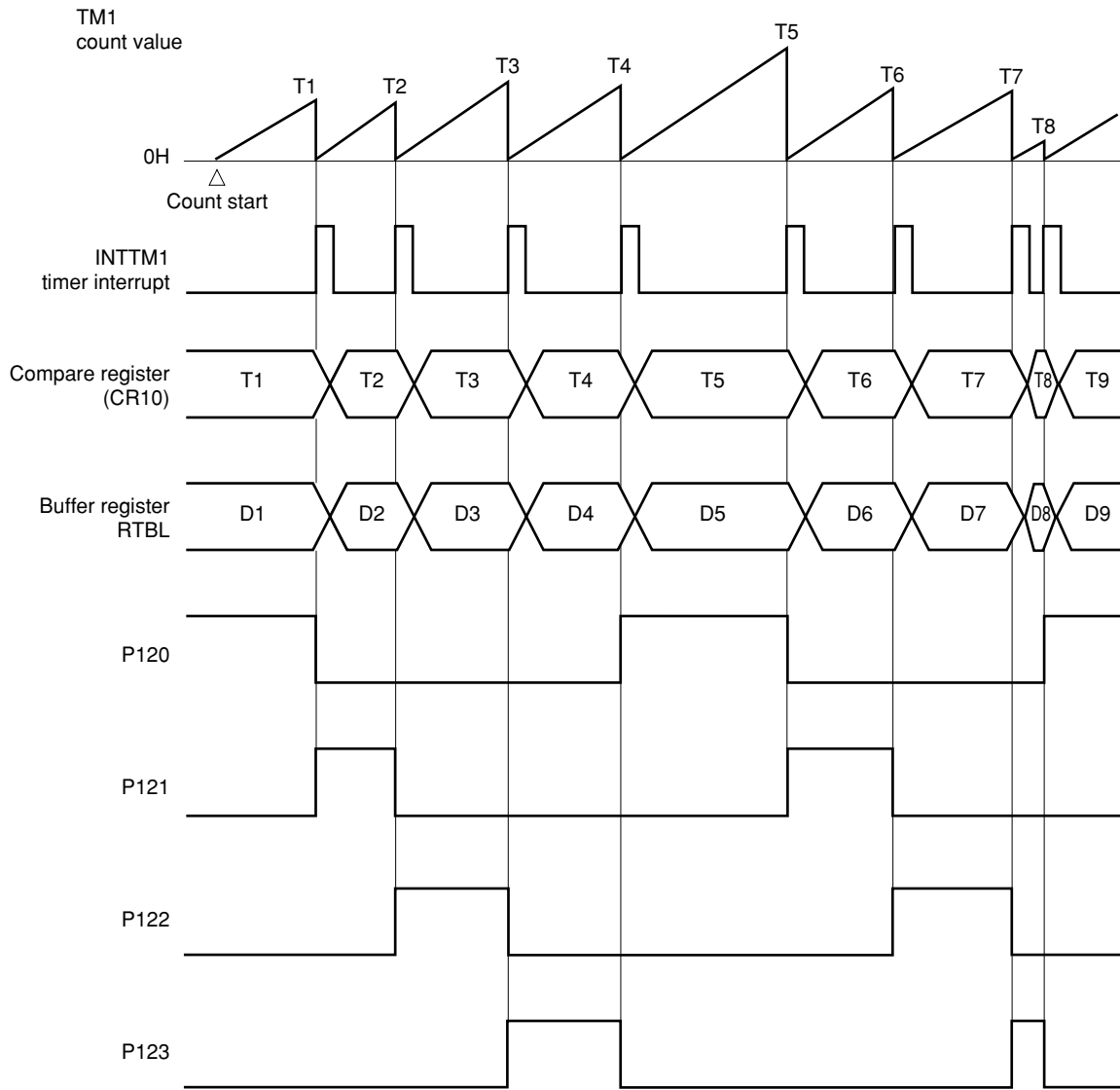
Update data is transferred from the two data storage areas set in the 1 MB space beforehand to the real-time output function buffer register (RTBL) and the compare register (CR10).

Figure 23-32. Stepping Motor Open Loop Control by Real-Time Output Port



Remark Internal RAM addresses in the figure are the values when the LOCATION 0H instruction is executed. When the LOCATION 0FH instruction is executed, 0F0000H should be added to the values in the figure.

Figure 23-33. Data Transfer Control Timing



(b) Examples of use of automatic addition control and ring control**(i) Automatic addition control**

The output timing data (Δt) specified by the macro service pointer (MPT) is added to the contents of the compare register, and the result is written back to the compare register.

Use of this automatic addition control eliminates the need to calculate the compare register setting value in the program each time.

(ii) Ring control

With ring control, the predetermined output patterns is prepared for one cycle only, and the one-cycle data patterns are output repeatedly in order in ring form.

When ring control is used, only the output patterns for one cycle need be prepared, allowing the size of the data ROM area to be reduced.

The macro service counter (MSC) is decremented each time a data transfer is performed.

With ring control, too, an interrupt request is generated when $MSC = 0$.

When controlling a stepping motor, for example, the output patterns will vary depending on the configuration of the stepping motor concerned, and the phase excitation method (single-phase excitation, two-phase excitation, etc.), but repeat patterns are used in all cases. Examples of single-phase excitation and 1-2-phase excitation of a 4-phase stepping motor are shown in Figures 23-34 and 23-35.

Figure 23-34. Single-Phase Excitation of 4-Phase Stepping Motor

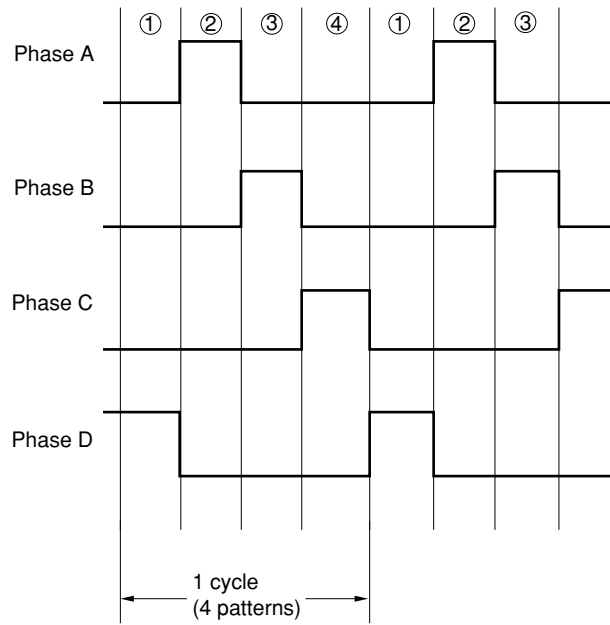


Figure 23-35. 1-2-Phase Excitation of 4-Phase Stepping Motor

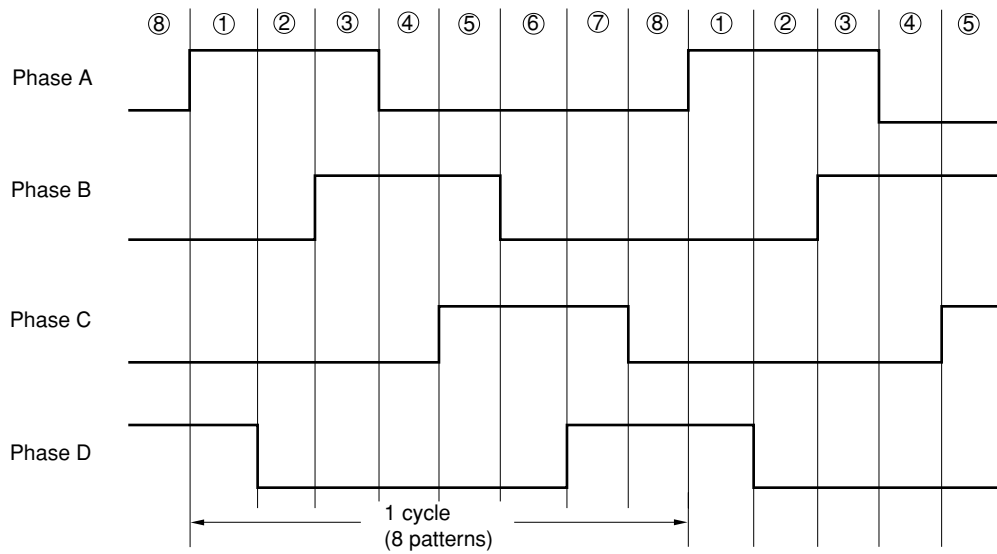
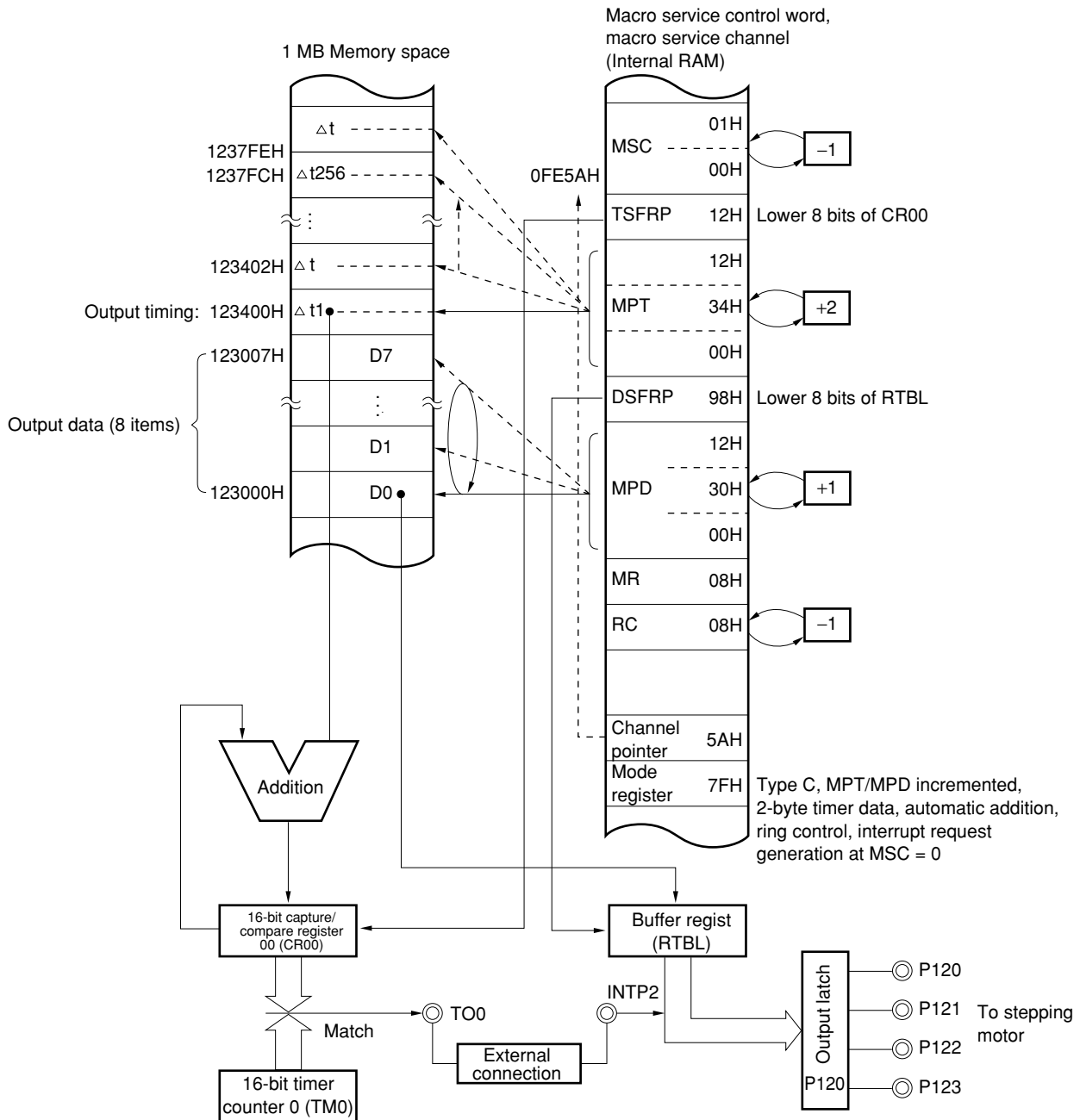
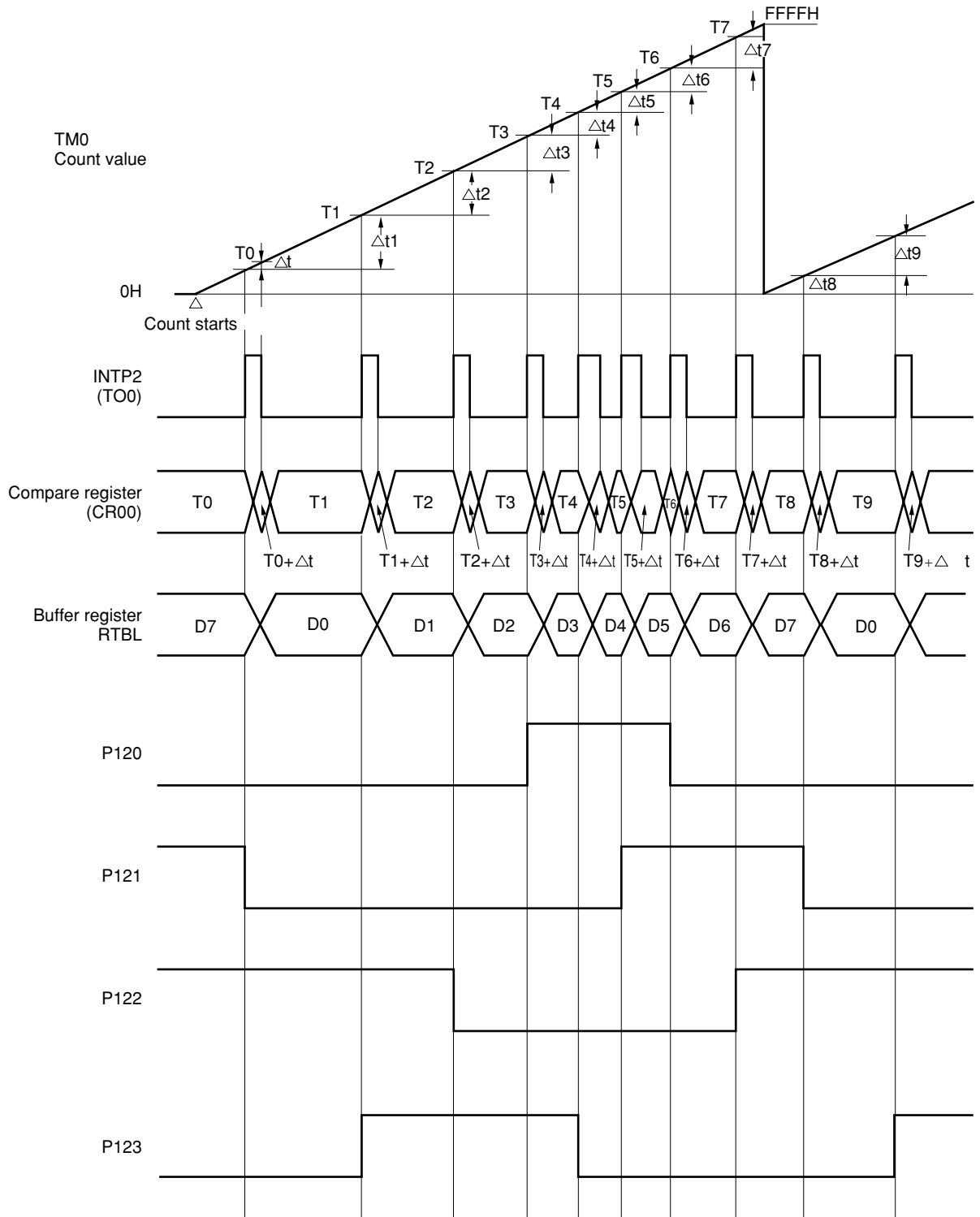


Figure 23-36. Automatic Addition Control + Ring Control Block Diagram 1
(When Output Timing Varies with 1-2-Phase Excitation)



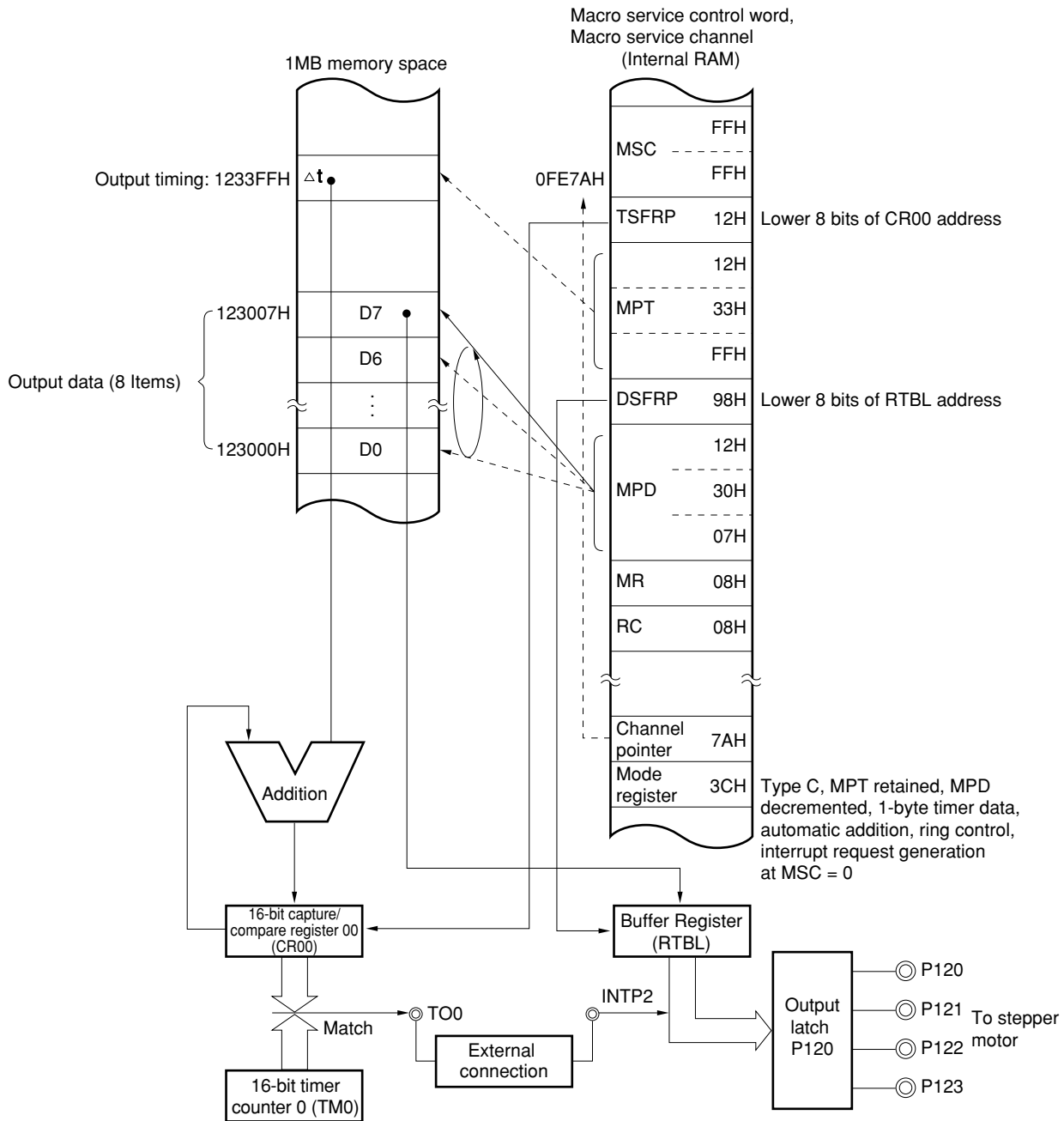
Remark Internal RAM addresses in the figure are the values when the LOCATION 0H instruction is executed. When the LOCATION 0FH instruction is executed, 0F0000H should be added to the values in the figure.

Figure 23-37. Automatic Addition Control + Ring Control Timing Diagram 1
(When Output Timing Varies with 1-2-Phase Excitation)



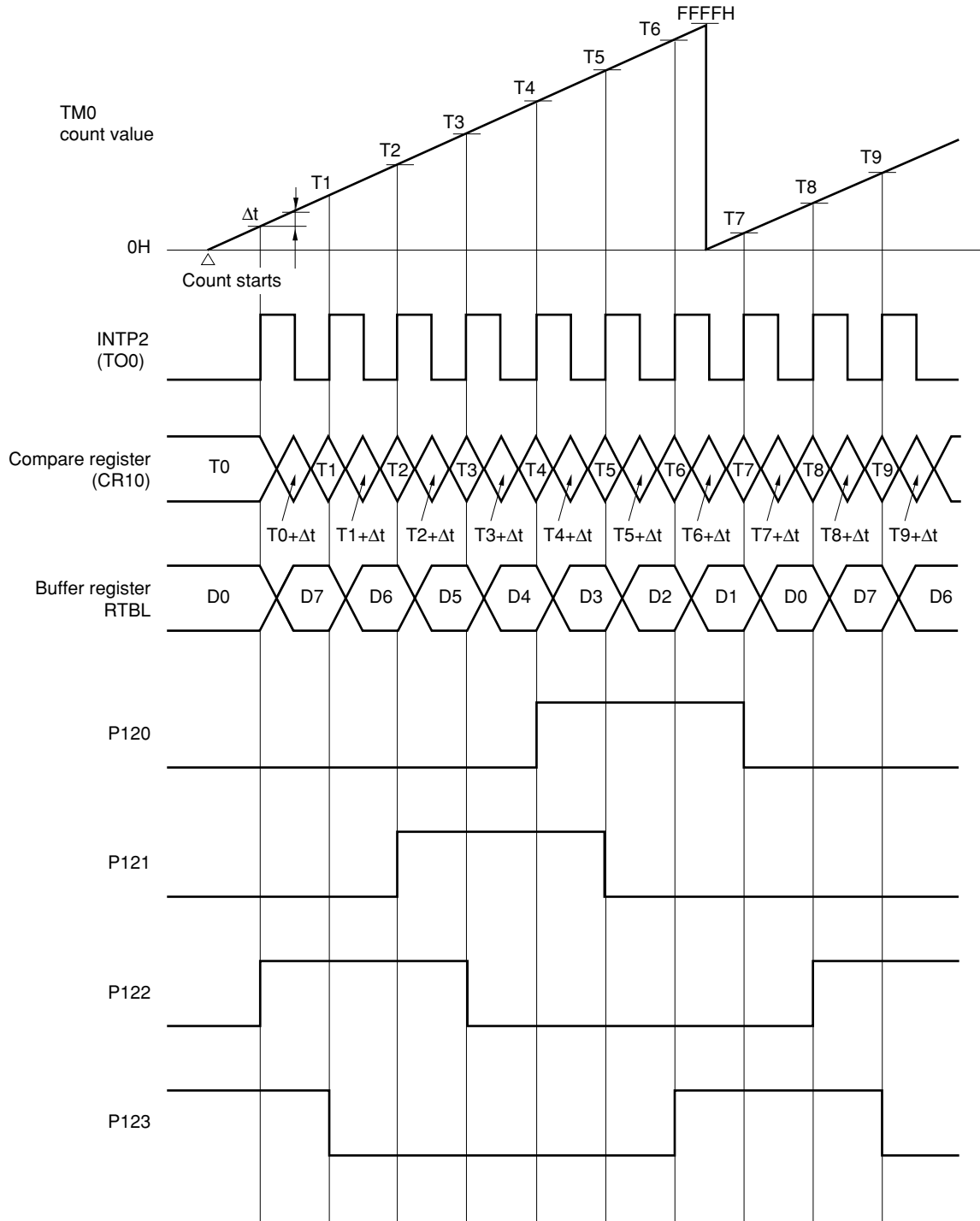
Note For the INTP2 high-/low-level width, refer to the data sheet.

Figure 23-38. Automatic Addition Control + Ring Control Block Diagram 2
(1-2-Phase Excitation Constant-Velocity Operation)



Remark Internal RAM addresses in the figure are the values when the LOCATION 0H instruction is executed. When the LOCATION 0FH instruction is executed, 0F0000H should be added to the values in the figure.

Figure 23-39. Automatic Addition Control + Ring Control Timing Diagram 2
(1-2-Phase Excitation Constant-Velocity Operation)



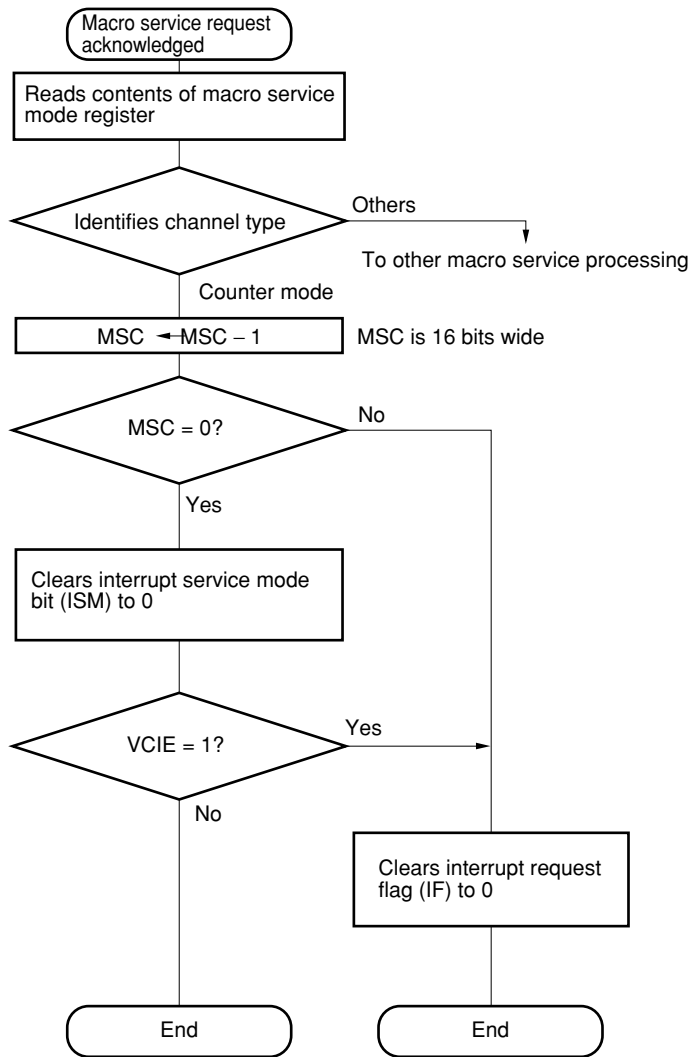
Note For the INTP2 high-/low-level width, refer to the data sheet.

23.8.9 Counter mode

(1) Operation

MSC is decremented the number of times set in advance to the macro service counter (MSC).
 Because the number of times an interrupt occurs can be counted, this function can be used as an event counter where the interrupt generation cycle is long.

Figure 23-40. Macro Service Data Transfer Processing Flow (Counter Mode)

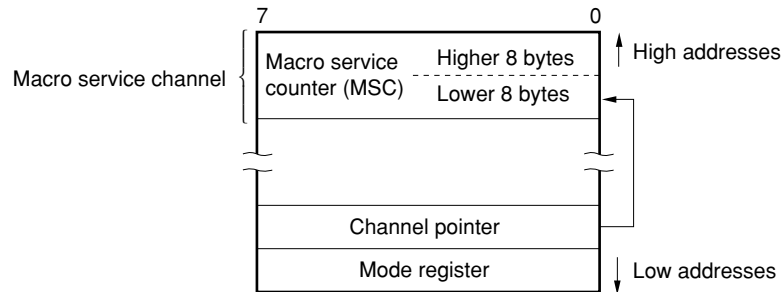


(Vectored interrupt request is generated)

(2) Configuration of macro service channel

The macro service channel consists of only a 16-bit macro service counter (MSC). The lower 8 bits of the address of the MSC are written to the channel pointer.

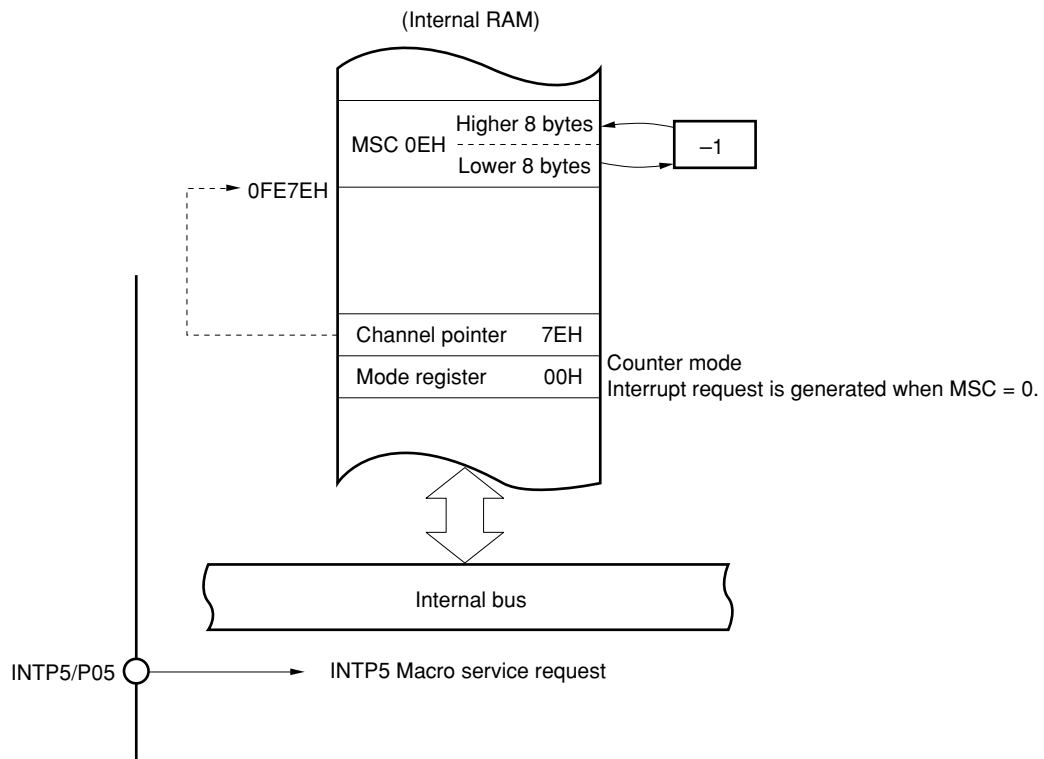
Figure 23-41. Counter Mode



(3) Example of using counter mode

Here is an example of counting the number of edges input to external interrupt pin INTP5.

Figure 23-42. Counting Number of Edges



Remark The internal RAM addresses in the figure above are the values when the LOCATION 0H instruction is executed. When the LOCATION 0FH instruction is executed, 0F0000H should be added to the values in the figure.

23.9 When Interrupt Requests and Macro Service Are Temporarily Held Pending

When the following instructions are executed, interrupt acknowledgement and macro service processing are temporarily held pending for 8 system clock cycles. However, software interrupts are not held pending.

EI
 DI
 BRK
 BRKCS
 RETCS
 RETCSB !addr16
 RETI
 RETB
 LOCATION 0H or LOCATION 0FH

POP PSW

POPU post

MOV PSWL, A

MOV PSWL, #byte

MOVG SP, #imm24

Write instruction and bit manipulation instruction (excluding BT and BF) to interrupt control registers^{Note}, MK0, MK1, IMC, ISPR, and SNMI

PSW bit manipulation instruction

(Excluding the BT PSWL.bit, \$addr20 instruction, BF PSWL.bit, \$addr20 instruction, BT PSWH.bit, \$addr20 instruction, BF PSWH.bit, \$addr20 instruction, SET1 CY instruction, NOT1 CY instruction, and CLR1 CY instruction)

Note Interrupt control registers: WDTIC, PIC0, PIC1, PIC2, PIC3, PIC4, PIC5, PIC6, CSIIC0, SERIC1, SRIC1, STIC1, SERIC2, SRIC2, STIC2, TMIC3, TMIC00, TMIC01, TMIC1, TMIC2, ADIC, TMIC5, TMIC6, TMIC7, TMIC8, WTIC, KRIC

Caution If problems are caused by a long pending period for interrupts and macro servicing when the corresponding instructions are used in succession, a time during which interrupts and macro service requests can be acknowledged should be provided by inserting an NOP instruction, etc., in the series of instructions.

23.10 Instructions Whose Execution Is Temporarily Suspended by Interrupt or Macro Service

Execution of the following instructions is temporarily suspended by an acknowledgeable interrupt request or macro service request, and the interrupt or macro service request is acknowledged. The suspended instruction is resumed after completion of the interrupt service program or macro service processing.

Temporarily suspended instructions:

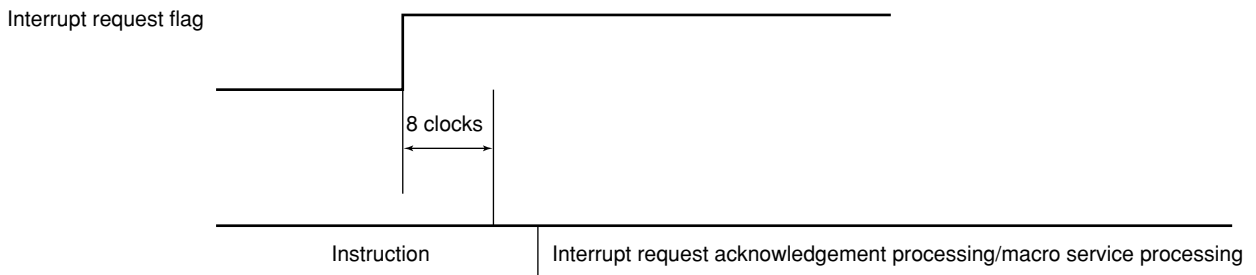
MOVM, XCHM, MOVBK, XCHBK
 CMPME, CMPMNE, CMPMC, CMPMNC
 CMPBKE, CMPBKNE, CMPBKC, CMPBKNC
 SACW

23.11 Interrupt and Macro Service Operation Timing

Interrupt requests are generated by hardware. The generated interrupt request sets (1) an interrupt request flag. When the interrupt request flag is set (1), a time of 8 clocks ($0.64 \mu\text{s}$: $f_{\text{xx}} = 12.5 \text{ MHz}$) is taken to determine the priority, etc.

Following this, if acknowledgement of that interrupt or macro service is enabled, interrupt request acknowledgement processing is performed when the instruction being executed ends. If the instruction being executed is one which temporarily holds interrupts and macro service, the interrupt request is acknowledged after the following instruction (refer to **23.9 When Interrupt Requests and Macro Service Are Temporarily Held Pending** for pending instructions).

Figure 23-43. Interrupt Request Generation and Acknowledgement (Unit: Clock = $1/f_{\text{CLK}}$)



23.11.1 Interrupt acknowledge processing time

The time shown in Table 23-7 is required to acknowledge an interrupt request. After the time shown in this table has elapsed, execution of the interrupt processing program is started.

Table 23-7. Interrupt Acknowledge Processing Time

(Unit: Clock = 1/f_{CLK})

Vector Table	IROM						EMEM					
	IROM, PRAM			EMEM			PRAM			EMEM		
Stack	IRAM	PRAM	EMEM	IRAM	PRAM	EMEM	IRAM	PRAM	EMEM	IRAM	PRAM	EMEM
Vectored Interrupts	26	29	37 + 4n	27	30	38 + 4n	30	33	41 + 4n	31	34	42 + 4n
Context Switching	22	–	–	23	–	–	22	–	–	23	–	–

- Remarks**
1. IROM: Internal ROM (with high-speed fetch specified)
 PRAM: Peripheral RAM of internal RAM (only when LOCATION 0H instruction is executed in the case of branch destination)
 IRAM: Internal high-speed RAM
 EMEM: Internal ROM when external memory and high-speed fetch are not specified
 2. n is the number of wait states per byte necessary for writing data to the stack (the number of wait states is the sum of the number of address wait states and the number of access wait states).
 3. If the vector table is EMEM, and if wait states are inserted in reading the vector table, add 2 m to the value of the vectored interrupt in the above table, and add m to the value of context switching, where m is the number of wait states per byte necessary for reading the vector table.
 4. If the branch destination is EMEM and if wait states are inserted in reading the instruction at the branch destination, add that number of wait states.
 5. If the stack is occupied by PRAM and if the value of the stack pointer (SP) is odd, add 4 to the value in the above table.
 6. The number of wait states is the sum of the number of address wait states and the number of access wait states.

23.11.2 Processing time of macro service

Macro service processing time differs depending on the type of the macro service, as shown in Table 23-8.

Table 23-8. Macro Service Processing Time(Units: Clock = $1/f_{CLK}$)

Processing Type of Macro Service			Data Area	
			IRAM	Others
Type A	SFR → memory	1 byte	24	–
		2 bytes	25	–
	Memory → SFR	1 byte	24	–
		2 bytes	26	–
Type B	SFR → memory		33	35
	Memory → SFR		34	36
Type C			49	53
Counter mode	MSC ≠ 0		17	–
	USC = 0		25	–

Remarks 1. IRAM: Internal high-speed RAM

2. In the following cases in the other data areas, add the number of clocks specified below.
 - If the data size is 2 bytes with IROM or PRAM, and the data is located at an odd address: 4 clocks
 - If the data size is 1 byte with EMEM: number of wait states for data access
 - If the data size is 2 bytes with EMEM: $4 + 2n$ (where n is the number of wait states per byte)
3. If MSC = 0 with type A, B, or C, add 1 clock.
4. With type C, add the following value depending on the function to be used and the status at that time.
 - Ring control: 4 clocks. Adds 7 more clocks if the ring counter is 0 during ring control.

23.12 Restoring Interrupt Function to Initial State

If an inadvertent program loop or system error is detected by means of an operand error interrupt, the watchdog timer, NMI pin input, etc., the entire system must be restored to its initial state. In the μ PD784218A, interrupt acknowledgement related priority control is performed by hardware. This interrupt acknowledgement related hardware must also be restored to its initial state, otherwise subsequent interrupt acknowledgement control may not be performed normally.

A method of initializing interrupt acknowledgement related hardware in the program is shown below. The only way of performing initialization by hardware is by $\overline{\text{RESET}}$ input.

```

Example      MOVW  MK0, #0FFFFH   ; Mask all maskable interrupts
                MOV   MK1L, #0FFH
IRESL :
                CMP   ISPR, #0       ; No interrupt service programs running?
                BZ    $NEXT
                MOVG  SP, #RETVL     ; Forcibly change SP location
                RETI                    ; Forcibly terminate running interrupt service program, return
                                        address = IRESL
RETVL :
                DW   LOWW (IRESL)    ; Stack data to return to IRESL with RETI instruction
                DB   0
                DB   HIGHW (IRESL)   ; LOWW and HIGHW are assembler operators for calculating
                                        lower 16 bits and higher 16 bits respectively of symbol
NEXT :


- It is necessary to ensure that a non-maskable interrupt request is not generated via the NMI pin during execution of this program.
- After this, on-chip peripheral hardware initialization and interrupt control register initialization are performed.
- When interrupt control register initialization is performed, the interrupt request flags must be cleared (0).

```

23.13 Cautions

- (1) The in-service priority register (ISPR) is read-only. Writing to this register may result in misoperation.
- (2) The watchdog timer mode register (WDM) can only be written to with a dedicated instruction (MOV WDM, #byte).
- (3) The RETI instruction must not be used to return from a software interrupt caused by a BRK instruction. Use the RETB instruction.
- (4) The RETCS instruction must not be used to return from a software interrupt caused by a BRKCS instruction. Use the RETCSB instruction.
- (5) When a maskable interrupt is acknowledged by vectored interruption, the RETI instruction must be used to return from the interrupt. Subsequent interrupt related operations will not be performed normally if a different instruction is used.
- (6) The RETCS instruction must be used to return from a context switching interrupt. Subsequent interrupt related operations will not be performed normally if a different instruction is used.
- (7) Macro service requests are acknowledged and serviced even during execution of a non-maskable interrupt service program. If you do not want macro service processing to be performed during a non-maskable interrupt service program, you should manipulate the interrupt mask register in the non-maskable interrupt service program to prevent macro service generation.
- (8) The RETI instruction must be used to return from a non-maskable interrupt. Subsequent interrupt acknowledgement will not be performed normally if a different instruction is used. If you restart a program from the initial state after a non-maskable interrupt acknowledgement, refer to **23.12 Restoring Interrupt Function to Initial State**.
- (9) Non-maskable interrupts are always acknowledged, except during non-maskable interrupt service program execution (except when a high non-maskable interrupt request is generated during execution of a low-priority non-maskable interrupt service program) and for a certain period after execution of the special instructions shown in **23.9**. Therefore, a non-maskable interrupt will be acknowledged even when the stack pointer (SP) value is undefined, in particular after reset release, etc. In this case, depending on the value of the SP, it may happen that the program counter (PC) and program status word (PSW) are written to the address of a write-inhibited special function register (SFR) (refer to **Table 3-6** in **3.9 Special Function Registers (SFRs)**), and the CPU becomes deadlocked, or an unexpected signal output from a pin, or PC and PSW are written to an address in which RAM is not mounted, with the result that the return from the non-maskable interrupt service program is not performed normally and a runaway occurs.

Therefore, the program following $\overline{\text{RESET}}$ release must be as follows.

```

CSEG AT 0
DW STRT
CSEG BASE
STRT:
LOCATION 0FH; or LOCATION 0
MOVG SP, #imm24

```

- (10) When the following instructions are executed, interrupt acknowledgement and macro service processing are held pending for 8 system clocks. However, software interrupts are not held pending.

EI
 DI
 BRK
 BRKCS
 RETCS
 RETCSB !addr16
 RETI
 RETB
 LOCATION 0H or LOCATION 0FH
 POP PSW
 POPU post
 MOV PSWL, A
 MOV PSWL, #byte
 MOVG SP, #imm24

Write instruction and bit manipulation instruction to interrupt control registers^{Note}, MK0, MK1, IMC, ISPR, or SNM1 register (excluding BT, BF instructions)

PSW bit manipulation instructions (excluding BT PSWL.bit, \$addr20 instruction, BF PSWL.bit, \$addr20 instruction, BT PSWH.bit, \$addr20 instruction, BF PSWH.bit, \$addr20 instruction, SET1 CY instruction, NOT1 CY instruction, CLR1 CY instruction)

Note Interrupt control registers: WDTIC, PIC0, PIC1, PIC2, PIC3, PIC4, PIC5, PIC6, CSIC0, SERIC1, SRIC1, STIC1, SERIC2, SRIC2, STIC2, TMIC3, TMIC00, TMIC01, TMIC1, TMIC2, ADIC, TMIC5, TMIC6, TMIC7, TMIC8, WTIC, KRIC

Caution If problems are caused by a long pending period for interrupts and macro servicing when the corresponding instructions are used in succession, a time at which interrupts and macro service requests can be acknowledged should be provided by inserting an NOP instruction, etc., in the series of instructions.

CHAPTER 24 LOCAL BUS INTERFACE FUNCTIONS

24.1 External Memory Expansion Function

The external memory expansion function connects external memory to the areas other than the internal ROM, RAM, and SFR.

The external memory expansion function has the following two modes.

- Multiplexed bus mode
- Separate bus mode

(1) Multiplexed bus mode

A time-divided address/data bus is used to connect external memory. When external memory is connected, the number of ports used can be reduced.

When external memory is connected, ports 4 to 6 are used. Ports 4 to 6 control the address/data, read/write strobe, wait signal, and address strobe.

Table 24-1. Pin Functions in Multiplexed Bus Mode

Pin Functions in Multiplexed Bus Mode		Alternate Functions
Name	Function	
AD0 to AD7	Multiplexed address/data bus	P40 to P47
A8 to A15	Middle address bus	P50 to P57
A16 to A19	High address bus	P60 to P63
\overline{RD}	Read strobe	P64
\overline{WR}	Write strobe	P65
\overline{WAIT}	Wait signal	P66
ASTB	Address strobe	P67

Table 24-2. Pin States in Ports 4 to 6 in Multiplexed Bus Mode

Port	Port 4	Port 5							Port 6								
External Expansion Mode	0 to 7	0	1	2	3	4	5	6	7	0	1	2	3	4	5	6	7
Single-chip mode	Port	Port							Port								
256 KB expansion mode	Address/data	Address							Address	Port	\overline{RD} , \overline{WR} , \overline{WAIT} , ASTB						
1 MB expansion mode	Address/data	Address							Address			\overline{RD} , \overline{WR} , \overline{WAIT} , ASTB					

Caution When the external wait function is not used, the \overline{WAIT} pin can be used as the port in all of the modes.

(2) Separate bus mode

An independent address bus and data bus are used to connect external memory. Since an external latch circuit is not used, this mode is useful in reducing the number of parts and the mounting area.

Ports 4, 5, 6, and 8 are used to connect to the external memory. Ports 4, 5, 6, and 8 control the address/data, read/write strobe, and wait signal.

Table 24-3. Pin Functions in Separate Bus Mode

Pin Functions in Separate Bus Mode		Alternate Functions
Name	Function	
AD0 to AD7	Data bus	P40 to P47
A0 to A7	Low address bus	P80 to P87
A8 to A15	Middle address bus	P50 to P57
A16 to A19	High address bus	P60 to P63
\overline{RD}	Read strobe	P64
\overline{WR}	Write strobe	P65
\overline{WAIT}	Wait signal	P66

Caution In the separate bus mode, the address strobe does not have to be used. However, the address strobe is output from pin ASTB/P67. See Figures 24-10 to 24-13 for the output timing.

Table 24-4. Pin States of Ports 4, 5, 6, and 8 in Separate Bus Mode

Port	Port 4	Port 8	Port 5	Port 6
External Expansion Mode	0 to 7	0 1 2 3 4 5 6 7	0 1 2 3 4 5 6 7	0 1 2 3 4 5 6 7
Single-chip mode	Port	Port	Port	Port
256 KB expansion mode	Data	Address	Address	Address Port \overline{RD} , \overline{WR} , \overline{WAIT} , (ASTB)
1 MB expansion mode	Data	Address	Address	Address \overline{RD} , \overline{WR} , \overline{WAIT} , (ASTB)

- Cautions**
1. When the external wait function is not used, the \overline{WAIT} pin can be used as a port in all of the modes.
 2. In the separate bus mode, the address strobe does not have to be used. However, the address strobe is output from the pin ASTB/P67. See Figures 24-10 to 24-13 for the output timing.

24.2 Control Registers

(1) Memory expansion mode register (MM)

MM is an 8-bit register that controls the external expanded memory, sets the number of address waits, and controls the internal fetch cycle.

MM can be read or written by a 1-bit or 8-bit memory manipulation instruction. Figure 24-1 shows the MM format. $\overline{\text{RESET}}$ input sets MM to 20H.

Figure 24-1. Memory Expansion Mode Register (MM) Format

Address: 0FFC4H After reset: 20H R/W

Symbol	7	6	5	4	3	2	1	0
MM	IFCH	0	AW	0	MM3	MM2	MM1	MM0

IFCH	Internal ROM fetch
0	Fetch at the same speed as from external memory. All of the wait control settings are valid.
1	High-speed fetch The wait control settings are invalid.

AW	Address wait setting
0	An address wait is not inserted.
1	A one-clock address wait is inserted in the address output timing.

MM3	MM2	MM1	MM0	Mode	Port 4 (P40 to P47)	Port 5 (P50 to P57)	P60 to P63	P64	P65	P66	
0	0	0	0	Single-chip mode	Port						
1	0	0	0	256 KB expansion mode	AD0 to AD7	A8 to A15	A16, A17	Port	$\overline{\text{RD}}$	$\overline{\text{WR}}$	ASTB
1	0	0	1	1 MB expansion mode			A16 to A19				
Other than above				Setting prohibited							

(2) External bus type selection register (EBTS)

EBTS is an 8-bit register that sets the operating mode of the external memory expansion function. When the multiplexed bus mode is selected, the P80/A0 to P87/A7 pins can be used as an I/O port.

EBTS is set by a 1-bit or 8-bit memory manipulation instruction.

RESET input sets EBTS to 00H.

Figure 24-2. External Bus Type Selection Register (EBTS) Format

Address: 0FF8CH After reset: 00H R/W

Symbol	7	6	5	4	3	2	1	0
EBTS	0	0	0	0	0	0	0	EBTS0

EBTS0	Selection of operating mode of external memory expansion function
0	Multiplexed bus mode
1	Separate bus mode

(3) Programmable wait control register (PWC1)

PWC1 is an 8-bit register that sets the number of waits.

The insertion of wait cycles is controlled by PWC1 over the entire space.

PWC1 can be read and written by a 1-bit or 8-bit manipulation instruction.

RESET input sets PWC1 to AAH.

Figure 24-3. Programmable Wait Control Register (PWC1) Format

Address: 0FFC7H After reset: AAH R/W

Symbol	7	6	5	4	3	2	1	0
PWC1	×	×	×	×	×	×	PW01	PW00

PW01	PW00	Insertion wait cycles	Data access cycles, fetch cycles
0	0	0	3
0	1	1	4
1	0	2	5
1	1	Low level period that is input at the WAIT pin	—

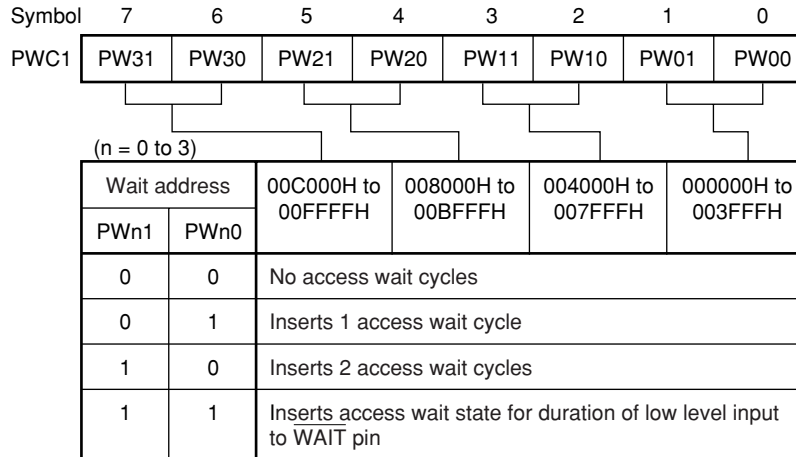
Remarks 1. The insertion of wait cycles is controlled by the entire address space (except for the peripheral RAM area).

2. ×: don't care

Caution Note that the configuration of the registers used for wait control of the in-circuit emulator differs as follows. If an external wait cycle is set in the internal ROM area, the CPU is deadlocked. The deadlock status can be cleared only by reset input.

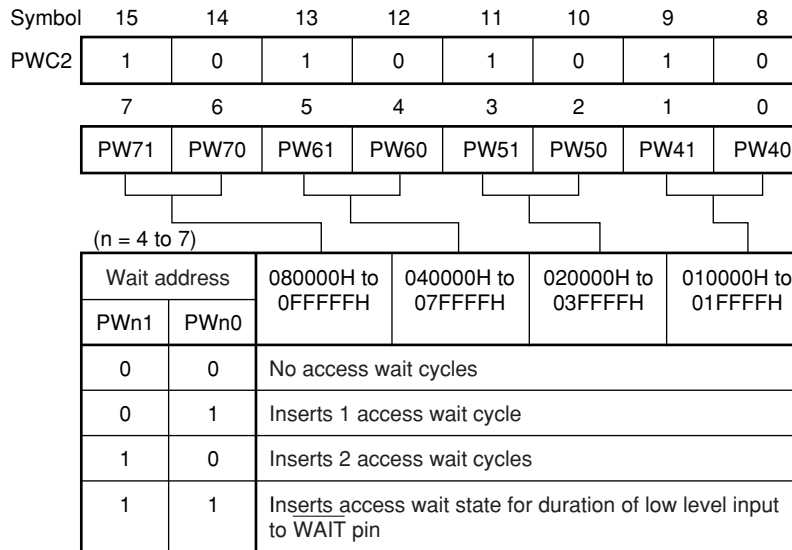
(a) Programmable wait control register 1 (PWC1) of in-circuit emulator

Address: 0FFC7H After reset: AAH R/W



(b) Programmable wait control register 2 (PWC2) of in-circuit emulator

Address: 0FFC8H After reset: AAAAH W



Remark Insertion of wait cycles is controlled on the entire address space (except the peripheral RAM area).

24.3 Memory Map for External Memory Expansion

Figures 24-4 to 24-8 show the memory map during memory expansion. Even during memory expansion, an external device at the same address as the internal ROM area, internal RAM area, or SFR area (except for the external SFR area (0FFD0H to 0FFDFH)) cannot be accessed. If these areas are accessed, the memory and SFR in μ PD784218A are accessed with priority, and the $\overline{\text{ASTB}}$, $\overline{\text{RD}}$, and $\overline{\text{WD}}$ signals are not output (remaining at the inactive level). The output level of the address bus remains at the previous output level. The output of the address/data bus has a high impedance.

Except in the 1 MB expansion mode, an address for external output is output in the state that masked the high order side of the address set by the program.

<Example 1>

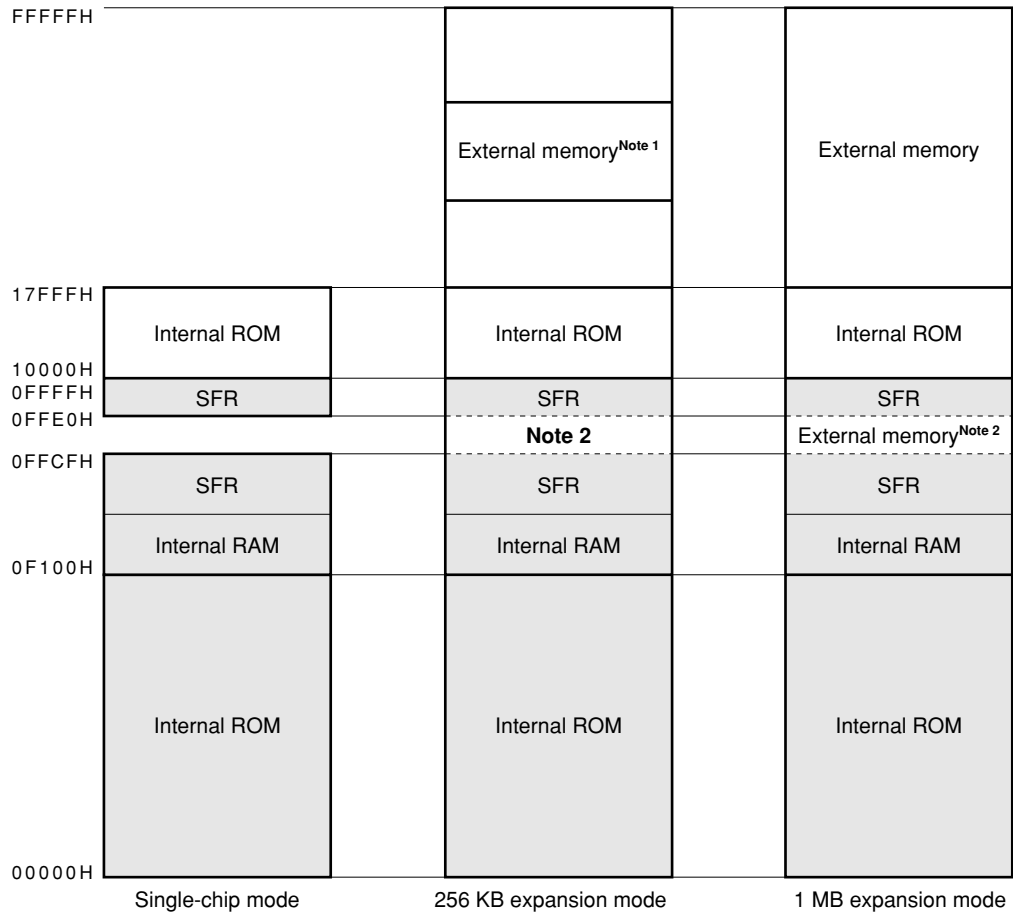
When address 54321H is accessed in the program in the 256 KB expansion mode, the address that is output becomes 14321H.

<Example 2>

When address 67821H is accessed in the program in the 256 KB expansion mode, the address that is output becomes 27821H.

Figure 24-4. μ PD784214A Memory Map (1/2)

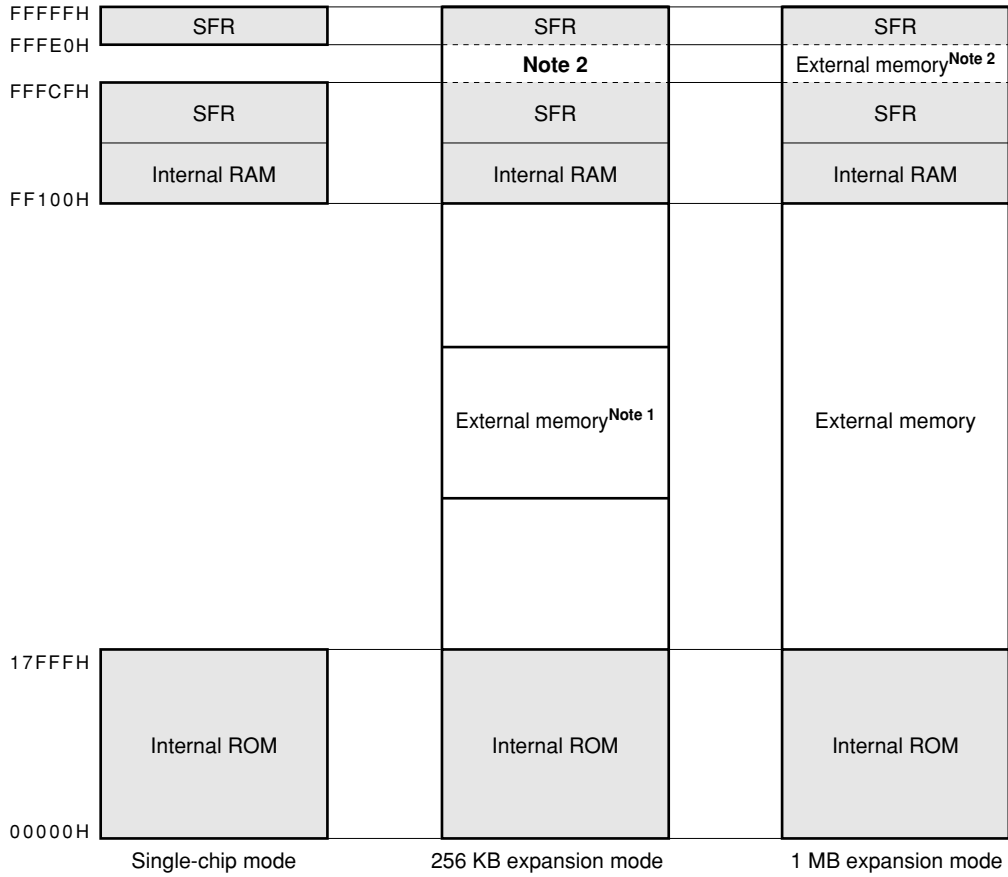
(a) When executing the LOCATION 0H instruction



- Notes**
1. Area having any expansion size in the unshaded parts
 2. External SFR area

Figure 24-4. μ PD784214A Memory Map (2/2)

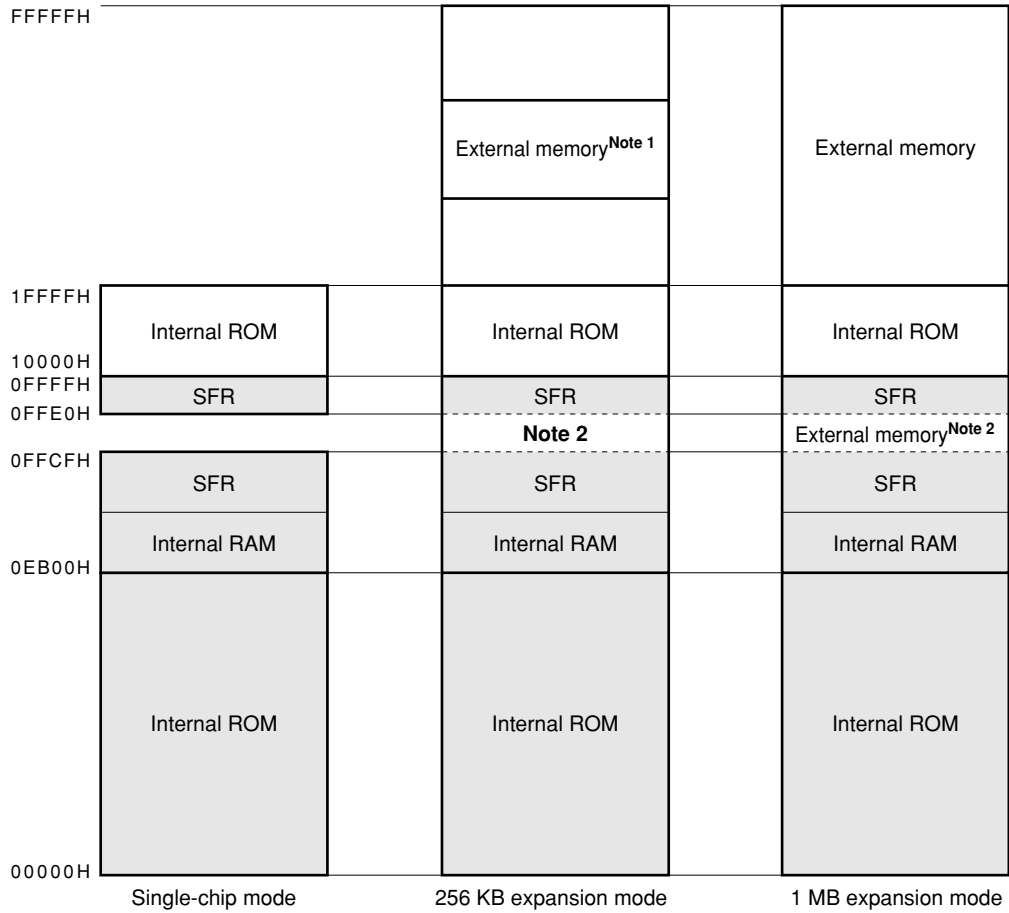
(b) When executing the LOCATION 0FH instruction



- Notes**
1. Area having any expansion size in the unshaded parts
 2. External SFR area

Figure 24-5. μ PD784215A Memory Map (1/2)

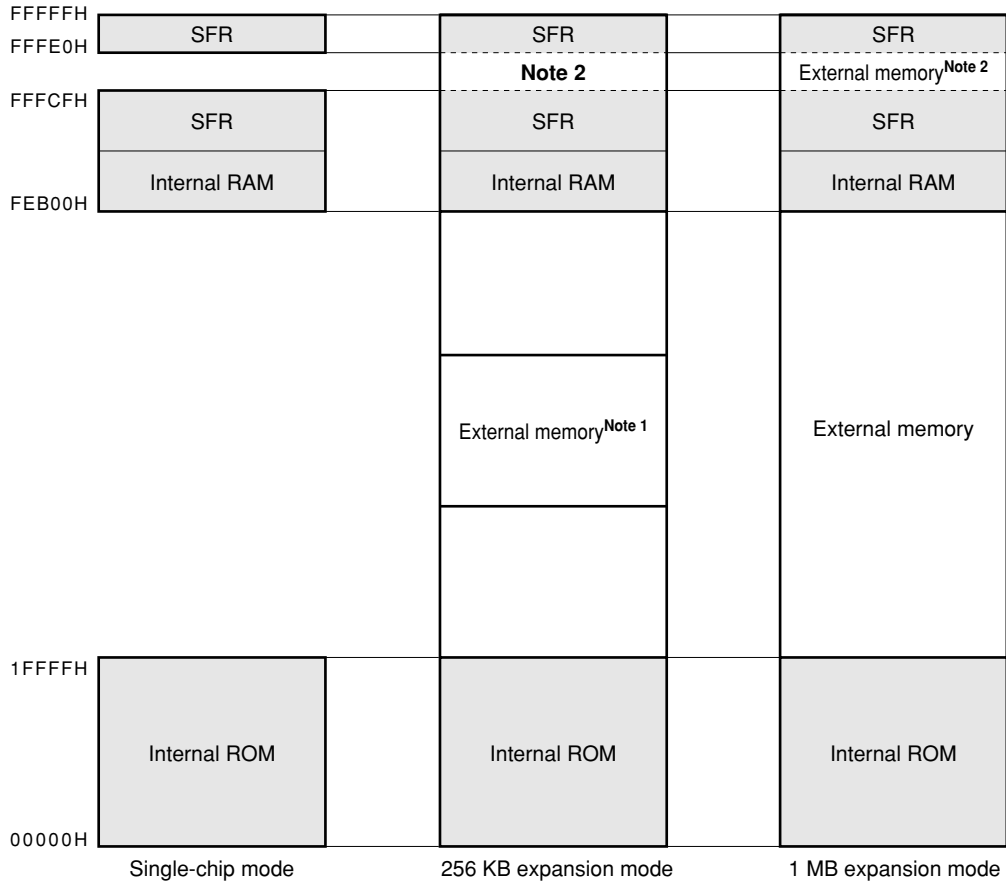
(a) When executing the LOCATION 0H instruction



- Notes**
1. Area having any expansion size in the unshaded parts
 2. External SFR area

Figure 24-5. μ PD784215A Memory Map (2/2)

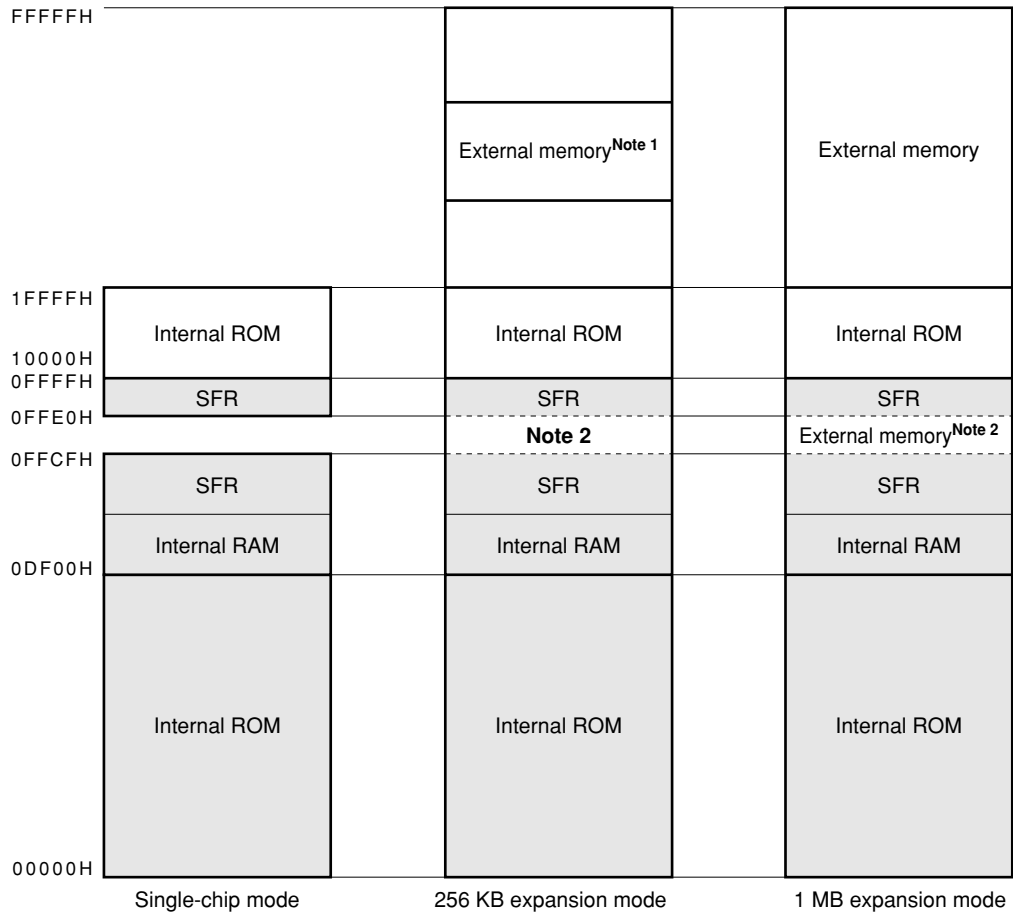
(b) When executing the LOCATION 0FH instruction



- Notes**
1. Area having any expansion size in the unshaded parts
 2. External SFR area

Figure 24-6. μ PD784216A Memory Map (1/2)

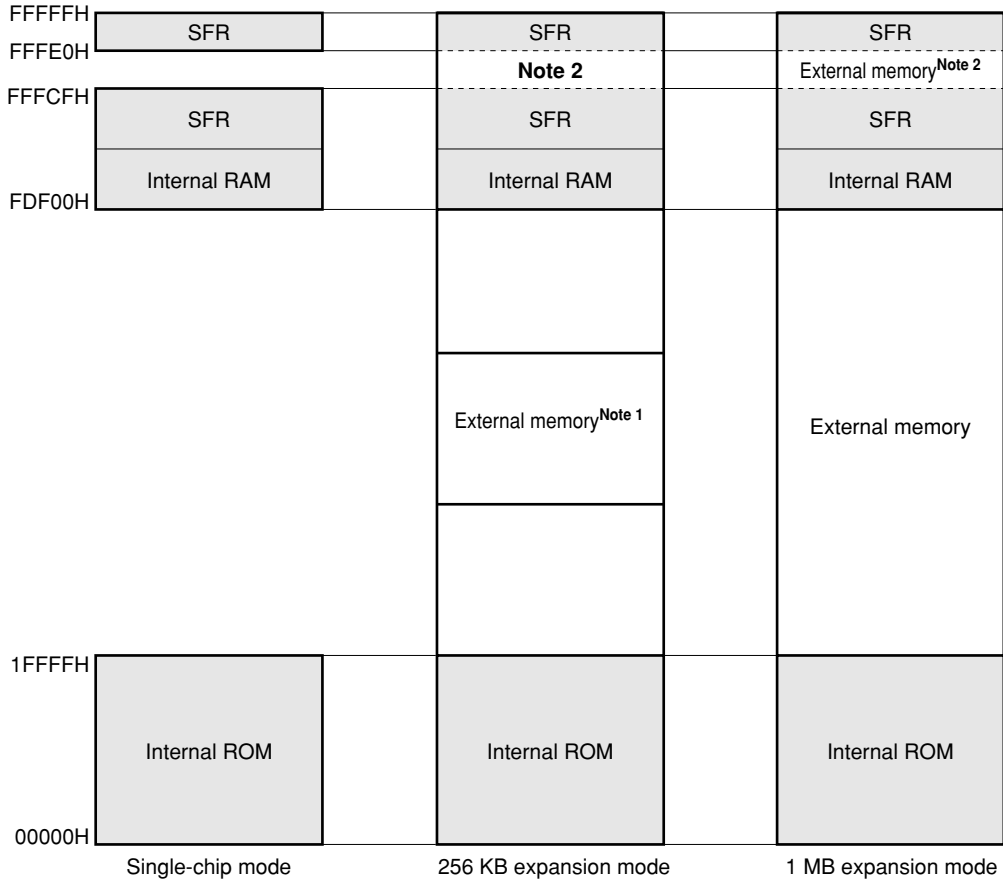
(a) When executing the LOCATION 0H instruction



- Notes**
1. Area having any expansion size in the unshaded parts
 2. External SFR area

Figure 24-6. μ PD784216A Memory Map (2/2)

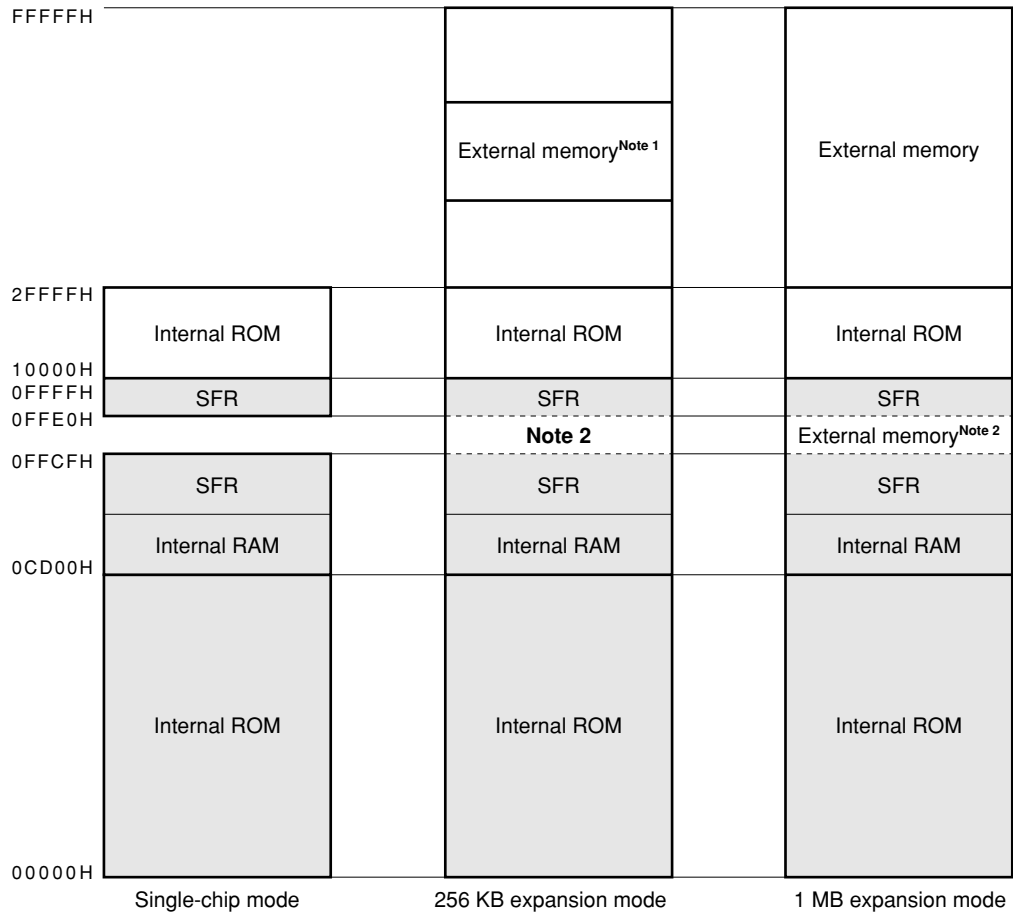
(b) When executing the LOCATION 0FH instruction



- Notes**
1. Area having any expansion size in the unshaded parts
 2. External SFR area

Figure 24-7. μ PD784217A Memory Map (1/2)

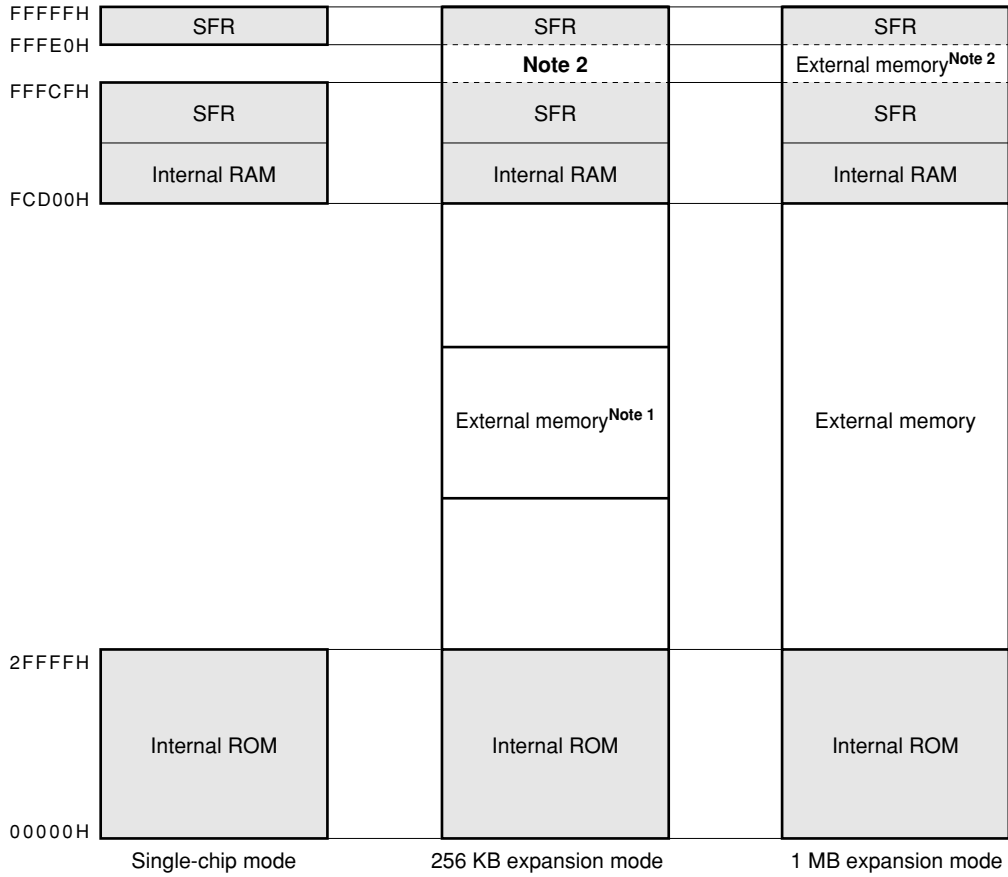
(a) When executing the LOCATION 0H instruction



- Notes**
1. Area having any expansion size in the unshaded parts
 2. External SFR area

Figure 24-7. μ PD784217A Memory Map (2/2)

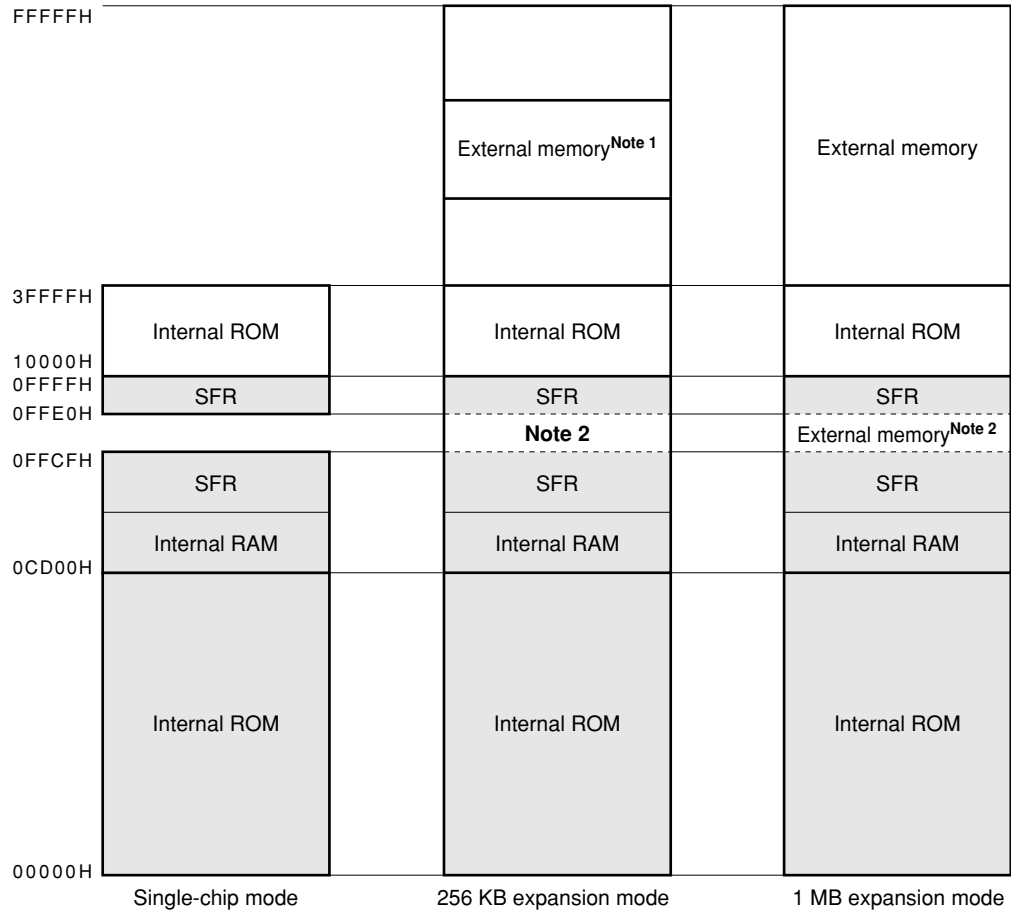
(b) When executing the LOCATION 0FH instruction



- Notes**
1. Area having any expansion size in the unshaded parts
 2. External SFR area

Figure 24-8. μ PD784218A Memory Map (1/2)

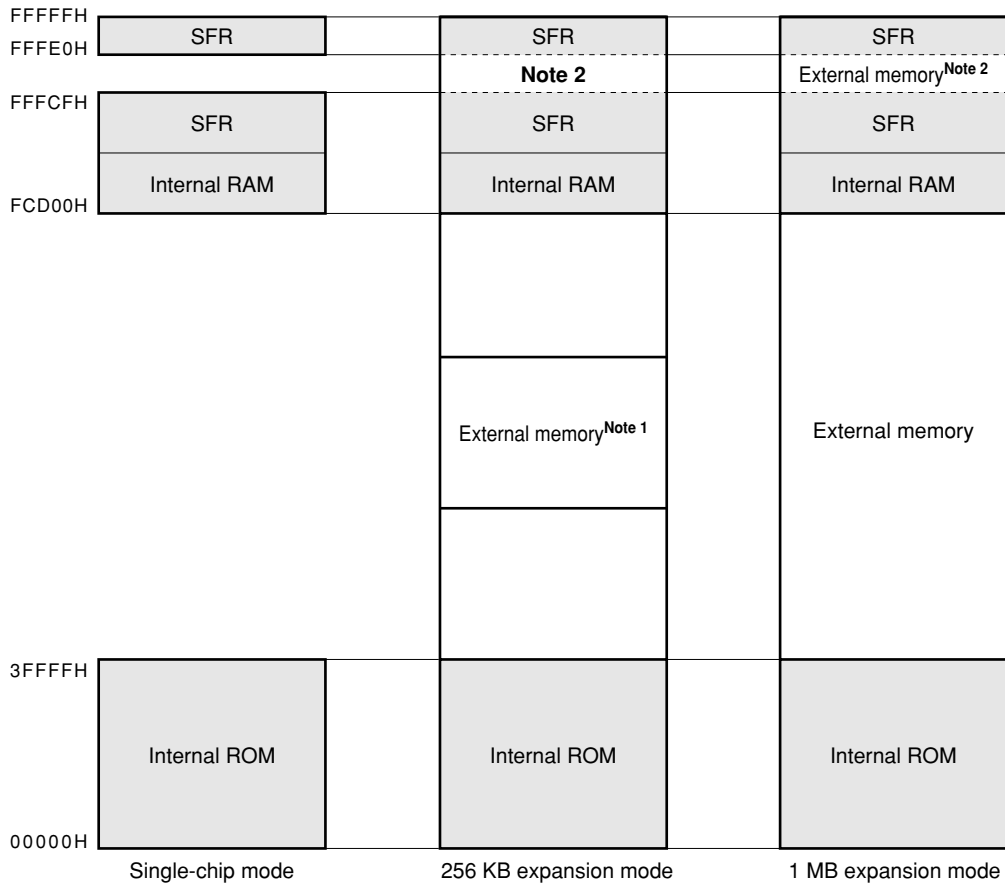
(a) When executing the LOCATION 0H instruction



- Notes**
1. Area having any expansion size in the unshaded parts
 2. External SFR area

Figure 24-8. μ PD784218A Memory Map (2/2)

(b) When executing the LOCATION 0FH instruction



- Notes**
1. Area having any expansion size in the unshaded parts
 2. External SFR area

24.4 Timing of External Memory Expansion Functions

24.4.1 Multiplexed bus mode timing

Next, the timing control signal output pins in the multiplexed bus mode are described below.

(1) **\overline{RD} pin (shared by: P64)**

This pin outputs the read strobe during an instruction fetch or a data access from external memory. During an internal memory access, the read strobe is not output (held at the high level)

(2) **\overline{WR} pin (shared by: P65)**

This pin outputs the write strobe during a data access to external memory. During an internal memory access, the write strobe is not output (held at the high level).

(3) **\overline{WAIT} pin (shared by: P66)**

This pin inputs the external wait signal. When the external wait is not used, \overline{WAIT} pin can be used as an I/O port. During an internal memory access, the external wait signal is ignored.

(4) **ASTB pin (shared by: P67)**

This pin always outputs the address strobe in any instruction fetch or data access from external memory. During an internal memory access, the address strobe is not output (keeps low level).

(5) **AD0 to AD7, A8 to A15, A16 to A19 pins (shared by: P40 to P47, P50 to P57, P60 to P63)**

These pins output the address and data signals. When an instruction is fetched or data is accessed from external memory, valid signals are output or input. During an internal memory access, the signals do not change.

Figures 24-9 to 24-12 are the timing charts.

Figure 24-9. Instruction Fetch from External Memory in Multiplexed Bus Mode

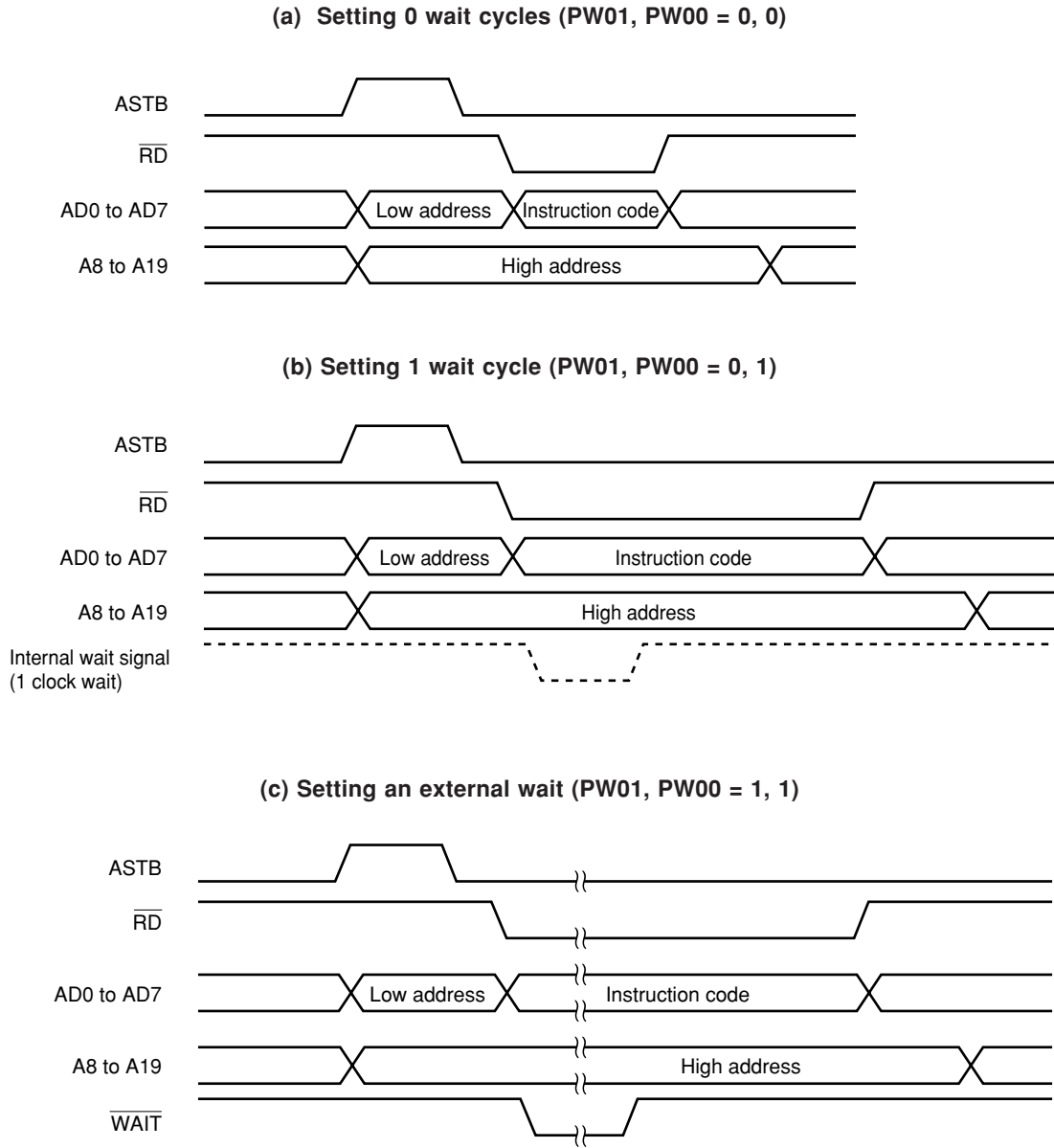


Figure 24-10. Read Timing for External Memory in Multiplexed Bus Mode

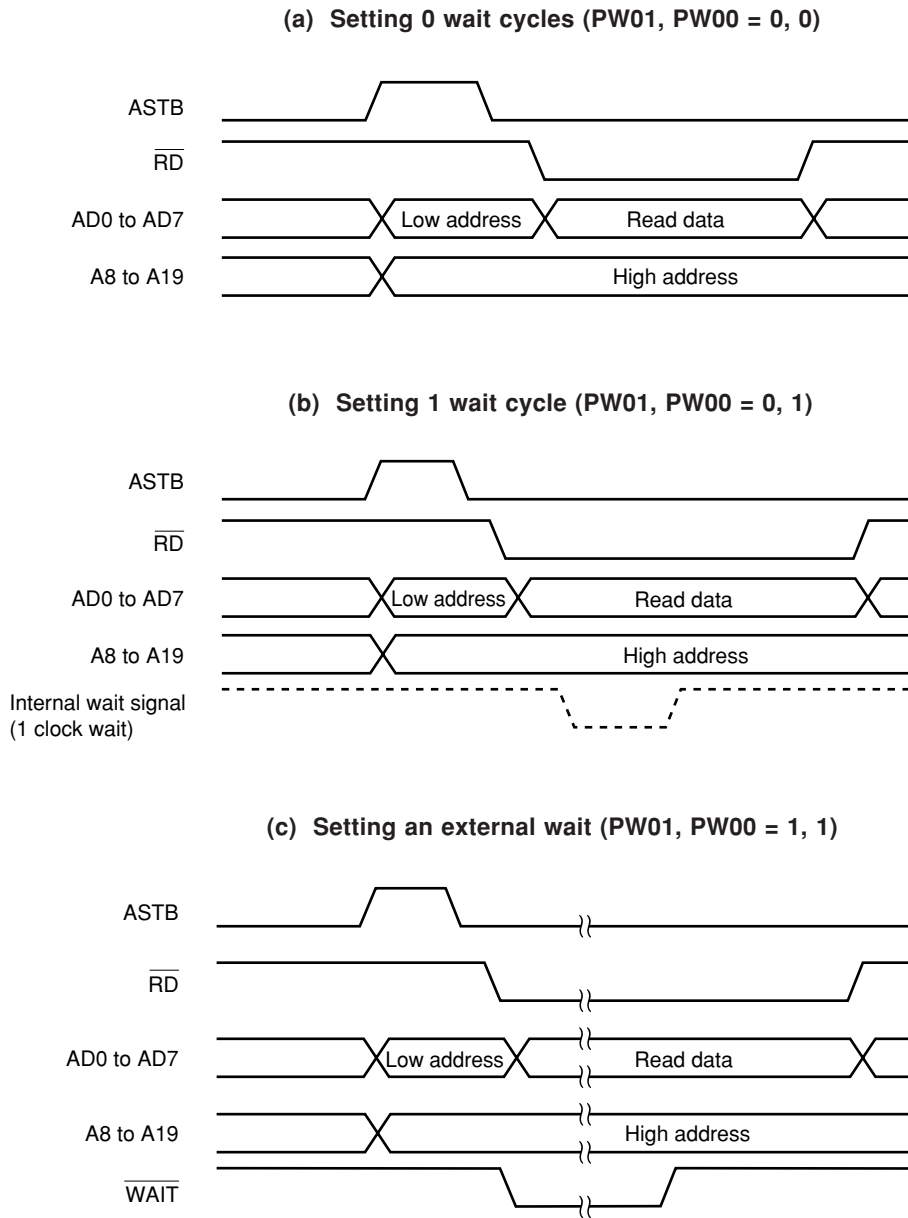


Figure 24-11. Write Timing for External Memory in Multiplexed Bus Mode

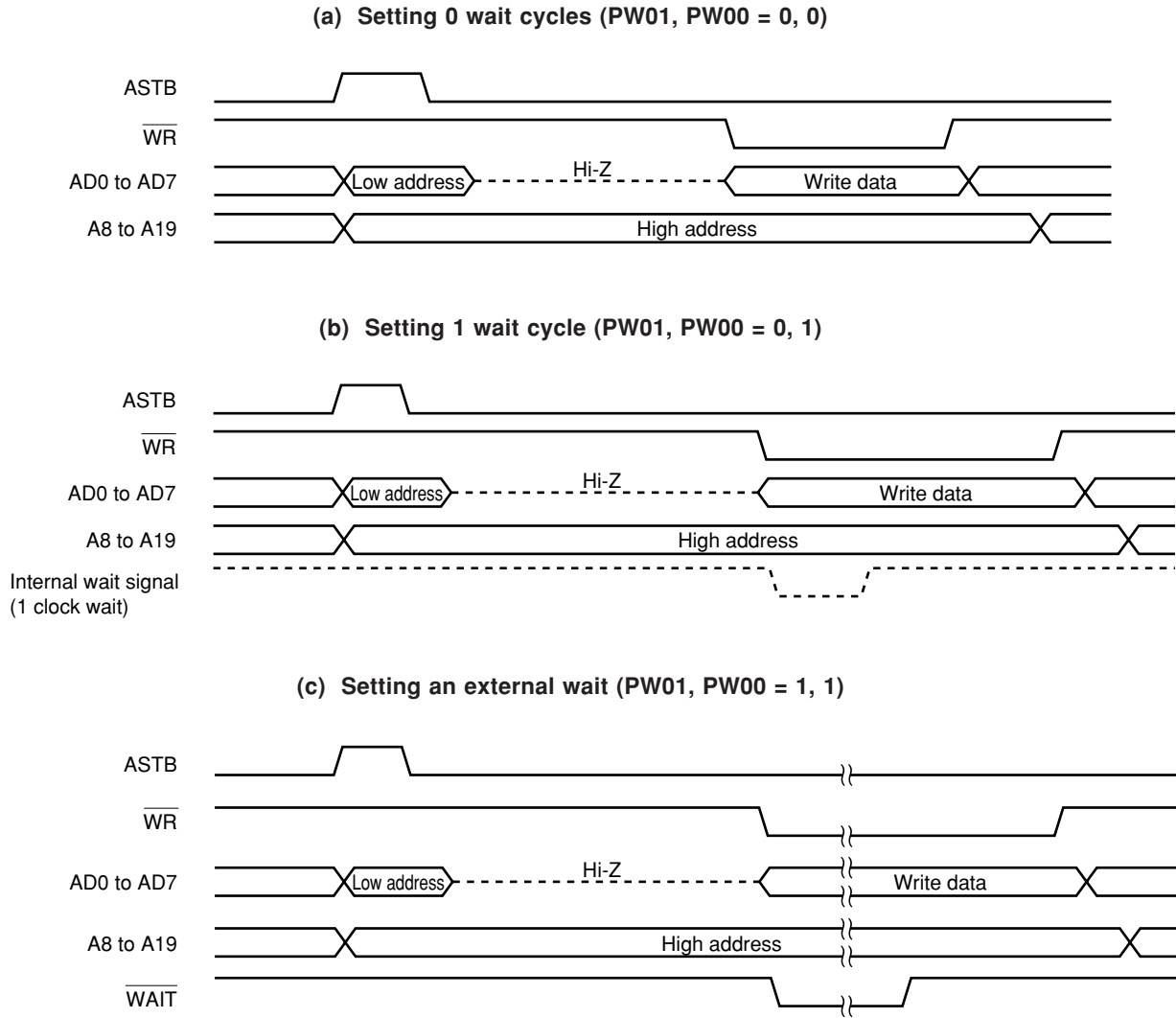
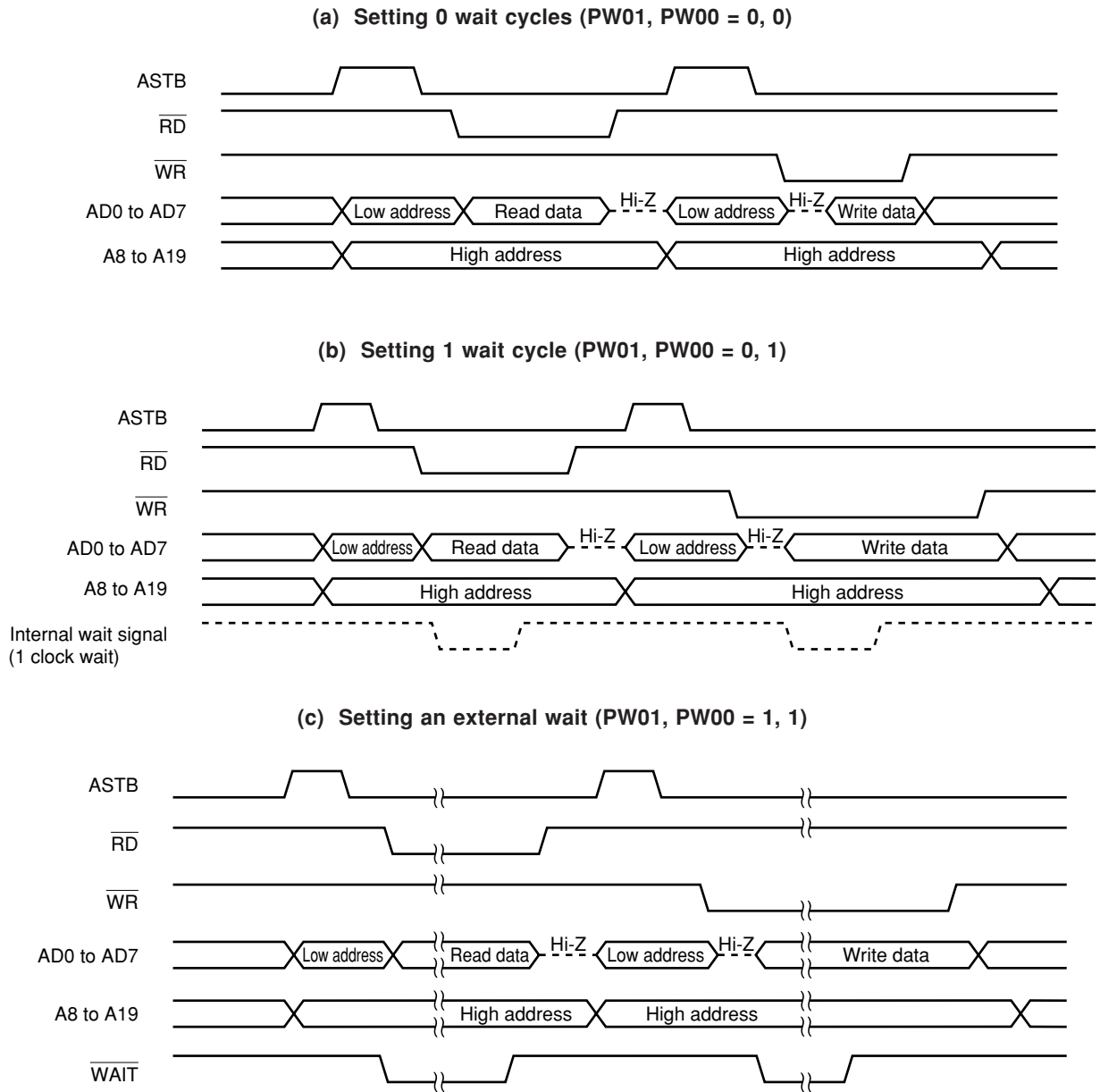


Figure 24-12. Read Modify Write Timing for External Memory in Multiplexed Bus Mode



24.4.2 Separate bus mode timing

The timing control signal output pins in the separate bus mode are described next.

(1) $\overline{\text{RD}}$ pin (shared by: P64)

This pin outputs the read strobe during an instruction fetch or a data access from external memory. During an internal memory access, the read strobe signal is not output (held at the high level).

(2) $\overline{\text{WR}}$ pin (shared by: P65)

This pin outputs the write strobe during a data access to external memory. During an internal memory access, the write strobe is not output (held at the high level).

(3) $\overline{\text{WAIT}}$ pin (shared by: P66)

This pin inputs the external wait signal. When external waits are not used, the $\overline{\text{WAIT}}$ pin can be used as an I/O port. During an internal memory access, the external wait signal is ignored.

(4) AD0 to AD7, A0 to A7, A8 to A15, A16 to A19 pins (shared by: P40 to P47, P80 to P87, P50 to P57, P60 to P63)

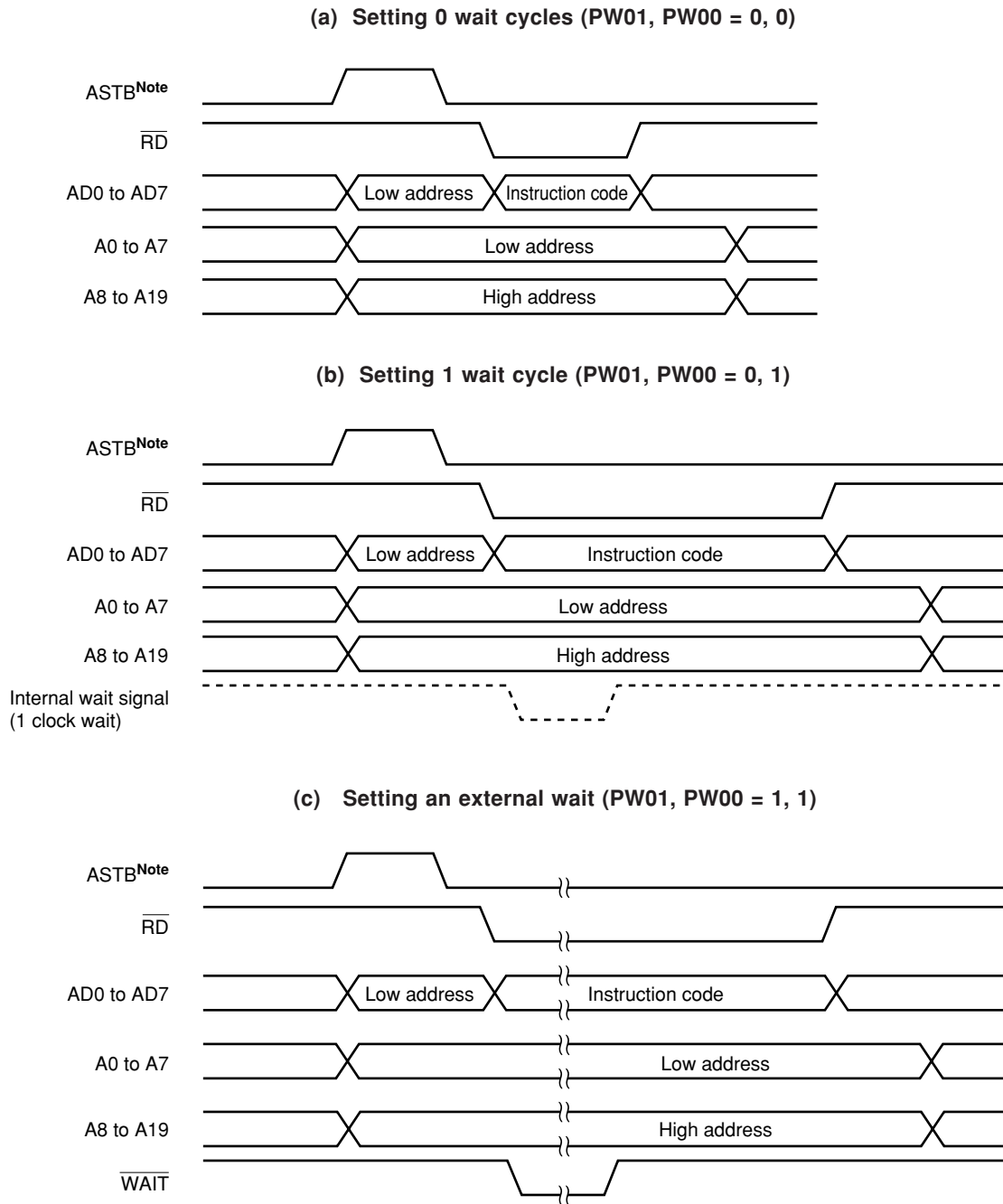
These pins output the address and data signals. During an instruction fetch or a data access from external memory, valid signals are output or input.

The signals of the AD0 to AD7, A8 to A15, and A16 to A19 pins do not change while the internal memory is being accessed. The A0 to A7 pins output the status of the internal bus when the internal memory is accessed.

Figures 24-13 to 24-16 are the timing charts.

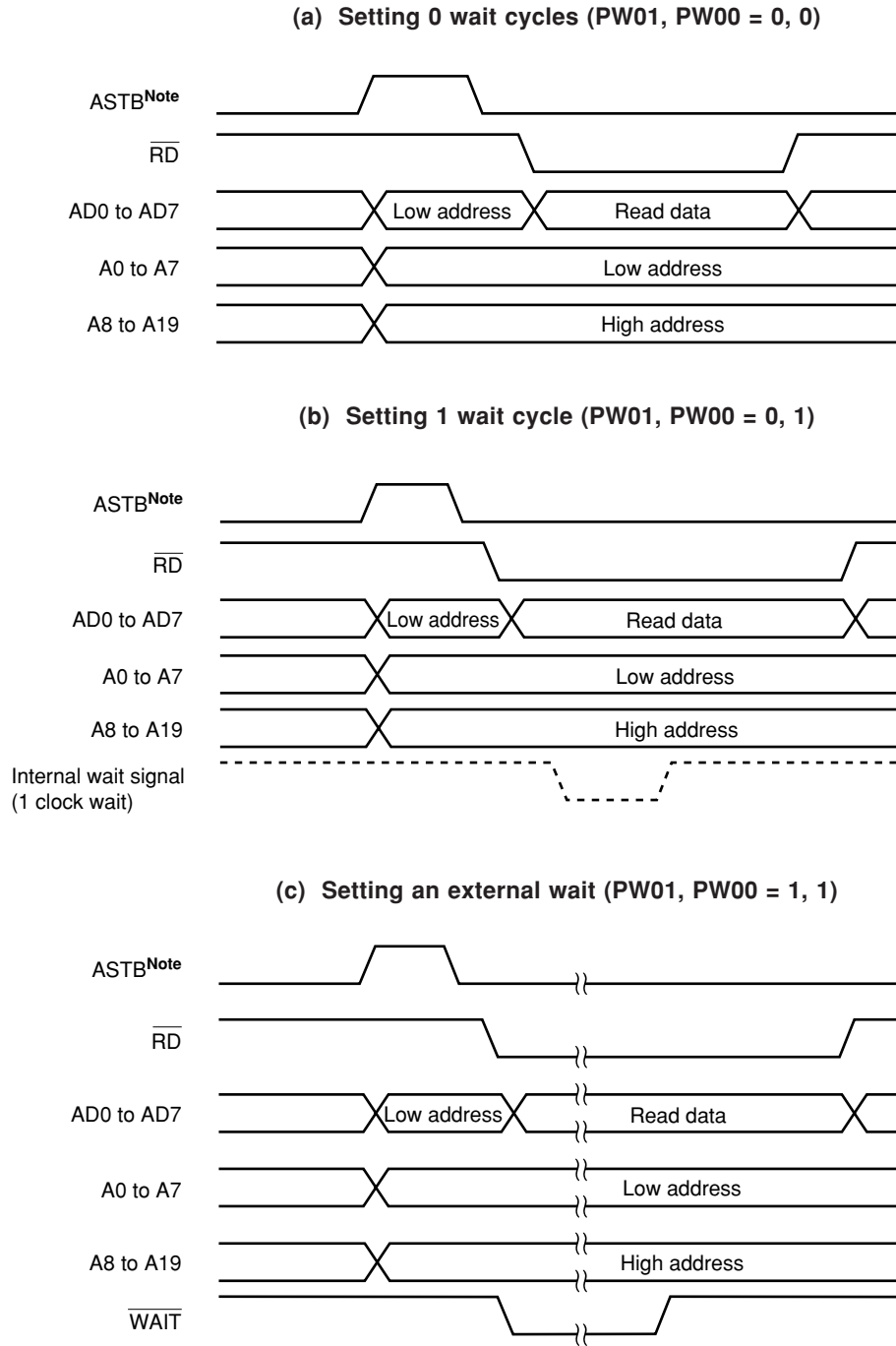
Caution In the separate bus mode, the address strobe does not have to be used. However, the address strobe is output from pin ASTB/P67. See Figures 24-13 to 24-16 for the output timing.

Figure 24-13. Instruction Fetch from External Memory in Separate Bus Mode



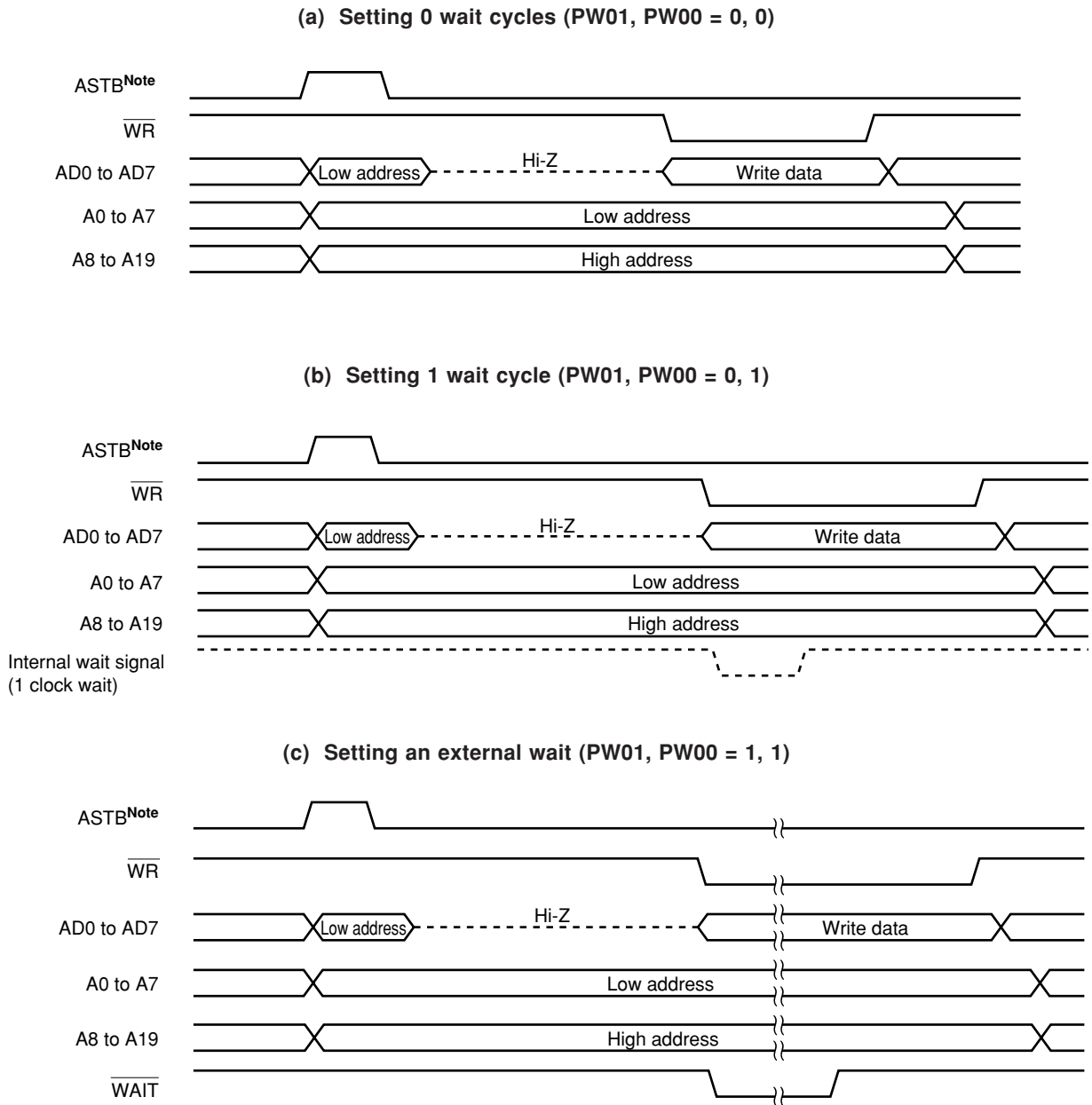
Note In the separate bus mode, the address strobe does not have to be used. However, the address strobe is output from the ASTB/P67 pin.

Figure 24-14. Read Timing for External Memory in Separate Bus Mode



Note In the separate bus mode, the address strobe does not have to be used. However, the address strobe is output from the $\overline{ASTB}/P67$ pin.

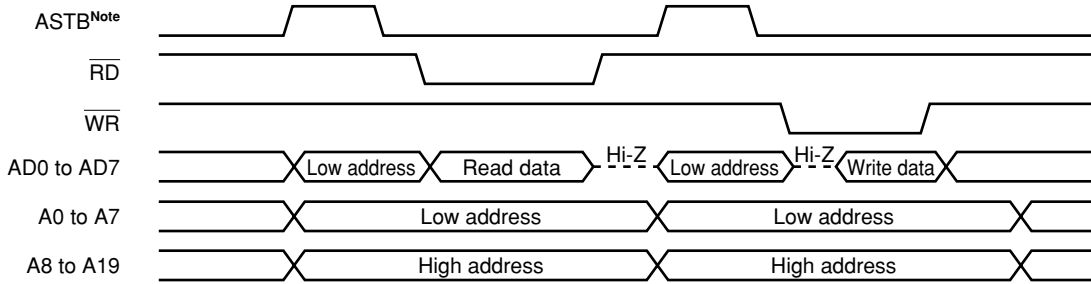
Figure 24-15. Write Timing for External Memory in Separate Bus Mode



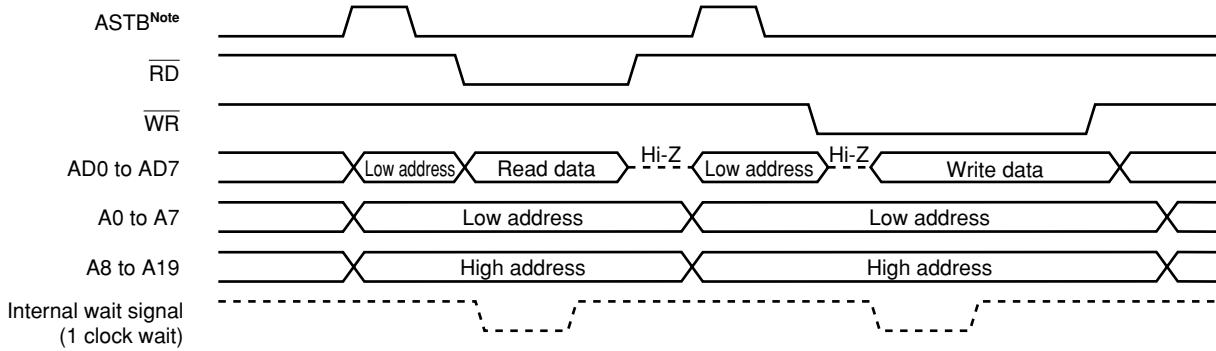
Note In the separate bus mode, the address strobe does not have to be used. However, the address strobe is output from the ASTB/P67 pin.

Figure 24-16. Read Modify Write Timing for External Memory in Separate Bus Mode

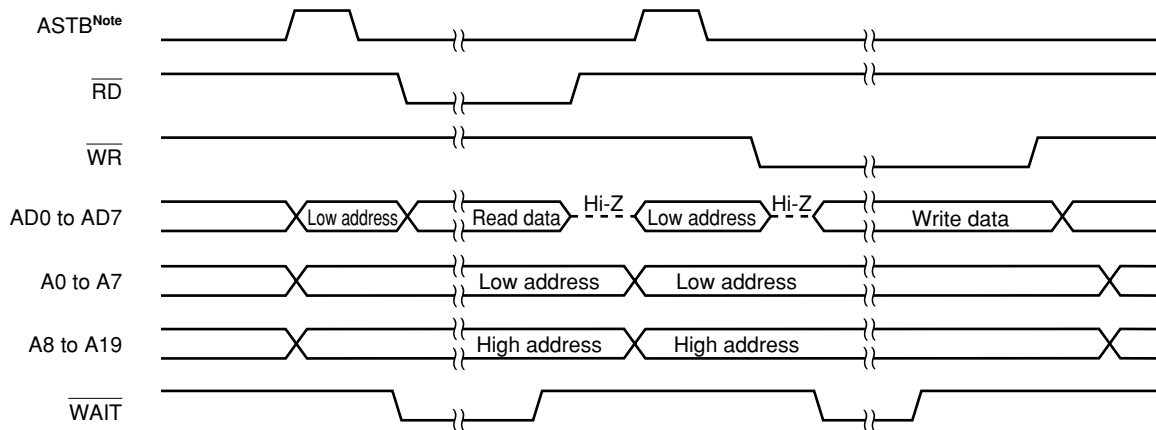
(a) Setting 0 wait cycles (PW01, PW00 = 0, 0)



(b) Setting 1 wait cycle (PW01, PW00 = 0, 1)



(c) Setting an external wait (PW01, PW00 = 1, 1)



Note In the separate bus mode, the address strobe does not have to be used. However, the address strobe is output from the ASTB/P67 pin.

24.5 Wait Functions

If slow memory and I/O are connected externally to the μ PD784218A, waits can be inserted in the external memory access cycle.

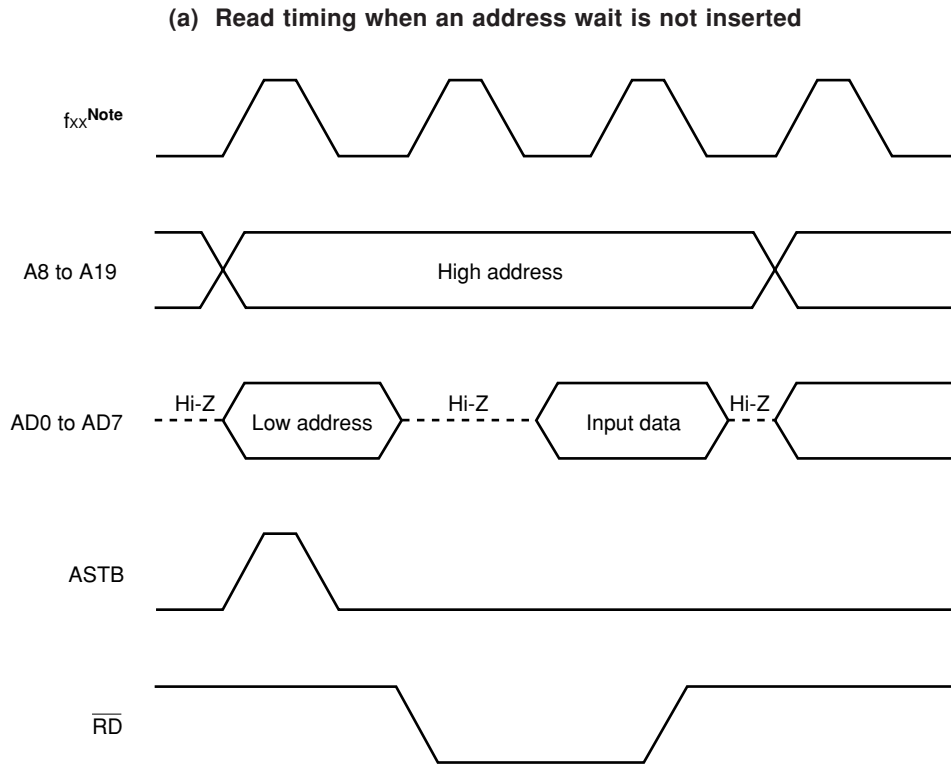
During the wait cycle, there is an address wait to guarantee the address decoding time and an access wait to guarantee the access time.

24.5.1 Address wait

An address wait guarantees the address decoding time. By setting the AW bit in the memory expansion mode register (MM) to 1, an address wait is inserted into the entire memory access time^{Note}. When the address wait is inserted, the high level period of the ASTB signal is lengthened by one system clock (80 ns, $f_{xx} = 12.5$ MHz).

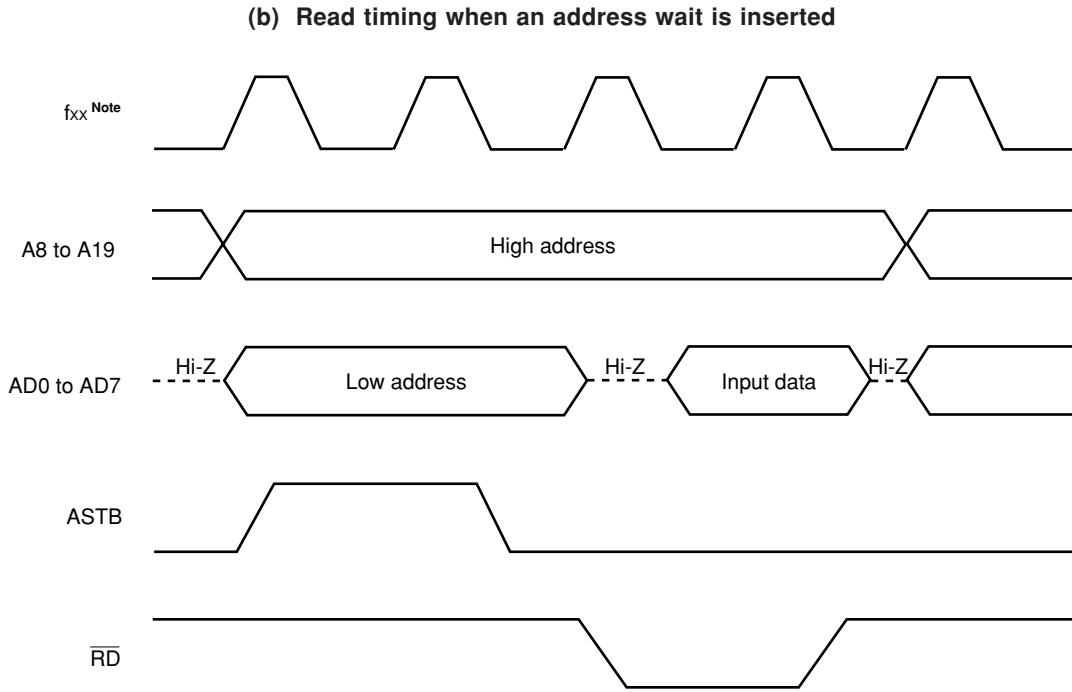
Note This excludes the internal RAM, internal SFR, and internal ROM during a high-speed fetch. When the internal ROM access is set to have the same cycle as an external ROM access, an address wait is inserted during an internal ROM access.

Figure 24-17. Read/Write Timing by Address Wait Function (1/3)



Note f_{xx} : Main system clock frequency. This signal is only in the μ PD784218A.

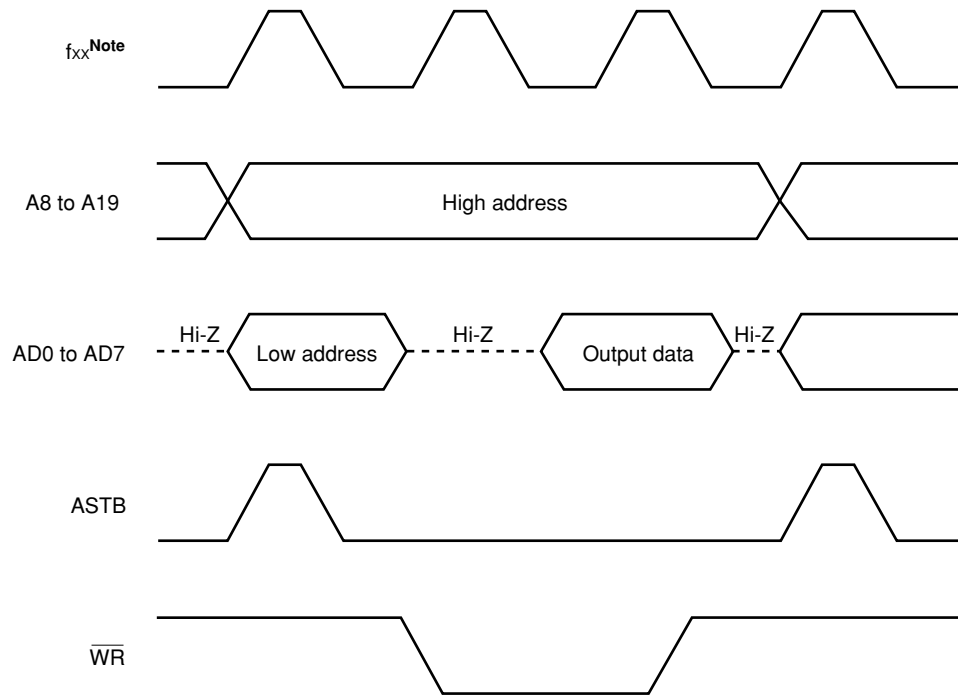
Figure 24-17. Read/Write Timing by Address Wait Function (2/3)



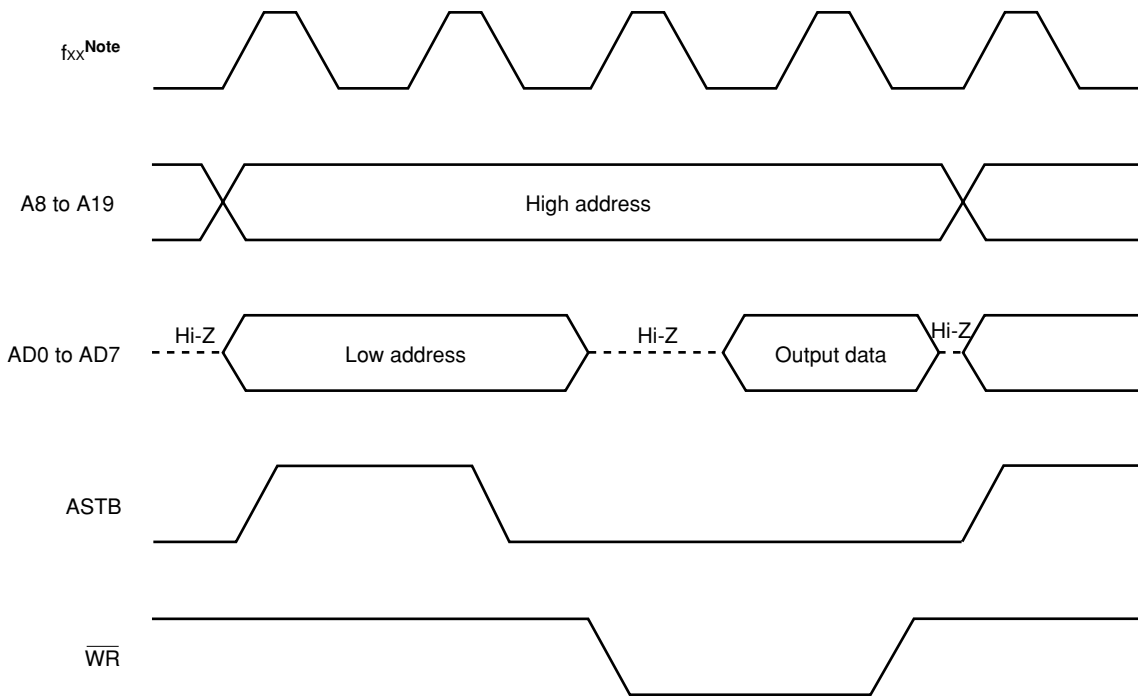
Note fxx: Main system clock frequency. This signal is only in the μ PD784218A.

Figure 24-17. Read/Write Timing by Address Wait Function (3/3)

(c) Write timing when an address wait is not inserted



(d) Write timing when an address wait is inserted



Note fxx: Main system clock frequency. This signal is only in the μ PD784218A.

24.5.2 Access wait

An access wait is inserted during low \overline{RD} and \overline{WR} signals. The low level is lengthened by $1/f_{xx}$ (80 ns, $f_{xx} = 12.5$ MHz) per cycle.

The wait insertion methods are the programmable wait function that automatically inserts a preset number of cycles and the external wait function that is controlled from the outside by the wait signal.

Wait cycle insertion control is set by the programmable wait control register (PWC1) for the 1 MB memory space. If an internal ROM or internal RAM is accessed during a high-speed fetch, a wait is not inserted. If accessing an internal SFR, a wait is inserted based on required timing unrelated to this setting.

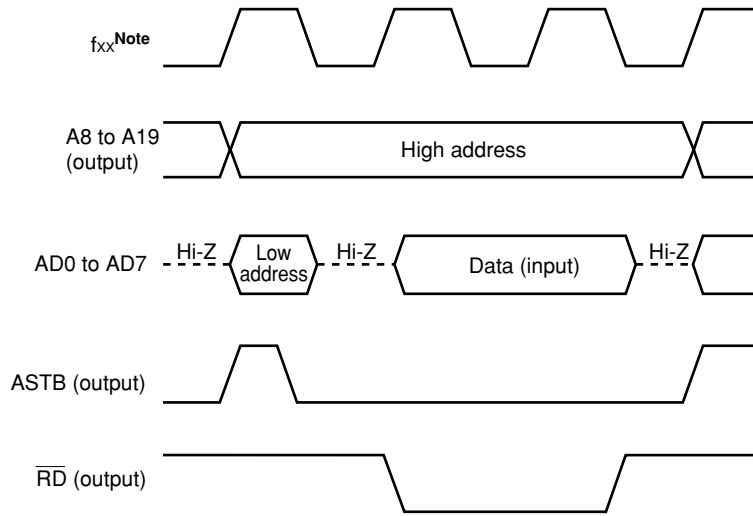
If set so that an access has the same number of cycles as for an external ROM, a wait is also inserted in an internal ROM access in accordance with the PWC1 setting.

If there is space that was externally selected to be controlled by the wait signal by PWC1, pin P66 acts as the \overline{WAIT} signal input pin. \overline{RESET} input makes pin P66 act as an ordinary I/O port.

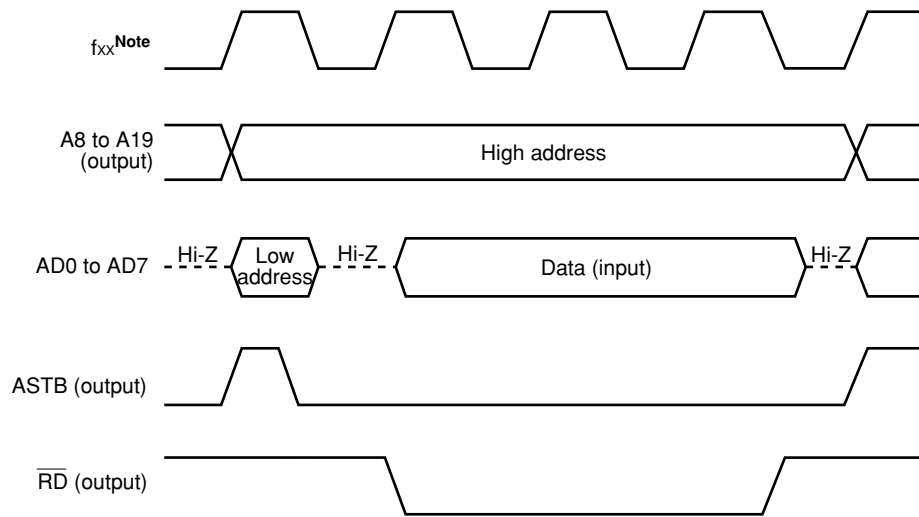
Figures 24-18 to 24-20 show the bus timing when an access wait is inserted.

Figure 24-18. Read Timing by Access Wait Function (1/2)

(a) Setting 0 wait cycles (PW01, PW00 = 0, 0)



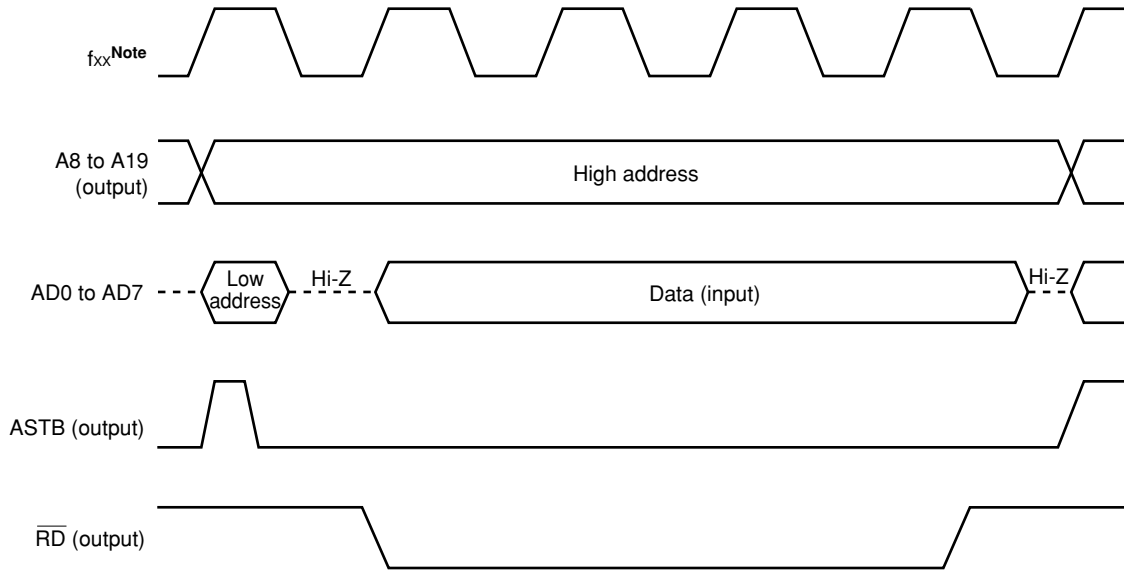
(b) Setting 1 wait cycle (PW01, PW00 = 0, 1)



Note fxx: Main system clock frequency. This signal is only in the μ PD784218A.

Figure 24-18. Read Timing by Access Wait Function (2/2)

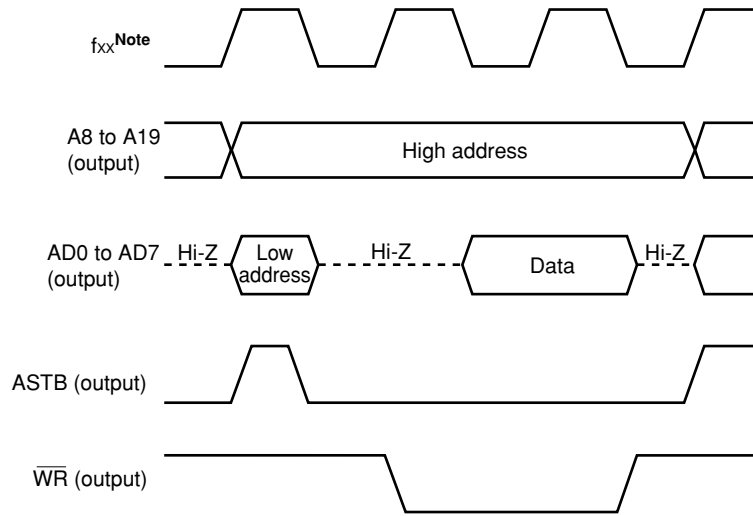
(c) Setting 2 wait cycles (PW01, PW00 = 1, 0)



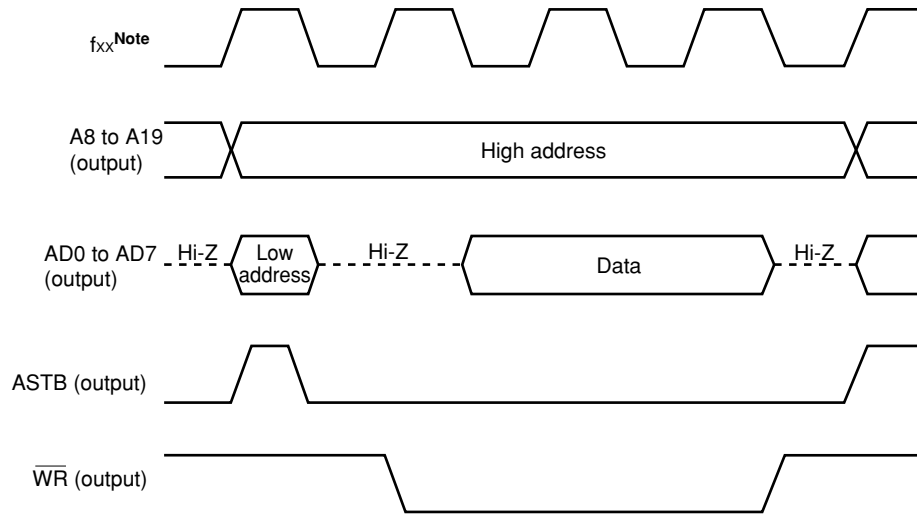
Note fxx: Main system clock frequency. This signal is only in the μ PD784218A.

Figure 24-19. Write Timing by Access Wait Function (1/2)

(a) Setting 0 wait cycles (PW01, PW00 = 0, 0)



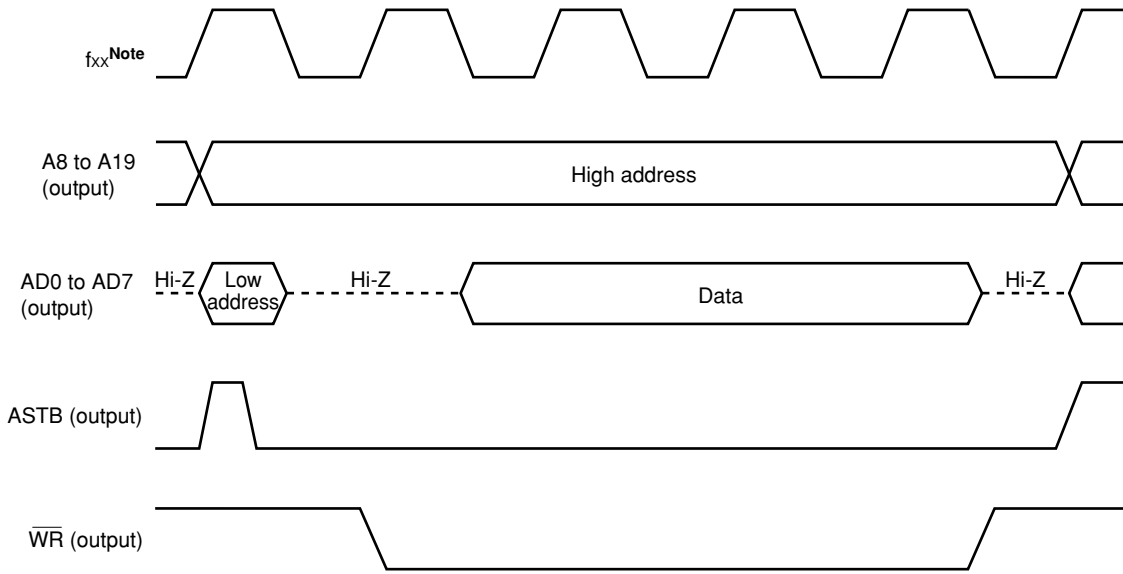
(b) Setting 1 wait cycle (PW01, PW00 = 0, 1)



Note fxx: Main system clock frequency. This signal is only in the μ PD784218A.

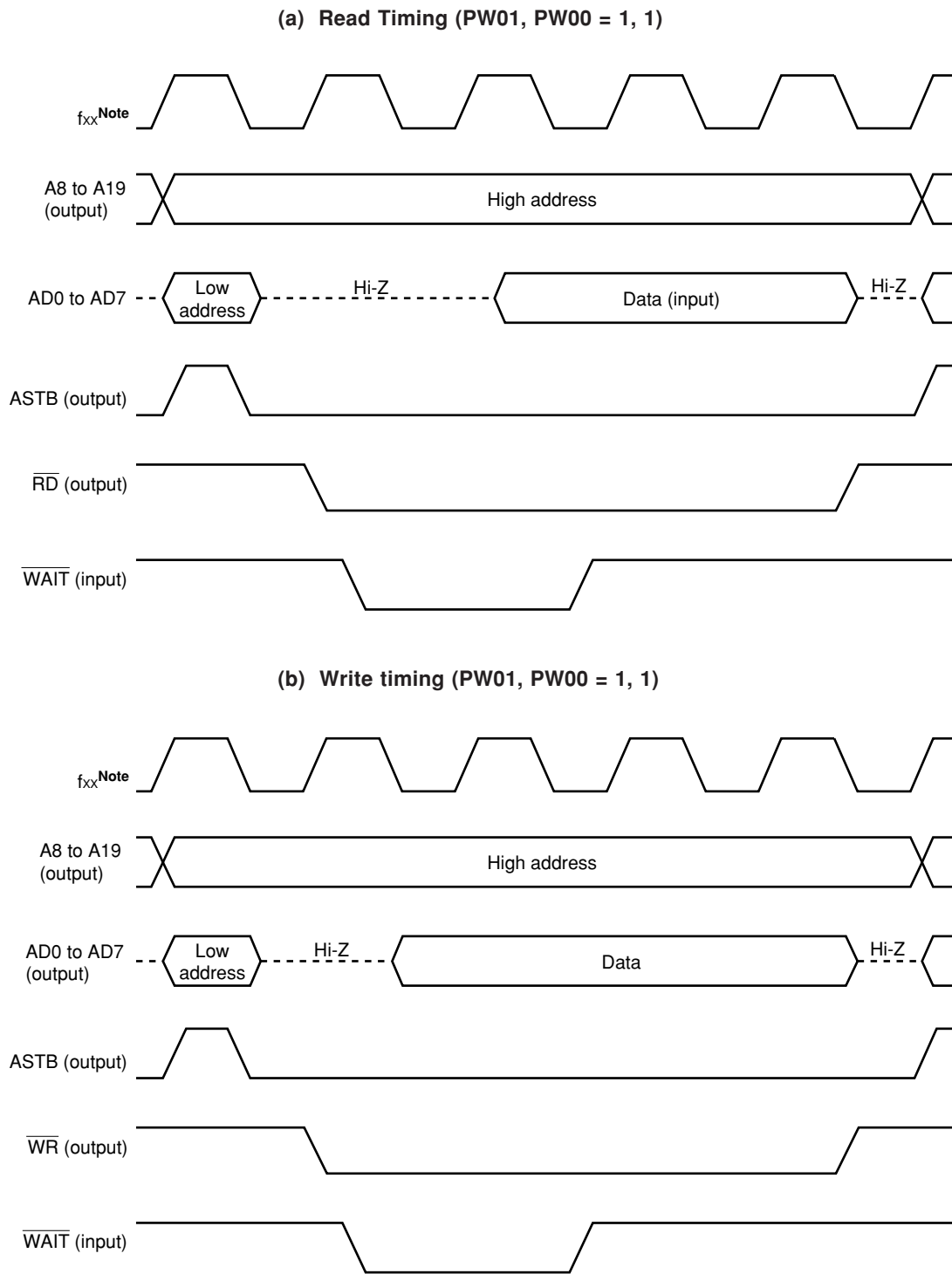
Figure 24-19. Write Timing by Access Wait Function (2/2)

(c) Setting 2 wait cycles (PW01, PW00 = 1, 0)



Note fxx: Main system clock frequency. This signal is only in the μ PD784218A.

Figure 24-20. Timing by External Wait Signal



Note fxx: Main system clock frequency. This signal is only in the μ PD784218A.

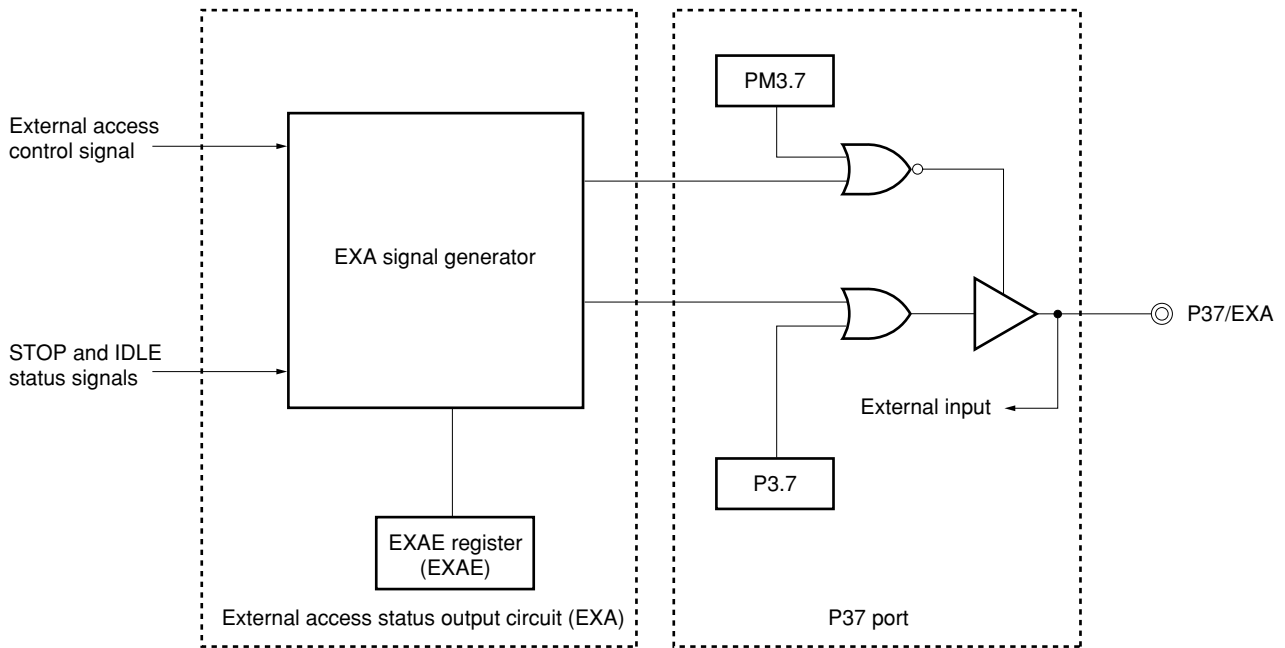
24.6 External Access Status Output Function (μ PD784218A, 784218AY Subseries Only)

24.6.1 Overview

The external access status signal is output from the P37/EXA pin. This signal is output at the moment of external access when use of the external bus interface function has been enabled. This signal detected the external access status of other devices connected to the external bus, prohibits other devices from outputting data to the external bus, and enables reception.

24.6.2 Configuration of external access status output function

Figure 24-21. Configuration of External Access Status Output Function



24.6.3 External access status enable register

The external access status enable register (EXAE) controls the EXA signal output indicated during external access. EXAE are set by a 1-bit or 8-bit memory manipulation instruction. $\overline{\text{RESET}}$ input sets EXAE to 00H.

Figure 24-22. External Access Status Enable Register (EXAE) Format

Address: 0FF8DH After reset: 00H

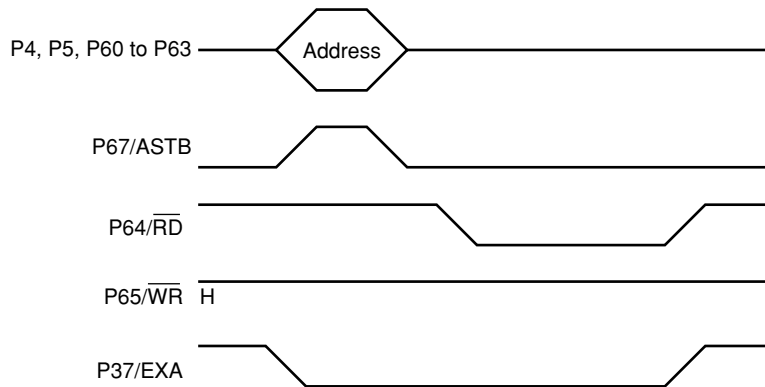
Symbol	7	6	5	4	3	2	1	0
EXAE	0	0	0	0	0	0	0	EXAE0

EXAE0	P37 function
0	Port function
1	External access status output function

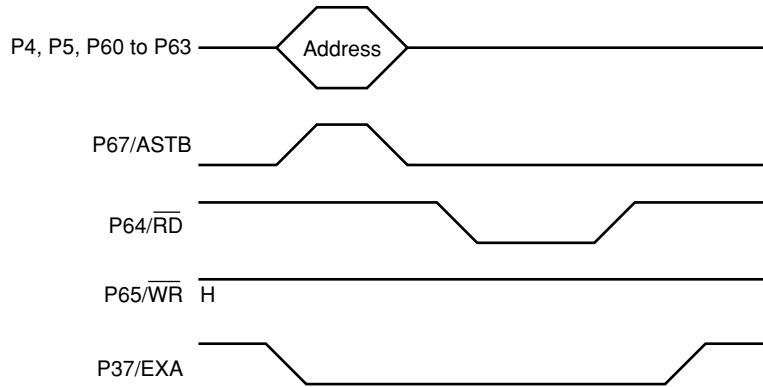
24.6.4 External access status signal timing

A timing chart for the P37/EXA and external bus interface pin is shown below. The EXA signal is set at low active, and indicates the external access status when at “0”.

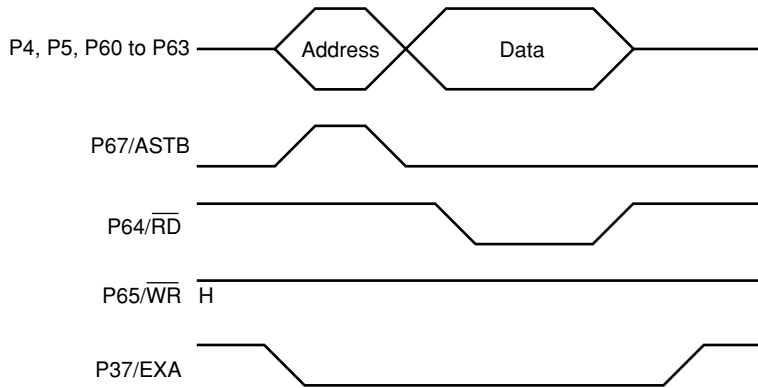
(a) Data fetch timing



(b) Data read timing



(c) Data write timing



24.6.5 EXA pin status during each mode

P37/EXA pin status during each mode is shown in Table 24-5.

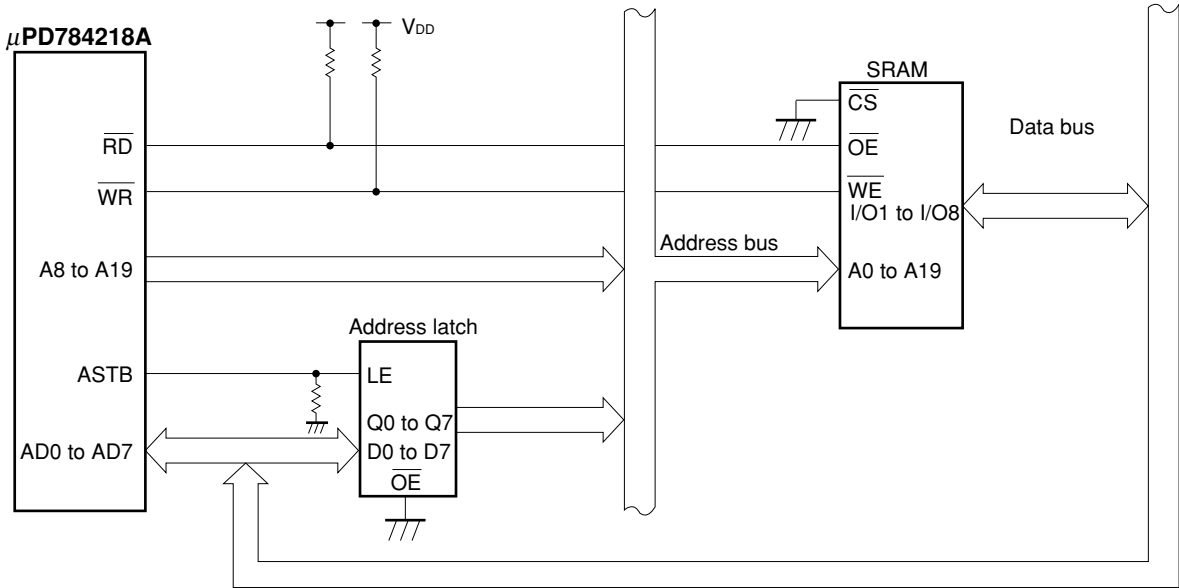
Table 24-5. P37/EXA Pin Status During Each Mode

Mode	P37/EXA Functions
After reset	Hi-Z
After reset is released	Hi-Z immediately after the reset is released (input mode, PM37 = 1) Port operations when EXAE = 00H with PM37 = 0 EXA signal output enabled when EXAE = 01H with PM37 and P37 = 0
When in the HALT mode	Hold
When in the IDLE mode	Hi-Z
When in the STOP mode	Hi-Z

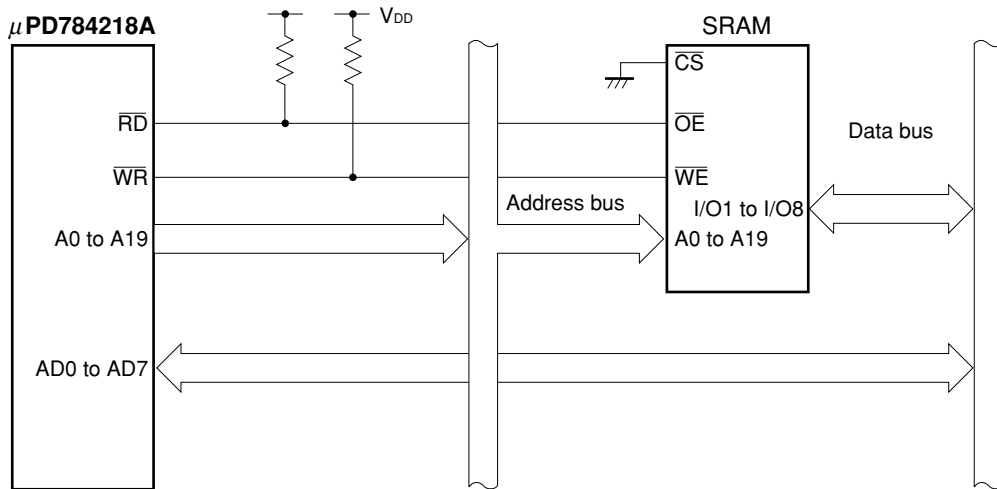
24.7 External Memory Connection Example

Figure 24-23. Example of Local Bus Interface

(a) Multiplexed bus mode



(b) Separate bus mode



CHAPTER 25 STANDBY FUNCTION

25.1 Configuration and Function

The μ PD784218A has a standby function that can decrease the system's power consumption. The standby function has the following six modes.

Table 25-1. Standby Function Modes

HALT mode	Stops the CPU operating clock. The average power consumption can be reduced by intermittent operation during normal operation.
STOP mode	Stops the main system clock. All of the operations in the chip are stopped, and the extremely low power consumption state of only a leakage current is entered.
IDLE mode	In this mode, the oscillator continues operating while the rest of the system stops. Normal program operation can return to power consumption near that of the STOP mode and for the same time as the HALT mode.
Low power consumption mode	The subsystem clock is used as the system clock, and the main system clock is stopped. Since reduced power consumption is designed, the CPU can operate with the subsystem clock.
Low power consumption HALT mode	The CPU operating clock is stopped by the standby function in the low power consumption mode. Power consumption for the entire system is decreased.
Low power consumption IDLE mode	The oscillator continues operating while the rest of the system is stopped by the standby function in the low power consumption mode. Power consumption for the entire system is decreased.

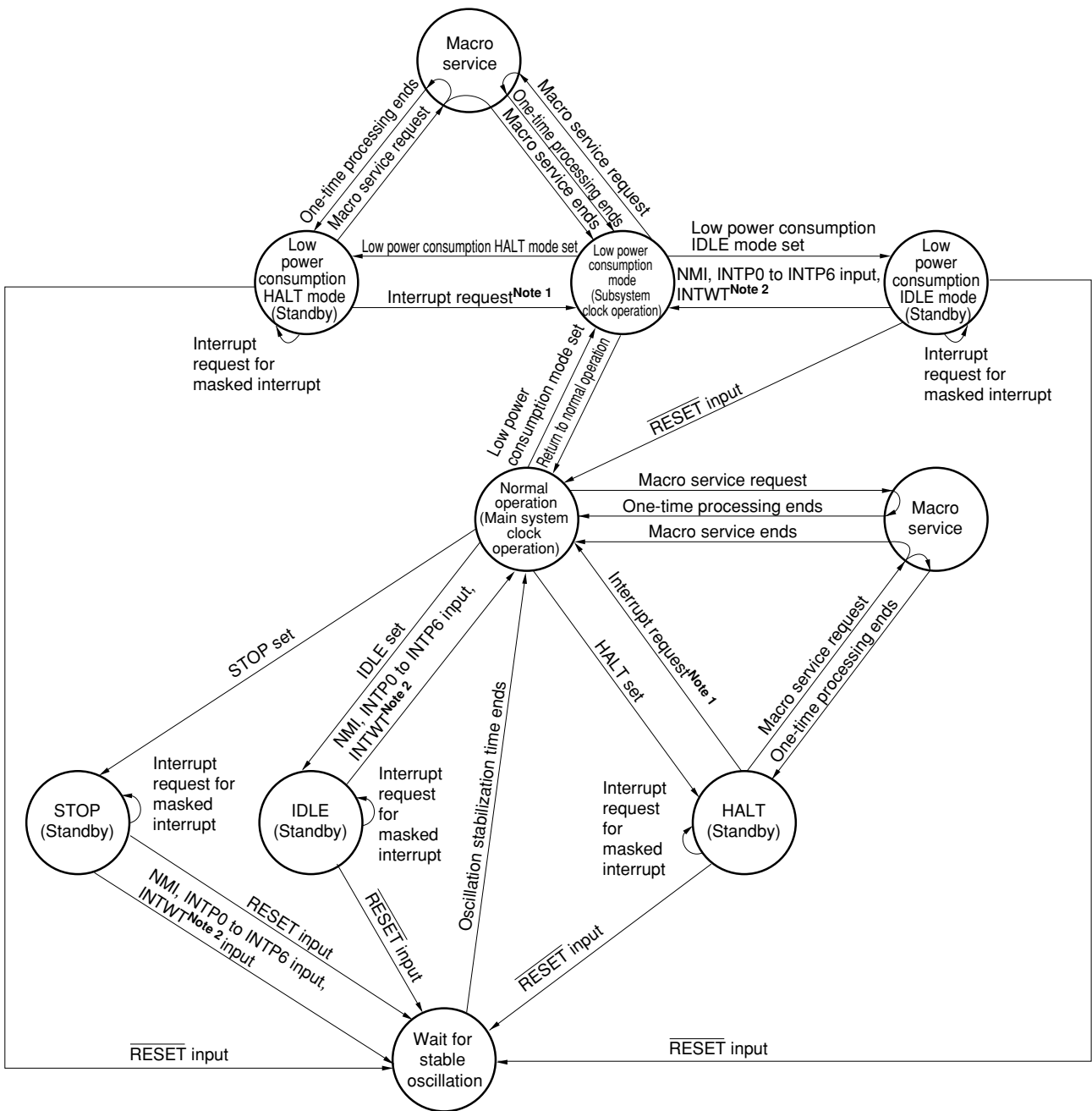
These modes are programmable.

Macro service can be started from the HALT mode and the low power consumption HALT mode. After macro service execution, the device is returned to the HALT mode.

Figure 25-1 shows the standby function state transitions.

★

Figure 25-1. Standby Function State Transitions



- Notes**
1. Only unmasked interrupt requests
 2. When INTP0 to INTP6 and watch timer interrupt (INTWT) are not masked

Remark NMI is only valid with external input. The watchdog timer cannot be used for the release of Standby (HALT mode/STOP mode/IDLE mode.)

25.2 Control Registers

(1) Standby control register (STBC)

The STBC register sets the STOP mode and selects the internal system clock.

To prevent the standby mode from accidentally being entered due to a runaway program, this register can only be written by a special instruction. This special instruction is `MOV STBC, #byte` which has a special code structure (4 bytes). This register can only be written when the third and fourth byte op codes are mutual 1's complements. If the third and fourth byte op codes are not mutual 1's complements, the register is not written and an operand error interrupt is generated. In this case, the return address that is saved on the stack is the address of the instruction that caused the error. Therefore, the address that caused the error can be determined from the return address saved on the stack.

If the `RETB` instruction is used to simply return from an operand error, an infinite loop occurs.

Since an operand error interrupt is generated only when the program runs wild (only the correct instruction is generated when `MOV STBC, #byte` is specified in RA78K4 NEC Electronics assembler), make the program initialize the system.

Other write instructions (i.e., `MOV STBC, A`; `STBC, #byte`; and `SET1 STBC.7`) are ignored and nothing happens.

In other words, STBC is not written, and an interrupt, such as an operand error interrupt, is not generated.

STBC can always be read by a data transfer instruction.

$\overline{\text{RESET}}$ input sets STBC to 30H.

Figure 25-2 shows the STBC format.

Figure 25-2. Standby Control Register (STBC) Format

Address: 0FFC0H After reset: 30H R/W

Symbol	7	6	5	4	3	2	1	0
STBC	SBK	CK2	CK1	CK0	0	MCK	STP	HLT

SBK	Oscillation control for subsystem clock
0	Oscillator operation (Use internal feedback resistors.)
1	Oscillator stop (Do not use internal feedback resistors.)

CK2	CK1	CK0	CPU clock selection
0	0	0	f _{xx}
0	0	1	f _{xx} /2
0	1	0	f _{xx} /4
0	1	1	f _{xx} /8
1	1	1	f _{XT} (recommended)
1	×	×	f _{XT}

MCK	Main system clock oscillation control
0	Oscillator operation (Use internal feedback resistors.)
1	Oscillator stop (Do not use internal feedback resistors.)

STP	HLT	Operation setting flag
0	0	Normal operating mode
0	1	HALT mode (automatically cleared when the HALT mode is released)
1	0	STOP mode (automatically cleared when the STOP mode is released)
1	1	IDLE mode (automatically cleared when the IDLE mode is released)

- Cautions**
1. If the STOP mode is used when an external clock is input, set the STOP mode after setting bit EXTC in the oscillation stabilization time specification register (OSTS) to 1. Using the STOP mode in the state where bit EXTC of OSTS is cleared while the external clock is input may destroy the μ PD784218A or reduce reliability. When the EXTC bit of OSTS is set to 1, always input at pin X2 the clock that has the inverse phase of the clock input at pin X1.
 2. Execute three NOP instructions after the standby instruction (after releasing the standby). If this is not done, when the execution of a standby instruction competes with an interrupt request, the standby instruction is not executed, and interrupts are acknowledged after executing multiple instructions that follow a standby instruction. The instruction that is executed before acknowledging the interrupt starts executing within a maximum of six clocks after the standby instruction is executed.

Example MOV STBC, #byte

NOP

NOP

NOP

:

3. When CK2 = 0, even if MCK = 1, the oscillation of the main system clock does not stop (refer to 4.5.1 Main system clock operations).

- Remarks**
1. f_{xx}: Main system clock frequency (fx or fx/2)
fx: Main system clock oscillation frequency
f_{xt}: Subsystem clock oscillation frequency
 2. x: don't care

(2) Clock status register (PCS)

PCS is a read-only 8-bit register that shows the operating state of the CPU clock. When bits 2, and 4 to 7 in PCS are read, the corresponding bits in the standby control register (STBC) can be read.

PCS is read by a 1-bit or 8-bit memory manipulation instruction.

$\overline{\text{RESET}}$ input sets PCS to 32H.

Figure 25-3. Clock Status Register (PCS) Format

Address: 0FFCEH After reset: 32H R

Symbol	7	6	5	4	3	2	1	0
PCS	SBK	CK2	CK1	CK0	0	MCK	1	CST

SBK	Feedback resistor state for subsystem clock
0	Use internal feedback resistors.
1	Do not use internal feedback resistors.

CK2	CK1	CK0	CPU clock operating frequency
0	0	0	f_{xx}
0	0	1	$f_{xx}/2$
0	1	0	$f_{xx}/4$
0	1	1	$f_{xx}/8$
1	1	1	f_{XT} (recommended)
1	×	×	f_{XT}

MCK	Main System clock oscillation control
0	Oscillator operation.
1	Oscillator stop.

CST	CPU clock state
0	Main system clock operation
1	Subsystem clock operation

Caution Bit 1 of the clock status register (PCS) of the device is fixed to 1, but is fixed to 0 in the in-circuit emulator. Keep this in mind when using the in-circuit emulator.

Remark ×: don't care

(3) Oscillation stabilization time specification register (OSTS)

The OSTS register sets the oscillator operation and the oscillation stabilization time when the STOP mode is released. Whether a crystal/ceramic resonator or an external clock will be used is set in the EXTC bit of OSTS. If only the EXTC bit is set to 1, the STOP mode can also be set when the external clock is input.

Bits OSTS0 to OSTS2 in OSTS select the oscillation stabilization time when the STOP mode is released. Generally, select an oscillation stabilization time of at least 40 ms when using a crystal resonator and at least 4 ms when using a ceramic resonator.

The time until the stabilization oscillation is affected by the crystal/ceramic resonator that is used and the capacitance of the connected capacitor. Therefore, if you want a short oscillation stabilization time, consult the manufacturer of the crystal/ceramic resonator.

OSTS is set by a 1-bit or 8-bit transfer instruction.

$\overline{\text{RESET}}$ input sets OSTS to 00H.

Figure 25-4 shows the OSTS format.

Figure 25-4. Oscillation Stabilization Time Specification Register (OSTS) Format

Address: 0FFCFH After reset: 00H R/W

Symbol	7	6	5	4	3	2	1	0
OSTS	EXTC	0	0	0	0	OSTS2	OSTS1	OSTS0

EXTC	External clock selection
0	Use crystal/ceramic oscillation
1	Use an external clock

EXTC	OSTS2	OSTS1	OSTS0	Oscillation stabilization time selection
0	0	0	0	$2^{19}/f_{xx}$ (42.0 ms)
0	0	0	1	$2^{18}/f_{xx}$ (21.0 ms)
0	0	1	0	$2^{17}/f_{xx}$ (10.5 ms)
0	0	1	1	$2^{16}/f_{xx}$ (5.3 ms)
0	1	0	0	$2^{15}/f_{xx}$ (2.6 ms)
0	1	0	1	$2^{14}/f_{xx}$ (1.3 ms)
0	1	1	0	$2^{13}/f_{xx}$ (0.7 ms)
0	1	1	1	$2^{12}/f_{xx}$ (0.4 ms)
1	×	×	×	$512/f_{xx}$ (41.0 μ s)

- Cautions**
1. When using crystal/ceramic oscillation, always clear the EXTC bit to 0. When the EXTC bit is set to 1, oscillation stops.
 2. If the STOP mode is used when an external clock is input, always set the EXTC bit to 1 and then set the STOP mode. Using the STOP mode in the state where the EXTC bit is cleared while the external clock is input may destroy the μ PD784218A or reduce reliability.
 3. When the EXTC bit is set to 1 when an external clock is input, input to pin X2 a clock that has the inverse phase of the clock input to pin X1. If the EXTC bit is set to 1, the μ PD784218A only operates with the clock that is input to the X2 pin.

- Remarks**
1. Figures in parentheses apply to operation with $f_{xx} = 12.5$ MHz.
 2. ×: don't care

25.3 HALT Mode

25.3.1 Settings and operating states of HALT mode

The HALT mode is set by setting the HLT bit in standby control register (STBC) to 1.

STBC can be written in with 8-bit data by a special instruction. Therefore, the HALT mode is specified by the MOV STBC, #byte instruction.

When enable interrupts is set (IE flag in PSW is set to 1), specify three NOP instructions after the HALT mode setting instruction (after the HALT mode is released). If this is not done, after the HALT mode is released, multiple instructions may execute before interrupts are acknowledged. Unfortunately, the order relationship between the interrupt process and instruction execution changes. Since problems caused by the changes in the execution order are prevented, the measures described earlier are required.

The system clock when setting can be set to either the main system clock or the subsystem clock.

The operating states in the HALT mode are described next.

Table 25-2. Operating States in HALT Mode

HALT Mode Setting		HALT Mode Setting During Main System Clock Operation		HALT Mode Setting During Subsystem Clock Operation	
		No Subsystem Clock Note 1	Subsystem Clock Note 2	When the Main System Clock Continues Oscillating	When the Main System Clock Stops Oscillating
Item					
Clock oscillator		Both the main system clock and subsystem clock can oscillate. The clock supply to the CPU stops.			
CPU		Operation disabled			
Port (output latch)		Holds the state before the HALT mode is set.			
16-bit timer/counter		Operation enabled			Operation enabled when the watch timer output is selected as the count clock (Select f_{XT} as the count clock of the watch timer.)
8-bit timer/counters 1, 2		Operation enabled			Operation enabled when TI1 and TI2 are selected as the count clocks
8-bit timer/counters 5, 6		Operation enabled			Operation enabled when TI5 and TI6 are selected as the count clocks
8-bit timer/counters 7, 8		Operation enabled			Operation enabled when TI7 and TI8 are selected as the count clocks
Watch timer		Operation enabled when $f_{XX}/2^7$ is selected as the count clock	Operation enabled		Operation enabled when f_{XT} is selected as the count clock
Watchdog timer		Operation disabled (initializing counter)			
A/D converter		Operation enabled			Operation disabled
D/A converter		Operation enabled			
Real-time output port		Operation enabled			
Serial interface		Operation enabled			Operation enabled during an external SCK.
External interrupt	INTP0 to INTP6	Operation enabled			
Key return interrupt	P80 to P87	Operation enabled			
Bus lines during external expansion	AD0 to AD7	High impedance			
	A0 to A19	Holds the state before the HALT mode is set			
	ASTB	Low level			
	\overline{WR} , \overline{RD}	High level			
	\overline{WAIT}	Holds input status			
	EXA	Holds the state before the HALT mode is set			

- Notes**
1. This includes not supplying the external clock.
 2. This includes supplying the external clock.

25.3.2 Releasing HALT mode

The HALT mode can be released by the following three sources.

- NMI pin input
- Maskable interrupt request (vectored interrupt, context switching, macro service)
- $\overline{\text{RESET}}$ input

Table 25-3 lists the release source and describes the operation after release.

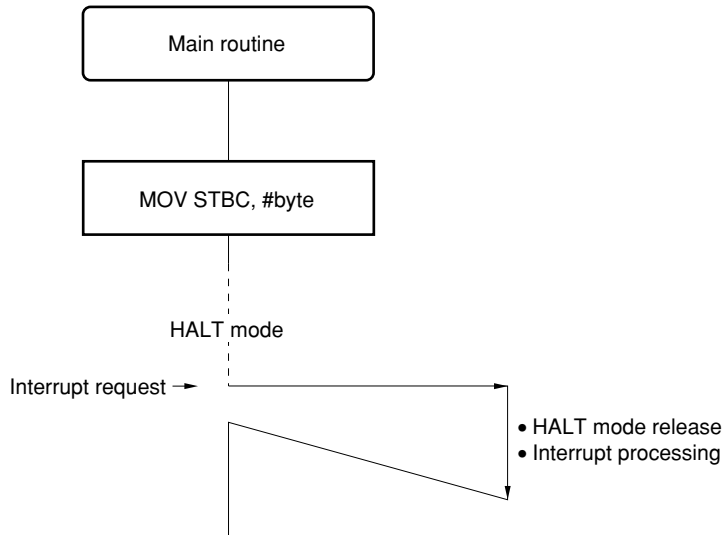
Table 25-3. Releasing HALT Mode and Operation After Release

Release Source	Mk ^{Note 1}	IE ^{Note 2}	State During Release	Operation After Release
RESET input	x	x	–	Normal reset operation
NMI pin input	x	x	<ul style="list-style-type: none"> • Not executing a non-maskable interrupt service program • Executing a low-priority non-maskable interrupt service program 	Acknowledges interrupt requests
			<ul style="list-style-type: none"> • Executing the service program for the NMI pin input • Executing a high-priority non-maskable interrupt service program 	The instruction following the MOV STBC, #byte instruction is executed. (The interrupt request that released the HALT mode is held ^{Note 3} .)
Maskable interrupt request (except for a macro service request)	0	1	<ul style="list-style-type: none"> • Not executing an interrupt service program • Executing a low-priority maskable interrupt service program • The PRSL bit^{Note 4} is cleared to 0 while executing an interrupt service program at priority level 3. 	Acknowledges interrupt requests
			<ul style="list-style-type: none"> • Executing a maskable interrupt service program with the same priority (This excludes executing an interrupt service program in priority level 3 when the PRSL bit^{Note 4} is cleared to 0.) • Executing a high-priority interrupt service program 	The instruction following the MOV STBC, #byte instruction is executed. (The interrupt request that released the HALT mode is held ^{Note 3} .)
	0	0	–	
	1	x	–	Holds the HALT mode
Macro service request	0	x	–	Macro service process execution End condition is not satisfied → HALT mode end condition is satisfied again → When VCIE ^{Note 5} = 1: HALT mode again When VCIE ^{Note 5} = 0: Same as a release by the maskable interrupt request
	1	x	–	Holds the HALT mode

- Notes**
1. Interrupt mask bit in each interrupt request source
 2. Interrupt enable flag in the program status word (PSW)
 3. The held interrupt request is acknowledged when acknowledgement is enabled.
 4. Bit in the interrupt mode control register (IMC)
 5. Bit in the macro service mode register of the macro service control word that is in each macro service request source

Figure 25-5. Operation After HALT Mode Release (1/4)

(1) Interrupt after HALT mode



(2) Reset after HALT mode

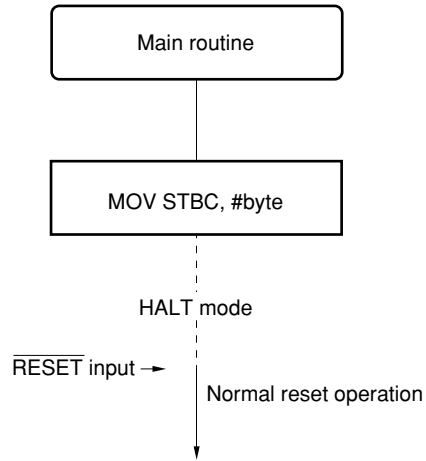
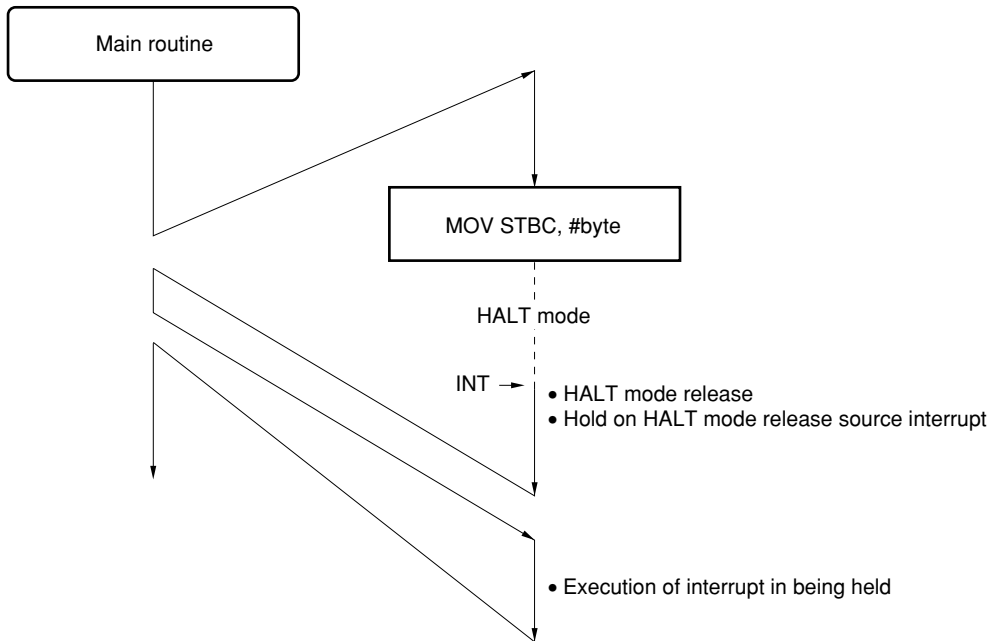


Figure 25-5. Operation After HALT Mode Release (2/4)

(3) HALT mode during interrupt processing routine whose priority is higher than or equal to release source interrupt



(4) HALT mode during interrupt processing routine whose priority is lower than release source interrupt

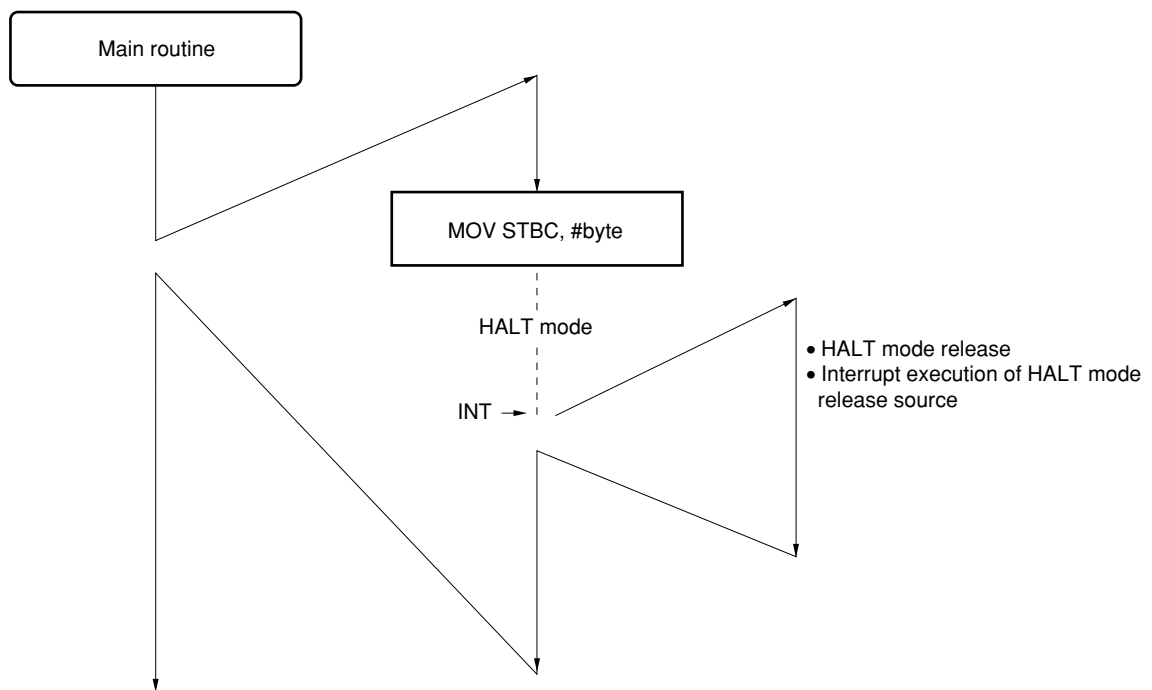
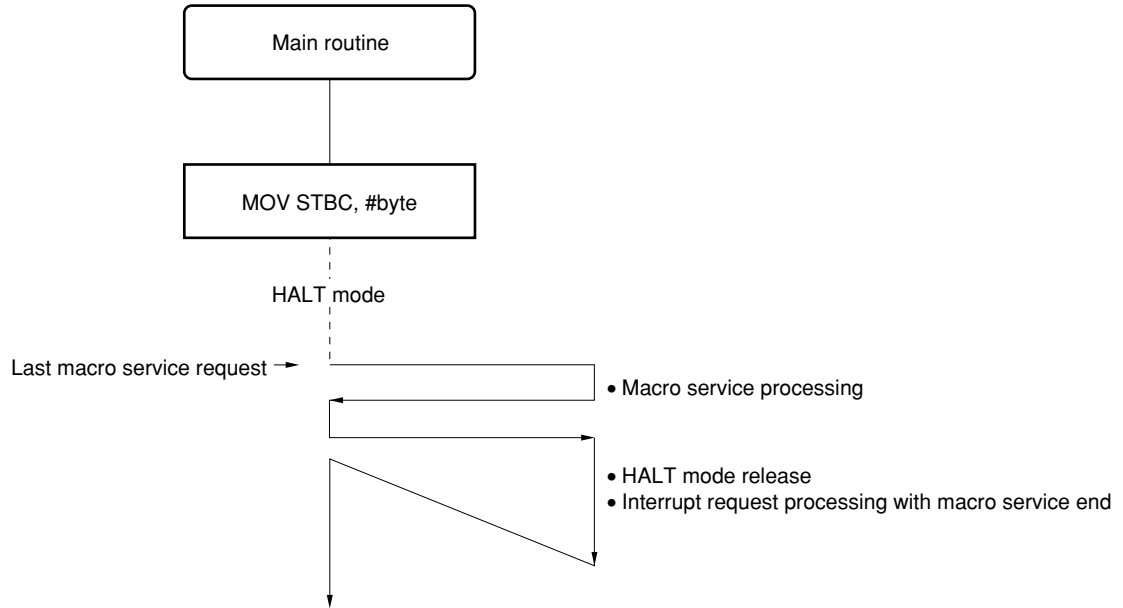


Figure 25-5. Operation After HALT Mode Release (3/4)

(5) Macro service request during HALT mode

(a) Immediately after macro service end condition is satisfied, interrupt request is issued. (VCIE = 0)



(b) Macro service end condition is not satisfied, or after macro service end condition is satisfied, interrupt request is not issued. (VCIE = 1)

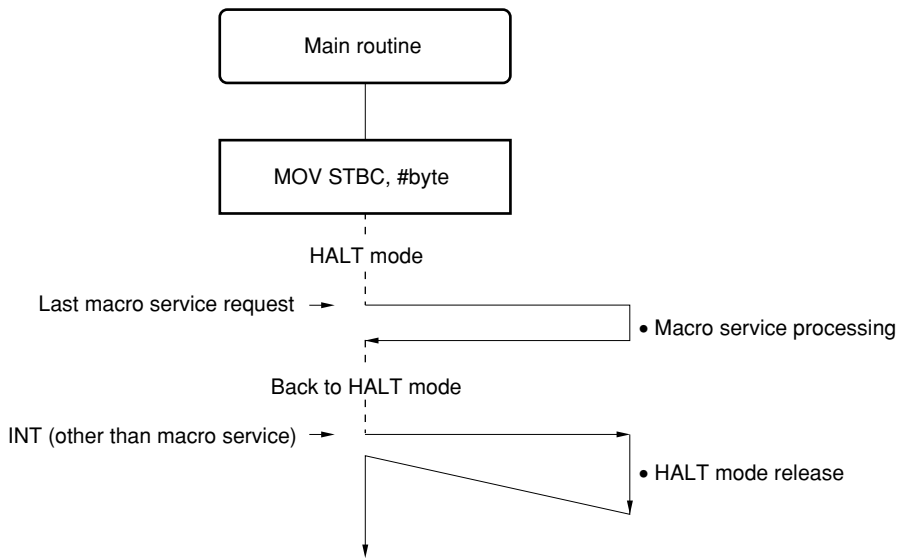
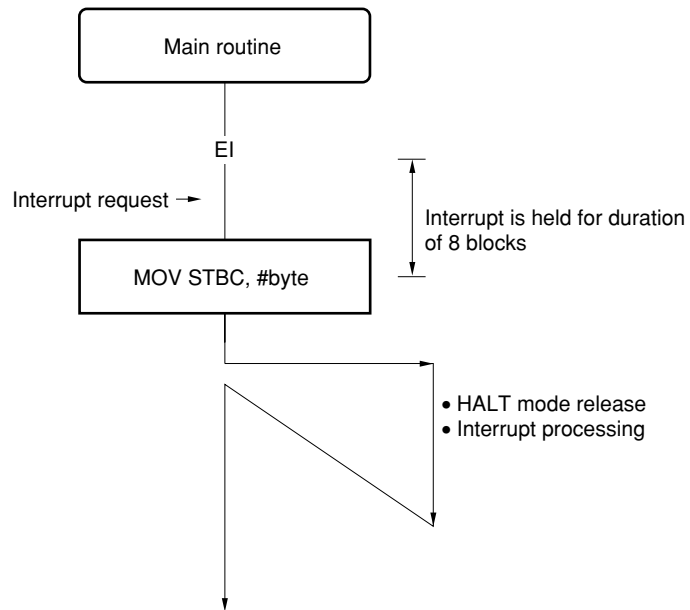
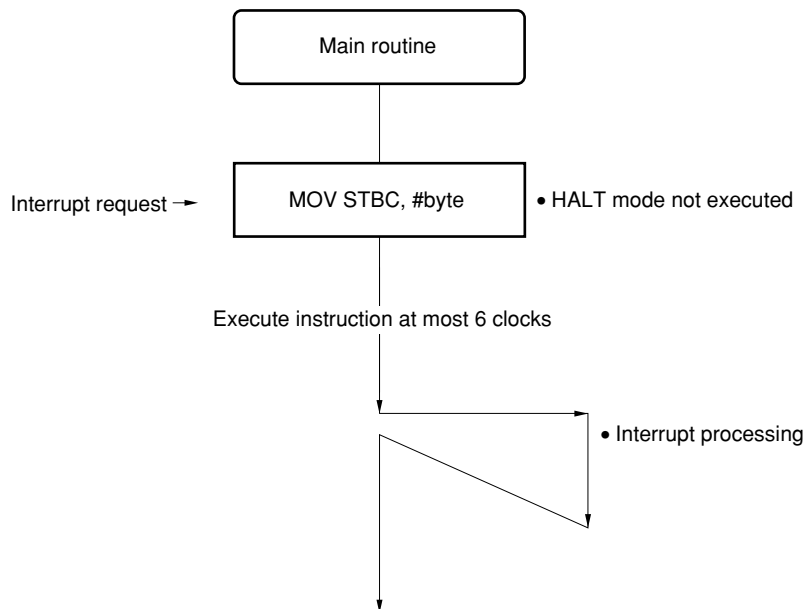


Figure 25-5. Operation After HALT Mode Release (4/4)

- (6) HALT mode which the interrupt is held, which is enabled in an instruction that interrupt requests are temporarily held.



- (7) Contention between HALT instruction and interrupt



(1) Released by NMI pin input

When a non-maskable interrupt is generated by NMI pin input, the HALT mode is released regardless of the enable state (EI) and disable state (DI) for interrupt acknowledgement.

If the non-maskable interrupt that released the HALT mode by NMI pin input can be acknowledged when released from the HALT mode, and execution branches to the NMI interrupt service program. If it cannot be acknowledged, the instruction following the instruction that set the HALT mode (MOV STBC, #byte instruction) is executed. The non-maskable interrupt that released the HALT mode is acknowledged when acceptance is possible. For details about non-maskable interrupts acknowledgement, refer to **23.6 Non-Maskable Interrupt Acknowledge**.

Caution The HALT mode cannot be released by watchdog timer.

(2) Released by a maskable interrupt request

The HALT mode released by a maskable interrupt request can only be released by an interrupt where the interrupt mask flag is 0.

If an interrupt can be acknowledged when the HALT mode is released and the interrupt request enable flag (IE) is set to 1, execution branches to the interrupt service program. If the IE flag is cleared to 0 when acknowledgement is not possible, execution restarts from the next instruction that sets the HALT mode. For details about interrupt acknowledgement, refer to **23.7 Maskable Interrupt Acknowledge**.

A macro service temporarily releases the HALT mode, performs the one-time processing, and returns again to the HALT mode. If the macro service is only specified several times, the HALT mode is released when the VCIE bit in the macro service mode register in the macro service control word is cleared to 0.

The operation after this release is identical to the release by the maskable interrupt described earlier. Also when the VCIE bit is set to 1, the HALT mode is entered again, and the HALT mode is released by the next interrupt request.

Table 25-4. Releasing HALT Mode by Maskable Interrupt Request

Release Source	MK ^{Note 1}	IE ^{Note 2}	State During Release	Operation After Release
Maskable interrupt request (except for a macro service request)	0	1	<ul style="list-style-type: none"> Not executing an interrupt service program Executing a low-priority maskable interrupt service program The PRSL bit^{Note 4} is cleared to 0 while executing an interrupt service program at priority level 3. 	Acknowledges interrupt requests
			<ul style="list-style-type: none"> Executing a maskable interrupt service program with the same priority (This excludes executing an interrupt service program in priority level 3 when the PRSL bit^{Note 4} is cleared to 0.) Executing a high-priority interrupt service program 	The instruction following the MOV STBC, #byte instruction is executed. (The interrupt request that released the HALT mode is held ^{Note 3} .)
	0	0	–	
	1	×	–	Holds the HALT mode
Macro service request	0	×	–	Macro service process execution End condition is not satisfied → HALT mode end condition is satisfied again → When VCIE ^{Note 5} = 1: HALT mode again When VCIE ^{Note 5} = 0: Same as a release by a maskable interrupt request
	1	×	–	Holds the HALT mode

- Notes**
1. Interrupt mask bit in each interrupt request source
 2. Interrupt enable flag in the program status word (PSW)
 3. The held interrupt request is acknowledged when acknowledgement is possible.
 4. Bit in the interrupt mode control register (IMC)
 5. Bit in the macro service mode register of the macro service control word that is in each macro service request source

(3) Released by $\overline{\text{RESET}}$ input

After branching to the reset vector address as in a normal reset, the program executes. However, the contents of the internal RAM hold the value before the HALT mode was set.

25.4 STOP Mode

25.4.1 Settings and operating states of STOP mode

The STOP mode is set by setting the STP bit in the standby control register (STBC) to 1.

STBC can be written with 8-bit data by a special instruction. Therefore, the STOP mode is set by the MOV STBC, #byte instruction.

When enable interrupt is set (IE flag in PSW is set to 1), specify three NOP instructions after the STOP mode setting instruction (after the STOP mode is released). If this is not done, after the STOP mode is released, multiple instructions can be executed before interrupts are acknowledged. Unfortunately, the order relationship between the interrupt process and instruction execution changes. Since the problems caused by changes in the execution order are prevented, the measures described earlier are required.

The system clock during setting can only be set to the main system clock.

Caution Since an interrupt request signal is used when releasing the standby mode, when there is an interrupt source that sets the interrupt request flag or resets the interrupt mask flag, even though the standby mode is entered, it is immediately released. When the STOP mode setting instruction conflicts with the setting of an unmasked interrupt request flag or a non-maskable interrupt request, either of following two statuses are entered.

(1) Status in which STOP mode is set once, and then released

(2) Status in which STOP mode is not set

The oscillation stabilization time after releasing STOP mode is inserted only for the status in which STOP mode is set once and then released.

Next, the operating states during the STOP mode are described.

Table 25-5. Operating States in STOP Mode

STOP Mode Setting		When There Is a Subsystem Clock	When There Is no Subsystem Clock
Item			
Clock generator		Only main system clock stops oscillating.	
CPU		Operation disabled	
Port (output latch)		Holds the state before the STOP mode was set.	
16-bit timer/event counter		Operation enabled when the watch timer output is selected as the count clock (Select f_{XT} as the count clock of the watch timer)	Operation disabled
8-bit timer/counters 1, 2		Operation enabled only when T11 and T12 are selected as the count clocks	
8-bit timer/counters 5, 6		Operation enabled only when T15 and T16 are selected as the count clocks	
8-bit timer/counters 7, 8		Operation enabled only when T17 and T18 are selected as the count clocks	
Watch timer		Operation enabled only when f_{XT} is selected as the count clock	Operation disabled
Watchdog timer		Operation disabled (initializing counter)	
A/D converter		Operation disabled	
D/A converter		Operation enabled	
Real-time output port		Operation enabled when an external trigger is used or T11 and T12 are selected as the count clocks of the 8-bit timer/counters 1 and 2	
Serial interface	Other than I ² C bus mode	Operation enabled only when an external input clock is selected as the serial clock	
	I ² C bus mode	Operation disabled	
External interrupt	INTP0 to INTP6	Operation enabled	
Key return interrupt	P80 to P87	Operation enabled	
Bus lines during external expansion	AD0 to AD7	High impedance	
	A0 to A7	Outputs C0H	
	A8 to A19	High impedance	
	ASTB	High impedance	
	\overline{WR} , \overline{RD}	High impedance	
	\overline{WAIT}	Holds input status	
	EXA	High impedance	

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Caution In the STOP mode, only external interrupts (INTP0 to INTP6), watch timer interrupt (INTWT), and key return interrupts (P80 to P87) can release the STOP mode and be acknowledged as interrupt requests. All other interrupt requests are pended, and acknowledged after the STOP mode has been released through NMI input, INTP0 to INTP6 input, INTWT, or key return interrupt.

25.4.2 Releasing STOP mode

The STOP mode is released by NMI input, INTP0 to INTP6 input, watch timer interrupt (INTWT), key return interrupt, or $\overline{\text{RESET}}$ input.

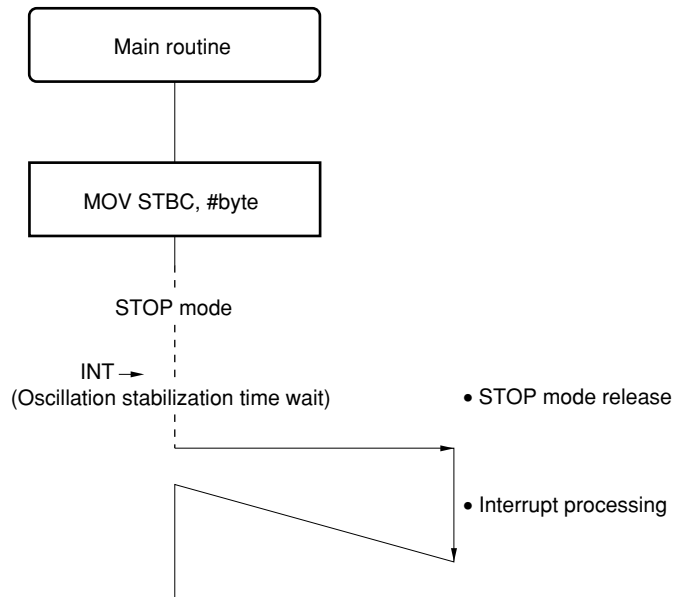
Table 25-6. Releasing STOP Mode and Operation After Release

Release Source	MK ^{Note 1}	ISM ^{Note 2}	IE ^{Note 3}	State During Release	Operation After Release		
$\overline{\text{RESET}}$ input	×	×	×	–	Normal reset operation		
NMI pin input	×	×	×	<ul style="list-style-type: none"> Not executing a non-maskable interrupt service program Executing a low-priority non-maskable interrupt service program 	Acknowledges interrupt requests		
				<ul style="list-style-type: none"> Executing the service program for the NMI pin input Executing a high-priority non-maskable interrupt service program 	The instruction following the MOV STBC, #byte instruction is executed. (The interrupt request that released the STOP mode is held ^{Note 4} .)		
INTP0 to INTP6 pin input, watch timer interrupt ^{Note 6} , key return interrupt	0	0	1	<ul style="list-style-type: none"> Not executing an interrupt service program Executing a low-priority maskable interrupt service program The PRSL bit^{Note 5} is cleared to 0 while an interrupt service program at priority level 3 is executing. 	Acknowledges interrupt requests		
				<ul style="list-style-type: none"> Executing a maskable interrupt service program with the same priority (This excludes executing an interrupt service program in priority level 3 when the PRSL bit^{Note 5} is cleared to 0.) Executing a high-priority interrupt service program 	The instruction following the MOV STBC, #byte instruction is executed. (The interrupt request that released the STOP mode is held ^{Note 4} .)		
			0	0	0	–	
			1	0	×	–	Holds the STOP mode
	×	1	×				

- Notes**
1. Interrupt mask bit in each interrupt request source
 2. Macro service enable flag that is in each interrupt request source
 3. Interrupt enable flag in the program status word (PSW)
 4. The held interrupt request is acknowledged when acknowledgement is possible.
 5. Bit in the interrupt mode control register (IMC)
 6. The STOP mode is released only when the subsystem clock is selected as the count clock. It is not released when the main system clock is selected.

Figure 25-6. Operation After STOP Mode Release (1/3)

(1) Interrupt after STOP mode



(2) Reset after STOP mode

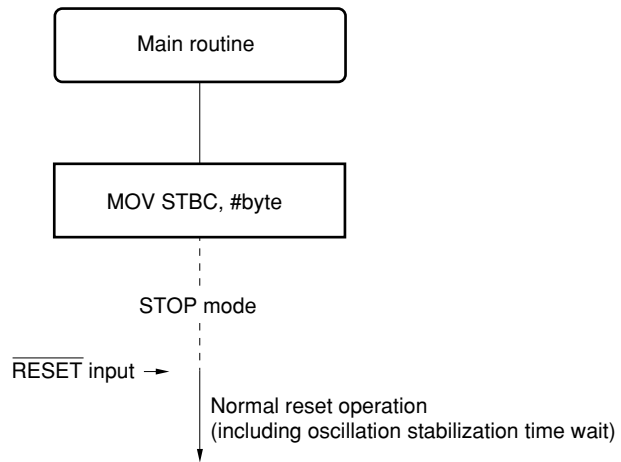
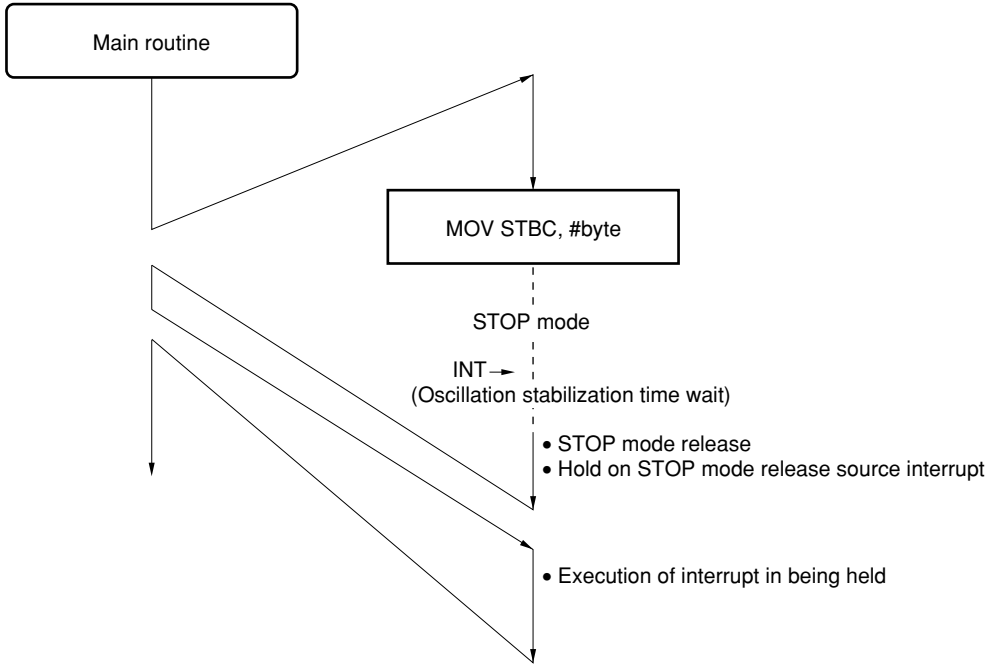


Figure 25-6. Operation After STOP Mode Release (2/3)

(3) STOP mode during interrupt processing routine whose priority is higher than or equal to release source interrupt



(4) STOP mode during interrupt processing routine whose priority is lower than release source interrupt

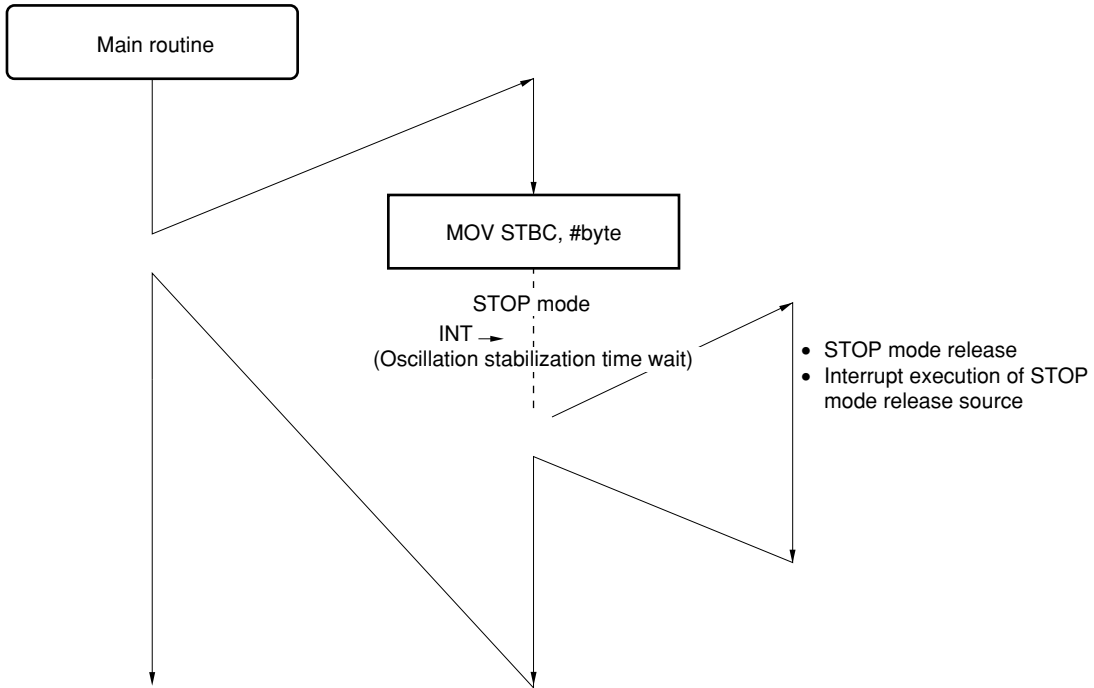
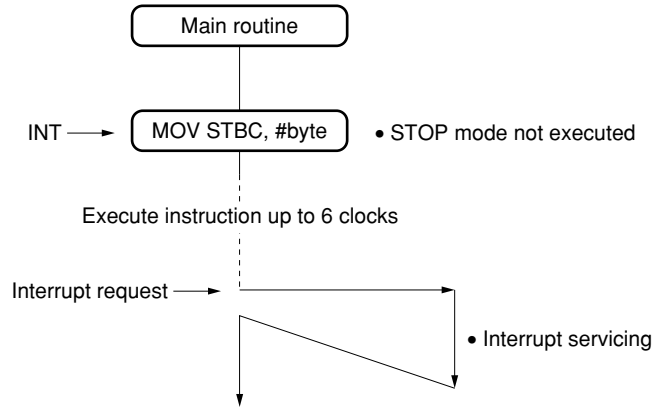


Figure 25-6. Operation After STOP Mode Release (3/3)

(5) Contention between STOP mode setting instruction and interrupt



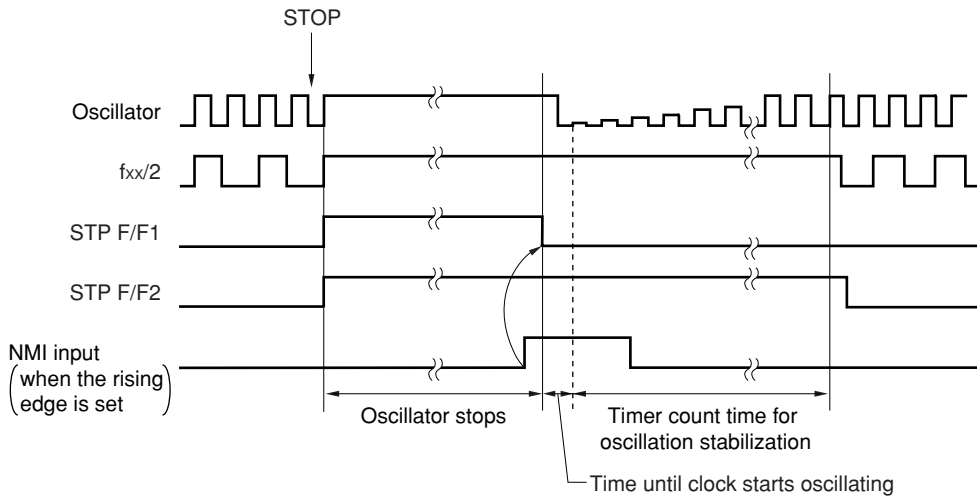
(1) Releasing the STOP mode by NMI input

When the valid edge specified in the external interrupt edge enable registers (EGP0, EGN0) is input by the NMI input, the oscillator starts oscillating again. Then the STOP mode is released after the oscillation stabilization time set in the oscillation stabilization time specification register (OSTS) elapses.

When the STOP mode is released and non-maskable interrupts from the NMI pin input can be acknowledged, execution branches to the NMI interrupt service program. If acknowledgement is not possible (such as when set in the STOP mode in the NMI interrupt service program), execution starts again from the instruction following the instruction that set the STOP mode. When acknowledgement is enabled, execution branches to the NMI interrupt service program (by executing the RETI instruction).

For details about NMI interrupt acknowledgement, refer to **23.6 Non-Maskable Interrupt Acknowledge**.

Figure 25-7. Releasing STOP Mode by NMI Input



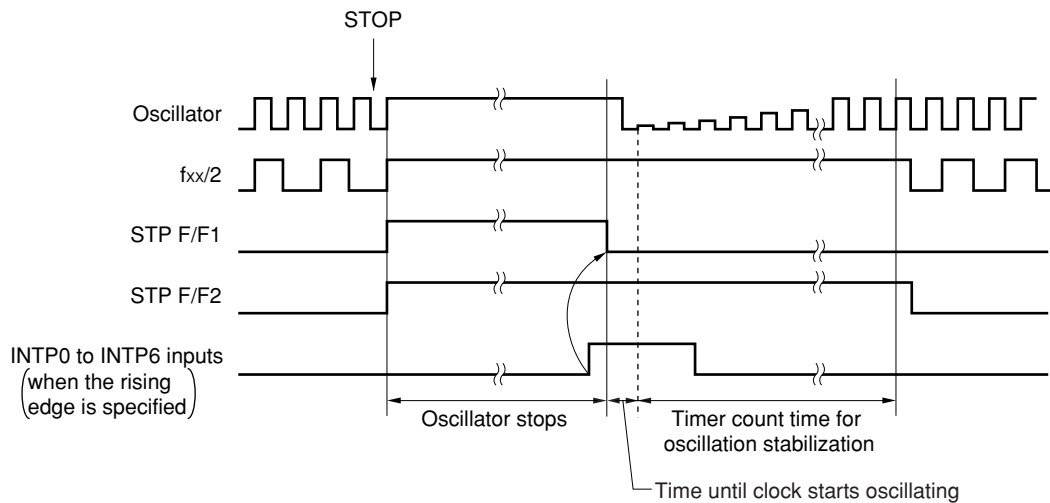
(2) Releasing the STOP mode by INTP0 to INTP6 input, watch timer interrupt, and key return interrupt

If interrupt masking is released through INTP0 to INTP6 input and macro service is disabled, the oscillator restarts oscillating when a valid edge specified in the external interrupt edge enable registers (EGP0, EGN0) is input to INTP0 to INTP6. If the mask of watch timer interrupt is released and macro service is disabled, an overflow of watch timer occurs and STOP mode is released. If key return interrupt masking is released and macro service is disabled, the oscillator restarts oscillating when a falling edge is input to the port 8 pins (P80 to P87). Then the STOP mode is released after the oscillation stabilization time specified in the oscillation stabilization time specification register (OSTS) elapses.

If interrupts can be acknowledged when released from the STOP mode and the interrupt enable flag (IE) is set to 1, execution branches to the interrupt service program. If the IE flag is cleared to 0 when acknowledgement is not possible, execution starts again from the instruction following the instruction that set the STOP mode.

For details on interrupt acknowledgement, refer to **23.7 Maskable Interrupt Acknowledge**.

Figure 25-8. Example of Releasing STOP Mode by INTP0 to INTP6 Inputs

**(3) Releasing the STOP mode by RESET input**

- ★ When $\overline{\text{RESET}}$ input rises from low to high and the reset is released, the oscillator starts oscillating. The oscillation stops for the $\overline{\text{RESET}}$ active period. After the oscillation stabilization time has elapsed, normal operation starts. The difference from the normal reset operation is the data memory saves the contents before setting the STOP mode.

25.5 IDLE Mode

25.5.1 Settings and operating states of IDLE mode

The IDLE mode is set by setting both bits STP and HLT in the standby control register (STBC) to 1.

STBC can only be written with 8-bit data by using a special instruction. Therefore, the IDLE mode is set by the MOV STBC, #byte instruction.

When enable interrupts is set (the IE flag in PSW is set to 1), specify three NOP instructions after the IDLE mode setting instruction (after the IDLE mode is released). If this is not done, after the IDLE mode is released, multiple instructions can be executed before interrupts are acknowledged. Unfortunately, the order relationship between the interrupt processing and the instruction execution changes. To prevent the problems caused by the change in the execution order, the measures described earlier are required.

The system clock when setting can be set to either the main system clock or the subsystem clock.

The operating states in the IDLE mode are described next.

Table 25-7. Operating States in IDLE Mode

IDLE Mode Setting		When There Is a Subsystem Clock	When There Is Not a Subsystem Clock
Item			
Clock generator		The oscillator in both the main system clock and subsystem clock continue operating. The clock supply to both the CPU and peripherals is stopped.	
CPU		Operation disabled	
Port (output latch)		Holds the state before the IDLE mode is set	
16-bit timer/counter		Operation enabled when the watch timer output is selected as the count clock (Select f_{XT} as the count clock of the watch timer.)	Operation disabled
8-bit timer/counters 1, 2		Operation enabled only when T11 and T12 are selected as the count clocks	
8-bit timer/counters 5, 6		Operation enabled only when T15 and T16 are selected as the count clocks	
8-bit timer/counters 7, 8		Operation enabled only when T17 and T18 are selected as the count clocks	
Watch timer		Operation enabled only when f_{XT} is selected as the count clock	Operation disabled
Watchdog timer		Operation disabled	
A/D converter		Operation disabled	
D/A converter		Operation enabled	
Real-time output port		Operation enabled when an external trigger is used or T11 and T12 are selected as the count clocks of the 8-bit timer/counters 1 and 2	
Serial interface	Other than I ² C bus mode	Operation enabled only when an external input clock is selected as the serial clock	
	I ² C bus mode	Operation disabled	
External interrupt	INTP0 to INTP6	Operation enabled	
Key return interrupt	P80 to P87	Operation enabled	
Bus lines during external expansion	AD0 to AD7	High impedance	
	A0 to A7	Outputs C0H	
	A8 to A19	High impedance	
	ASTB	High impedance	
	\overline{WR} , \overline{RD}	High impedance	
	\overline{WAIT}	Holds input status	
	EXA	High impedance	

Caution In the IDLE mode, only external interrupts (INTP0 to INTP6), watch timer interrupt (INTWT), and key return interrupts (P80 to P87) can release the IDLE mode and be acknowledged as interrupt requests. All other interrupt requests are pended, and acknowledged after the IDLE mode has been released through NMI input, INTP0 to INTP6 input, INTWT, or key return interrupt.

25.5.2 Releasing IDLE mode

The IDLE mode is released by NMI input, INTP0 to INTP6 input, watch timer interrupt (INTWT), key return interrupt, or $\overline{\text{RESET}}$ input.

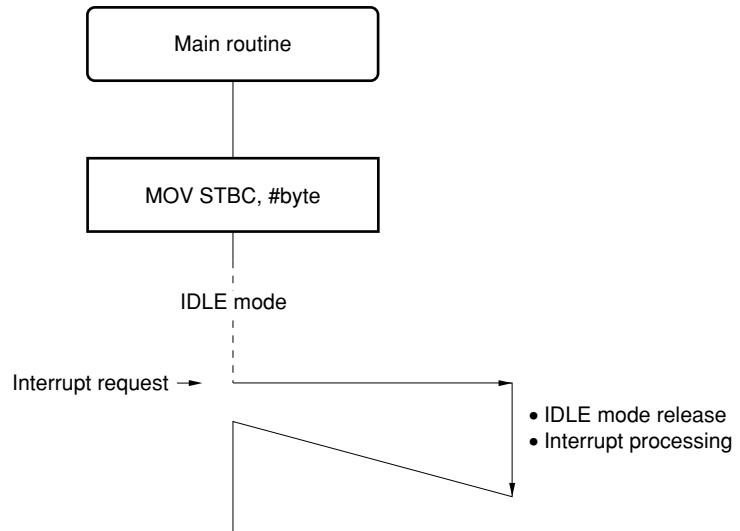
Table 25-8. Releasing IDLE Mode and Operation After Release

Release Source	MK ^{Note 1}	ISM ^{Note 2}	IE ^{Note 3}	State During Release	Operation After Release
$\overline{\text{RESET}}$ input	x	x	x	–	Normal reset operation
NMI pin input	x	x	x	<ul style="list-style-type: none"> Not executing a non-maskable interrupt service program Executing a low-priority non-maskable interrupt service program 	Acknowledges interrupt requests
				<ul style="list-style-type: none"> Executing the service program for the NMI pin input Executing a high-priority non-maskable interrupt service program 	Executes the instruction following the MOV STBC, #byte instruction (The interrupt request that released the IDLE mode is held ^{Note 4.})
INTP0 to INTP6 pin input, watch timer interrupt ^{Note 6} , key return interrupt	0	0	1	<ul style="list-style-type: none"> Not executing an interrupt service program Executing a low-priority maskable interrupt service program The PRSL bit^{Note 5} is cleared to 0 while executing an interrupt service program at priority level 3. 	Acknowledges interrupt requests
				<ul style="list-style-type: none"> Executing the maskable interrupt service program with the same priority (This excludes executing an interrupt service program in priority level 3 when the PRSL bit^{Note 5} is cleared to 0.) Executing a high-priority interrupt service program 	Execute the instruction following the MOV STBC, #byte instruction. (The interrupt request that released the IDLE mode is held ^{Note 4.})
				–	
				–	Holds the IDLE mode
	0	0	0	–	
	1	0	x	–	
	x	1	x	–	

- Notes**
1. Interrupt mask bit in each interrupt request source
 2. Macro service enable flag that is in each interrupt request source
 3. Interrupt enable flag in the program status word (PSW)
 4. The held interrupt request is acknowledged when acknowledgement is possible.
 5. Bit in the interrupt mode control register (IMC)
 6. The IDLE mode is released only when the subsystem clock is selected as the count clock. It is not released when the main system clock is selected.

Figure 25-9. Operation After IDLE Mode Release (1/3)

(1) Interrupt after IDLE mode



(2) Reset after IDLE mode

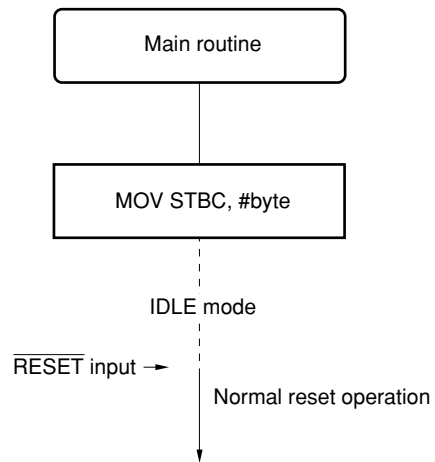
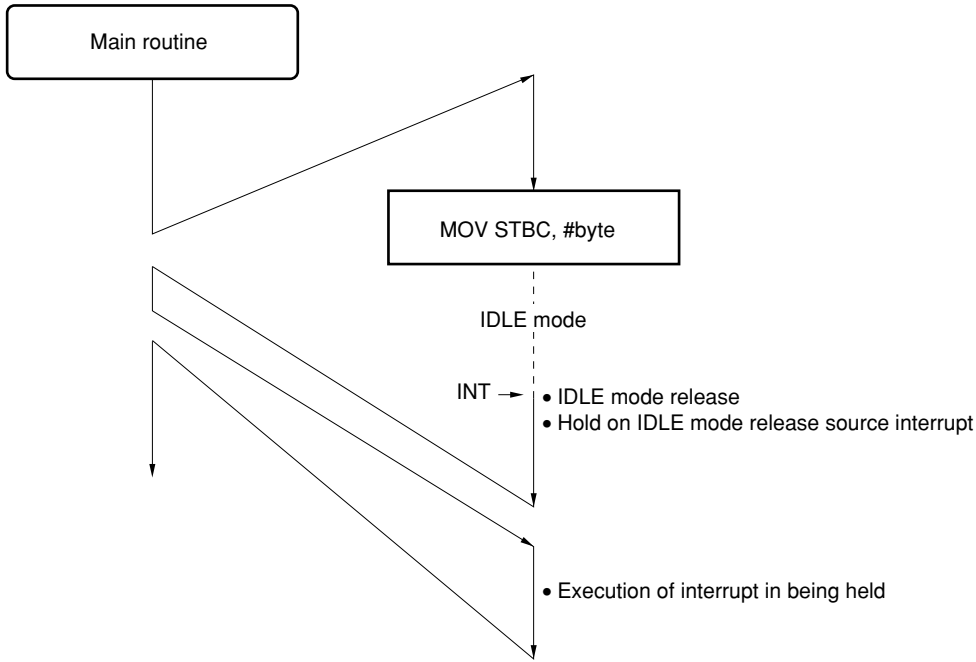


Figure 25-9. Operation After IDLE Mode Release (2/3)

(3) IDLE mode during interrupt processing routine whose priority is higher than or equal to release source interrupt



(4) IDLE mode during interrupt processing routine whose priority is lower than release source interrupt

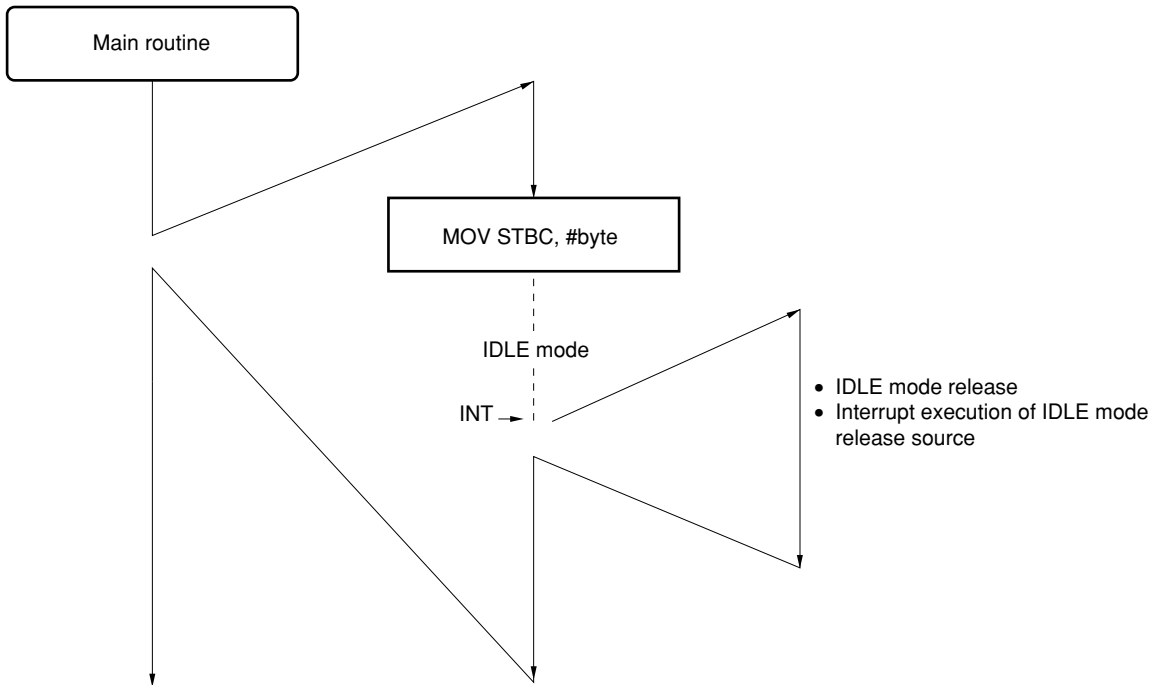
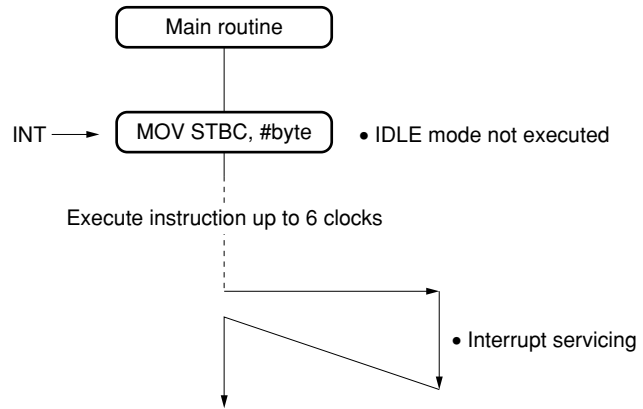


Figure 25-9. Operation After IDLE Mode Release (3/3)

(5) Contention between IDLE mode setting instruction and interrupt



(1) Releasing the IDLE mode by NMI input

When the valid edge specified in the external interrupt edge enable registers (EGP0, EGN0) is input by the NMI input, the IDLE mode is released.

When the IDLE mode is released and the non-maskable interrupt from the NMI pin input can be acknowledged, execution branches to the NMI interrupt service program. If acknowledgement is not possible (such as when set in the IDLE mode in the NMI interrupt service program), execution starts again from the instruction following the instruction that set the IDLE mode. When acknowledgement is enabled, execution branches to the NMI interrupt service program (by executing the RETI instruction).

For details about NMI interrupt acknowledgement, refer to **23.6 Non-Maskable Interrupt Acknowledge**.

(2) Releasing the IDLE mode by INTP0 to INTP6 input, watch timer interrupt and key return interrupt

If interrupt masking by INTP0 to INTP6 input is released and macro service is disabled and the valid edge specified with the external interrupt edge enable register (EGP0, EGN0) is input to INTP0 to INTP6, the IDLE mode is released. If the mask of watch timer interrupt is released and macro service is disabled, an overflow of watch timer occurs and IDLE mode is released. If key return interrupt masking is released and macro service is disabled, and a falling edge is input to port 8 (P80 to P87), the IDLE mode is released.

If interrupts can be acknowledged when released from the IDLE mode and the interrupt enable flag (IE) is set to 1, execution branches to the interrupt service program. If the IE flag is cleared to 0 when acknowledgement is not possible, execution starts again from the instruction following the instruction that set the IDLE mode.

For details on interrupt acknowledgement, refer to **23.7 Maskable Interrupt Acknowledge**.

★ (3) Releasing the IDLE mode by $\overline{\text{RESET}}$ input

When $\overline{\text{RESET}}$ input rises from low to high and the reset is released, the oscillator starts oscillating. The oscillation stops for the $\overline{\text{RESET}}$ active period. After the oscillation stabilization time has elapsed, normal operation starts. The difference from the normal reset operation is the data memory saves the contents before setting the IDLE mode.

25.6 Check Items When Using STOP or IDLE Mode

The checks required to decrease the current consumption when using the STOP mode or IDLE mode are described below.

(1) Is the output level of each output pin appropriate?

The appropriate output level of each pin differs with the circuit in the next stage. Select the output level so that the current consumption is minimized.

- If a high level is output when the input impedance of the circuit in the next stage is low, current flows from the power source to the port, and the current consumption increases. This occurs when the circuit in the next stage is, for example, a CMOS IC. When the power supply is turned off, the input impedance of a CMOS IC becomes low. To suppress the current consumption and not negatively affect the reliability of the CMOS IC, output a low level. If a high level is output, latch-up results when the power supply is applied again.
- Depending on the circuit in the next stage, the current consumption sometimes increases when a low level is input. In this case, output a high level or high impedance to eliminate the current consumption.
- When the circuit in the next stage is a CMOS IC, if the output is high impedance when power is supplied to the CMOS IC, the current consumption of the CMOS IC sometimes increases (in this case, the CMOS IC overheats and is sometimes destroyed). In this case, output a suitable level or pull-up or pull-down resistors.

The setting method for the output level differs with the port mode.

- Since the output level is determined by the state of the internal hardware when the port is in the control mode, the output level must be set while considering the state of the internal hardware.
- The output level can be set by writing to the output latch of the port and the port mode register by the software when in the port mode.

When the port enters the control mode, the output level setting is simplified by switching to the port mode.

(2) Is the input level to each input pin appropriate?

Set the voltage level input to each pin within the range from the V_{SS} voltage to the V_{DD} voltage. If a voltage outside of this range is applied, not only does the current consumption increase, but the reliability of the $\mu\text{PD784218A}$ is negatively affected.

In addition, do not increase the middle voltage.

(3) Are internal pull-up resistors needed?

Unnecessary pull-up resistors increase the current consumption and are another cause of device latch-up. Set the pull-up resistors to the mode in which they are used only in the required parts.

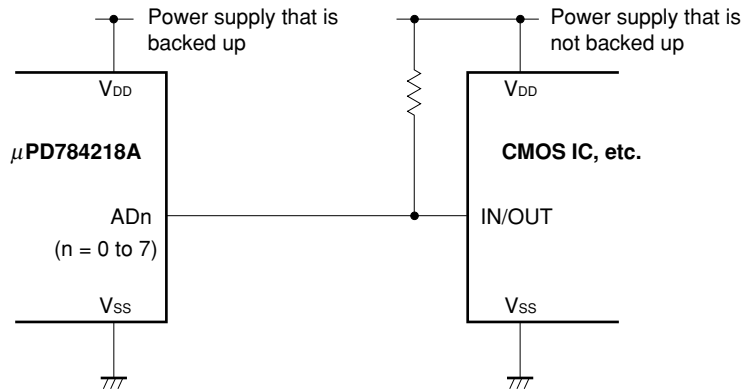
When the parts needing pull-up resistors and the parts not needing them are mixed together, externally connect the pull-up resistors where they are needed and set the mode in which the internal pull-up resistors are not used.

(4) Are the address bus, the address/data bus, etc. handled appropriately?

The address bus, address/data bus, and \overline{RD} and \overline{WR} pins have high impedances in the STOP and IDLE modes. Normally, these pins are pulled up by pull-up resistors. If the pull-up resistors are connected to the power supply that is backed up, the current flows through the pull-up resistors when the low input impedance of the circuit connected to the power supply that is not backed up, and the current consumption increases. Therefore, connect the pull-up resistors on the power supply side that is not backed up as shown in Figure 25-10.

The ASTB pin has a high impedance in both the STOP and IDLE modes. Handle in the manner described in (1) above.

Figure 25-10. Example of Handling Address/Data Bus



Set the input voltage level applied to the \overline{WAIT} pin in the range from the V_{SS} voltage to the V_{DD} voltage. If a voltage outside of this range is applied, not only does the current consumption increase, but the reliability of the $\mu\text{PD784218A}$ is negatively affected.

(5) A/D converter

The current flowing through pins AV_{DD} and AV_{REF0} can be reduced by clearing the ADCS bit, that is bit 7 in the A/D converter mode register (ADM), to 0. Furthermore, if you want to decrease the current, disconnect the current supplied to AV_{REF0} by an externally attached circuit.

★

The AV_{DD} pin must always have the same voltage as the V_{DD} pin. If current is not supplied to the AV_{DD} pin in the STOP mode, not only does the current consumption increase, but the reliability of the μ PD784218A is negatively affected.

(6) D/A converter

The D/A converter consumes a constant current in the STOP and IDLE modes. By clearing the DACEn (n = 0, 1) bits in the D/A converter mode registers (DAM0, DAM1) to 0, the output of ANOn (n = 0, 1) has high impedance, and the current consumption can be decreased.

Do not apply an external voltage to the ANOn pins. If an external voltage is applied, not only is the current consumption increased, but the μ PD784218A may be destroyed or the reliability decreased.

25.7 Low Power Consumption Mode

25.7.1 Setting low power consumption mode^{Note}

When the low power consumption mode is entered, set 70H in the standby control register (STBC). This setting switches the system clock from the main system clock to the subsystem clock.

Whether the system clock switched to the subsystem clock can be verified from the data read from bit CST in the clock status register (PCS) (refer to **Figure 25-3**).

To check whether switching has ended, set 74H in STBC to stop the oscillation of the main system clock. Then switch to the backup power supply from the main power supply.

Note The low power consumption mode is the state where the subsystem clock is used as the system clock, and the main system clock is stopped.

Figure 25-11 shows the flow for setting subsystem clock operation. Figure 25-12 shows the setting timing diagram.

Figure 25-11. Flow for Setting Subsystem Clock Operation

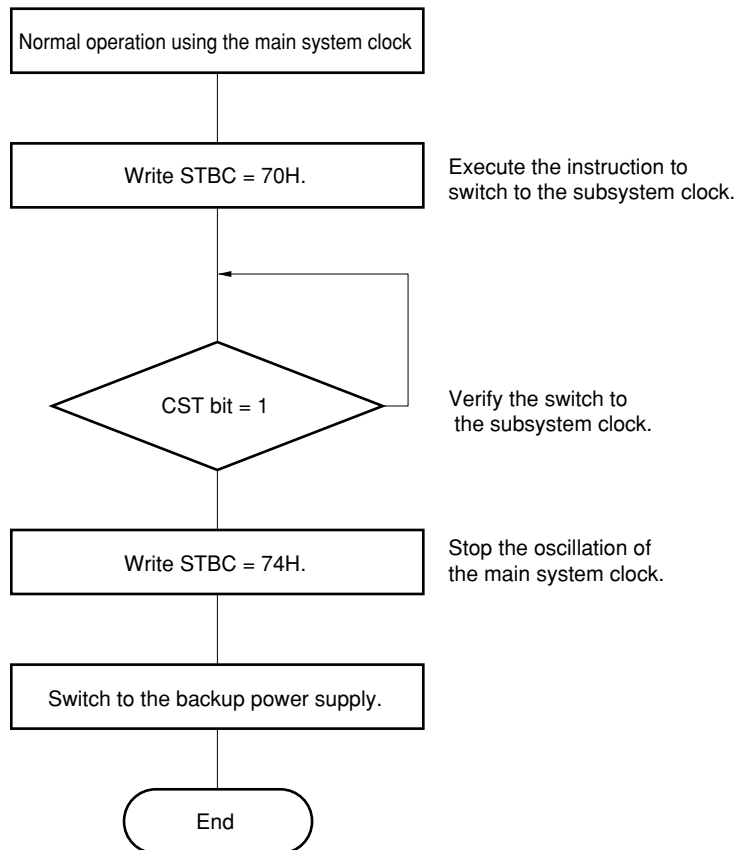
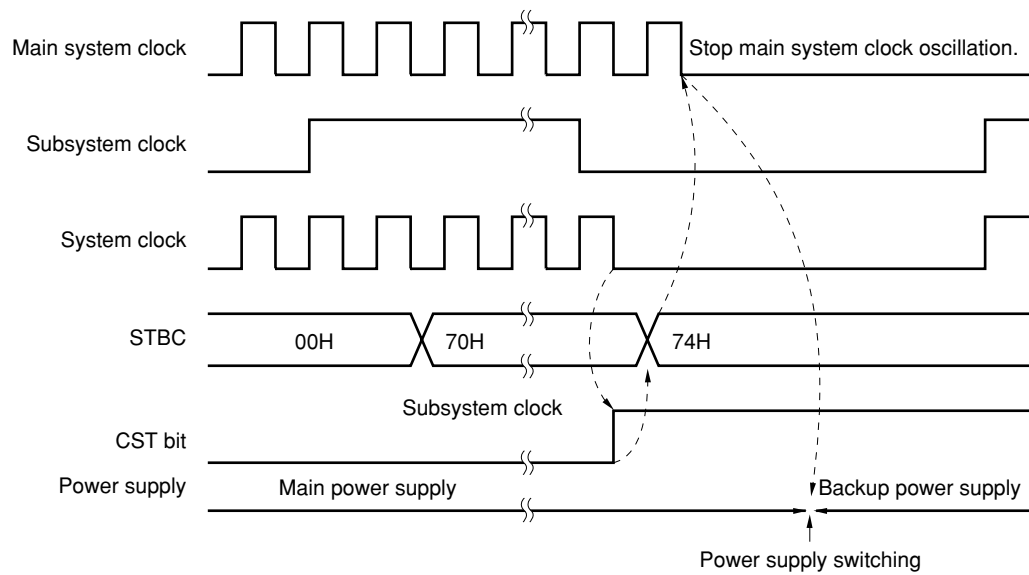


Figure 25-12. Setting Timing for Subsystem Clock Operation



25.7.2 Returning to main system clock operation

When returning to main system clock operation from subsystem clock operation, the system power supply first switches to the main power supply and enables the oscillation of the main system clock (set STBC = 70H). Then the software waits the oscillation stabilization time of the main system clock, and the system clock switches to the main system clock (set STBC to 00H).

- Cautions**
1. When returning from subsystem clock operation (stopped oscillation of the main system clock) to main system clock operation, do not simultaneously specify bit MCK = 0 and bit CK2 = 0 by write instructions to STBC.
 2. The oscillation stabilization time specification register (OSTS) specifies the oscillation stabilization time after the STOP mode is released, except when released by RESET, when the system clock is the main system clock. This cannot be used when the system clock is restored from the subsystem clock to the main system clock.

Figure 25-13 is the flow for restoring main system clock operation, and Figure 25-14 is the restore timing diagram.

Figure 25-13. Flow to Restore Main System Clock Operation

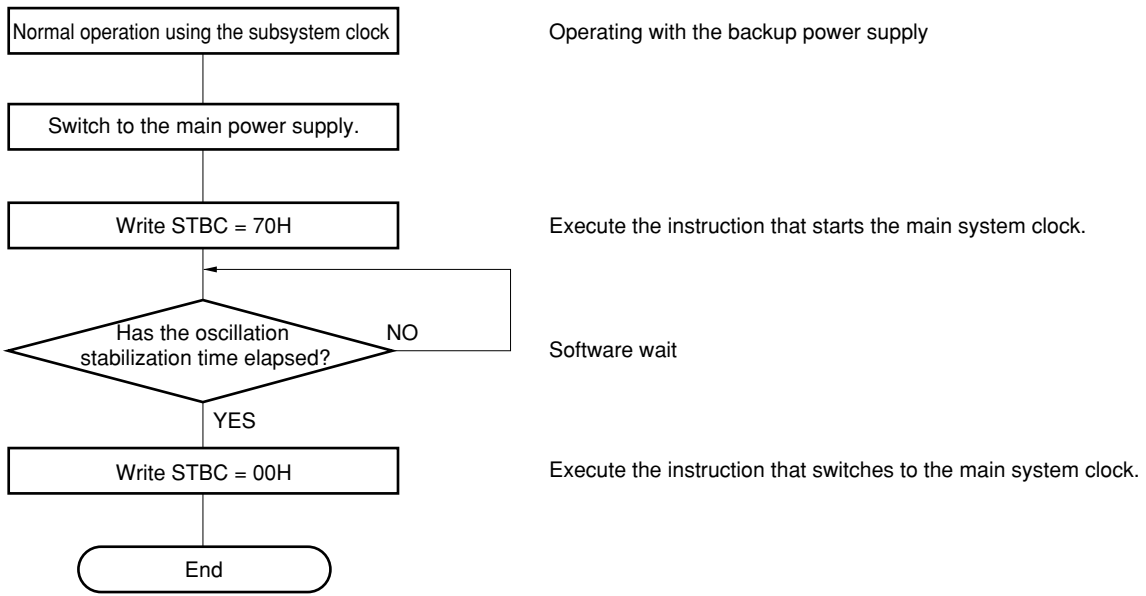
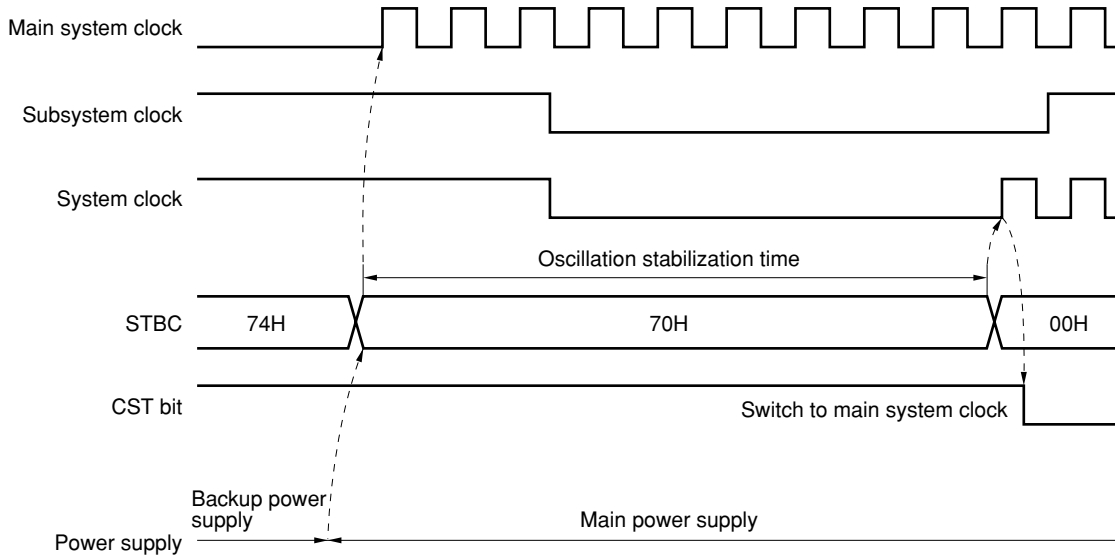


Figure 25-14. Timing for Restoring Main System Clock Operation



25.7.3 Standby function in low power consumption mode

The standby function in the low power consumption mode has a HALT mode and an IDLE mode.

(1) HALT mode

(a) HALT mode settings and the operating states

When set in the HALT mode in the low power consumption mode, set 75H in STBC.

Table 25-9 shows the operating states in the HALT mode.

Table 25-9. Operating States in HALT Mode

Item		Operating State
Clock generator		The clock supplied to the CPU stops, and only the main system clock stops oscillating.
CPU		Operation disabled
Port (output latch)		Holds the state before the HALT mode is set
16-bit timer/counter		Operation enabled when the watch timer output is selected as the count clock (Select fx_T as the count clock of the watch timer)
8-bit timer/counters 1, 2		Operation enabled when T11 and T12 are selected as the count clocks
8-bit timer/counters 5, 6		Operation enabled when T15 and T16 are selected as the count clocks
8-bit timer/counters 7, 8		Operation enabled when T17 and T18 are selected as the count clocks
Watch timer		Operation enabled only when fx_T is selected as the count clock
Watchdog timer		Operation disabled (initializing counter)
A/D converter		Operation disabled
D/A converter		Operation enabled
Real-time output port		Operation enabled when an external trigger is used or T11 and T12 are selected as the count clocks of the 8-bit timer/counters 1 and 2
Serial interface	Other than I ² C bus mode	Operation enabled only when an external input clock is selected as the serial clock
	I ² C bus mode	Operation disabled
External interrupt	INTP0 to INTP6	Operation enabled
Key return interrupt	P80 to P87	Operation enabled
Bus lines during external expansion	AD0 to AD7	High impedance
	A0 to A19	Holds the state before the HALT mode is set
	ASTM	Low level
	\overline{WR} , \overline{RD}	High level
	\overline{WAIT}	Holds input status
	EXA	Holds the state before the HALT mode is set

(b) Releasing the HALT mode**(i) Releasing the HALT mode by NMI input**

When the valid edge specified by the external interrupt edge enable registers (EGP0, EGN0) is input to the NMI input, the IDLE mode is released.

When released from the HALT mode, if non-maskable interrupts by the NMI pin input can be acknowledged, execution branches to the NMI interrupt service program. If interrupts cannot be acknowledged (when set in the HALT mode by the NMI interrupt service program), execution starts again from the instruction following the instruction that set the HALT mode. When interrupts can be acknowledged (by executing the RETI instruction), execution branches to the NMI interrupt service program.

For details about NMI interrupts acknowledgement, refer to **23.6 Non-Maskable Interrupt Acknowledge**.

(ii) Releasing the HALT mode by a maskable interrupt request

An unmasked maskable interrupt request is generated to release the HALT mode.

When the HALT mode is released and the interrupt enable flag (IE) is set to 1, if the interrupt can be acknowledged, execution branches to interrupt service program. When interrupts cannot be acknowledged and when the IE flag is cleared to 0, execution restarts from the instruction following the instruction that set the HALT mode.

For details about interrupt acknowledgement, refer to **23.7 Maskable Interrupt Acknowledge**.

(iii) Releasing the HALT mode by $\overline{\text{RESET}}$ input

★

When $\overline{\text{RESET}}$ input rises from low to high and the reset is released, the oscillator starts oscillating. The oscillation stops for the $\overline{\text{RESET}}$ active period. After the oscillation stabilization time has elapsed, normal operation starts.

The difference from the normal reset operation is the data memory saves the contents before setting the HALT mode.

(2) IDLE mode

(a) Setting the IDLE mode and the operating states

★

When the low power consumption mode is set in the IDLE mode, set 77H in STBC.

Table 25-10 shows the operating states in the IDLE mode.

Table 25-10. Operating States in IDLE Mode

Item		Operating State
Clock generator		The main system clock stops oscillating. The oscillator of the subsystem clock continues operating. The clock supplied to the CPU and the peripherals stops.
CPU		Operation disabled
Port (output latch)		Holds the state before the IDLE mode is set
16-bit timer/counter		Operation enabled when the watch timer output is selected as the count clock (Select fx_T as the count clock of the watch timer.)
8-bit timer/counters 1, 2		Operation enabled when T11 and T12 are selected as the count clocks
8-bit timer/counters 5, 6		Operation enabled when T15 and T16 are selected as the count clocks
8-bit timer/counters 7, 8		Operation enabled when T17 and T18 are selected as the count clocks
Watch timer		Operation enabled only when fx_T is selected as the count clock
Watchdog timer		Operation disabled
A/D converter		Operation disabled
D/A converter		Operation enabled
Real-time output port		Operation enabled when an external trigger is used or T11 and T12 are selected as the count clocks of the 8-bit timer/counters 1 and 2
Serial interface	Other than I ² C bus mode	Operation enabled only when an external input clock is selected as the serial clock
	I ² C bus mode	Operation disabled
External interrupt	INTP0 to INTP6	Operation enabled
Key return interrupt	P80 to P87	Operation enabled
Bus lines during external expansion	AD0 to AD7	High impedance
	A0 to A7	Outputs C0H
	A8 to A19	High impedance
	ASTB	High impedance
	\overline{WR} , \overline{RD}	High impedance
	\overline{WAIT}	Holds input status
	EXA	High impedance

Caution In the IDLE mode, only external interrupts (INTP0 to INTP6), watch timer interrupt (INTWT), and key return interrupts (P80 to P87) can release the IDLE mode and be acknowledged as interrupt requests. All other interrupt requests are pended, and acknowledged after the IDLE mode has been released through NMI input, INTP0 to INTP6 input, INTWT, or key return interrupt.

(b) Releasing the IDLE mode**(i) Releasing the IDLE mode by NMI input**

When the valid edge set in the external interrupt edge enable registers (EGP0, EGN0) is input to the NMI input, the IDLE mode is released.

When the IDLE mode is released and non-maskable interrupts by the NMI pin input can be acknowledged, execution branches to the NMI interrupt service program. When interrupts cannot be acknowledged (when set to the IDLE mode in the NMI interrupt service program), execution restarts from the instruction following the instruction that set the IDLE mode. When interrupts can be acknowledged (by executing the RETI instruction), execution branches to the NMI interrupt service program.

For details about NMI interrupts acknowledgement, refer to **23.6 Non-Maskable Interrupt Acknowledge**.

(ii) Releasing IDLE mode by INTP0 to INTP6 inputs, watch timer interrupt, and key return interrupt

If interrupt masking is released through INTP0 to INTP6 input and macro service is disabled, the IDLE mode is released when a valid edge specified in the external interrupt edge enable registers (EGP0, EGN0) is input to INTP0 to INTP6. If the mask of watch timer interrupt is released and macro service is disabled, an overflow of watch timer occurs and IDLE mode is released. If key return interrupt masking is released and macro service is disabled, the IDLE mode is released when a falling edge is input to the port 8 pins (P80 to P87).

When the IDLE mode is released and the interrupt enable flag (IE) is set to 1, if interrupts can be acknowledged, execution branches to interrupt service program. When interrupts cannot be acknowledged and when the IE flag is cleared to 0, execution restarts from the instruction following the instruction that set the IDLE mode.

For details about interrupt acknowledgement, refer to **23.7 Maskable Interrupt Acknowledge**.

(iii) Releasing the IDLE mode by $\overline{\text{RESET}}$ input

★

When $\overline{\text{RESET}}$ input rises from low to high and the reset is released, the oscillator starts oscillating. The oscillation stops for the $\overline{\text{RESET}}$ active period. After the oscillation stabilization time has elapsed, normal operation starts.

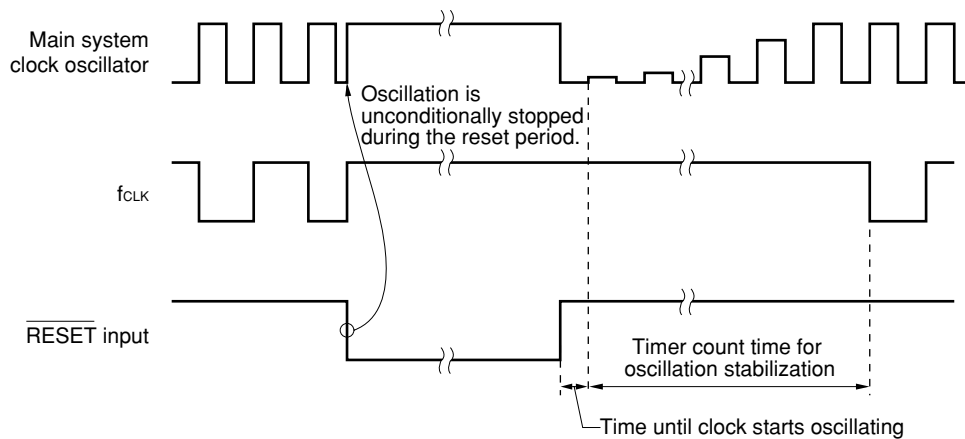
The difference from the normal reset operation is the data memory saves the contents before setting the IDLE mode.

CHAPTER 26 RESET FUNCTION

When a low level is input to the $\overline{\text{RESET}}$ pin, a system reset is performed. The hardware enters the states listed in Figure 26-1. Since the oscillation of the main system clock unconditionally stops during the reset period, the current consumption of the entire system can be reduced.

When $\overline{\text{RESET}}$ input goes from low to high, the reset state is released. After the count time of the timer for oscillation stabilization (84.0 ms: at 12.5 MHz operation), the content of the reset vector table is set in the program counter (PC). Execution branches to the address set in the PC, and program execution starts from the branch destination address. Therefore, the reset can start from any address.

Figure 26-1. Oscillation of Main System Clock in Reset Period



To prevent erroneous operation caused by noise, a noise eliminator based on an analog delay is incorporated at the $\overline{\text{RESET}}$ input pin.

Figure 26-2. Accepting Reset Signal

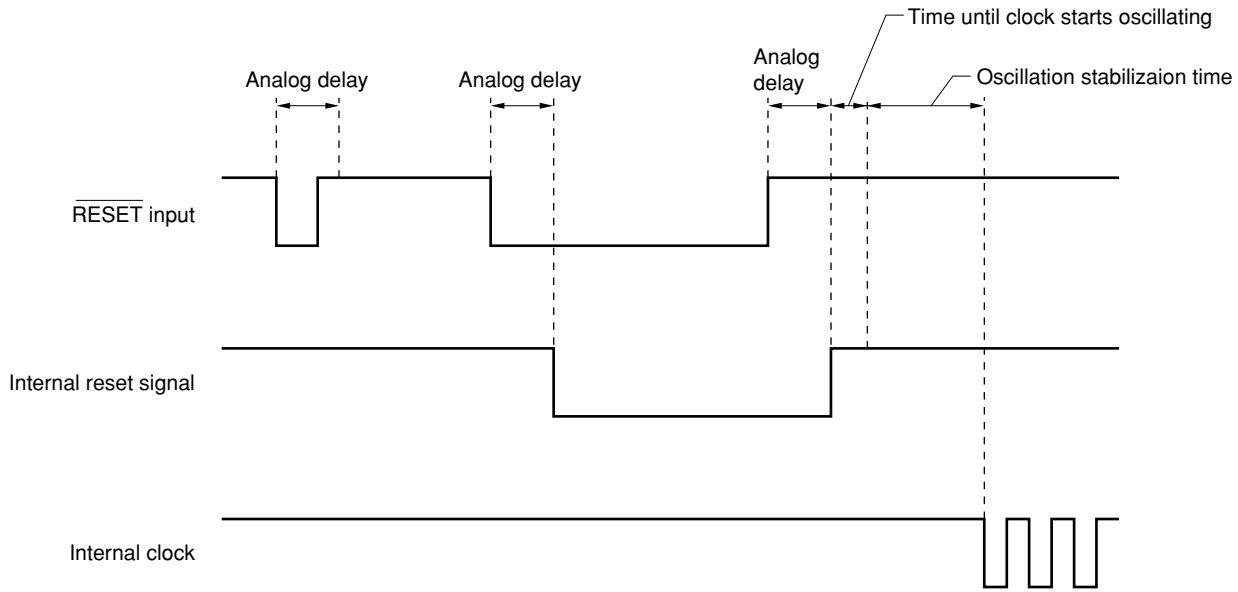


Table 26-1. State After Reset for All Hardware Resets

Hardware	State During Reset ($\overline{\text{RESET}} = \text{L}$)	State After Reset ($\overline{\text{RESET}} = \text{H}$)
Main system clock oscillator	Oscillation stops	Oscillation starts
Subsystem clock oscillator	Not affected by the reset	
Program counter (PC)	Undefined	Set a value in the reset vectored table.
Stack pointer (SP)	Undefined	
Program status word (PSW)	Initialize to 0000H.	
Internal RAM	This is undefined. However, when the standby state is released by a reset, the value is saved before setting standby.	
I/O lines	The input and output buffers turn off.	High impedance
Other hardware	Initialize to the fixed state ^{Note} .	

Note See “After Reset” in **Table 3-6 Special Function Register (SFR) List**.

CHAPTER 27 ROM CORRECTION (μ PD784218A, 784218AY SUBSERIES ONLY)

27.1 ROM Correction Functions

The μ PD784218A converts part of the program within the mask ROM into the program within the peripheral ROM. The use of ROM correction enables command bugs discovered in the mask ROM to be repaired, and change the flow of the program.

ROM correction can be used in a maximum of four locations within the internal ROM (program).

- Cautions**
- 1. Note that ROM correction cannot perform emulation in the in-circuit emulator (IE-784000-R, IE-784000-R-EM).**
 - 2. The ROM correction function is not provided for the μ PD784216A, 784216AY Subseries.**

In more detail, the command addresses that require repair from the inactive memory connected to an external microcomputer by a user program and the repair command codes are loaded into the peripheral RAM.

The above addresses and the internal ROM access addresses are compared by the comparator built into the microcomputer during execution of internal ROM programs (during command fetch), and internal ROM's output data is then converted to call command (CALLT) codes and output when a match is determined.

When the CALLT command codes are executed as valid commands by the CPU, the CALLT table is referenced, and the process routine and other peripheral RAM are branched. At this point, a CALLT table is prepared for each repair address for referencing purposes. Four repair address can be set for the μ PD784218A.

Match-ups with address pointer 0:	CALLT table (0078H)
	Conversion command code: FCH
Match-ups with address pointer 1:	CALLT table (007AH)
	Conversion command code: FDH
Match-ups with address pointer 2:	CALLT table (007CH)
	Conversion command code: FEH
Match-ups with address pointer 3:	CALLT table (007EH)
	Conversion command code: FFH

Caution As it is necessary to reserve four locations for the CALLT tables when the ROM correction function is used (0078H, 007AH, 007CH, 007EH), ensure that these are not used for other applications. However, the CALLT tables can be used if the ROM correction function is not being used.

The differences between 78K/IV ROM correction and 78K/0 ROM correction are shown in Table 27-1.

Table 27-1. Differences Between 78K/IV ROM Correction and 78K/0 ROM Correction

Difference	78K/IV	78K/0
Generated command codes	CALLT instruction (1-byte instruction: FCH, FDH, FEH, FFH)	Branch instruction to peripheral RAM (3-byte instruction)
Change of the stack pointer	Yes (3-byte save)	None
Address comparison conditions	Instruction fetch only	Instruction fetch only
Correction status flag	None As there is a possibility that the addresses match owing to an invalid fetch, the status is not necessary	Yes
Jump destination address during correction	CALLT table 0078H, 007AH, 007CH, 007EH	Fixed address on the peripheral RAM

27.2 ROM Correction Configuration

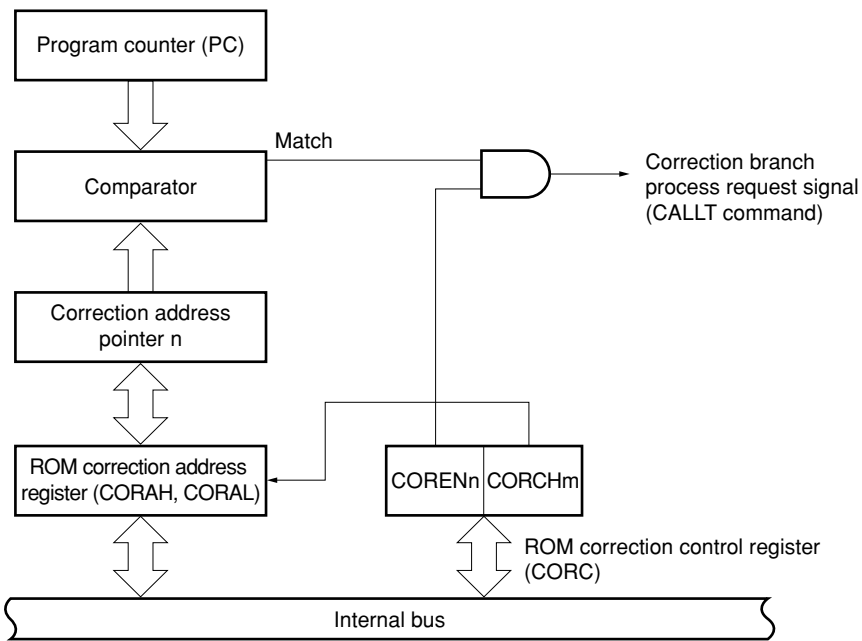
ROM correction is composed of the following hardware.

Table 27-2. ROM Correction Configuration

Item	Configuration
Register	ROM correction address register H, L (CORAH, CORAL)
Control register	ROM correction control register (CORC)

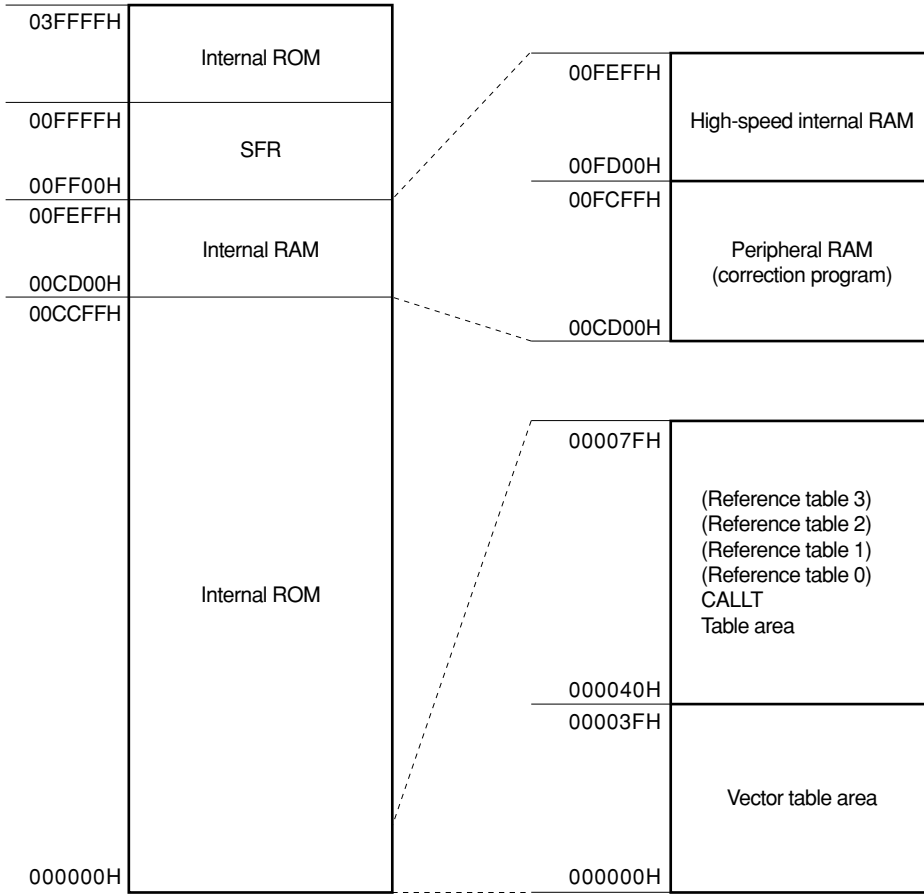
A ROM correction block diagram is shown in Figure 27-1, and Figure 27-2 shows an example of memory mapping.

Figure 27-1. ROM Correction Block Diagram



Remark n = 0 to 3, m = 0, 1

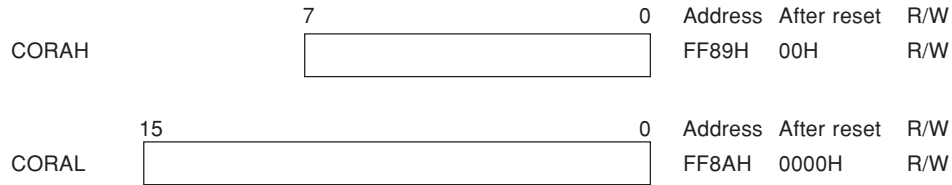
Figure 27-2. Memory Mapping Example (μ PD784218A)



(1) ROM correction address register (CORAH, CORAL)

The register that sets the start address (correction address) of the command within the mask ROM that needs to be repaired. A maximum of four program locations can be repaired with ROM correction. First of all, the channel is selected with bit 0 (CORCH0) and bit 1 (CORCH1) of the ROM correction control register (CORC), and the address is then set in the specified channel's address pointer when the address is written in CORAH and CORAL.

Figure 27-3. ROM Correction Address Register (CORAH, CORAL) Format



(2) Comparator

ROM correction address registers H and L (CORAH, CORAL) normally compare the corrected address value with the fetch register value. If any of the ROM correction control register (CORC) bits between bit 4 and bit 7 (COREN0 to 3) are 1 and the correct address matches the fetch address value, a table reference instruction (CALLT) is issued from the ROM correction circuit.

27.3 Control Register for ROM Correction

ROM correction is controlled by the ROM correction control register (CORC).

(1) ROM correction control register (CORC)

The register that controls the issuance of the table reference instruction (CALLT) when the correct address set in ROM correction address registers H and L (CORAH, CORAL) match the value of the fetch address.

This is composed of a correction enable flag (COREN0 to 3) that enables or disables match detection with the comparator, and four-channel correction pointers.

CORC is set by a 1-bit or 8-bit memory manipulation instruction.

RESET input sets CORC to 00H.

Figure 27-4. ROM Correction Control Register (CORC) Format

Address: 0FF88H	After reset: 00H	R/W						
Symbol	7	6	5	4	3	2	1	0
CORC	COREN3	COREN2	COREN1	COREN0	0	0	CORCH1	CORCH0

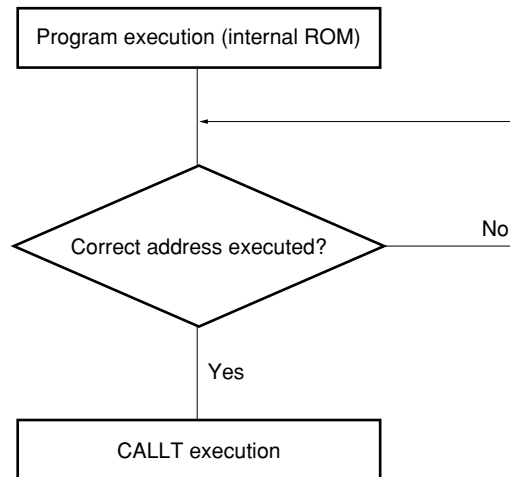
CORENn	Controls the match detection for the ROM correction address register and the fetch address.
0	Disabled
1	Enabled

CORCH1	CORCH0	Channel selection
0	0	Address pointer channel 0
0	1	Address pointer channel 1
1	0	Address pointer channel 2
1	1	Address pointer channel 3

Remark n = 0 to 3

27.4 Usage of ROM Correction

- <1> The correct address and post-correction instruction (correction program) are stored in the microcontroller external inactive memory (EEPROM™).
- <2> A substitute instruction is read from the inactive memory with the use of a serial interface when the initialization program is running after being reset, and this is stored in the peripheral RAM and external memory. The correction channel is then selected, the address for the command that requires correction is read and set in the ROM correction address registers (CORAH, CORAL), and the correction enable flag (COREN0 to 3) is set at 1. A maximum of four locations can be set.
- <3> Execute the CALLT instruction during execution of the corrected address.



- <4> CALLT routine branch

When matched with address pointer 0: CALLT table (0078H)

When matched with address pointer 1: CALLT table (007AH)

When matched with address pointer 2: CALLT table (007CH)

When matched with address pointer 3: CALLT table (007EH)

- <5> Execute substitute instruction

- <6> Add +3 to the stack pointer (SP)

- <7> Restore to any addresses with the branch instruction (BR)

27.5 Conditions for Executing ROM Correction

In order to use the ROM correction function, it is necessary for the external environment and program to satisfy the following conditions.

(1) External environment

Must be connected externally to an inactive memory, and be configured to read that data.

(2) Target program

The data setting instruction for CORC, CORAH and CORAL will be previously annotated in the target program (program stored in the ROM).

The setup data (the items written in lowercase in the setup example below) must be read from the external inactive memory, and the correct number of required correction pointers must be set.

Example of four pointer settings

```

MOV    CORC, #00H      ; Specified channel 0
MOVW   CORAL, #ch0_data ; Sets the channel 0 matching address
MOV    CORAH, #ch0_data ; Sets the channel 0 matching address
MOV    CORC, #01H      ; Specified channel 1
MOVW   CORAL, #ch1_data ; Sets the channel 1 matching address
MOV    CORAH, #ch1_data ; Sets the channel 1 matching address
MOV    CORC, #02H      ; Specified channel 2
MOVW   CORAL, #ch2_data ; Sets the channel 2 matching address
MOV    CORAH, #ch2_data ; Sets the channel 2 matching address
MOV    CORC, #03H      ; Specified channel 3
MOV    CORAL, #ch3_data ; Sets the channel 3 matching address
MOV    CORAH, #ch3_data ; Sets the channel 3 matching address
MOV    CORC, #romcor_en ; Sets 00H when correction is disabled
                                ; Sets F0H when correction is operated

BR     $NORMAL
BR     !!COR_ADDR0      ; Specifies the address of the correction program (channel 0)
BR     !!COR_ADDR1      ; Specifies the address of the correction program (channel 1)
BR     !!COR_ADDR2      ; Specifies the address of the correction program (channel 2)
BR     !!COR_ADDR3      ; Specifies the address of the correction program (channel 3)
;                               (two-level branch)
NOMAL instruction      ; Next instruction
    
```

(3) Setting the branch instruction in the CALLT table

In the case of the above program, the start address for the BR!!COR_ADDR instruction is specified (COR_ADDR indicates the address where the correction program is located).

The reason for this branching into two levels, the CALLT instruction and BR instruction, is that only the base area can be branched with CALLT. There is no necessity to branch into two levels when RAM is to be allocated to the base area with the LOCATION instruction.

CHAPTER 28 FLASH MEMORY PROGRAMMING

The flash memory can be written when installed in the target system (on board). The dedicated flash programmer (Flashpro III (part No.: FL-PR3, PG-FP3)) is connected to the host machine and target system.

Writing to the flash memory can be performed using the flash memory write adapter connected to Flashpro III.

Remark FL-PR3 is a product of Naitou Densai Machida Mfg. Co., Ltd.

28.1 Selecting Communication Protocol

Flashpro III writes to flash memory by serial communication. The communication protocol is selected from Table 28-1 then writing is performed. The selection of the communication protocol has the format shown in Figure 28-1. Each communication protocol is selected by the number of V_{PP} pulses shown in Table 28-1.

Table 28-1. Communication Protocols

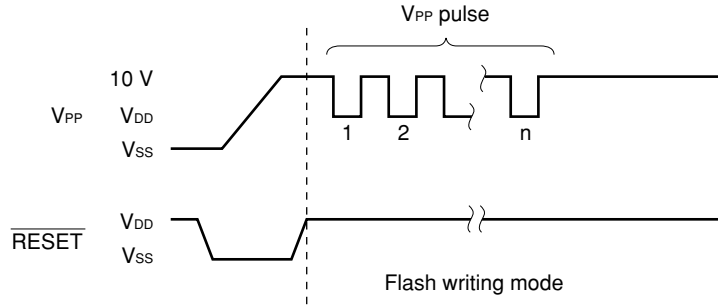
Communication Protocol	No. of Channels	Pins Used	No. of V_{PP} Pulses
3-wire serial I/O	3	$\overline{SCK0}/P27/SCL0$ ^{Note 2} SO0/P26 SI0/P25/SDA0 ^{Note 2}	0
		$\overline{SCK1}/ASCK1/P22$ SO1/TxD1/P21 SI1/RxD1/P20	1
		$\overline{SCK2}/ASCK2/P72$ SO2/TxD2/P71 SI2/RxD2/P70	2
3-wire serial I/O (handshake ^{Note 3})	1	$\overline{SCK0}/P27/SCL0$ ^{Note 2} SO0/P26 SI0/P25/SDA0 ^{Note 2} P24/BUZ	3
UART	2	TxD1/SO1/P21 RxD1/SI1/P20	8
		TxD2/SO2/P71 RxD2/SI2/P70	9

Notes 1. Shifting to the flash memory programming mode sets all pins not used for flash memory programming to the same state as immediately after reset. Therefore, if the external device connected to each port do not acknowledge the port state immediately after reset, handling such as connecting to V_{DD} via a resistor or connecting to V_{SS} via a resistor is required.

2. μ PD78F4216AY, 78F4218AY only
3. μ PD78F4216A, 78F4216AY (other than K, E standards)
 μ PD78F4218A, 78F4218AY (all standards)

Caution Select the communication protocol by using the number of V_{PP} pulses given in Table 28-1.

Figure 28-1. Communication Protocol Selection Format



28.2 Flash Memory Programming Functions

By transmitting and receiving various commands and data by the selected communication protocol, operations such as writing to the flash memory are performed. Table 28-2 shows the major functions.

Table 28-2. Major Functions in Flash Memory Programming

Function	Description
Area erase	Erase the contents of the specified memory area.
Area blank check	Checks the erase state of the specified area.
Data write	Writes to the flash memory based on the start write address and the number of data written (number of bytes).
Area verify	Compares the data input to the contents of the specified memory area.

28.3 Connecting Flashpro III

The connection between the Flashpro III and the μ PD78F4218A differs with the communication protocol. Figures 28-2 to 28-4 are the connection diagrams in each case.

Figure 28-2. Connection of Flashpro III in 3-Wire Serial I/O Mode (When Using 3-Wire Serial I/O)

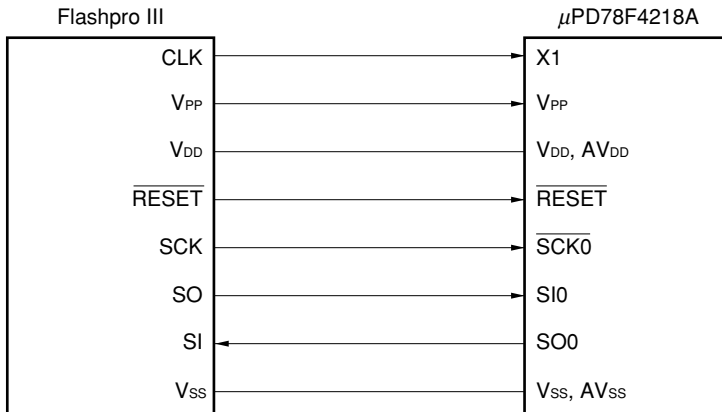
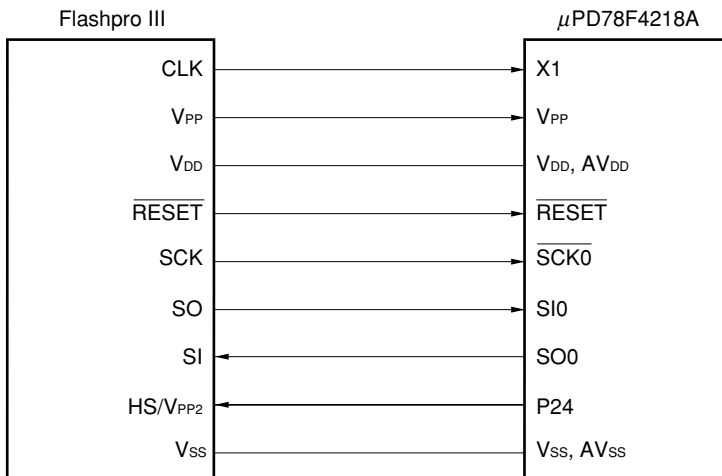
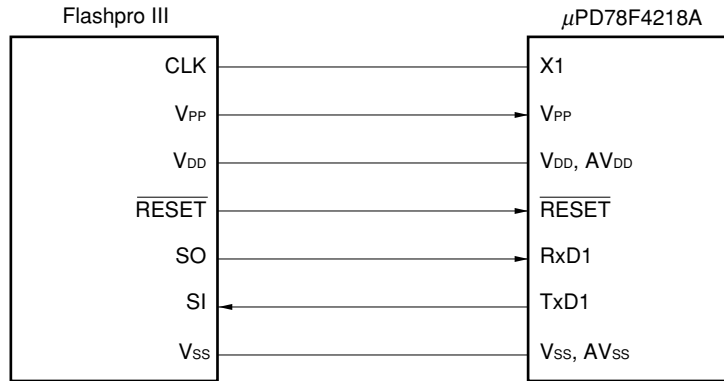


Figure 28-3. Connection of Flashpro III in 3-Wire Serial I/O Mode (When Using Handshake)



**Figure 28-4. Connection of Flashpro III in UART Mode
(When Using UART)**



Caution Connect the V_{PP} pin directly to V_{SS} or pull down. For the pull-down connection, use of resistors with a resistance between 470 Ω and 10 kΩ is recommended.

CHAPTER 29 INSTRUCTION OPERATION

29.1 Examples

(1) Operand expression format and description (1/2)

Expression Format	Description
r, r ^{Note 1}	X(R0), A(R1), C(R2), B(R3), R4, R5, R6, R7, R8, R9, R10, R11, E(R12), D(R13), L(R14), H(R15)
r1 ^{Note 1}	X(R0), A(R1), C(R2), B(R3), R4, R5, R6, R7
r2	R8, R9, R10, R11, E(R12), D(R13), L(R14), H(R15)
r3	V, U, T, W
rp, rp ^{Note 2}	AX(RP0), BC(RP1), RP2, RP3, VP(RP4), UP(RP5), DE(RP6), HL(RP7)
rp1 ^{Note 2}	AX(RP0), BC(RP1), RP2, RP3
rp2	VP(RP4), UP(RP5), DE(RP6), HL(RP7)
rg, rg'	VVP(RG4), UUP(RG5), TDE(RG6), WHL(RG7)
sfr	Special function register symbol (see Table 3-6 Special Function Register (SFR) List)
sfrp	Special function register symbol (16-bit manipulation register: see Table 3-6 Special Function Register (SFR) List)
post ^{Note 2}	AX(RP0), BC(RP1), RP2, RP3, VP(RP4), UP(RP5)/PSW, DE(RP6), HL(RP7) Multiple descriptions are possible. However, UP is restricted to the PUSH/POP instruction, and PSW is restricted to the PUSHU/POPU instruction.
mem	[TDE], [WHL], [TDE+], [WHL+], [TDE-], [WHL-], [VVP], [UUP]: register indirect addressing [TDE+byte], [WHL+byte], [SP+byte], [UUP+byte], [VVP+byte]: based addressing imm24[A], imm24[B], imm24[DE], imm24[HL]: indexed addressing [TDE+A], [TDE+B], [TDE+C], [WHL+A], [WHL+B], [WHL+C], [VVP+DE], [VVP+HL]: based indexed addressing
mem1	Everything under mem except [WHL+] and [WHL-]
mem2	[TDE], [WHL]
mem3	[AX], [BC], [RP2], [RP3], [VVP], [UUP], [TDE], [WHL]

- Notes**
1. By setting the RSS bit to 1, R4 to R7 can be used as X, A, C, and B. Use this function only when 78K/III Series programs are also used.
 2. By setting the RSS bit to 1, RP2 and RP3 can be used as AX and BC. Use this function only when 78K/III Series programs are also used.

(1) Operand expression format and description (2/2)

Expression Format	Description
Note	
saddr, saddr'	FD20H to FF1FH Immediate data or label
saddr1	FE00H to FEFFH Immediate data or label
saddr2	FD20H to FDFFH, FF00H to FF1FH Immediate data or label
saddrp	FD20H to FF1EH Immediate data or label (when manipulating 16 bits)
saddrp1	FE00H to FEFFH Immediate data or label (when manipulating 16 bits)
saddrp2	FD20H to FDFFH, FF00H to FF1EH Immediate data or label (when manipulating 16 bits)
saddrg	FD20H to FEFDH Immediate data or label (when manipulating 24 bits)
saddrg1	FE00H to FEFDH Immediate data or label (when manipulating 24 bits)
saddrg2	FD20H to FDFFH Immediate data or label (when manipulating 24 bits)
addr24	0H to FFFFFFFH Immediate data or label
addr20	0H to FFFFFH Immediate data or label
addr16	0H to FFFFH Immediate data or label
addr11	800H to FFFH Immediate data or label
addr8	0FE00H to 0FEFFH ^{Note} Immediate data or label
addr5	40H to 7EH Immediate data or label
imm24	24-bit immediate data or label
word	16-bit immediate data or label
byte	8-bit immediate data or label
bit	3-bit immediate data or label
n	3-bit immediate data
locaddr	00H or 0FH

Note When 00H is set by the LOCATION instruction, these addresses become the addresses shown here.
 When 0FH is set by the LOCATION instruction, the values of the addresses shown here added to F0000H become the addresses.

(2) Operand column symbols

Symbol	Description
+	Auto increment
-	Auto decrement
#	Immediate data
!	16-bit absolute address
!!	24-bit/20-bit absolute address
\$	8-bit relative address
\$!	16-bit relative address
/	Bit reversal
[]	Indirect addressing
[%]	24-bit indirect addressing

(3) Flag column symbols

Symbol	Description
(Blank)	Not changed
0	Clear to zero.
1	Set to one.
×	Set or clear based on the result.
P	Operate with the P/V flag as the parity flag.
V	Operate with the P/V flag as the overflow flag.
R	Restore the previously saved value.

(4) Operation column symbols

Symbol	Description
jdisp8	Two's complement data (8 bits) of the relative address distance between the start address of the next instruction and the branch address
jdisp16	Two's complement data (16 bits) of the relative address distance between the start address of the next instruction and the branch address
PC _{HW}	PC bits 16 to 19
PC _{LW}	PC bits 0 to 15

(5) Number of bytes in instruction that has mem in operand

mem Mode	Register Indirect Addressing		Based Addressing	Indexed Addressing	Based Indexed Addressing
No. of bytes	1	2 ^{Note}	3	5	2

Note This becomes a 1-byte instruction only when [TDE], [WHL], [TDE+], [TDE-], [WHL+], or [WHL-] is described in mem in the MOV instruction.

(6) Number of bytes in instruction that has saddr, saddrp, r, or rp in operand

The number of bytes in an instruction that has saddr, saddrp, r, or rp in the operand is described in two parts divided by a slash (/). The following table shows the number of bytes in each one.

Description	No. of Bytes on Left Side	No. of Bytes on Right Side
saddr	saddr2	saddr1
saddrp	saddrp2	saddrp1
r	r1	r2
rp	rp1	rp2

(7) Descriptions of instructions with mem in operand and string instructions

The TDE, WHL, VVP, and UUP (24-bit registers) operands can be described by DE, HL, VP, and UP. However, when DE, HL, VP, and UP are described, they are handled as TDE, WHL, VVP, and UUP (24-bit registers).

29.2 List of Operations

(1) 8-bit data transfer instruction: MOV

Mnemonic	Operand	Bytes	Operation	Flags				
				S	Z	AC	P/V	CY
MOV	r, #byte	2/3	$r \leftarrow \text{byte}$					
	saddr, #byte	3/4	$(\text{saddr}) \leftarrow \text{byte}$					
	sfr, #byte	3	$\text{sfr} \leftarrow \text{byte}$					
	laddr16,, #byte	5	$(\text{saddr16}) \leftarrow \text{byte}$					
	!!addr24, #byte	6	$(\text{addr24}) \leftarrow \text{byte}$					
	r, r'	2/3	$r \leftarrow r'$					
	A, r	1/2	$A \leftarrow r$					
	A, saddr2	2	$A \leftarrow (\text{saddr2})$					
	r, saddr	3	$r \leftarrow (\text{saddr})$					
	saddr2, A	2	$(\text{saddr2}) \leftarrow A$					
	saddr, r	3	$(\text{saddr}) \leftarrow r$					
	A, sfr	2	$A \leftarrow \text{sfr}$					
	r, sfr	3	$r \leftarrow \text{sfr}$					
	sfr, A	2	$\text{sfr} \leftarrow A$					
	sfr, r	3	$\text{sfr} \leftarrow r$					
	saddr, saddr'	4	$(\text{saddr}) \leftarrow (\text{saddr}')$					
	r, laddr16	4	$r \leftarrow (\text{addr16})$					
	laddr16, r	4	$(\text{addr16}) \leftarrow r$					
	r, !!addr24	5	$r \leftarrow (\text{addr24})$					
	!!addr24, r	5	$(\text{addr24}) \leftarrow r$					
	A, [saddrp]	2/3	$A \leftarrow ((\text{saddrp}))$					
	A, [%saddrg]	3/4	$A \leftarrow ((\text{saddrg}))$					
	A, mem	1-5	$A \leftarrow (\text{mem})$					
	[saddrp], A	2/3	$((\text{saddrp})) \leftarrow A$					
	[%saddrg], A	3/4	$((\text{saddrg})) \leftarrow A$					
	mem, A	1-5	$(\text{mem}) \leftarrow A$					
	PSWL #byte	3	$\text{PSWL} \leftarrow \text{byte}$		x	x	x	x
	PSWH #byte	3	$\text{PSWH} \leftarrow \text{byte}$					
	PSWL, A	2	$\text{PSWL} \leftarrow A$		x	x	x	x
	PSWH, A	2	$\text{PSWH} \leftarrow A$					
	A, PSWL	2	$A \leftarrow \text{PSWL}$					
	A, PSWH	2	$A \leftarrow \text{PSWH}$					
	r3, #byte	3	$r3 \leftarrow \text{byte}$					
	A, r3	2	$A \leftarrow r3$					
r3, A	2	$r3 \leftarrow A$						

(2) 16-bit data transfer instruction: MOVW

Mnemonic	Operand	Bytes	Operation	Flags				
				S	Z	AC	P/V	CY
MOVW	rp, #word	3	rp ← word					
	saddrp, #word	4/5	(saddrp) ← word					
	sfrp, #word	4	sfrp ← word					
	!addr16, #word	6	(addr16) ← word					
	!!addr24, #word	7	(addr24) ← word					
	rp, rp'	2	rp ← rp'					
	AX, saddrp2	2	AX ← (saddrp2)					
	rp, saddrp	3	rp ← (saddrp)					
	saddrp2, AX	2	(saddrp2) ← AX					
	saddrp, rp	3	(saddrp) ← rp					
	AX, sfrp	2	AX ← sfrp					
	rp, sfrp	3	rp ← sfrp					
	sfrp, AX	2	sfrp ← AX					
	sfrp, rp	3	sfrp ← rp					
	saddrp, saddrp'	4	(saddrp) ← (saddrp')					
	rp, !addr16	4	rp ← (addr16)					
	!addr16, rp	4	(addr16) ← rp					
	rp, !!addr24	5	rp ← (addr24)					
	!!addr24, rp	5	(addr24) ← rp					
	AX, [saddrp]	3/4	AX ← ((saddrp))					
	AX, [%saddrg]	3/4	AX ← ((saddrg))					
	AX, mem	2-5	AX ← (mem)					
	[saddrp], AX	3/4	((saddrp)) ← AX					
	[%saddrg], AX	3/4	((saddrg)) ← AX					
mem, AX	2-5	(mem) ← AX						

(3) 24-bit data transfer instruction: **MOVG**

Mnemonic	Operand	Bytes	Operation	Flags				
				S	Z	AC	P/V	CY
MOVG	rg, #imm24	5	rg ← imm24					
	rg, rg'	2	rg ← rg'					
	rg, !addr24	5	rg ← (addr24)					
	!addr24, rg	5	(addr24) ← rg					
	rg, saddrg	3	rg ← (saddrg)					
	saddrg, rg	3	(saddrg) ← rg					
	WHL, [%saddrg]	3/4	WHL ← ((saddrg))					
	[%saddrg], WHL	3/4	((saddrg)) ← WHL					
	WHL, mem1	2-5	WHL ← (mem1)					
	mem1, WHL	2-5	(mem1) ← WHL					

(4) 8-bit data exchange instruction: **XCH**

Mnemonic	Operand	Bytes	Operation	Flags				
				S	Z	AC	P/V	CY
XCH	r, r'	2/3	r ↔ r'					
	A, r	1/2	A ↔ r					
	A, saddr2	2	A ↔ (saddr2)					
	r, saddr	3	r ↔ (saddr)					
	r, sfr	3	r ↔ sfr					
	saddr, saddr'	4	(saddr) ↔ (saddr')					
	r, laddr16	4	r ↔ (addr16)					
	r, !addr24	5	r ↔ (addr24)					
	A, [saddrp]	2/3	A ↔ ((saddrp))					
	A, [%saddrg]	3/4	A ↔ ((saddrg))					
	A, mem	2-5	A ↔ (mem)					

(5) 16-bit data exchange instruction: XCHW

Mnemonic	Operand	Bytes	Operation	Flags				
				S	Z	AC	P/V	CY
XCHW	rp, rp'	2	rp ↔ rp'					
	AX, saddrp2	2	AX ↔ (saddrp2)					
	rp, saddrp	3	rp ↔ (saddrp)					
	rp, sfrp	3	rp ↔ sfrp					
	AX, [saddrp]	3/4	AX ↔ ((saddrp))					
	AX, [%saddrg]	3/4	AX ↔ ((saddrg))					
	AX, laddr16	4	AX ↔ (addr16)					
	AX, !!addr24	5	AX ↔ (addr24)					
	saddrp, saddrp'	4	(saddrp) ↔ (saddrp')					
	AX, mem	2-5	AX ↔ (mem)					

(6) 8-bit arithmetic instructions: ADD, ADDC, SUB, SUBC, CMP, AND, OR, XOR

Mnemonic	Operand	Bytes	Operation	Flags				
				S	Z	AC	P/V	CY
ADD	A, #byte	2	A, CY ← A + byte	×	×	×	V	×
	r, #byte	3	r, CY ← r + byte	×	×	×	V	×
	saddr, #byte	3/4	(saddr), CY ← (saddr) + byte	×	×	×	V	×
	sfr, #byte	4	sfr, CY ← sfr + byte	×	×	×	V	×
	r, r'	2/3	r, CY ← r + r'	×	×	×	V	×
	A, saddr2	2	A, CY ← A + (saddr2)	×	×	×	V	×
	r, saddr	3	r, CY ← r + (saddr)	×	×	×	V	×
	saddr, r	3	(saddr), CY ← (saddr) + r	×	×	×	V	×
	r, sfr	3	r, CY ← r + sfr	×	×	×	V	×
	sfr, r	3	sfr, CY ← sfr + r	×	×	×	V	×
	saddr, saddr'	4	(saddr), CY ← (saddr) + (saddr')	×	×	×	V	×
	A, [saddrp]	3/4	A, CY ← A + ((saddrp))	×	×	×	V	×
	A, [%saddrg]	3/4	A, CY ← A + ((saddrg))	×	×	×	V	×
	[saddrp], A	3/4	((saddrp)), CY ← ((saddrp)) + A	×	×	×	V	×
	[%saddrg], A	3/4	((saddrg)), CY ← ((saddrg)) + A	×	×	×	V	×
	A, laddr16	4	A, CY ← A + (addr16)	×	×	×	V	×
	A, !!addr24	5	A, CY ← A + (addr24)	×	×	×	V	×
	!addr16, A	4	(addr16), CY ← (addr16) + A	×	×	×	V	×
	!!addr24, A	5	(addr24), CY ← (addr24) + A	×	×	×	V	×
	A, mem	2-5	A, CY ← A + (mem)	×	×	×	V	×
mem, A	2-5	(mem), CY ← (mem) + A	×	×	×	V	×	

Mnemonic	Operand	Bytes	Operation	Flags				
				S	Z	AC	P/V	CY
ADDC	A, #byte	2	$A, CY \leftarrow A + \text{byte} + CY$	x	x	x	V	x
	r, #byte	3	$r, CY \leftarrow r + \text{byte} + CY$	x	x	x	V	x
	saddr, #byte	3/4	$(\text{saddr}), CY \leftarrow (\text{saddr}) + \text{byte} + CY$	x	x	x	V	x
	sfr, #byte	4	$\text{sfr}, CY \leftarrow \text{sfr} + \text{byte} + CY$	x	x	x	V	x
	r, r'	2/3	$r, CY \leftarrow r + r' + CY$	x	x	x	V	x
	A, saddr2	2	$A, CY \leftarrow A + (\text{saddr}2) + CY$	x	x	x	V	x
	r, saddr	3	$r, CY \leftarrow r + (\text{saddr}) + CY$	x	x	x	V	x
	saddr, r	3	$(\text{saddr}), CY \leftarrow (\text{saddr}) + r + CY$	x	x	x	V	x
	r, sfr	3	$r, CY \leftarrow r + \text{sfr} + CY$	x	x	x	V	x
	sfr, r	3	$\text{sfr}, CY \leftarrow \text{sfr} + r + CY$	x	x	x	V	x
	saddr, saddr'	4	$(\text{saddr}), CY \leftarrow (\text{saddr}) + (\text{saddr}') + CY$	x	x	x	V	x
	A, [saddrp]	3/4	$A, CY \leftarrow A + ((\text{saddrp})) + CY$	x	x	x	V	x
	A, [%saddrg]	3/4	$A, CY \leftarrow A + ((\text{saddrg})) + CY$	x	x	x	V	x
	[saddrp], A	3/4	$((\text{saddrp})), CY \leftarrow ((\text{saddrp})) + A + CY$	x	x	x	V	x
	[%saddrg], A	3/4	$((\text{saddrg})), CY \leftarrow ((\text{saddrg})) + A + CY$	x	x	x	V	x
	A, laddr16	4	$A, CY \leftarrow A + (\text{addr}16) + CY$	x	x	x	V	x
	A, !laddr24	5	$A, CY \leftarrow A + (\text{addr}24) + CY$	x	x	x	V	x
	!laddr16, A	4	$(\text{addr}16), CY \leftarrow (\text{addr}16) + A + CY$	x	x	x	V	x
	!laddr24, A	5	$(\text{addr}24), CY \leftarrow (\text{addr}24) + A + CY$	x	x	x	V	x
	A, mem	2-5	$A, CY \leftarrow A + (\text{mem}) + CY$	x	x	x	V	x
mem, A	2-5	$(\text{mem}), CY \leftarrow (\text{mem}) + A + CY$	x	x	x	V	x	

Mnemonic	Operand	Bytes	Operation	Flags				
				S	Z	AC	P/V	CY
SUB	A, #byte	2	A, CY ← A – byte	×	×	×	V	×
	r, #byte	3	r, CY ← r – byte	×	×	×	V	×
	saddr, #byte	3/4	(saddr), CY ← (saddr) – byte	×	×	×	V	×
	sfr, #byte	4	sfr, CY ← sfr – byte	×	×	×	V	×
	r, r'	2/3	r, CY ← r – r'	×	×	×	V	×
	A, saddr2	2	A, CY ← A – (saddr2)	×	×	×	V	×
	r, saddr	3	r, CY ← r – (saddr)	×	×	×	V	×
	saddr, r	3	(saddr), CY ← (saddr) – r	×	×	×	V	×
	r, sfr	3	r, CY ← r – sfr	×	×	×	V	×
	sfr, r	3	sfr, CY ← sfr – r	×	×	×	V	×
	saddr, saddr'	4	(saddr), CY ← (saddr) – (saddr')	×	×	×	V	×
	A, [saddrp]	3/4	A, CY ← A – ((saddrp))	×	×	×	V	×
	A, [%saddrg]	3/4	A, CY ← A – ((saddrg))	×	×	×	V	×
	[saddrp], A	3/4	((saddrp)), CY ← ((saddrp)) – A	×	×	×	V	×
	[%saddrg], A	3/4	((saddrg)), CY ← ((saddrg)) – A	×	×	×	V	×
	A, laddr16	4	A, CY ← A – (addr16)	×	×	×	V	×
	A, !laddr24	5	A, CY ← A – (addr24)	×	×	×	V	×
	!laddr16, A	4	(addr16), CY ← (addr16) – A	×	×	×	V	×
	!laddr24, A	5	(addr24), CY ← (addr24) – A	×	×	×	V	×
	A, mem	2-5	A, CY ← A – (mem)	×	×	×	V	×
mem, A	2-5	(mem), CY ← (mem) – A	×	×	×	V	×	

Mnemonic	Operand	Bytes	Operation	Flags				
				S	Z	AC	P/V	CY
SUBC	A, #byte	2	$A, CY \leftarrow A - \text{byte} - CY$	x	x	x	V	x
	r, #byte	3	$r, CY \leftarrow r - \text{byte} - CY$	x	x	x	V	x
	saddr, #byte	3/4	$(saddr), CY \leftarrow (saddr) - \text{byte} - CY$	x	x	x	V	x
	sfr, #byte	4	$sfr, CY \leftarrow sfr - \text{byte} - CY$	x	x	x	V	x
	r, r'	2/3	$r, CY \leftarrow r - r' - CY$	x	x	x	V	x
	A, saddr2	2	$A, CY \leftarrow A - (saddr2) - CY$	x	x	x	V	x
	r, saddr	3	$r, CY \leftarrow r - (saddr) - CY$	x	x	x	V	x
	saddr, r	3	$(saddr), CY \leftarrow (saddr) - r - CY$	x	x	x	V	x
	r, sfr	3	$r, CY \leftarrow r - sfr - CY$	x	x	x	V	x
	sfr, r	3	$sfr, CY \leftarrow sfr - r - CY$	x	x	x	V	x
	saddr, saddr'	4	$(saddr), CY \leftarrow (saddr) - (saddr') - CY$	x	x	x	V	x
	A, [saddrp]	3/4	$A, CY \leftarrow A - ((saddrp)) - CY$	x	x	x	V	x
	A, [%saddrg]	3/4	$A, CY \leftarrow A - ((saddrg)) - CY$	x	x	x	V	x
	[saddrp], A	3/4	$((saddrp)), CY \leftarrow ((saddrp)) - A - CY$	x	x	x	V	x
	[%saddrg], A	3/4	$((saddrg)), CY \leftarrow ((saddrg)) - A - CY$	x	x	x	V	x
	A, !addr16	4	$A, CY \leftarrow A - (addr16) - CY$	x	x	x	V	x
	A, !!addr24	5	$A, CY \leftarrow A - (addr24) - CY$	x	x	x	V	x
	!addr16, A	4	$(addr16), CY \leftarrow (addr16) - A - CY$	x	x	x	V	x
	!!addr24, A	5	$(addr24), CY \leftarrow (addr24) - A - CY$	x	x	x	V	x
	A, mem	2-5	$A, CY \leftarrow A - (\text{mem}) - CY$	x	x	x	V	x
mem, A	2-5	$(\text{mem}), CY \leftarrow (\text{mem}) - A - CY$	x	x	x	V	x	

Mnemonic	Operand	Bytes	Operation	Flags				
				S	Z	AC	P/V	CY
CMP	A, #byte	2	A – byte	×	×	×	V	×
	r, #byte	3	r – byte	×	×	×	V	×
	saddr, #byte	3/4	(saddr) – byte	×	×	×	V	×
	sfr, #byte	4	sfr – byte	×	×	×	V	×
	r, r'	2/3	r – r'	×	×	×	V	×
	A, saddr2	2	A – (saddr2)	×	×	×	V	×
	r, saddr	3	r – (saddr)	×	×	×	V	×
	saddr, r	3	(saddr) – r	×	×	×	V	×
	r, sfr	3	r – sfr	×	×	×	V	×
	sfr, r	3	sfr – r	×	×	×	V	×
	saddr, saddr'	4	(saddr) – (saddr')	×	×	×	V	×
	A, [saddrp]	3/4	A – ((saddrp))	×	×	×	V	×
	A, [%saddrg]	3/4	A – ((saddrg))	×	×	×	V	×
	[saddrp], A	3/4	((saddrp)) – A	×	×	×	V	×
	[%saddrg], A	3/4	((saddrg)) – A	×	×	×	V	×
	A, laddr16	4	A – (addr16)	×	×	×	V	×
	A, !!addr24	5	A – (addr24)	×	×	×	V	×
	!addr16, A	4	(addr16) – A	×	×	×	V	×
	!!addr24, A	5	(addr24) – A	×	×	×	V	×
	A, mem	2-5	A – (mem)	×	×	×	V	×
mem, A	2-5	(mem) – A	×	×	×	V	×	

Mnemonic	Operand	Bytes	Operation	Flags				
				S	Z	AC	P/V	CY
AND	A, #byte	2	$A \leftarrow A \wedge \text{byte}$	x	x			P
	r, #byte	3	$r \leftarrow r \wedge \text{byte}$	x	x			P
	saddr, #byte	3/4	$(\text{saddr}) \leftarrow (\text{saddr}) \wedge \text{byte}$	x	x			P
	sfr, #byte	4	$\text{sfr} \leftarrow \text{sfr} \wedge \text{byte}$	x	x			P
	r, r'	2/3	$r \leftarrow r \wedge r'$	x	x			P
	A, saddr2	2	$A \leftarrow A \wedge (\text{saddr}2)$	x	x			P
	r, saddr	3	$r \leftarrow r \wedge (\text{saddr})$	x	x			P
	saddr, r	3	$(\text{saddr}) \leftarrow (\text{saddr}) \wedge r$	x	x			P
	r, sfr	3	$r \leftarrow r \wedge \text{sfr}$	x	x			P
	sfr, r	3	$\text{sfr} \leftarrow \text{sfr} \wedge r$	x	x			P
	saddr, saddr'	4	$(\text{saddr}) \leftarrow (\text{saddr}) \wedge (\text{saddr}')$	x	x			P
	A, [saddrp]	3/4	$A \leftarrow A \wedge ((\text{saddr}p))$	x	x			P
	A, [%saddrg]	3/4	$A \leftarrow A \wedge ((\text{saddr}g))$	x	x			P
	[saddrp], A	3/4	$((\text{saddr}p)) \leftarrow ((\text{saddr}p)) \wedge A$	x	x			P
	[%saddrg], A	3/4	$((\text{saddr}g)) \leftarrow ((\text{saddr}g)) \wedge A$	x	x			P
	A, !addr16	4	$A \leftarrow A \wedge (\text{addr}16)$	x	x			P
	A, !!addr24	5	$A \leftarrow A \wedge (\text{addr}24)$	x	x			P
	!addr16, A	4	$(\text{addr}16) \leftarrow (\text{addr}16) \wedge A$	x	x			P
	!!addr24, A	5	$(\text{addr}24) \leftarrow (\text{addr}24) \wedge A$	x	x			P
	A, mem	2-5	$A \leftarrow A \wedge (\text{mem})$	x	x			P
mem, A	2-5	$(\text{mem}) \leftarrow (\text{mem}) \wedge A$	x	x			P	

Mnemonic	Operand	Bytes	Operation	Flags				
				S	Z	AC	P/V	CY
OR	A, #byte	2	$A \leftarrow A \vee \text{byte}$	x	x			P
	r, #byte	3	$r \leftarrow r \vee \text{byte}$	x	x			P
	saddr, #byte	3/4	$(\text{saddr}) \leftarrow (\text{saddr}) \vee \text{byte}$	x	x			P
	sfr, #byte	4	$\text{sfr} \leftarrow \text{sfr} \vee \text{byte}$	x	x			P
	r, r'	2/3	$r \leftarrow r \vee r'$	x	x			P
	A, saddr2	2	$A \leftarrow A \vee (\text{saddr}2)$	x	x			P
	r, saddr	3	$r \leftarrow r \vee (\text{saddr})$	x	x			P
	saddr, r	3	$(\text{saddr}) \leftarrow (\text{saddr}) \vee r$	x	x			P
	r, sfr	3	$r \leftarrow r \vee \text{sfr}$	x	x			P
	sfr, r	3	$\text{sfr} \leftarrow \text{sfr} \vee r$	x	x			P
	saddr, saddr'	4	$(\text{saddr}) \leftarrow (\text{saddr}) \vee (\text{saddr}')$	x	x			P
	A, [saddrp]	3/4	$A \leftarrow A \vee ((\text{saddrp}))$	x	x			P
	A, [%saddrg]	3/4	$A \leftarrow A \vee ((\text{saddrg}))$	x	x			P
	[saddrp], A	3/4	$((\text{saddrp})) \leftarrow ((\text{saddrp})) \vee A$	x	x			P
	[%saddrg], A	3/4	$((\text{saddrg})) \leftarrow ((\text{saddrg})) \vee A$	x	x			P
	A, !addr16	4	$A \leftarrow A \vee (\text{addr}16)$	x	x			P
	A, !!addr24	5	$A \leftarrow A \vee (\text{saddr}24)$	x	x			P
	!addr16, A	4	$(\text{addr}16) \leftarrow (\text{addr}16) \vee A$	x	x			P
	!!addr24, A	5	$(\text{addr}24) \leftarrow (\text{addr}24) \vee A$	x	x			P
	A, mem	2-5	$A \leftarrow A \vee (\text{mem})$	x	x			P
mem, A	2-5	$(\text{mem}) \leftarrow (\text{mem}) \vee A$	x	x			P	

Mnemonic	Operand	Bytes	Operation	Flags				
				S	Z	AC	P/V	CY
XOR	A, #byte	2	$A \leftarrow A \nabla \text{byte}$	x	x		P	
	r, #byte	3	$r \leftarrow r \nabla \text{byte}$	x	x		P	
	saddr, #byte	3/4	$(\text{saddr}) \leftarrow (\text{saddr}) \nabla \text{byte}$	x	x		P	
	sfr, #byte	4	$\text{sfr} \leftarrow \text{sfr} \nabla \text{byte}$	x	x		P	
	r, r'	2/3	$r \leftarrow r \nabla r'$	x	x		P	
	A, saddr2	2	$A \leftarrow A \nabla (\text{saddr2})$	x	x		P	
	r, saddr	3	$r \leftarrow r \nabla (\text{saddr})$	x	x		P	
	saddr, r	3	$(\text{saddr}) \leftarrow (\text{saddr}) \nabla r$	x	x		P	
	r, sfr	3	$r \leftarrow r \nabla \text{sfr}$	x	x		P	
	sfr, r	3	$\text{sfr} \leftarrow \text{sfr} \nabla r$	x	x		P	
	saddr, saddr'	4	$(\text{saddr}) \leftarrow (\text{saddr}) \nabla (\text{saddr}')$	x	x		P	
	A, [saddrp]	3/4	$A \leftarrow A \nabla ((\text{saddrp}))$	x	x		P	
	A, [%saddrg]	3/4	$A \leftarrow A \nabla ((\text{saddrg}))$	x	x		P	
	[saddrp], A	3/4	$((\text{saddrp})) \leftarrow ((\text{saddrp})) \nabla A$	x	x		P	
	[%saddrg], A	3/4	$((\text{saddrg})) \leftarrow ((\text{saddrg})) \nabla A$	x	x		P	
	A, laddr16	4	$A \leftarrow A \nabla (\text{addr16})$	x	x		P	
	A, !!addr24	5	$A \leftarrow A \nabla (\text{addr24})$	x	x		P	
	!addr16, A	4	$(\text{addr16}) \leftarrow (\text{addr16}) \nabla A$	x	x		P	
	!!addr24, A	5	$(\text{addr24}) \leftarrow (\text{addr24}) \nabla A$	x	x		P	
	A, mem	2-5	$A \leftarrow A \nabla (\text{mem})$	x	x		P	
mem, A	2-5	$(\text{mem}) \leftarrow (\text{mem}) \nabla A$	x	x		P		

(7) 16-bit arithmetic instructions: **ADDW, SUBW, CMPW**

Mnemonic	Operand	Bytes	Operation	Flags				
				S	Z	AC	P/V	CY
ADDW	AX, #word	3	AX, CY ← AX + word	×	×	×	V	×
	rp, #word	4	rp, CY ← rp + word	×	×	×	V	×
	rp, rp'	2	rp, CY ← rp + rp'	×	×	×	V	×
	AX, saddrp2	2	AX, CY ← AX + (saddrp2)	×	×	×	V	×
	rp, saddrp	3	rp, CY ← rp + (saddrp)	×	×	×	V	×
	saddrp, rp	3	(saddrp), CY ← (saddrp) + rp	×	×	×	V	×
	rp, sfrp	3	rp, CY ← rp + sfrp	×	×	×	V	×
	sfrp, rp	3	sfrp, CY ← sfrp + rp	×	×	×	V	×
	saddrp, #word	4/5	(saddrp), CY ← (saddrp) + word	×	×	×	V	×
	sfrp, #word	5	sfrp, CY ← sfrp + word	×	×	×	V	×
	saddrp, saddrp'	4	(saddrp), CY ← (saddrp) + (saddrp')	×	×	×	V	×
SUBW	AX, #word	3	AX, CY ← AX – word	×	×	×	V	×
	rp, #word	4	rp, CY ← rp – word	×	×	×	V	×
	rp, rp'	2	rp, CY ← rp – rp'	×	×	×	V	×
	AX, saddrp2	2	AX, CY ← AX – (saddrp2)	×	×	×	V	×
	rp, saddrp	3	rp, CY ← rp – (saddrp)	×	×	×	V	×
	saddrp, rp	3	(saddrp), CY ← (saddrp) – rp	×	×	×	V	×
	rp, sfrp	3	rp, CY ← rp – sfrp	×	×	×	V	×
	sfrp, rp	3	sfrp, CY ← sfrp – rp	×	×	×	V	×
	saddrp, #word	4/5	(saddrp), CY ← (saddrp) – word	×	×	×	V	×
	sfrp, #word	5	sfrp, CY ← sfrp – word	×	×	×	V	×
	saddrp, saddrp'	4	(saddrp), CY ← (saddrp) – (saddrp')	×	×	×	V	×
CMPW	AX, #word	3	AX – word	×	×	×	V	×
	rp, #word	4	rp – word	×	×	×	V	×
	rp, rp'	2	rp – rp'	×	×	×	V	×
	AX, saddrp2	2	AX – (saddrp2)	×	×	×	V	×
	rp, saddrp	3	rp – (saddrp)	×	×	×	V	×
	saddrp, rp	3	(saddrp) – rp	×	×	×	V	×
	rp, sfrp	3	rp – sfrp	×	×	×	V	×
	sfrp, rp	3	sfrp – rp	×	×	×	V	×
	saddrp, #word	4/5	(saddrp) – word	×	×	×	V	×
	sfrp, #word	5	sfrp – word	×	×	×	V	×
	saddrp, saddrp'	4	(saddrp) – (saddrp')	×	×	×	V	×

(8) 24-bit arithmetic instructions: **ADDG, SUBG**

Mnemonic	Operand	Bytes	Operation	Flags				
				S	Z	AC	P/V	CY
ADDG	rg, rg'	2	rg, CY \leftarrow rg + rg'	x	x	x	V	x
	rg, #imm24	5	rg, CY \leftarrow rg + imm24	x	x	x	V	x
	WHL, saddrg	3	WHL, CY \leftarrow WHL + (saddrg)	x	x	x	V	x
SUBG	rg, rg'	2	rg, CY \leftarrow rg - rg'	x	x	x	V	x
	rg, #imm24	5	rg, CY \leftarrow rg - imm24	x	x	x	V	x
	WHL, saddrg	3	WHL, CY \leftarrow WHL - (saddrg)	x	x	x	V	x

(9) Multiply/divide instructions: **MULU, MULUW, MULW, DIVUW, DIVUX**

Mnemonic	Operand	Bytes	Operation	Flags				
				S	Z	AC	P/V	CY
MULU	r	2/3	AX \leftarrow AXr					
MULUW	rp	2	AX (high order), rp (low order) \leftarrow AXrp					
MULW	rp	2	AX (high order), rp (low order) \leftarrow AXrp					
DIVUW	r	2/3	AX (quotient), r (remainder) \leftarrow AX \div r ^{Note 1}					
DIVUX	rp	2	AXDE (quotient), rp (remainder) \leftarrow AXDE \div rp ^{Note 2}					

- Notes**
1. When r = 0, r \leftarrow X, AX \leftarrow FFFFH
 2. When rp = 0, rp \leftarrow DE, AXDE \leftarrow FFFFFFFFH

(10) Special arithmetic instructions: **MACW, MACSW, SACW**

Mnemonic	Operand	Bytes	Operation	Flags				
				S	Z	AC	P/V	CY
MACW	byte	3	AXDE \leftarrow (B) X (C) + AXDE, B \leftarrow B + 2, C \leftarrow C + 2, byte \leftarrow byte - 1 End if (byte = 0 or P/V = 1)	x	x	x	V	x
MACSW	byte	3	AXDE \leftarrow (B) X (C) + AXDE, B \leftarrow B + 2, C \leftarrow C + 2, byte \leftarrow byte - 1 if byte = 0 then End if P/V = 1 then if overflow AXDE \leftarrow 7FFFFFFFH, End if underflow AXDE \leftarrow 80000000H, End	x	x	x	V	x
SACW	[TDE+], [WHL+]	4	AX \leftarrow (TDE) - (WHL) + AX, TDE \leftarrow TDE + 2, WHL \leftarrow WHL + 2 C \leftarrow C - 1 End if (C = 0 or CY = 1)	x	x	x	V	x

(11) Increment and decrement instructions: INC, DEC, INCW, DECW, INCG, DECG

Mnemonic	Operand	Bytes	Operation	Flags				
				S	Z	AC	P/V	CY
INC	r	1/2	$r \leftarrow r + 1$	x	x	x	V	
	saddr	2/3	$(saddr) \leftarrow (saddr) + 1$	x	x	x	V	
DEC	r	1/2	$r \leftarrow r - 1$	x	x	x	V	
	saddr	2/3	$(saddr) \leftarrow (saddr) - 1$	x	x	x	V	
INCW	rp	2/1	$rp \leftarrow rp + 1$					
	saddrp	3/4	$(saddrp) \leftarrow (saddrp) + 1$					
DECW	rp	2/1	$rp \leftarrow rp - 1$					
	saddrp	3/4	$(saddrp) \leftarrow (saddrp) - 1$					
INCG	rg	2	$rg \leftarrow rg + 1$					
DECG	rg	2	$rg \leftarrow rg - 1$					

(12) Decimal adjust instructions: ADJBA, ADJBS, CVTBW

Mnemonic	Operand	Bytes	Operation	Flags				
				S	Z	AC	P/V	CY
ADJBA		2	Decimal Adjust Accumulator after Addition	x	x	x	P	x
ADJBS		2	Decimal Adjust Accumulator after Subtract	x	x	x	P	x
CVTBW		1	$X \leftarrow A, A \leftarrow 00H$ if $A_7 = 0$ $X \leftarrow A, A \leftarrow FFH$ if $A_7 = 1$					

(13) Shift and rotate instructions: ROR, ROL, RORC, ROLC, SHR, SHL, SHRW, SHLW, ROR4, ROL4

Mnemonic	Operand	Bytes	Operation	Flags				
				S	Z	AC	P/V	CY
ROR	r, n	2/3	$(CY, r_7 \leftarrow r_0, r_{m-1} \leftarrow r_m) \times n$ $n = 0 \text{ to } 7$				P	×
ROL	r, n	2/3	$(CY, r_0 \leftarrow r_7, r_{m+1} \leftarrow r_m) \times n$ $n = 0 \text{ to } 7$				P	×
RORC	r, n	2/3	$(CY \leftarrow r_0, r_7 \leftarrow CY, r_{m-1} \leftarrow r_m) \times n$ $n = 0 \text{ to } 7$				P	×
ROLC	r, n	2/3	$(CY \leftarrow r_7, r_0 \leftarrow CY, r_{m+1} \leftarrow r_m) \times n$ $n = 0 \text{ to } 7$				P	×
SHR	r, n	2/3	$(CY \leftarrow r_0, r_7 \leftarrow 0, r_{m-1} \leftarrow r_m) \times n$ $n = 0 \text{ to } 7$	×	×	0	P	×
SHL	r, n	2/3	$(CY \leftarrow r_7, r_0 \leftarrow 0, r_{m+1} \leftarrow r_m) \times n$ $n = 0 \text{ to } 7$	×	×	0	P	×
SHRW	rp, n	2	$(CY \leftarrow rp_0, rp_{15} \leftarrow 0, rp_{m-1} \leftarrow rp_m) \times n$ $n = 0 \text{ to } 7$	×	×	0	P	×
SHLW	rp, n	2	$(CY \leftarrow rp_{15}, rp_0 \leftarrow 0, rp_{m+1} \leftarrow rp_m) \times n$ $n = 0 \text{ to } 7$	×	×	0	P	×
ROR4	mem3	2	$A_{3-0} \leftarrow (\text{mem3})_{3-0}, (\text{mem3})_{7-4} \leftarrow A_{3-0},$ $(\text{mem3})_{3-0} \leftarrow (\text{mem3})_{7-4}$					
ROL4	mem3	2	$A_{3-0} \leftarrow (\text{mem3})_{7-4}, (\text{mem3})_{3-0} \leftarrow A_{3-0},$ $(\text{mem3})_{7-4} \leftarrow (\text{mem3})_{3-0}$					

(14) Bit manipulation instructions: MOV1, AND1, OR1, XOR1, NOT1, SET1, CLR1

Mnemonic	Operand	Bytes	Operation	Flags				
				S	Z	AC	P/V	CY
MOV1	CY, saddr.bit	3/4	$CY \leftarrow (\text{saddr.bit})$					×
	CY, sfr.bit	3	$CY \leftarrow \text{sfr.bit}$					×
	CY, X.bit	2	$CY \leftarrow X.bit$					×
	CY, A.bit	2	$CY \leftarrow A.bit$					×
	CY, PSWL.bit	2	$CY \leftarrow \text{PSWL.bit}$					×
	CY, PSWH.bit	2	$CY \leftarrow \text{PSWH.bit}$					×
	CY, !addr16.bit	5	$CY \leftarrow !\text{addr16.bit}$					×
	CY, !!addr24.bit	2	$CY \leftarrow !!\text{addr24.bit}$					×
	CY, mem2.bit	2	$CY \leftarrow \text{mem2.bit}$					×
	saddr.bit, CY	3/4	$(\text{saddr.bit}) \leftarrow CY$					
	sfr.bit, CY	3	$\text{sfr.bit} \leftarrow CY$					
	X.bit, CY	2	$X.bit \leftarrow CY$					
	A.bit, CY	2	$A.bit \leftarrow CY$					
	PSWL.bit, CY	2	$\text{PSWL.bit} \leftarrow CY$	×	×	×	×	×
	PSWH.bit, CY	2	$\text{PSWH.bit} \leftarrow CY$					
	!addr16.bit, CY	5	$!\text{addr16.bit} \leftarrow CY$					
	!!addr24.bit, CY	6	$!!\text{addr24.bit} \leftarrow CY$					
	mem2.bit, CY	2	$\text{mem2.bit} \leftarrow CY$					

Mnemonic	Operand	Bytes	Operation	Flags					
				S	Z	AC	P/V	CY	
AND1	CY, saddr.bit	3/4	$CY \leftarrow CY \wedge (\text{saddr.bit})$						x
	CY, /saddr.bit	3/4	$CY \leftarrow CY \wedge \overline{(\text{saddr.bit})}$						x
	CY, sfr.bit	3	$CY \leftarrow CY \wedge \text{sfr.bit}$						x
	CY, /sfr.bit	3	$CY \leftarrow CY \wedge \overline{\text{sfr.bit}}$						x
	CY, X.bit	2	$CY \leftarrow CY \wedge X.\text{bit}$						x
	CY, /X.bit	2	$CY \leftarrow CY \wedge \overline{X.\text{bit}}$						x
	CY, A.bit	2	$CY \leftarrow CY \wedge A.\text{bit}$						x
	CY, /A.bit	2	$CY \leftarrow CY \wedge \overline{A.\text{bit}}$						x
	CY, PSWL.bit	2	$CY \leftarrow CY \wedge \text{PSWL.bit}$						x
	CY, /PSWL.bit	2	$CY \leftarrow CY \wedge \overline{\text{PSWL.bit}}$						x
	CY, PSWH.bit	2	$CY \leftarrow CY \wedge \text{PSWH.bit}$						x
	CY, /PSWH.bit	2	$CY \leftarrow CY \wedge \overline{\text{PSWH.bit}}$						x
	CY, laddr16.bit	5	$CY \leftarrow CY \wedge \text{laddr16.bit}$						x
	CY, /laddr16.bit	5	$CY \leftarrow CY \wedge \overline{\text{laddr16.bit}}$						x
	CY, !!addr24.bit	2	$CY \leftarrow CY \wedge \text{!!addr24.bit}$						x
	CY, /!addr24.bit	6	$CY \leftarrow CY \wedge \overline{\text{!addr24.bit}}$						x
	CY, mem2.bit	2	$CY \leftarrow CY \wedge \text{mem2.bit}$						x
	CY, /mem2.bit	2	$CY \leftarrow CY \wedge \overline{\text{mem2.bit}}$						x
OR1	CY, saddr.bit	3/4	$CY \leftarrow CY \vee (\text{saddr.bit})$						x
	CY, /saddr.bit	3/4	$CY \leftarrow CY \vee \overline{(\text{saddr.bit})}$						x
	CY, sfr.bit	3	$CY \leftarrow CY \vee \text{sfr.bit}$						x
	CY, /sfr.bit	3	$CY \leftarrow CY \vee \overline{\text{sfr.bit}}$						x
	CY, X.bit	2	$CY \leftarrow CY \vee X.\text{bit}$						x
	CY, /X.bit	2	$CY \leftarrow CY \vee \overline{X.\text{bit}}$						x
	CY, A.bit	2	$CY \leftarrow CY \vee A.\text{bit}$						x
	CY, /A.bit	2	$CY \leftarrow CY \vee \overline{A.\text{bit}}$						x
	CY, PSWL.bit	2	$CY \leftarrow CY \vee \text{PSWL.bit}$						x
	CY, /PSWL.bit	2	$CY \leftarrow CY \vee \overline{\text{PSWL.bit}}$						x
	CY, PSWH.bit	2	$CY \leftarrow CY \vee \text{PSWH.bit}$						x
	CY, /PSWH.bit	2	$CY \leftarrow CY \vee \overline{\text{PSWH.bit}}$						x
	CY, laddr16.bit	5	$CY \leftarrow CY \vee \text{laddr16.bit}$						x
	CY, /laddr16.bit	5	$CY \leftarrow CY \vee \overline{\text{laddr16.bit}}$						x
	CY, !!addr24.bit	2	$CY \leftarrow CY \vee \text{!!addr24.bit}$						x
	CY, /!addr24.bit	6	$CY \leftarrow CY \vee \overline{\text{!addr24.bit}}$						x
	CY, mem2.bit	2	$CY \leftarrow CY \vee \text{mem2.bit}$						x
	CY, /mem2.bit	2	$CY \leftarrow CY \vee \overline{\text{mem2.bit}}$						x

Mnemonic	Operand	Bytes	Operation	Flags					
				S	Z	AC	P/V	CY	
XOR1	CY, saddr.bit	3/4	$CY \leftarrow CY \nabla (saddr.bit)$						x
	CY, sfr.bit	3	$CY \leftarrow CY \nabla sfr.bit$						x
	CY, X.bit	2	$CY \leftarrow CY \nabla X.bit$						x
	CY, A.bit	2	$CY \leftarrow CY \nabla A.bit$						x
	CY, PSWL.bit	2	$CY \leftarrow CY \nabla PSWL.bit$						x
	CY, PSWH.bit	2	$CY \leftarrow CY \nabla PSWH.bit$						x
	CY, !addr16.bit	5	$CY \leftarrow CY \nabla !addr16.bit$						x
	CY, !!addr24.bit	2	$CY \leftarrow CY \nabla !!addr24.bit$						x
	CY, mem2.bit	2	$CY \leftarrow CY \nabla mem2.bit$						x
NOT1	saddr.bit	3/4	$(saddr.bit) \leftarrow \overline{(saddr.bit)}$						
	sfr.bit	3	$sfr.bit \leftarrow \overline{sfr.bit}$						
	X.bit	2	$X.bit \leftarrow \overline{X.bit}$						
	A.bit	2	$A.bit \leftarrow \overline{A.bit}$						
	PSWL.bit	2	$PSWL.bit \leftarrow \overline{PSWL.bit}$	x	x	x	x	x	x
	PSWH.bit	2	$PSWH.bit \leftarrow \overline{PSWH.bit}$						
	!addr16.bit	5	$!addr16.bit \leftarrow \overline{!addr16.bit}$						
	!!addr24.bit	2	$!!addr24.bit \leftarrow \overline{!!addr24.bit}$						
	mem2.bit	2	$mem2.bit \leftarrow \overline{mem2.bit}$						
	CY	1	$CY \leftarrow \overline{CY}$						x
SET1	saddr.bit	2/3	$(saddr.bit) \leftarrow 1$						
	sfr.bit	3	$sfr.bit \leftarrow 1$						
	X.bit	2	$X.bit \leftarrow 1$						
	A.bit	2	$A.bit \leftarrow 1$						
	PSWL.bit	2	$PSWL.bit \leftarrow 1$	x	x	x	x	x	x
	PSWH.bit	2	$PSWH.bit \leftarrow 1$						
	!addr16.bit	5	$!addr16.bit \leftarrow 1$						
	!!addr24.bit	2	$!!addr24.bit \leftarrow 1$						
	mem2.bit	2	$mem2.bit \leftarrow 1$						
	CY	1	$CY \leftarrow 1$						1
CLR1	saddr.bit	2/3	$(saddr.bit) \leftarrow 0$						
	sfr.bit	3	$sfr.bit \leftarrow 0$						
	X.bit	2	$X.bit \leftarrow 0$						
	A.bit	2	$A.bit \leftarrow 0$						
	PSWL.bit	2	$PSWL.bit \leftarrow 0$	x	x	x	x	x	x
	PSWH.bit	2	$PSWH.bit \leftarrow 0$						
	!addr16.bit	5	$!addr16.bit \leftarrow 0$						
	!!addr24.bit	2	$!!addr24.bit \leftarrow 0$						
	mem2.bit	2	$mem2.bit \leftarrow 0$						
	CY	1	$CY \leftarrow 0$						0

(15) Stack manipulation instructions: PUSH, PUSHU, POP, POPU, MOVG, ADDWG, SUBWG, INCG, DECG

Mnemonic	Operand	Bytes	Operation	Flags				
				S	Z	AC	P/V	CY
PUSH	PSW	1	$(SP - 2) \leftarrow PSW, SP \leftarrow SP - 2$					
	sfrp	3	$(SP - 2) \leftarrow sfrp, SP \leftarrow SP - 2$					
	sfr	3	$(SP - 1) \leftarrow sfr, SP \leftarrow SP - 1$					
	post	2	$\{(SP - 2) \leftarrow post, SP \leftarrow SP - 2\} \times m$ ^{Note}					
	rg	2	$(SP - 3) \leftarrow rg, SP \leftarrow SP - 3$					
PUSHU	post	2	$\{(UUP - 2) \leftarrow post, UUP \leftarrow UUP - 2\} \times m$ ^{Note}					
POP	PSW	1	$PSW \leftarrow (SP), SP \leftarrow SP + 2$	R	R	R	R	R
	sfrp	3	$sfrp \leftarrow (SP), SP \leftarrow SP + 2$					
	sfr	3	$sfr \leftarrow (SP), SP \leftarrow SP + 1$					
	post	2	$\{post \leftarrow (SP), SP \leftarrow SP + 2\} \times m$ ^{Note}					
	rg	2	$rg \leftarrow (SP), SP \leftarrow SP + 3$					
POPU	post	2	$\{post \leftarrow (UUP), UUP \leftarrow UUP + 2\} \times m$ ^{Note}					
MOVG	SP, #imm24	5	$SP \leftarrow imm24$					
	SP, WHL	2	$SP \leftarrow WHL$					
	WHL, SP	2	$WHL \leftarrow SP$					
ADDWG	SP, #word	4	$SP \leftarrow SP + word$					
SUBWG	SP, #word	4	$SP \leftarrow SP - word$					
INCG	SP	2	$SP \leftarrow SP + 1$					
DECG	SP	2	$SP \leftarrow SP - 1$					

Note m is the number of registers specified by post.

(16) Call return instructions: CALL, CALLF, CALLT, BRK, BRKCS, RET, RETI, RETB, RETCS, RETCSB

Mnemonic	Operand	Bytes	Operation	Flags				
				S	Z	AC	P/V	CY
CALL	!addr16	3	$(SP - 3) \leftarrow (PC + 3)$, $SP \leftarrow SP - 3$, $PC_{HW} \leftarrow 0$, $PC_{LW} \leftarrow \text{addr16}$					
	!!addr20	4	$(SP - 3) \leftarrow (PC + 4)$, $SP \leftarrow SP - 3$, $PC \leftarrow \text{addr20}$					
	rp	2	$(SP - 3) \leftarrow (PC + 2)$, $SP \leftarrow SP - 3$, $PC_{HW} \leftarrow 0$, $PC_{LW} \leftarrow rp$					
	rg	2	$(SP - 3) \leftarrow (PC + 2)$, $SP \leftarrow SP - 3$, $PC \leftarrow rg$					
	[rp]	2	$(SP - 3) \leftarrow (PC + 2)$, $SP \leftarrow SP - 3$, $PC_{HW} \leftarrow 0$, $PC_{LW} \leftarrow (rp)$					
	[rg]	2	$(SP - 3) \leftarrow (PC + 2)$, $SP \leftarrow SP - 3$, $PC \leftarrow (rg)$					
	!addr20	3	$(SP - 3) \leftarrow (PC + 3)$, $SP \leftarrow SP - 3$, $PC \leftarrow PC + 3 + \text{jdisp16}$					
CALLF	!addr11	2	$(SP - 3) \leftarrow (PC + 2)$, $SP \leftarrow SP - 3$ $PC_{19-12} \leftarrow 0$, $PC_{11} \leftarrow 1$, $PC_{10-0} \leftarrow \text{addr11}$					
CALLT	[addr5]	1	$(SP - 3) \leftarrow (PC + 1)$, $SP \leftarrow SP - 3$ $PC_{HW} \leftarrow 0$, $PC_{CW} \leftarrow (\text{addr5})$					
BRK		1	$(SP - 2) \leftarrow PSW$, $(SP - 1)_{0-3} \leftarrow (PC + 1)_{HW}$, $(SP - 4) \leftarrow (PC + 1)_{LW}$, $SP \leftarrow SP - 4$ $PC_{HW} \leftarrow 0$, $PC_{LW} \leftarrow (003EH)$					
BRKCS	RBn	2	$PC_{LW} \leftarrow RP2$, $RP3 \leftarrow PSW$, $RBS2 - 0 \leftarrow n$, $RSS \leftarrow 0$, $IE \leftarrow 0$, $RP3_{8-11} \leftarrow PC_{HW}$, $PC_{HW} \leftarrow 0$					
RET		1	$PC \leftarrow (SP)$, $SP \leftarrow SP + 3$					
RETI		1	$PC_{LW} \leftarrow (SP)$, $PC_{HW} \leftarrow (SP + 3)_{0-3}$, $PSW \leftarrow (SP + 2)$, $SP \leftarrow SP + 4$ The flag with the highest priority that is set to 1 in the ISPR is cleared to 0.	R	R	R	R	R
RETB		1	$PC_{LW} \leftarrow (SP)$, $PC_{HW} \leftarrow (SP + 3)_{0-3}$, $PSW \leftarrow (SP + 2)$, $SP \leftarrow SP + 4$	R	R	R	R	R
RETCS	!addr16	3	$PSW \leftarrow RP3$, $PC_{LW} \leftarrow RP2$, $RP2 \leftarrow \text{addr16}$, $PC_{HW} \leftarrow RP3_{8-11}$ The flag with the highest priority that is set to 1 in the ISPR is cleared to 0.	R	R	R	R	R
RETCSB	!addr16	4	$PSW \leftarrow RP3$, $PC_{LW} \leftarrow RP2$, $RP2 \leftarrow \text{addr16}$, $PC_{HW} \leftarrow RP3_{8-11}$	R	R	R	R	R

(17) Unconditional branch instruction: BR

Mnemonic	Operand	Bytes	Operation	Flags				
				S	Z	AC	P/V	CY
BR	!addr16	3	PC _{HW} ← 0, PC _{LW} ← addr16					
	!!addr20	4	PC ← addr20					
	rp	2	PC _{HW} ← 0, PC _{LW} ← rp					
	rg	2	PC ← rg					
	[rp]	2	PC _{HW} ← 0, PC _{LW} ← (rp)					
	[rg]	2	PC ← (rg)					
	\$addr20	2	PC ← PC + 2 + jdisp8					
	!addr20	3	PC ← PC + 3 + jdisp16					

(18) Conditional branch instructions: **BNZ, BNE, BZ, BE, BNC, BNL, BC, BL, BNV, BPO, BV, BPE, BP, BN, BLT, BGE, BLE, BGT, BNH, BH, BF, BT, BTCLR, BFSET, DBNZ**

Mnemonic	Operand	Bytes	Operation	Flags				
				S	Z	AC	P/V	CY
BNZ	\$addr20	2	$PC \leftarrow PC + 2 + jdisp8$ if Z = 0					
BNE								
BZ	\$addr20	2	$PC \leftarrow PC + 2 + jdisp8$ if Z = 1					
BE								
BNC	\$addr20	2	$PC \leftarrow PC + 2 + jdisp8$ if CY = 0					
BNL								
BC	\$addr20	2	$PC \leftarrow PC + 2 + jdisp8$ if CY = 1					
BL								
BNV	\$addr20	2	$PC \leftarrow PC + 2 + jdisp8$ if P/V = 0					
BPO								
BV	\$addr20	2	$PC \leftarrow PC + 2 + jdisp8$ if P/V = 1					
BPE								
BP	\$addr20	2	$PC \leftarrow PC + 2 + jdisp8$ if S = 0					
BN	\$addr20	2	$PC \leftarrow PC + 2 + jdisp8$ if S = 1					
BLT	\$addr20	3	$PC \leftarrow PC + 3 + jdisp8$ if P/V ∇ S = 1					
BGE	\$addr20	3	$PC \leftarrow PC + 3 + jdisp8$ if P/V ∇ S = 0					
BLE	\$addr20	3	$PC \leftarrow PC + 3 + jdisp8$ if (P/V ∇ S) \vee Z = 1					
BGT	\$addr20	3	$PC \leftarrow PC + 3 + jdisp8$ if (P/V ∇ S) \vee Z = 0					
BNH	\$addr20	3	$PC \leftarrow PC + 3 + jdisp8$ if ZVCY = 1					
BH	\$addr20	3	$PC \leftarrow PC + 3 + jdisp8$ if ZVCY = 0					
BF	saddr.bit, \$addr20	4/5	$PC \leftarrow PC + 4^{Note} + jdisp8$ if (saddr.bit) = 0					
	sfr.bit, \$addr20	4	$PC \leftarrow PC + 4 + jdisp8$ if sfr.bit = 0					
	X.bit, \$addr20	3	$PC \leftarrow PC + 3 + jdisp8$ if X.bit = 0					
	A.bit, \$addr20	3	$PC \leftarrow PC + 3 + jdisp8$ if A.bit = 0					
	PSWL.bit, \$addr20	3	$PC \leftarrow PC + 3 + jdisp8$ if PSWL.bit = 0					
	PSWH.bit, \$addr20	3	$PC \leftarrow PC + 3 + jdisp8$ if PSWH.bit = 0					
	!addr16.bit, \$addr20	6	$PC \leftarrow PC + 3 + jdisp8$ if !addr16.bit = 0					
	!!addr24.bit, \$addr20	3	$PC \leftarrow PC + 3 + jdisp8$ if !!addr24.bit = 0					
mem2.bit, \$addr20	3	$PC \leftarrow PC + 3 + jdisp8$ if mem2.bit = 0						

Note This is used when the number of bytes is four. When five, it becomes $PC \leftarrow PC + 5 + jdisp8$.

Mnemonic	Operand	Bytes	Operation	Flags				
				S	Z	AC	P/V	CY
BT	saddr.bit, \$addr20	3/4	$PC \leftarrow PC + 3^{\text{Note 1}} + \text{jdisp8}$ if (saddr.bit) = 1					
	sfr.bit, \$addr20	4	$PC \leftarrow PC + 4 + \text{jdisp8}$ if sfr.bit = 1					
	X.bit, \$addr20	3	$PC \leftarrow PC + 3 + \text{jdisp8}$ if X.bit = 1					
	A.bit, \$addr20	3	$PC \leftarrow PC + 3 + \text{jdisp8}$ if A.bit = 1					
	PSWL.bit, \$addr20	3	$PC \leftarrow PC + 3 + \text{jdisp8}$ if PSWL.bit = 1					
	PSWH.bit, \$addr20	3	$PC \leftarrow PC + 3 + \text{jdisp8}$ if PSWH.bit = 1					
	!addr16.bit, \$addr20	6	$PC \leftarrow PC + 3 + \text{jdisp8}$ if !addr16.bit = 1					
	!!addr24.bit, \$addr20	3	$PC \leftarrow PC + 3 + \text{jdisp8}$ if !!addr24.bit = 1					
mem2.bit, \$addr20	3	$PC \leftarrow PC + 3 + \text{jdisp8}$ if mem2.bit = 1						
BTCLR	saddr.bit, \$addr20	4/5	{ $PC \leftarrow PC + 4^{\text{Note 2}} + \text{jdisp8}$, (saddr.bit) \leftarrow 0} if (saddr.bit = 1)					
	sfr.bit, \$addr20	4	{ $PC \leftarrow PC + 4 + \text{jdisp8}$, sfr.bit \leftarrow 0} if sfr.bit = 1					
	X.bit, \$addr20	3	{ $PC \leftarrow PC + 3 + \text{jdisp8}$, X.bit \leftarrow 0} if X.bit = 1					
	A.bit, \$addr20	3	{ $PC \leftarrow PC + 3 + \text{jdisp8}$, A.bit \leftarrow 0} if A.bit = 1					
	PSWL.bit, \$addr20	3	{ $PC \leftarrow PC + 3 + \text{jdisp8}$, PSWL.bit \leftarrow 0} if PSWL.bit = 1	x	x	x	x	x
	PSWH.bit, \$addr20	3	{ $PC \leftarrow PC + 3 + \text{jdisp8}$, PSWH.bit \leftarrow 0} if PSWH.bit = 1					
	!addr16.bit, \$addr20	6	{ $PC \leftarrow PC + 3 + \text{jdisp8}$, !addr16.bit \leftarrow 0} if !addr16.bit = 1					
	!!addr24.bit, \$addr20	3	{ $PC \leftarrow PC + 3 + \text{jdisp8}$, !!addr24.bit \leftarrow 0} if !!addr24.bit = 1					
	mem2.bit, \$addr20	3	{ $PC \leftarrow PC + 3 + \text{jdisp8}$, mem2.bit \leftarrow 0} if mem2.bit = 1					

Notes 1. This is used when the number of bytes is three. When four, it becomes $PC \leftarrow PC + 4 + \text{jdisp8}$.

2. This is used when the number of bytes is four. When five, it becomes $PC \leftarrow PC + 5 + \text{jdisp8}$.

Mnemonic	Operand	Bytes	Operation	Flags				
				S	Z	AC	P/V	CY
BFSET	saddr.bit, \$addr20	4/5	{PC ← PC + 4 ^{Note 2} + jdisp8, (saddr.bit) ← 1} if (saddr.bit = 0)					
	sfr.bit, \$addr20	4	{PC ← PC + 4 + jdisp8, sfr.bit ← 1} if sfr.bit = 0					
	X.bit, \$addr20	3	{PC ← PC + 3 + jdisp8, X.bit ← 1} if X.bit = 0					
	A.bit, \$addr20	3	{PC ← PC + 3 + jdisp8, A.bit ← 1} if A.bit = 0					
	PSWL.bit, \$addr20	3	{PC ← PC + 3 + jdisp8, PSWL.bit ← 1} if PSWL.bit = 0	×	×	×	×	×
	PSWH.bit, \$addr20	3	{PC ← PC + 3 + jdisp8, PSWH.bit ← 1} if PSWH.bit = 0					
	!addr16.bit, \$addr20	6	{PC ← PC + 3 + jdisp8, !addr16.bit ← 1} if !addr16.bit = 0					
	!!addr24.bit, \$addr20	3	{PC ← PC + 3 + jdisp8, !!addr24.bit ← 1} if !!addr24.bit = 0					
	mem2.bit, \$addr20	3	{PC ← PC + 3 + jdisp8, mem2.bit ← 1} if mem2.bit = 0					
DBNZ	B, \$addr20	2	B ← B - 1, PC ← PC + 2 + jdisp8 if B ≠ 0					
	C, \$addr20	2	C ← C - 1, PC ← PC + 2 + jdisp8 if C ≠ 0					
	saddr, \$addr20	3/4	(saddr) ← (saddr) - 1, PC ← PC + 3 ^{Note 1} + jdisp8 if (saddr) ≠ 0					

- Notes** 1. This is used when the number of bytes is three. When four, it becomes PC ← PC + 4 + jdisp8.
 2. This is used when the number of bytes is four. When five, it becomes PC ← PC + 5 + jdisp8.

(19) CPU control instructions: MOV, LOCATION, SEL, SWRS, NOP, EI, DI

Mnemonic	Operand	Bytes	Operation	Flags				
				S	Z	AC	P/V	CY
MOV	STBC, #byte	4	STBC ← byte					
	WDM, #byte	4	WDM ← byte					
LOCATION	locaddr	4	Specification of the high-order word of the location address of the SFR and internal data area					
SEL	RBn	2	RSS ← 0, RBS2 - 0 ← n					
	RBn, ALT	2	RSS ← 1, RBS2 - 0 ← n					
SWRS		2	RSS ← $\overline{\text{RSS}}$					
NOP		1	No operation					
EI		1	IE ← 1 (Enable interrupt)					
DI		1	IE ← 0 (Disable interrupt)					

(20) String instructions: **MOVTBLW, MOVMM, XCHM, MOVBK, XCHBK, CMPME, CMPMNE, CMPMC, CMPMNC, CMPBKE, CMPBKNE, CMPBKC, CMPBKNC**

Mnemonic	Operand	Bytes	Operation	Flags				
				S	Z	AC	P/V	CY
MOVTBLW	!addr8, byte	4	(addr8 + 2) ← (addr8), byte ← byte - 1, addr8 ← addr8 - 2 End if byte = 0					
MOVMM	[TDE+], A	2	(TDE) ← A, TDE ← TDE + 1, C ← C - 1 End if C = 0					
	[TDE-], A	2	(TDE) ← A, TDE ← TDE - 1, C ← C - 1 End if C = 0					
XCHM	[TDE+], A	2	(TDE) ↔ A, TDE ← TDE + 1, C ← C - 1 End if C = 0					
	[TDE-], A	2	(TDE) ↔ A, TDE ← TDE - 1, C ← C - 1 End if C = 0					
MOVBK	[TDE+], [WHL+]	2	(TDE) ← (WHL), TDE ← TDE + 1, WHL ← WHL + 1, C ← C - 1 End if C = 0					
	[TDE-], [WHL-]	2	(TDE) ← (WHL), TDE ← TDE - 1, WHL ← WHL - 1, C ← C - 1 End if C = 0					
XCHBK	[TDE+], [WHL+]	2	(TDE) ↔ (WHL), TDE ← TDE + 1, WHL ← WHL + 1, C ← C - 1 End if C = 0					
	[TDE-], [WHL-]	2	(TDE) ↔ (WHL), TDE ← TDE - 1, WHL ← WHL - 1, C ← C - 1 End if C = 0					
CMPME	[TDE+], A	2	(TDE) - A, TDE ← TDE + 1, C ← C - 1 End if C = 0 or Z = 0	x	x	x	V	x
	[TDE-], A	2	(TDE) - A, TDE ← TDE - 1, C ← C - 1 End if C = 0 or Z = 0	x	x	x	V	x
CMPMNE	[TDE+], A	2	(TDE) - A, TDE ← TDE + 1, C ← C - 1 End if C = 0 or Z = 1	x	x	x	V	x
	[TDE-], A	2	(TDE) - A, TDE ← TDE - 1, C ← C - 1 End if C = 0 or Z = 1	x	x	x	V	x
CMPMC	[TDE+], A	2	(TDE) - A, TDE ← TDE + 1, C ← C - 1 End if C = 0 or CY = 0	x	x	x	V	x
	[TDE-], A	2	(TDE) - A, TDE ← TDE - 1, C ← C - 1 End if C = 0 or CY = 0	x	x	x	V	x
CMPMNC	[TDE+], A	2	(TDE) - A, TDE ← TDE + 1, C ← C - 1 End if C = 0 or CY = 1	x	x	x	V	x
	[TDE-], A	2	(TDE) - A, TDE ← TDE - 1, C ← C - 1 End if C = 0 or CY = 1	x	x	x	V	x
CMPBKE	[TDE+], [WHL+]	2	(TDE) - (WHL), TDE ← TDE + 1, WHL ← WHL + 1, C ← C - 1 End if C = 0 or Z = 0	x	x	x	V	x
	[TDE-], [WHL-]	2	(TDE) - (WHL), TDE ← TDE - 1, WHL ← WHL - 1, C ← C - 1 End if C = 0 or Z = 0	x	x	x	V	x

Mnemonic	Operand	Bytes	Operation	Flags				
				S	Z	AC	P/V	CY
CMPBKNE	[TDE+], [WHL+]	2	(TDE) – (WHL), TDE ← TDE + 1, WHL ← WHL + 1, C ← C – 1 End if C = 0 or Z = 1	x	x	x	V	x
	[TDE–], [WHL–]	2	(TDE) – (WHL), TDE ← TDE – 1, WHL ← WHL – 1, C ← C – 1 End if C = 0 or Z = 1	x	x	x	V	x
CMPBKC	[TDE+], [WHL+]	2	(TDE) – (WHL), TDE ← TDE + 1, WHL ← WHL + 1, C ← C – 1 End if C = 0 or CY = 0	x	x	x	V	x
	[TDE–], [WHL–]	2	(TDE) – (WHL), TDE ← TDE – 1, WHL ← WHL – 1, C ← C – 1 End if C = 0 or CY = 0	x	x	x	V	x
CMPBKNC	[TDE+], [WHL+]	2	(TDE) – (WHL), TDE ← TDE + 1, WHL ← WHL + 1, C ← C – 1 End if C = 0 or CY = 1	x	x	x	V	x
	[TDE–], [WHL–]	2	(TDE) – (WHL), TDE ← TDE – 1, WHL ← WHL – 1, C ← C – 1 End if C = 0 or CY = 1	x	x	x	V	x

29.3 Lists of Addressing Instructions

(1) 8-bit instructions (combinations expressed by writing **A** for *r* are shown in parentheses)

MOV, XCH, ADD, ADDC, SUB, SUBC, AND OR XOR, CMP, MULU, DIVUW, INC, DEC, ROR, ROL, RORC, ROLC, SHR, SHL, ROR4, ROL4, DBNZ, PUSH, POP, MOV_M, XCH_M, CMP_{ME}, CMP_{MNE}, CMP_{MNC}, CMP_{MC}, MOV_{BK}, XCH_{BK}, CMP_{BKE}, CMP_{BKNE}, CMP_{BKNC}, CMP_{BKC}

Table 29-1. 8-Bit Addressing Instructions (1/2)

2nd Operand 1st Operand	# byte	A	r r'	saddr saddr'	sfr
A	(MOV) ADD Note 1	(MOV) (XCH) (ADD) Note 1	MOV XCH (ADD) Note 1	(MOV) Note 6 (XCH) Note 6 (ADD) Notes 1, 6	MOV (XCH) (ADD) Note 1
r	MOV ADD Note 1	(MOV) (XCH) (ADD) Note 1	MOV XCH ADD Note 1	MOV XCH ADD Note 1	MOV XCH ADD Note 1
saddr	MOV ADD Note 1	(MOV) Note 6 (ADD) Note 1	MOV ADD Note 1	MOV XCH ADD Note 1	
sfr	MOV ADD Note 1	MOV (ADD) Note 1	MOV ADD Note 1		
!addr16 !!addr24	MOV	(MOV) ADD Note 1	MOV		
mem [saddrp] [%saddrg]		MOV ADD Note 1			
mem3					
r3 PSWL PSWH	MOV	MOV			
B, C					
STBC, WDM	MOV				
[TDE +] [TDE -]		(MOV) (ADD) Note 1 MOV _M Note 4			

(See the following page for the explanation of **Note**.)

Table 29-1. 8-Bit Addressing Instructions (2/2)

2nd Operand 1st Operand	!addr16 !!addr24	mem [saddrp] [%saddrg]	r3 PSWL PSWH	[WHL +] [WHL -]	n	None Note 2
A	(MOV) (XCH) ADD Note 1	MOV XCH ADD Note 1	MOV	(MOV) (XCH) (ADD) Note 1		
r	MOV XCH				ROR Note 3	MULU DIVUW INC DEC
saddr						INC DEC DBNZ
sfr						PUSH POP
!addr16 !!addr24						
mem [saddrp] [%saddrg]						
mem3						ROR4 ROL4
r3 PSWL PSWH						
B, C						DBNZ
STBC, WDM						
[TDE +] [TDE -]				MOVBK Note 5		

- Notes**
1. ADDC, SUB, SUBC, AND, OR, XOR and CMP are the same as ADD.
 2. There is no 2nd operand, or the 2nd operand is not an operand address.
 3. ROL, RORC, ROLC, SHR and SHL are the same as ROR.
 4. XCHM, CMPME, CMPMNE, CMPMNC and CMPMC are the same as MOV. M.
 5. XCHBK, CMPBKE, CMPBKNE, CMPBKNC and CMPBKC are the same as MOV. BK.
 6. If saddr is saddr2 in this combination, there is a short code length instruction.

(2) 16-bit instructions (combinations expressed by writing AX for rp are shown in parentheses)
 MOVM, XCHW, ADDW, SUBW, CMPW, MULUW, MULW, DIVUX, INCW, DECW, SHRW, SHLW, PUSH, POP,
 ADDWG, SUBWG, PUSHU, POPU, MOVTBLW, MACW, MACSW, SACW

Table 29-2. 16-Bit Addressing Instructions (1/2)

2nd Operand 1st Operand	# word	A	r	saddr	sfrp
AX	(MOVW) ADDW Note 1	(MOVW) (XCHW) (ADD) Note 1	(MOVW) (XCHW) (ADDW) Note 1	(MOVW) Note 3 (XCHW) Note 3 (ADDW) Notes 1,3	MOVW (XCHW) (ADDW) Note 1
rp	MOVW ADDW Note 1	(MOVW) (XCHW) (ADDW) Note 1	MOVW XCHW ADDW Note 1	MOVW XCHW ADDW Note 1	MOVW XCHW ADDW Note 1
saddrp	MOVW ADDW Note 1	(MOVW) Note 3 (ADDW) Note 1	MOVW ADDW Note 1	MOVW XCHW ADDW Note 1	
sfrp	MOVW ADDW Note 1	MOVW (ADDW) Note 1	MOVW ADDW Note 1		
!addr16 !!addr24	MOVW	(MOVW)	MOVW		
mem [saddrp] [%saddrg]		MOVW			
PSW					
SP	ADDWG SUBWG				
post					
[TDE +]		(MOVW)			
byte					

(See the following page for the explanation of **Note**.)

Table 29-2. 16-Bit Addressing Instructions (2/2)

2nd Operand 1st Operand	!!addr16 !!addr24	mem [saddrp] [%saddrg]	[WHL +]	byte	n	None Note 2
AX	(MOVW) XCHW	MOVW XCHW	(MOVW) (XCHW)			
rp	MOVW				SHRW SHLW	MULW Note 4 INCW DECW
saddrp						INCW DECW
sfrp						PUSH POP
!addr16 !!addr24				MOVTBLW		
mem [saddrp] [%saddrg]						
PSW						PUSH POP
SP						
post						PUSH POP PUSHU POPU
[TDE +]			SACW			
byte						MACW MACSW

- Notes**
1. SUBW and CMPW are the same as ADDW.
 2. There is no 2nd operand, or the 2nd operand is not an operand address.
 3. If saddrp is saddrp2 in this combination, there is a short code length instruction.
 4. MULUW and DIVUX are the same as MULW.

(3) 24-bit instructions (The values enclosed by parentheses are combined to express WHL description as rg.)

MOVG, ADDG, SUBG, INCG, DECG, PUSH, POP

Table 29-3. 24-Bit Addressing Instructions

Second operand \ First operand	#imm24	WHL	rg rg'	saddrg	!!addr24	mem1	[%saddrg]	SP	None ^{Note}
WHL	(MOVG) (ADDG) (SUBG)	(MOVG) (ADDG) (SUBG)	(MOVG) (ADDG) (SUBG)	(MOVG) ADDG SUBG	(MOVG)	MOVG	MOVG	MOVG	
rg	MOVG ADDG SUBG	(MOVG) (ADDG) (SUBG)	MOVG ADDG SUBG	MOVG	MOVG				INCG DECG PUSH POP
saddrg		(MOVG)	MOVG						
!!addr24		(MOVG)	MOVG						
mem1		MOVG							
[%saddrg]		MOVG							
SP	MOVG	MOVG							INCG DECG

Note There is no second operand, or the second operand is not an operand address.

(4) Bit manipulation instructions

MOV1, AND1, OR1, XOR1, SET1, CLR1, NOT1, BT, BF, BTCLR, BFSET

Table 29-4. Bit Manipulation Instruction Addressing Instructions

Second operand \ First operand	CY	saddr.bit A.bit PSWL.bit mem2.bit !addr16.bit !!addr24.bit	sfr.bit X.bit PSWH.bit	/saddr.bit /A.bit /PSWL.bit /mem2.bit /!addr16.bit /!!addr24.bit	/sfr.bit /X.bit /PSWH.bit	None ^{Note}
CY		MOV1 AND1 OR1 XOR1		AND1 OR1		NOT1 SET1 CLR1
saddr.bit sfr.bit A.bit X.bit PSWL.bit PSWH.bit mem2.bit !addr16.bit !!addr24.bit	MOV1					NOT1 SET1 CLR1 BF BT BTCLR BFSET

Note There is no second operand, or the second operand is not an operand address.

(5) Call return instructions and branch instructions

CALL, CALLF, CALLT, BRK, RET, RETI, RETB, RETCS, RETCSB, BRKCS, BR, BNZ, BNE, BZ, BE, BNC, BNL, BC, BL, BNV, BPO, BV, BPE, BP, BN, BLT, BGE, BLE, BGT, BNH, BH, BF, BT, BTCLR, BFSET, DBNZ

Table 29-5. Call Return Instructions and Branch Instruction Addressing Instructions

Instruction Address Operand	\$addr20	!addr20	!addr16	!!addr20	rp	rg	[rp]	[rg]	!addr11	[addr5]	RBn	None
Basic instructions	BC ^{Note} BR	CALL BR	CALL BR RETCS RETCSB	CALL BR	CALL BR	CALL BR	CALL BR	CALL BR	CALLF CALLT		BRKCS	BRK RET RETI RETB
Composite instructions	BF BT BTCLR BFSET DBNZ											

Note BNZ, BNE, BZ, BE, BNC, BNL, BL, BNV, BPO, BV, BPE, BP, BN, BLT, BGE, BLE, BGT, BNH, and BH are identical to BC.

(6) Other instructions

ADJBA, ADJBS, CVTBW, LOCATION, SEL, NOT, EI, DI, SWRS

★ **CHAPTER 30 ELECTRICAL SPECIFICATIONS** (μ PD784214A, 784215A, 784216A, 784217A, 784218A, 784214AY, 784215AY, 784216AY, 784217AY, 784218AY)

Absolute Maximum Ratings (T_A = 25°C)

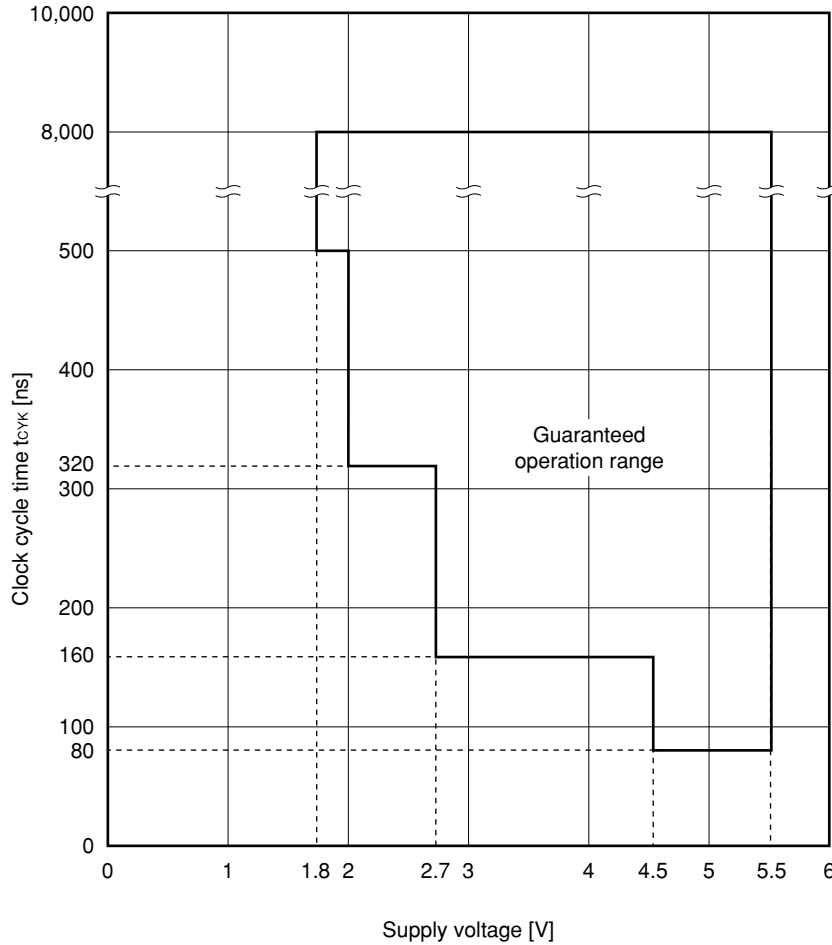
Parameter	Symbol	Conditions		Ratings	Unit
Supply voltage	V _{DD}			-0.3 to +6.5	V
	AV _{DD}			-0.3 to V _{DD} + 0.3	V
	AV _{SS}			-0.3 to V _{SS} + 0.3	V
	AV _{REF0}	A/D converter reference voltage input		-0.3 to V _{DD} + 0.3	V
	AV _{REF1}	D/A converter reference voltage input		-0.3 to V _{DD} + 0.3	V
Input voltage	V _{I1}	Other than P90 to P95		-0.3 to V _{DD} + 0.3	V
	V _{I2}	P90 to P95	N-ch open drain	-0.3 to +12	V
Analog input voltage	V _{AN}	Analog input pin		AV _{SS} - 0.3 to AV _{REF0} + 0.3	V
Output voltage	V _O			-0.3 to V _{DD} + 0.3	V
Output current, low	I _{OL}	Per pin		15	mA
		Total of P2, P4 to P8		75	mA
		Total of P0, P3, P9, P10, P12, P13		75	mA
		Total of all pins		100	mA
Output current, high	I _{OH}	Per pin		-10	mA
		Total of all pins		-50	mA
Operating ambient temperature	T _A			-40 to +85	°C
Storage temperature	T _{stg}			-65 to +150	°C

Caution Product quality may suffer if the absolute maximum rating is exceeded even momentarily for any parameter. That is, the absolute maximum ratings are rated values at which the product is on the verge of suffering physical damage, and therefore the product must be used under conditions that ensure that the absolute maximum ratings are not exceeded.

Operating Conditions

- Operating ambient temperature (T_A): -40 to $+85^\circ\text{C}$
- Power supply voltage and clock cycle time: see **Figure 30-1**
- Power supply voltage with subsystem clock operation: $V_{DD} = 1.8$ to 5.5 V

Figure 30-1. Power Supply Voltage and Clock Cycle Time (CPU Clock Frequency: f_{CPU})



Capacitance ($T_A = 25^\circ\text{C}$, $V_{DD} = V_{SS} = 0$ V)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit	
Input capacitance	C_i	f = 1 MHz Unmeasured pins returned to 0 V.	Other than port 9			15	pF
			Port 9			20	pF
Output capacitance	C_o		Other than port 9			15	pF
			Port 9			20	pF
I/O capacitance	C_{io}		Other than port 9			15	pF
			Port 9			20	pF

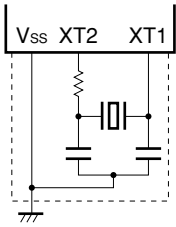
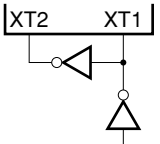
Main System Clock Oscillator Characteristics ($T_A = -40$ to $+85^\circ\text{C}$)

Resonator	Recommended Circuit	Parameter	Conditions	MIN.	TYP.	MAX.	Unit	
Ceramic resonator or crystal resonator		Oscillation frequency (f_x)	ENMP = 0	$4.5\text{ V} \leq V_{DD} \leq 5.5\text{ V}$	4		25	MHz
				$2.7\text{ V} \leq V_{DD} < 4.5\text{ V}$	4		12.5	
				$2.0\text{ V} \leq V_{DD} < 2.7\text{ V}$	4		6.25	
				$1.8\text{ V} \leq V_{DD} < 2.0\text{ V}$	4		4	
			ENMP = 1	$4.5\text{ V} \leq V_{DD} \leq 5.5\text{ V}$	2		12.5	MHz
				$2.7\text{ V} \leq V_{DD} < 4.5\text{ V}$	2		6.25	
				$2.0\text{ V} \leq V_{DD} < 2.7\text{ V}$	2		3.125	
				$1.8\text{ V} \leq V_{DD} < 2.0\text{ V}$	2		2	
External clock		X1 input frequency (f_x)	ENMP = 0	$4.5\text{ V} \leq V_{DD} \leq 5.5\text{ V}$	4		25	MHz
				$2.7\text{ V} \leq V_{DD} < 4.5\text{ V}$	4		12.5	
				$2.0\text{ V} \leq V_{DD} < 2.7\text{ V}$	4		6.25	
				$1.8\text{ V} \leq V_{DD} < 2.0\text{ V}$	4		4	
			ENMP = 1	$4.5\text{ V} \leq V_{DD} \leq 5.5\text{ V}$	2		12.5	MHz
				$2.7\text{ V} \leq V_{DD} < 4.5\text{ V}$	2		6.25	
				$2.0\text{ V} \leq V_{DD} < 2.7\text{ V}$	2		3.125	
				$1.8\text{ V} \leq V_{DD} < 2.0\text{ V}$	2		2	
		X1 input high-/low-level width (t_{WXH} , t_{WXL})			15		250	ns
		X1 input rising/falling time (t_{XR} , t_{XF})	$4.5\text{ V} \leq V_{DD} \leq 5.5\text{ V}$		0		5	ns
			$2.7\text{ V} \leq V_{DD} < 4.5\text{ V}$		0		10	
			$2.0\text{ V} \leq V_{DD} < 2.7\text{ V}$		0		20	
$1.8\text{ V} \leq V_{DD} < 2.0\text{ V}$			0		30			

Cautions 1. When using the main system clock oscillator, wire as follows in the area enclosed by the broken lines in the above figures to avoid an adverse effect from wiring capacitance.

- Keep the wiring length as short as possible.
 - Do not cross the wiring with other signal lines.
 - Do not route the wiring near a signal line through which a high fluctuating current flows.
 - Always make the ground point of the oscillator capacitor the same potential as V_{SS} .
 - Do not ground the capacitor to a ground pattern through which a high current flows.
 - Do not fetch signals from the oscillator.
2. When the main system clock is stopped and the system is operated by the subsystem clock, the subsystem clock should be switched back to the main system clock after the oscillation stabilization time is secured by the program.

Subsystem Clock Oscillator Characteristics ($T_A = -40$ to $+85^\circ\text{C}$)

Resonator	Recommended Circuit	Parameter	Conditions	MIN.	TYP.	MAX.	Unit
Crystal resonator		Oscillation frequency (f_{XT})		32	32.768	35	kHz
		Oscillation stabilization time ^{Note}	$4.5\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ $1.8\text{ V} \leq V_{DD} < 4.5\text{ V}$		1.2	2	s
External clock		XT1 input frequency (f_{XT})		32		35	kHz
		XT1 input high-/low-level width (t_{XTH} , t_{XTL})		14.3		15.6	μs

Note Time required to stabilize oscillation after applying the supply voltage (V_{DD}).

Cautions 1. When using the subsystem clock oscillator, wire as follows in the area enclosed by the broken lines in the above figures to avoid an adverse effect from wiring capacitance.

- Keep the wiring length as short as possible.
- Do not cross the wiring with other signal lines.
- Do not route the wiring near a signal line through which a high fluctuating current flows.
- Always make the ground point of the oscillator capacitor the same potential as V_{SS} .
- Do not ground the capacitor to a ground pattern through which a high current flows.
- Do not fetch signals from the oscillator.

2. When the main system clock is stopped and the device is operating on the subsystem clock, wait until the oscillation stabilization time has been secured by the program before switching back to the main system clock.

Remark For the resonator selection and oscillator constant, users are required to either evaluate the oscillation themselves or apply to the resonator manufacturer for evaluation.

Recommended Oscillator Constant**Main system clock: Ceramic resonator connection ($T_A = -40$ to $+85^\circ\text{C}$)****(1) μ PD784214A, 784215A, 784216A, 784214AY, 784215AY, 784216AY**

Manufacturer	Part Number	Oscillation Frequency f_{xx} (MHz)	Recommended Circuit Constants		Oscillation Voltage Range		Oscillation Stabilization Time (MAX.) t_{OST} (ms)
			C1 (pF)	C2 (pF)	MIN. (V)	MAX. (V)	
Murata Mfg. Co., Ltd.	CSTLS4M00G56-B0	4.0	On-chip	On-chip	2.7	5.5	0.40
	CSTLS8M00G53-B0	8.0	On-chip	On-chip	4.5	5.5	0.28
	CSTLA12M5T55-B0	12.5	On-chip	On-chip	4.5	5.5	0.29

Caution The oscillator constant is a reference value based on evaluation in specific environments by the resonator manufacturer. If the oscillator characteristics need to be optimized in the actual application, request the resonator manufacturer for evaluation on the implementation circuit. Note that the oscillation voltage and oscillation frequency merely indicate the characteristics of the oscillator. Use the internal operation conditions of each product within the specifications of the DC and AC characteristics.

(2) μ PD784217A, 784218A, 784217AY, 784218AY (1/2)

Manufacturer	Part Number	Oscillation Frequency f_{xx} (MHz)	Recommended Circuit Constants		Oscillation Voltage Range		Oscillation Stabilization Time (MAX.) t_{OST} (ms)
			C1 (pF)	C2 (pF)	MIN. (V)	MAX. (V)	
Murata Mfg. Co., Ltd.	CSTCC2.00MG0H6	2.0	On-chip	On-chip	1.9	5.5	0.46
	CSA2.00MG040	2.0	100	100	2.0	5.5	0.74
	CST2.00MG040	2.0	On-chip	On-chip	2.0	5.5	0.74
	CSTCC4.00MG0H6	4.0	On-chip	On-chip	2.7	5.5	0.43
	CSTCC4.00MGU0H6	4.0	On-chip	On-chip	2.7	5.5	0.43
	CSA4.00MG	4.0	30	30	2.7	5.5	0.32
	CST4.00MGW	4.0	On-chip	On-chip	2.7	5.5	0.32
	CSA4.00MG093	4.0	30	30	2.7	5.5	0.32
	CST4.00MGW093	4.0	On-chip	On-chip	2.7	5.5	0.32
	CSTLS4M00G56-B0	4.0	On-chip	On-chip	2.7	5.5	0.45
	CSTLS4M00G56093-B0	4.0	On-chip	On-chip	2.7	5.5	0.45
	CSTCC6.00MG0H6	6.0	On-chip	On-chip	2.7	5.5	0.45
	CSTCC6.00MGU0H6	6.0	On-chip	On-chip	2.7	5.5	0.45
	CSA6.00MG	6.0	30	30	2.7	5.5	0.33
	CST6.00MGW	6.0	On-chip	On-chip	2.7	5.5	0.33
	CSA6.00MG093	6.0	30	30	2.7	5.5	0.33
	CST6.00MGW093	6.0	On-chip	On-chip	2.7	5.5	0.33
	CSTLS6M00G56-B0	6.0	On-chip	On-chip	2.7	5.5	0.45
	CSTLS6M00G56093-B0	6.0	On-chip	On-chip	2.7	5.5	0.45
	CSTCC8.00MG	8.0	On-chip	On-chip	4.5	5.5	0.28
CSTCC8.00MG093	8.0	On-chip	On-chip	4.5	5.5	0.28	

(2) μ PD784217A, 784218A, 784217AY, 784218AY (2/2)

Manufacturer	Part Number	Oscillation Frequency f_{xx} (MHz)	Recommended Circuit Constants		Oscillation Voltage Range		Oscillation Stabilization Time (MAX.) t_{OS1} (ms)
			C1 (pF)	C2 (pF)	MIN. (V)	MAX. (V)	
Murata Mfg. Co, Ltd.	CSA8.00MTZ	8.0	30	30	4.5	5.5	0.30
	CST8.00MTW	8.0	On-chip	On-chip	4.5	5.5	0.30
	CSA8.00MTZ093	8.0	30	30	4.5	5.5	0.30
	CST8.00MTW093	8.0	On-chip	On-chip	4.5	5.5	0.30
	CSTLS8M00G53-B0	8.0	On-chip	On-chip	4.5	5.5	0.27
	CSTLS8M00G53093-B0	8.0	On-chip	On-chip	4.5	5.5	0.27
	CSTCC10.0MG	10.0	On-chip	On-chip	4.5	5.5	0.28
	CSTCC10.0MG093	10.0	On-chip	On-chip	4.5	5.5	0.28
	CSA10.0MTZ	10.0	30	30	4.5	5.5	0.32
	CST10.0MTW	10.0	On-chip	On-chip	4.5	5.5	0.32
	CSA10.0MTZ093	10.0	30	30	4.5	5.5	0.32
	CST10.0MTW093	10.0	On-chip	On-chip	4.5	5.5	0.32
	CSTCV12.5MTJ0C4	12.5	On-chip	On-chip	4.5	5.5	0.26
	CSA12.5MTZ	12.5	30	30	4.5	5.5	0.30
	CSTLA12M5T55-B0	12.5	On-chip	On-chip	4.5	5.5	0.30
	CSA12.5MTZ093	12.5	30	30	4.5	5.5	0.30
CSTLA12M5T55093-B0	12.5	On-chip	On-chip	4.5	5.5	0.30	
Kyocera Corporation	PBRC2.00AR-A	2.0	68	68	1.9	5.5	0.4
	PBRC4.00HR	4.0	On-chip	On-chip	2.7	5.5	0.4
	PBRC6.00HR	6.0	On-chip	On-chip	2.7	5.5	0.2
	SSR8.00CR-S24	8.0	On-chip	On-chip	4.5	5.5	0.4
	SSR12.50CR-S24	12.5	On-chip	On-chip	4.5	5.5	0.3
TDK	FCR4.0MC5	4.0	On-chip	On-chip	2.7	5.5	0.28
	FCR6.0MC5	6.0	On-chip	On-chip	2.7	5.5	0.28
	FCR8.0MC5	8.0	On-chip	On-chip	4.5	5.5	0.3
	FCR10.0MC5	10.0	On-chip	On-chip	4.5	5.5	0.4

Caution The oscillator constant is a reference value based on evaluation in specific environments by the resonator manufacturer. If the oscillator characteristics need to be optimized in the actual application, request the resonator manufacturer for evaluation on the implementation circuit. Note that the oscillation voltage and oscillation frequency merely indicate the characteristics of the oscillator. Use the internal operation conditions of each product within the specifications of the DC and AC characteristics.

DC Characteristics ($T_A = -40$ to $+85^\circ\text{C}$, $V_{DD} = AV_{DD} = 1.8$ to 5.5 V, $V_{SS} = AV_{SS} = 0$ V) (1/3)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit	
Input voltage, low	V_{IL1}	Note 1	$2.2\text{ V} \leq V_{DD} \leq 5.5\text{ V}$	0		$0.3V_{DD}$	V
			$1.8\text{ V} \leq V_{DD} < 2.2\text{ V}$	0		$0.2V_{DD}$	
	V_{IL2}	P00 to P06, P20, P22, P33, P34, P70, P72, P100 to P103, $\overline{\text{RESET}}$	$2.2\text{ V} \leq V_{DD} \leq 5.5\text{ V}$	0		$0.2V_{DD}$	V
			$1.8\text{ V} \leq V_{DD} < 2.2\text{ V}$	0		$0.15V_{DD}$	
	V_{IL3}	P90 to P95 (N-ch open drain)	$2.2\text{ V} \leq V_{DD} \leq 5.5\text{ V}$	0		$0.3V_{DD}$	V
			$1.8\text{ V} \leq V_{DD} < 2.2\text{ V}$	0		$0.2V_{DD}$	
	V_{IL4}	P10 to P17, P130, P131	$2.2\text{ V} \leq V_{DD} \leq 5.5\text{ V}$	0		$0.3V_{DD}$	V
			$1.8\text{ V} \leq V_{DD} < 2.2\text{ V}$	0		$0.2V_{DD}$	
	V_{IL5}	X1, X2, XT1, XT2	$2.2\text{ V} \leq V_{DD} \leq 5.5\text{ V}$	0		$0.2V_{DD}$	V
			$1.8\text{ V} \leq V_{DD} < 2.2\text{ V}$	0		$0.1V_{DD}$	
	V_{IL6}	P25, P27	$2.2\text{ V} \leq V_{DD} \leq 5.5\text{ V}$	0		$0.3V_{DD}$	V
			$1.8\text{ V} \leq V_{DD} < 2.2\text{ V}$	0		$0.2V_{DD}$	
Input voltage, high	V_{IH1}	Note 1	$2.2\text{ V} \leq V_{DD} \leq 5.5\text{ V}$	$0.7V_{DD}$		V_{DD}	V
			$1.8\text{ V} \leq V_{DD} < 2.2\text{ V}$	$0.8V_{DD}$		V_{DD}	
	V_{IH2}	P00 to P06, P20, P22, P33, P34, P70, P72, P100 to P103, $\overline{\text{RESET}}$	$2.2\text{ V} \leq V_{DD} \leq 5.5\text{ V}$	$0.8V_{DD}$		V_{DD}	V
			$1.8\text{ V} \leq V_{DD} < 2.2\text{ V}$	$0.85V_{DD}$		V_{DD}	
	V_{IH3}	P90 to P95 (N-ch open drain)	$2.2\text{ V} \leq V_{DD} \leq 5.5\text{ V}$	$0.7V_{DD}$		12	V
			$1.8\text{ V} \leq V_{DD} < 2.2\text{ V}$	$0.8V_{DD}$		V_{DD}	
	V_{IH4}	P10 to P17, P130, P131	$2.2\text{ V} \leq V_{DD} \leq 5.5\text{ V}$	$0.7V_{DD}$		V_{DD}	V
			$1.8\text{ V} \leq V_{DD} < 2.2\text{ V}$	$0.8V_{DD}$		V_{DD}	
	V_{IH5}	X1, X2, XT1, XT2	$2.2\text{ V} \leq V_{DD} \leq 5.5\text{ V}$	$0.8V_{DD}$		V_{DD}	V
			$1.8\text{ V} \leq V_{DD} < 2.2\text{ V}$	$0.85V_{DD}$		V_{DD}	
	V_{IH6}	P25, P27	$2.2\text{ V} \leq V_{DD} \leq 5.5\text{ V}$	$0.7V_{DD}$		V_{DD}	V
			$1.8\text{ V} \leq V_{DD} < 2.2\text{ V}$	$0.8V_{DD}$		V_{DD}	
Output voltage, low	V_{OL1}	For pins other than P40 to P47, P50 to P57, P90 to P95, $I_{OL} = 1.6\text{ mA}$ Note 2	$4.5\text{ V} \leq V_{DD} \leq 5.5\text{ V}$			0.4	V
		P40 to P47, P50 to P57 $I_{OL} = 8\text{ mA}$ Note 2	$4.5\text{ V} \leq V_{DD} \leq 5.5\text{ V}$			1.0	
		P90 to P95 $I_{OL} = 15\text{ mA}$ Note 2	$4.5\text{ V} \leq V_{DD} \leq 5.5\text{ V}$		0.8	2.0	
	V_{OL2}	$I_{OL} = 400\ \mu\text{A}$ Note 2				0.5	V
Output voltage, high	V_{OH1}	$I_{OH} = -1\text{ mA}$ Note 2	$4.5\text{ V} \leq V_{DD} \leq 5.5\text{ V}$	$V_{DD} - 1.0$			V
		$I_{OH} = -100\ \mu\text{A}$ Note 2	$1.8\text{ V} \leq V_{DD} \leq 5.5\text{ V}$	$V_{DD} - 0.5$			V
Input leakage current, low	I_{LIL1}	$V_I = 0\text{ V}$	Except X1, X2, XT1, XT2			-3	μA
	I_{LIL2}		X1, X2, XT1, XT2			-20	μA

- Notes** 1. P21, P23, P24, P26, P30 to P32, P35 to P37, P40 to P47, P50 to P57, P60 to P67, P71, P120 to P127
2. Per pin

DC Characteristics ($T_A = -40$ to $+85^\circ\text{C}$, $V_{DD} = AV_{DD} = 1.8$ to 5.5 V, $V_{SS} = AV_{SS} = 0$ V) (2/3)

Parameter	Symbol	Conditions		MIN.	TYP.	MAX.	Unit
Input leakage current, high	I_{LIH1}	$V_i = V_{DD}$	Except X1, X2, XT1, XT2			3	μA
	I_{LIH2}		X1, X2, XT1, XT2			20	μA
	I_{LIH3}	$V_i = 12$ V (N-ch open drain)	P90 to P95			20	μA
Output leakage current, low	I_{LOL1}	$V_o = 0$ V				-3	μA
Output leakage current, high	I_{LOH1}	$V_o = V_{DD}$				3	μA

(1) μ PD784214A, 784215A, 784216A, 784214AY, 784215AY, 784216AY

Parameter	Symbol	Conditions		MIN.	TYP.	MAX.	Unit
Supply current	I_{DD1}	Operation mode	$f_{XX} = 12.5$ MHz, $V_{DD} = 5.0$ V $\pm 10\%$		11	40	mA
			$f_{XX} = 6$ MHz, $V_{DD} = 3.0$ V $\pm 10\%$		3	17	mA
			$f_{XX} = 2$ MHz, $V_{DD} = 2.0$ V $\pm 10\%$		1	8	mA
	I_{DD2}	HALT mode	$f_{XX} = 12.5$ MHz, $V_{DD} = 5.0$ V $\pm 10\%$		5	20	mA
			$f_{XX} = 6$ MHz, $V_{DD} = 3.0$ V $\pm 10\%$		2	8	mA
			$f_{XX} = 2$ MHz, $V_{DD} = 2.0$ V $\pm 10\%$		0.3	3.5	mA
	I_{DD3}	IDLE mode	$f_{XX} = 12.5$ MHz, $V_{DD} = 5.0$ V $\pm 10\%$		1	2.5	mA
			$f_{XX} = 6$ MHz, $V_{DD} = 3.0$ V $\pm 10\%$		0.4	1.3	mA
			$f_{XX} = 2$ MHz, $V_{DD} = 2.0$ V $\pm 10\%$		0.2	0.9	mA
	I_{DD4}	Operation mode ^{Note}	$f_{XX} = 32$ kHz, $V_{DD} = 5.0$ V $\pm 10\%$		80	200	μA
			$f_{XX} = 32$ kHz, $V_{DD} = 3.0$ V $\pm 10\%$		60	110	μA
			$f_{XX} = 32$ kHz, $V_{DD} = 2.0$ V $\pm 10\%$		30	100	μA
	I_{DD5}	HALT mode ^{Note}	$f_{XX} = 32$ kHz, $V_{DD} = 5.0$ V $\pm 10\%$		60	160	μA
			$f_{XX} = 32$ kHz, $V_{DD} = 3.0$ V $\pm 10\%$		20	80	μA
			$f_{XX} = 32$ kHz, $V_{DD} = 2.0$ V $\pm 10\%$		10	70	μA
I_{DD6}	IDLE mode ^{Note}	$f_{XX} = 32$ kHz, $V_{DD} = 5.0$ V $\pm 10\%$		50	150	μA	
		$f_{XX} = 32$ kHz, $V_{DD} = 3.0$ V $\pm 10\%$		15	70	μA	
		$f_{XX} = 32$ kHz, $V_{DD} = 2.0$ V $\pm 10\%$		5	60	μA	
Data retention voltage	V_{DDDR}	HALT, IDLE modes		1.8		5.5	V
Data retention current	I_{DDDR}	STOP mode	$V_{DD} = 2.0$ V $\pm 10\%$		2	10	μA
			$V_{DD} = 5.0$ V $\pm 10\%$		10	50	μA
Pull-up resistor	R_L	$V_i = 0$ V		10	30	100	k Ω

Note When the main system clock is stopped and subsystem clock is operating.

Remark Unless otherwise specified, the characteristics of alternate-function pins are the same as those of port pins.

DC Characteristics ($T_A = -40$ to $+85^\circ\text{C}$, $V_{DD} = AV_{DD} = 1.8$ to 5.5 V, $V_{SS} = AV_{SS} = 0$ V) (3/3)(2) μ PD784217A, 784218A, 784217AY, 784218AY

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit	
Supply current	I _{DD1}	Operation mode	f _{XX} = 12.5 MHz, V _{DD} = 5.0 V \pm 10%		11	40	mA
			f _{XX} = 6 MHz, V _{DD} = 3.0 V \pm 10%		4	17	mA
			f _{XX} = 2 MHz, V _{DD} = 2.0 V \pm 10%		1	8	mA
	I _{DD2}	HALT mode	f _{XX} = 12.5 MHz, V _{DD} = 5.0 V \pm 10%		6	20	mA
			f _{XX} = 6 MHz, V _{DD} = 3.0 V \pm 10%		2	8	mA
			f _{XX} = 2 MHz, V _{DD} = 2.0 V \pm 10%		0.4	3.5	mA
	I _{DD3}	IDLE mode	f _{XX} = 12.5 MHz, V _{DD} = 5.0 V \pm 10%		1	2.5	mA
			f _{XX} = 6 MHz, V _{DD} = 3.0 V \pm 10%		0.4	1.3	mA
			f _{XX} = 2 MHz, V _{DD} = 2.0 V \pm 10%		0.2	0.9	mA
	I _{DD4}	Operation mode ^{Note}	f _{XX} = 32 kHz, V _{DD} = 5.0 V \pm 10%		80	200	μ A
			f _{XX} = 32 kHz, V _{DD} = 3.0 V \pm 10%		60	110	μ A
			f _{XX} = 32 kHz, V _{DD} = 2.0 V \pm 10%		30	100	μ A
	I _{DD5}	HALT mode ^{Note}	f _{XX} = 32 kHz, V _{DD} = 5.0 V \pm 10%		60	160	μ A
			f _{XX} = 32 kHz, V _{DD} = 3.0 V \pm 10%		20	80	μ A
			f _{XX} = 32 kHz, V _{DD} = 2.0 V \pm 10%		10	70	μ A
I _{DD6}	IDLE mode ^{Note}	f _{XX} = 32 kHz, V _{DD} = 5.0 V \pm 10%		50	150	μ A	
		f _{XX} = 32 kHz, V _{DD} = 3.0 V \pm 10%		15	70	μ A	
		f _{XX} = 32 kHz, V _{DD} = 2.0 V \pm 10%		5	60	μ A	
Data retention voltage	V _{DDDR}	HALT, IDLE modes	1.8		5.5	V	
Data retention current	I _{DDDR}	STOP mode	V _{DD} = 2.0 V \pm 10%		2	10	μ A
			V _{DD} = 5.0 V \pm 10%		10	50	μ A
Pull-up resistor	R _L	V _I = 0 V	10	30	100	k Ω	

Note When the main system clock is stopped and subsystem clock is operating.

Remark Unless otherwise specified, the characteristics of alternate-function pins are the same as those of port pins.

AC Characteristics ($T_A = -40$ to $+85^\circ\text{C}$, $V_{DD} = AV_{DD} = 1.8$ to 5.5 V, $V_{SS} = AV_{SS} = 0$ V)**(1) Read/write operation (1/3)**

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Cycle time	t_{CYK}	$4.5\text{ V} \leq V_{DD} \leq 5.5\text{ V}$	80			ns
		$2.7\text{ V} \leq V_{DD} < 4.5\text{ V}$	160			ns
		$2.0\text{ V} \leq V_{DD} < 2.7\text{ V}$	320			ns
		$1.8\text{ V} \leq V_{DD} < 2.0\text{ V}$	500			ns
Address setup time (to $ASTB\downarrow$)	t_{SAST}	$V_{DD} = 5.0\text{ V} \pm 10\%$	$(0.5 + a) T - 20$			ns
		$V_{DD} = 3.0\text{ V} \pm 10\%$	$(0.5 + a) T - 40$			ns
		$V_{DD} = 2.0\text{ V} \pm 10\%$	$(0.5 + a) T - 80$			ns
Address hold time (from $ASTB\downarrow$)	t_{HSTLA}	$V_{DD} = 5.0\text{ V} \pm 10\%$	$0.5T - 19$			ns
		$V_{DD} = 3.0\text{ V} \pm 10\%$	$0.5T - 24$			ns
		$V_{DD} = 2.0\text{ V} \pm 10\%$	$0.5T - 34$			ns
ASTB high-level width	t_{WSTH}	$V_{DD} = 5.0\text{ V} \pm 10\%$	$(0.5 + a) T - 17$			ns
		$V_{DD} = 3.0\text{ V} \pm 10\%$	$(0.5 + a) T - 40$			ns
		$V_{DD} = 2.0\text{ V} \pm 10\%$	$(0.5 + a) T - 110$			ns
Address hold time (from $\overline{RD}\uparrow$)	t_{HRA}	$V_{DD} = 5.0\text{ V} \pm 10\%$	$0.5T - 14$			ns
		$V_{DD} = 3.0\text{ V} \pm 10\%$	$0.5T - 14$			ns
		$V_{DD} = 2.0\text{ V} \pm 10\%$	$0.5T - 14$			ns
Delay time from address to $\overline{RD}\downarrow$	t_{DAR}	$V_{DD} = 5.0\text{ V} \pm 10\%$	$(1 + a) T - 24$			ns
		$V_{DD} = 3.0\text{ V} \pm 10\%$	$(1 + a) T - 35$			ns
		$V_{DD} = 2.0\text{ V} \pm 10\%$	$(1 + a) T - 80$			ns
Address float time (from $\overline{RD}\downarrow$)	t_{FAR}	$V_{DD} = 5.0\text{ V} \pm 10\%$			0	ns
		$V_{DD} = 3.0\text{ V} \pm 10\%$			0	ns
		$V_{DD} = 2.0\text{ V} \pm 10\%$			0	ns
Data input time from address	t_{DAID}	$V_{DD} = 5.0\text{ V} \pm 10\%$			$(2.5 + a + n) T - 37$	ns
		$V_{DD} = 3.0\text{ V} \pm 10\%$			$(2.5 + a + n) T - 52$	ns
		$V_{DD} = 2.0\text{ V} \pm 10\%$			$(2.5 + a + n) T - 120$	ns
Data input time from $ASTB\downarrow$	t_{DSTID}	$V_{DD} = 5.0\text{ V} \pm 10\%$			$(2 + n) T - 35$	ns
		$V_{DD} = 3.0\text{ V} \pm 10\%$			$(2 + n) T - 50$	ns
		$V_{DD} = 2.0\text{ V} \pm 10\%$			$(2 + n) T - 80$	ns
Data input time from $\overline{RD}\downarrow$	t_{DRID}	$V_{DD} = 5.0\text{ V} \pm 10\%$			$(1.5 + n) T - 40$	ns
		$V_{DD} = 3.0\text{ V} \pm 10\%$			$(1.5 + n) T - 50$	ns
		$V_{DD} = 2.0\text{ V} \pm 10\%$			$(1.5 + n) T - 90$	ns
Delay time from $ASTB\downarrow$ to $\overline{RD}\downarrow$	t_{DSTR}	$V_{DD} = 5.0\text{ V} \pm 10\%$	$0.5T - 9$			ns
		$V_{DD} = 3.0\text{ V} \pm 10\%$	$0.5T - 9$			ns
		$V_{DD} = 2.0\text{ V} \pm 10\%$	$0.5T - 20$			ns
Data hold time (from $\overline{RD}\uparrow$)	t_{HRID}	$V_{DD} = 5.0\text{ V} \pm 10\%$	0			ns
		$V_{DD} = 3.0\text{ V} \pm 10\%$	0			ns
		$V_{DD} = 2.0\text{ V} \pm 10\%$	0			ns

Remark T: $t_{CYK} = 1/f_{XX}$ (f_{XX} : Main system clock frequency)

a: 1 (during address wait), otherwise, 0

n: Number of wait states ($n \geq 0$)

(1) Read/write operation (2/3)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Address active time from $\overline{RD}\uparrow$	t_{DRA}	$V_{DD} = 5.0\text{ V} \pm 10\%$	$0.5T - 2$			ns
		$V_{DD} = 3.0\text{ V} \pm 10\%$	$0.5T - 12$			ns
		$V_{DD} = 2.0\text{ V} \pm 10\%$	$0.5T - 35$			ns
Delay time from $\overline{RD}\uparrow$ to $ASTB\uparrow$	t_{DRST}	$V_{DD} = 5.0\text{ V} \pm 10\%$	$0.5T - 9$			ns
		$V_{DD} = 3.0\text{ V} \pm 10\%$	$0.5T - 9$			ns
		$V_{DD} = 2.0\text{ V} \pm 10\%$	$0.5T - 40$			ns
\overline{RD} low-level width	t_{WRL}	$V_{DD} = 5.0\text{ V} \pm 10\%$	$(1.5 + n) T - 25$			ns
		$V_{DD} = 3.0\text{ V} \pm 10\%$	$(1.5 + n) T - 30$			ns
		$V_{DD} = 2.0\text{ V} \pm 10\%$	$(1.5 + n) T - 25$			ns
Address active time from $\overline{WR}\uparrow$	t_{DWA}	$V_{DD} = 5.0\text{ V} \pm 10\%$	$0.5T - 2$			ns
		$V_{DD} = 3.0\text{ V} \pm 10\%$	$0.5T - 12$			ns
		$V_{DD} = 2.0\text{ V} \pm 10\%$	$0.5T - 35$			ns
Delay time from address to $\overline{WR}\downarrow$	t_{DAW}	$V_{DD} = 5.0\text{ V} \pm 10\%$	$(1 + a) T - 24$			ns
		$V_{DD} = 3.0\text{ V} \pm 10\%$	$(1 + a) T - 34$			ns
		$V_{DD} = 2.0\text{ V} \pm 10\%$	$(1 + a) T - 70$			ns
Address hold time (from $\overline{WR}\uparrow$)	t_{HWA}	$V_{DD} = 5.0\text{ V} \pm 10\%$	$0.5T - 14$			ns
		$V_{DD} = 3.0\text{ V} \pm 10\%$	$0.5T - 14$			ns
		$V_{DD} = 2.0\text{ V} \pm 10\%$	$0.5T - 14$			ns
Delay time from $ASTB\downarrow$ to data output	t_{DSTOD}	$V_{DD} = 5.0\text{ V} \pm 10\%$			$0.5T + 15$	ns
		$V_{DD} = 3.0\text{ V} \pm 10\%$			$0.5T + 30$	ns
		$V_{DD} = 2.0\text{ V} \pm 10\%$			$0.5T + 240$	ns
Delay time from $\overline{WR}\downarrow$ to data output	t_{DWOD}	$V_{DD} = 5.0\text{ V} \pm 10\%$			$0.5T - 30$	ns
		$V_{DD} = 3.0\text{ V} \pm 10\%$			$0.5T - 30$	ns
		$V_{DD} = 2.0\text{ V} \pm 10\%$			$0.5T - 30$	ns
Delay time from $ASTB\downarrow$ to $\overline{WR}\downarrow$	t_{DSTW}	$V_{DD} = 5.0\text{ V} \pm 10\%$	$0.5T - 9$			ns
		$V_{DD} = 3.0\text{ V} \pm 10\%$	$0.5T - 9$			ns
		$V_{DD} = 2.0\text{ V} \pm 10\%$	$0.5T - 20$			ns
Data setup time (to $\overline{WR}\uparrow$)	t_{SODWR}	$V_{DD} = 5.0\text{ V} \pm 10\%$	$(1.5 + n) T - 20$			ns
		$V_{DD} = 3.0\text{ V} \pm 10\%$	$(1.5 + n) T - 25$			ns
		$V_{DD} = 2.0\text{ V} \pm 10\%$	$(1.5 + n) T - 70$			ns
Data hold time (from $\overline{WR}\uparrow$)	t_{HWOD}	$V_{DD} = 5.0\text{ V} \pm 10\%$	$0.5T - 14$			ns
		$V_{DD} = 3.0\text{ V} \pm 10\%$	$0.5T - 14$			ns
		$V_{DD} = 2.0\text{ V} \pm 10\%$	$0.5T - 50$			ns
Delay time from $\overline{WR}\uparrow$ to $ASTB\uparrow$	t_{DWST}	$V_{DD} = 5.0\text{ V} \pm 10\%$	$0.5T - 9$			ns
		$V_{DD} = 3.0\text{ V} \pm 10\%$	$0.5T - 9$			ns
		$V_{DD} = 2.0\text{ V} \pm 10\%$	$0.5T - 30$			ns
\overline{WR} low-level width	t_{WWL}	$V_{DD} = 5.0\text{ V} \pm 10\%$	$(1.5 + n) T - 25$			ns
		$V_{DD} = 3.0\text{ V} \pm 10\%$	$(1.5 + n) T - 30$			ns
		$V_{DD} = 2.0\text{ V} \pm 10\%$	$(1.5 + n) T - 30$			ns

Remark T: $t_{CYK} = 1/f_{XX}$ (f_{XX} : Main system clock frequency)

a: 1 (during address wait), otherwise, 0

n: Number of wait states ($n \geq 0$)

(1) Read/write operation (3/3)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Delay time from address to EXA \downarrow	t _{ADEXD}	V _{DD} = 5.0 V \pm 10%	0			ns
		V _{DD} = 3.0 V \pm 10%	0			ns
		V _{DD} = 2.0 V \pm 10%	0			ns
Delay time from EXA \downarrow to ASTB \downarrow	t _{EXTAH}	V _{DD} = 5.0 V \pm 10%	0.5T – 20			ns
		V _{DD} = 3.0 V \pm 10%	0.5T – 30			ns
		V _{DD} = 2.0 V \pm 10%	0.5T – 40			ns
Delay time from $\overline{\text{RD}}\uparrow$ to EXA \uparrow	t _{EXRDS}	V _{DD} = 5.0 V \pm 10%	0			ns
		V _{DD} = 3.0 V \pm 10%	0			ns
		V _{DD} = 2.0 V \pm 10%	0			ns
Delay time from $\overline{\text{WR}}\uparrow$ to EXA \uparrow	t _{EXWDS}	V _{DD} = 5.0 V \pm 10%	T			ns
		V _{DD} = 3.0 V \pm 10%	T			ns
		V _{DD} = 2.0 V \pm 10%	T			ns
Delay time from EXA \uparrow to ASTB \uparrow	t _{EXADR}	V _{DD} = 5.0 V \pm 10%	0.5T			ns
		V _{DD} = 3.0 V \pm 10%	0.5T			ns
		V _{DD} = 2.0 V \pm 10%	0.5T			ns

Remark T: t_{cyk} = 1/f_{xx} (f_{xx}: Main system clock frequency)

(2) External wait timing (1/2)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Input time from address to $\overline{\text{WAIT}}\downarrow$	t_{DAWT}	$V_{\text{DD}} = 5.0 \text{ V} \pm 10\%$			$(2 + a) T - 40$	ns
		$V_{\text{DD}} = 3.0 \text{ V} \pm 10\%$			$(2 + a) T - 60$	ns
		$V_{\text{DD}} = 2.0 \text{ V} \pm 10\%$			$(2 + a) T - 300$	ns
Input time from $\text{ASTB}\downarrow$ to $\overline{\text{WAIT}}\downarrow$	t_{DSTWT}	$V_{\text{DD}} = 5.0 \text{ V} \pm 10\%$			$1.5T - 40$	ns
		$V_{\text{DD}} = 3.0 \text{ V} \pm 10\%$			$1.5T - 60$	ns
		$V_{\text{DD}} = 2.0 \text{ V} \pm 10\%$			$1.5T - 260$	ns
Hold time from $\text{ASTB}\downarrow$ to $\overline{\text{WAIT}}$	t_{HSTWT}	$V_{\text{DD}} = 5.0 \text{ V} \pm 10\%$	$(0.5 + n) T + 5$			ns
		$V_{\text{DD}} = 3.0 \text{ V} \pm 10\%$	$(0.5 + n) T + 10$			ns
		$V_{\text{DD}} = 2.0 \text{ V} \pm 10\%$	$(0.5 + n) T + 30$			ns
Delay time from $\text{ASTB}\downarrow$ to $\overline{\text{WAIT}}\uparrow$	t_{DSTWTH}	$V_{\text{DD}} = 5.0 \text{ V} \pm 10\%$			$(1.5 + n) T - 40$	ns
		$V_{\text{DD}} = 3.0 \text{ V} \pm 10\%$			$(1.5 + n) T - 60$	ns
		$V_{\text{DD}} = 2.0 \text{ V} \pm 10\%$			$(1.5 + n) T - 90$	ns
Input time from $\overline{\text{RD}}\downarrow$ to $\overline{\text{WAIT}}\downarrow$	t_{DRWTL}	$V_{\text{DD}} = 5.0 \text{ V} \pm 10\%$			$T - 40$	ns
		$V_{\text{DD}} = 3.0 \text{ V} \pm 10\%$			$T - 60$	ns
		$V_{\text{DD}} = 2.0 \text{ V} \pm 10\%$			$T - 70$	ns
Hold time from $\overline{\text{RD}}\downarrow$ to $\overline{\text{WAIT}}$	t_{HRWT}	$V_{\text{DD}} = 5.0 \text{ V} \pm 10\%$	$nT + 5$			ns
		$V_{\text{DD}} = 3.0 \text{ V} \pm 10\%$	$nT + 10$			ns
		$V_{\text{DD}} = 2.0 \text{ V} \pm 10\%$	$nT + 30$			ns
Delay time from $\overline{\text{RD}}\downarrow$ to $\overline{\text{WAIT}}\uparrow$	t_{DRWTH}	$V_{\text{DD}} = 5.0 \text{ V} \pm 10\%$			$(1 + n) T - 40$	ns
		$V_{\text{DD}} = 3.0 \text{ V} \pm 10\%$			$(1 + n) T - 60$	ns
		$V_{\text{DD}} = 2.0 \text{ V} \pm 10\%$			$(1 + n) T - 90$	ns
Data input time from $\overline{\text{WAIT}}\uparrow$	t_{DWTID}	$V_{\text{DD}} = 5.0 \text{ V} \pm 10\%$			$0.5T - 5$	ns
		$V_{\text{DD}} = 3.0 \text{ V} \pm 10\%$			$0.5T - 10$	ns
		$V_{\text{DD}} = 2.0 \text{ V} \pm 10\%$			$0.5T - 30$	ns
Delay time from $\overline{\text{WAIT}}\uparrow$ to $\overline{\text{RD}}\uparrow$	t_{DWTR}	$V_{\text{DD}} = 5.0 \text{ V} \pm 10\%$	$0.5T$			ns
		$V_{\text{DD}} = 3.0 \text{ V} \pm 10\%$	$0.5T$			ns
		$V_{\text{DD}} = 2.0 \text{ V} \pm 10\%$	$0.5T + 5$			ns
Delay time from $\overline{\text{WAIT}}\uparrow$ to $\overline{\text{WR}}\uparrow$	t_{DWTW}	$V_{\text{DD}} = 5.0 \text{ V} \pm 10\%$	$0.5T$			ns
		$V_{\text{DD}} = 3.0 \text{ V} \pm 10\%$	$0.5T$			ns
		$V_{\text{DD}} = 2.0 \text{ V} \pm 10\%$	$0.5T + 5$			ns
Input time from $\overline{\text{WR}}\downarrow$ to $\overline{\text{WAIT}}\downarrow$	t_{DWWTL}	$V_{\text{DD}} = 5.0 \text{ V} \pm 10\%$			$T - 40$	ns
		$V_{\text{DD}} = 3.0 \text{ V} \pm 10\%$			$T - 60$	ns
		$V_{\text{DD}} = 2.0 \text{ V} \pm 10\%$			$T - 90$	ns

Remark T: $t_{\text{CYK}} = 1/f_{\text{XX}}$ (f_{XX} : Main system clock frequency)

a: 1 (during address wait), otherwise, 0

n: Number of wait states ($n \geq 0$)

(2) External wait timing (2/2)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Hold time from $\overline{WR}\downarrow$ to \overline{WAIT}	t_{HWWT}	$V_{DD} = 5.0\text{ V} \pm 10\%$	$nT + 5$			ns
		$V_{DD} = 3.0\text{ V} \pm 10\%$	$nT + 10$			ns
		$V_{DD} = 2.0\text{ V} \pm 10\%$	$nT + 30$			ns
Delay time from $\overline{WR}\downarrow$ to $\overline{WAIT}\uparrow$	t_{DWWTH}	$V_{DD} = 5.0\text{ V} \pm 10\%$			$(1 + n)T - 40$	ns
		$V_{DD} = 3.0\text{ V} \pm 10\%$			$(1 + n)T - 60$	ns
		$V_{DD} = 2.0\text{ V} \pm 10\%$			$(1 + n)T - 90$	ns

Remark T: $t_{CYK} = 1/f_{XX}$ (f_{XX} : Main system clock frequency)

n: Number of wait states ($n \geq 0$)

(3) Serial operation ($T_A = -40$ to $+85^\circ\text{C}$, $V_{DD} = AV_{DD} = 1.8$ to 5.5 V, $V_{SS} = AV_{SS} = 0$ V) (1/2)**(a) 3-wire serial I/O mode ($\overline{\text{SCK}}$: Internal clock output)**

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
$\overline{\text{SCK}}$ cycle time	t_{KCY1}	$4.5 \text{ V} \leq V_{\text{DD}} \leq 5.5 \text{ V}$	640			ns
		$2.7 \text{ V} \leq V_{\text{DD}} < 4.5 \text{ V}$	1,280			ns
		$2.0 \text{ V} \leq V_{\text{DD}} < 2.7 \text{ V}$	2,560			ns
		$1.8 \text{ V} \leq V_{\text{DD}} < 2.0 \text{ V}$	4,000			ns
$\overline{\text{SCK}}$ high-/low-level width	t_{KH1} , t_{KL1}	$4.5 \text{ V} \leq V_{\text{DD}} \leq 5.5 \text{ V}$	270			ns
		$2.7 \text{ V} \leq V_{\text{DD}} < 4.5 \text{ V}$	590			ns
		$2.0 \text{ V} \leq V_{\text{DD}} < 2.7 \text{ V}$	1,180			ns
		$1.8 \text{ V} \leq V_{\text{DD}} < 2.0 \text{ V}$	1,900			ns
SI setup time (to $\overline{\text{SCK}}\uparrow$)	t_{SIK1}	$2.7 \text{ V} \leq V_{\text{DD}} \leq 5.5 \text{ V}$	10			ns
		$1.8 \text{ V} \leq V_{\text{DD}} < 2.7 \text{ V}$	30			ns
SI hold time (from $\overline{\text{SCK}}\uparrow$)	t_{HIK1}		40			ns
Delay time from $\overline{\text{SCK}}\downarrow$ to SO output	t_{DSO1}				30	ns
Hold time from $\overline{\text{SCK}}\uparrow$ to SO output	t_{HSO1}		$t_{\text{KCY1}}/2 - 50$			ns

(b) 3-wire serial I/O mode ($\overline{\text{SCK}}$: External clock input)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
$\overline{\text{SCK}}$ cycle time	t_{KCY2}	$4.5 \text{ V} \leq V_{\text{DD}} \leq 5.5 \text{ V}$	640			ns
		$2.7 \text{ V} \leq V_{\text{DD}} < 4.5 \text{ V}$	1,280			ns
		$2.0 \text{ V} \leq V_{\text{DD}} < 2.7 \text{ V}$	2,560			ns
		$1.8 \text{ V} \leq V_{\text{DD}} < 2.0 \text{ V}$	4,000			ns
$\overline{\text{SCK}}$ high-/low-level width	t_{KH2} , t_{KL2}	$4.5 \text{ V} \leq V_{\text{DD}} \leq 5.5 \text{ V}$	320			ns
		$2.7 \text{ V} \leq V_{\text{DD}} < 4.5 \text{ V}$	640			ns
		$2.0 \text{ V} \leq V_{\text{DD}} < 2.7 \text{ V}$	1,280			ns
		$1.8 \text{ V} \leq V_{\text{DD}} < 2.0 \text{ V}$	2,000			ns
SI setup time (to $\overline{\text{SCK}}\uparrow$)	t_{SIK2}	$2.7 \text{ V} \leq V_{\text{DD}} \leq 5.5 \text{ V}$	10			ns
		$1.8 \text{ V} \leq V_{\text{DD}} < 2.7 \text{ V}$	30			ns
SI hold time (from $\overline{\text{SCK}}\uparrow$)	t_{HIK2}		40			ns
Delay time from $\overline{\text{SCK}}\downarrow$ to SO output	t_{DSO2}				30	ns
Hold time from $\overline{\text{SCK}}\uparrow$ to SO output	t_{HSO2}		$t_{\text{KCY2}}/2 - 50$			ns

(c) UART mode

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
ASCK cycle time	t_{KCY3}	$4.5 \text{ V} \leq V_{\text{DD}} \leq 5.5 \text{ V}$	417			ns
		$2.7 \text{ V} \leq V_{\text{DD}} < 4.5 \text{ V}$	833			ns
		$1.8 \text{ V} \leq V_{\text{DD}} < 2.7 \text{ V}$	1,667			ns
ASCK high-/low-level width	t_{KH3} , t_{KL3}	$4.5 \text{ V} \leq V_{\text{DD}} \leq 5.5 \text{ V}$	208			ns
		$2.7 \text{ V} \leq V_{\text{DD}} < 4.5 \text{ V}$	416			ns
		$1.8 \text{ V} \leq V_{\text{DD}} < 2.7 \text{ V}$	833			ns

(3) Serial operation ($T_A = -40$ to $+85^\circ\text{C}$, $V_{DD} = AV_{DD} = 1.8$ to 5.5 V, $V_{SS} = AV_{SS} = 0$ V) (2/2)**(d) I²C bus mode**

Parameter	Symbol	Standard Mode		High-Speed Mode		Unit
		MIN.	MAX.	MIN.	MAX.	
SCL0 clock frequency	f_{CLK}	0	100	0	400	kHz
Bus free time (between stop and start conditions)	t_{BUF}	4.7	–	1.3	–	μs
Hold time ^{Note 1}	$t_{HD:STA}$	4.0	–	0.6	–	μs
Low-level width of SCL0 clock	t_{LOW}	4.7	–	1.3	–	μs
High-level width of SCL0 clock	t_{HIGH}	4.0	–	0.6	–	μs
Setup time of start/restart conditions	$t_{SU:STA}$	4.7	–	0.6	–	μs
Data hold time	When using CBUS-compatible master	$t_{HD:DAT}$	5.0	–	–	μs
	When using I ² C bus		0 ^{Note 2}	–	0 ^{Note 2}	0.9 ^{Note 3}
Data setup time	$t_{SU:DAT}$	250	–	100 ^{Note 4}	–	ns
Rising time of SDA0 and SCL0 signals	t_R	–	1,000	$20 + 0.1C_b$ ^{Note 5}	300	ns
Falling time of SDA0 and SCL0 signals	t_F	–	300	$20 + 0.1C_b$ ^{Note 5}	300	ns
Setup time of stop condition	$t_{SU:STO}$	4.0	–	0.6	–	μs
Pulse width of spike restricted by input filter	t_{SP}	–	–	0	50	ns
Load capacitance of each bus line	C_b	–	400	–	400	pF

- Notes**
- For the start condition, the first clock pulse is generated after the hold time.
 - To fill the undefined area of the SCL0 falling edge, it is necessary for the device to provide an internal SDA0 signal (on $V_{IHmin.}$) with at least 300 ns of hold time.
 - If the device does not extend the SCL0 signal low-level hold time (t_{LOW}), only the maximum data hold time $t_{HD:DAT}$ needs to be satisfied.
 - The high-speed mode I²C bus can be used in a standard mode I²C bus system. In this case, the conditions described below must be satisfied.
 - If the device does not extend the SCL0 signal low-level hold time
 $t_{SU:DAT} \geq 250$ ns
 - If the device extends the SCL0 signal low-level hold time
Be sure to transmit the data bit to the SDA0 line before the SCL0 line is released
($t_{Rmax.} + t_{SU:DAT} = 1,000 + 250 = 1,250$ ns by standard mode I²C bus specification)
 - C_b : Total capacitance per bus line (unit: pF)

(4) Clock output operation ($T_A = -40$ to $+85^\circ\text{C}$, $V_{DD} = AV_{DD} = 1.8$ to 5.5 V, $V_{SS} = AV_{SS} = 0$ V)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
PCL cycle time	t_{CYCL}	$4.5\text{ V} \leq V_{DD} \leq 5.5\text{ V}$, nT	80		31,250	ns
PCL high-/low-level width	t_{CLL} , t_{CLH}	$4.5\text{ V} \leq V_{DD} \leq 5.5\text{ V}$, $0.5T - 10$	30		15,615	ns
PCL rise/fall time	t_{CLR} , t_{CLF}	$4.5\text{ V} \leq V_{DD} \leq 5.5\text{ V}$			5	ns
		$2.7\text{ V} \leq V_{DD} < 4.5\text{ V}$			10	ns
		$1.8\text{ V} \leq V_{DD} < 2.7\text{ V}$			20	ns

Remark T: $t_{CYK} = 1/f_{XX}$ (f_{XX} : Main system clock frequency)

n: Divided frequency ratio set by software in the CPU

- When using the main system clock: $n = 1, 2, 4, 8, 16, 32, 64, 128$
- When using the subsystem clock: $n = 1$

(5) Other operations ($T_A = -40$ to $+85^\circ\text{C}$, $V_{DD} = AV_{DD} = 1.8$ to 5.5 V, $V_{SS} = AV_{SS} = 0$ V)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
NMI high-/low-level width	t_{WNIL} , t_{WNIH}		10			μs
INTP input high-/low-level width	t_{WITL} , t_{WITR}	INTP0 to INTP6	100			ns
$\overline{\text{RESET}}$ high-/low-level width	t_{WRSL} , t_{WRSH}		10			μs

A/D Converter Characteristics ($T_A = -40$ to $+85^\circ\text{C}$, $V_{DD} = AV_{DD} = 1.8$ to 5.5 V, $V_{SS} = AV_{SS} = 0$ V)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Resolution			8	8	8	bit
Overall error ^{Notes 1, 2}		$2.7\text{ V} \leq V_{DD} \leq 5.5\text{ V}$, $2.2\text{ V} \leq AV_{REF0} \leq V_{DD}$, $AV_{DD} = V_{DD}$			± 1.2	%FSR
		$1.8\text{ V} \leq V_{DD} < 2.7\text{ V}$, $1.8\text{ V} \leq AV_{REF0} \leq V_{DD}$, $AV_{DD} = V_{DD}$			± 1.6	%FSR
Conversion time	t_{CONV}		14		144	μs
Sampling time	t_{SAMP}		$24/f_{xx}$			μs
Analog input voltage	V_{IAN}		AV_{SS}		AV_{REF0}	V
Reference voltage	AV_{REF0}		1.8		AV_{DD}	V
Resistance between AV_{REF0} and AV_{SS}	R_{AVREF0}	When not A/D converting		40		$\text{k}\Omega$

- Notes**
- Quantization error ($\pm 1/2$ LSB) is not included.
 - Overall error is indicated as a ratio to the full-scale value (%FSR).

Remark f_{xx} : Main system clock frequency

D/A Converter Characteristics ($T_A = -40$ to $+85^\circ\text{C}$, $V_{DD} = AV_{DD} = 1.8$ to 5.5 V, $V_{SS} = AV_{SS} = 0$ V)

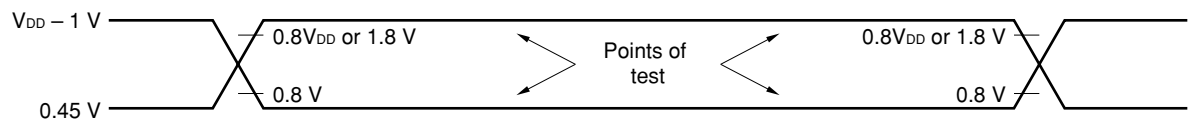
Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit	
Resolution			8	8	8	bit	
Overall error ^{Notes 1, 2}		$R = 10\text{ M}\Omega$, $2.0\text{ V} \leq AV_{REF1} \leq V_{DD}$, $2.0\text{ V} \leq V_{DD} \leq 5.5\text{ V}$, $AV_{DD} = V_{DD}$			± 0.6	%FSR	
		$R = 10\text{ M}\Omega$, $1.8\text{ V} \leq AV_{REF1} \leq V_{DD}$, $1.8\text{ V} \leq V_{DD} \leq 2.0\text{ V}$, $AV_{DD} = V_{DD}$			± 1.2	%FSR	
Settling time		Load conditions: $C = 30\text{ pF}$	$4.5\text{ V} \leq AV_{REF1} \leq 5.5\text{ V}$			10	μs
			$2.7\text{ V} \leq AV_{REF1} < 4.5\text{ V}$			15	μs
			$1.8\text{ V} \leq AV_{REF1} < 2.7\text{ V}$			20	μs
Output resistance	R_O	DACS0, 1 = 55H		8		$\text{k}\Omega$	
Reference voltage	AV_{REF1}		1.8		V_{DD}	V	
AV_{REF1} current	AI_{REF1}	For only 1 channel			2.5	mA	

- Notes**
- Quantization error ($\pm 1/2$ LSB) is not included.
 - Overall error is indicated as a ratio to the full-scale value (%FSR).

Data Retention Characteristics ($T_A = -40$ to $+85^\circ\text{C}$, $V_{DD} = AV_{DD} = 1.8$ to 5.5 V, $V_{SS} = AV_{SS} = 0$ V)

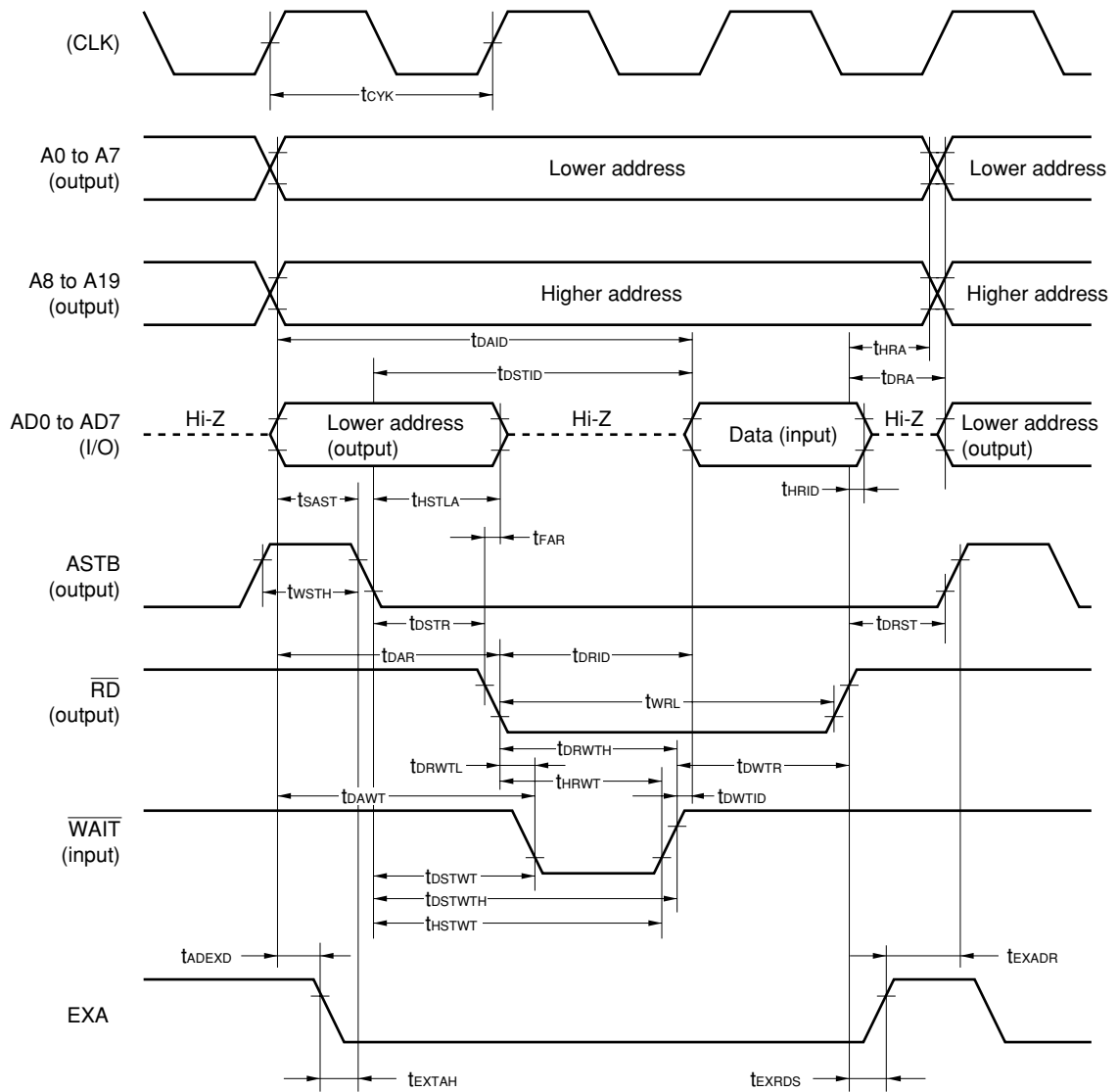
Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Data retention voltage	V_{DDDR}	STOP mode	1.8		5.5	V
Data retention current	I_{DDDR}	$V_{DDDR} = 5.0\text{ V} \pm 10\%$		10	50	μA
		$V_{DDDR} = 2.0\text{ V} \pm 10\%$		2	10	μA
V_{DD} rise time	t_{RVD}		200			μs
V_{DD} fall time	t_{FVD}		200			μs
V_{DD} hold time (from STOP mode setting)	t_{HVD}		0			ms
STOP release signal input time	t_{DREL}		0			ms
Oscillation stabilization wait time	t_{WAIT}	Crystal resonator	30			ms
		Ceramic resonator	5			ms
Low-level input voltage	V_{IL}	$\overline{\text{RESET}}$, P00/INTP0 to P06/INTP6	0		$0.1V_{DDDR}$	V
High-level input voltage	V_{IH}		$0.9V_{DDDR}$		V_{DDDR}	V

AC Timing Test Points



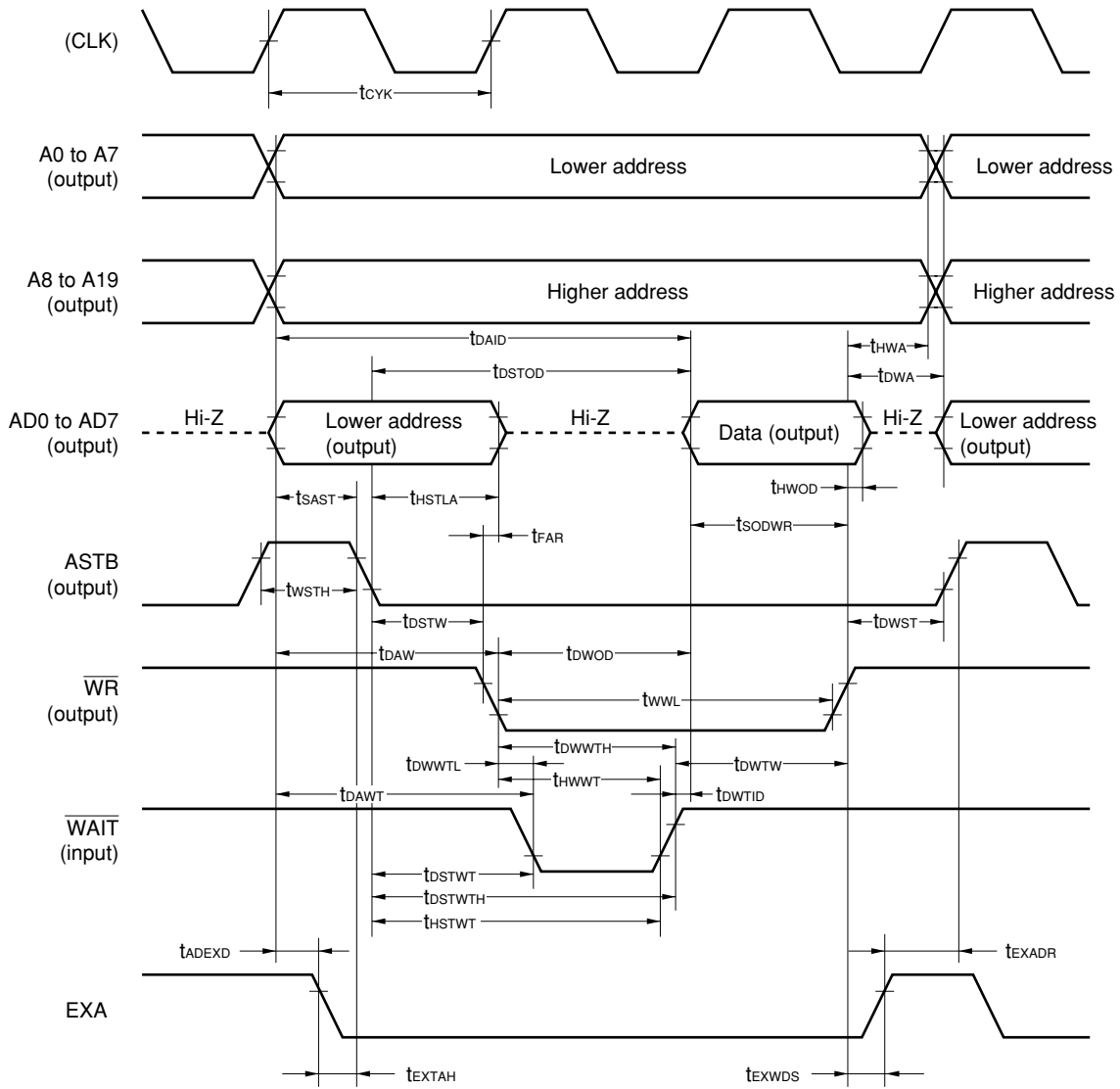
Timing Waveforms

(1) Read operations



Remark The signal is output from pins A0 to A7 when P80 to P87 are unused.

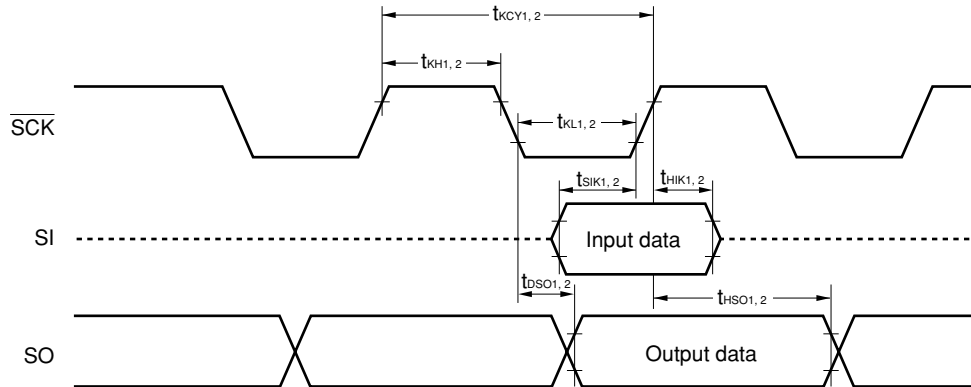
(2) Write operation



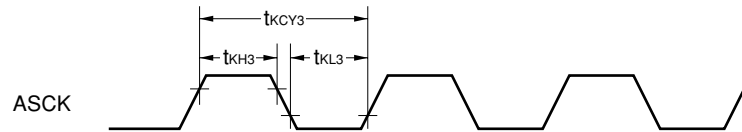
Remark The signal is output from pins A0 to A7 when P80 to P87 are unused.

Serial Operation

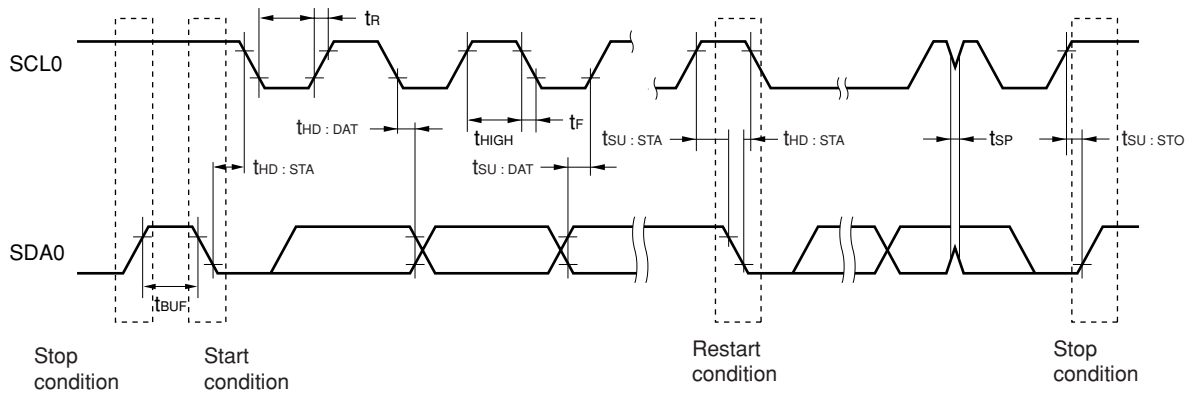
(1) 3-wire serial I/O mode



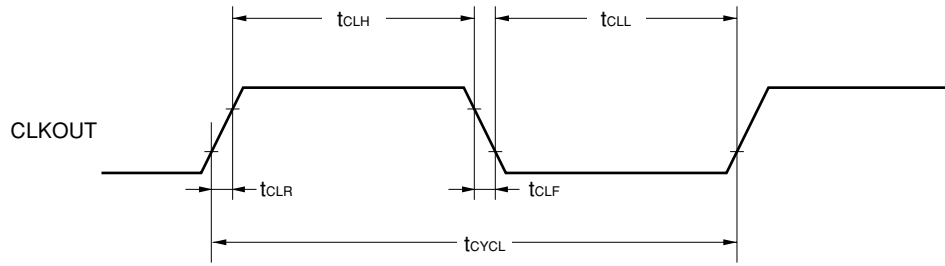
(2) UART mode



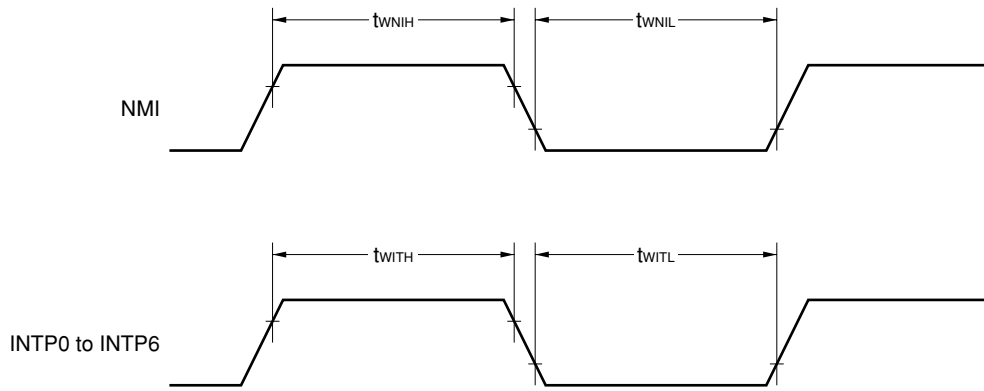
(3) I²C bus mode (μ PD784216AY, 784218AY Subseries only)



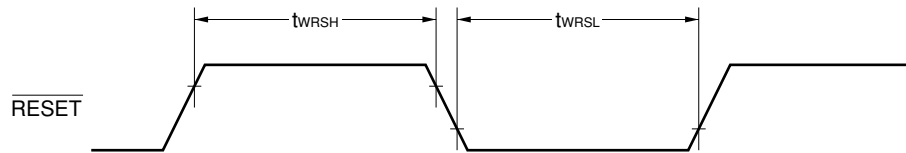
Clock Output Timing



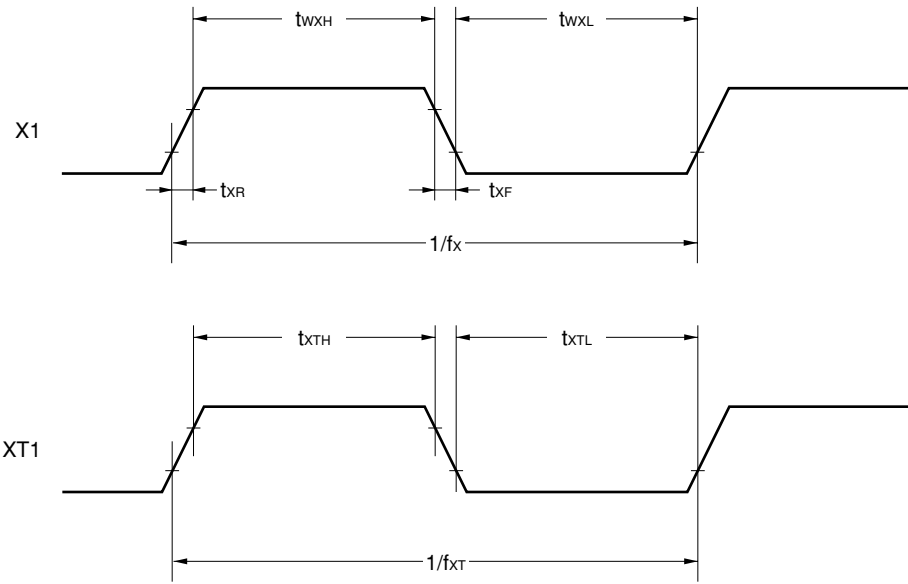
Interrupt Input Timing



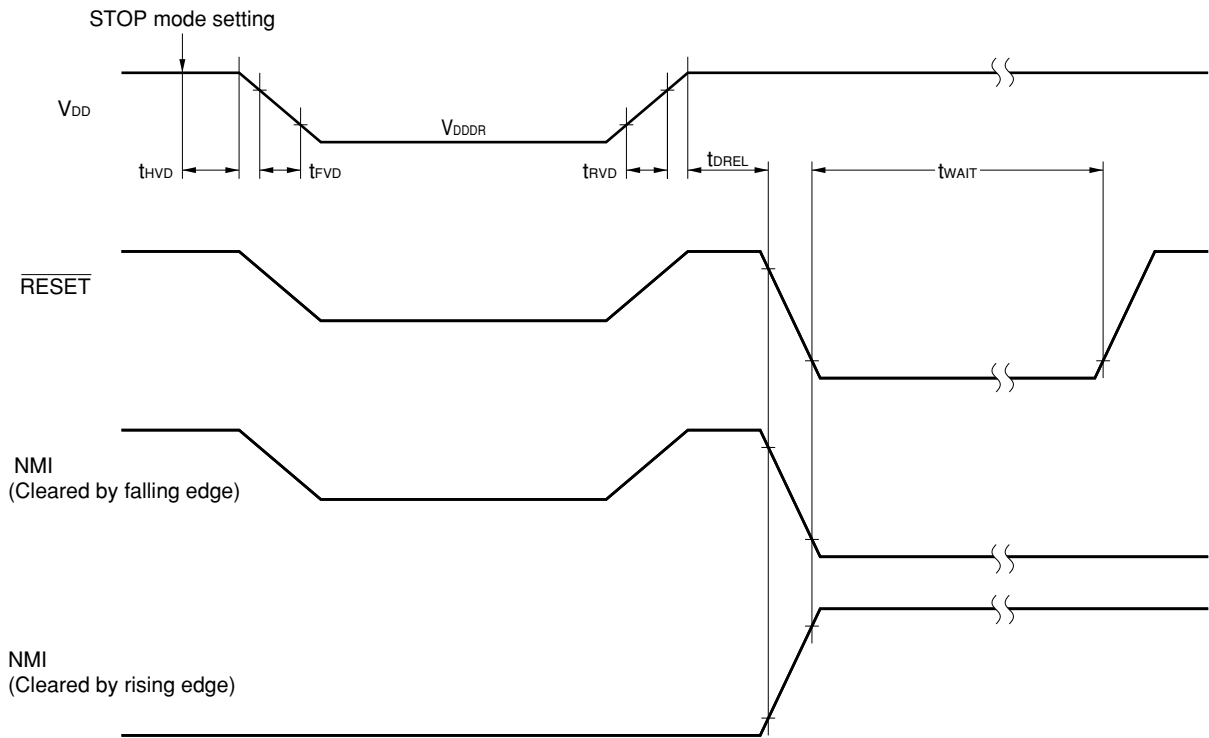
Reset Input Timing



Clock Timing



Data Retention Characteristics



★ CHAPTER 31 ELECTRICAL SPECIFICATIONS (μ PD78F4216A, 78F4218A, 78F4216AY, 78F4218AY)

Absolute Maximum Ratings (T_A = 25°C)

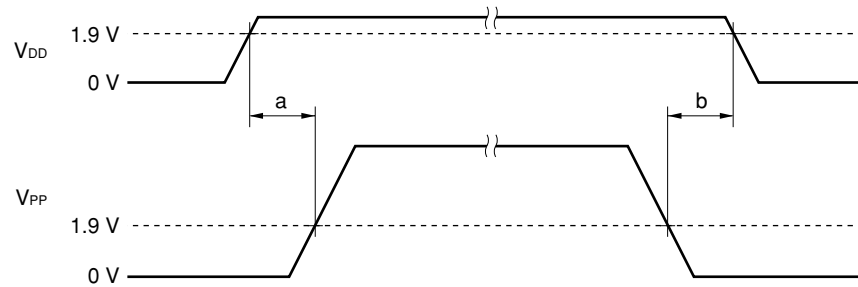
Parameter	Symbol	Conditions	Ratings	Unit	
Supply voltage	V _{DD}		-0.3 to +6.5	V	
	V _{PP}	Note	-0.3 to +10.5	V	
	AV _{DD}		-0.3 to V _{DD} + 0.3	V	
	AV _{SS}		-0.3 to V _{SS} + 0.3	V	
	AV _{REF0}	A/D converter reference voltage input	-0.3 to V _{DD} + 0.3	V	
	AV _{REF1}	D/A converter reference voltage input	-0.3 to V _{DD} + 0.3	V	
Input voltage	V _{I1}	Other than P90 to P95	-0.3 to V _{DD} + 0.3	V	
	V _{I2}	P90 to P95	N-ch open drain	-0.3 to +12	V
	V _{I3}	V _{DD} pin during programming		-0.3 to +10.5	V
Analog input voltage	V _{AN}	Analog input pin	AV _{SS} - 0.3 to AV _{REF0} + 0.3	V	
Output voltage	V _O		-0.3 to V _{DD} + 0.3	V	
Output current, low	I _{OL}	Per pin	15	mA	
		Total of P2, P4 to P8	75	mA	
		Total of P0, P3, P9, P10, P12, P13	75	mA	
		Total of all pins	100	mA	
Output current, high	I _{OH}	Per pin	-10	mA	
		Total of all pins	-50	mA	
Operating ambient temperature	T _A	During normal operation	-40 to +85	°C	
		During flash memory programming	+10 to +40	°C	
Storage temperature	T _{stg}		-65 to +150	°C	

(The notes are explained on the following page.)

- Cautions**
1. Product quality may suffer if the absolute maximum rating is exceeded even momentarily for any parameter. That is, the absolute maximum ratings are rated values at which the product is on the verge of suffering physical damage, and therefore the product must be used under conditions that ensure that the absolute maximum ratings are not exceeded.
 2. The operating ambient temperature of the μ PD78F4216A and 78F4218A rank K is T_A = -10 to +60°C, and the storage temperature is T_{stg} = -10 to +80°C.

Note Make sure that the following conditions of the V_{PP} voltage application timing are satisfied when the flash memory is written.

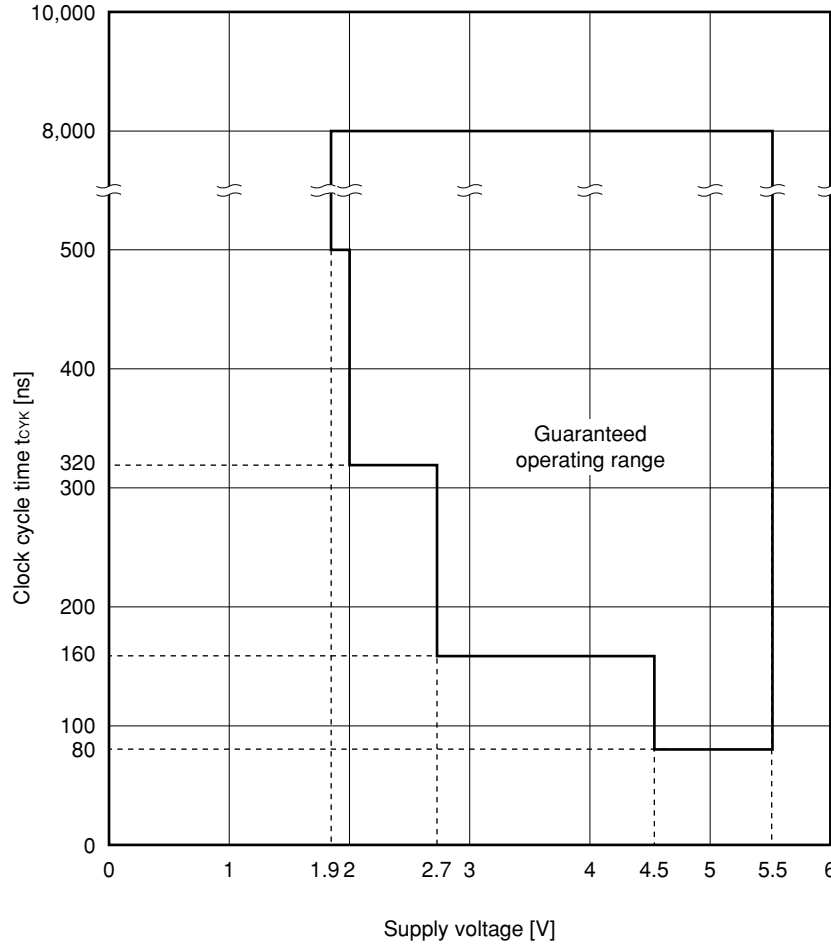
- When supply voltage rises
 V_{PP} must exceed V_{DD} $10\ \mu\text{s}$ or more after V_{DD} has reached the lower-limit value (1.9 V) of the operating voltage range (see **a** in the figure below).
- When supply voltage drops
 V_{DD} must be lowered $10\ \mu\text{s}$ or more after V_{PP} falls below the lower-limit value (1.9 V) of the operating voltage range of V_{DD} (see **b** in the figure below).



Operating Conditions

- Operating ambient temperature (T_A): -40 to $+85^\circ\text{C}$
- Power supply voltage and clock cycle time: see **Figure 31-1**
- Power supply voltage with subsystem clock operation: $V_{DD} = 1.9$ to 5.5 V

Figure 31-1. Power Supply Voltage and Clock Cycle Time (CPU Clock Frequency: f_{CPU})



Caution The operating voltage of the μ PD78F4216A and 78F4216AY rank K, E is $2.7\text{ V} \leq V_{DD} \leq 5.5\text{ V}$.

Capacitance ($T_A = 25^\circ\text{C}$, $V_{DD} = V_{SS} = 0\text{ V}$)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit	
Input capacitance	C_i	f = 1 MHz Unmeasured pins returned to 0 V.	Other than port 9			15	pF
			Port 9			20	pF
Output capacitance	C_o	f = 1 MHz Unmeasured pins returned to 0 V.	Other than port 9			15	pF
			Port 9			20	pF
I/O capacitance	C_{iO}	f = 1 MHz Unmeasured pins returned to 0 V.	Other than port 9			15	pF
			Port 9			20	pF

Main System Clock Oscillator Characteristics ($T_A = -40$ to $+85^\circ\text{C}$)

Resonator	Recommended Circuit	Parameter	Conditions	MIN.	TYP.	MAX.	Unit		
Ceramic resonator or crystal resonator		Oscillation frequency (f_x)	ENMP = 0	$4.5\text{ V} \leq V_{DD} \leq 5.5\text{ V}$	4		25	MHz	
				$2.7\text{ V} \leq V_{DD} < 4.5\text{ V}$	4		12.5		
				$2.0\text{ V} \leq V_{DD} < 2.7\text{ V}$	4		6.25		
				$1.9\text{ V} \leq V_{DD} < 2.0\text{ V}$	4		4		
			ENMP = 1	$4.5\text{ V} \leq V_{DD} \leq 5.5\text{ V}$	2		12.5	MHz	
				$2.7\text{ V} \leq V_{DD} < 4.5\text{ V}$	2		6.25		
				$2.0\text{ V} \leq V_{DD} < 2.7\text{ V}$	2		3.125		
				$1.9\text{ V} \leq V_{DD} < 2.0\text{ V}$	2		2		
External clock		X1 input frequency (f_x)	ENMP = 0	$4.5\text{ V} \leq V_{DD} \leq 5.5\text{ V}$	4		25	MHz	
				$2.7\text{ V} \leq V_{DD} < 4.5\text{ V}$	4		12.5		
				$2.0\text{ V} \leq V_{DD} < 2.7\text{ V}$	4		6.25		
				$1.9\text{ V} \leq V_{DD} < 2.0\text{ V}$	4		4		
			ENMP = 1	$4.5\text{ V} \leq V_{DD} \leq 5.5\text{ V}$	2		12.5	MHz	
				$2.7\text{ V} \leq V_{DD} < 4.5\text{ V}$	2		6.25		
				$2.0\text{ V} \leq V_{DD} < 2.7\text{ V}$	2		3.125		
				$1.9\text{ V} \leq V_{DD} < 2.0\text{ V}$	2		2		
			X1 input high-/low-level width (t_{WXH} , t_{WXL})			15		250	ns
			X1 input rising/falling time (t_{XR} , t_{XF})	$4.5\text{ V} \leq V_{DD} \leq 5.5\text{ V}$		0		5	ns
$2.7\text{ V} \leq V_{DD} < 4.5\text{ V}$		0			10				
$2.0\text{ V} \leq V_{DD} < 2.7\text{ V}$		0			20				
$1.9\text{ V} \leq V_{DD} < 2.0\text{ V}$		0			30				

Cautions 1. When using the main system clock oscillator, wire as follows in the area enclosed by the broken lines in the above figures to avoid an adverse effect from wiring capacitance.

- Keep the wiring length as short as possible.
- Do not cross the wiring with other signal lines.
- Do not route the wiring near a signal line through which a high fluctuating current flows.
- Always make the ground point of the oscillator capacitor the same potential as V_{SS} .
- Do not ground the capacitor to a ground pattern through which a high current flows.
- Do not fetch signals from the oscillator.

2. When the main system clock is stopped and the system is operated by the subsystem clock, the subsystem clock should be switched back to the main system clock after the oscillation stabilization time is secured by the program.

Subsystem Clock Oscillator Characteristics ($T_A = -40$ to $+85^\circ\text{C}$)

Resonator	Recommended Circuit	Parameter	Conditions	MIN.	TYP.	MAX.	Unit
Crystal resonator		Oscillation frequency (f_{XT})		32	32.768	35	kHz
		Oscillation stabilization time ^{Note}	$4.5\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ $1.9\text{ V} \leq V_{DD} < 4.5\text{ V}$		1.2	2	10
External clock		XT1 input frequency (f_{XT})		32		35	kHz
		XT1 input high-/low-level width (t_{XTH} , t_{XTL})		14.3		15.6	μs

Note Time required to stabilize oscillation after applying the supply voltage (V_{DD}).

Cautions 1. When using the subsystem clock oscillator, wire as follows in the area enclosed by the broken lines in the above figures to avoid an adverse effect from wiring capacitance.

- Keep the wiring length as short as possible.
- Do not cross the wiring with other signal lines.
- Do not route the wiring near a signal line through which a high fluctuating current flows.
- Always make the ground point of the oscillator capacitor the same potential as V_{SS} .
- Do not ground the capacitor to a ground pattern through which a high current flows.
- Do not fetch signals from the oscillator.

2. When the main system clock is stopped and the device is operating on the subsystem clock, wait until the oscillation stabilization time has been secured by the program before switching back to the main system clock.

Remark For the resonator selection and oscillator constant, users are required to either evaluate the oscillation themselves or apply to the resonator manufacturer for evaluation.

Recommended Oscillator Constant

Main system clock: Ceramic resonator connection ($T_A = -40$ to $+85^\circ\text{C}$)

(1) μ PD78F4216A, 78F4216AY

Manufacturer	Part Number	Oscillation Frequency f_{xx} (MHz)	Recommended Circuit Constants		Oscillation Voltage Range		Oscillation Stabilization Time (MAX.) t_{OST} (ms)
			C1 (pF)	C2 (pF)	MIN. (V)	MAX. (V)	
Murata Mfg. Co., Ltd.	CSTS0200MG06	2.0	On-chip	On-chip	1.9	5.5	0.46
	CSTCC2.00MG0H6	2.0	On-chip	On-chip	1.9	5.5	0.44
	CSTS0400MG06	4.0	On-chip	On-chip	2.7	5.5	0.44
	CSTCC4.00MG0H6	4.0	On-chip	On-chip	2.7	5.5	0.40
	CSTS0600MG03	6.0	On-chip	On-chip	2.7	5.5	0.25
	CSTCC6.00MG	6.0	On-chip	On-chip	2.7	5.5	0.25
	CSTS0800MG03	8.0	On-chip	On-chip	4.5	5.5	0.24
	CSTCC8.00MG	8.0	On-chip	On-chip	4.5	5.5	0.24
	CST10.0MTW	10.0	On-chip	On-chip	4.5	5.5	0.30
	CST10.0MTW093	10.0	On-chip	On-chip	4.5	5.5	0.30
	CSTCC10.0MG	10.0	On-chip	On-chip	4.5	5.5	0.25
	CSTCC10.0MG93	10.0	On-chip	On-chip	4.5	5.5	0.25
	CST12.5MTW	12.5	On-chip	On-chip	4.5	5.5	0.30
	CST12.5MTW093	12.5	On-chip	On-chip	4.5	5.5	0.30
CSTCV12.5MTJ0C4	12.5	On-chip	On-chip	4.5	5.5	0.25	
Kyocera Corporation	PBRC4.00HR	4.0	On-chip	On-chip	2.7	5.5	0.3
	PBRC4.00GR	4.0	33	33	2.7	5.5	0.3
	KBR-4.0MKC	4.0	On-chip	On-chip	2.7	5.5	0.3
	KBR-4.0MSB	4.0	33	33	2.7	5.5	0.3
	PBRC8.00HR	8.0	On-chip	On-chip	4.5	5.5	0.3
	PBRC8.00GR	8.0	33	33	4.5	5.5	0.3
	KBR-8.0MKC	8.0	On-chip	On-chip	4.5	5.5	0.3
	KBR-8.0MSB	8.0	33	33	4.5	5.5	0.3
	PBRC10.00BR-A	10.0	On-chip	On-chip	4.5	5.5	0.2
PBRC12.50BR-A	12.5	On-chip	On-chip	4.5	5.5	0.2	
TDK	FCR4.0MC5	4.0	On-chip	On-chip	2.7	5.5	0.17
	FCR6.0MC5	6.0	On-chip	On-chip	2.7	5.5	0.15
	FCR8.0MC5	8.0	On-chip	On-chip	4.5	5.5	0.15

Caution The oscillator constant is a reference value based on evaluation in specific environments by the resonator manufacturer. If the oscillator characteristics need to be optimized in the actual application, request the resonator manufacturer for evaluation on the implementation circuit. Note that the oscillation voltage and oscillation frequency merely indicate the characteristics of the oscillator. Use the internal operation conditions of each product within the specifications of the DC and AC characteristics.

(2) μ PD78F4218A, 78F4218AY

Manufacturer	Part Number	Oscillation Frequency f_{xx} (MHz)	Recommended Circuit Constants		Oscillation Voltage Range		Oscillation Stabilization Time (MAX.) t_{OST} (ms)
			C1 (pF)	C2 (pF)	MIN. (V)	MAX. (V)	
Murata Mfg. Co., Ltd.	CSTS2.00MG040	2.0	On-chip	On-chip	1.9	5.5	0.72
	CSTLS2M00G56-B0	2.0	On-chip	On-chip	1.9	5.5	0.48
	CSTCC2M00G56-R0	2.0	On-chip	On-chip	1.9	5.5	0.50
	CSTLS4M00G56-B0	4.0	On-chip	On-chip	2.7	5.5	0.47
	CSTCR4M00G55-R0	4.0	On-chip	On-chip	2.7	5.5	0.45
	CSTLS6M00G56-B0	6.0	On-chip	On-chip	2.7	5.5	0.48
	CSTCR6M00G55-R0	6.0	On-chip	On-chip	2.7	5.5	0.45
	CSTLS8M00G53-B0	8.0	On-chip	On-chip	4.5	5.5	0.30
	CSTCC8M00G53-R0	8.0	On-chip	On-chip	4.5	5.5	0.28
	CSTLS10M0G53-B0	10.0	On-chip	On-chip	4.5	5.5	0.29
	CSTCC10M0G53-R0	10.0	On-chip	On-chip	4.5	5.5	0.30
	CSTLA12M5T55-B0	12.5	On-chip	On-chip	4.5	5.5	0.33
	CSTCV12M5T54J-R0	12.5	On-chip	On-chip	4.5	5.5	0.30
Kyocera Corporation	PBRC2.00AR-A	2.0	68	68	1.9	5.5	0.4
	PBRC4.00HR	4.0	On-chip	On-chip	2.7	5.5	0.3
	PBRC6.00HR	6.0	On-chip	On-chip	2.7	5.5	0.2
	SSR8.00CR-S24	8.0	On-chip	On-chip	4.5	5.5	0.3
	SSR12.50CR-S24	12.5	On-chip	On-chip	4.5	5.5	0.3
TDK	FCR4.0MC5	4.0	On-chip	On-chip	2.7	5.5	0.30
	FCR6.0MC5	6.0	On-chip	On-chip	2.7	5.5	0.22
	FCR8.0MC5	8.0	On-chip	On-chip	4.5	5.5	0.3
	FCR10.0MC5	10.0	On-chip	On-chip	4.5	5.5	0.20

Caution The oscillator constant is a reference value based on evaluation in specific environments by the resonator manufacturer. If the oscillator characteristics need to be optimized in the actual application, request the resonator manufacturer for evaluation on the implementation circuit. Note that the oscillation voltage and oscillation frequency merely indicate the characteristics of the oscillator. Use the internal operation conditions of each product within the specifications of the DC and AC characteristics.

DC Characteristics ($T_A = -40$ to $+85^\circ\text{C}$, $V_{DD} = AV_{DD} = 1.9$ to 5.5 V, $V_{SS} = AV_{SS} = 0$ V) (1/3)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit	
Input voltage, low	V_{IL1}	Note 1	$2.2\text{ V} \leq V_{DD} \leq 5.5\text{ V}$	0		$0.3V_{DD}$	V
			$1.9\text{ V} \leq V_{DD} < 2.2\text{ V}$	0		$0.2V_{DD}$	
	V_{IL2}	P00 to P06, P20, P22, P33, P34, P70, P72, P100 to P103, $\overline{\text{RESET}}$	$2.2\text{ V} \leq V_{DD} \leq 5.5\text{ V}$	0		$0.2V_{DD}$	V
			$1.9\text{ V} \leq V_{DD} < 2.2\text{ V}$	0		$0.15V_{DD}$	
	V_{IL3}	P90 to P95 (N-ch open drain)	$2.2\text{ V} \leq V_{DD} \leq 5.5\text{ V}$	0		$0.3V_{DD}$	V
			$1.9\text{ V} \leq V_{DD} < 2.2\text{ V}$	0		$0.2V_{DD}$	
	V_{IL4}	P10 to P17, P130, P131	$2.2\text{ V} \leq V_{DD} \leq 5.5\text{ V}$	0		$0.3V_{DD}$	V
			$1.9\text{ V} \leq V_{DD} < 2.2\text{ V}$	0		$0.2V_{DD}$	
	V_{IL5}	X1, X2, XT1, XT2	$2.2\text{ V} \leq V_{DD} \leq 5.5\text{ V}$	0		$0.2V_{DD}$	V
			$1.9\text{ V} \leq V_{DD} < 2.2\text{ V}$	0		$0.1V_{DD}$	
	V_{IL6}	P25, P27	$2.2\text{ V} \leq V_{DD} \leq 5.5\text{ V}$	0		$0.3V_{DD}$	V
			$1.9\text{ V} \leq V_{DD} < 2.2\text{ V}$	0		$0.2V_{DD}$	
Input voltage, high	V_{IH1}	Note 1	$2.2\text{ V} \leq V_{DD} \leq 5.5\text{ V}$	$0.7V_{DD}$		V_{DD}	V
			$1.9\text{ V} \leq V_{DD} < 2.2\text{ V}$	$0.8V_{DD}$		V_{DD}	
	V_{IH2}	P00 to P06, P20, P22, P33, P34, P70, P72, P100 to P103, $\overline{\text{RESET}}$	$2.2\text{ V} \leq V_{DD} \leq 5.5\text{ V}$	$0.8V_{DD}$		V_{DD}	V
			$1.9\text{ V} \leq V_{DD} < 2.2\text{ V}$	$0.85V_{DD}$		V_{DD}	
	V_{IH3}	P90 to P95 (N-ch open drain)	$2.2\text{ V} \leq V_{DD} \leq 5.5\text{ V}$	$0.7V_{DD}$		12	V
			$1.9\text{ V} \leq V_{DD} < 2.2\text{ V}$	$0.8V_{DD}$		V_{DD}	
	V_{IH4}	P10 to P17, P130, P131	$2.2\text{ V} \leq V_{DD} \leq 5.5\text{ V}$	$0.7V_{DD}$		V_{DD}	V
			$1.9\text{ V} \leq V_{DD} < 2.2\text{ V}$	$0.8V_{DD}$		V_{DD}	
	V_{IH5}	X1, X2, XT1, XT2	$2.2\text{ V} \leq V_{DD} \leq 5.5\text{ V}$	$0.8V_{DD}$		V_{DD}	V
			$1.9\text{ V} \leq V_{DD} < 2.2\text{ V}$	$0.85V_{DD}$		V_{DD}	
	V_{IH6}	P25, P27	$2.2\text{ V} \leq V_{DD} \leq 5.5\text{ V}$	$0.7V_{DD}$		V_{DD}	V
			$1.9\text{ V} \leq V_{DD} < 2.2\text{ V}$	$0.8V_{DD}$		V_{DD}	
Output voltage, low	V_{OL1}	For pins other than P40 to P47, P50 to P57, P90 to P95, $I_{OL} = 1.6\text{ mA}$ Note 2	$4.5\text{ V} \leq V_{DD} \leq 5.5\text{ V}$			0.4	V
		P40 to P47, P50 to P57 $I_{OL} = 8\text{ mA}$ Note 2	$4.5\text{ V} \leq V_{DD} \leq 5.5\text{ V}$			1.0	V
		P90 to P95 $I_{OL} = 15\text{ mA}$ Note 2	$4.5\text{ V} \leq V_{DD} \leq 5.5\text{ V}$		0.8	2.0	V
	V_{OL2}	$I_{OL} = 400\ \mu\text{A}$ Note 2				0.5	V
Output voltage, high	V_{OH1}	$I_{OH} = -1\text{ mA}$ Note 2	$4.5\text{ V} \leq V_{DD} \leq 5.5\text{ V}$	$V_{DD} - 1.0$			V
		$I_{OH} = -100\ \mu\text{A}$ Note 2	$1.9\text{ V} \leq V_{DD} \leq 5.5\text{ V}$	$V_{DD} - 0.5$			V
Input leakage current, low	I_{LIL1}	$V_I = 0\text{ V}$	Except X1, X2, XT1, XT2			-3	μA
	I_{LIL2}		X1, X2, XT1, XT2			-20	μA

- Notes** 1. P21, P23, P24, P26, P30 to P32, P35 to P37, P40 to P47, P50 to P57, P60 to P67, P71, P120 to P127
 2. Per pin

DC Characteristics ($T_A = -40$ to $+85^\circ\text{C}$, $V_{DD} = AV_{DD} = 1.9$ to 5.5 V, $V_{SS} = AV_{SS} = 0$ V) (2/3)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Input leakage current, high	I_{LIH1}	$V_i = V_{DD}$			3	μA
	I_{LIH2}		Except X1, X2, XT1, XT2			
	I_{LIH3}	$V_i = 12$ V (N-ch open drain)	X1, X2, XT1, XT2		20	μA
					20	μA
Output leakage current, low	I_{LOL1}	$V_o = 0$ V			-3	μA
Output leakage current, high	I_{LOH1}	$V_o = V_{DD}$			3	μA

(1) μ PD78F4216A, 78F4216AY

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit	
Supply current	I_{DD1}	Operation mode	$f_{XX} = 12.5$ MHz, $V_{DD} = 5.0$ V $\pm 10\%$		17	40	mA
			$f_{XX} = 6$ MHz, $V_{DD} = 3.0$ V $\pm 10\%$		5	17	mA
			$f_{XX} = 2$ MHz, $V_{DD} = 2.0$ V $\pm 5\%$		2	10	mA
	I_{DD2}	HALT mode	$f_{XX} = 12.5$ MHz, $V_{DD} = 5.0$ V $\pm 10\%$		6	20	mA
			$f_{XX} = 6$ MHz, $V_{DD} = 3.0$ V $\pm 10\%$		2	10	mA
			$f_{XX} = 2$ MHz, $V_{DD} = 2.0$ V $\pm 5\%$		0.4	7	mA
	I_{DD3}	IDLE mode	$f_{XX} = 12.5$ MHz, $V_{DD} = 5.0$ V $\pm 10\%$		1	3	mA
			$f_{XX} = 6$ MHz, $V_{DD} = 3.0$ V $\pm 10\%$		0.5	1.3	mA
			$f_{XX} = 2$ MHz, $V_{DD} = 2.0$ V $\pm 5\%$		0.3	0.9	mA
	I_{DD4}	Operation mode ^{Note}	$f_{XX} = 32$ kHz, $V_{DD} = 5.0$ V $\pm 10\%$		130	500	μA
			$f_{XX} = 32$ kHz, $V_{DD} = 3.0$ V $\pm 10\%$		90	350	μA
			$f_{XX} = 32$ kHz, 2.0 V $\leq V_{DD} \leq 2.7$ V		80	300	μA
			$f_{XX} = 32$ kHz, 1.9 V $\leq V_{DD} < 2.0$ V		70	250	μA
	I_{DD5}	HALT mode ^{Note}	$f_{XX} = 32$ kHz, $V_{DD} = 5.0$ V $\pm 10\%$		60	200	μA
			$f_{XX} = 32$ kHz, $V_{DD} = 3.0$ V $\pm 10\%$		20	160	μA
			$f_{XX} = 32$ kHz, 2.0 V $\leq V_{DD} \leq 2.7$ V		15	120	μA
$f_{XX} = 32$ kHz, 1.9 V $\leq V_{DD} < 2.0$ V				10	100	μA	
I_{DD6}	IDLE mode ^{Note}	$f_{XX} = 32$ kHz, $V_{DD} = 5.0$ V $\pm 10\%$		50	190	μA	
		$f_{XX} = 32$ kHz, $V_{DD} = 3.0$ V $\pm 10\%$		15	150	μA	
		$f_{XX} = 32$ kHz, 2.0 V $\leq V_{DD} \leq 2.7$ V		12	110	μA	
		$f_{XX} = 32$ kHz, 1.9 V $\leq V_{DD} < 2.0$ V		7	90	μA	
Data retention voltage	V_{DDDR}	HALT, IDLE modes	1.9		5.5	V	
Data retention current	I_{DDDR}	STOP mode	$V_{DD} = 2.0$ V $\pm 5\%$		2	10	μA
			$V_{DD} = 5.0$ V $\pm 10\%$		10	50	μA
Pull-up resistor	R_L	$V_i = 0$ V	10	30	100	k Ω	

Note When the main system clock is stopped and subsystem clock is operating.

Remark Unless otherwise specified, the characteristics of alternate-function pins are the same as those of port pins.

DC Characteristics ($T_A = -40$ to $+85^\circ\text{C}$, $V_{DD} = AV_{DD} = 1.9$ to 5.5 V, $V_{SS} = AV_{SS} = 0$ V) (3/3)

 (2) μ PD78F4218A, 78F4218AY

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit	
Supply current	I _{DD1}	Operation mode	f _{XX} = 12.5 MHz, V _{DD} = 5.0 V \pm 10%		19	40	mA
			f _{XX} = 6 MHz, V _{DD} = 3.0 V \pm 10%		6	17	mA
			f _{XX} = 3 MHz, V _{DD} = 2.0 V \pm 5%		2	10	mA
	I _{DD2}	HALT mode	f _{XX} = 12.5 MHz, V _{DD} = 5.0 V \pm 10%		7	20	mA
			f _{XX} = 6 MHz, V _{DD} = 3.0 V \pm 10%		2	10	mA
			f _{XX} = 3 MHz, V _{DD} = 2.0 V \pm 5%		0.5	7	mA
	I _{DD3}	IDLE mode	f _{XX} = 12.5 MHz, V _{DD} = 5.0 V \pm 10%		1	3	mA
			f _{XX} = 6 MHz, V _{DD} = 3.0 V \pm 10%		0.5	1.3	mA
			f _{XX} = 3 MHz, V _{DD} = 2.0 V \pm 5%		0.3	0.9	mA
	I _{DD4}	Operation mode ^{Note}	f _{XX} = 32 kHz, V _{DD} = 5.0 V \pm 10%		140	500	μ A
			f _{XX} = 32 kHz, V _{DD} = 3.0 V \pm 10%		100	350	μ A
			f _{XX} = 32 kHz, 2.0 V \leq V _{DD} \leq 2.7 V		90	300	μ A
			f _{XX} = 32 kHz, 1.9 V \leq V _{DD} < 2.0 V		80	250	μ A
	I _{DD5}	HALT mode ^{Note}	f _{XX} = 32 kHz, V _{DD} = 5.0 V \pm 10%		60	200	μ A
			f _{XX} = 32 kHz, V _{DD} = 3.0 V \pm 10%		20	160	μ A
			f _{XX} = 32 kHz, 2.0 V \leq V _{DD} \leq 2.7 V		15	120	μ A
f _{XX} = 32 kHz, 1.9 V \leq V _{DD} < 2.0 V				10	100	μ A	
I _{DD6}	IDLE mode ^{Note}	f _{XX} = 32 kHz, V _{DD} = 5.0 V \pm 10%		50	190	μ A	
		f _{XX} = 32 kHz, V _{DD} = 3.0 V \pm 10%		15	150	μ A	
		f _{XX} = 32 kHz, 2.0 V \leq V _{DD} \leq 2.7 V		12	110	μ A	
		f _{XX} = 32 kHz, 1.9 V \leq V _{DD} < 2.0 V		7	90	μ A	
Data retention voltage	V _{DDDR}	HALT, IDLE modes	1.9		5.5	V	
Data retention current	I _{DDDR}	STOP mode	V _{DD} = 2.0 V \pm 5%		2	10	μ A
			V _{DD} = 5.0 V \pm 10%		10	50	μ A
Pull-up resistor	R _L	V _I = 0 V	10	30	100	k Ω	

Note When the main system clock is stopped and subsystem clock is operating.

Remark Unless otherwise specified, the characteristics of alternate-function pins are the same as those of port pins.

AC Characteristics (T_A = -40 to +85°C, V_{DD} = AV_{DD} = 1.9 to 5.5 V, V_{SS} = AV_{SS} = 0 V)

(1) Read/write operation (1/3)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Cycle time	t _{cyk}	4.5 V ≤ V _{DD} ≤ 5.5 V	80			ns
		2.7 V ≤ V _{DD} < 4.5 V	160			ns
		2.0 V ≤ V _{DD} < 2.7 V	320			ns
		1.9 V ≤ V _{DD} < 2.0 V	500			ns
Address setup time (to ASTB↓)	t _{sAST}	V _{DD} = 5.0 V ±10%	(0.5 + a) T - 20			ns
		V _{DD} = 3.0 V ±10%	(0.5 + a) T - 40			ns
		V _{DD} = 2.0 V ±5%	(0.5 + a) T - 80			ns
Address hold time (from ASTB↓)	t _{hSTLA}	V _{DD} = 5.0 V ±10%	0.5T - 19			ns
		V _{DD} = 3.0 V ±10%	0.5T - 24			ns
		V _{DD} = 2.0 V ±5%	0.5T - 34			ns
ASTB high-level width	t _{wSTH}	V _{DD} = 5.0 V ±10%	(0.5 + a) T - 17			ns
		V _{DD} = 3.0 V ±10%	(0.5 + a) T - 40			ns
		V _{DD} = 2.0 V ±5%	(0.5 + a) T - 110			ns
Address hold time (from $\overline{RD}\uparrow$)	t _{hRA}	V _{DD} = 5.0 V ±10%	0.5T - 14			ns
		V _{DD} = 3.0 V ±10%	0.5T - 14			ns
		V _{DD} = 2.0 V ±5%	0.5T - 14			ns
Delay time from address to $\overline{RD}\downarrow$	t _{dAR}	V _{DD} = 5.0 V ±10%	(1 + a) T - 24			ns
		V _{DD} = 3.0 V ±10%	(1 + a) T - 35			ns
		V _{DD} = 2.0 V ±5%	(1 + a) T - 80			ns
Address float time (from $\overline{RD}\downarrow$)	t _{fAR}	V _{DD} = 5.0 V ±10%			0	ns
		V _{DD} = 3.0 V ±10%			0	ns
		V _{DD} = 2.0 V ±5%			0	ns
Data input time from address	t _{dAID}	V _{DD} = 5.0 V ±10%			(2.5 + a + n) T - 37	ns
		V _{DD} = 3.0 V ±10%			(2.5 + a + n) T - 52	ns
		V _{DD} = 2.0 V ±5%			(2.5 + a + n) T - 120	ns
Data input time from ASTB↓	t _{dSTID}	V _{DD} = 5.0 V ±10%			(2 + n) T - 35	ns
		V _{DD} = 3.0 V ±10%			(2 + n) T - 50	ns
		V _{DD} = 2.0 V ±5%			(2 + n) T - 80	ns
Data input time from $\overline{RD}\downarrow$	t _{dRID}	V _{DD} = 5.0 V ±10%			(1.5 + n) T - 40	ns
		V _{DD} = 3.0 V ±10%			(1.5 + n) T - 50	ns
		V _{DD} = 2.0 V ±5%			(1.5 + n) T - 90	ns
Delay time from ASTB↓ to $\overline{RD}\downarrow$	t _{dSTR}	V _{DD} = 5.0 V ±10%	0.5T - 9			ns
		V _{DD} = 3.0 V ±10%	0.5T - 9			ns
		V _{DD} = 2.0 V ±5%	0.5T - 20			ns
Data hold time (from $\overline{RD}\uparrow$)	t _{hRID}	V _{DD} = 5.0 V ±10%	0			ns
		V _{DD} = 3.0 V ±10%	0			ns
		V _{DD} = 2.0 V ±5%	0			ns

Remark T: t_{cyk} = 1/f_{xx} (f_{xx}: Main system clock frequency)

a: 1 (during address wait), otherwise, 0

n: Number of wait states (n ≥ 0)

(1) Read/write operation (2/3)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Address active time from $\overline{RD}\uparrow$	t_{DRA}	$V_{DD} = 5.0\text{ V} \pm 10\%$	$0.5T - 2$			ns
		$V_{DD} = 3.0\text{ V} \pm 10\%$	$0.5T - 12$			ns
		$V_{DD} = 2.0\text{ V} \pm 5\%$	$0.5T - 35$			ns
Delay time from $\overline{RD}\uparrow$ to $ASTB\uparrow$	t_{DRST}	$V_{DD} = 5.0\text{ V} \pm 10\%$	$0.5T - 9$			ns
		$V_{DD} = 3.0\text{ V} \pm 10\%$	$0.5T - 9$			ns
		$V_{DD} = 2.0\text{ V} \pm 5\%$	$0.5T - 40$			ns
\overline{RD} low-level width	t_{WRL}	$V_{DD} = 5.0\text{ V} \pm 10\%$	$(1.5 + n) T - 25$			ns
		$V_{DD} = 3.0\text{ V} \pm 10\%$	$(1.5 + n) T - 30$			ns
		$V_{DD} = 2.0\text{ V} \pm 5\%$	$(1.5 + n) T - 25$			ns
Address active time from $\overline{WR}\uparrow$	t_{DWA}	$V_{DD} = 5.0\text{ V} \pm 10\%$	$0.5T - 2$			ns
		$V_{DD} = 3.0\text{ V} \pm 10\%$	$0.5T - 12$			ns
		$V_{DD} = 2.0\text{ V} \pm 5\%$	$0.5T - 35$			ns
Delay time from address to $\overline{WR}\downarrow$	t_{DAW}	$V_{DD} = 5.0\text{ V} \pm 10\%$	$(1 + a) T - 24$			ns
		$V_{DD} = 3.0\text{ V} \pm 10\%$	$(1 + a) T - 34$			ns
		$V_{DD} = 2.0\text{ V} \pm 5\%$	$(1 + a) T - 70$			ns
Address hold time (from $\overline{WR}\uparrow$)	t_{HWA}	$V_{DD} = 5.0\text{ V} \pm 10\%$	$0.5T - 14$			ns
		$V_{DD} = 3.0\text{ V} \pm 10\%$	$0.5T - 14$			ns
		$V_{DD} = 2.0\text{ V} \pm 5\%$	$0.5T - 14$			ns
Delay time from $ASTB\downarrow$ to data output	t_{DSTOD}	$V_{DD} = 5.0\text{ V} \pm 10\%$			$0.5T + 15$	ns
		$V_{DD} = 3.0\text{ V} \pm 10\%$			$0.5T + 30$	ns
		$V_{DD} = 2.0\text{ V} \pm 5\%$			$0.5T + 240$	ns
Delay time from $\overline{WR}\downarrow$ to data output	t_{DWOD}	$V_{DD} = 5.0\text{ V} \pm 10\%$			$0.5T - 30$	ns
		$V_{DD} = 3.0\text{ V} \pm 10\%$			$0.5T - 30$	ns
		$V_{DD} = 2.0\text{ V} \pm 5\%$			$0.5T - 30$	ns
Delay time from $ASTB\downarrow$ to $\overline{WR}\downarrow$	t_{DSTW}	$V_{DD} = 5.0\text{ V} \pm 10\%$	$0.5T - 9$			ns
		$V_{DD} = 3.0\text{ V} \pm 10\%$	$0.5T - 9$			ns
		$V_{DD} = 2.0\text{ V} \pm 5\%$	$0.5T - 20$			ns
Data setup time (to $\overline{WR}\uparrow$)	t_{SODWR}	$V_{DD} = 5.0\text{ V} \pm 10\%$	$(1.5 + n) T - 20$			ns
		$V_{DD} = 3.0\text{ V} \pm 10\%$	$(1.5 + n) T - 25$			ns
		$V_{DD} = 2.0\text{ V} \pm 5\%$	$(1.5 + n) T - 70$			ns
Data hold time (from $\overline{WR}\uparrow$)	t_{HWOD}	$V_{DD} = 5.0\text{ V} \pm 10\%$	$0.5T - 14$			ns
		$V_{DD} = 3.0\text{ V} \pm 10\%$	$0.5T - 14$			ns
		$V_{DD} = 2.0\text{ V} \pm 5\%$	$0.5T - 50$			ns
Delay time from $\overline{WR}\uparrow$ to $ASTB\uparrow$	t_{DWST}	$V_{DD} = 5.0\text{ V} \pm 10\%$	$0.5T - 9$			ns
		$V_{DD} = 3.0\text{ V} \pm 10\%$	$0.5T - 9$			ns
		$V_{DD} = 2.0\text{ V} \pm 5\%$	$0.5T - 30$			ns
\overline{WR} low-level width	t_{WWL}	$V_{DD} = 5.0\text{ V} \pm 10\%$	$(1.5 + n) T - 25$			ns
		$V_{DD} = 3.0\text{ V} \pm 10\%$	$(1.5 + n) T - 30$			ns
		$V_{DD} = 2.0\text{ V} \pm 5\%$	$(1.5 + n) T - 30$			ns

Remark T: $t_{CYK} = 1/f_{XX}$ (f_{XX} : Main system clock frequency)

a: 1 (during address wait), otherwise, 0

n: Number of wait states ($n \geq 0$)

(1) Read/write operation (3/3)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Delay time from address to EXA \downarrow	t_{ADEXD}	$V_{\text{DD}} = 5.0 \text{ V} \pm 10\%$	0			ns
		$V_{\text{DD}} = 3.0 \text{ V} \pm 10\%$	0			ns
		$V_{\text{DD}} = 2.0 \text{ V} \pm 5\%$	0			ns
Delay time from EXA \downarrow to ASTB \downarrow	t_{EXTAH}	$V_{\text{DD}} = 5.0 \text{ V} \pm 10\%$	$0.5T - 20$			ns
		$V_{\text{DD}} = 3.0 \text{ V} \pm 10\%$	$0.5T - 30$			ns
		$V_{\text{DD}} = 2.0 \text{ V} \pm 5\%$	$0.5T - 40$			ns
Delay time from $\overline{\text{RD}}\uparrow$ to EXA \uparrow	t_{EXRDS}	$V_{\text{DD}} = 5.0 \text{ V} \pm 10\%$	0			ns
		$V_{\text{DD}} = 3.0 \text{ V} \pm 10\%$	0			ns
		$V_{\text{DD}} = 2.0 \text{ V} \pm 5\%$	0			ns
Delay time from $\overline{\text{WR}}\uparrow$ to EXA \uparrow	t_{EXWDS}	$V_{\text{DD}} = 5.0 \text{ V} \pm 10\%$	T			ns
		$V_{\text{DD}} = 3.0 \text{ V} \pm 10\%$	T			ns
		$V_{\text{DD}} = 2.0 \text{ V} \pm 5\%$	T			ns
Delay time from EXA \uparrow to ASTB \uparrow	t_{EXADR}	$V_{\text{DD}} = 5.0 \text{ V} \pm 10\%$	$0.5T$			ns
		$V_{\text{DD}} = 3.0 \text{ V} \pm 10\%$	$0.5T$			ns
		$V_{\text{DD}} = 2.0 \text{ V} \pm 5\%$	$0.5T$			ns

Remark T: $t_{\text{CYK}} = 1/f_{\text{xx}}$ (f_{xx} : Main system clock frequency)

(2) External wait timing (1/2)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Input time from address to $\overline{\text{WAIT}}\downarrow$	t_{DAWT}	$V_{\text{DD}} = 5.0 \text{ V} \pm 10\%$			$(2 + a) T - 40$	ns
		$V_{\text{DD}} = 3.0 \text{ V} \pm 10\%$			$(2 + a) T - 60$	ns
		$V_{\text{DD}} = 2.0 \text{ V} \pm 5\%$			$(2 + a) T - 300$	ns
Input time from $\text{ASTB}\downarrow$ to $\overline{\text{WAIT}}\downarrow$	t_{DSTWT}	$V_{\text{DD}} = 5.0 \text{ V} \pm 10\%$			$1.5T - 40$	ns
		$V_{\text{DD}} = 3.0 \text{ V} \pm 10\%$			$1.5T - 60$	ns
		$V_{\text{DD}} = 2.0 \text{ V} \pm 5\%$			$1.5T - 260$	ns
Hold time from $\text{ASTB}\downarrow$ to $\overline{\text{WAIT}}$	t_{HSTWT}	$V_{\text{DD}} = 5.0 \text{ V} \pm 10\%$	$(0.5 + n) T + 5$			ns
		$V_{\text{DD}} = 3.0 \text{ V} \pm 10\%$	$(0.5 + n) T + 10$			ns
		$V_{\text{DD}} = 2.0 \text{ V} \pm 5\%$	$(0.5 + n) T + 30$			ns
Delay time from $\text{ASTB}\downarrow$ to $\overline{\text{WAIT}}\uparrow$	t_{DSTWTH}	$V_{\text{DD}} = 5.0 \text{ V} \pm 10\%$			$(1.5 + n) T - 40$	ns
		$V_{\text{DD}} = 3.0 \text{ V} \pm 10\%$			$(1.5 + n) T - 60$	ns
		$V_{\text{DD}} = 2.0 \text{ V} \pm 5\%$			$(1.5 + n) T - 90$	ns
Input time from $\overline{\text{RD}}\downarrow$ to $\overline{\text{WAIT}}\downarrow$	t_{DRWL}	$V_{\text{DD}} = 5.0 \text{ V} \pm 10\%$			$T - 40$	ns
		$V_{\text{DD}} = 3.0 \text{ V} \pm 10\%$			$T - 60$	ns
		$V_{\text{DD}} = 2.0 \text{ V} \pm 5\%$			$T - 70$	ns
Hold time from $\overline{\text{RD}}\downarrow$ to $\overline{\text{WAIT}}$	t_{HRWT}	$V_{\text{DD}} = 5.0 \text{ V} \pm 10\%$	$nT + 5$			ns
		$V_{\text{DD}} = 3.0 \text{ V} \pm 10\%$	$nT + 10$			ns
		$V_{\text{DD}} = 2.0 \text{ V} \pm 5\%$	$nT + 30$			ns
Delay time from $\overline{\text{RD}}\downarrow$ to $\overline{\text{WAIT}}\uparrow$	t_{DRWTH}	$V_{\text{DD}} = 5.0 \text{ V} \pm 10\%$			$(1 + n) T - 40$	ns
		$V_{\text{DD}} = 3.0 \text{ V} \pm 10\%$			$(1 + n) T - 60$	ns
		$V_{\text{DD}} = 2.0 \text{ V} \pm 5\%$			$(1 + n) T - 90$	ns
Data input time from $\overline{\text{WAIT}}\uparrow$	t_{DWTID}	$V_{\text{DD}} = 5.0 \text{ V} \pm 10\%$			$0.5T - 5$	ns
		$V_{\text{DD}} = 3.0 \text{ V} \pm 10\%$			$0.5T - 10$	ns
		$V_{\text{DD}} = 2.0 \text{ V} \pm 5\%$			$0.5T - 30$	ns
Delay time from $\overline{\text{WAIT}}\uparrow$ to $\overline{\text{RD}}\uparrow$	t_{DWTR}	$V_{\text{DD}} = 5.0 \text{ V} \pm 10\%$	$0.5T$			ns
		$V_{\text{DD}} = 3.0 \text{ V} \pm 10\%$	$0.5T$			ns
		$V_{\text{DD}} = 2.0 \text{ V} \pm 5\%$	$0.5T + 5$			ns
Delay time from $\overline{\text{WAIT}}\uparrow$ to $\overline{\text{WR}}\uparrow$	t_{DWTW}	$V_{\text{DD}} = 5.0 \text{ V} \pm 10\%$	$0.5T$			ns
		$V_{\text{DD}} = 3.0 \text{ V} \pm 10\%$	$0.5T$			ns
		$V_{\text{DD}} = 2.0 \text{ V} \pm 5\%$	$0.5T + 5$			ns
Input time from $\overline{\text{WR}}\downarrow$ to $\overline{\text{WAIT}}\downarrow$	t_{DWWTL}	$V_{\text{DD}} = 5.0 \text{ V} \pm 10\%$			$T - 40$	ns
		$V_{\text{DD}} = 3.0 \text{ V} \pm 10\%$			$T - 60$	ns
		$V_{\text{DD}} = 2.0 \text{ V} \pm 5\%$			$T - 90$	ns

Remark T: $t_{\text{CYK}} = 1/f_{\text{XX}}$ (f_{XX} : Main system clock frequency)

a: 1 (during address wait), otherwise, 0

n: Number of wait states ($n \geq 0$)

(2) External wait timing (2/2)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Hold time from $\overline{WR}\downarrow$ to \overline{WAIT}	t_{HWT}	$V_{DD} = 5.0\text{ V} \pm 10\%$	$nT + 5$			ns
		$V_{DD} = 3.0\text{ V} \pm 10\%$	$nT + 10$			ns
		$V_{DD} = 2.0\text{ V} \pm 5\%$	$nT + 30$			ns
Delay time from $\overline{WR}\downarrow$ to $\overline{WAIT}\uparrow$	t_{DWWTH}	$V_{DD} = 5.0\text{ V} \pm 10\%$			$(1 + n)T - 40$	ns
		$V_{DD} = 3.0\text{ V} \pm 10\%$			$(1 + n)T - 60$	ns
		$V_{DD} = 2.0\text{ V} \pm 5\%$			$(1 + n)T - 90$	ns

Remark T: $t_{CYK} = 1/f_{XX}$ (f_{XX} : Main system clock frequency)

n: Number of wait states ($n \geq 0$)

(3) Serial operation ($T_A = -40$ to $+85^\circ\text{C}$, $V_{DD} = AV_{DD} = 1.9$ to 5.5 V, $V_{SS} = AV_{SS} = 0$ V) (1/2)
(a) 3-wire serial I/O mode ($\overline{\text{SCK}}$: Internal clock output)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
$\overline{\text{SCK}}$ cycle time	t_{KCY1}	$4.5 \text{ V} \leq V_{\text{DD}} \leq 5.5 \text{ V}$	640			ns
		$2.7 \text{ V} \leq V_{\text{DD}} < 4.5 \text{ V}$	1,280			ns
		$2.0 \text{ V} \leq V_{\text{DD}} < 2.7 \text{ V}$	2,560			ns
		$1.9 \text{ V} \leq V_{\text{DD}} < 2.0 \text{ V}$	4,000			ns
$\overline{\text{SCK}}$ high-/low-level width	t_{KH1} , t_{KL1}	$4.5 \text{ V} \leq V_{\text{DD}} \leq 5.5 \text{ V}$	270			ns
		$2.7 \text{ V} \leq V_{\text{DD}} < 4.5 \text{ V}$	590			ns
		$2.0 \text{ V} \leq V_{\text{DD}} < 2.7 \text{ V}$	1,180			ns
		$1.9 \text{ V} \leq V_{\text{DD}} < 2.0 \text{ V}$	1,900			ns
SI setup time (to $\overline{\text{SCK}}\uparrow$)	t_{SIK1}	$2.7 \text{ V} \leq V_{\text{DD}} \leq 5.5 \text{ V}$	10			ns
		$1.9 \text{ V} \leq V_{\text{DD}} < 2.7 \text{ V}$	30			ns
SI hold time (from $\overline{\text{SCK}}\uparrow$)	t_{HIK1}		40			ns
Delay time from $\overline{\text{SCK}}\downarrow$ to SO output	t_{DSO1}				30	ns
Hold time from $\overline{\text{SCK}}\uparrow$ to SO output	t_{HSO1}		$t_{\text{KCY1}}/2 - 50$			ns

(b) 3-wire serial I/O mode ($\overline{\text{SCK}}$: External clock input)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
$\overline{\text{SCK}}$ cycle time	t_{KCY2}	$4.5 \text{ V} \leq V_{\text{DD}} \leq 5.5 \text{ V}$	640			ns
		$2.7 \text{ V} \leq V_{\text{DD}} < 4.5 \text{ V}$	1,280			ns
		$2.0 \text{ V} \leq V_{\text{DD}} < 2.7 \text{ V}$	2,560			ns
		$1.9 \text{ V} \leq V_{\text{DD}} < 2.0 \text{ V}$	4,000			ns
$\overline{\text{SCK}}$ high-/low-level width	t_{KH2} , t_{KL2}	$4.5 \text{ V} \leq V_{\text{DD}} \leq 5.5 \text{ V}$	320			ns
		$2.7 \text{ V} \leq V_{\text{DD}} < 4.5 \text{ V}$	640			ns
		$2.0 \text{ V} \leq V_{\text{DD}} < 2.7 \text{ V}$	1,280			ns
		$1.9 \text{ V} \leq V_{\text{DD}} < 2.0 \text{ V}$	2,000			ns
SI setup time (to $\overline{\text{SCK}}\uparrow$)	t_{SIK2}	$2.7 \text{ V} \leq V_{\text{DD}} \leq 5.5 \text{ V}$	10			ns
		$1.9 \text{ V} \leq V_{\text{DD}} < 2.7 \text{ V}$	30			ns
SI hold time (from $\overline{\text{SCK}}\uparrow$)	t_{HIK2}		40			ns
Delay time from $\overline{\text{SCK}}\downarrow$ to SO output	t_{DSO2}				30	ns
Hold time from $\overline{\text{SCK}}\uparrow$ to SO output	t_{HSO2}		$t_{\text{KCY2}}/2 - 50$			ns

(c) UART mode

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
ASCK cycle time	t_{KCY3}	$4.5 \text{ V} \leq V_{\text{DD}} \leq 5.5 \text{ V}$	417			ns
		$2.7 \text{ V} \leq V_{\text{DD}} < 4.5 \text{ V}$	833			ns
		$1.9 \text{ V} \leq V_{\text{DD}} < 2.7 \text{ V}$	1,667			ns
ASCK high-/low-level width	t_{KH3} , t_{KL3}	$4.5 \text{ V} \leq V_{\text{DD}} \leq 5.5 \text{ V}$	208			ns
		$2.7 \text{ V} \leq V_{\text{DD}} < 4.5 \text{ V}$	416			ns
		$1.9 \text{ V} \leq V_{\text{DD}} < 2.7 \text{ V}$	833			ns

(3) Serial operation ($T_A = -40$ to $+85^\circ\text{C}$, $V_{DD} = AV_{DD} = 1.9$ to 5.5 V, $V_{SS} = AV_{SS} = 0$ V) (2/2)(d) I²C bus mode

Parameter	Symbol	Standard Mode		High-Speed Mode		Unit
		MIN.	MAX.	MIN.	MAX.	
SCL0 clock frequency	f_{CLK}	0	100	0	400	kHz
Bus free time (between stop and start conditions)	t_{BUF}	4.7	–	1.3	–	μs
Hold time ^{Note 1}	$t_{HD:STA}$	4.0	–	0.6	–	μs
Low-level width of SCL0 clock	t_{LOW}	4.7	–	1.3	–	μs
High-level width of SCL0 clock	t_{HIGH}	4.0	–	0.6	–	μs
Setup time of start/restart conditions	$t_{SU:STA}$	4.7	–	0.6	–	μs
Data hold time	When using CBUS-compatible master	$t_{HD:DAT}$	5.0	–	–	μs
	When using I ² C bus		0 ^{Note 2}	–	0 ^{Note 2}	0.9 ^{Note 3}
Data setup time	$t_{SU:DAT}$	250	–	100 ^{Note 4}	–	ns
Rising time of SDA0 and SCL0 signals	t_R	–	1,000	$20 + 0.1C_b$ ^{Note 5}	300	ns
Falling time of SDA0 and SCL0 signals	t_F	–	300	$20 + 0.1C_b$ ^{Note 5}	300	ns
Setup time of stop condition	$t_{SU:STO}$	4.0	–	0.6	–	μs
Pulse width of spike restricted by input filter	t_{SP}	–	–	0	50	ns
Load capacitance of each bus line	C_b	–	400	–	400	pF

- Notes**
- For the start condition, the first clock pulse is generated after the hold time.
 - To fill the undefined area of the SCL0 falling edge, it is necessary for the device to provide an internal SDA0 signal (on $V_{IHmin.}$) with at least 300 ns of hold time.
 - If the device does not extend the SCL0 signal low-level hold time (t_{LOW}), only the maximum data hold time $t_{HD:DAT}$ needs to be satisfied.
 - The high-speed mode I²C bus can be used in a standard mode I²C bus system. In this case, the conditions described below must be satisfied.
 - If the device does not extend the SCL0 signal low-level hold time
 $t_{SU:DAT} \geq 250$ ns
 - If the device extends the SCL0 signal low-level hold time
Be sure to transmit the data bit to the SDA0 line before the SCL0 line is released
($t_{Rmax.} + t_{SU:DAT} = 1,000 + 250 = 1,250$ ns by standard mode I²C bus specification)
 - C_b : Total capacitance per bus line (unit: pF)

(4) Clock output operation ($T_A = -40$ to $+85^\circ\text{C}$, $V_{DD} = AV_{DD} = 1.9$ to 5.5 V, $V_{SS} = AV_{SS} = 0$ V)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
PCL cycle time	t_{CYCL}	$4.5\text{ V} \leq V_{DD} \leq 5.5\text{ V}$, nT	80		31,250	ns
PCL high-/low-level width	t_{CLL} , t_{CLH}	$4.5\text{ V} \leq V_{DD} \leq 5.5\text{ V}$, $0.5T - 10$	30		15,615	ns
PCL rise/fall time	t_{CLR} , t_{CLF}	$4.5\text{ V} \leq V_{DD} \leq 5.5\text{ V}$			5	ns
		$2.7\text{ V} \leq V_{DD} < 4.5\text{ V}$			10	ns
		$1.9\text{ V} \leq V_{DD} < 2.7\text{ V}$			20	ns

Remark T: $t_{CYK} = 1/f_{XX}$ (f_{XX} : Main system clock frequency)

n: Divided frequency ratio set by software in the CPU

- When using the main system clock: $n = 1, 2, 4, 8, 16, 32, 64, 128$
- When using the subsystem clock: $n = 1$

(5) Other operations ($T_A = -40$ to $+85^\circ\text{C}$, $V_{DD} = AV_{DD} = 1.9$ to 5.5 V, $V_{SS} = AV_{SS} = 0$ V)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
NMI high-/low-level width	t_{WNIL} , t_{WNIH}		10			μs
INTP input high-/low-level width	t_{WITL} , t_{WITR}	INTP0 to INTP6	100			ns
$\overline{\text{RESET}}$ high-/low-level width	t_{WRSL} , t_{WRSH}		10			μs

A/D Converter Characteristics ($T_A = -40$ to $+85^\circ\text{C}$, $V_{DD} = AV_{DD} = 1.9$ to 5.5 V, $V_{SS} = AV_{SS} = 0$ V)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Resolution			8	8	8	bit
Overall error ^{Notes 1, 2}		$2.7\text{ V} \leq V_{DD} \leq 5.5\text{ V}$, $2.2\text{ V} \leq AV_{REF0} \leq V_{DD}$, $AV_{DD} = V_{DD}$			± 1.2	%FSR
		$1.9\text{ V} \leq V_{DD} < 2.7\text{ V}$, $1.9\text{ V} \leq AV_{REF0} \leq V_{DD}$, $AV_{DD} = V_{DD}$			± 1.6	%FSR
Conversion time	t_{CONV}		14		144	μs
Sampling time	t_{SAMP}		$24/f_{xx}$			μs
Analog input voltage	V_{IAN}		AV_{SS}		AV_{REF0}	V
Reference voltage	AV_{REF0}		1.9		AV_{DD}	V
Resistance between AV_{REF0} and AV_{SS}	R_{AVREF0}	When not A/D converting		40		$\text{k}\Omega$

Notes 1. Quantization error ($\pm 1/2$ LSB) is not included.

2. Overall error is indicated as a ratio to the full-scale value (%FSR).

Remark f_{xx} : Main system clock frequency

D/A Converter Characteristics ($T_A = -40$ to $+85^\circ\text{C}$, $V_{DD} = AV_{DD} = 1.9$ to 5.5 V, $V_{SS} = AV_{SS} = 0$ V)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit	
Resolution			8	8	8	bit	
Overall error ^{Notes 1, 2}		$R = 10\text{ M}\Omega$, $2.0\text{ V} \leq AV_{REF1} \leq V_{DD}$, $2.0\text{ V} \leq V_{DD} \leq 5.5\text{ V}$, $AV_{DD} = V_{DD}$			± 0.6	%FSR	
		$R = 10\text{ M}\Omega$, $1.9\text{ V} \leq AV_{REF1} \leq V_{DD}$, $1.9\text{ V} \leq V_{DD} \leq 2.0\text{ V}$, $AV_{DD} = V_{DD}$			± 1.2	%FSR	
Settling time		Load conditions: $C = 30\text{ pF}$	$4.5\text{ V} \leq AV_{REF1} \leq 5.5\text{ V}$			10	μs
			$2.7\text{ V} \leq AV_{REF1} < 4.5\text{ V}$			15	μs
			$1.9\text{ V} \leq AV_{REF1} < 2.7\text{ V}$			20	μs
Output resistance	R_O	DACS0, 1 = 55H		8		$\text{k}\Omega$	
Reference voltage	AV_{REF1}		1.9		V_{DD}	V	
AV_{REF1} current	AI_{REF1}	For only 1 channel			2.5	mA	

Notes 1. Quantization error ($\pm 1/2$ LSB) is not included.

2. Overall error is indicated as a ratio to the full-scale value (%FSR).

Flash Memory Programming Characteristics

($T_A = 10$ to 40°C , $V_{DD} = AV_{DD} = 1.9$ to 5.5 V, $V_{SS} = AV_{SS} = 0$ V, $V_{PP} = 9.7$ to 10.3 V)

(1) Basic characteristics

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Operating frequency	f_{XX}	$4.5\text{ V} \leq V_{DD} \leq 5.5\text{ V}$	2		12.5	MHz
		$2.7\text{ V} \leq V_{DD} < 4.5\text{ V}$	2		6.25	MHz
		$2.0\text{ V} \leq V_{DD} < 2.7\text{ V}$	2		3.125	MHz
		$1.9\text{ V} \leq V_{DD} < 2.0\text{ V}$	2	2	2	MHz
Oscillation frequency ^{Note 1}	f_X	$4.5\text{ V} \leq V_{DD} \leq 5.5\text{ V}$	4		25	MHz
		$2.7\text{ V} \leq V_{DD} < 4.5\text{ V}$	4		12.5	MHz
		$2.0\text{ V} \leq V_{DD} < 2.7\text{ V}$	4		6.25	MHz
		$1.9\text{ V} \leq V_{DD} < 2.0\text{ V}$	4	4	4	MHz
Supply voltage ^{Note 2}	V_{DD}		1.9		5.5	V
	V_{PPL}	When detecting V_{PP} low level	0		$0.2V_{DD}$	V
	V_{PP}	When detecting V_{PP} high level	$0.9V_{DD}$		$1.1V_{DD}$	V
	V_{PPH}	When detecting V_{PP} high voltage	9.7	10	10.3	V
Write time	C_{WRT}		²⁰ Note 3			times
Operating temperature ^{Note 4}	T_A		-40		85	$^\circ\text{C}$
Storage temperature ^{Note 5}	T_{stg}		-65		125	$^\circ\text{C}$
Programming temperature	T_{PRG}		10		40	$^\circ\text{C}$

Notes 1. When rewriting without using handshake mode

2. μ PD78F4216A, 78F4216AY rank K: $2.7\text{ V} \leq V_{DD} \leq 5.5\text{ V}$, $V_{PP} = 10.3 \pm 0.3\text{ V}$
 rank E: $2.7\text{ V} \leq V_{DD} \leq 5.5\text{ V}$, $V_{PP} = 10.0 \pm 0.3\text{ V}$

3. Operation cannot be guaranteed when the number of rewrites exceeds 20.

In the case of K rank of the μ PD78F4216A and 78F4216AY, operation cannot be guaranteed when the number of rewrites exceeds 5.

4. μ PD78F4216A, 78F4216AY rank K: $T_A = -10$ to $+60^\circ\text{C}$
 5. μ PD78F4216A, 78F4216AY rank K: $T_A = -10$ to $+80^\circ\text{C}$

Cautions 1. If writing is not successful in the initial write operation, execute the program command again, and then execute the verify command to confirm that the write operation has been completed normally (K, E, and P ranks of the μ PD78F4216A and 78F4216AY).

2. Handshake mode is supported by products as shown below.

- μ PD78F4216A, 78F4216AY: Products with other than rank K, E
- μ PD78F4218A, 78F4218AY: Products with any rank

Remarks 1. The fifth letter from the left in the lot number indicates the standard of the product.

2. After executing the program command, execute the verify command to confirm that the write operation has been completed normally.

3. Handshake mode is the CSI write mode that uses P24. Handshake mode can be used with the PG-FR3 and FL-PR3.

4. Rank I only applies to ES (engineering sample) products. Because these products are engineering samples, their operation cannot be guaranteed.

(2) Write erase characteristics

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
V _{PP} supply voltage	V _{PP2}	During flash memory programming	9.7	10.0	10.3	V
V _{DD} supply current	I _{DD}	When V _{PP} = V _{PP2} , f _{XX} = 12.5 MHz			40	mA
V _{PP} supply current	I _{PP}	When V _{PP} = V _{PP2}			100	mA
Step erase time	T _{er}	Note 1		0.2		s
Overall erase time per area	T _{era}	When step erase time = 0.2 s Note 2			20	s/area
Write-back time	T _{wb}	Note 3		50		ms
Number of write-backs per write-back command	C _{wb}	When write-back time = 50 ms Note 4			60	times/ write-back command
Number of erase/write-backs	C _{erwb}				16	times
Step write time	T _{wr}	Note 5		50		μ s
Overall write time per word	T _{wrw}	When step write time = 50 μ s (1 word = 1 byte) Note 6	50		500	μ s/ word
Number of rewrites per area	C _{erwr}	1 erase + 1 write after erase = 1 rewrite Note 7		20		times/ area

- Notes**
1. The recommended setting value for the step erase time is 0.2 s.
 2. The prewrite time before erasure and the erase verify time (write-back time) is not included.
 3. The recommended setting value for the write-back time is 50 ms.
 4. Write-back is executed once by the issuance of the write-back command. Therefore, the retry times must be the maximum value minus the number of commands issued.
 5. The recommended step write time setting value is 50 μ s.
 6. The actual write time per word is 100 μ s longer. The internal verify time during or after a write is not included.
 7. When a product is first written after shipment, "erase \rightarrow write" and "write only" are both taken as one rewrite.

Example: P: Write, E: Erase

Shipped product \rightarrow P \rightarrow E \rightarrow P \rightarrow E \rightarrow P: 3 rewrites

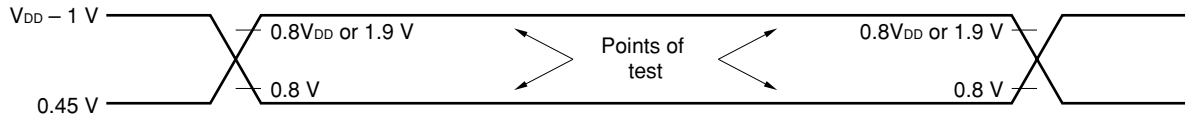
Shipped product \rightarrow E \rightarrow P \rightarrow E \rightarrow P \rightarrow E \rightarrow P: 3 rewrites

- Remarks**
1. The range of the operating clock during flash memory programming is the same as the range during normal operation.
 2. When using the PG-FP3, the time parameters that need to be downloaded from the parameter files for write/erase are automatically set. Unless otherwise directed, do not change the set values.

Data Retention Characteristics ($T_A = -40$ to $+85^\circ\text{C}$, $V_{DD} = AV_{DD} = 1.9$ to 5.5 V, $V_{SS} = AV_{SS} = 0$ V)

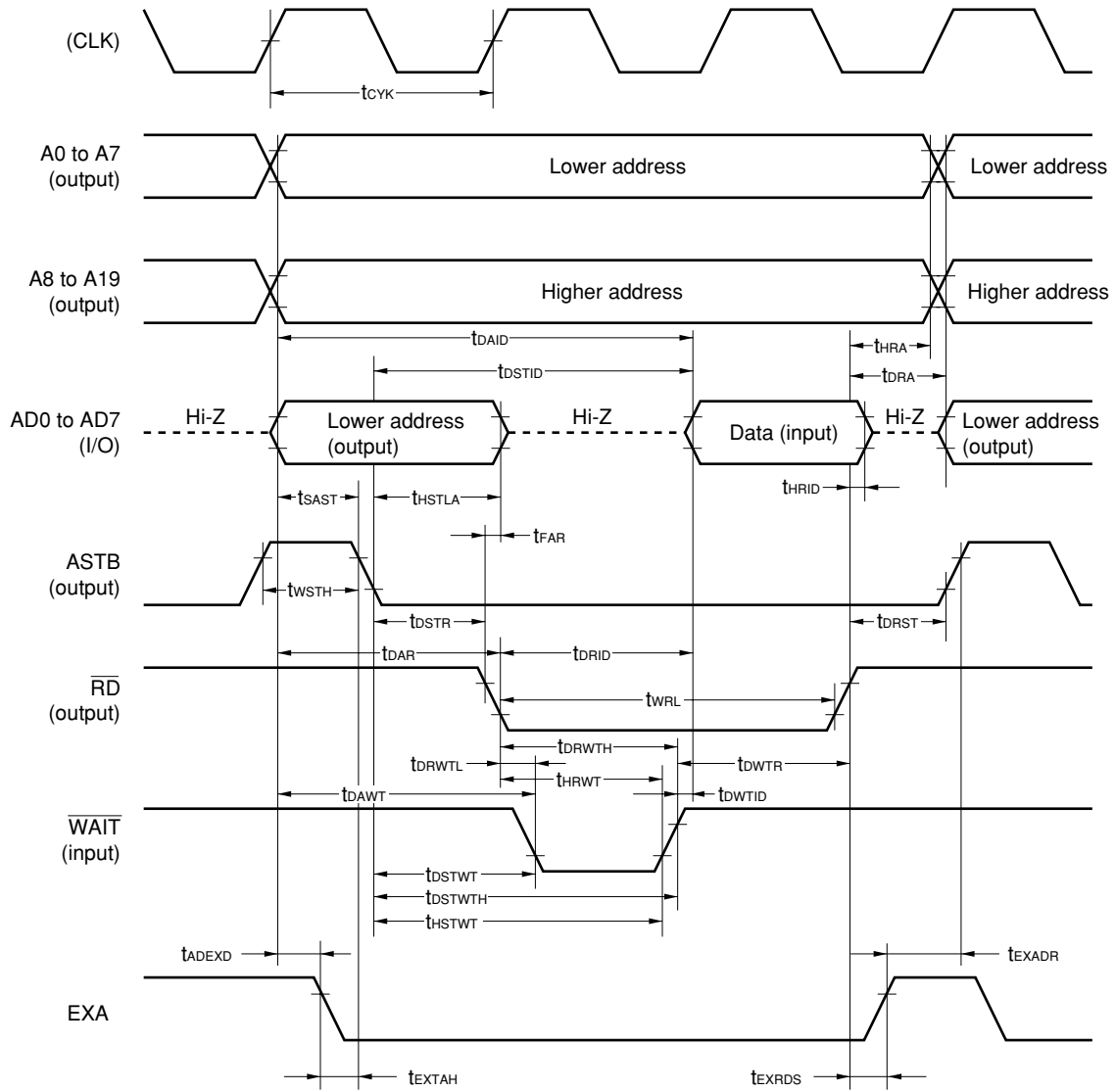
Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Data retention voltage	V_{DDDR}	STOP mode	1.9		5.5	V
Data retention current	I_{DDDR}	$V_{DDDR} = 5.0$ V $\pm 10\%$		10	50	μA
		$V_{DDDR} = 2.0$ V $\pm 5\%$		2	10	μA
V_{DD} rise time	t_{RVD}		200			μs
V_{DD} fall time	t_{FVD}		200			μs
V_{DD} hold time (from STOP mode setting)	t_{HVD}		0			ms
STOP release signal input time	t_{DREL}		0			ms
Oscillation stabilization wait time	t_{WAIT}	Crystal resonator	30			ms
		Ceramic resonator	5			ms
Low-level input voltage	V_{IL}	$\overline{\text{RESET}}$, P00/INTP0 to P06/INTP6	0		$0.1V_{DDDR}$	V
High-level input voltage	V_{IH}		$0.9V_{DDDR}$		V_{DDDR}	V

AC Timing Test Points



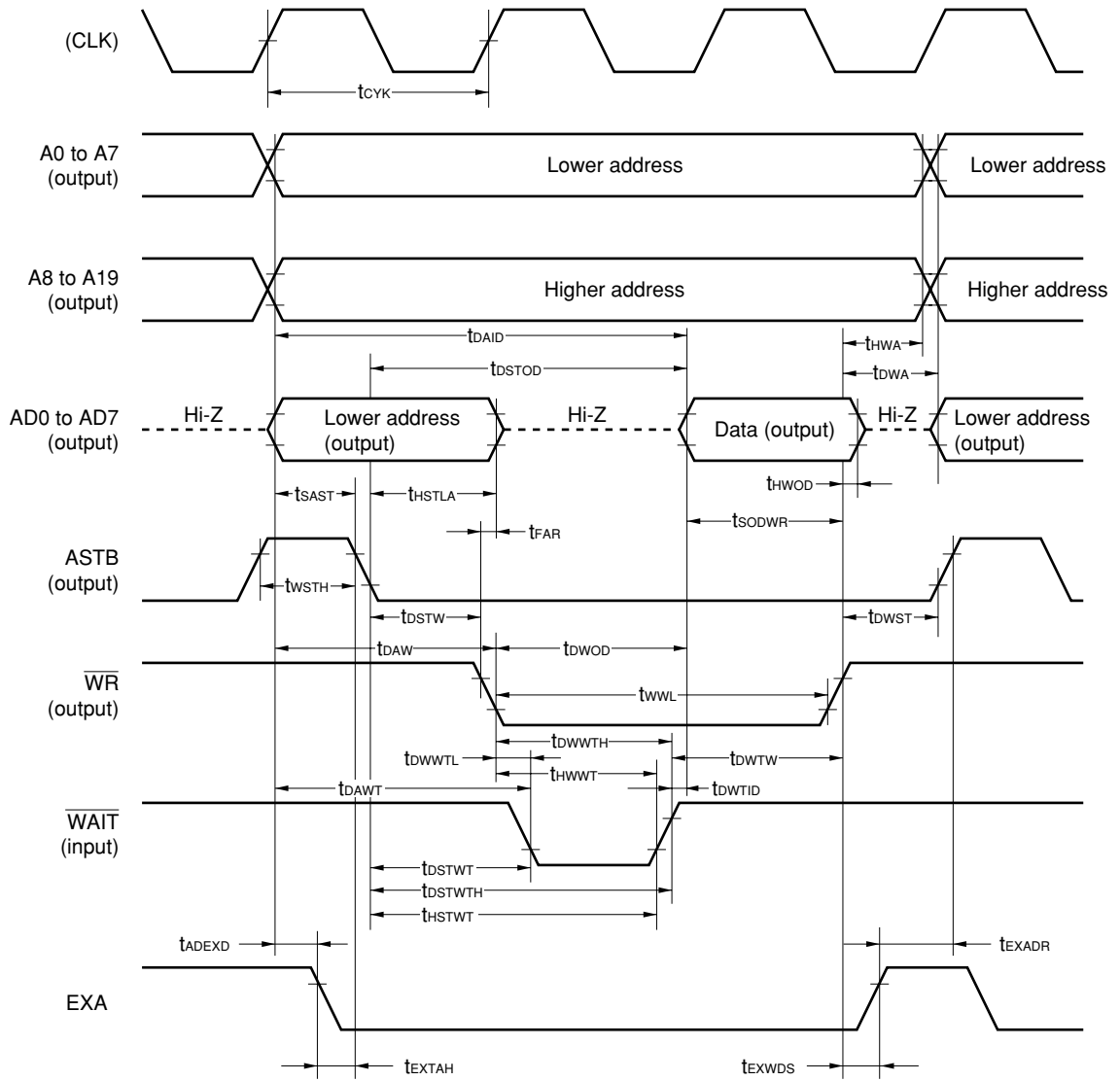
Timing Waveforms

(1) Read operations



Remark The signal is output from pins A0 to A7 when P80 to P87 are unused.

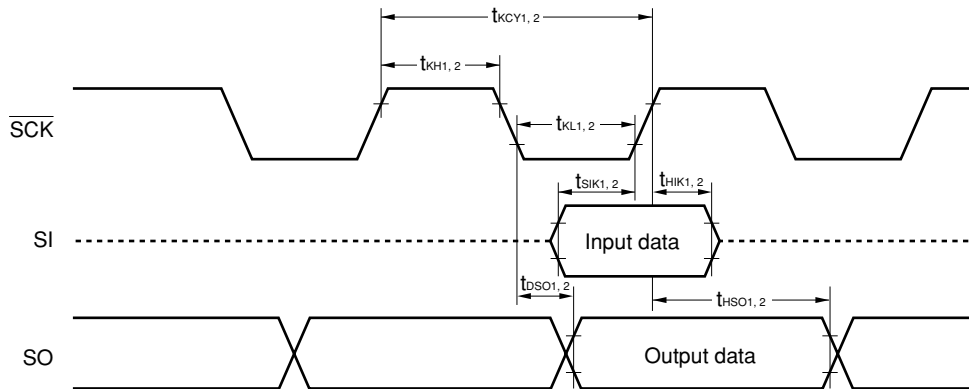
(2) Write operation



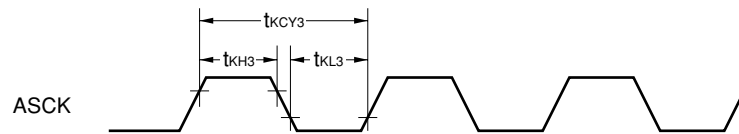
Remark The signal is output from pins A0 to A7 when P80 to P87 are unused.

Serial Operation

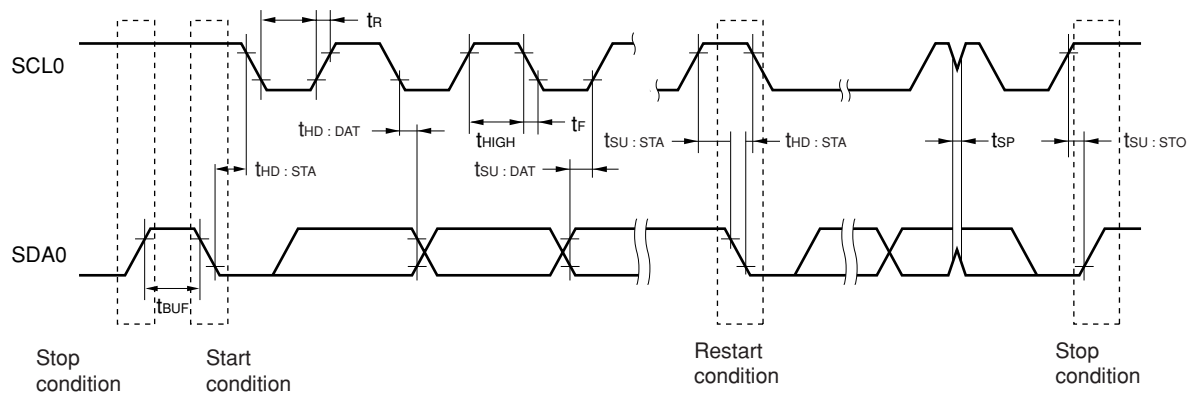
(1) 3-wire serial I/O mode



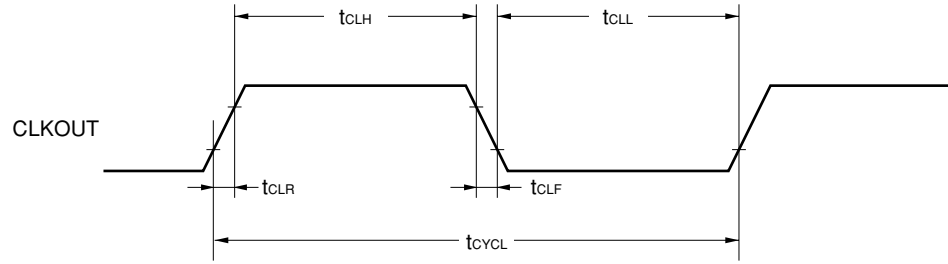
(2) UART mode



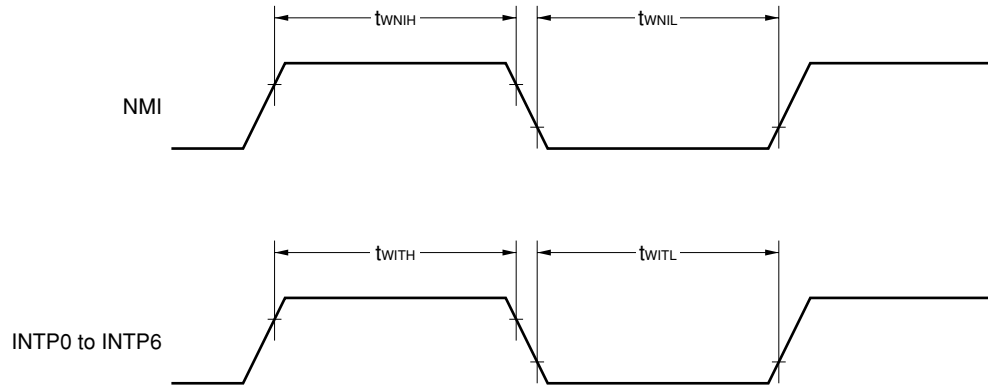
(3) I²C bus mode (μ PD78F4216AY, 78F4218AY Subseries only)



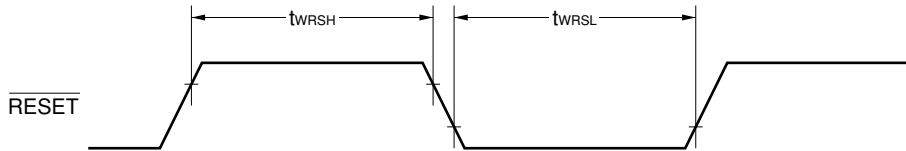
Clock Output Timing



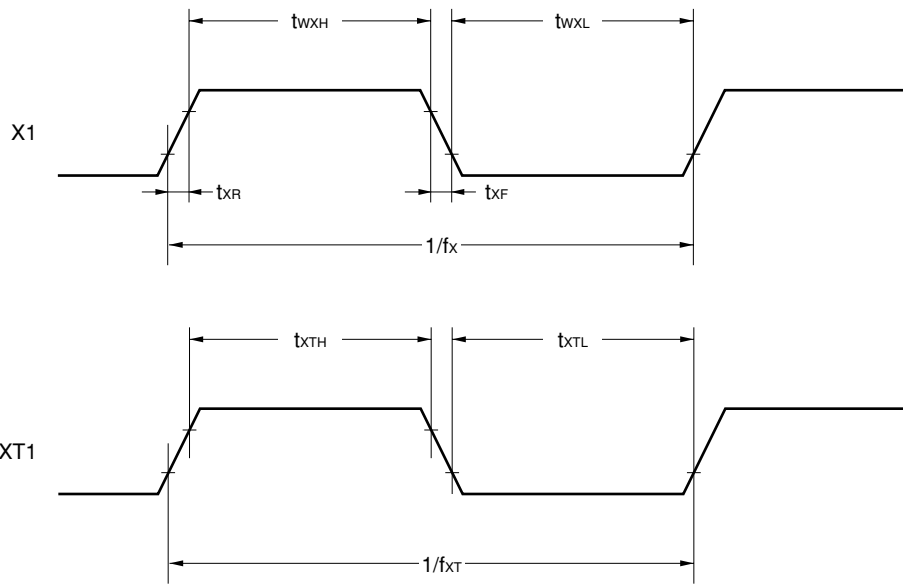
Interrupt Input Timing



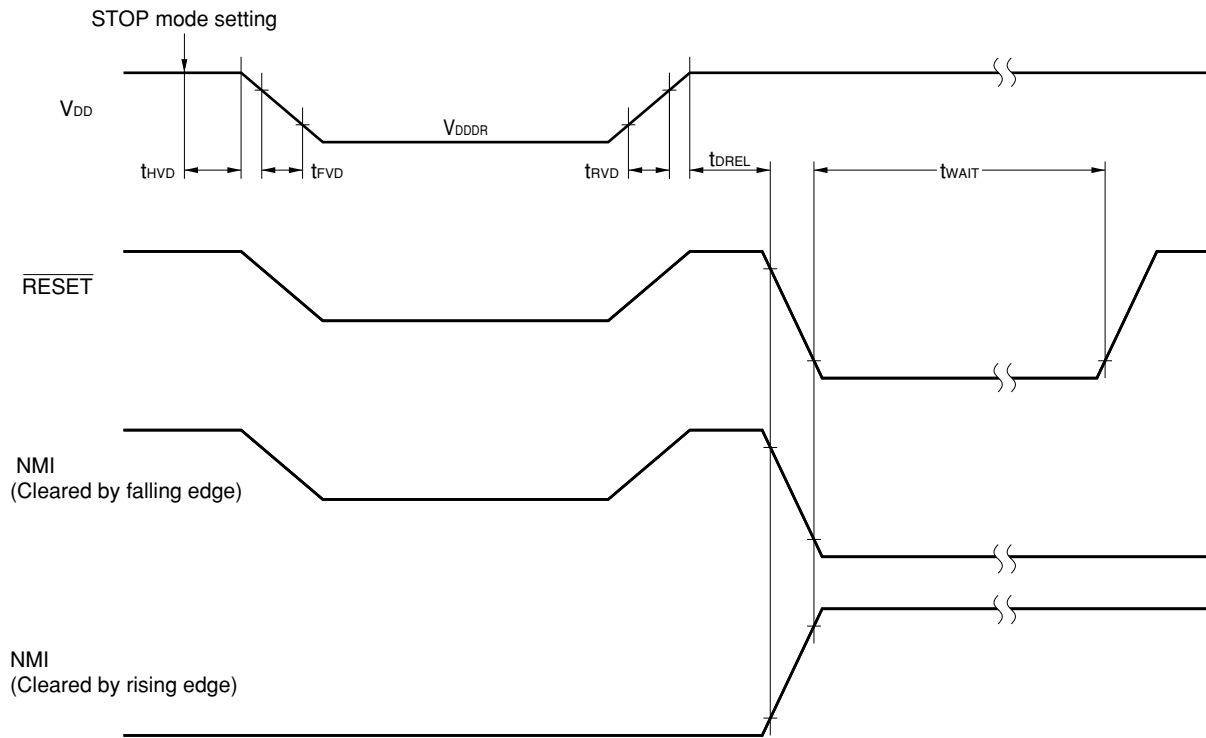
Reset Input Timing



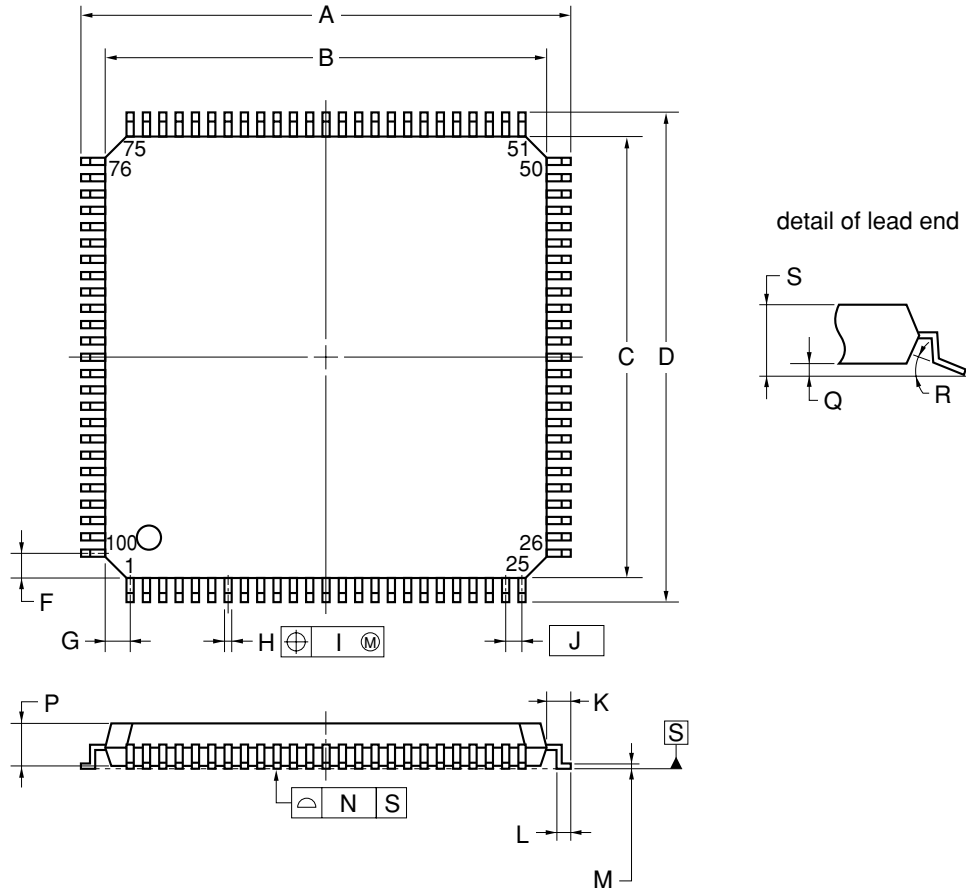
Clock Timing



Data Retention Characteristics



100-PIN PLASTIC LQFP (FINE PITCH) (14x14)

**NOTE**

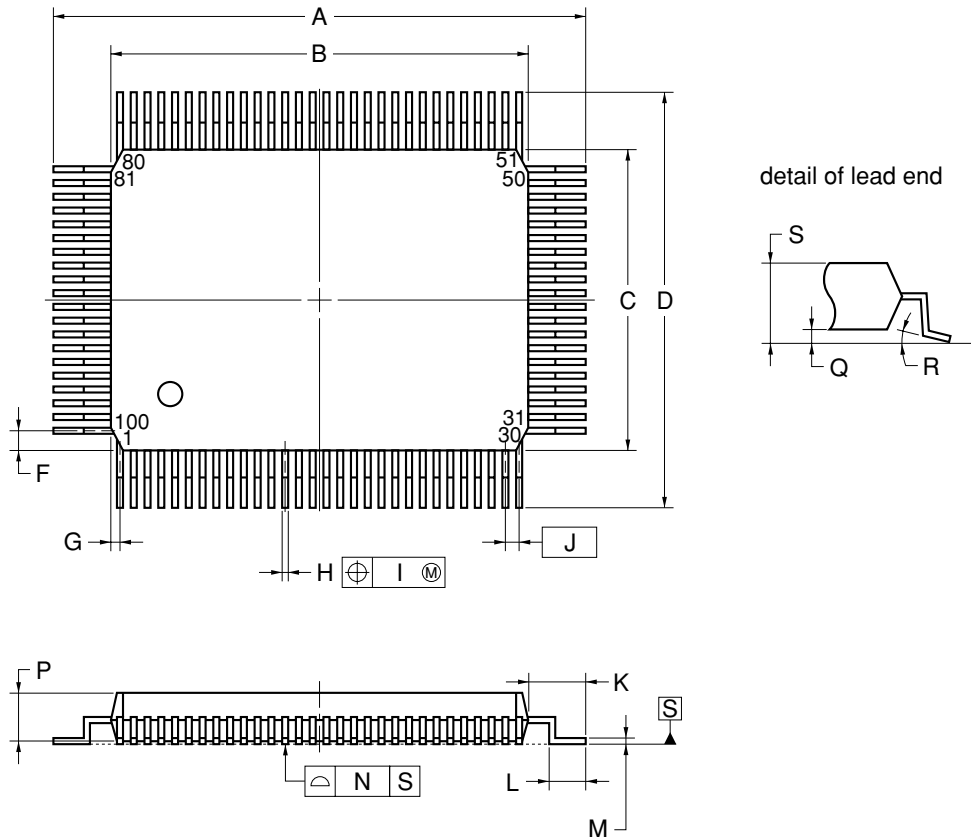
Each lead centerline is located within 0.08 mm of its true position (T.P.) at maximum material condition.

ITEM	MILLIMETERS
A	16.00±0.20
B	14.00±0.20
C	14.00±0.20
D	16.00±0.20
F	1.00
G	1.00
H	0.22 ^{+0.05} _{-0.04}
I	0.08
J	0.50 (T.P.)
K	1.00±0.20
L	0.50±0.20
M	0.17 ^{+0.03} _{-0.07}
N	0.08
P	1.40±0.05
Q	0.10±0.05
R	3 ^{+7°} _{-3°}
S	1.60 MAX.

S100GC-50-8EU, 8EA-2

Remark The external dimensions and material of the ES version are the same as those of the mass-produced version.

100-PIN PLASTIC QFP (14x20)



NOTE

Each lead centerline is located within 0.15 mm of its true position (T.P.) at maximum material condition.

ITEM	MILLIMETERS
A	23.6±0.4
B	20.0±0.2
C	14.0±0.2
D	17.6±0.4
F	0.8
G	0.6
H	0.30±0.10
I	0.15
J	0.65 (T.P.)
K	1.8±0.2
L	0.8±0.2
M	0.15 ^{+0.10} _{-0.05}
N	0.10
P	2.7±0.1
Q	0.1±0.1
R	5°±5°
S	3.0 MAX.

P100GF-65-3BA1-4

Remark The external dimensions and material of the ES version are the same as those of the mass-produced version.

The μ PD784218A Subseries products should be soldered and mounted under the following recommended conditions.

For soldering methods and conditions other than those recommended below, contact an NEC Electronics sales representative. For technical information, see the following website.

Semiconductor Device Mount Manual (<http://www.necel.com/pkg/en/mount/index.html>)

Table 33-1. Surface Mounting Type Soldering Conditions (1/5)

- (1) μ PD784214AGC-xxx-8EU: 100-pin plastic LQFP (fine pitch) (14 x 14)
 μ PD784215AGC-xxx-8EU: 100-pin plastic LQFP (fine pitch) (14 x 14)
 μ PD784216AGC-xxx-8EU: 100-pin plastic LQFP (fine pitch) (14 x 14)
 μ PD784214AYGC-xxx-8EU: 100-pin plastic LQFP (fine pitch) (14 x 14)
 μ PD784215AYGC-xxx-8EU: 100-pin plastic LQFP (fine pitch) (14 x 14)
 μ PD784216AYGC-xxx-8EU: 100-pin plastic LQFP (fine pitch) (14 x 14)

Soldering Method	Soldering Conditions	Recommended Condition Symbol
Infrared reflow	Package peak temperature: 235°C, Time: 30 seconds max. (at 210°C or higher), Count: Two times or less	IR35-00-2
VPS	Package peak temperature: 215°C, Time: 40 seconds max. (at 200°C or higher), Count: Two times or less	VP15-00-2
Partial heating	Pin temperature: 350°C max., Time: 3 seconds max. (per pin row)	—

Caution Do not use different soldering methods together (except for partial heating).

- (2) μ PD784217AGC-xxx-8EU: 100-pin plastic LQFP (fine pitch) (14 x 14)
 μ PD784218AGC-xxx-8EU: 100-pin plastic LQFP (fine pitch) (14 x 14)
 μ PD784217AYGC-xxx-8EU: 100-pin plastic LQFP (fine pitch) (14 x 14)
 μ PD784218AYGC-xxx-8EU: 100-pin plastic LQFP (fine pitch) (14 x 14)
 μ PD78F4216AGC-8EU: 100-pin plastic LQFP (fine pitch) (14 x 14)
 μ PD78F4218AGC-8EU: 100-pin plastic LQFP (fine pitch) (14 x 14)
 μ PD78F4216AYGC-8EU: 100-pin plastic LQFP (fine pitch) (14 x 14)
 μ PD78F4218AYGC-8EU: 100-pin plastic LQFP (fine pitch) (14 x 14)

Soldering Method	Soldering Conditions	Recommended Condition Symbol
Infrared reflow	Package peak temperature: 235°C, Time: 30 seconds max. (at 210°C or higher), Count: Two times or less, Exposure limit: 7 days ^{Note} (after that, prebake at 125°C for 10 hours)	IR35-107-2
VPS	Package peak temperature: 215°C, Time: 40 seconds max. (at 200°C or higher), Count: Two times or less, Exposure limit: 7 days ^{Note} (after that, prebake at 125°C for 10 hours)	VP15-107-2
Partial heating	Pin temperature: 350°C max., Time: 3 seconds max. (per pin row)	—

Note After opening the dry pack, store it at 25°C or less and 65%RH or less for the allowable storage period.

Caution Do not use different soldering methods together (except for partial heating).

Table 33-1. Surface Mounting Type Soldering Conditions (2/5)

- (3) μ PD784214AGF-xxx-3BA: 100-pin plastic QFP (14 x 20)
- μ PD784215AGF-xxx-3BA: 100-pin plastic QFP (14 x 20)
- μ PD784216AGF-xxx-3BA: 100-pin plastic QFP (14 x 20)
- μ PD784217AGF-xxx-3BA: 100-pin plastic QFP (14 x 20)
- μ PD784218AGF-xxx-3BA: 100-pin plastic QFP (14 x 20)
- μ PD784214AYGF-xxx-3BA: 100-pin plastic QFP (14 x 20)
- μ PD784215AYGF-xxx-3BA: 100-pin plastic QFP (14 x 20)
- μ PD784216AYGF-xxx-3BA: 100-pin plastic QFP (14 x 20)
- μ PD784217AYGF-xxx-3BA: 100-pin plastic QFP (14 x 20)
- μ PD784218AYGF-xxx-3BA: 100-pin plastic QFP (14 x 20)
- μ PD78F4216AGF-3BA: 100-pin plastic QFP (14 x 20)
- μ PD78F4216AYGF-3BA: 100-pin plastic QFP (14 x 20)

Soldering Method	Soldering Conditions	Recommended Condition Symbol
Infrared reflow	Package peak temperature: 235°C, Time: 30 seconds max. (at 210°C or higher), Count: Two times or less	IR35-00-2
VPS	Package peak temperature: 215°C, Time: 40 seconds max. (at 200°C or higher), Count: Two times or less	VP15-00-2
Wave soldering	Solder bath temperature: 260°C max., Time: 10 seconds max., Count: Once, Preheating temperature: 120°C max. (package surface temperature)	WS60-00-1
Partial heating	Pin temperature: 350°C max., Time: 3 seconds max. (per pin row)	–

Caution Do not use different soldering methods together (except for partial heating).

- (4) μ PD78F4218AGF-3BA: 100-pin plastic QFP (14 x 20)
- μ PD78F4218AYGF-3BA: 100-pin plastic QFP (14 x 20)

Soldering Method	Soldering Conditions	Recommended Condition Symbol
Infrared reflow	Package peak temperature: 235°C, Time: 30 seconds max. (at 210°C or higher), Count: Two times or less, Expose limit: 7 days ^{Note} (after that, prebake at 125°C for 20 hours)	IR35-207-2
VPS	Package peak temperature: 215°C, Time: 40 seconds max. (at 200°C or higher), Count: Two times or less, Expose limit: 7 days ^{Note} (after that, prebake at 125°C for 20 hours)	VP15-207-2
Wave soldering	Solder bath temperature: 260°C max., Time: 10 seconds max., Count: Once, Preheating temperature: 120°C max. (package surface temperature), Expose limit: 7 days ^{Note} (after that, prebake at 125°C for 20 hours)	WS60-207-1
Partial heating	Pin temperature: 350°C max., Time: 3 seconds max. (per pin row)	–

Note After opening the dry pack, store it at 25°C or less and 65%RH or less for the allowable storage period.

Caution Do not use different soldering methods together (except for partial heating).

Remark The label on the dry pack was correct originally.

Table 33-1. Surface Mounting Type Soldering Conditions (3/5)

(5) μ PD784214AYGC-xxx-8EU: 100-pin plastic LQFP (fine pitch) (14 x 14)

Soldering Method	Soldering Conditions	Recommended Condition Symbol
Infrared reflow	Package peak temperature: 260°C, Time: 60 seconds max. (at 220°C or higher), Count: Three times or less, Exposure limit: 3 days ^{Note} (after that, prebake at 125°C for 20 to 72 hours)	IR60-203-3
Wave soldering	When the pin pitch of the package is 0.65 mm or more, wave soldering can also be performed. For details, contact an NEC Electronics sales representative.	–
Partial heating	Pin temperature: 350°C max., Time: 3 seconds max. (per pin row)	–

Note After opening the dry pack, store it at 25°C or less and 65%RH or less for the allowable storage period.

Caution Do not use different soldering methods together (except for partial heating).

- Remarks**
1. Products that have the part numbers suffixed by “-A” are lead-free products.
 2. For soldering methods and conditions other than those recommended above, contact an NEC Electronics sales representative.

Table 33-1. Surface Mounting Type Soldering Conditions (4/5)

- (6) μ PD784215AGF-xxx-3BA-A: 100-pin plastic QFP (14 × 20)
 μ PD784214AGC-xxx-8EU-A: 100-pin plastic LQFP (fine pitch) (14 × 14)
 μ PD784215AGC-xxx-8EU-A: 100-pin plastic LQFP (fine pitch) (14 × 14)
 μ PD784216AGC-xxx-8EU-A: 100-pin plastic LQFP (fine pitch) (14 × 14)
 μ PD784217AGC-xxx-8EU-A: 100-pin plastic LQFP (fine pitch) (14 × 14)
 μ PD784218AGC-xxx-8EU-A: 100-pin plastic LQFP (fine pitch) (14 × 14)
 μ PD78F4216AGC-8EU-A: 100-pin plastic LQFP (fine pitch) (14 × 14)
 μ PD78F4218AGC-8EU-A: 100-pin plastic LQFP (fine pitch) (14 × 14)
 μ PD784214AYGF-xxx-3BA-A: 100-pin plastic QFP (14 × 20)
 μ PD784215AYGF-xxx-3BA-A: 100-pin plastic QFP (14 × 20)
 μ PD784216AYGF-xxx-3BA-A: 100-pin plastic QFP (14 × 20)
 μ PD784215AYGC-xxx-8EU-A: 100-pin plastic LQFP (fine pitch) (14 × 14)
 μ PD784217AYGC-xxx-8EU-A: 100-pin plastic LQFP (fine pitch) (14 × 14)
 μ PD784218AYGC-xxx-8EU-A: 100-pin plastic LQFP (fine pitch) (14 × 14)
 μ PD78F4216AYGC-8EU-A: 100-pin plastic LQFP (fine pitch) (14 × 14)
 μ PD78F4218AYGC-8EU-A: 100-pin plastic LQFP (fine pitch) (14 × 14)

Soldering Method	Soldering Conditions	Recommended Condition Symbol
Infrared reflow	Package peak temperature: 260°C, Time: 60 seconds max. (at 220°C or higher), Count: Three times or less, Exposure limit: 7 days ^{Note} (after that, prebake at 125°C for 20 to 72 hours)	IR60-207-3
Wave soldering	When the pin pitch of the package is 0.65 mm or more, wave soldering can also be performed. For details, contact an NEC Electronics sales representative.	–
Partial heating	Pin temperature: 350°C max., Time: 3 seconds max. (per pin row)	–

Note After opening the dry pack, store it at 25°C or less and 65%RH or less for the allowable storage period.

Caution Do not use different soldering methods together (except for partial heating).

Remark Products that have the part numbers suffixed by “-A” are lead-free products.

Table 33-1. Surface Mounting Type Soldering Conditions (5/5)

- (7) μ PD784216AGF-xxx-3BA-A: 100-pin plastic QFP (14 × 20)
 μ PD784217AGF-xxx-3BA-A: 100-pin plastic QFP (14 × 20)
 μ PD784218AGF-xxx-3BA-A: 100-pin plastic QFP (14 × 20)
 μ PD78F4216AGF-3BA-A: 100-pin plastic QFP (14 × 20)
 μ PD78F4218AGF-3BA-A: 100-pin plastic QFP (14 × 20)
 μ PD784217AYGF-xxx-3BA-A: 100-pin plastic QFP (14 × 20)
 μ PD784218AYGF-xxx-3BA-A: 100-pin plastic QFP (14 × 20)
 μ PD78F4216AYGF-3BA-A: 100-pin plastic QFP (14 × 20)
 μ PD78F4218AYGF-3BA-A: 100-pin plastic QFP (14 × 20)
 μ PD784214AYGC-xxx-8EU-A: 100-pin plastic LQFP (fine pitch) (14 × 14)
 μ PD784216AYGC-xxx-8EU-A: 100-pin plastic LQFP (fine pitch) (14 × 14)

Soldering Method	Soldering Conditions	Recommended Condition Symbol
Infrared reflow	Package peak temperature: 260°C, Time: 60 seconds max. (at 220°C or higher), Count: Three times or less, Exposure limit: 3 days ^{Note} (after that, prebake at 125°C for 36 to 72 hours)	IR60-363-3
Wave soldering	When the pin pitch of the package is 0.65 mm or more, wave soldering can also be performed. For details, contact an NEC Electronics sales representative.	–
Partial heating	Pin temperature: 350°C max., Time: 3 seconds max. (per pin row)	–

Note After opening the dry pack, store it at 25°C or less and 65%RH or less for the allowable storage period.

Caution Do not use different soldering methods together (except for partial heating).

Remark Products that have the part numbers suffixed by "-A" are lead-free products.

APPENDIX A MAJOR DIFFERENCES FROM μ PD78078Y SUBSERIES

Series Name		μ PD784218AY Subseries	μ PD78078Y Subseries
Item			
CPU		16-bit CPU	8-bit CPU
Minimum instruction execution time	When the main system clock is selected	160 ns (at 12.5 MHz operation)	400 ns (at 5.0 MHz operation)
	When the subsystem clock is selected	61 μ s (at 32.768-kHz operation)	122 μ s (at 32.768-kHz operation)
Memory space		1 MB	64 KB
I/O port	Total	86	88
	CMOS inputs	8	2
	CMOS I/O	72	78
	N-channel open drain I/O	6	8
Pins with added functions ^{Note}	Pins with pull-up resistors	70	86
	LED direct drive outputs	22	16
	Medium voltage pins	6	8
Timer/counters		<ul style="list-style-type: none"> • 16-bit timer/counter \times 1 unit • 8-bit timer/counter \times 6 units 	<ul style="list-style-type: none"> • 16-bit timer/counter \times 1 unit • 8-bit timer/counter \times 4 units
Serial interface		<ul style="list-style-type: none"> • UART/IOE (3-wire serial I/O) \times 2 channels • CSI (3-wire serial I/O, multi-master compatible I²C bus) \times 1 channel 	<ul style="list-style-type: none"> • UART/IOE (3-wire serial I/O) \times 1 channel • CSI (3-wire serial I/O, 2-wire serial I/O, I²C bus) \times 1 channel • CSI (3-wire serial I/O, 3-wire serial I/O with automatic communication function) \times 1 channel
Interrupts	NMI pin	Yes	No
	Macro service	Yes	No
	Context switching	Yes	No
	Programmable priority	4 levels	No
Standby function		<ul style="list-style-type: none"> • HALT/STOP/IDLE mode • In low power consumption mode: HALT or IDLE mode 	HALT/STOP mode
Package		<ul style="list-style-type: none"> • 100-pin plastic LQFP (fine pitch) (14 \times 14) • 100-pin plastic QFP (14 \times 20) 	<ul style="list-style-type: none"> • 100-pin plastic LQFP (fine pitch) (14 \times 14) • 100-pin plastic QFP (14 \times 20) • 100-pin ceramic WQFN (14 \times 20) (only μPD78P078Y)

Note The pins with added functions are included in the I/O pins.

APPENDIX B DEVELOPMENT TOOLS

The following development tools are available for the development of systems that employ μ PD784218A Subseries products.

- For PC98-NX series
Unless otherwise specified, products supported by IBM PC/AT™ compatible machines can be used for the PC98-NX series. When using the PC98-NX series, refer to the explanation of IBM PC/AT compatible machines.
- For Windows
Unless otherwise specified, "Windows" indicates the following OSs.
 - Windows 3.1
 - Windows 95, 98, 2000
 - Windows NT Ver. 4.0

Figure B-1. Development Tool Configuration (1/2)

(1) When using the in-circuit emulator IE-78K4-NS

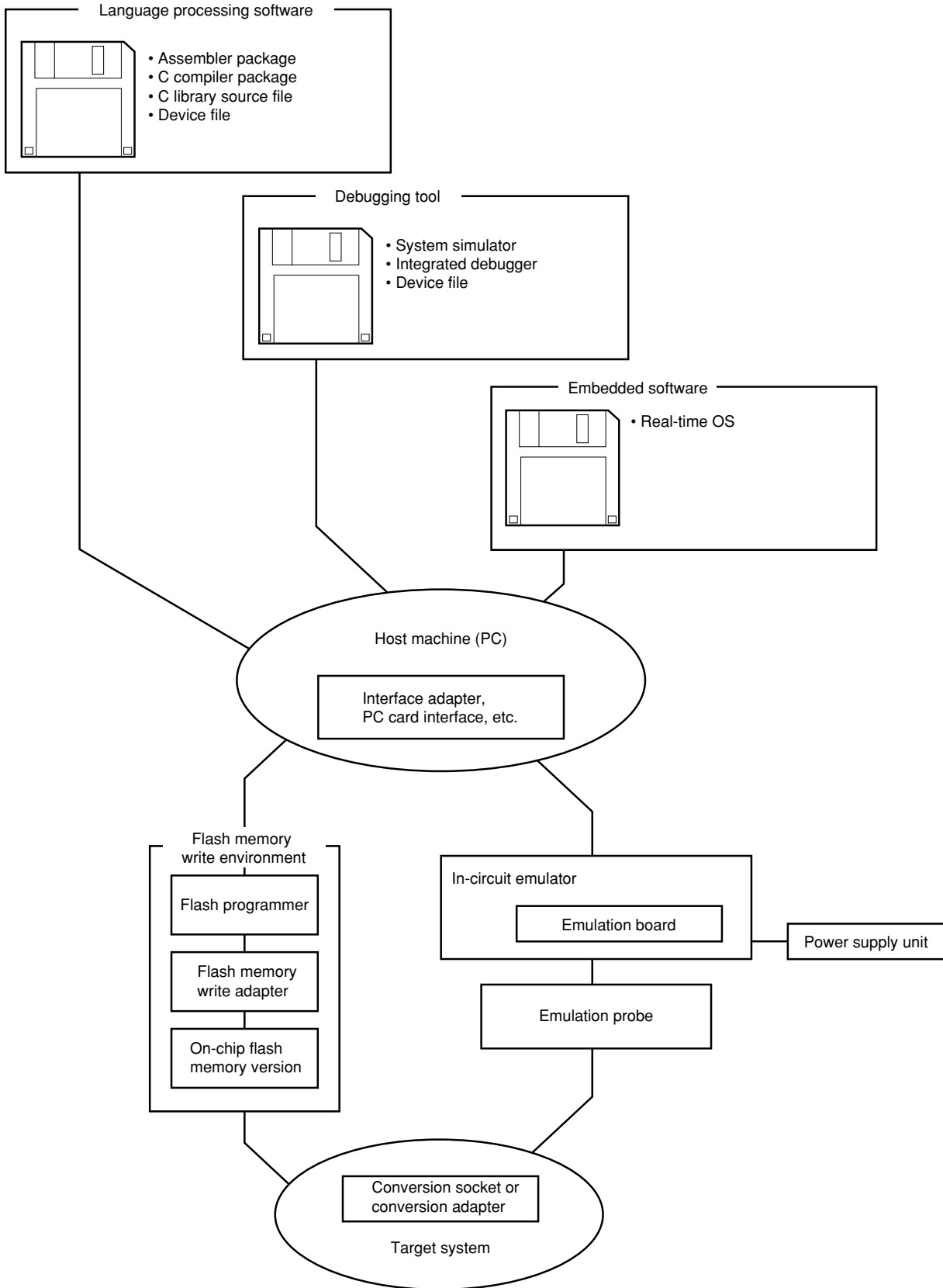
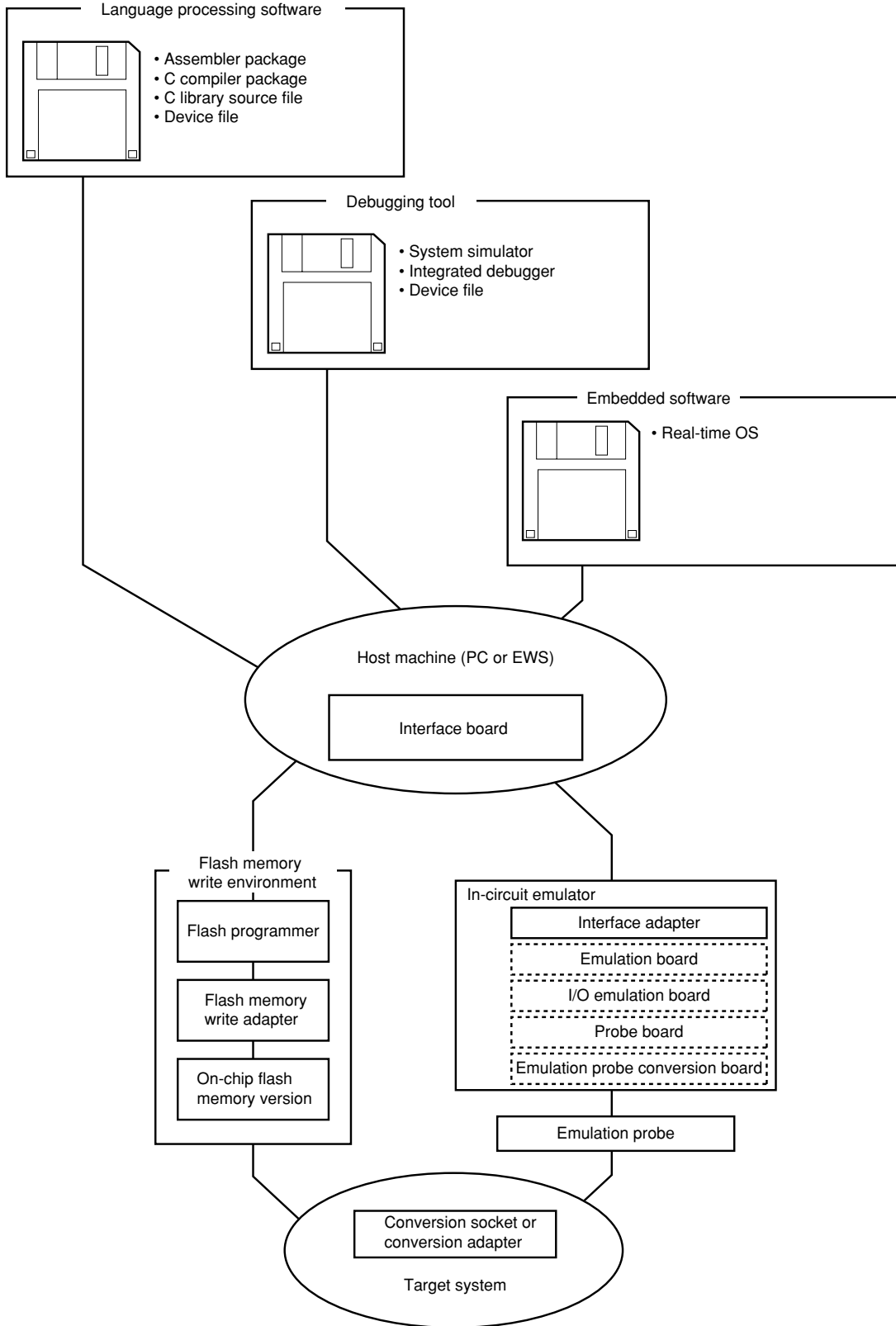


Figure B-1. Development Tool Configuration (2/2)

(2) When using the in-circuit emulator IE-784000-R



Remark Items in broken line boxes differ according to the development environment. Refer to **B.3.1 Hardware**.

B.1 Language Processing Software

★ SP78K4 78K/IV Series Software Package	Development tools (software) common to the 78K/IV Series are combined in this package.
	Part Number: μ SxxxxSP78K4
RA78K4 Assembler Package	This assembler converts programs written in mnemonics into object code executable with a microcontroller. Further, this assembler is provided with functions capable of automatically creating symbol tables and branch instruction optimization. This assembler should be used in combination with an optional device file (DF784218). <Precaution when using RA78K4 in PC environment> This assembler package is a DOS-based application. It can also be used in Windows, however, by using the Project Manager (included in assembler package) on Windows.
	Part Number: μ SxxxxRA78K4
CC78K4 C Compiler Package	This compiler converts programs written in C language into object codes executable with a microcontroller. This compiler should be used in combination with an optional assembler package and device file. <Precaution when using CC78K4 in PC environment> This C compiler package is a DOS-based application. It can also be used in Windows, however, by using the Project Manager (included in assembler package) on Windows.
	Part Number: μ SxxxxCC78K4
DF784218 ^{Note} Device File	This file contains information peculiar to the device. This device file should be used in combination with an optional tool (RA78K4, CC78K4, SM78K4, ID78K4-NS, and ID78K4). Corresponding OS and host machine differ depending on the tool to be used with.
	Part Number: μ SxxxxDF784218
CC78K4-L C Library Source File	This is a source file of functions configuring the object library included in the C compiler package. This file is required to match the object library included in C compiler package to the customer's specifications. The operating environment does not depend on the OS because this is a source file.
	Part Number: μ SxxxxCC78K4-L

Note The DF784218 can be used in common with the RA78K4, CC78K4, SM78K4, ID78K4-NS, and ID78K4.

★ **Remark** The xxxx part number differs depending on the host machine and operating system used.

μSxxxxSP78K4

xxxx	Host Machine	OS	Supply Medium
AB17	PC-9800 series,	Japanese Windows	CD-ROM
BB17	IBM PC/AT compatibles	English Windows	

μSxxxxRA78K4

μSxxxxCC78K4

xxxx	Host Machine	OS	Supply Medium
AB13	PC-9800 series, IBM PC/AT compatibles	Japanese Windows	3.5-inch 2HD FD
BB13		English Windows	
AB17		Japanese Windows	CD-ROM
BB17		English Windows	
3P17	HP9000 series 700™	HP-UX™ (Rel. 10.10)	
3K17	SPARCstation™	SunOS™ (Rel. 4.1.4), Solaris™ (Rel. 2.5.1)	

μSxxxxDF784218

μSxxxxCC78K4-L

xxxx	Host Machine	OS	Supply Medium
AB13	PC-9800 series, IBM PC/AT compatibles	Japanese Windows	3.5-inch 2HD FD
BB13		English Windows	
3P16	HP9000 series 700	HP-UX (Rel. 10.10)	DAT
3K13	SPARCstation	SunOS (Rel. 4.1.4)	3.5-inch 2HD FD
3K15		Solaris (Rel. 2.5.1)	1/4-inch CGMT

B.2 Flash Memory Writing Tools

Flashpro III (type FL-PR3, PG-FP3) Flash Programmer	Flash programmer dedicated to microcontrollers with on-chip flash memory.
FA-100GC FA-100GF Flash Memory Writing Adapter	Flash memory writing adapter used connected to the Flashpro III. <ul style="list-style-type: none"> • FA-100GC: 100-pin plastic LQFP (fine pitch) (GC-8EU type) • FA-100GF: 100-pin plastic QFP (GF-3BA type)

Remark FL-PR2, FL-PR3, FA-100GC, and FA-100GF are products of Naito Densai Machida Mfg. Co., Ltd.
Phone: +81-45-475-4191 Naito Densai Machida Mfg. Co., Ltd.

B.3 Debugging Tools

B.3.1 Hardware (1/2)

(1) When using the in-circuit emulator IE-78K4-NS

IE-78K4-NS In-circuit Emulator		The in-circuit emulator serves to debug hardware and software when developing application systems using a 78K/IV Series product. It corresponds to integrated debugger (ID78K4-NS). This emulator should be used in combination with power supply unit, emulation probe, and interface adapter which is required to connect this emulator to the host machine.
IE-70000-MC-PS-B Power Supply Unit		This adapter is used for supplying power from a receptacle of 100-V to 240-V AC.
IE-70000-98-IF-C Interface Adapter		This adapter is required when using the PC-9800 series computer (except notebook type) as the IE-78K4-NS host machine (C bus supported).
IE-70000-CD-IF-A PC Card Interface		This PC card and interface cable is required when using a notebook-type computer as the IE-78K4-NS host machine (PCMCIA socket supported).
IE-70000-PC-IF-C Interface Adapter		This adapter is required when using the IBM PC/AT compatible computers as the IE-78K4-NS host machine (ISA bus supported).
IE-70000-PCI-IF Interface Adapter		This adapter is required when using a computer that incorporates a PCI bus as the IE-78K4-NS host machine.
IE-784225-NS-EM1 Emulation Board		This board emulates the operations of the peripheral hardware peculiar to a device. It should be used in combination with an in-circuit emulator.
★ NP-100GC NP-H100GC-TQ		This probe is used to connect the in-circuit emulator to the target system and is designed for 100-pin plastic LQFP (fine pitch) (GC-8EU type).
Emulation Probe	TGC-100SDW Conversion Adapter (Refer to Figures B-3 and B-4)	This conversion adapter connects the NP-100GC or NP-H100GC-TQ to the target system board designed to mount a 100-pin plastic LQFP (fine pitch) (GC-8EU type).
★ NP-100GF-TQ NP-H100GF-TQ		This probe is used to connect the in-circuit emulator to the target system and is designed for 100-pin plastic QFP (GF-3BA type).
Emulation Probe	TGF-100RBP Conversion Adapter (Refer to Figures B-5 and B-6)	This conversion adapter connects the NP-100GF-TQ or NP-H100GF-TQ to the target system board designed to mount a 100-pin plastic QFP (GF-3BA type).

- Remarks 1.** NP-100GC, NP-H100GC-TQ, NP-100GF-TQ, and NP-H100GF-TQ are products of Naito Densai Machida Mfg. Co., Ltd.
Phone: +81-45-475-4191 Naito Densai Machida Mfg. Co., Ltd.
- 2.** TGC-100SDW and TGF-100RBP are products of TOKYO ELETECH CORPORATION.
Phone: +81-3-3820-7112 Tokyo Electronics Department
+81-6-6244-6672 Osaka Electronics Department
- 3.** TGC-100SDW and TGF-100RBP are sold in one units.

B.3.1 Hardware (2/2)

(2) When using the in-circuit emulator IE-784000-R

IE-784000-R In-circuit Emulator	IE-784000-R is an in-circuit emulator that can be used with the 78K/IV Series. IE-784000-R can be used with the optional IE-784000-R-EM, IE-784225-NS-EM1, or IE-784218-R-EM1 emulation boards, that are sold separately. The host machine is connected in order to debug. The integrated debugger (ID78K4) and the device files that are sold separately are required. By using this in-circuit emulator in combination with them, debugging is possible at the source program levels of the C language and the structured assembly language. Debugging and program inspection have better efficiency than the C0 coverage function. IE-784000-R can be connected to the host machine by Ethernet™ or a dedicated bus. A separately sold interface adapter is required.
IE-70000-98-IF-C Interface Adapter	This adapter is required when using the PC-9800 series computer (except notebook type) as the IE-784000-R host machine (C bus supported).
IE-70000-PC-IF-C Interface Adapter	This adapter is required when using an IBM PC/AT or compatible computer as the IE-784000-R host machine (ISA bus supported).
IE-70000-PCI-IF Interface Adapter	This adapter is required when using a computer that incorporates a PCI bus as the IE-784000-R host machine.
IE-78000-R-SV3 Interface Adapter	This adapter and cable is required when using an EWS computer as the IE-784000-R host machine, and is used connected to the board in the IE-784000-R. 10Base-5 is supported for Ethernet. For other methods, a conversion adapter commercially available is required.
IE-784000-R-EM	This emulation board is used with the 78K/IV Series.
IE-784225-NS-EM1 IE-784218-R-EM1 Emulation Board	This board emulates the operations of the peripheral hardware peculiar to a device.
IE-78K4-R-EX3 Emulation Probe Conversion Board	This conversion board for 100-pin is required when using the IE-784225-NS-EM1 on the IE-784000-R. It is not required when using the conventional IE-784218-R-EM1.
EP-78064GC-R Emulation Probe	This probe is used to connect the in-circuit emulator to the target system and is designed for 100-pin plastic LQFP (fine pitch) (GC-8EU type).
TGC-100SDW Conversion Adapter (Refer to Figure B-9)	This conversion adapter connects the EP-78064GC-R to the target system board designed to mount a 100-pin plastic LQFP (fine pitch) (GC-8EU type).
EP-784218GF-R Emulation Probe	This probe is used to connect the in-circuit emulator to the target system and is designed for 100-pin plastic QFP (GF-3BA type).
EV-9200GF-100 Conversion Socket (Refer to Figures B-7 and B-8)	This conversion socket connects the EP-784218GF-R to the target system board designed to mount a 100-pin plastic QFP (GF-3BA type).

- Remarks 1.** TGC-100SDW is a product of TOKYO ELETECH CORPORATION.
 Phone: +81-3-3820-7112 Tokyo Electronics Department
 +81-6-6244-6672 Osaka Electronics Department
- 2.** EV-9200GF-100 is sold in five units.
- 3.** TGC-100SDW is sold in one units.

B.3.2 Software

SM78K4 System Simulator	This system simulator is used to perform debugging at C source level or assembler level while simulating the operation of the target system on a host machine. This simulator runs on Windows. Use of the SM78K4 allows the execution of application logical testing and performance testing on an independent basis from hardware development without having to use an in-circuit emulator, thereby providing higher development efficiency and software quality. The SM78K4 should be used in combination with an optional device file (DF784218). Part Number: μ SxxxxSM78K4
ID78K4-NS Integrated Debugger (supporting in-circuit emulator IE-78K4-NS)	This debugger is a control program to debug 78K/IV Series microcontrollers. It adopts a graphical user interface, which is equivalent visually and operationally to Windows. It also has an enhanced debugging function for C language programs, and thus trace results can be displayed on screen in C-language level by using the window integration function which links a trace result with its source program, disassembled display, and memory display. In addition, by incorporating function modules such as task debugger and system performance analyzer, the efficiency of debugging programs, which run on real-time OSs can be improved. It should be used in combination with the optional device file (DF784218). Part Number: μ SxxxxID78K4-NS, μ SxxxxID78K4
ID78K4 Integrated Debugger (supporting in-circuit emulator IE-784000-R)	

★ **Remark** xxxx in the part number differs depending on the host machine and OS used.

μ SxxxxSM78K4
 μ SxxxxID78K4-NS
 μ SxxxxID78K4

xxxx	Host Machine	OS	Supply Medium
AB13	IBM PC/AT compatible	Japanese Windows	3.5-inch 2HC FD
BB13		English Windows	
AB17		Japanese Windows	CD-ROM
BB17		English Windows	

★ **B.4 Cautions on Designing Target System**

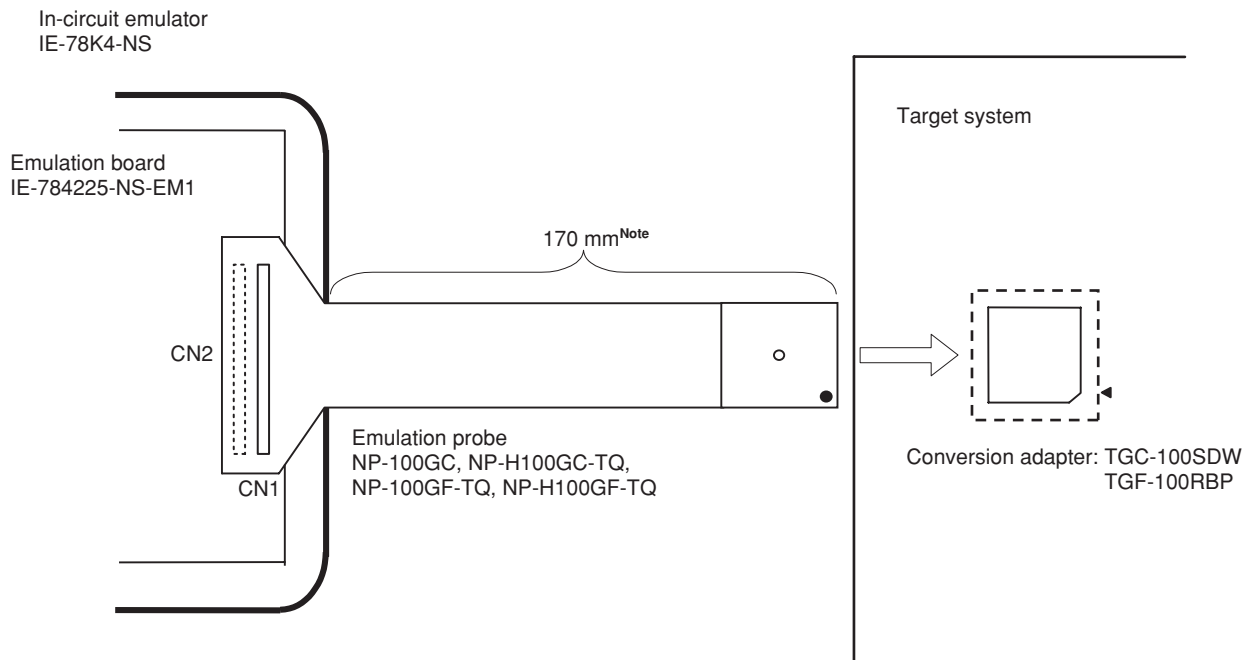
The following shows the conditions when connecting the emulation probe to the conversion adapter. Follow the configuration below and consider the shape of parts to be mounted on the target system when designing a system.

Among the products described in this appendix, NP-100GC, NP-H100GC-TQ, NP-100GF-TQ, and NP-H100GF-TQ are products of Naito Densai Machida Mfg. Co., Ltd., and TGC-100SDW and TGF-100RBP are products of TOKYO ELETECH CORPORATION.

Table B-1. Distance Between IE System and Conversion Adapter

Emulation Probe	Conversion Adapter	Distance Between IE System and Conversion Adapter
NP-100GC	TGC-100SDW	170 mm
NP-H100GC-TQ		370 mm
NP-100GF-TQ	TGF-100RBP	170 mm
NP-H100GF-TQ		370 mm

Figure B-2. Distance Between IE System and Conversion Adapter



Note Distance when the NP-100GC or NP-100GF-TQ is used. When the NP-H100GC-TQ or NP-H100GF-TQ is used, the distance is 370 mm.

Figure B-3. Connection Conditions of Target System (When NP-100GC Is Used)

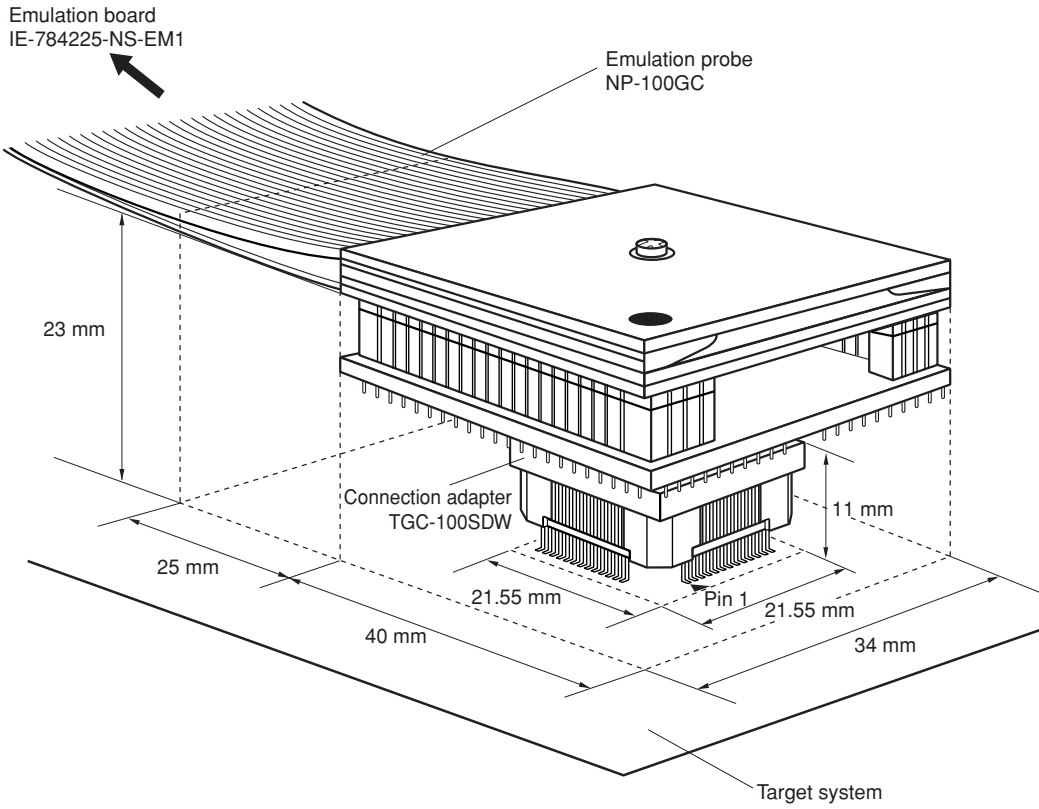


Figure B-4. Connection Conditions of Target System (When NP-H100GC-TQ Is Used)

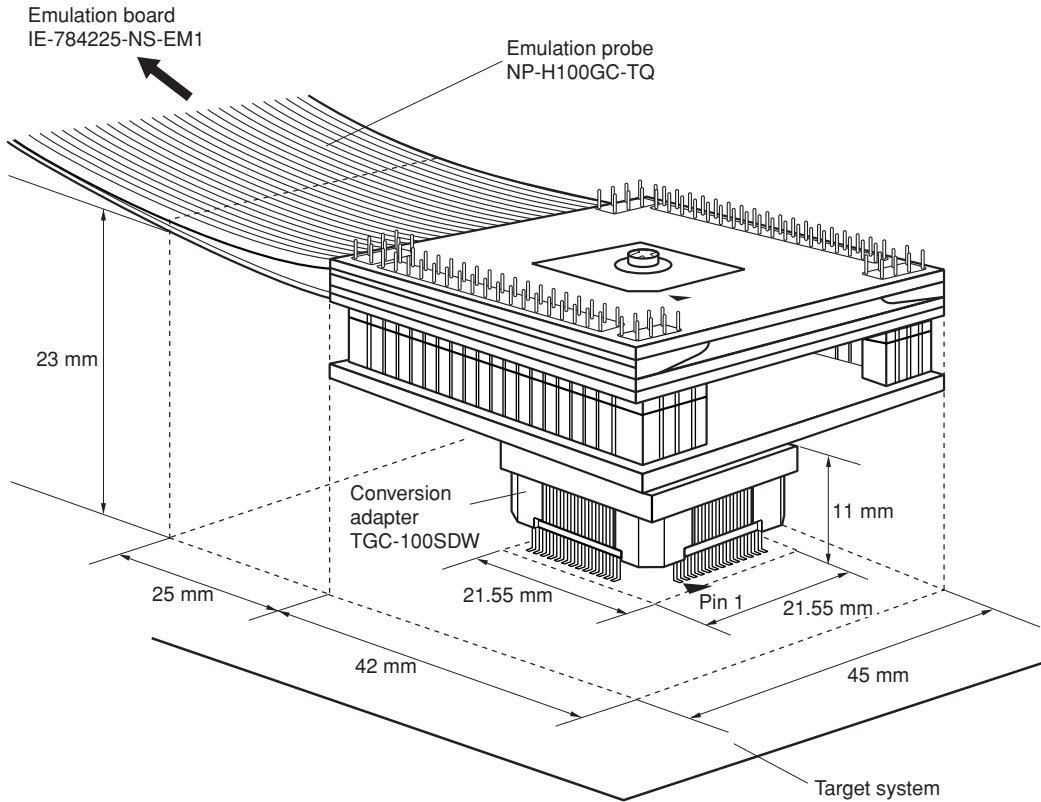


Figure B-5. Connection Conditions of Target System (When NP-100GF-TQ Is Used)

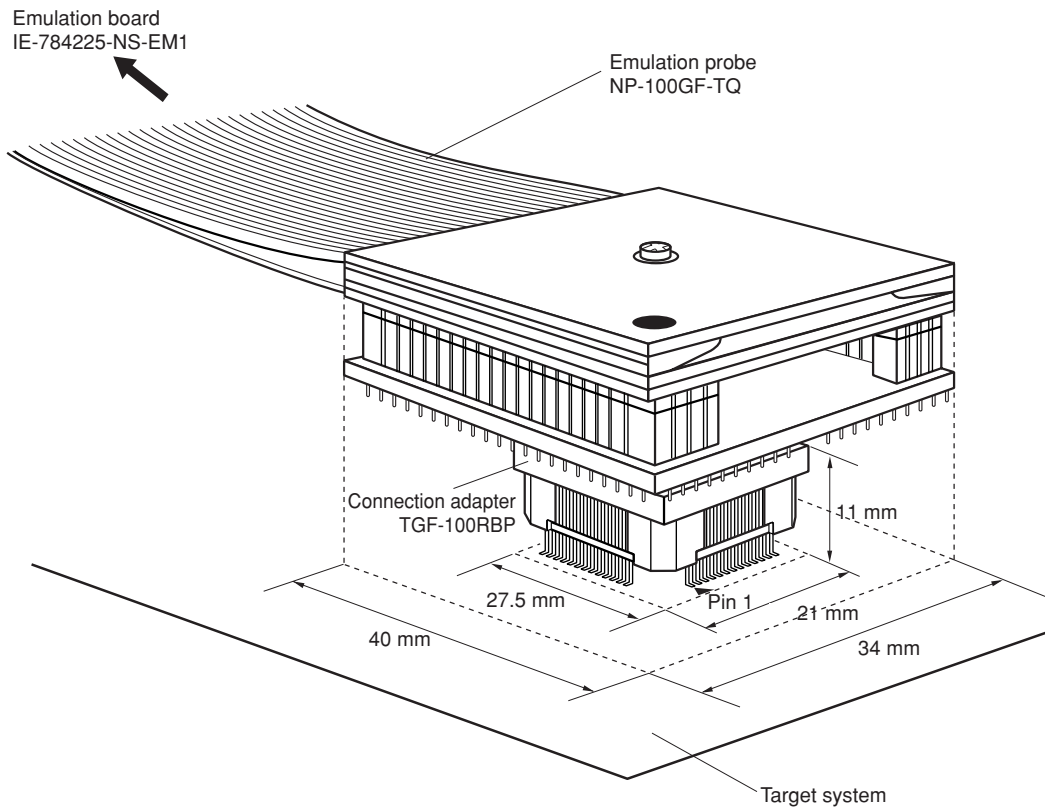
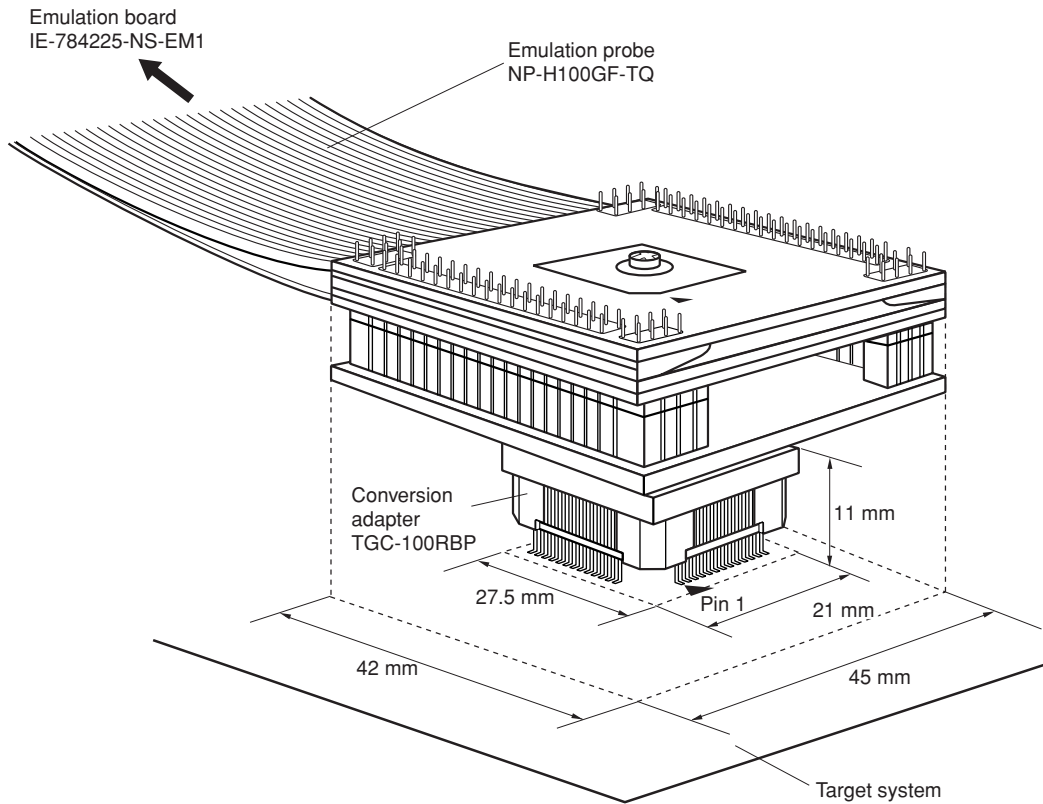


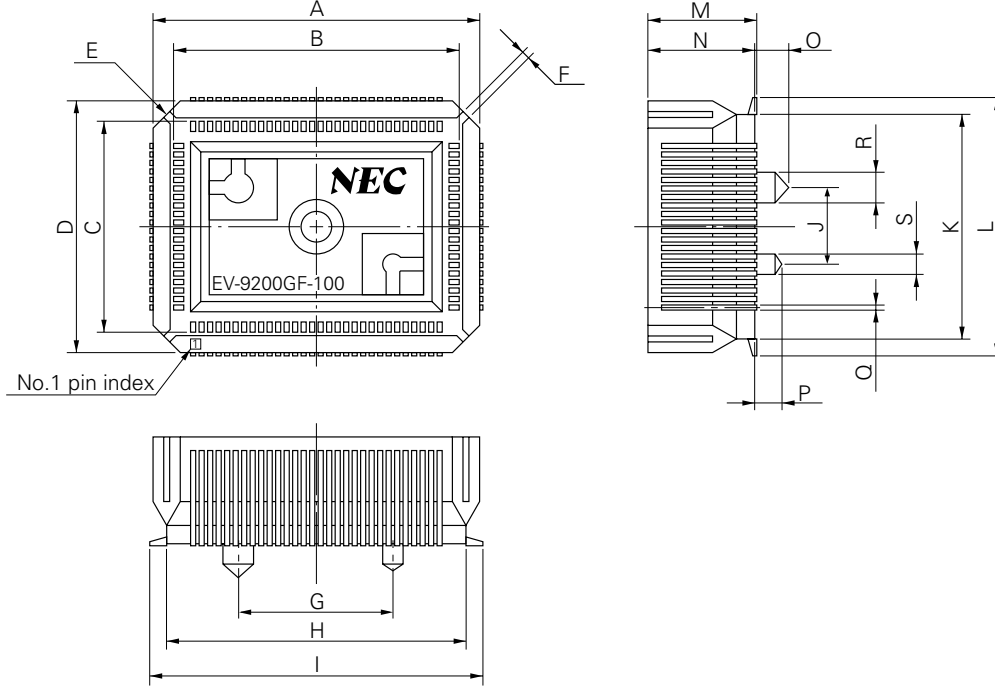
Figure B-6. Connection Conditions of Target System (When NP-H100GF-TQ Is Used)



B.5 Conversion Socket (EV-9200GF-100) and Conversion Adapter (TGC-100SDW)

- (1) Package drawing of the conversion socket (EV-9200GF-100) and recommended footprint EP-784218GF-R is mounted together on the board.

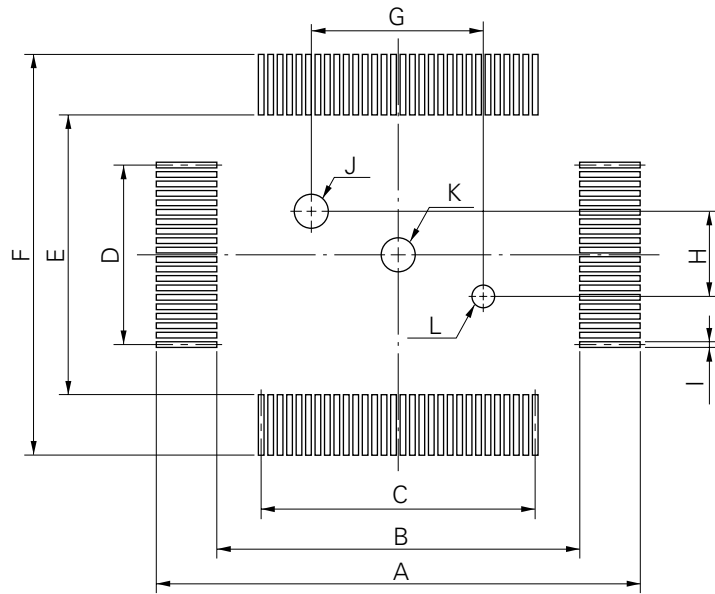
Figure B-7. Package Drawing of EV-9200GF-100 (Reference)



EV-9200GF-100-G0E

ITEM	MILLIMETERS	INCHES
A	24.6	0.969
B	21	0.827
C	15	0.591
D	18.6	0.732
E	4-C 2	4-C 0.079
F	0.8	0.031
G	12.0	0.472
H	22.6	0.89
I	25.3	0.996
J	6.0	0.236
K	16.6	0.654
L	19.3	0.76
M	8.2	0.323
N	8.0	0.315
O	2.5	0.098
P	2.0	0.079
Q	0.35	0.014
R	φ2.3	φ0.091
S	φ1.5	φ0.059

Figure B-8. Recommended Footprint of EV-9200GF-100 (Reference)



EV-9200GF-100-P1E

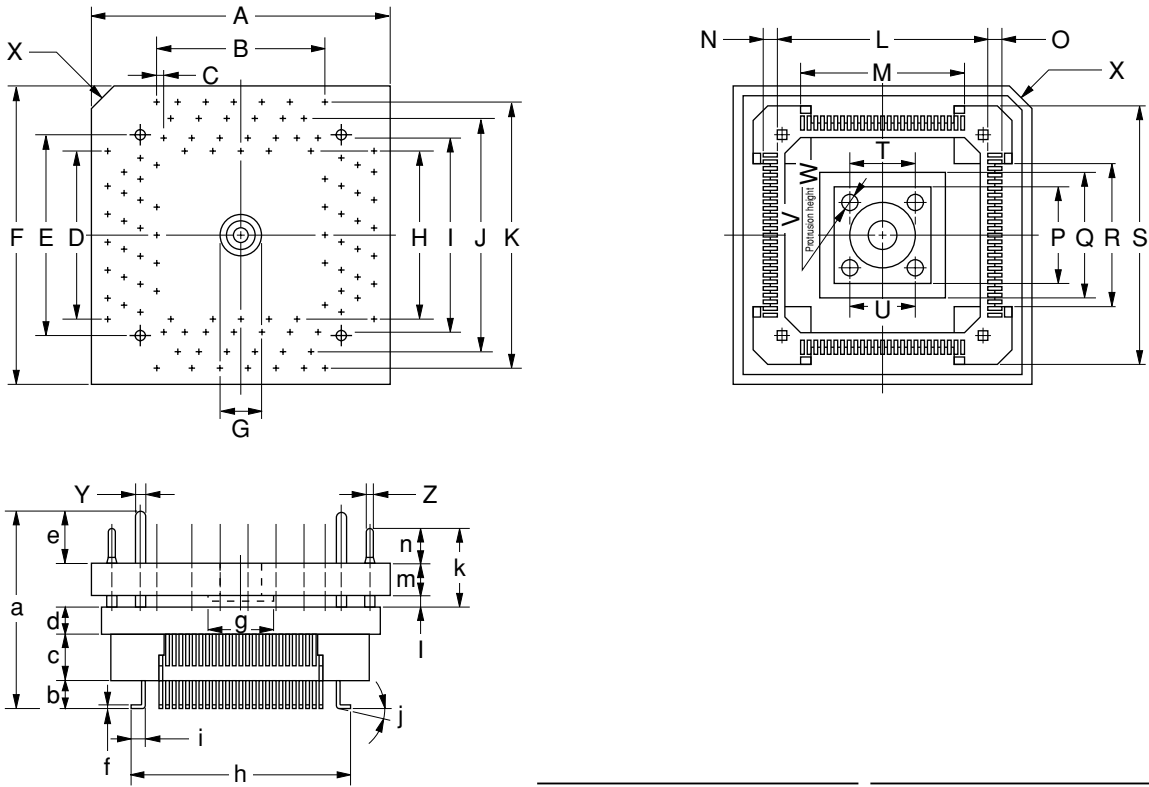
ITEM	MILLIMETERS	INCHES
A	26.3	1.035
B	21.6	0.85
C	$0.65 \pm 0.02 \times 29 = 18.85 \pm 0.05$	$0.026^{+0.001}_{-0.002} \times 1.142 = 0.742^{+0.002}_{-0.002}$
D	$0.65 \pm 0.02 \times 19 = 12.35 \pm 0.05$	$0.026^{+0.001}_{-0.002} \times 0.748 = 0.486^{+0.003}_{-0.002}$
E	15.6	0.614
F	20.3	0.799
G	12 ± 0.05	$0.472^{+0.003}_{-0.002}$
H	6 ± 0.05	$0.236^{+0.003}_{-0.002}$
I	0.35 ± 0.02	$0.014^{+0.001}_{-0.001}$
J	$\phi 2.36 \pm 0.03$	$\phi 0.093^{+0.001}_{-0.002}$
K	$\phi 2.3$	$\phi 0.091$
L	$\phi 1.57 \pm 0.03$	$\phi 0.062^{+0.001}_{-0.002}$

Caution Dimensions of mount pad for EV-9200 and that for target device (QFP) may be different in some parts. For the recommended mount pad dimensions for QFP, refer to "Semiconductor Device Mount Manual" website (<http://www.necel.com/pkg/en/mount/index.html>).

(2) Package drawing of the conversion adapter (TGC-100SDW)

NP-100GC, NP-H100GC-TQ, or EP-78064GC-R is mounted together on the board.

Figure B-9. Package Drawing of TGC-100SDW (Reference)



ITEM	MILLIMETERS	INCHES	ITEM	MILLIMETERS	INCHES
A	21.55	0.848	a	14.45	0.569
B	0.5x24=12	0.020x0.945=0.472	b	1.85±0.25	0.073±0.010
C	0.5	0.020	c	3.5	0.138
D	0.5x24=12	0.020x0.945=0.472	d	2.0	0.079
E	15.0	0.591	e	3.9	0.154
F	21.55	0.848	f	0.25	0.010
G	φ3.55	φ0.140	g	φ4.5	φ0.177
H	10.9	0.429	h	16.0	0.630
I	13.3	0.524	i	1.125±0.3	0.044±0.012
J	15.7	0.618	j	0~5°	0.000~0.197°
K	18.1	0.713	k	5.9	0.232
L	13.75	0.541	l	0.8	0.031
M	0.5x24=12.0	0.020x0.945=0.472	m	2.4	0.094
N	1.125±0.3	0.044±0.012	n	2.7	0.106
O	1.125±0.2	0.044±0.008	TGC-100SDW-G1E		
P	7.5	0.295			
Q	10.0	0.394			
R	11.3	0.445			
S	18.1	0.713			
T	φ5.0	φ0.197			
U	5.0	0.197			
V	4-φ1.3	4-φ0.051			
W	1.8	0.071			
X	C 2.0	C 0.079			
Y	φ0.9	φ0.035			
Z	φ0.3	φ0.012			

note: Product by TOKYO ELETECH CORPORATION.

APPENDIX C EMBEDDED SOFTWARE

For efficient development and maintenance of the μ PD784218A Subseries, the following embedded products are available.

RX78K4 Real-time OS	RX78K4 is a real-time OS conforming to the μ TRON specifications. Tool (configurator) for generating nucleus of RX78K4 and plural information tables is supplied. Used in combination with an optional assembler package (RA78K4) and device file (DF784218). <Precaution when using RX78K/IV in PC environment> The real-time OS is a DOS-based application. It should be used in the DOS Prompt when using in Windows.
	Part number: μ SxxxxRX78K4- $\Delta\Delta\Delta\Delta$

Caution When purchasing the RX78K4, fill in the purchase application form in advance and sign the user agreement.

Remark xxxx and $\Delta\Delta\Delta\Delta$ in the part number differ depending on the host machine and OS used.

μ SxxxxRX78K4- $\Delta\Delta\Delta\Delta$

$\Delta\Delta\Delta\Delta$	Product Outline	Maximum Number for Use in Mass Production
001	Evaluation object	Do not use for mass-produced product.
100K	Mass-production object	0.1 million units
001M		1 million units
010M		10 million units
S01	Source program	Source program for mass-produced object

xxxx	Host Machine	OS	Supply Medium
AA13	PC-9800 series	Windows (Japanese version) ^{Note}	3.5-inch 2HD FD
AB13	IBM PC/AT compatible	Windows (Japanese version) ^{Note}	3.5-inch 2HC FD
BB13		Windows (English version) ^{Note}	
3P16	HP9000 series 700	HP-UX (Rel. 10.10)	DAT (DDS)
3K13	SPARCstation	SunOS (Rel. 4.1.4),	3.5-inch 2HC FD
3K15		Solaris (Rel. 2.5.1)	1/4-inch CGMT

Note Can also be operated in DOS environment.

APPENDIX D REGISTER INDEX

D.1 Register Index (Alphabetical Order)

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16-bit timer counter 0 (TM0)	163
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16-bit timer output control register (TOC0)	169
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8-bit compare register 60 (CR60)	218
8-bit compare register 70 (CR70)	239
8-bit compare register 80 (CR80)	239
8-bit timer counter 1 (TM1)	197
8-bit timer counter 2 (TM2)	197
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8-bit timer counter 7 (TM7)	239
8-bit timer counter 8 (TM8)	239
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8-bit timer mode control register 2 (TMC2)	198
8-bit timer mode control register 5 (TMC5)	219
8-bit timer mode control register 6 (TMC6)	219
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8-bit timer mode control register 8 (TMC8)	240

[A]

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[C]

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 External bus type selection register (EBTS) 480
 External interrupt falling edge enable register (EGN0) 397
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 In-service priority register (ISPR) 412
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 Interrupt mask register 0H (MK0H) 410
 Interrupt mask register 0L (MK0L) 410
 Interrupt mask register 1H (MK1H) 410
 Interrupt mask register 1L (MK1L) 410
 Interrupt mode control register (IMC) 413
 Interrupt selection control register (SNMI) 415

[M]

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 Oscillation stabilization time specification register (OSTS) 111, 522

[P]

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Pull-up resistor option register 2 (PU2)	147
Pull-up resistor option register 3 (PU3)	147
Pull-up resistor option register 7 (PU7)	147
Pull-up resistor option register 8 (PU8)	147
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[T]

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[W]

Watch timer mode control register (WTM)	259
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D.2 Register Index (Symbols)

[A]

ADCR: A/D conversion result register 270
 ADIC: Interrupt control register 409
 ADIS: A/D converter input selection register 273
 ADM: A/D converter mode register 271
 ASIM1: Asynchronous serial interface mode register 1 298, 305
 ASIM2: Asynchronous serial interface mode register 2 298, 305
 ASIS1: Asynchronous serial interface status register 1 300, 306
 ASIS2: Asynchronous serial interface status register 2 300, 306

[B]

BRGC1: Baud rate generator control register 1 301, 307
 BRGC2: Baud rate generator control register 2 301, 307

[C]

CC: Oscillation mode selection register 109
 CKS: Clock output control register 392, 395
 CORAH: ROM correction address register H 565
 CORAL: ROM correction address register L 565
 CORC: ROM correction control register 565
 CR00: 16-bit capture/compare register 00 164
 CR01: 16-bit capture/compare register 01 165
 CR10: 8-bit compare register 10 197
 CR20: 8-bit compare register 20 197
 CR50: 8-bit compare register 50 218
 CR60: 8-bit compare register 60 218
 CR70: 8-bit compare register 70 239
 CR80: 8-bit compare register 80 239
 CRC0: Capture/compare control register 0 169
 CSICC0: Interrupt control register 407
 CSIM0: Serial operation mode register 0 327, 329, 330
 CSIM1: Serial operation mode register 1 321, 322, 323
 CSIM2: Serial operation mode register 2 321, 322, 323

[D]

DACS0: D/A conversion setting register 0 286
 DACS1: D/A conversion setting register 1 286
 DAM0: D/A converter mode register 0 287
 DAM1: D/A converter mode register 1 287

[E]

EBTS: External bus type selection register 480
 EGN0: External interrupt falling edge enable register 397
 EGPO: External interrupt rising edge enable register 397
 EXAE: External access status enable register 512

[I]

IIC0:	Serial shift register	335, 346
IICC0:	I ² C bus control register	336
IICS0:	I ² C bus status register	341
IMC:	Interrupt mode control register	413
IMS:	Internal memory size switching register	80
ISPR:	In-service priority register	412

[K]

KRIC:	Interrupt control register	409
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[M]

MK0H:	Interrupt mask register 0H	410
MK0L:	Interrupt mask register 0L	410
MK1H:	Interrupt mask register 1H	410
MK1L:	Interrupt mask register 1L	410
MM:	Memory expansion mode register	479

[O]

OSTS:	Oscillation stabilization time specification register	111, 522
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[P]

P0:	Port 0	122
P1:	Port 1	124
P10:	Port 10	141
P12:	Port 12	142
P13:	Port 13	143
P2:	Port 2	125
P3:	Port 3	129
P4:	Port 4	131
P5:	Port 5	132
P6:	Port 6	133
P7:	Port 7	135
P8:	Port 8	139
P9:	Port 9	140
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PF2:	Port function control register	149
PIC0:	Interrupt control register	407
PIC1:	Interrupt control register	407
PIC2:	Interrupt control register	407
PIC3:	Interrupt control register	407
PIC4:	Interrupt control register	407
PIC5:	Interrupt control register	407
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PM0:	Port 0 mode register	144
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PM12:	Port 12 mode register	144
PM13:	Port 13 mode register	144

PM2:	Port 2 mode register	144, 393, 396
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PM5:	Port 5 mode register	144
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PM7:	Port 7 mode register	144
PM8:	Port 8 mode register	144
PM9:	Port 9 mode register	144
PRM0:	Prescaler mode register 0	171
PRM1:	Prescaler mode register 1	201
PRM2:	Prescaler mode register 2	201
PRM5:	Prescaler mode register 5	222
PRM6:	Prescaler mode register 6	222
PRM7:	Prescaler mode register 7	243
PRM8:	Prescaler mode register 8	243
PSW:	Program status word	82, 416
PU0:	Pull-up resistor option register 0	147
PU10:	Pull-up resistor option register 10	147
PU12:	Pull-up resistor option register 12	147
PU2:	Pull-up resistor option register 2	147
PU3:	Pull-up resistor option register 3	147
PU7:	Pull-up resistor option register 7	147
PU8:	Pull-up resistor option register 8	147
PUO:	Pull-up resistor option register	147
PWC1:	Programmable wait control register 1	480
[R]		
RTBH:	Real-time output buffer register H	153
RTBL:	Real-time output buffer register L	153
RTPC:	Real-time output port control register	155
RTPM:	Real-time output port mode register	154
RX1:	Receive shift register 1	297
RX2:	Receive shift register 2	297
RXB1:	Receive buffer register 1	297
RXB2:	Receive buffer register 2	297
[S]		
SERIC1:	Interrupt control register	408
SERIC2:	Interrupt control register	408
SIO0:	Serial I/O shift register 0	326
SIO1:	Serial I/O shift register 1	320
SIO2:	Serial I/O shift register 2	320
SNMI:	Interrupt selection control register	415
SPRM0:	Prescaler mode register for serial clock	344
SRIC1:	Interrupt control register	408
SRIC2:	Interrupt control register	408
STBC:	Standby control register	107, 414
STIC1:	Interrupt control register	408
STIC2:	Interrupt control register	408
SVA0:	Slave address register	335, 346

[T]

TM0:	16-bit timer counter 0	163
TM1:	8-bit timer counter 1	197
TM2:	8-bit timer counter 2	197
TM5:	8-bit timer counter 5	218
TM6:	8-bit timer counter 6	218
TM7:	8-bit timer counter 7	239
TM8:	8-bit timer counter 8	239
TMC0:	16-bit timer mode control register	166
TMC1:	8-bit timer mode control register 1	198
TMC2:	8-bit timer mode control register 2	198
TMC5:	8-bit timer mode control register 5	219
TMC6:	8-bit timer mode control register 6	219
TMC7:	8-bit timer mode control register 7	240
TMC8:	8-bit timer mode control register 8	240
TMIC00:	Interrupt control register	408
TMIC01:	Interrupt control register	408
TMIC1:	Interrupt control register	409
TMIC2:	Interrupt control register	409
TMIC3:	Interrupt control register	408
TMIC5:	Interrupt control register	409
TMIC6:	Interrupt control register	409
TMIC7:	Interrupt control register	409
TMIC8:	Interrupt control register	409
TOC0:	16-bit timer output control register	169
TXS1:	Transmit shift register 1	297
TXS2:	Transmit shift register 2	297

[W]

WDM:	Watchdog timer mode register	264, 414
WDTIC:	Interrupt control register	407
WTIC:	Interrupt control register	409
WTM:	Watch timer mode control register	259

APPENDIX E REVISION HISTORY

(1/7)

Edition	Major Revised Contents from Previous Version	Location
2nd edition	Combination of manuals of μ PD784216A/784216AY Subseries and μ PD784218A/784218AY Subseries with following part numbers changed: Before change: μ PD784217, 784218, 784217Y, 784218Y, 78F4218, 78F4218Y After change: μ PD784217A, 784218A, 784217AY, 784218AY, 78F4218A, 78F4218AY Products covered μ PD784214A, 784215A, 784216A, 784217A, 784218A, 784214AY, 784215AY, 784216AY, 784217AY, 784218AY, 78F4216A, 78F4218A, 78F4216AY, 784218AY	Throughout
	Change of power supply voltage Mask version: $V_{DD} = 2.2\text{ V to }5.5\text{ V} \rightarrow V_{DD} = 1.8\text{ V to }5.5\text{ V}$ Flash memory: $V_{DD} = 2.7\text{ V to }5.5\text{ V} \rightarrow V_{DD} = 1.9\text{ V to }5.5\text{ V}$	CHAPTER 1 OVERVIEW
	Modification of Table 2-1 I/O Circuit Type for Each Pin and Handling Unused Pins	CHAPTER 2 PIN FUNCTIONS
	Modification of Figure 2-1 Pin I/O Circuit	
	Modification of Figure 3-7 Internal Memory Size Switching Register (IMS) Format	CHAPTER 3 CPU ARCHITECTURE
	Modification of Table 3-7 Special Function Register (SFR) List	
	Modification of text in (1) Main system clock oscillator	CHAPTER 4 CLOCK GENERATOR
	Modification of Figure 4-1 Block Diagram of Clock Generator	
	Modification of Figure 4-2 Standby Control Register (STBC) Format	
	Modification of Figure 4-4 Clock Status Register (PCS) Format	
	Change of Caution in 5.2.1 Port 0	CHAPTER 5 PORT FUNCTIONS
	Modification of Figure 5-2 Block Diagram of P00 to P06	
	Modification of Figure 5-3 Block Diagram of P10 to P17	
	Modification of Figures 5-4 to 5-7 Block Diagrams of P20 to P27	
	Modification of Figures 5-8 and 5-9 Block Diagrams of P30 to P37	
	Modification of Figure 5-10 Block Diagram of P40 to P47	
	Modification of Figure 5-11 Block Diagram of P50 to P57	
	Modification of Figures 5-12 to 5-14 Block Diagrams of P60 to P67	
	Modification of Figures 5-15 to 5-17 Block Diagrams of P70 to P72	
	Modification of Figure 5-22 Block Diagram of P120 to P127	
	Modification of Figure 5-23 Block Diagram of P130 and P131	
	Addition of Caution to Figure 5-25 Pull-Up Resistor Option Register Format	
	Addition of Caution to Figure 6-4 Real-Time Output Port Control Register (RTPC) Format	CHAPTER 6 REAL-TIME OUTPUT FUNCTIONS
Modification of text in 6.5 Usage		

Edition	Major Revised Contents from Previous Version	Location
2nd edition	Addition of Table 8-4 Valid Edge of TI00 Pin and Capture Trigger of CR01	CHAPTER 8 16-BIT TIMER/EVENT COUNTER
	Modification of Figure 8-4 Format of 16-Bit Timer Output Control Register (TOC0)	
	Modification of Caution of Figure 8-5 Format of Prescaler Mode Register 0 (PRM0)	
	Addition of Caution to Figure 8-12 Timing of Pulse Width Measurement with Free-Running Counter and One Capture Register (with Both Edges Specified)	
	Addition of Caution to Figure 8-15 Timing of Pulse Width Measurement with Free-Running Counter (with Both Edges Specified)	
	Addition of Caution to Figure 8-17 Timing of Pulse Width Measurement with Free-Running Counter and Two Capture Registers (with Rising Edge Specified)	
	Addition of Caution to Figure 8-19 Timing of Pulse Width Measurement by Restarting (with Rising Edge Specified)	
	Modification of text in 8.4.4 Operation as external event counter	
	Addition of Caution 2 to 8.4.6 Operation as one-shot pulse output	
	Addition of Caution 2 to Figure 8-26 Timing of One-Shot Pulse Output Operation with Software Trigger	
	Modification of Caution in (3) One-shot pulse output with external trigger	
	Addition of Caution 2 to Figure 8-28 Timing of One-Shot Pulse Output Operation with External Trigger (with Rising Edge Specified)	
	Addition of (6) Cautions on edge detection	
	Addition of (7) Trigger for one-shot pulse	
	2nd edition	
Modification of Caution in (1) 8-bit timer counter 1, 2 (TM1, TM2)		
Modification of Caution in (2) 8-bit compare register 1, 2 (CR10, CR20)		
Modification of text in (1) 8-bit timer mode control register 1, 2 (TMC1, TMC2)		
Change of Figure 9-2 Format of 8-Bit Timer Mode Control Register 1 (TMC1)		
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Addition of Caution 3 to Figure 9-4 Format of Prescaler Mode Register 1 (PRM1)		
Addition of Caution 3 to Figure 9-5 Format of Prescaler Mode Register 2 (PRM2)		
Modification of setting method in 9.4.3 Operation as square wave output (8-bit resolution)		
Modification of setting method in 9.4.4 Operation as 8-bit PWM output		

Edition	Major Revised Contents from Previous Version	Location	
2nd edition	Change of Figure 9-8 Timing of PWM Output	CHAPTER 9 8-BIT TIMER/EVENT COUNTER 1, 2	
	Modification of Caution 4 in 9.4.5 Operation as internal timer (16-bit operation)		
	Modification of text in (3) TM1, TM2 read out during timer operation in 9.5 Cautions		
	Change of Figure 10-1 Block Diagram of 8-Bit Timer/Event Counter 5, 6	CHAPTER 10 8-BIT TIMER/EVENT COUNTER 5, 6	
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	Modification of Caution in (2) 8-bit compare register 5, 6 (CR50, CR60)		
	Modification of text in (1) 8-bit timer mode control register 5, 6 (TMC5, TMC6)		
	Change of Figure 10-2 Format of 8-Bit Timer Mode Control Register 5 (TMC5)		
	Change of Figure 10-3 Format of 8-Bit Timer Mode Control Register 6 (TMC6)		
	Addition of Caution 3 to Figure 10-4 Format of Prescaler Mode Register 5 (PRM5)		
	Addition of Caution 3 to Figure 10-5 Format of Prescaler Mode Register 6 (PRM6)		
	Modification of setting method in 10.4.3 Operation as square wave output (8-bit resolution)		
	Modification of setting method in 10.4.4 Operation as 8-bit PWM output		
	Change of Figure 10-8 Timing of PWM Output		
	Modification of Caution 4 in 10.4.5 Operation as internal timer (16-bit operation)		
	Modification of text in (3) TM5, TM6 read out during timer operation in 10.5 Cautions		
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	Modification of text in (1) 8-bit timer mode control register 7, 8 (TMC7, TMC8)		
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	Addition of Caution 3 to Figure 11-4 Format of Prescaler Mode Register 7 (PRM7)		
	Addition of Caution 3 to Figure 11-5 Format of Prescaler Mode Register 8 (PRM8)		
	Modification of setting method in 11.4.3 Operation as square wave output (8-bit resolution)		

Edition	Major Revised Contents from Previous Version	Location
2nd edition	Modification of setting method in 11.4.4 Operation as 8-bit PWM output	CHAPTER 11 8-BIT TIMER/EVENT COUNTER 7, 8
	Change of Figure 11-8 Timing of PWM Output	
	Modification of Caution 4 in 11.4.5 Operation as interval timer (16-bit operation)	
	Modification of text in (3) TM7, TM8 read out during timer operation in 11.5 Cautions	
	Addition of Figure 12-1 Block Diagram of Watch Timer	CHAPTER 12 WATCH TIMER
	Addition of Caution to Figure 12-2 Format of Watch Timer Mode Control Register (WTM)	
	Addition of Caution to Table 12-3 Interval Time of Interval Timer	
	Modification of Figure 12-3 Operation Timing of Watch Timer/Interval Timer	
	Modification of Figure 13-1 Watchdog Timer Block Diagram	CHAPTER 13 WATCHDOG TIMER
	Modification of text in 13.3.2 Interrupt priority order	
	Modification of Figure 14-1 A/D Converter Block Diagram	CHAPTER 14 A/D CONVERTER
	Modification of Figure 14-2 A/D Converter Mode Register (ADM) Format	
	Addition of Caution to 14.4.1 Basic operation of A/D converter	
	Addition of Note to Figure 14-6 A/D Conversion Operation by Hardware Start (with Falling Edge Specified)	
	Addition of Note to Figure 14-7 A/D Conversion Operation by Software Start	
	Change of Figure 14-8 Method to Reduce Current Consumption in Standby Mode	
	Addition of Note to Figure 14-10 A/D Conversion End Interrupt Generation Timing	
	Addition of an item (14) to 14.5 Cautions	
	Addition of Figure 14-15 Internal Equivalence Circuit of ANI0 to ANI7 Pins	
	Addition of Table 14-2 Resistance and Capacitance Values for Equivalence Circuits (Reference Values)	
	Addition of Figure 14-16 Example of Circuit When Signal Source Impedance Is High	
Modification of Figure 17-2 Block Diagram in Asynchronous Serial Interface Mode		
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	Modification of Figure 18-1 Block Diagram of Clocked Serial Interface (in 3-Wire Serial I/O Mode)	CHAPTER 18 3-WIRE SERIAL I/O MODE
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	Modification of Figure 23-32 Stepping Motor Open Loop Control by Real-Time Output Port	
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	Addition of Figure 24-4 Memory Map of μPD784214A	
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	Addition of Figure 24-6 Memory Map of μPD784216A	

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	Modification of Figure 25-12 Setting Timing for Subsystem Clock Operation	
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	Addition of Figure 28-4 Connection of Flashpro III in UART Mode (When Using UART)	
3rd edition	Update of 78K/IV PRODUCT LINEUP	CHAPTER 1 GENERAL
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	Addition of chapter	CHAPTER 32 PACKAGE DRAWINGS
	Addition of chapter	CHAPTER 33 RECOMMENDED SOLDERING CONDITIONS
3rd edition	<ul style="list-style-type: none"> • Addition of SP78K4 to B.1 Language Processing Software, modification of description in Remark • Addition and modification of description in B.3.1 Hardware • Modification of description in Remark in B.3.2 Software • Addition of B.4 Cautions on Designing Target System 	APPENDIX B DEVELOPMENT TOOLS
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